Hitachi Single-Chip Microcomputer H8S/2138 Series H8S/2134 Series H8S/2138F-ZTATTM H8S/2134F-ZTATTM

H8S/2138 HD6432138W, HD6432138, HD64F2138, HD64F2138V H8S/2137 HD6432137W, HD6432137 H8S/2134 HD6432134, HD64F2134, HD64F2134V H8S/2133 HD6432133 H8S/2132 HD6432132, HD64F2132R, HD64F2132V H8S/2130 HD6432130 Hardware Manual

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Preface

The H8S/2138 Series and H8S/2134 Series comprise high-performance microcomputers with a 32-bit H8S/2000 CPU core, and a set of on-chip supporting functions required for system configuration.

The H8S/2000 CPU can execute basic instructions in one state, and is provided with sixteen internal 16-bit general registers with a 32-bit configuration, and a concise and optimized instruction set. The CPU can handle a 16-Mbyte linear address space (architecturally 4 Gbytes). Programs based on the high-level language C can also be run efficiently.

Single-power-supply flash memory (F-ZTAT^{TM*}) and mask ROM versions are available, providing a quick and flexible response to conditions from ramp-up through full-scale volume production, even for applications with frequently changing specifications.

On-chip peripheral functions include a 16-bit free-running timer (FRT), 8-bit timer (TMR), watchdog timer (WDT), two PWM timers (PWM and PWMX), a serial communication interface (SCI, IrDA), host interface (HIF), D/A converter (DAC), A/D converter (ADC), and I/O ports. An I²C bus interface (IIC) can also be incorporated as an option.

An on-chip data transfer controller (DTC) is also provided, enabling high-speed data transfer without CPU intervention.

The H8S/2138 Series has all the above on-chip supporting functions, and can also be provided with an IIC module as an option. The H8S/2134 Series comprises reduced-function versions, with fewer TMR channels, and no PWM, HIF, IIC, or DTC modules.

Use of the H8S/2138 or H8S/2134 Series enables compact, high-performance systems to be implemented easily. The comprehensive PC-related interface functions and 16×8 matrix key-scan functions are ideal for applications such as notebook PC keyboard control and intelligent battery and power supply control, while the various timer functions and their interconnectability (timer connection), plus the interlinked operation of the I²C bus interface and data transfer controller (DTC), in particular, make these devices ideal for use in PC monitors. In addition, the combination of F-ZTAT^{TM*} and reduced-function versions is ideal for applications such as system units in which on-chip program memory is essential to meet performance requirements, product start-up times are short, and program modifications may be necessary after end-product assembly.

This manual describes the hardware of the H8S/2138 Series and H8S/2134 Series. Refer to the *H8S/2600 Series and H8S/2000 Series Programming Manual* for a detailed description of the instruction set.

Note: * F-ZTATTM (Flexible-ZTAT) is a trademark of Hitachi, Ltd.

On-Chip Supporting Modules

Series	H8S/2138 Series	H8S/2134 Series	
Product names	H8S/2138, 2137	H8S/2134, 2133, 2132, 2130	
Bus controller (BSC)	Available (8 bits)	Available (8 bits)	
Data transfer controller (DTC)	Available	_	
8-bit PWM timer (PWM)	×16	_	
14-bit PWM timer (PWMX)	×2	×2	
16-bit free-running timer (FRT)	×1	×1	
8-bit timer (TMR)	×4	×3	
Timer connection	Available	_	
Watchdog timer (WDT)	×2	×2	
Serial communication interface (SCI)	×3	×3	
I ² C bus interface (IIC)	×2 (option)	—	
Host interface (HIF)	Available	_	
D/A converter	×2	×2	
A/D converter	×8 (analog input)	×8 (analog input)	
	×8 (expansion A/D inputs)	×8 (expansion A/D inputs)	

Section 1 Overview

1.1 Overview

The H8S/2138 Series and H8S/2134 Series comprise microcomputers (MCUs) built around the H8S/2000 CPU, employing Hitachi's proprietary architecture, and equipped with supporting modules on-chip.

The H8S/2000 CPU has an internal 32-bit architecture, is provided with sixteen 16-bit general registers and a concise, optimized instruction set designed for high-speed operation, and can address a 16-Mbyte linear address space. The instruction set is upward-compatible with H8/300 and H8/300H CPU instructions at the object-code level, facilitating migration from the H8/300, H8/300L, or H8/300H Series.

On-chip supporting modules required for system configuration include a data transfer controller (DTC) bus master, ROM and RAM memory, a16-bit free-running timer module (FRT), 8-bit timer module (TMR), watchdog timer module (WDT), two PWM timers (PWM and PWMX), serial communication interface (SCI), host interface (HIF), D/A converter (DAC), A/D converter (ADC), and I/O ports. An I²C bus interface (IIC) can also be incorporated as an option.

The on-chip ROM is either flash memory (F-ZTAT^{TM*}) or mask ROM, with a capacity of 128, 96, 64, or 32 kbytes. ROM is connected to the CPU via a 16-bit data bus, enabling both byte and word data to be accessed in one state. Instruction fetching has been speeded up, and processing speed increased.

Three operating modes, modes 1 to 3, are provided, and there is a choice of address space and single-chip mode or externally expanded modes.

The features of the H8S/2138 Series and H8S/2134 Series are shown in Table 1.1.

Note: * F-ZTATTM is a trademark of Hitachi, Ltd.

Table 1.1Overview

ltem	Speci	Specifications						
CPU	• Ge	eneral-register a	architecture					
	 — Sixteen 16-bit general registers (also usable as sixteen 8-bit registers or eight 32-bit registers) 							
	• Hi							
		 Maximum operating frequency: 20 MHz/5 V, 10 MHz/3 V 						
		 High-speed arithmetic operations 						
		8/16/32-bit register-register add/subtract: 50 ns (20 MHz operation)						
		16×16 -bit rec	ister-register multiply:	1000 ns (2	20 MHz o	operation)		
			jister-register divide: 1	-				
	• In:	-	table for high-speed o	-	- 1	,		
		Sixty-five basi						
		•	nsfer/arithmetic and lo	aic instruct	ions			
			ed multiply and divide	•				
			anipulation instruction					
		vo CPU operatir	-	-				
		•	0	ice				
		 Normal mode: 64-kbyte address space Advanced mode: 16-Mbyte address space 						
Operating modes		Three MCU operating modes						
					Extern	al Data Bus		
		CPU Operatii	ng	On-Chip	Initial	Maximum		
	Mode	Mode	Description	ROM	Value	Value		
	1	Normal	Expanded mode with on-chip ROM disabled	Disabled	8 bits	8 bits		
	2	Advanced	Expanded mode with on-chip ROM enabled	Enabled	8 bits	8 bits		
			Single-chip mode		None			
	3	Normal	Expanded mode with on-chip ROM enabled	Enabled	8 bits	8 bits		
			Single-chip mode		None			
Bus controller	ex • Nu	pansion areas	access space can be m wait states can be s	C C				

Item	Specifications
Data transfer controller (DTC) (H8S/2138 Series)	 Can be activated by internal interrupt or software Multiple transfers or multiple types of transfer possible for one activation source Transfer possible in repeat mode, block transfer mode, etc. Request can be sent to CPU for interrupt that activated DTC
16-bit free-running timer module (FRT: 1 channel)	 One 16-bit free-running counter (also usable for external event counting) Two output compare outputs Four input capture inputs (with buffer operation capability)
8-bit timer module (2 channels: TMR0, TMR1)	 Each channel has: One 8-bit up-counter (also usable for external event counting) Two timer constant registers The two channels can be connected
Timer connection and 8-bit timer (TMR) module (2 channels: TMRX, TMRY) (Timer connection and TMRX provided in H8S/2138 Series)	 Input/output and FRT, TMR1, TMRX, TMRY can be interconnected Measurement of input signal or frequency-divided waveform pulse width and cycle (FRT, TMR1) Output of waveform obtained by modification of input signal edge (FRT, TMR1) Determination of input signal duty cycle (TMRX) Output of waveform synchronized with input signal (FRT, TMRX, TMRY) Automatic generation of cyclical waveform (FRT, TMRY)
Watchdog timer module (WDT: 2 channels)	Watchdog timer or interval timer function selectableSubclock operation capability (channel 1 only)
8-bit PWM timer (PWM) (H8S/2138 Series)	 Up to 16 outputs Pulse duty cycle settable from 0 to 100% Resolution: 1/256 1.25 MHz maximum carrier frequency (20 MHz operation)
14-bit PWM timer (PWMX)	 Up to 2 outputs Resolution: 1/16384 312.5 kHz maximum carrier frequency (20 MHz operation)
Serial communication interface (SCI: 2 channels, SCI0 and SCI1)	 Asynchronous mode or synchronous mode selectable Multiprocessor communication function

Table 1.1Overview (cont)

Item	Specifications				
SCI with IrDA:	Asynchronous mode or synchronous mode selectable				
1 channel (SCI2)	Multiprocessor	communication fu	nction		
	Compatible with	h IrDA specificatio	n version 1.0		
	TxD and RxD e	encoding/decoding	in IrDA format		
Host interface (HIF)	8-bit high-imper	dance (ISA) port			
(H8S/2138 Series)	Three host inte	rrupt requests (HI	RQ11, HIRQ1, HIRQ12)		
	 Normal and fas 	t A20 gate output			
	 Two register se registers) 	ets (each comprisin	ng two data registers and two status		
Keyboard controller	Matrix keyboard and sense port		yboard scan with wakeup interrupt		
A/D converter	Resolution: 10				
	Input:				
	— 8 channels	(dedicated analog	pins)		
	— 8 channels (same pins as keyboard sense port)				
	 High-speed conversion: 6.7 µs minimum conversion time (20 MHz operation) 				
	Single or scan mode selectable				
	Sample-and-hold function				
	A/D conversion	can be activated	by external trigger or timer trigger		
D/A converter	Resolution: 8 bi	its			
	Output: 2 chani	nels			
I/O ports	 58 input/output 	pins (including 24	with LED drive capability)		
•	 8 input-only pins 				
Memory	Flash memory or mask ROM				
	High-speed static RAM				
	Product Name	ROM	RAM		
	H8S/2134, H8S/2138	128 kbytes	4 kbytes		
	H8S/2133	96 kbytes	4 kbytes		
	H8S/2132, H8S/2137	64 kbytes	2 kbytes		
	H8S/2130	32 kbytes	2 kbytes		

Table 1.1	Overview	(cont)
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Item	Specificati	ions				
Interrupt controller	 Nine external interrupt pins (NMI, IRQ0 to IRQ7) 					
	• 39 inter	nal interrupt sour	ces			
	Three p	priority levels sette	ble			
Power-down state	Medium	n-speed mode				
	 Sleep n 					
		stop mode				
		e standby mode				
		re standby mode				
		k operation	•.			
Clock pulse generator		duty correction ci				
Packages		plastic QFP (FP-8	,			
		plastic TQFP (TFF	,			
I ² C bus interface		ns to Philips I ² C b		ndard		
(IIC: 2 channels) (option in H8S/2138	Single master mode/slave mode					
Series)	Arbitration lost condition can be identified					
Draduat linaun	Supports two slave addresses					
Product lineup (preliminary)		Product Cod				
(prominiary)	Series	Mask ROM Versions	F-ZTAT™ Versions	ROM/RAM (Bytes)	Packages	
	H8S/2138	HD6432138	HD64F2138*2	128 k/4 k	FP-80A,	
		HD6432138W*1	_		TFP-80C	
		HD6432137		64 k/2 k		
	_	HD6432137W*1	—			
	H8S/2134	HD6432134	HD64F2134	128 k/4 k		
		HD6432133		96 k/4 k		
		HD6432132	HD64F2132R	64 k/2 k		
		HD6432130	_	32 k/2 k		
		"W" indicates the	I ² C bus option.			
	*2	FP-80A only				

1.2 Internal Block Diagram

An internal block diagram of the H8S/2138 Series is shown in figure 1.1, and an internal block diagram of the H8S/2134 Series in figure 1.2.

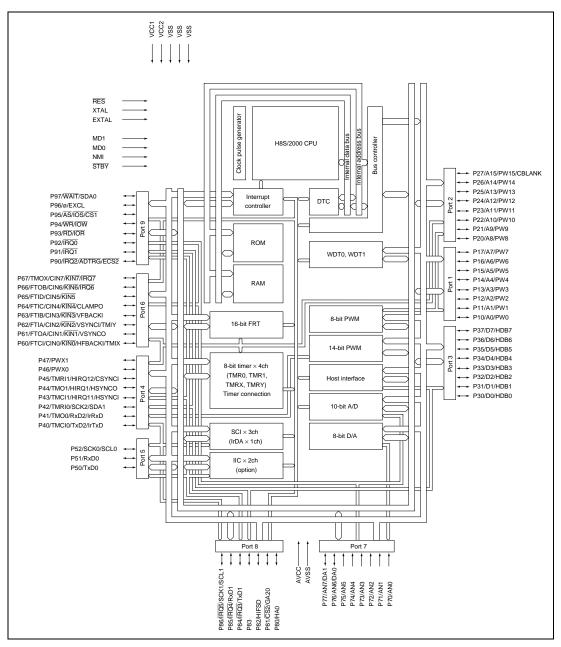


Figure 1.1 Internal Block Diagram of H8S/2138 Series

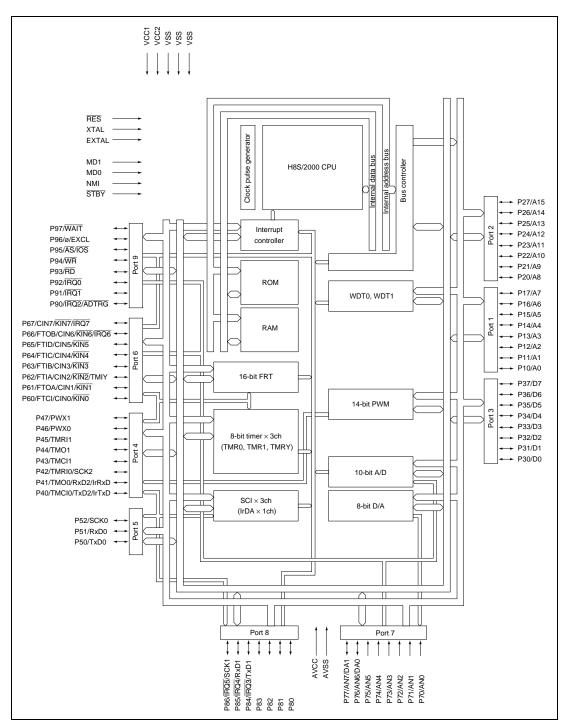


Figure 1.2 Internal Block Diagram of H8S/2134 Series

1.3 Pin Arrangement and Functions

1.3.1 Pin Arrangement

The pin arrangement of the H8S/2138 Series is shown in figure 1.3, and the pin arrangement of the H8S/2134 Series in figure 1.4.

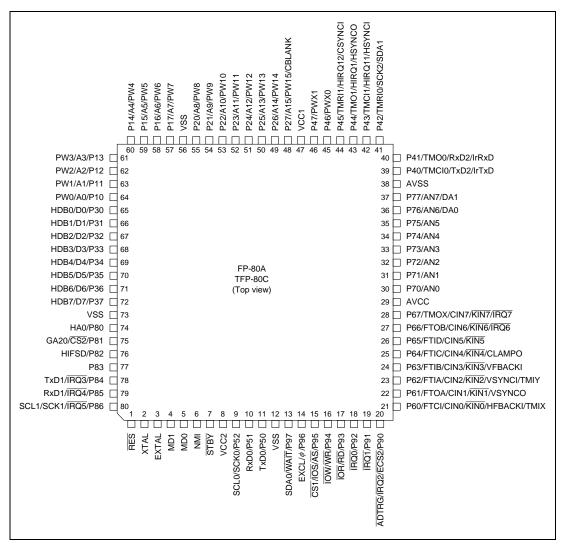


Figure 1.3 Pin Arrangement of H8S/2138 Series (FP-80A, TFP-80C: Top View)

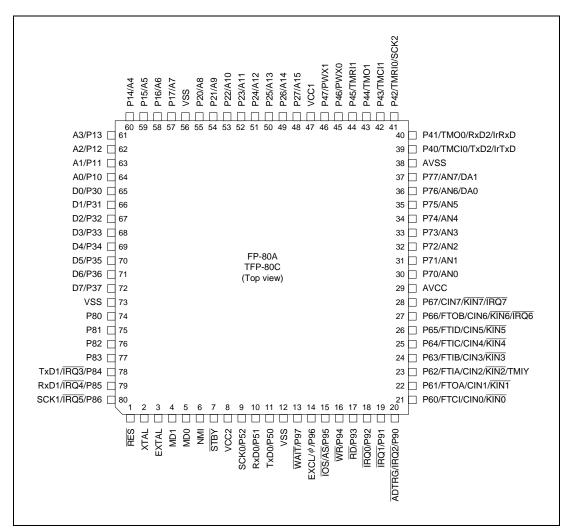


Figure 1.4 Pin Arrangement of H8S/2134 Series (FP-80A, TFP-80C: Top View)

1.3.2 Pin Functions in Each Operating Mode

Tables 1.2 and 1.3 show the pin functions of the H8S/2138 Series and H8S/2134 Series in each of the operating modes.

	Pin Name				
Pin No.	Expand	led Modes	Single-Chip Modes		
FP-80A TFP-80C	Mode 1	Mode 2 (EXPE = 1) Mode 3 (EXPE = 1)	Mode 2 (EXPE = 0) Mode 3 (EXPE = 0)	Flash Memory Writer Mode	
1	RES	RES	RES	RES	
2	XTAL	XTAL	XTAL	XTAL	
3	EXTAL	EXTAL	EXTAL	EXTAL	
4	MD1	MD1	MD1	VSS	
5	MD0	MD0	MD0	VSS	
6	NMI	NMI	NMI	FA9	
7	STBY	STBY	STBY	VCC	
8	VCC2	VCC2	VCC2	VCC	
9	P52/SCK0/SCL0	P52/SCK0/SCL0	P52/SCK0/SCL0	NC	
10	P51/RxD0	P51/RxD0	P51/RxD0	FA17	
11	P50/TxD0	P50/TxD0	P50/TxD0	NC	
12	VSS	VSS	VSS	VSS	
13	P97/WAIT/SDA0	P97/WAIT/SDA0	P97/SDA0	VCC	
14	ø/P96/EXCL	ø/P96/EXCL	P96/ø/EXCL	NC	
15	AS/IOS	AS/IOS	P95/CS1	FA16	
16	WR	WR	P94/IOW	FA15	
17	RD	RD	P93/IOR	WE	
18	P92/IRQ0	P92/IRQ0	P92/IRQ0	VSS	
19	P91/IRQ1	P91/IRQ1	P91/IRQ1	VCC	
20	P90/IRQ2/ ADTRG	P90/IRQ2/ADTRG	P90/IRQ2/ADTRG/ ECS2	VCC	
21	P60/FTCI/CIN0/ KIN0/TMIX/ HFBACKI	P60/FTCI/CIN0/ KIN0/TMIX/ HFBACKI	P60/FTCI/CIN0/ KIN0/TMIX/ HFBACKI	NC	
22	P61/FTOA/CIN1/ KIN1/VSYNCO	P61/FTOA/CIN1/ KIN1/VSYNCO	P61/FTOA/CIN1/ KIN1/VSYNCO	NC	
23	P62/FTIA/CIN2/ KIN2/TMIY/ VSYNCI	P62/FTIA/CIN2/ KIN2/TMIY/ VSYNCI	P62/FTIA/CIN2/ KIN2/TMIY/ VSYNCI	NC	

Table 1.2	H8S/2138 Series Pin Functions in Each Operating Mode
	Pin Name

	Pin Name				
Pin No. FP-80A TFP-80C	Expanded Modes		Single-Chip Modes		
	Mode 1	Mode 2 (EXPE = 1) Mode 3 (EXPE = 1)	Mode 2 (EXPE = 0) Mode 3 (EXPE = 0)	Flash Memory Writer Mode	
24	P63/FTIB/CIN3/ KIN3/VFBACKI	P63/FTIB/CIN3/ KIN3/VFBACKI	P63/FTIB/CIN3/ KIN3/VFBACKI	NC	
25	P64/FTIC/CIN4/ KIN4/CLAMPO	P64/FTIC/CIN4/ KIN4/CLAMPO	P64/FTIC/CIN4/ KIN4/CLAMPO	NC	
26	P65/FTID/CIN5/ KIN5	P65/FTID/CIN5/ KIN5	P65/FTID/CIN5/ KIN5	NC	
27	P66/FTOB/CIN6/ KIN6/IRQ6	P66/FTOB/CIN6/ KIN6/IRQ6	P66/FTOB/CIN6/ KIN6/IRQ6	NC	
28	P67/TMOX/CIN/ KIN7/IRQ7	P67/TMOX/CIN7/ KIN7/IRQ7	P67/TMOX/CIN7/ KIN7/IRQ7	VSS	
29	AVCC	AVCC	AVCC	VCC	
30	P70/AN0	P70/AN0	P70/AN0	NC	
31	P71/AN1	P71/AN1	P71/AN1	NC	
32	P72/AN2	P72/AN2	P72/AN2	NC	
33	P73/AN3	P73/AN3	P73/AN3	NC	
34	P74/AN4	P74/AN4	P74/AN4	NC	
35	P75/AN5	P75/AN5	P75/AN5	NC	
36	P76/AN6/DA0	P76/AN6/DA0	P76/AN6/DA0	NC	
37	P77/AN7/DA1	P77/AN7/DA1	P77/AN7/DA1	NC	
38	AVSS	AVSS	AVSS	VSS	
39	P40/TMCI0/ TxD2/IrTxD	P40/TMCI0/ TxD2/IrTxD	P40/TMCI0/ TxD2/IrTxD	NC	
40	P41/TMO0/ RxD2/IrRxD	P41/TMO0/ RxD2/IrRxD	P41/TMO0/ RxD2/IrRxD	NC	
41	P42/TMRI0/ SCK2/SDA1	P42/TMRI0/ SCK2/SDA1	P42/TMRI0/ SCK2/SDA1	NC	
42	P43/TMCI1/ HSYNCI	P43/TMCI1/ HSYNCI	P43/TMCI1/HIRQ11/ HSYNCI	NC	
43	P44/TMO1/ HSYNCO	P44/TMO1/ HSYNCO	P44/TMO1/HIRQ1/ HSYNCO	NC	
44	P45/TMRI1/ CSYNCI	P45/TMRI1/ CSYNCI	P45/TMRI1/HIRQ12/ CSYNCI	NC	
45	P46/PWX0	P46/PWX0	P46/PWX0	NC	
46	P47/PWX1	P47/PWX1	P47/PWX1	NC	
47	VCC1	VCC1	VCC1	VCC	

Table 1.2 H8S/2138 Series Pin Functions in Each Operating Mode (cont)

	Pin Name				
Pin No. FP-80A TFP-80C	Expanded Modes		Single-Chip Modes		
	Mode 1	Mode 2 (EXPE = 1) Mode 3 (EXPE = 1)	Mode 2 (EXPE = 0) Mode 3 (EXPE = 0)	Flash Memory Writer Mode	
48	A15	A15/P27/PW15/ CBLANK	P27/PW15/CBLANK	CE	
49	A14	A14/P26/PW14	P26/PW14	FA14	
50	A13	A13/P25/PW13	P25/PW13	FA13	
51	A12	A12/P24/PW12	P24/PW12	FA12	
52	A11	A11/P23/PW11	P23/PW11	FA11	
53	A10	A10/P22/PW10	P22/PW10	FA10	
54	A9	A9/P21/PW9	P21/PW9	ŌĒ	
55	A8	A8/P20/PW8	P20/PW8	FA8	
56	VSS	VSS	VSS	VSS	
57	A7	A7/P17/PW7	P17/PW7	FA7	
58	A6	A6/P16/PW6	P16/PW6	FA6	
59	A5	A5/P15/PW5	P15/PW5	FA5	
60	A4	A4/P14/PW4	P14/PW4	FA4	
61	A3	A3/P13/PW3	P13/PW3	FA3	
62	A2	A2/P12/PW2	P12/PW2	FA2	
63	A1	A1/P11/PW1	P11/PW1	FA1	
64	A0	A0/P10/PW0	P10/PW0	FA0	
65	D0	D0	P30/HDB0	FO0	
66	D1	D1	P31/HDB1	FO1	
67	D2	D2	P32/HDB2	FO2	
68	D3	D3	P33/HDB3	FO3	
69	D4	D4	P34/HDB4	FO4	
70	D5	D5	P35/HDB5	FO5	
71	D6	D6	P36/HDB6	FO6	
72	D7	D7	P37/HDB7	FO7	
73	VSS	VSS	VSS	VSS	
74	P80	P80	P80/HA0	NC	
75	P81	P81	P81/CS2/GA20	NC	
76	P82	P82	P82/HIFSD	NC	
77	P83	P83	P83	NC	

 Table 1.2
 H8S/2138 Series Pin Functions in Each Operating Mode (cont)

Pin No. FP-80A TFP-80C	Pin Name			
	Expanded Modes		Single-Chip Modes	
	Mode 1	Mode 2 (EXPE = 1) Mode 3 (EXPE = 1)	Mode 2 (EXPE = 0) Mode 3 (EXPE = 0)	Flash Memory Writer Mode
78	P84/IRQ3/TxD1	P84/IRQ3/TxD1	P84/IRQ3/TxD1	NC
79	P85/IRQ4/RxD1	P85/IRQ4/RxD1	P85/IRQ4/RxD1	NC
80	P86/IRQ5/SCK1/ SCL1	P86/IRQ5/SCK1/ SCL1	P86/IRQ5/SCK1/ SCL1	NC

 Table 1.2
 H8S/2138 Series Pin Functions in Each Operating Mode (cont)

Pin No. FP-80A TFP-80C	Pin Name				
	Expanded Modes		Single-Chip Modes		
	Mode 1	Mode 2 (EXPE = 1) Mode 3 (EXPE = 1)	Mode 2 (EXPE = 0) Mode 3 (EXPE = 0)	Flash Memory Writer Mode	
1	RES	RES	RES	RES	
2	XTAL	XTAL	XTAL	XTAL	
3	EXTAL	EXTAL	EXTAL	EXTAL	
4	MD1	MD1	MD1	VSS	
5	MD0	MD0	MD0	VSS	
6	NMI	NMI	NMI	FA9	
7	STBY	STBY	STBY	VCC	
8	VCC2	VCC2	VCC2	VCC	
9	P52/SCK0	P52/SCK0	P52/SCK0	NC	
10	P51/RxD0	P51/RxD0	P51/RxD0	FA17	
11	P50/TxD0	P50/TxD0	P50/TxD0	NC	
12	VSS	VSS	VSS	VSS	
13	P97/WAIT	P97/WAIT	P97	VCC	
14	ø/P96/EXCL	ø/P96/EXCL	ø/P96/EXCL	NC	
15	AS/IOS	AS/IOS	P95	FA16	
16	WR	WR	P94	FA15	
17	RD	RD	P93	WE	
18	P92/IRQ0	P92/IRQ0	P92/IRQ0	VSS	
19	P91/IRQ1	P91/IRQ1	P91/IRQ1	VCC	
20	P90/IRQ2/ ADTRG	P90/IRQ2/ADTRG	P90/IRQ2/ADTRG	VCC	
21	P60/FTCI/CIN0/ KIN0	P60/FTCI/CIN0/ KIN0	P60/FTCI/CIN0/ KIN0	NC	
22	P61/FTOA/ CIN1/KIN1	P61/FTOA/CIN1/ KIN1	P61/FTOA/CIN1/ KIN1	NC	
23	P62/FTIA/CIN2/ KIN2/TMIY	P62/FTIA/CIN2/ KIN2/TMIY	P62/FTIA/CIN2/ KIN2/TMIY	NC	
24	P63/FTIB/CIN3/ KIN3	P63/FTIB/CIN3/ KIN3	P63/FTIB/CIN3/ KIN3	NC	
25	P64/FTIC/CIN4/ KIN4	P64/FTIC/CIN4/ KIN4	P64/FTIC/CIN4/ KIN4	NC	
26	P65/FTID/CIN5/ KIN5	P65/FTID/CIN5/ KIN5	P65/FTID/CIN5/ KIN5	NC	

 Table 1.3
 H8S/2134 Series Pin Functions in Each Operating Mode

	Pin Name				
Pin No. FP-80A TFP-80C	Expanded Modes		Single-Chip Modes		
	Mode 1	Mode 2 (EXPE = 1) Mode 3 (EXPE = 1)	Mode 2 (EXPE = 0) Mode 3 (EXPE = 0)	Flash Memory Writer Mode	
27	P66/FTOB/CIN6/ KIN6/IRQ6	P66/FTOB/CIN6/ KIN6/IRQ6	P66/FTOB/CIN6/ KIN6/IRQ6	NC	
28	P67/CIN7/KIN7/ IRQ7	P67/CIN7/KIN7/ IRQ7	P67/CIN7/KIN7/ IRQ7	VSS	
29	AVCC	AVCC	AVCC	VCC	
30	P70/AN0	P70/AN0	P70/AN0	NC	
31	P71/AN1	P71/AN1	P71/AN1	NC	
32	P72/AN2	P72/AN2	P72/AN2	NC	
33	P73/AN3	P73/AN3	P73/AN3	NC	
34	P74/AN4	P74/AN4	P74/AN4	NC	
35	P75/AN5	P75/AN5	P75/AN5	NC	
36	P76/AN6/DA0	P76/AN6/DA0	P76/AN6/DA0	NC	
37	P77/AN7/DA1	P77/AN7/DA1	P77/AN7/DA1	NC	
38	AVSS	AVSS	AVSS	VSS	
39	P40/TMCI0/ TxD2/IrTxD	P40/TMCI0/ TxD2/IrTxD	P40/TMCI0/ TxD2/IrTxD	NC	
40	P41/TMO0/ RxD2/IrRxD	P41/TMO0/ RxD2/IrRxD	P41/TMO0/ RxD2/IrRxD	NC	
41	P42/TMRI0/ SCK2	P42/TMRI0/ SCK2	P42/TMRI0/ SCK2	NC	
42	P43/TMCI1	P43/TMCI1	P43/TMCI1	NC	
43	P44/TMO1	P44/TMO1	P44/TMO1	NC	
44	P45/TMRI1	P45/TMRI1	P45/TMRI1	NC	
45	P46/PWX0	P46/PWX0	P46/PWX0	NC	
46	P47/PWX1	P47/PWX1	P47/PWX1	NC	
47	VCC1	VCC1	VCC1	VCC	
48	A15	A15/P27	P27	CE	
49	A14	A14/P26	P26	FA14	
50	A13	A13/P25	P25	FA13	
51	A12	A12/P24	P24	FA12	
52	A11	A11/P23	P23	FA11	
53	A10	A10/P22	P22	FA10	

Table 1.3 H8S/2134 Series Pin Functions in Each Operating Mode (cont)

	Pin Name				
Pin No. FP-80A TFP-80C	Expanded Modes		Single-Chip Modes		
	Mode 1	Mode 2 (EXPE = 1) Mode 3 (EXPE = 1)	Mode 2 (EXPE = 0) Mode 3 (EXPE = 0)	Flash Memory Writer Mode	
54	A9	A9/P21	P21	ŌĒ	
55	A8	A8/P20	P20	FA8	
56	VSS	VSS	VSS	VSS	
57	A7	A7/P17	P17	FA7	
58	A6	A6/P16	P16	FA6	
59	A5	A5/P15	P15	FA5	
60	A4	A4/P14	P14	FA4	
61	A3	A3/P13	P13	FA3	
62	A2	A2/P12	P12	FA2	
63	A1	A1/P11	P11	FA1	
64	A0	A0/P10	P10	FA0	
65	D0	D0	P30	FO0	
66	D1	D1	P31	FO1	
67	D2	D2	P32	FO2	
68	D3	D3	P33	FO3	
69	D4	D4	P34	FO4	
70	D5	D5	P35	FO5	
71	D6	D6	P36	FO6	
72	D7	D7	P37	FO7	
73	VSS	VSS	VSS	VSS	
74	P80	P80	P80	NC	
75	P81	P81	P81	NC	
76	P82	P82	P82	NC	
77	P83	P83	P83	NC	
78	P84/IRQ3/TxD1	P84/IRQ3/TxD1	P84/IRQ3/TxD1	NC	
79	P85/IRQ4/RxD1	P85/IRQ4/RxD1	P85/IRQ4/RxD1	NC	
80	P86/IRQ5/SCK1	P86/IRQ5/SCK1	P86/IRQ5/SCK1	NC	

 Table 1.3
 H8S/2134 Series Pin Functions in Each Operating Mode (cont)

1.3.3 Pin Functions

Table 1.4 summarizes the functions of the H8S/2138 Series and H8S/2134 Series pins.

Table 1.4Pin Functions

		Pin No.						
Туре	Symbol	FP-80A TFP-80C		Name and Function				
Power supply	VCC1, VCC2	8, 47	Input	Power supply: For connection to the power supply. All VCC1 and VCC2 pins should be connected to the system power supply.				
	VSS	, , , , , , , , , , , , , , , , , , , ,		Ground: For connection to the power supply (0 V). All VSS pins should be connected to the system power supply (0 V).				
Clock	XTAL	2	Input	Connected to a crystal oscillator. See section 22, Clock Pulse Generator, for typical connection diagrams for a crystal oscillator and external clock input.				
	EXTAL	Connected to a crystal oscillator. The EXTAL pin can also input an external clock. See section 22, Clock Pulse Generator, for typical connection diagrams for a crystal oscillator and external clock input.						
	Ø	14	Output	System clock: Supplies the system clock to external devices.				
	EXCL	14	Input	External subclock input: Input a 32.768 kHz external subclock.				

Table 1.4	Pin Functions ((cont)
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Туре	Symbol	Pin No. FP-80A TFP-80C	 I/O	Name and Function						
Operating mode control	MD1 MD0	4 5	Input	The r MD0 These	elation and the	bins: These pins set the operating mode. ation between the settings of pins MD1 and and the operating mode is shown below. pins should not be changed while the MCU ating				
				MD1	MD0	Operating Mode	Description			
				0	1	Mode 1	Normal Expanded mode with on-chip ROM disabled			
				1	0	Mode 2	Advanced Expanded mode with on-chip ROM enabled or single-chip mode			
				1	1	Mode 3	Normal Expanded mode with on-chip ROM enabled or single-chip mode			
System control	RES	1	Input	Reset input: When this pin is driven low, the chip is reset.						
	STBY	7	Input		-	hen this pin i ardware stan	s driven low, a transition dby mode.			
Address bus	A15 to A0	48 to 55, 57 to 64	Output	Addr	ess bu	s: These pin	s output an address.			
Data bus	D7 to D0	72 to 65	Input/ output		bus (u for 8-b		ctional data bus.			
Bus control	WAIT	13	Input		when a		of a wait state in the bus ternal 3-state address			
	RD	17	Output			this pin is lo ress space is	w, it indicates that the being read.			
	WR	16	Output				w, it indicates that the being written to.			
	AS/IOS	15	Output				his pin is low, it indicates e address bus is valid.			

Table 1.4 Pin Functions (cont)

		Pin No.						
Туре	Symbol	FP-80A TFP-80C	I/O	Name and Function				
Interrupt signals	NMI	6	Input	Nonmaskable interrupt: Requests a nonmaskable interrupt.				
	IRQ0 to IRQ7	18 to 20, 78 to 80, 27, 28	Input	Interrupt request 0 to 7: These pins request a maskable interrupt.				
16-bit free- running time	FTCI r	21	Input	FRT counter clock input: Input pin for an external clock signal for the free-running counter (FRC).				
(FRT)	FTOA	22	Output	FRT output compare A output: The output compare A output pin.				
	FTOB	27	Output	FRT output compare B output: The output compare B output pin.				
	FTIA	23	Input	FRT input capture A input: The input capture A input pin.				
	FTIB	24	Input	FRT input capture B input: The input capture B input pin.				
	FTIC	25	Input	FRT input capture C input: The input capture C input pin.				
	FTID	26	Input	FRT input capture D input: The input capture D input pin.				
8-bit timer (TMR0, TMR1,	TMO0 TMO1 TMOX	40 43 28	Output	Compare-match output: TMR0, TMR1, and TMRX compare-match output pins.				
TMRX, TMRY)	TMCI0 TMCI1	39 42	Input	Counter external clock input: Input pins for the external clock input to the TMR0 and TMR1 counters.				
	TMRI0 TMRI1	41 44	Input	Counter external reset input: TMR0 and TMR1 counter reset input pins.				
	TMIX TMIY	21 23	Input	Counter external clock input and reset input: Dual function as TMRX and TMRY counter clock input pin and reset input pin.				
PWM timer (PWM)	PW15 to PW0	48 to 55, 57 to 64	Output	PWM timer output: PWM timer pulse output pins.				
14-bit PWM timer (PWMX)	PWX0 PWX1	45 46	Output	PWMX timer output: PWM D/A pulse output pins.				

Table 1.4 Pin Functions (cont)

Туре	Symbol	Pin No. FP-80A TFP-80C	 I/O	Name and Function
Serial com- munication interface	TxD0 TxD1 TxD2	11 78 39	Output	Transmit data: Data output pins.
(SCI0, SCI1, SCI2)	RxD0 RxD1 RxD2	10 79 40	Input	Receive data: Data input pins.
	SCK0 SCK1 SCK2	9 80 41	Input/ output	Serial clock: Clock input/output pins. The SCK0 output type is NMOS push-pull. (H8S/2138 Series only)
SCI with IrDA (SCI2)	lrTxD IrRxD	39 40	Output Input	IrDA transmit data/receive data: Input and output pins for data encoded for IrDA use.
Host interface	HDB7 to HDB0	72 to 65	Input/ output	Host interface data bus: Bidirectional 8-bit bus for accessing the host interface.
(HIF)	<u>CS1,</u> <u>CS2,</u> ECS2	15, 75, 20	Input	Chip select 1 and 2: Input pins for selecting host interface channel 1 or 2.
	IOR	17	Input	I/O read: Input pin that enables reading from the host interface.
	IOW	16	Input	I/O write: Input pin that enables writing to the host interface.
	HA0	74	Input	Command/data: Input pin that indicates whether an access is a data access or command access.
	GA20	75	Output	GATE A20: A20 gate control signal output pin.
	HIRQ11 HIRQ1 HIRQ12	42 43 44	Output	Host interrupt 11, 1, and 12: Output pins for interrupt requests to the host.
	HIFSD	76	Input	Host interface shutdown: Control input pin used to place host interface input/output pins in the high-impedance/cutoff state.
Keyboard control	KINO to KIN7	21 to 24, 25 to 28	Input	Keyboard input: Matrix keyboard input pins. Normally, P10 to P17 and P20 to P27 are used as key-scan outputs. This enables a maximum 16-output \times 16-input, 256-key matrix to be configured.

Table 1.4 Pin Functions (cont)

		Pin No.						
Туре	Symbol	FP-80A TFP-80C	I/O	Name and Function				
A/D converter (ADC)	AN7 to AN0	37 to 30	Input	Analog input: A/D converter analog input pins.				
	CN0 to CN7	21 to 24, 25 to 28	Input	Expansion A/D inputs: Expansion A/D input pins can be connected to the A/D converter, but since they are also used as digital input/output pins, precision will fall.				
	ADTRG	20	Input	A/D conversion external trigger input: Pin for input of an external trigger to start A/D conversion.				
D/A converter (DAC)	DA0 DA1	36 37	Output	Analog output: D/A converter analog output pins.				
A/D converter	AVCC	29	Input	Analog reference voltage: The analog power supply pin for the A/D converter and D/A converter.				
D/A converter				When the A/D and D/A converters are not used, this pin should be connected to the system power supply ($+5 \text{ V or } +3 \text{ V}$).				
	AVSS	38	Input	Analog ground: The ground pin for the A/D converter and D/A converter. This pin should be connected to the system power supply (0 V).				
Timer connection	VSYNCI, HSYNCI, CSYNCI, VFBACKI, HFBACKI	42 44 24	Input	Timer connection input: Timer connection synchronous signal input pins.				
	VSYNCO, HSYNCO, CLAMPO, CBLANK	43 25	Output	Timer connection output: Timer connection synchronous signal output pins.				
I ² C bus interface (IIC) (option)	SCL0 SCL1	9 80	Input/ output	I ² C clock input/output (channels 0 and 1): I ² C clock I/O pins. These pins have a bus drive function. The SCL0 output form is NMOS open-drain				
	SDA0 SDA1	13 41	Input/ output	I²C data input/output (channels 0 and 1): I ² C data I/O pins. These pins have a bus drive function. The SDA0 output form is NMOS open-drain.				

Table 1.4	Pin Functions (cont)	
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		Pin No.							
Туре	Symbol	FP-80A TFP-80C	I/O	Name and Function					
I/O ports	P17 to P10	57 to 64	Input/ output	Port 1: Eight input/output pins. The data direction of each pin can be selected in the port 1 data direction register (P1DDR). These pins have built-in MOS input pull-ups, and also have LED drive capability.					
	P27 to P20	48 to 55	Input/ output	Port 2: Eight input/output pins. The data direction of each pin can be selected in the port 2 data direction register (P2DDR). These pins have built-in MOS input pull-ups, and also have LED drive capability.					
	P37 to P30	Port 3: Eight input/output pins. The data direction of each pin can be selected in the port 3 data direction register (P3DDR). These pins have built-in MOS input pull-ups, and also have LED drive capability.							
	P47 to P40	46 to 39	Input/ output	Port 4: Eight input/output pins. The data direction of each pin can be selected in the port 4 data direction register (P4DDR).					
	P52 to P50	9 to 11	Input/ output	Port 5: Three input/output pins. The data direction of each pin can be selected in the port 5 data direction register (P5DDR). P52 is an NMOS pushpull output. (H8S/2138 Series only)					
	P67 to P60	28 to 21	Input/ output	Port 6: Eight input/output pins. The data direction of each pin can be selected in the port 6 data direction register (P6DDR). These pins have built-in MOS input pull-ups.					
	P77 to P70	37 to 30	Input	Port 7: Eight input pins.					
	P86 to P80	80 to 74	Input/ output	Port 8: Seven input/output pins. The data direction of each pin can be selected in the port 8 data direction register (P8DDR).					
	P97 to P90	13 to 20	Input/ output	Port 9: Eight input/output pins. The data direction of each pin (except P96) can be selected in the port 9 data direction register (P9DDR). P97 is an NMOS push-pull output. (H8S/2138 Series only)					

Section 2 CPU

2.1 Overview

The H8S/2000 CPU is a high-speed central processing unit with an internal 32-bit architecture that is upward-compatible with the H8/300 and H8/300H CPUs. The H8S/2000 CPU has sixteen 16-bit general registers, can address a 16-Mbyte (architecturally 4-Gbyte) linear address space, and is ideal for realtime control.

2.1.1 Features

The H8S/2000 CPU has the following features.

- Upward-compatible with H8/300 and H8/300H CPUs
 - Can execute H8/300 and H8/300H object programs
- General-register architecture
 - Sixteen 16-bit general registers (also usable as sixteen 8-bit registers or eight 32-bit registers)
- Sixty-five basic instructions
 - 8/16/32-bit arithmetic and logic instructions
 - Multiply and divide instructions
 - Powerful bit-manipulation instructions
 - Eight addressing modes

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- Register direct [Rn]
- Register indirect [@ERn]
- Register indirect with displacement [@(d:16,ERn) or @(d:32,ERn)]
- Register indirect with post-increment or pre-decrement [@ERn+ or @-ERn]
- Absolute address [@aa:8, @aa:16, @aa:24, or @aa:32]
- Immediate [#xx:8, #xx:16, or #xx:32]
- Program-counter relative [@(d:8,PC) or @(d:16,PC)]
- Memory indirect [@@aa:8]
- 16-Mbyte address space
 - Program: 16 Mbytes
 - Data: 16 Mbytes (4 Gbytes architecturally)

- High-speed operation
 - All frequently-used instructions execute in one or two states
 - Maximum clock rate: 20 MHz
 - 8/16/32-bit register-register add/subtract: 50 ns
 - 8 × 8-bit register-register multiply: 600 ns
 - $16 \div 8$ -bit register-register divide: 600 ns
 - 16 \times 16-bit register-register multiply: 1000 ns
 - $32 \div 16$ -bit register-register divide: 1000 ns
- Two CPU operating modes
 - Normal mode
 - Advanced mode
- Power-down state
 - Transition to power-down state by SLEEP instruction
 - CPU clock speed selection

2.1.2 Differences between H8S/2600 CPU and H8S/2000 CPU

The differences between the H8S/2600 CPU and the H8S/2000 CPU are shown below.

Register configuration

The MAC register is supported only by the H8S/2600 CPU.

- Basic instructions The four instructions MAC, CLRMAC, LDMAC, and STMAC are supported only by the H8S/2600 CPU.
- Number of execution states

The number of execution states of the MULXU and MULXS instructions differ as follows.

		Number	r of Execution States
Instruction	Mnemonic	H8S/2600	H8S/2000
MULXU	MULXU.B Rs, Rd	3	12
	MULXU.W Rs, ERd	4	20
MULXS	MULXS.B Rs, Rd	4	13
	MULXS.W Rs, ERd	5	21

There are also differences in the address space, EXR register functions, power-down state, etc., depending on the product.

2.1.3 Differences from H8/300 CPU

In comparison to the H8/300 CPU, the H8S/2000 CPU has the following enhancements.

- More general registers and control registers
 - Eight 16-bit extended registers, and one 8-bit control register, have been added.
- Expanded address space
 - Normal mode supports the same 64-kbyte address space as the H8/300 CPU.
 - Advanced mode supports a maximum 16-Mbyte address space.
- Enhanced addressing
 - The addressing modes have been enhanced to make effective use of the 16-Mbyte address space.
- Enhanced instructions
 - Addressing modes of bit-manipulation instructions have been enhanced.
 - Signed multiply and divide instructions have been added.
 - Two-bit shift instructions have been added.
 - Instructions for saving and restoring multiple registers have been added.
 - A test and set instruction has been added.
- Higher speed
 - Basic instructions execute twice as fast.

2.1.4 Differences from H8/300H CPU

In comparison to the H8/300H CPU, the H8S/2000 CPU has the following enhancements.

- Additional control register
 - One 8-bit control register has been added.
- Enhanced instructions
 - Addressing modes of bit-manipulation instructions have been enhanced.
 - Two-bit shift instructions have been added.
 - Instructions for saving and restoring multiple registers have been added.
 - A test and set instruction has been added.
- Higher speed
 - Basic instructions execute twice as fast.

2.2 CPU Operating Modes

The H8S/2000 CPU has two operating modes: normal and advanced. Normal mode supports a maximum 64-kbyte address space. Advanced mode supports a maximum 16-Mbyte total address space (architecturally the maximum total address space is 4 Gbytes, with a maximum of 16 Mbytes for the program area and a maximum of 4 Gbytes for the data area). The mode is selected by the mode pins of the microcontroller.

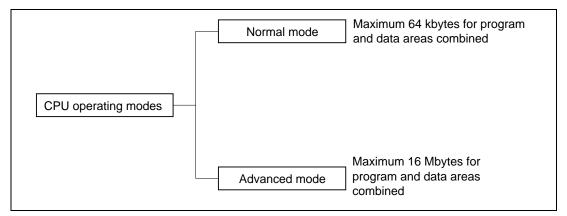


Figure 2.1 CPU Operating Modes

(1) Normal Mode

The exception vector table and stack have the same structure as in the H8/300 CPU.

Address Space: A maximum address space of 64 kbytes can be accessed.

Extended Registers (En): The extended registers (E0 to E7) can be used as 16-bit registers, or as the upper 16-bit segments of 32-bit registers. When En is used as a 16-bit register it can contain any value, even when the corresponding general register (Rn) is used as an address register. If the general register is referenced in the register indirect addressing mode with predecrement (@–Rn) or post-increment (@Rn+) and a carry or borrow occurs, however, the value in the corresponding extended register (En) will be affected.

Instruction Set: All instructions and addressing modes can be used. Only the lower 16 bits of effective addresses (EA) are valid.

Exception Vector Table and Memory Indirect Branch Addresses: In normal mode the top area starting at H'0000 is allocated to the exception vector table. One branch address is stored per 16 bits. The configuration of the exception vector table in normal mode is shown in figure 2.2. For details of the exception vector table, see section 4, Exception Handling.

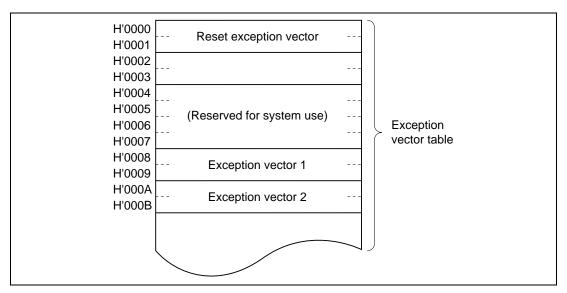


Figure 2.2 Exception Vector Table (Normal Mode)

The memory indirect addressing mode (@@aa:8) employed in the JMP and JSR instructions uses an 8-bit absolute address included in the instruction code to specify a memory operand that contains a branch address. In normal mode the operand is a 16-bit word operand, providing a 16-bit branch address. Branch addresses can be stored in the top area from H'0000 to H'00FF. Note that this area is also used for the exception vector table.

Stack Structure: When the program counter (PC) is pushed onto the stack in a subroutine call, and the PC and condition-code register (CCR) are pushed onto the stack in exception handling, they are stored as shown in figure 2.3. The extended control register (EXR) is not pushed onto the stack. For details, see section 4, Exception Handling.

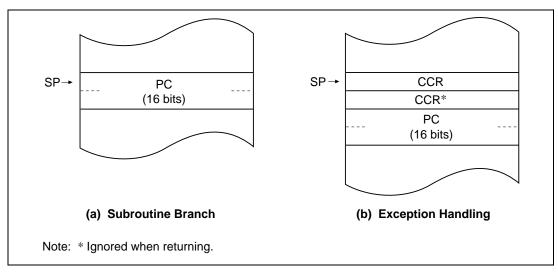


Figure 2.3 Stack Structure in Normal Mode

(2) Advanced Mode

Address Space: Linear access is provided to a 16-Mbyte maximum address space (architecturally a maximum 16-Mbyte program area and a maximum 4-Gbyte data area, with a maximum of 4 Gbytes for program and data areas combined).

Extended Registers (En): The extended registers (E0 to E7) can be used as 16-bit registers, or as the upper 16-bit segments of 32-bit registers or address registers.

Instruction Set: All instructions and addressing modes can be used.

Exception Vector Table and Memory Indirect Branch Addresses: In advanced mode the top area starting at H'00000000 is allocated to the exception vector table in units of 32 bits. In each 32 bits, the upper 8 bits are ignored and a branch address is stored in the lower 24 bits (figure 2.4). For details of the exception vector table, see section 4, Exception Handling.

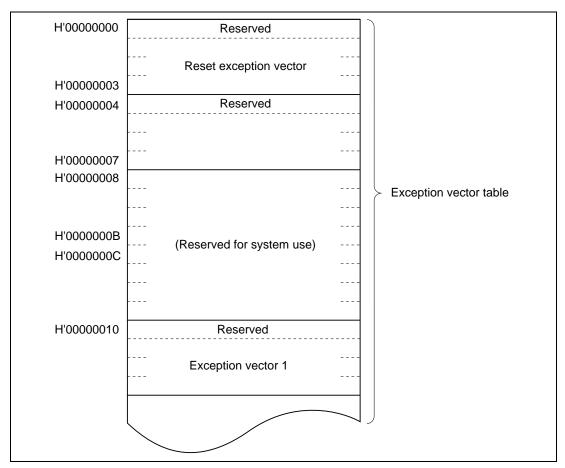


Figure 2.4 Exception Vector Table (Advanced Mode)

The memory indirect addressing mode (@@aa:8) employed in the JMP and JSR instructions uses an 8-bit absolute address included in the instruction code to specify a memory operand that contains a branch address. In advanced mode the operand is a 32-bit longword operand, providing a 32-bit branch address. The upper 8 bits of these 32 bits are a reserved area that is regarded as H'00. Branch addresses can be stored in the area from H'00000000 to H'000000FF. Note that the first part of this range is also the exception vector table.

Stack Structure: In advanced mode, when the program counter (PC) is pushed onto the stack in a subroutine call, and the PC and condition-code register (CCR) are pushed onto the stack in exception handling, they are stored as shown in figure 2.5. The extended control register (EXR) is not pushed onto the stack. For details, see section 4, Exception Handling.

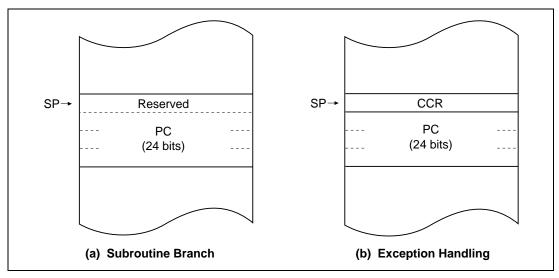


Figure 2.5 Stack Structure in Advanced Mode

2.3 Address Space

Figure 2.6 shows a memory map of the H8S/2000 CPU. The H8S/2000 CPU provides linear access to a maximum 64-kbyte address space in normal mode, and a maximum 16-Mbyte (architecturally 4-Gbyte) address space in advanced mode.

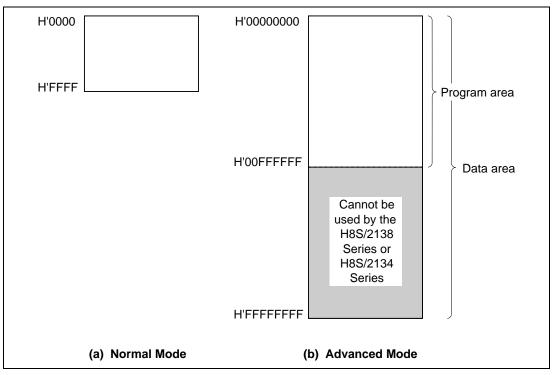


Figure 2.6 Memory Map

2.4 Register Configuration

2.4.1 Overview

The CPU has the internal registers shown in figure 2.7. There are two types of registers: general registers and control registers.

	15	07		07
ER0	E0		R0H	R0L
ER1	E1		R1H	R1L
ER2	E2		R2H	R2L
ER3	E3		R3H	R3L
ER4	E4		R4H	R4L
ER5	E5		R5H	R5L
ER6	E6		R6H	R6L
ER7 (SP)	E7		R7H	R7L
			I	
			I	$ \begin{array}{c} 7 & 6 & 5 & 4 & 3 & 2 & 1 & 0 \\ EXR* T I2 & I1 & I1 \\ \hline 7 & 6 & 5 & 4 & 3 & 2 & 1 & 0 \\ \hline CCR I & UIH & V & Z & V & 0 \end{array} $
Legend:			I	EXR* T 12 11 10 7 6 5 4 3 2 1 0

Figure 2.7 CPU Registers

2.4.2 General Registers

The CPU has eight 32-bit general registers. These general registers are all functionally alike and can be used as both address registers and data registers. When a general register is used as a data register, it can be accessed as a 32-bit, 16-bit, or 8-bit register. When the general registers are used as 32-bit registers or address registers, they are designated by the letters ER (ER0 to ER7).

The ER registers divide into 16-bit general registers designated by the letters E (E0 to E7) and R (R0 to R7). These registers are functionally equivalent, providing a maximum of sixteen 16-bit registers. The E registers (E0 to E7) are also referred to as extended registers.

The R registers divide into 8-bit general registers designated by the letters RH (R0H to R7H) and RL (R0L to R7L). These registers are functionally equivalent, providing a maximum of sixteen 8-bit registers.

Figure 2.8 illustrates the usage of the general registers. The usage of each register can be selected independently.

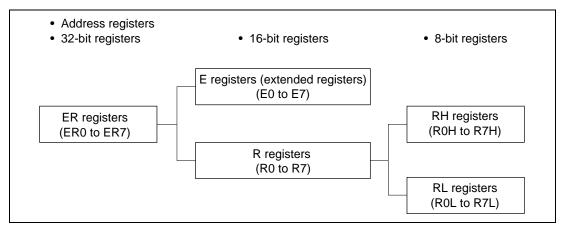


Figure 2.8 Usage of General Registers

General register ER7 has the function of stack pointer (SP) in addition to its general-register function, and is used implicitly in exception handling and subroutine calls. Figure 2.9 shows the stack.

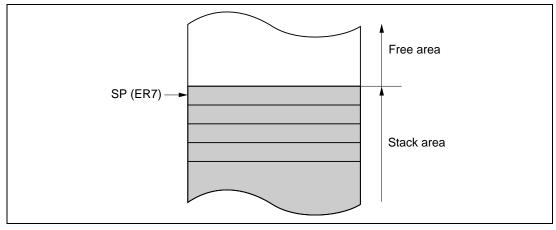


Figure 2.9 Stack

2.4.3 Control Registers

The control registers are the 24-bit program counter (PC), 8-bit extended control register (EXR), and 8-bit condition-code register (CCR).

(1) **Program Counter (PC):** This 24-bit counter indicates the address of the next instruction the CPU will execute. The length of all CPU instructions is 2 bytes (one word), so the least significant PC bit is ignored. (When an instruction is fetched, the least significant PC bit is regarded as 0.)

(2) Extended Control Register (EXR): An 8-bit register. In the H8S/2138 Series and H8S/2134 Series, this register does not affect operation.

Bit 7—Trace Bit (T): This bit is reserved. In the H8S/2138 Series and H8S/2134 Series, this bit does not affect operation.

Bits 6 to 3—Reserved: These bits are reserved. They are always read as 1.

Bits 2 to 0—Interrupt Mask Bits (I2 to I0): These bits are reserved. In the H8S/2138 Series and H8S/2134 Series, these bits do not affect operation.

(3) Condition-Code Register (CCR): This 8-bit register contains internal CPU status information, including an interrupt mask bit (I) and half-carry (H), negative (N), zero (Z), overflow (V), and carry (C) flags.

Bit 7—Interrupt Mask Bit (I): Masks interrupts other than NMI when set to 1. (NMI is accepted regardless of the I bit setting.) The I bit is set to 1 by hardware at the start of an exception-handling sequence. For details, refer to section 5, Interrupt Controller.

Bit 6—User Bit or Interrupt Mask Bit (UI): Can be written and read by software using the LDC, STC, ANDC, ORC, and XORC instructions. This bit can also be used as an interrupt mask bit. For details, refer to section 5, Interrupt Controller.

Bit 5—Half-Carry Flag (H): When the ADD.B, ADDX.B, SUB.B, SUBX.B, CMP.B, or NEG.B instruction is executed, this flag is set to 1 if there is a carry or borrow at bit 3, and cleared to 0 otherwise. When the ADD.W, SUB.W, CMP.W, or NEG.W instruction is executed, the H flag is set to 1 if there is a carry or borrow at bit 11, and cleared to 0 otherwise. When the ADD.L, SUB.L, CMP.L, or NEG.L instruction is executed, the H flag is set to 1 if there is a carry or borrow at bit 27, and cleared to 0 otherwise.

Bit 4—User Bit (U): Can be written and read by software using the LDC, STC, ANDC, ORC, and XORC instructions.

Bit 3—Negative Flag (N): Stores the value of the most significant bit (sign bit) of data.

Bit 2—Zero Flag (Z): Set to 1 to indicate zero data, and cleared to 0 to indicate non-zero data.

Bit 1—Overflow Flag (V): Set to 1 when an arithmetic overflow occurs, and cleared to 0 otherwise.

Bit 0—Carry Flag (C): Set to 1 when a carry occurs, and cleared to 0 otherwise. Used by:

- Add instructions, to indicate a carry
- Subtract instructions, to indicate a borrow
- Shift and rotate instructions, to store the carry

The carry flag is also used as a bit accumulator by bit-manipulation instructions.

Some instructions leave some or all of the flag bits unchanged. For the action of each instruction on the flag bits, refer to Appendix A.1, List of Instructions.

Operations can be performed on the CCR bits by the LDC, STC, ANDC, ORC, and XORC instructions. The N, Z, V, and C flags are used as branching conditions for conditional branch (Bcc) instructions.

2.4.4 Initial Register Values

Reset exception handling loads the CPU's program counter (PC) from the vector table, clears the trace bit in EXR to 0, and sets the interrupt mask bits in CCR and EXR to 1. The other CCR bits and the general registers are not initialized. In particular, the stack pointer (ER7) is not initialized. The stack pointer should therefore be initialized by an MOV.L instruction executed immediately after a reset.

2.5 Data Formats

The CPU can process 1-bit, 4-bit (BCD), 8-bit (byte), 16-bit (word), and 32-bit (longword) data. Bit-manipulation instructions operate on 1-bit data by accessing bit n (n = 0, 1, 2, ..., 7) of byte operand data. The DAA and DAS decimal-adjust instructions treat byte data as two digits of 4-bit BCD data.

2.5.1 General Register Data Formats

Figure 2.10 shows the data formats in general registers.

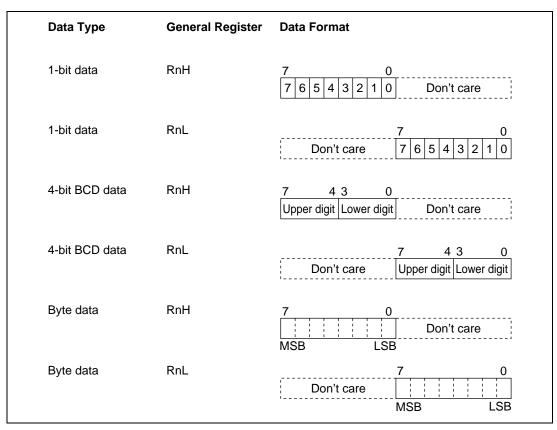


Figure 2.10 General Register Data Formats

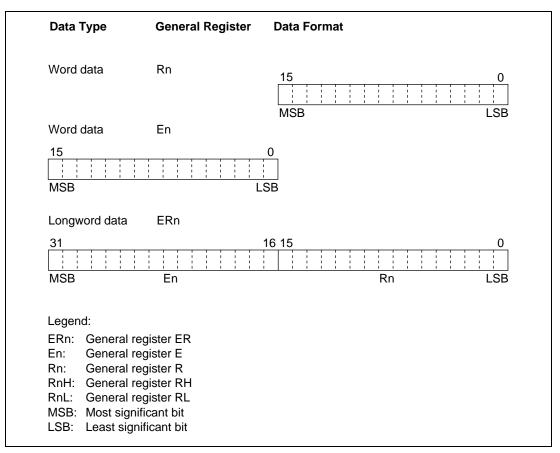


Figure 2.10 General Register Data Formats (cont)

2.5.2 Memory Data Formats

Figure 2.11 shows the data formats in memory. The CPU can access word data and longword data in memory, but word or longword data must begin at an even address. If an attempt is made to access word or longword data at an odd address, no address error occurs but the least significant bit of the address is regarded as 0, so the access starts at the preceding address. This also applies to instruction fetches.

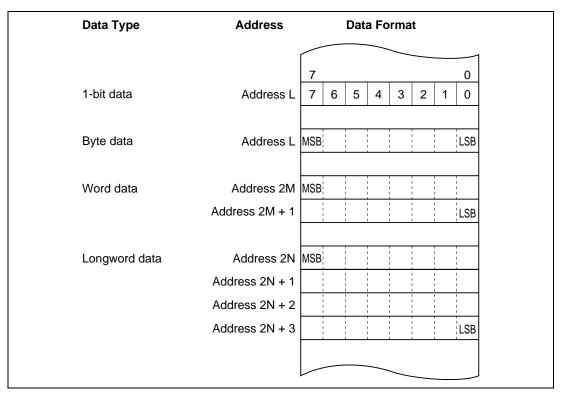


Figure 2.11 Memory Data Formats

When ER7 (SP) is used as an address register to access the stack, the operand size should be word size or longword size.

2.6 Instruction Set

2.6.1 Overview

The H8S/2000 CPU has 65 types of instructions. The instructions are classified by function in table 2.1.

Table 2.1 Instruction Classification

Function	Instructions	Size	Types
Data transfer	MOV	BWL	5
	POP* ¹ , PUSH* ¹	WL	_
	LDM, STM	L	_
	MOVFPE* ³ , MOVTPE* ³	В	_
Arithmetic	ADD, SUB, CMP, EG	BWL	19
operations	ADDX, SUBX, DAA, DAS	В	_
	INC, DEC	BWL	_
	ADDS, SUBS	L	_
	MULXU, DIVXU, MULXS, DIVXS	BW	_
	EXTU, EXTS	WL	_
	TAS	В	_
Logic operations	AND, OR, XOR, NOT	BWL	4
Shift	SHAL, SHAR, SHLL, SHLR, ROTL, ROTR, ROTXL, ROTXR	BWL	8
Bit manipulation	BSET, BCLR, BNOT, BTST, BLD, BILD, BST, BIST, BAND, BIAND, BOR, BIOR, BXOR, BIXOR	В	14
Branch	Bcc* ² , JMP, BSR, JSR, RTS	_	5
System control	TRAPA, RTE, SLEEP, LDC, STC, ANDC, ORC, XORC, NOP		9
Block data transfer	EEPMOV	_	1

Total: 65 types

Notes: B: byte size; W: word size; L: longword size.

1. POP.W Rn and PUSH.W Rn are identical to MOV.W @SP+, Rn and MOV.W Rn, @-SP.

POP.L ERn and PUSH.L ERn are identical to MOV.L @SP+, ERn and MOV.L ERn, @-SP.

2. Bcc is the general name for conditional branch instructions.

3. Cannot be used in the H8S/2138 Series or H8S/2134 Series.

2.6.2 Instructions and Addressing Modes

Table 2.2 indicates the combinations of instructions and addressing modes that the H8S/2000 CPU can use.

							Ad	dressi	ng Moo	les					
Function	Instruction	XX#	Rn	@ERn	@(d:16,ERn)	@(d:32,ERn)	@-ERn/@ERn+	@ aa:8	@aa:16	@aa:24	@aa:32	@(d:8,PC)	@(d:16,PC)	@ @ aa:8	1
Data	MOV	BWL	BWL	BWL	BWL	BWL	BWL	В	BWL	_	BWL	_	_	_	_
transfer	POP, PUSH	_	—	_	—	—	—	_	—	_	_	—	-	—	WL
	LDM, STM	_	—	_	—	—	—	_	—	_	_	—	—	—	L
	MOVFPE*, MOVTPE*		—		—	—	_		В			—	—	—	_
Arithmetic	ADD, CMP	BWL	BWL	_	_	—	—	_	—	_	—	—	—	—	—
operations	SUB	WL	BWL			—	—	_	—			_	—	_	—
	ADDX, SUBX	В	В			—	—	_	—		_	_	—	_	—
	ADDS, SUBS		L			—	—	_	—			_	—	_	—
	INC, DEC	_	BWL			—	—	_	—			_	—	_	—
	DAA, DAS	_	В	_	_	_	—	_	_	_	_	_	_	_	—
	MULXU, DIVXU	_	BW	_	—	—	_	_	_	_	_	-	_	-	—
	MULXS, DIVXS		BW	I	—	—	—		—	I		—	—	—	—
	NEG	_	BWL	_	_	_	—	_	-	_	_	_	_	_	_
	EXTU, EXTS	_	WL	_	_	_	_	_	_	_	_	_	_	_	_
	TAS		—	В	—	_	_	_	_			—	_	—	—
Logic operations	AND, OR, XOR	BWL	BWL	Ι	—	_	—		—	Ι	I	—	—	—	—
	NOT	_	BWL	_	_	_	_	_	_	_	_	_	_	_	_
Shift		—	BWL	—	_	-	—	_	-	—	—	—	-	—	—
Bit manipula	ation	_	В	В	—	—	_	В	В	_	В	—	—	—	—
Branch	Bcc, BSR	_	_	_	_	—	_	_	—	_	_	\bigcirc	0	_	—
	JMP, JSR	_	—	_	_	—	—	_	—	0	_	—	—	\bigcirc	—
	RTS	_	—	_	—	—	—	_	—	_	_	—	—	—	0

 Table 2.2
 Combinations of Instructions and Addressing Modes

Note: * Cannot be used in the H8S/2138 Series or H8S/2134 Series.

							Ad	dressi	ng Moo	les					
Function	Instruction	XX#	Rn	@ERn	@(d:16,ERn)	@(d:32,ERn)	@-ERn/@ERn+	@ aa:8	@aa:16	@aa:24	@ aa:32	@(d:8,PC)	@(d:16,PC)	@ @ aa:8	I
System	TRAPA		_		I			_			_				0
control	RTE	—	—	_	—	—	—	_	_	—	_	_	_	—	0
	SLEEP	—			—	_	—			—				_	0
	LDC	В	В	W	W	W	W		W	—	W			_	—
	STC	—	В	W	W	W	W		W	—	W			_	—
	ANDC, ORC, XORC	В	_	—	—	—	—	—	—	—	—	—	—	—	—
	NOP	—	—		—	—	—	_		—	_			—	0
Block data t	ransfer		—			—		—			—			—	BW

 Table 2.2
 Combinations of Instructions and Addressing Modes (cont)

Legend:

B: Byte

W: Word

L: Longword

2.6.3 Table of Instructions Classified by Function

Table 2.3 summarizes the instructions in each functional category. The notation used in table 2.3 is defined below.

Operation Notat	ion
Rd	General register (destination)*
Rs	General register (source)*
Rn	General register*
ERn	General register (32-bit register)
(EAd)	Destination operand
(EAs)	Source operand
EXR	Extended control register
CCR	Condition-code register
N	N (negative) flag in CCR
Z	Z (zero) flag in CCR
V	V (overflow) flag in CCR
С	C (carry) flag in CCR
PC	Program counter
SP	Stack pointer
#IMM	Immediate data
disp	Displacement
+	Addition
_	Subtraction
×	Multiplication
÷	Division
^	Logical AND
V	Logical OR
\oplus	Logical exclusive OR
\rightarrow	Move
7	NOT (logical complement)
:8/:16/:24/:32	8-, 16-, 24-, or 32-bit length

Operation Notation

Note: *General registers include 8-bit registers (R0H to R7H, R0L to R7L), 16-bit registers (R0 to R7, E0 to E7), and 32-bit registers (ER0 to ER7).

Туре	Instruction	Size*	Function
Data transfer	MOV	B/W/L	$(EAs) \rightarrow Rd, Rs \rightarrow (EAd)$ Moves data between two general registers or between a general register and memory, or moves immediate data to a general register.
	MOVFPE	В	Cannot be used in the H8S/2138 Series or H8S/2134 Series.
	MOVTPE	В	Cannot be used in the H8S/2138 Series or H8S/2134 Series.
	POP	W/L	$@SP+ \rightarrow Rn$ Pops a general register from the stack.
			POP.W Rn is identical to MOV.W @SP+, Rn.
			POP.L ERn is identical to MOV.L @SP+, ERn.
	PUSH	W/L	Rn → @–SP Pushes a general register onto the stack. PUSH.W Rn is identical to MOV.W Rn, @–SP. PUSH.L ERn is identical to MOV.L ERn, @–SP.
	LDM	L	$@SP+ \rightarrow Rn$ (register list) Pops two or more general registers from the stack.
	STM	L	Rn (register list) \rightarrow @–SP Pushes two or more general registers onto the stack.

 Table 2.3
 Instructions Classified by Function

Туре	Instruction	Size*	Function
Arithmetic operations	ADD SUB	B/W/L	$Rd \pm Rs \rightarrow Rd$, $Rd \pm \#IMM \rightarrow Rd$ Performs addition or subtraction on data in two general registers, or on immediate data and data in a general register. (Immediate byte data cannot be subtracted from byte data in a general register. Use the SUBX or ADD instruction.)
	ADDX SUBX	В	$Rd \pm Rs \pm C \rightarrow Rd$, $Rd \pm \#IMM \pm C \rightarrow Rd$ Performs addition or subtraction with carry on byte data in two general registers, or on immediate data and data in a general register.
	INC DEC	B/W/L	$Rd \pm 1 \rightarrow Rd$, $Rd \pm 2 \rightarrow Rd$ Increments or decrements a general register by 1 or 2. (Byte operands can be incremented or decremented by 1 only.)
	ADDS SUBS	L	$Rd \pm 1 \rightarrow Rd$, $Rd \pm 2 \rightarrow Rd$, $Rd \pm 4 \rightarrow Rd$ Adds or subtracts the value 1, 2, or 4 to or from data in a 32-bit register.
	DAA DAS	В	Rd decimal adjust \rightarrow Rd Decimal-adjusts an addition or subtraction result in a general register by referring to the CCR to produce 4-bi BCD data.
	MULXU	B/W	$Rd \times Rs \rightarrow Rd$ Performs unsigned multiplication on data in two general registers: either 8 bits \times 8 bits \rightarrow 16 bits or 16 bits \times 16 bits \rightarrow 32 bits.
	MULXS	B/W	$Rd \times Rs \rightarrow Rd$ Performs signed multiplication on data in two general registers: either 8 bits \times 8 bits \rightarrow 16 bits or 16 bits \times 16 bits \rightarrow 32 bits.
	DIVXU	B/W	Rd ÷ Rs → Rd Performs unsigned division on data in two general registers: either 16 bits ÷ 8 bits → 8-bit quotient and 8- bit remainder or 32 bits ÷ 16 bits → 16-bit quotient and 16-bit remainder.

 Table 2.3
 Instructions Classified by Function (cont)

Туре	Instruction	Size*	Function
Arithmetic operations	DIVXS	B/W	Rd ÷ Rs → Rd Performs signed division on data in two general registers: either 16 bits ÷ 8 bits → 8-bit quotient and 8- bit remainder or 32 bits ÷ 16 bits → 16-bit quotient and 16-bit remainder.
	CMP	B/W/L	Rd – Rs, Rd – #IMM Compares data in a general register with data in another general register or with immediate data, and sets CCR bits according to the result.
	NEG	B/W/L	$0 - Rd \rightarrow Rd$ Takes the two's complement (arithmetic complement) of data in a general register.
	EXTU	W/L	Rd (zero extension) \rightarrow Rd Extends the lower 8 bits of a 16-bit register to word size, or the lower 16 bits of a 32-bit register to longword size, by padding with zeros on the left.
	EXTS	W/L	Rd (sign extension) \rightarrow Rd Extends the lower 8 bits of a 16-bit register to word size, or the lower 16 bits of a 32-bit register to longword size, by extending the sign bit.
	TAS	В	@ERd – 0, 1 \rightarrow (<bit 7=""> of @ERd) Tests memory contents, and sets the most significant bit (bit 7) to 1.</bit>

 Table 2.3
 Instructions Classified by Function (cont)

Туре	Instruction	Size*	Function
Logic operations	AND	B/W/L	$Rd \land Rs \rightarrow Rd$, $Rd \land \#IMM \rightarrow Rd$ Performs a logical AND operation on a general register and another general register or immediate data.
	OR	B/W/L	$Rd \lor Rs \rightarrow Rd$, $Rd \lor \#IMM \rightarrow Rd$ Performs a logical OR operation on a general register and another general register or immediate data.
	XOR	B/W/L	$Rd \oplus Rs \rightarrow Rd$, $Rd \oplus \#IMM \rightarrow Rd$ Performs a logical exclusive OR operation on a general register and another general register or immediate data.
	NOT	B/W/L	¬ (Rd) → (Rd) Takes the one's complement (logical complement) of general register contents.
Shift operations	SHAL SHAR	B/W/L	$\begin{array}{l} Rd \ (shift) \to Rd \\ Performs \ an \ arithmetic \ shift \ on \ general \ register \\ contents. \\ A \ 1\text{-bit} \ or \ 2\text{-bit} \ shift \ is \ possible. \end{array}$
	SHLL SHLR	B/W/L	Rd (shift) \rightarrow Rd Performs a logical shift on general register contents. A 1-bit or 2-bit shift is possible.
	ROTL B/W/L ROTR		Rd (rotate) \rightarrow Rd Rotates general register contents. 1-bit or 2-bit rotation is possible.
	ROTXL ROTXR	B/W/L	Rd (rotate) \rightarrow Rd Rotates general register contents through the carry flag. 1-bit or 2-bit rotation is possible.

 Table 2.3
 Instructions Classified by Function (cont)

Туре	Instruction	Size*	Function
Bit- manipulation instructions	BSET	В	$1 \rightarrow$ (<bit-no.> of <ead>) Sets a specified bit in a general register or memory operand to 1. The bit number is specified by 3-bit immediate data or the lower three bits of a general register.</ead></bit-no.>
	BCLR	В	$0 \rightarrow (\text{sbit-No.> of })$ Clears a specified bit in a general register or memory operand to 0. The bit number is specified by 3-bit immediate data or the lower three bits of a general register.
	BNOT	В	¬ (<bit-no.> of <ead>) → (<bit-no.> of <ead>) Inverts a specified bit in a general register or memory operand. The bit number is specified by 3-bit immediate data or the lower three bits of a general register.</ead></bit-no.></ead></bit-no.>
	BTST	В	¬ (<bit-no.> of <ead>) → Z Tests a specified bit in a general register or memory operand and sets or clears the Z flag accordingly. The bit number is specified by 3-bit immediate data or the lower three bits of a general register.</ead></bit-no.>
	BAND	В	$C \land (\text{sbit-No.> of } \text{}) \rightarrow C$ ANDs the carry flag with a specified bit in a general register or memory operand and stores the result in the carry flag.
	BIAND	В	$C \land \neg$ (<bit-no.> of <ead>) $\rightarrow C$ ANDs the carry flag with the inverse of a specified bit in a general register or memory operand and stores the result in the carry flag. The bit number is specified by 3-bit immediate data.</ead></bit-no.>
	BOR	В	$C \lor (\text{sbit-No.> of } \text{}) \rightarrow C$ ORs the carry flag with a specified bit in a general register or memory operand and stores the result in the carry flag.
	BIOR	В	$C \lor \neg$ (<bit-no.> of <ead>) $\rightarrow C$ ORs the carry flag with the inverse of a specified bit in a general register or memory operand and stores the result in the carry flag. The bit number is specified by 3-bit immediate data.</ead></bit-no.>

Table 2.3 Instructions Classified by Function (cont)

Туре	Instruction	Size*	Function
Bit- manipulation instructions	BXOR	В	$C \oplus (of) \rightarrow C$ Exclusive-ORs the carry flag with a specified bit in a general register or memory operand and stores the result in the carry flag.
	BIXOR	В	$C \oplus \neg$ (<bit-no.> of <ead>) $\rightarrow C$ Exclusive-ORs the carry flag with the inverse of a specified bit in a general register or memory operand and stores the result in the carry flag. The bit number is specified by 3-bit immediate data.</ead></bit-no.>
	BLD	В	(<bit-no.> of <ead>) \rightarrow C Transfers a specified bit in a general register or memory operand to the carry flag.</ead></bit-no.>
	BILD	В	¬ (<bit-no.> of <ead>) → C Transfers the inverse of a specified bit in a general register or memory operand to the carry flag. The bit number is specified by 3-bit immediate data.</ead></bit-no.>
	BST	В	$C \rightarrow$ (<bit-no.> of <ead>) Transfers the carry flag value to a specified bit in a general register or memory operand.</ead></bit-no.>
	BIST	В	\neg C \rightarrow (<bit-no.> of <ead>) Transfers the inverse of the carry flag value to a specified bit in a general register or memory operand. The bit number is specified by 3-bit immediate data.</ead></bit-no.>

 Table 2.3
 Instructions Classified by Function (cont)

Туре	Instruction	Size*	Function						
Branch instructions	Bcc		Branches to a specified address if a specified condition is true. The branching conditions are listed below.						
			Mnemonic	Description	Condition				
			BRA(BT)	Always (true)	Always				
			BRN(BF)	Never (false)	Never				
			BHI	High	$C \lor Z = 0$				
			BLS	Low or same	C ∨ Z = 1				
			BCC(BHS)	Carry clear (high or same)	C = 0				
			BCS(BLO)	Carry set (low)	C = 1				
			BNE	Not equal	Z = 0				
			BEQ	Equal	Z = 1				
			BVC	Overflow clear	V = 0				
			BVS	Overflow set	V = 1				
			BPL	Plus	N = 0				
			BMI	Minus	N = 1				
			BGE	Greater or equal	$N \oplus V = 0$				
			BLT	Less than	N ⊕ V = 1				
			BGT	Greater than	$Z \lor (N \oplus V) = 0$				
			BLE	Less or equal	$Z_{\vee}(N \oplus V) = 1$				
	JMP	_	Branches unco	nditionally to a specifie	d address.				
	BSR		Branches to a subroutine at a specified address.						
	JSR	_	Branches to a subroutine at a specified address.						
	RTS	_	Returns from a						

Table 2.3 Instructions Classified by Function (cont)

Туре	Instruction	Size*	Function
System control	TRAPA	—	Starts trap-instruction exception handling.
instructions	RTE	_	Returns from an exception-handling routine.
	SLEEP	_	Causes a transition to a power-down state.
	LDC	B/W	$(EAs) \rightarrow CCR$, $(EAs) \rightarrow EXR$ Moves contents of a general register or memory or immediate data to CCR or EXR. Although CCR and EXR are 8-bit registers, word-size transfers are performed between them and memory. The upper 8 bits are valid.
	STC	B/W	$CCR \rightarrow (EAd), EXR \rightarrow (EAd)$ Transfers CCR or EXR contents to a general register or memory. Although CCR and EXR are 8-bit registers, word-size transfers are performed between them and memory. The upper 8 bits are valid.
	ANDC	В	CCR \land #IMM \rightarrow CCR, EXR \land #IMM \rightarrow EXR Logically ANDs the CCR or EXR contents with immediate data.
	ORC	В	$\label{eq:CCR} \begin{array}{l} CCR \lor \#IMM \to CCR, EXR \lor \#IMM \to EXR \\ Logically ORs the CCR or EXR contents with immediate \\ data. \end{array}$
	XORC	В	$\begin{array}{l} CCR \oplus \#IMM \to CCR, EXR \oplus \#IMM \to EXR \\ Logically \ exclusive\text{-}ORs \ the \ CCR \ or \ EXR \ contents \ with \\ immediate \ data. \end{array}$
	NOP	—	$PC + 2 \rightarrow PC$ Only increments the program counter.

 Table 2.3
 Instructions Classified by Function (cont)

Туре	Instruction	Size*	Function
Block data transfer instructions	EEPMOV.B	_	if R4L \neq 0 then Repeat @ER5+ \rightarrow @ER6+ R4L-1 \rightarrow R4L Until R4L = 0 else next;
	EEPMOV.W	_	if R4 \neq 0 then Repeat @ER5+ \rightarrow @ER6+ R4-1 \rightarrow R4 Until R4 = 0 else next;
			Block transfer instruction. Transfers the number of data bytes specified by R4L or R4 from locations starting at the address indicated by ER5 to locations starting at the address indicated by ER6. After the transfer, the next instruction is executed.
Note: *Size refers to the operand size.			

Table 2.3	Instructions Classified by Function (cont)

B: Byte

W: Word

L: Longword

2.6.4 Basic Instruction Formats

The CPU instructions consist of 2-byte (1-word) units. An instruction consists of an operation field (op field), a register field (r field), an effective address extension (EA field), and a condition field (cc).

Operation Field: Indicates the function of the instruction, the addressing mode, and the operation to be carried out on the operand. The operation field always includes the first four bits of the instruction. Some instructions have two operation fields.

Register Field: Specifies a general register. Address registers are specified by 3 bits, data registers by 3 bits or 4 bits. Some instructions have two register fields. Some have no register field.

Effective Address Extension: Eight, 16, or 32 bits specifying immediate data, an absolute address, or a displacement.

Condition Field: Specifies the branching condition of Bcc instructions.

Figure 2.12 shows examples of instruction formats.

(1) Operation field only					
	ор				NOP, RTS, etc.
(2) Operation field and register fields					
	o	р	rn	rm	ADD.B Rn, Rm, etc.
(3) Operation field, register fields, and effective address extension					
	ор		rn	rm	MOV.B @(d:16, Rn), Rm, etc.
	EA (disp)				
(4) Operation field, effective address extension, and condition field					
	ор	сс	EA (disp)		BRA d:16, etc

Figure 2.12 Instruction Formats (Examples)

2.6.5 Notes on Use of Bit-Manipulation Instructions

The BSET, BCLR, BNOT, BST, and BIST instructions read a byte of data, carry out bit manipulation, then write back the byte of data. Caution is therefore required when using these instructions on a register containing write-only bits, or a port.

The BCLR instruction can be used to clear internal I/O register flags to 0. In this case, the relevant flag need not be read beforehand if it is clear that it has been set to 1 in an interrupt handling routine, etc.

2.7 Addressing Modes and Effective Address Calculation

2.7.1 Addressing Mode

The CPU supports the eight addressing modes listed in table 2.4. Each instruction uses a subset of these addressing modes. Arithmetic and logic instructions can use the register direct and immediate modes. Data transfer instructions can use all addressing modes except program-counter relative and memory indirect. Bit-manipulation instructions use register direct, register indirect, or absolute addressing mode to specify an operand, and register direct (BSET, BCLR, BNOT, and BTST instructions) or immediate (3-bit) addressing mode to specify a bit number in the operand.

No.	Addressing Mode	Symbol
1	Register direct	Rn
2	Register indirect	@ERn
3	Register indirect with displacement	@(d:16,ERn)/@(d:32,ERn)
4	Register indirect with post-increment Register indirect with pre-decrement	@ERn+ @-ERn
5	Absolute address	@aa:8/@aa:16/@aa:24/@aa:32
6	Immediate	#xx:8/#xx:16/#xx:32
7	Program-counter relative	@(d:8,PC)/@(d:16,PC)
8	Memory indirect	@@aa:8

Table 2.4Addressing Modes

Register Direct—Rn: The register field of the instruction code specifies an 8-, 16-, or 32-bit general register containing the operand. R0H to R7H and R0L to R7L can be specified as 8-bit registers. R0 to R7 and E0 to E7 can be specified as 16-bit registers. ER0 to ER7 can be specified as 32-bit registers.

Register Indirect—@**ERn:** The register field of the instruction code specifies an address register (ERn) which contains the address of the operand in memory. If the address is a program instruction address, the lower 24 bits are valid and the upper 8 bits are all assumed to be 0 (H'00).

Register Indirect with Displacement—@(**d:16**, **ERn**) or @(**d:32**, **ERn**): A 16-bit or 32-bit displacement contained in the instruction is added to an address register (ERn) specified by the register field of the instruction, and the sum gives the address of a memory operand. A 16-bit displacement is sign-extended when added.

Register Indirect with Post-Increment or Pre-Decrement—@ERn+ or @-ERn:

• Register indirect with post-increment—@ERn+

The register field of the instruction code specifies an address register (ERn) which contains the address of a memory operand. After the operand is accessed, 1, 2, or 4 is added to the address register contents and the sum is stored in the address register. The value added is 1 for byte access, 2 for word access, or 4 for longword access. For word or longword access, the register value should be even.

• Register indirect with pre-decrement—@-ERn

The value 1, 2, or 4 is subtracted from an address register (ERn) specified by the register field in the instruction code, and the result becomes the address of a memory operand. The result is also stored in the address register. The value subtracted is 1 for byte access, 2 for word access, or 4 for longword access. For word or longword access, the register value should be even.

Absolute Address—@aa:8, @aa:16, @aa:24, or @aa:32: The instruction code contains the absolute address of a memory operand. The absolute address may be 8 bits long (@aa:8), 16 bits long (@aa:16), 24 bits long (@aa:24), or 32 bits long (@aa:32).

To access data, the absolute address should be 8 bits (@aa:8), 16 bits (@aa:16), or 32 bits (@aa:32) long. For an 8-bit absolute address, the upper 24 bits are all assumed to be 1 (H'FFFF). For a 16-bit absolute address the upper 16 bits are a sign extension. A 32-bit absolute address can access the entire address space.

A 24-bit absolute address (@aa:24) indicates the address of a program instruction. The upper 8 bits are all assumed to be 0 (H'00).

Table 2.5 indicates the accessible absolute address ranges.

Absolute Address		Normal Mode	Advanced Mode
Data address	8 bits (@aa:8)	H'FF00 to H'FFFF	H'FFFF00 to H'FFFFFF
	16 bits (@aa:16)	H'0000 to H'FFFF	H'000000 to H'007FFF, H'FF8000 to H'FFFFFF
	32 bits (@aa:32)		H'000000 to H'FFFFFF
Program instruction address	24 bits (@aa:24)	_	

Table 2.5 Absolute Address Access Ranges

Immediate—**#xx:8**, **#xx:16**, or **#xx:32**: The instruction contains 8-bit (#xx:8), 16-bit (#xx:16), or 32-bit (#xx:32) immediate data as an operand.

The ADDS, SUBS, INC, and DEC instructions contain immediate data implicitly. Some bit manipulation instructions contain 3-bit immediate data in the instruction code, specifying a bit number. The TRAPA instruction contains 2-bit immediate data in its instruction code, specifying a vector address.

Program-Counter Relative—@(**d:8**, **PC**) or @(**d:16**, **PC**): This mode is used in the Bcc and BSR instructions. An 8-bit or 16-bit displacement contained in the instruction is sign-extended and added to the 24-bit PC contents to generate a branch address. Only the lower 24 bits of this branch address are valid; the upper 8 bits are all assumed to be 0 (H'00). The PC value to which the displacement is added is the address of the first byte of the next instruction, so the possible branching range is -126 to +128 bytes (-63 to +64 words) or -32766 to +32768 bytes (-16383 to +16384 words) from the branch instruction. The resulting value should be an even number.

Memory Indirect—@@**aa:8:** This mode can be used by the JMP and JSR instructions. The instruction code contains an 8-bit absolute address specifying a memory operand. This memory operand contains a branch address. The upper bits of the absolute address are all assumed to be 0, so the address range is 0 to 255 (H'0000 to H'00FF in normal mode, H'000000 to H'000FF in advanced mode). In normal mode the memory operand is a word operand and the branch address is 16 bits long. In advanced mode the memory operand is a longword operand, the first byte of which is assumed to be all 0 (H'00).

Note that the first part of the address range is also the exception vector area. For further details, refer to section 4, Exception Handling.

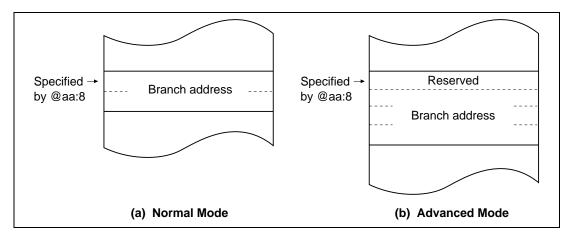


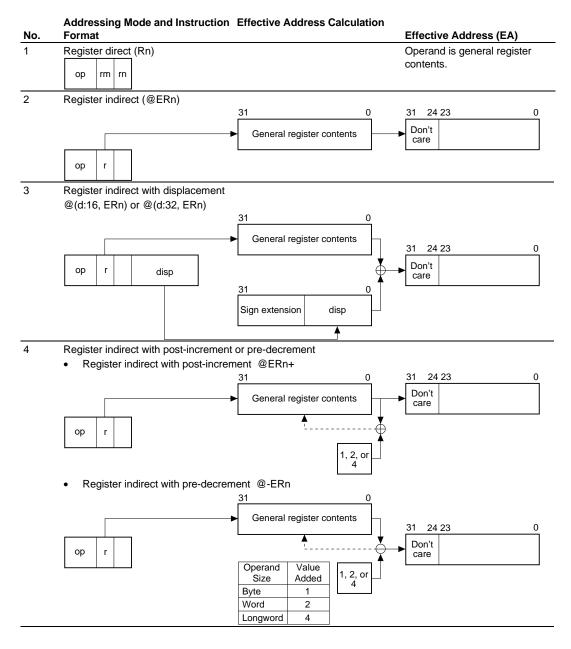
Figure 2.13 Branch Address Specification in Memory Indirect Mode

If an odd address is specified in word or longword memory access, or as a branch address, the least significant bit is regarded as 0, causing data to be accessed or an instruction code to be fetched at the address preceding the specified address. (For further information, see section 2.5.2, Memory Data Formats.)

2.7.2 Effective Address Calculation

Table 2.6 indicates how effective addresses are calculated in each addressing mode. In normal mode the upper 8 bits of the effective address are ignored in order to generate a 16-bit address.

Table 2.6 Effective Address Calculation



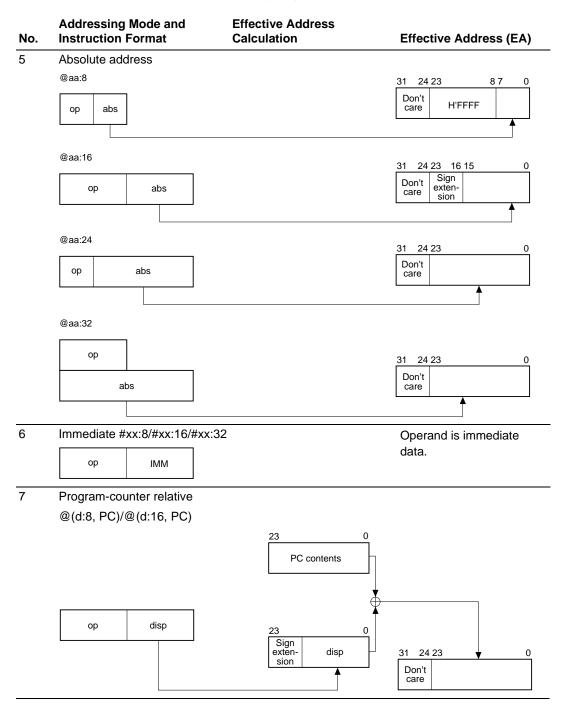


 Table 2.6
 Effective Address Calculation (cont)

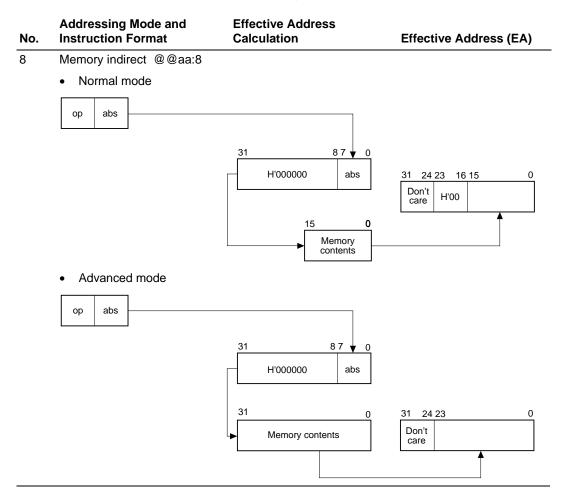


 Table 2.6
 Effective Address Calculation (cont)

2.8 Processing States

2.8.1 Overview

The CPU has five main processing states: the reset state, exception-handling state, program execution state, bus-released state, and power-down state. Figure 2.14 shows a diagram of the processing states. Figure 2.15 indicates the state transitions.

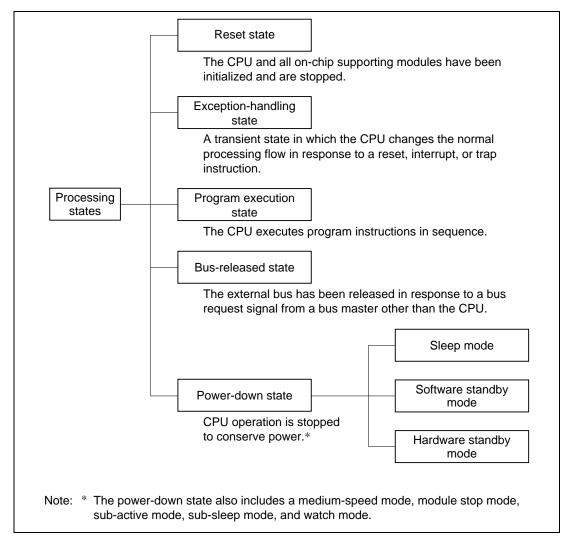


Figure 2.14 Processing States

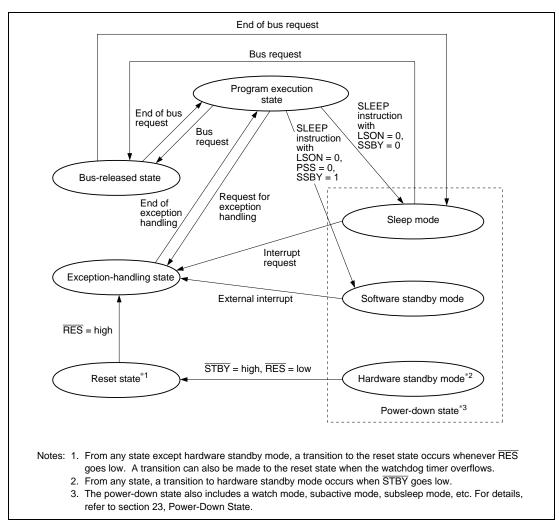


Figure 2.15 State Transitions

2.8.2 Reset State

When the $\overline{\text{RES}}$ input goes low all current processing stops and the CPU enters the reset state. All interrupts are disabled in the reset state. Reset exception handling starts when the $\overline{\text{RES}}$ signal changes from low to high.

The reset state can also be entered by a watchdog timer overflow. For details, refer to section 14, Watchdog Timer.

2.8.3 Exception-Handling State

The exception-handling state is a transient state that occurs when the CPU alters the normal processing flow due to a reset, interrupt, or trap instruction. The CPU fetches a start address (vector) from the exception vector table and branches to that address.

Types of Exception Handling and Their Priority: Exception handling is performed for resets, interrupts, and trap instructions. Table 2.7 indicates the types of exception handling and their priority. Trap instruction exception handling is always accepted in the program execution state.

Exception handling and the stack structure depend on the interrupt control mode set in SYSCR.

Priority	Type of Exception	Detection Timing	Start of Exception Handling				
High	Reset	Synchronized with clock	Exception handling starts immediately after a low-to-high transition at the RES pin, or when the watchdog timer overflows.				
	Interrupt	End of instruction execution or end of exception-handling sequence* ¹	When an interrupt is requested, exception handling starts at the end of the current instruction or current exception-handling sequence.				
Low	Trap instruction	When TRAPA instruction is executed	Exception handling starts when a trap (TRAPA) instruction is executed.* ²				
Notes: 1.	Notes: 1. Interrupts are not detected at the end of the ANDC, ORC, XORC, and LDC instructions, or immediately after reset exception handling.						

 Table 2.7
 Exception Handling Types and Priority

2. Trap instruction exception handling is always accepted in the program execution state.

Reset Exception Handling: After the $\overline{\text{RES}}$ pin has gone low and the reset state has been entered, when $\overline{\text{RES}}$ goes high again, reset exception handling starts. When reset exception handling starts the CPU fetches a start address (vector) from the exception vector table and starts program execution from that address. All interrupts, including NMI, are disabled during reset exception handling and after it ends.

Interrupt Exception Handling and Trap Instruction Exception Handling: When interrupt or trap-instruction exception handling begins, the CPU references the stack pointer (ER7) and pushes the program counter and other control registers onto the stack. Next, the CPU alters the settings of the interrupt mask bits in the control registers. Then the CPU fetches a start address (vector) from the exception vector table and program execution starts from that start address.

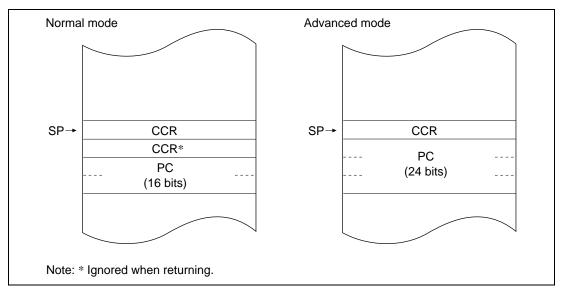


Figure 2.16 shows the stack after exception handling ends.

Figure 2.16 Stack Structure after Exception Handling (Examples)

2.8.4 **Program Execution State**

In this state the CPU executes program instructions in sequence.

2.8.5 Bus-Released State

This is a state in which the bus has been released in response to a bus request from a bus master other than the CPU. While the bus is released, the CPU halts except for internal operations.

There is one other bus master in addition to the CPU: the data transfer controller (DTC).

For further details, refer to section 6, Bus Controller.

2.8.6 Power-Down State

The power-down state includes both modes in which the CPU stops operating and modes in which the CPU does not stop. There are five modes in which the CPU stops operating: sleep mode, software standby mode, hardware standby mode, subsleep mode, and watch mode. There are also three other power-down modes: medium-speed mode, module stop mode, and subactive mode. In medium-speed mode, the CPU and other bus masters operate on a medium-speed clock. Module stop mode permits halting of the operation of individual modules, other than the CPU. Subactive mode, subsleep mode, and watch mode are power-down modes that use subclock input. For details, refer to section 23, Power-Down State.

Sleep Mode: A transition to sleep mode is made if the SLEEP instruction is executed while the software standby bit (SSBY) in the standby control register (SBYCR) and the LSON bit in the low-power control register (LPWRCR) are both cleared to 0. In sleep mode, CPU operations stop immediately after execution of the SLEEP instruction. The contents of CPU registers are retained.

Software Standby Mode: A transition to software standby mode is made if the SLEEP instruction is executed while the SSBY bit in SBYCR is set to 1 and the LSON bit in LPWRCR and the PSS bit in the WDT1 timer control/status register (TCSR) are both cleared to 0. In software standby mode, the CPU and clock halt and all MCU operations stop. As long as a specified voltage is supplied, the contents of CPU registers and on-chip RAM are retained. The I/O ports also remain in their existing states.

Hardware Standby Mode: A transition to hardware standby mode is made when the STBY pin goes low. In hardware standby mode, the CPU and clock halt and all MCU operations stop. The on-chip supporting modules are reset, but as long as a specified voltage is supplied, on-chip RAM contents are retained.

2.9 Basic Timing

2.9.1 Overview

The CPU is driven by a system clock, denoted by the symbol ø. The period from one rising edge of ø to the next is referred to as a "state." The memory cycle or bus cycle consists of one, two, or three states. Different methods are used to access on-chip memory, on-chip supporting modules, and the external address space.

2.9.2 On-Chip Memory (ROM, RAM)

On-chip memory is accessed in one state. The data bus is 16 bits wide, permitting both byte and word transfer instruction. Figure 2.17 shows the on-chip memory access cycle. Figure 2.18 shows the pin states.

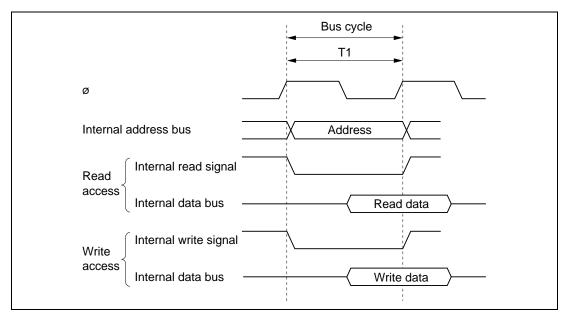


Figure 2.17 On-Chip Memory Access Cycle

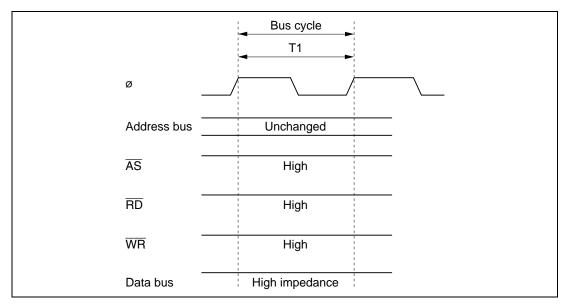


Figure 2.18 Pin States during On-Chip Memory Access

2.9.3 On-Chip Supporting Module Access Timing

The on-chip supporting modules are accessed in two states. The data bus is either 8 bits or 16 bits wide, depending on the particular internal I/O register being accessed. Figure 2.19 shows the access timing for the on-chip supporting modules. Figure 2.20 shows the pin states.

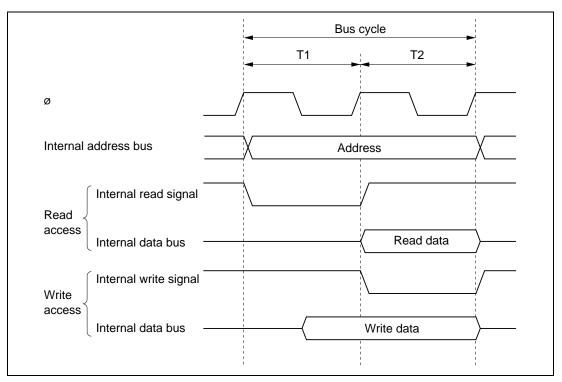


Figure 2.19 On-Chip Supporting Module Access Cycle

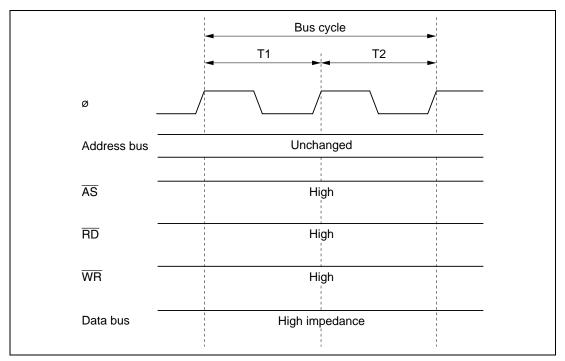


Figure 2.20 Pin States during On-Chip Supporting Module Access

2.9.4 External Address Space Access Timing

The external address space is accessed with an 8-bit data bus width in a two-state or three-state bus cycle. In three-state access, wait states can be inserted. For further details, refer to section 6, Bus Controller.

Section 3 MCU Operating Modes

3.1 Overview

3.1.1 Operating Mode Selection

The H8S/2138 Series and H8S/2134 Series have three operating modes (modes 1 to 3). These modes enable selection of the CPU operating mode and enabling/disabling of on-chip ROM, by setting the mode pins (MD1 and MD0).

Table 3.1 lists the MCU operating modes.

Table 3.1	MCU Operating Mode Selection
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MCU Operating Mode	MD1	MD0	CPU Operating Mode	Description	On-Chip ROM
0	0	0	_	_	_
1		1	Normal	Expanded mode with on-chip ROM disabled	Disabled
2	1	0	Advanced	Expanded mode with on-chip ROM enabled Single-chip mode	Enabled
3		1	Normal	Expanded mode with on-chip ROM enabled Single-chip mode	_

The CPU's architecture allows for 4 Gbytes of address space, but the H8S/2138 Series and H8S/2134 Series actually access a maximum of 16 Mbytes. However, as there are 16 external address output pins, advanced mode is enabled only in single-chip mode or in expanded mode with on-chip ROM enabled when a specific area in the external address space is accessed using IOS. The external data bus width is 8 bits.

Mode 1 is an externally expanded mode that allows access to external memory and peripheral devices. With modes 2 and 3, operation begins in single-chip mode after reset release, but a transition can be made to external expansion mode by setting the EXPE bit in MDCR.

The H8S/2138 Series and H8S/2134 Series can only be used in modes 1 to 3. These means that the mode pins must select one of these modes. Do not changes the inputs at the mode pins during operation.

3.1.2 Register Configuration

The H8S/2138 Series and H8S/2134 Series have a mode control register (MDCR) that indicates the inputs at the mode pins (MD1 and MD0), a system control register (SYSCR) and bus control register (BCR) that control the operation of the MCU, and a serial/timer control register (STCR) that controls the operation of the supporting modules. Table 3.2 summarizes these registers.

Name	Abbreviation	R/W	Initial Value	Address*
Mode control register	MDCR	R/W	Undetermined	H'FFC5
System control register	SYSCR	R/W	H'09	H'FFC4
Bus control register	BCR	R/W	H'D7	H'FFC6
Serial/timer control register	STCR	R/W	H'00	H'FFC3

Table 3.2MCU Registers

Note: *Lower 16 bits of the address.

3.2 Register Descriptions

3.2.1 Mode Control Register (MDCR)

Bit	7	6	5	4	3	2	1	0
	EXPE	—	—	—	—	_	MDS1	MDS0
Initial value	*	0	0	0	0	0	*	*
Read/Write	R/W*	_	_		_	_	R	R

Note: * Determined by pins MD1 and MD0.

MDCR is an 8-bit read-only register that indicates the operating mode setting and the current operating mode of the MCU.

The EXPE bit is initialized in coordination with the mode pin states by a reset and in hardware standby mode.

Bit 7—Expanded Mode Enable (EXPE): Sets expanded mode. In mode 1, this bit is fixed at 1 and cannot be modified. In modes 2 and 3, this bit has an initial value of 0, and can be read and written.

Bit 7

EXPE	Description
0	Single chip mode is selected
1	Expanded mode is selected

Bits 6 to 2—Reserved: These bits cannot be modified and are always read as 0.

Bits 1 and 0—Mode Select 1 and 0 (MDS1, MDS0): These bits indicate the input levels at pins MD1 and MD0 (the current operating mode). Bits MDS1 and MDS0 correspond to MD1 and MD0. MDS1 and MDS0 are read-only bits—they cannot be written to. The mode pin (MD1 and MD0) input levels are latched into these bits when MDCR is read.

3.2.2 System Control Register (SYSCR)

Bit	7	6	5	4	3	2	1	0
	CS2E	IOSE	INTM1	INTM0	XRST	NMIEG	HIE	RAME
Initial value	0	0	0	0	1	0	0	1
Read/Write	R/W	R/W	R	R/W	R	R/W	R/W	R/W

SYSCR is an 8-bit readable/writable register that performs selection of system pin functions, reset source monitoring, interrupt control mode selection, NMI detected edge selection, supporting module pin location selection, supporting module register access control, and RAM address space control.

Only bits 7, 6, 3, 1, and 0 are described here. For a detailed description of these bits, refer also to the description of the relevant modules (host interface, bus controller, watchdog timer, RAM, etc.). For information on bits 5, 4, and 2, see section 5.2.1, System Control Register (SYSCR).

SYSCR is initialized to H'09 by a reset and in hardware standby mode. It is not initialized in software standby mode.

Bit 7—Chip Select 2 Enable (CS2E): Specifies the location of the host interface control pin $(\overline{\text{CS2}})$. For details, see section 17, Host Interface.

Bit 6—IOS Enable (IOSE): Controls the function of the $\overline{AS}/\overline{IOS}$ pin in expanded mode.

Bit 6		
IOSE	Description	
0	The $\overline{AS}/\overline{IOS}$ pin functions as the address strobe pin (Low output when accessing an external area)	(Initial value)
1	The $\overline{\text{AS}/\text{IOS}}$ pin functions as the I/O strobe pin (Low output when accessing a specified address from H'(FF)F000) to H'(FF)FE4F)

Bit 3—External Reset (XRST): Indicates the reset source. When the watchdog timer is used, a reset can be generated by watchdog timer overflow as well as by external reset input. XRST is a read-only bit. It is set to 1 by an external reset and cleared to 0 by watchdog timer overflow.

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XRST	Description	
0	A reset is generated by watchdog timer overflow	
1	A reset is generated by an external reset	(Initial value)

Bit 1—Host Interface Enable (HIE): This bit controls CPU access to the host interface data registers and control registers (HICR, IDR1, ODR1, STR1, IDR2, ODR2, and STR2), the keyboard controller and MOS input pull-up control registers (KMIMR and KMPCR), the 8-bit timer (channel X and Y) data registers and control registers (TCRX/TCRY, TCSRX/TCSRY, TICRR/TCORAY, TICRF/TCORBY, TCNTX/TCNTY, TCORC/TISR, TCORAX, and TCORBX), and the timer connection control registers (TCONRI, TCONRO, TCONRS, and SEDGR).

Bit 1

HIE	Description
0	In areas H'(FF)FFF0 to H'(FF)FFF7 and H'(FF)FFFC to H'(FF)FFFF, (Initial value) CPU access to 8-bit timer (channel X and Y) data registers and control registers, and timer connection control registers, is permitted
1	In areas H'(FF)FFF0 to H'(FF)FFF7 and H'(FF)FFFC to H'(FF)FFFF, CPU access to host interface data registers and control registers, and keyboard controller and MOS input pull-up control registers, is permitted

Bit 0—RAM Enable (RAME): Enables or disables the on-chip RAM. The RAME bit is initialized when the reset state is released. It is not initialized in software standby mode.

Bit 0

RAME	Description	
0	On-chip RAM is disabled	
1	On-chip RAM is enabled	(Initial value)

3.2.3 Bus Control Register (BCR)

Bit	7	6	5	4	3	2	1	0
	ICIS1	ICIS0	BRSTRM	BRSTS1	BRSTS0	—	IOS1	IOS0
Initial value	1	1	0	1	0	1	1	1
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

BCR is an 8-bit readable/writable register that specifies the external memory space access mode, and the I/O area range when the \overline{AS} pin is designated for use as the I/O strobe. For details on bits 7 to 2, see section 6.2.1, Bus Control Register (BCR).

BCR is initialized to H'D7 by a reset and in hardware standby mode.

Bits 1 and 0—IOS Select 1 and 0 (IOS1, IOS0): These bits specify the addresses for which the $\overline{AS}/\overline{IOS}$ pin output goes low when IOSE = 1.

	BCR		
Bit 1	Bit 0		
IOS1	IOS0	Description	
0	0	The $\overline{AS}/\overline{IOS}$ pin output goes low in accesses to addresses H'(FF)F000 to H'(FF)F03F	
	1	The $\overline{AS}/\overline{IOS}$ pin output goes low in accesses to addresses H'(FF)F000 to H'(FF)F0FF	
1	0	The $\overline{AS}/\overline{IOS}$ pin output goes low in accesses to addresses H'(FF)F000 to H'(FF)F3FF	
	1	The $\overline{AS}/\overline{IOS}$ pin output goes low in accesses to addresses H'(FF)F000 to H'(FF)FE4F	(Initial value)

3.2.4 Serial Timer Control Register (STCR)

Bit	7	6	5	4	3	2	1	0
	IICS	IICX1	IICX0	IICE	FLSHE	—	ICKS1	ICKS0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

STCR is an 8-bit readable/writable register that controls register access, the IIC operating mode (when the on-chip IIC option is included), an on-chip flash memory control (in F-ZTAT versions), and also selects the TCNT input clock. For details of functions other than register access control, see the descriptions of the relevant modules. If a module controlled by STCR is not used, do not write 1 to the corresponding bit.

STCR is initialized to H'00 by a reset and in hardware standby mode.

Bits 7 to 5—I²C Control (IICS, IICX1, IICX0): These bits control the operation of the I²C bus interface when the on-chip IIC option is included. For details, see section 16, I²C Bus Interface.

Bit 4—I²C Master Enable (IICE): Controls CPU access to the I²C bus interface data registers and control registers (ICCR, ICSR, ICDR/SARX, and ICMR/SAR), the PWMX data registers and control registers (DADRAH/DACR, DADRAL, DADRBH/DACNTH, and DADRBL/DACNTL), and the SCI control registers (SMR, BRR, and SCMR).

Bit 4		
IICE	Description	
0	Addresses H'(FF)FF88 and H'(FF)FF89, and H'(FF)FF8E and H'(FF)FF8F, are used for SCI1 control register access	(Initial value)
	Addresses H'(FF)FFA0 and H'(FF)FFA1, and H'(FF)FFA6 and H'(FF)FFA7, are used for SCI2 control register access	
	Addresses H'(FF)FFD8 and H'(FF)FFD9, and H'(FF)FFDE and H'(FF)FFDF, are used for SCI0 control register access	
1	Addresses H'(FF)FF88 and H'(FF)FF89, and H'(FF)FF8E and H'(FF)FF8F, are used for IIC1 data register and control register access	
	Addresses H'(FF)FFA0 and H'(FF)FFA1, and H'(FF)FFA6 and H'(FF)FFA7, are used for PWMX data register and control register access	
	Addresses H'(FF)FFD8 and H'(FF)FFD9, and H'(FF)FFDE and H'(FF)FFDF, are used for IIC0 data register and control register access	5

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Bit 3—Flash Memory Control Register Enable (FLSHE): Controls CPU access to the flash memory control registers (FLMCR1, FLMCR2, EBR1, and EBR2), the power-down mode control registers (SBYCR, LPWRCR, MSTPCRH, and MSTPCRL), and the supporting module control register (PCSR and SYSCR2).

Bit 3

FLSHE	Description
0	Addresses H'(FF)FF80 to H'(FF)FF87 are used for power-down mode (Initial value) control register and supporting module control register access
1	Addresses H'(FF)FF80 to H'(FF)FF87 are used for flash memory control register access (F-ZTAT version only)

Bit 2—Reserved: Do not write 1 to this bit.

Bits 1 and 0—Internal Clock Select 1 and 0 (ICKS1, ICKS0): These bits, together with bits CKS2 to CKS0 in TCR, select the clock to be input to TCNT. For details, see section 12, 8-Bit Timers.

3.3 Operating Mode Descriptions

3.3.1 Mode 1

The CPU can access a 64-kbyte address space in normal mode. The on-chip ROM is disabled.

Ports 1 and 2 function as an address bus, port 3 function as a data bus, and part of port 9 carries bus control signals.

3.3.2 Mode 2

The CPU can access a 16-Mbyte address space in advanced mode. The on-chip ROM is enabled. After a reset, single-chip mode is set, and the EXPE bit in MDCR must be set to 1 in order to use external addresses. However, as these series have a maximum of 16 address outputs, an external address can be specified correctly only when the I/O strobe function of the $\overline{AS}/\overline{IOS}$ pin is used.

When the EXPE bit in MDCR is set to 1, ports 1, and 2 function as input ports after a reset. They can be set to output addresses by setting the corresponding bits in the data direction register (DDR) to 1. Port 3 function as a data bus, and part of port 9 carries bus control signals.

3.3.3 Mode 3

The CPU can access a 64-kbyte address space in normal mode. The on-chip ROM is enabled. After a reset, single-chip mode is set, and the EXPE bit in MDCR must be set to 1 in order to use external addresses.

When the EXPE bit in MDCR is set to 1, ports 1 and 2 function as input ports after a reset. They can be set to output addresses by setting the corresponding bits in the data direction register (DDR) to 1. Port 3 function as a data bus, and part of port 9 carries bus control signals.

In products with an on-chip ROM capacity of 64 kbytes or more, the amount of on-chip ROM that can be used is limited to 56 kbytes.

3.4 Pin Functions in Each Operating Mode

The pin functions of ports 1 to 3, and 9 vary depending on the operating mode. Table 3.3 shows their functions in each operating mode.

Port		Mode 1	Mode 2	Mode 3
Port 1		А	P*/A	P*/A
Port 2		А	P*/A	P*/A
Port 3		D	P*/D	P*/D
Port 9	P97	P*/C	P*/C	P*/C
	P96	C */P	P*/C	P*/C
	P95 to P93	С	P*/C	P*/C
	P92 to P90	Р	Р	Р

Table 3.3Pin Functions in Each Mode

Legend:

P: I/O port

A: Address bus output

D: Data bus I/O

C: Control signals, clock I/O

*: After reset

3.5 Memory Map in Each Operating Mode

Figures 3.1 to 3.4 show memory maps for each of the operating modes.

The address space is 64 kbytes in modes 1 and 3 (normal modes), and 16 Mbytes in mode 2 (advanced mode).

The on-chip ROM capacity is 32 kbytes (H8S/2130), 64 kbytes (H8S/2132 and H8S/2137), 96 kbytes (H8S/2133), or 128 kbytes (H8S/2134 and H8S/2138), but for products with an on-chip ROM capacity of 64 kbytes or more, the amount of on-chip ROM that can be used is limited to 56 kbytes in mode 3 (normal mode).

For details, see section 6, Bus Controller.

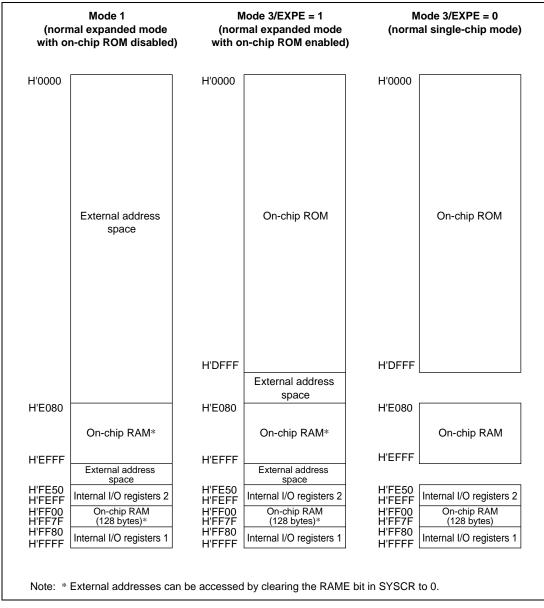


Figure 3.1 H8S/2138 and H8S/2134 Memory Map in Each Operating Mode

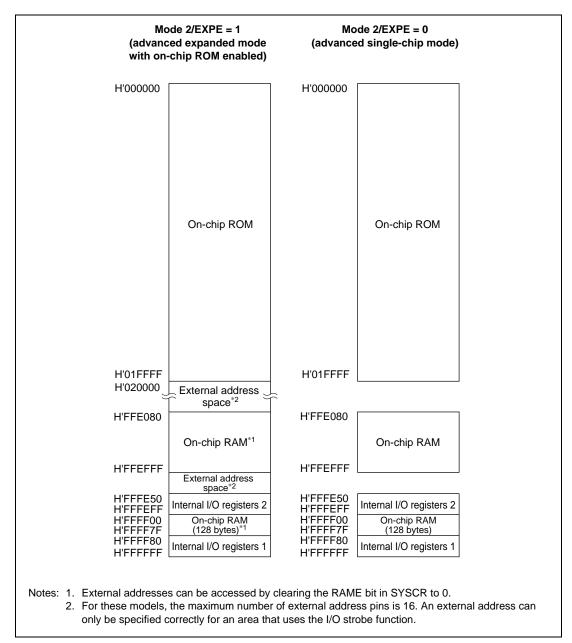


Figure 3.1 H8S/2138 and H8S/2134 Memory Map in Each Operating Mode (cont)

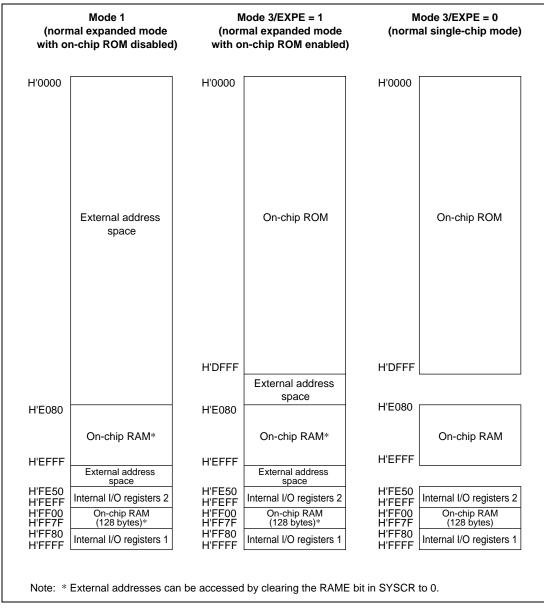


Figure 3.2 H8S/2133 Memory Map in Each Operating Mode

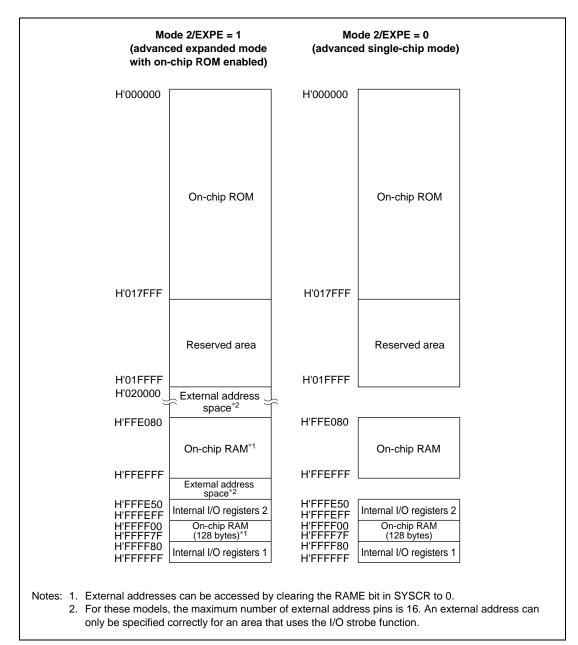


Figure 3.2 H8S/2133 Memory Map in Each Operating Mode (cont)

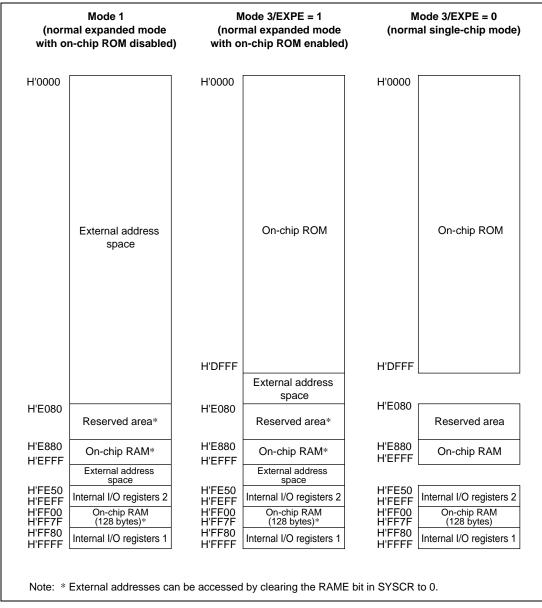


Figure 3.3 H8S/2137 and H8S/2132 Memory Map in Each Operating Mode

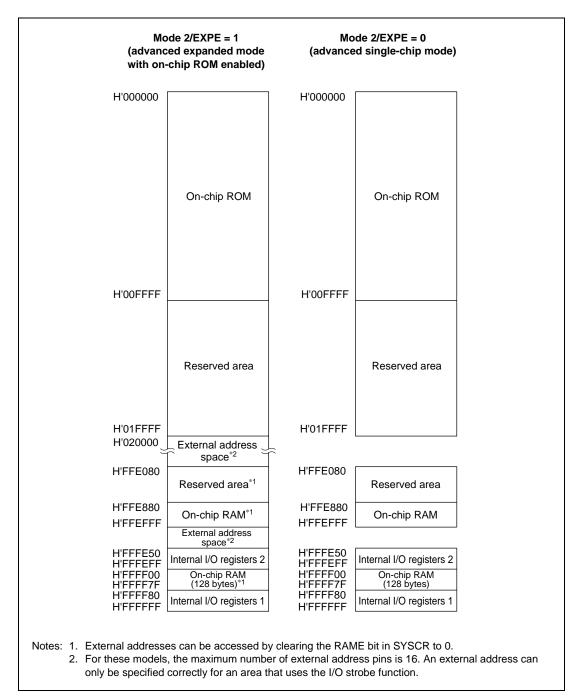


Figure 3.3 H8S/2137 and H8S/2132 Memory Map in Each Operating Mode (cont)

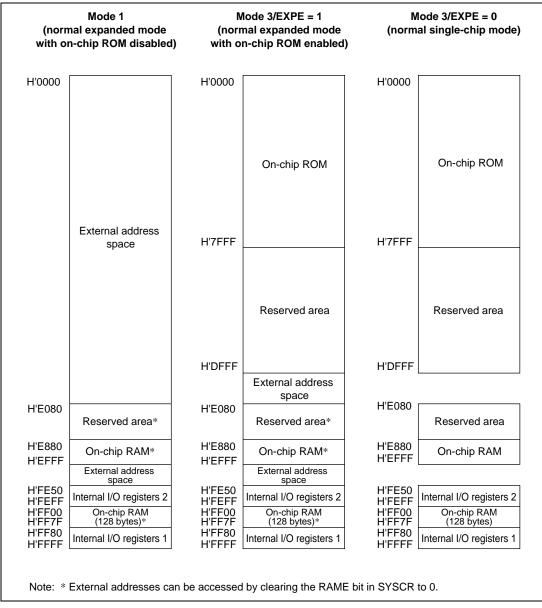


Figure 3.4 H8S/2130 Memory Map in Each Operating Mode

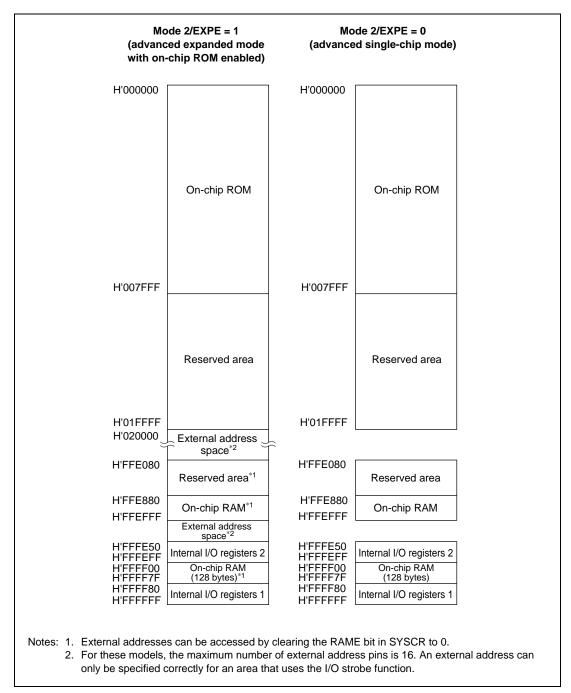


Figure 3.4 H8S/2130 Memory Map in Each Operating Mode (cont)

Section 4 Exception Handling

4.1 Overview

4.1.1 Exception Handling Types and Priority

As table 4.1 indicates, exception handling may be caused by a reset, direct transition, trap instruction, or interrupt. Exception handling is prioritized as shown in table 4.1. If two or more exceptions occur simultaneously, they are accepted and processed in order of priority. Trap instruction exceptions are accepted at all times in the program execution state.

Exception handling sources, the stack structure, and the operation of the CPU vary depending on the interrupt control mode set by the INTM0 and INTM1 bits in SYSCR.

Priority	Exception Type	Start of Exception Handling
High	Reset	Starts immediately after a low-to-high transition at the $\overline{\text{RES}}$ pin, or when the watchdog timer overflows.
	Trace ^{*1}	Starts when execution of the current instruction or exception handling ends, if the trace (T) bit is set to 1.
	Interrupt	Starts when execution of the current instruction or exception handling ends, if an interrupt request has been issued.* ²
	Direct transition	Started by a direct transition resulting from execution of a SLEEP instruction.
Low	Trap instruction (TRAPA)	* ³ Started by execution of a trap instruction (TRAPA).
Notes: 1	•	in interrupt control modes 2 and 3. (They cannot be used in 48S/2134 Series.) Trace exception handling is not executed E instruction.
2	•	performed on completion of ANDC, ORC, XORC, or LDC on completion of reset exception handling.
0	The state of the second st	

Table 4.1Exception Types and Priority

 Trap instruction exception handling requests are accepted at all times in the program execution state.

4.1.2 Exception Handling Operation

Exceptions originate from various sources. Trap instructions and interrupts are handled as follows:

- 1. The program counter (PC) and condition-code register (CCR) are pushed onto the stack.
- 2. The interrupt mask bits are updated. The T bit is cleared to 0.
- 3. A vector address corresponding to the exception source is generated, and program execution starts from that address.

For a reset exception, steps 2 and 3 above are carried out.

4.1.3 Exception Sources and Vector Table

The exception sources are classified as shown in figure 4.1. Different vector addresses are assigned to different exception sources.

Table 4.2 lists the exception sources and their vector addresses.

	Reset
Exception sources	Trace (Cannot be used in the H8S/2138 Series or H8S/2134 Series) Interrupts External interrupts: NMI, IRQ7 to IRQ0 Internal interrupts: interrupt sources in on-chip supporting modules Direct transition Trap instruction

Figure 4.1 Exception Sources

			Vector	Address*1	
Exception Source		Vector Number	Normal Mode	Advanced Mode	
Reset		0	H'0000 to H'0001	H'0000 to H'0003	
Reset Reserved for system use		1	H'0002 to H'0003	H'0004 to H'0007	
		2	H'0004 to H'0006	H'0008 to H'000B	
		3	H'0006 to H'0007	H'000C to H'000F	
		4	H'0008 to H'0009	H'0010 to H'0013	
		5	H'000A to H'000B	H'0014 to H'0017	
Reserved for system use Direct transition External interrupt NMI Trap instruction (4 sources) Reserved for system use		6	H'000C to H'000D	H'0018 to H'001B	
External interrupt	NMI	7	H'000E to H'000F	H'001C to H'001F	
Trap instruction (4	sources)	8	H'0010 to H'0011	H'0020 to H'0023	
		9	H'0012 to H'0013	H'0024 to H'0027	
		10	H'0014 to H'0015	H'0028 to H'002B	
		11	H'0016 to H'0017	H'002C to H'002F	
Reserved for system use		12	H'0018 to H'0019	H'0030 to H'0033	
		13	H'001A to H'001B	H'0034 to H'0037	
		14	H'001C to H'001D	H'0038 to H'003B	
		15	H'001E to H'001F	H'003C to H'003F	
External interrupt	IRQ0	16	H'0020 to H'0021	H'0040 to H'0043	
	IRQ1	17	H'0022 to H'0023	H'0044 to H'0047	
	IRQ2	18	H'0024 to H'0025	H'0048 to H'004B	
	IRQ3	19	H'0026 to H'0027	H'004C to H'004F	
	IRQ4	20	H'0028 to H'0029	H'0050 to H'0053	
	IRQ5	21	H'002A to H'002B	H'0054 to H'0057	
	IRQ6	22	H'002C to H'002D	H'0058 to H'005B	
	IRQ7	23	H'002E to H'002F	H'005C to H'005F	
Internal interrupt*2		24 	H'0030 to H'0031 	H'0060 to H'0063	
		103	H'00CE to H'00CF	H'019C to H'019F	

Table 4.2Exception Vector Table

Notes: 1. Lower 16 bits of the address.

2. For details on internal interrupt vectors, see section 5.3.3, Interrupt Exception Vector Table.

4.2 Reset

4.2.1 Overview

A reset has the highest exception priority.

When the $\overline{\text{RES}}$ pin goes low, all processing halts and the MCU enters the reset state. A reset initializes the internal state of the CPU and the registers of on-chip supporting modules. Immediately after a reset, interrupt control mode 0 is set.

Reset exception handling begins when the $\overline{\text{RES}}$ pin changes from low to high.

H8S/2138 Series and H8S/2134 Series MCUs can also be reset by overflow of the watchdog timer. For details, see section 14, Watchdog Timer.

4.2.2 Reset Sequence

The MCU enters the reset state when the $\overline{\text{RES}}$ pin goes low.

To ensure that the chip is reset, hold the $\overline{\text{RES}}$ pin low for at least 20 ms when powering on. To reset the chip during operation, hold the $\overline{\text{RES}}$ pin low for at least 20 states. For pin states in a reset, see Appendix D.1, Pin States at Reset.

When the $\overline{\text{RES}}$ pin goes high after being held low for the necessary time, the chip starts reset exception handling as follows:

- [1] The internal state of the CPU and the registers of the on-chip supporting modules are initialized, and the I bit is set to 1 in CCR.
- [2] The reset exception vector address is read and transferred to the PC, and program execution starts from the address indicated by the PC.

Figures 4.2 and 4.3 show examples of the reset sequence.

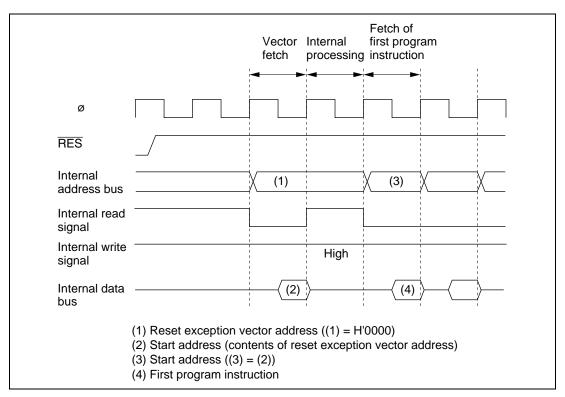


Figure 4.2 Reset Sequence (Mode 3)

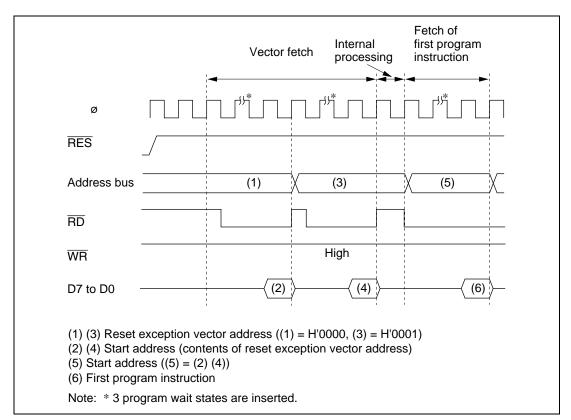


Figure 4.3 Reset Sequence (Mode 1)

4.2.3 Interrupts after Reset

If an interrupt is accepted after a reset but before the stack pointer (SP) is initialized, the PC and CCR will not be saved correctly, leading to a program crash. To prevent this, all interrupt requests, including NMI, are disabled immediately after a reset. Since the first instruction of a program is always executed immediately after the reset state ends, make sure that this instruction initializes the stack pointer (example: MOV.L #xx:32, SP).

4.3 Interrupts

Interrupt exception handling can be requested by nine external sources (NMI and IRQ7 to IRQ0) from 17 input pins (NMI, $\overline{IRQ7}$ to $\overline{IRQ0}$, and $\overline{KIN7}$ to $\overline{KIN0}$), and internal sources in the on-chip supporting modules. Figure 4.4 shows the interrupt sources and the number of interrupts of each type.

The on-chip supporting modules that can request interrupts include the watchdog timer (WDT), 16-bit free-running timer (FRT), 8-bit timer (TMR), serial communication interface (SCI), data transfer controller (DTC), A/D converter (ADC), host interface (HIF), and I²C bus interface (option). Each interrupt source has a separate vector address.

NMI is the highest-priority interrupt. Interrupts are controlled by the interrupt controller. The interrupt controller has two interrupt control modes and can assign interrupts other than NMI to either three priority/mask levels to enable multiplexed interrupt control.

Interrupts Interrupts	WDT* (2) FRT (7) TMR (10) SCI (12)					
	IIC (3) (option)					
	Other (1)					
Note: Numbers in parentheses are the numbers of interrupt sources. * When the watchdog timer is used as an interval timer, it generates an interrupt request at each counter overflow.						

For details on interrupts, see section 5, Interrupt Controller.

Figure 4.4 Interrupt Sources and Number of Interrupts

4.4 Trap Instruction

Trap instruction exception handling starts when a TRAPA instruction is executed. Trap instruction exception handling can be executed at all times in the program execution state.

The TRAPA instruction fetches a start address from a vector table entry corresponding to a vector number from 0 to 3, as specified in the instruction code.

Table 4.3 shows the status of CCR and EXR after execution of trap instruction exception handling.

 Table 4.3
 Status of CCR and EXR after Trap Instruction Exception Handling

		CCR	EXR		
Interrupt Control Mode	I	UI	l2 to l0	Т	
0	1	—	—	_	
1	1	1	—	_	

Legend:

1: Set to 1

0: Cleared to 0

-: Retains value prior to execution.

4.5 Stack Status after Exception Handling

Figure 4.5 shows the stack after completion of trap instruction exception handling and interrupt exception handling.

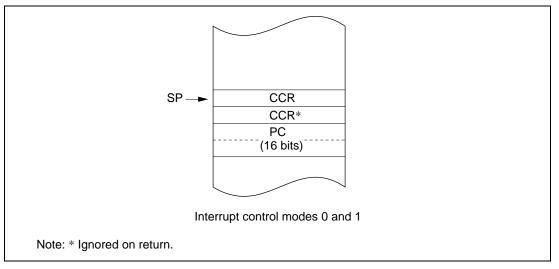


Figure 4.5 (1) Stack Status after Exception Handling (Normal Mode)

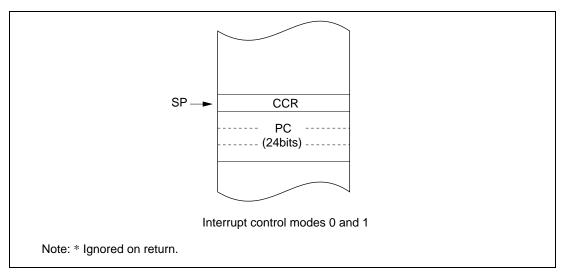


Figure 4.5 (2) Stack Status after Exception Handling (Advanced Mode)

4.6 Notes on Use of the Stack

When accessing word data or longword data, the H8S/2138 Series or H8S/2134 Series chip assumes that the lowest address bit is 0. The stack should always be accessed by word transfer instruction or longword transfer instruction, and the value of the stack pointer (SP: ER7) should always be kept even. Use the following instructions to save registers:

PUSH.W	Rn	(or	MOV.W	Rn,	@-SP)
PUSH.L	ERn	(or	MOV.L	ERn,	@-SP)

Use the following instructions to restore registers:

POP.W	Rn	(or	MOV.W	@SP+,	Rn)
POP.L	ERn	(or	MOV.L	@SP+,	ERn)

Setting SP to an odd value may lead to a malfunction. Figure 4.6 shows an example of what happens when the SP value is odd.

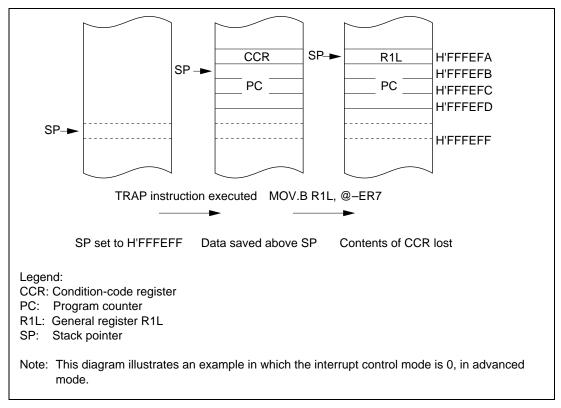


Figure 4.6 Operation when SP Value is Odd

Section 5 Interrupt Controller

5.1 Overview

5.1.1 Features

H8S/2138 Series and H8S/2134 Series MCUs control interrupts by means of an interrupt controller. The interrupt controller has the following features:

- Two interrupt control modes
 - Either of two interrupt control modes can be set by means of the INTM1 and INTM0 bits in the system control register (SYSCR).
- Priorities settable with ICR
 - An interrupt control register (ICR) is provided for setting interrupt priorities. Three priority levels can be set for each module for all interrupts except NMI.
- Independent vector addresses
 - All interrupt sources are assigned independent vector addresses, making it unnecessary for the source to be identified in the interrupt handling routine.
- Fifteen external interrupt pins (nine external sources)
 - NMI is the highest-priority interrupt, and is accepted at all times. A rising or falling edge at the NMI pin can be selected for the NMI interrupt.
 - Falling edge, rising edge, or both edge detection, or level sensing, at pins IRQ7 to IRQ0 can be selected for interrupts IRQ7 to IRQ0.
 - The IRQ6 interrupt is shared by the interrupt from the $\overline{\text{IRQ6}}$ pin and eight external interrupt inputs ($\overline{\text{KIN7}}$ to $\overline{\text{KIN0}}$).
- DTC control
 - DTC activation is controlled by means of interrupts.

5.1.2 Block Diagram

A block diagram of the interrupt controller is shown in Figure 5.1.

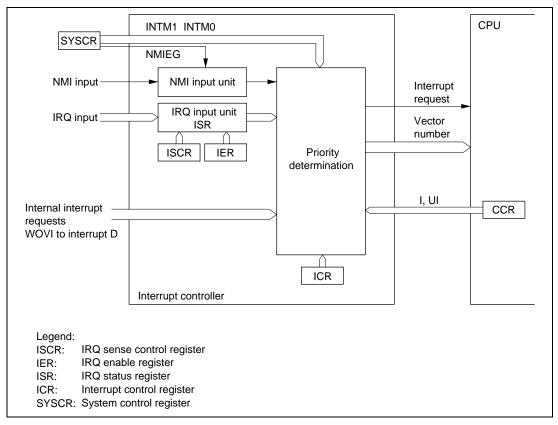


Figure 5.1 Block Diagram of Interrupt Controller

5.1.3 Pin Configuration

Table 5.1 summarizes the pins of the interrupt controller.

Table 5.1	Interrupt Controller Pins
-----------	---------------------------

Name	Symbol	I/O	Function
Nonmaskable interrupt	NMI	Input	Nonmaskable external interrupt; rising or falling edge can be selected
External interrupt requests 7 to 0	IRQ7 to IRQ0	Input	Maskable external interrupts; rising, falling, or both edges, or level sensing, can be selected.
Key input interrupt requests 7 to 0	KIN7 to KIN0	Input	Maskable external interrupts: falling edge or level sensing can be selected.

5.1.4 Register Configuration

Table 5.2 summarizes the registers of the interrupt controller.

Table 5.2 Interrupt Controller Registers

Name	Abbreviation	R/W	Initial Value	Address*1
System control register	SYSCR	R/W	H'09	H'FFC4
IRQ sense control register H	ISCRH	R/W	H'00	H'FEEC
IRQ sense control register L	ISCRL	R/W	H'00	H'FEED
IRQ enable register	IER	R/W	H'00	H'FFC2
IRQ status register	ISR	R/(W)* ²	H'00	H'FEEB
Keyboard matrix interrupt mask register	KMIMR	R/W	H'BF	H'FFF1* ³
Interrupt control register A	ICRA	R/W	H'00	H'FEE8
Interrupt control register B	ICRB	R/W	H'00	H'FEE9
Interrupt control register C	ICRC	R/W	H'00	H'FEEA
Address break control register	ABRKCR	R/W	H'00	H'FEF4
Break address register A	BARA	R/W	H'00	H'FEF5
Break address register B	BARB	R/W	H'00	H'FEF6
Break address register C	BARC	R/W	H'00	H'FEF7

Notes: 1. Lower 16 bits of the address.

2. Only 0 can be written, for flag clearing.

3. When setting KMIMR, the HIE bit in SYSCR must be set to 1.

5.2 **Register Descriptions**

5.2.1 System Control Register (SYSCR)

Bit	7	6	5	4	3	2	1	0
	CS2E	IOSE	INTM1	INTM0	XRST	NMIEG	HIE	RAME
Initial value	0	0	0	0	1	0	0	1
Read/Write	R/W	R/W	R	R/W	R	R/W	R/W	R/W

SYSCR is an 8-bit readable/writable register of which bits 5, 4, and 2 select the interrupt control mode and the detected edge for NMI.

Only bits 5, 4, and 2 are described here; for details on the other bits, see section 3.2.2, System Control Register (SYSCR).

SYSCR is initialized to H'09 by a reset and in hardware standby mode. It is not initialized in software standby mode.

Bits 5 and 4—Interrupt Control Mode 1 and 0 (INTM1, INTM0): These bits select one of four interrupt control modes for the interrupt controller. The INTM1 bit must not be set to 1.

Bit 5	Bit 4	Interrupt	
INTM1	INTM0	Control Mode	Description
0	0	0	Interrupts are controlled by I bit (Initial value)
	1	1	Interrupts are controlled by I and UI bits and ICR
1	0	2	Cannot be used in the H8S/2138 Series or H8S/2134 Series
	1	3	Cannot be used in the H8S/2138 Series or H8S/2134 Series

Bit 2-NMI Edge Select (NMIEG): Selects the input edge for the NMI pin.

Description	
Interrupt request generated at falling edge of NMI input	(Initial value)
Interrupt request generated at rising edge of NMI input	
	Interrupt request generated at falling edge of NMI input

5.2.2 Interrupt Control Registers A to C (ICRA to ICRC)

Bit	7	6	5	4	3	2	1	0
	ICR7	ICR6	ICR5	ICR4	ICR3	ICR2	ICR1	ICR0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W							

The ICR registers are three 8-bit readable/writable registers that set the interrupt control level for interrupts other than NMI.

The correspondence between ICR settings and interrupt sources is shown in table 5.3.

The ICR registers are initialized to H'00 by a reset and in hardware standby mode.

Bit n—Interrupt Control Level (ICRn): Sets the control level for the corresponding interrupt source.

Bit n

ICRn	Description	
0	Corresponding interrupt source is control level 0 (non-priority)	(Initial value)
1	Corresponding interrupt source is control level 1 (priority)	

(n = 7 to 0)

Table 5.3 Correspondence between Interrupt Sources and ICR Settings

	Bits							
Register	7	6	5	4	3	2	1	0
ICRA	IRQ0	IRQ1	IRQ2 IRQ3	IRQ4 IRQ5	IRQ6 IRQ7	DTC	Watchdog timer 0	Watchdog timer 1
ICRB	A/D converter	Free- running timer			8-bit timer channel 0	8-bit timer channel 1	8-bit timer channels X, Y	HIF
ICRC	SCI channel 0	SCI channel 1	SCI channel 2	IIC channel 0 (option)	IIC channel 1 (option)	—	—	_

5.2.3 IRQ Enable Register (IER)

Bit	7	6	5	4	3	2	1	0
	IRQ7E	IRQ6E	IRQ5E	IRQ4E	IRQ3E	IRQ2E	IRQ1E	IRQ0E
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W							

IER is an 8-bit readable/writable register that controls enabling and disabling of interrupt requests IRQ7 to IRQ0.

IER is initialized to H'00 by a reset and in hardware standby mode.

Bits 7 to 0—IRQ7 to IRQ0 Enable (IRQ7E to IRQ0E): These bits select whether IRQ7 to IRQ0 are enabled or disabled.

Bit n		
IRQnE	Description	
0	IRQn interrupt disabled	(Initial value)
1	IRQn interrupt enabled	
		(n = 7 to 0)

5.2.4 IRQ Sense Control Registers H and L (ISCRH, ISCRL)

• ISCRH

Bit	15	14	13	12	11	10	9	8
	IRQ7SCB	IRQ7SCA	IRQ6SCB	IRQ6SCA	IRQ5SCB	IRQ5SCA	IRQ4SCB	IRQ4SCA
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W							
• ISCRL								
Bit	7	6	5	4	3	2	1	0
	IRQ3SCB	IRQ3SCA	IRQ2SCB	IRQ2SCA	IRQ1SCB	IRQ1SCA	IRQ0SCB	IRQ0SCA
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W							

ISCRH and ISCRL are 8-bit readable/writable registers that select rising edge, falling edge, or both edge detection, or level sensing, for the input at pins $\overline{IRQ7}$ to $\overline{IRQ0}$.

Each of the ISCR registers is initialized to H'00 by a reset and in hardware standby mode.

ISCRH Bits 7 to 0, ISCRL Bits 7 to 0: IRQ7 Sense Control A and B (IRQ7SCA, IRQ7SCB) to IRQ0 Sense Control A and B (IRQ0SCA, IRQ0SCB)

ISCRH Bits 7 to 0 ISCRL Bits 7 to 0		
IRQ7SCB to IRQ0SCB	IRQ7SCA to IRQ0SCA	 Description
0	0	Interrupt request generated at IRQ7 to IRQ0 input low level (Initial value)
	1	Interrupt request generated at falling edge of $\overline{\text{IRQ7}}$ to $\overline{\text{IRQ0}}$ input
1	0	Interrupt request generated at rising edge of $\overline{\text{IRQ7}}$ to $\overline{\text{IRQ0}}$ input
	1	Interrupt request generated at both falling and rising edges of IRQ7 to IRQ0 input

5.2.5 IRQ Status Register (ISR)

Bit	7	6	5	4	3	2	1	0
	IRQ7F	IRQ6F	IRQ5F	IRQ4F	IRQ3F	IRQ2F	IRQ1F	IRQ0F
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/(W)*							

Note: * Only 0 can be written, to clear the flag.

ISR is an 8-bit readable/writable register that indicates the status of IRQ7 to IRQ0 interrupt requests.

ISR is initialized to H'00 by a reset and in hardware standby mode.

Bits 7 to 0—IRQ7 to IRQ0 Flags (IRQ7F to IRQ0F): These bits indicate the status of IRQ7 to IRQ0 interrupt requests.

Bit n

IRQnF	 Description									
0	[Clearing conditions] (Initial value)									
	• Cleared by reading IRQnF when set to 1, then writing 0 in IRQnF									
	 When interrupt exception handling is executed when low-level det (IRQnSCB = IRQnSCA = 0) and IRQn input is high 	ection is set								
	 When IRQn interrupt exception handling is executed when falling, edge detection is set (IRQnSCB = 1 or IRQnSCA = 1) 	rising, or both-								
1	[Setting conditions]									
	 When IRQn input goes low when low-level detection is set (IRQnS 0) 	SCB = IRQnSCA =								
	 When a falling edge occurs in IRQn input when falling edge detec (IRQnSCB = 0, IRQnSCA = 1) 	tion is set								
	 When a rising edge occurs in IRQn input when rising edge detecti (IRQnSCB = 1, IRQnSCA = 0) 	on is set								
	 When a falling or rising edge occurs in IRQn input when both-edg (IRQnSCB = IRQnSCA = 1) 	e detection is set								

(n = 7 to 0)

5.2.6 Keyboard Matrix Interrupt Mask Register (KMIMR)

Bit	7	6	5	4	3	2	1	0
	KMIMR7	KMIMR6	KMIMR5	KMIMR4	KMIMR3	KMIMR2	KMIMR1	KMIMR0
Initial value	1	0	1	1	1	1	1	1
Read/Write	R/W							

KMIMR is an 8-bit readable/writable register that performs mask control for the keyboard matrix interrupt inputs (pins $\overline{\text{KIN7}}$ to $\overline{\text{KIN0}}$). To enable key-sense input interrupts from multiple pin inputs in keyboard matrix scanning/sensing, clear the corresponding mask bits to 0.

KMIMR is initialized to H'BF by a reset and in hardware standby mode.

Bits 7 to 0—Keyboard Matrix Interrupt Mask (KMIMR7 to KMIMR0): These bits control key-sense input interrupt requests (KIN7 to KIN0).

Bits 7 to 0		
KMIMR7 to KMIMR0	o Description	
0	Key-sense input interrupt requests enabled	
1	Key-sense input interrupt requests disabled	(Initial value)*
Note: *Ho	waver the initial value of KMIMR6 is 0	

Note: *However, the initial value of KMIMR6 is 0.

Figure 5.2 shows the relationship between interrupts IRQ6, interrupts KIN7 to KIN0, and registers KMIMR.

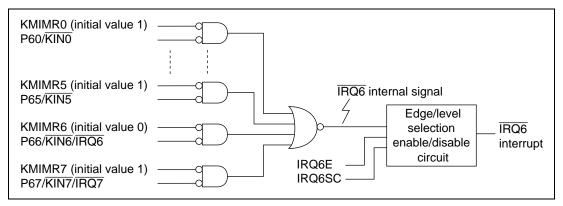


Figure 5.2 Relationship between Interrupts IRQ6, Interrupts KIN7 to KIN0, and Registers KMIMR

When pins $\overline{\text{KIN7}}$ to $\overline{\text{KIN0}}$ are used as key-sense interrupt input pins, either low-level sensing or falling-edge sensing must be designated as the interrupt sense condition for the corresponding interrupt source (IRQ6).

5.2.7 Address Break Control Register (ABRKCR)

Bit	7	6	5	4	3	2	1	0
	CMF	_	_			_	_	BIE
Initial value	0	0	0	0	0	0	0	0
Read/Write	R	_	_	_	_	_	_	R/W

ABRKCR is an 8-bit readable/writable register that performs address break control.

ABRKCR is initialized to H'00 by a reset and in hardware standby mode. It is not initialized in software standby mode.

Bit 7—Condition Match Flag (CMF): This is the address break source flag, used to indicate that the address set by BAR has been prefetched. When the CMF flag and BIE flag are both set to 1, an address break is requested.

Bit 7

CMF	Description	
0	[Clearing condition] When address break interrupt exception handling is executed	(Initial value)
1	[Setting condition] When address set by BARA to BARC is prefetched while BIE = 1	

Bits 6 to 1—Reserved: These bits cannot be modified and are always read as 0.

Bit 0—Break Interrupt Enable (BIE): Selects address break enabling or disabling.

Bit 0		
BIE	Description	
0	Address break disabled	(Initial value)
1	Address break enabled	

Bit	7	6	5	4	3	2	1	0
BARA	A23	A22	A21	A20	A19	A18	A17	A16
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W							
Bit	7	6	5	4	3	2	1	0
BARB	A15	A14	A13	A12	A11	A10	A9	A8
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W							
Bit	7	6	5	4	3	2	1	0
BARC	A7	A6	A5	A4	A3	A2	A1	—
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	—						

5.2.8 Break Address Registers A, B, C (BARA, BARB, BARC)

BAR consists of three 8-bit readable/writable registers (BARA, BARB, and BARC), and is used to specify the address at which an address break is to be executed.

Each of the BAR registers is initialized to H'00 by a reset and in hardware standby mode. They are not initialized in software standby mode.

BARA Bits 7 to 0—Address 23 to 16 (A23 to A16) BARB Bits 7 to 0—Address 15 to 8 (A15 to A8) BARC Bits 7 to 1—Address 7 to 1 (A7 to A1)

These bits specify the address at which an address break is to be executed. BAR bits A15 to A1 are compared with internal address bus lines A15 to A1, respectively.

The address at which the first instruction byte is located should be specified as the break address. Occurrence of the address break condition may not be recognized for other addresses.

In normal mode, no comparison is made with address lines A23 to A16.

BARC Bit 0—Reserved: This bit cannot be modified and is always read as 0.

5.3 Interrupt Sources

Interrupt sources comprise external interrupts (NMI and IRQ7 to IRQ0) and internal interrupts.

5.3.1 External Interrupts

There are nine external interrupt sources from 17 input pins (15 actual pins): NMI, $\overline{IRQ7}$ to $\overline{IRQ0}$, and $\overline{KIN7}$ to $\overline{KIN0}$. KIN7 to KIN0 share the IRQ6 interrupt source. Of these, NMI, IRQ7, IRQ6, and IRQ2 to IRQ0 can be used to restore the H8S/2138 Series or H8S/2134 Series chip from software standby mode.

NMI Interrupt: NMI is the highest-priority interrupt, and is always accepted by the CPU regardless of the interrupt control mode and the status of the CPU interrupt mask bits. The NMIEG bit in SYSCR can be used to select whether an interrupt is requested at a rising edge or a falling edge on the NMI pin.

The vector number for NMI interrupt exception handling is 7.

IRQ7 to IRQ0 Interrupts: Interrupts IRQ7 to IRQ0 are requested by an input signal at pins $\overline{\text{IRQ7}}$ to $\overline{\text{IRQ0}}$. Interrupts IRQ7 to IRQ0 have the following features:

- Using ISCR, it is possible to select whether an interrupt is generated by a low level, falling edge, rising edge, or both edges, at pins IRQ7 to IRQ0.
- Enabling or disabling of interrupt requests IRQ7 to IRQ0 can be selected with IER.
- The interrupt control level can be set with ICR.
- The status of interrupt requests IRQ7 to IRQ0 is indicated in ISR. ISR flags can be cleared to 0 by software.

A block diagram of interrupts IRQ7 to IRQ0 is shown in figure 5.3.

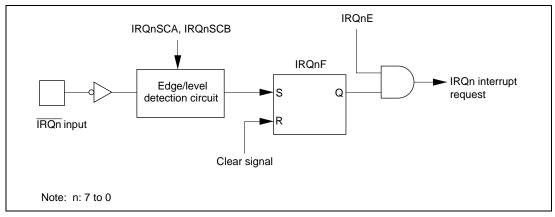


Figure 5.3 Block Diagram of Interrupts IRQ7 to IRQ0

110

Figure 5.4 shows the timing of IRQnF setting.

ø	
IRQn input pin	_
IRQnF	_

Figure 5.4 Timing of IRQnF Setting

The vector numbers for IRQ7 to IRQ0 interrupt exception handling are 23 to 16.

Detection of IRQ7 to IRQ0 interrupts does not depend on whether the relevant pin has been set for input or output. Therefore, when a pin is used as an external interrupt input pin, do not clear the corresponding DDR bit to 0 and use the pin as an I/O pin for another function.

As interrupt request flags IRQ7F to IRQ0F are set when the setting condition is met, regardless of the IER setting, only the necessary flags should be referenced.

Interrupts KIN7 to KIN0: Interrupts KIN7 to KIN0 are requested by input signals at pins $\overline{\text{KIN7}}$ to $\overline{\text{KIN0}}$. When any of pins $\overline{\text{KIN7}}$ to $\overline{\text{KIN0}}$ are used as key-sense inputs, the corresponding KMIMR bits should be cleared to 0 to enable those key-sense input interrupts. The remaining unused key-sense input KMIMR bits should be set to 1 to disable those interrupts. Interrupts KIN7 to KIN0 correspond to the IRQ6 interrupt. Interrupt request generation pin conditions, interrupt request enabling, interrupt control level setting, and interrupt request status indications, are all in accordance with the IRQ6 interrupt settings.

When pins $\overline{\text{KIN7}}$ to $\overline{\text{KIN0}}$ are used as key-sense interrupt input pins, either low-level sensing or falling-edge sensing must be designated as the interrupt sense condition for the corresponding interrupt source (IRQ6).

5.3.2 Internal Interrupts

There are 38 sources for internal interrupts from on-chip supporting modules, plus one software interrupt source (PC break).

- For each on-chip supporting module there are flags that indicate the interrupt request status, and enable bits that select enabling or disabling of these interrupts. If any one of these is set to 1, an interrupt request is issued to the interrupt controller.
- The interrupt control level can be set by means of ICR.
- The DTC can be activated by an FRT, TMR, SCI, or other interrupt request. When the DTC is activated by an interrupt, the interrupt control mode and interrupt mask bits have no effect.

5.3.3 Interrupt Exception Vector Table

Table 5.4 shows interrupt exception handling sources, vector addresses, and interrupt priorities. For default priorities, the lower the vector number, the higher the priority.

Priorities among modules can be set by means of ICR. The situation when two or more modules are set to the same priority, and priorities within a module, are fixed as shown in table 5.4.

	Origin of		Vecto	or Address		
Interrupt Source	Interrupt Source	Vector Number	Normal Mode			Priorit y
NMI	External	7	H'000E	H'00001C		High
IRQ0	pin	16	H'0020	H'000040	ICRA7	_
IRQ1		17	H'0022	H'000044	ICRA6	_
IRQ2 IRQ3		18 19	H'0024 H'0026	H'000048 H'00004C	ICRA5	—
IRQ4 IRQ5		20 21	H'0028 H'002A	H'000050 H'000054	ICRA4	—
IRQ6, KIN7 to KIN0 IRQ7		22 23	H'002C H'002E	H'000058 H'00005C	ICRA3	—
SWDTEND (software activation interrupt end)	DTC	24	H'0030	H'000060	ICRA2	—
WOVI0 (interval timer)	Watchdog timer 0	25	H'0032	H'000064	ICRA1	—
WOVI1 (interval timer)	Watchdog timer 1	26	H'0034	H'000068	ICRA0	—
PC break	_	27	H'0036	H'00006C		_
ADI (A/D conversion end)	A/D	28	H'0038	H'000070	ICRB7	_
Reserved	_	29	H'003A	H'000074		_
		to 47	to H'005E	to H'0000BC		
ICIA (input capture A) ICIB (input capture B) ICIC (input capture C) ICID (input capture D) OCIA (output compare A) OCIB (output compare B) FOVI (overflow) Reserved Reserved	Free-running timer	48 49 50 51 52 53 54 55 56	H'0060 H'0062 H'0064 H'0066 H'0068 H'006A H'006C H'006E H'0070	H'0000C0 H'0000C4 H'0000C8 H'0000CC H'0000D0 H'0000D4 H'0000D8 H'0000DC H'0000E0	ICRB6	_
		to 63	to H'007E	to H'0000FC		Low

Table 5.4 Interrupt Sources, Vector Addresses, and Interrupt Priorities

	Origin of		Vecto			
Interrupt Source	Interrupt Source	Vector Number	Normal Mode	Advanced Mode	ICR	Priority
CMIA0 (compare-match A) CMIB0 (compare-match B) OVI0 (overflow) Reserved	8-bit timer channel 0	64 65 66 67	H'0080 H'0082 H'0084 H'0086	H'000100 H'000104 H'000108 H'00010C	ICRB3	High
CMIA1 (compare-match A) CMIB1 (compare-match B) OVI1 (overflow) Reserved	8-bit timer channel 1	68 69 70 71	H'0088 H'008A H'008C H'008E	H'000110 H'000114 H'000118 H'00011C	ICRB2	-
CMIAY (compare-match A) CMIBY (compare-match B) OVIY (overflow) ICIX (input capture X)	8-bit timer channels Y, X	72 73 74 75	H'0090 H'0092 H'0094 H'0096	H'000120 H'000124 H'000128 H'00012C	ICRB1	-
IBF1 (IDR1 reception completed) IBF2 (IDR2 reception completed) Reserved Reserved		76 77 78 79	H'0098 H'009A H'009C H'009E	H'000130 H'000134 H'000138 H'00013C	ICRB0	-
ERI0 (receive error 0) RXI0 (reception completed 0) TXI0 (transmit data empty 0) TEI0 (transmission end 0)	SCI channel 0	80 81 82 83	H'00A0 H'00A2 H'00A4 H'00A6	H'000140 H'000144 H'000148 H'00014C	ICRC7	-
ERI1 (receive error 1) RXI1 (reception completed 1) TXI1 (transmit data empty 1) TEI1 (transmission end 1)	SCI channel 1	84 85 86 87	H'00A8 H'00AA H'00AC H'00AE	H'000150 H'000154 H'000158 H'00015C	ICRC6	-
ERI2 (receive error 2) RXI2 (reception completed 2) TXI2 (transmit data empty 2) TEI2 (transmission end 2)	SCI channel 2	88 89 90 91	H'00B0 H'00B2 H'00B4 H'00B6	H'000160 H'000164 H'000168 H'00016C	ICRC5	-
IICI0 (1-byte transmission/ reception completed) DDCSWI (format switch)	IIC channel 0 (option)	92 93	H'00B8 H'00BA	H'000170 H'000174	ICRC4	-
IICI1 (1-byte transmission/ reception completed) Reserved	IIC channel 1 (option)	94 95	H'00BC H'00BE	H'000178 H'00017C	ICRC3	-
Reserved	_	96 to 103	H'00C0 to H'00CE	H'000180 to H'00019C		Low

Table 5.4 Interrupt Sources, Vector Addresses, and Interrupt Priorities (cont)

5.4 Address Breaks

5.4.1 Features

With the H8S/2138 Series and H8S/2134 Series, it is possible to identify the prefetch of a specific address by the CPU and generate an address break interrupt, using the ABRKCR and BAR registers. When an address break interrupt is generated, address break interrupt exception handling is executed.

This function can be used to detect the beginning of execution of a bug location in the program, and branch to a correction routine.

5.4.2 Block Diagram

A block diagram of the address break function is shown in figure 5.5.

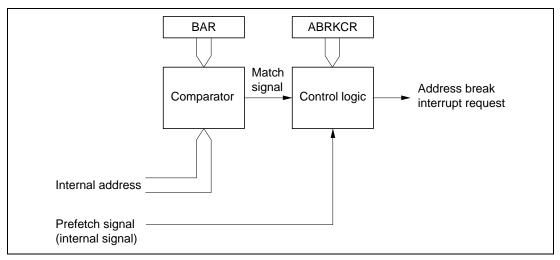


Figure 5.5 Block Diagram of Address Break Function

5.4.3 Operation

ABRKCR and BAR settings can be made so that an address break interrupt is generated when the CPU prefetches the address set in BAR. This address break function issues an interrupt request to the interrupt controller when the address is prefetched, and the interrupt controller determines the interrupt priority. When the interrupt is accepted, interrupt exception handling is started on completion of the currently executing instruction. With an address break interrupt, interrupt mask control by the I and UI bits in the CPU's CCR is ineffective.

The register settings when the address break function is used are as follows.

- 1. Set the break address in bits A23 to A1 in BAR.
- 2. Set the BIE bit in ABRKCR to 1 to enable address breaks. An address break will not be requested if the BIE bit is cleared to 0.

When the setting condition occurs, the CMF flag in ABRKCR is set to 1 and an interrupt is requested. If necessary, the source should be identified in the interrupt handling routine.

5.4.4 Usage Notes

- 1. With the address break function, the address at which the first instruction byte is located should be specified as the break address. Occurrence of the address break condition may not be recognized for other addresses.
- 2. In normal mode, no comparison is made with address lines A23 to A16.
- 3. If a branch instruction (Bcc, BSR), jump instruction (JMP, JSR), RTS instruction, or RTE instruction is located immediately before the address set in BAR, execution of this instruction will output a prefetch signal for that address, and an address break may be requested. This can be prevented by not making a break address setting for an address immediately following one of these instructions, or by determining within the interrupt handling routine whether interrupt handling was initiated by a genuine condition occurrence.
- 4. As an address break interrupt is generated by a combination of the internal prefetch signal and address, the timing of the start of interrupt exception handling depends on the content and execution cycle of the instruction at the set address and the preceding instruction. Figure 5.6 shows some address timing examples.

I	nstruction Instruction Ir fetch fetch	nstruction Instruction Ins fetch fetch	truction Internal fetch , operation ,	Ctask source	Vector	Internal Instru operation fet	uction
				Stack save			
ø							
Address bus	KH'0310 H'0312	H'0314 H'0316	H'0318	SP-2 SP	-4 Х н	1'0036	
	NOP	NOP NOP		Interrupt exce	eption handling	9	-
Break request signal	execution	execution execution					
	H'0310 NO H'0312 NO H'0314 NO H'0316 NO	P 🗕 Break	next add	ruction is execute ress, H'0314; feto cception handling	h from addre		
Program area i	n on-chip memo	ory, 2-state exec	ution instructi	on at specifie	ed break a	address	
	Instruction Instruction fetch fetch	Instruction Instruction fetch fetch	Instruction Internation		Vec		Instruction fetch
ø							
Address bus	X H'0310 X H'0312	X H'0314 X H'0316	H'0318	SP-2	SP-4	H'0036	χ
	NOP	MOV.W execution	•	Interrupt ex	ception handli	ing	►
Break request	execution.						
	H'0310 NOP H'0312 MOV.W H'0316 NOP H'0318 NOP	#xx:16,Rd	. NO	OV instruction is OP instruction at the from address	next address	, H'0316, is not	executed;
		ory (2-state acce specified break		s access),			
	Instruction fetch	Instruction fetch	Instruction fetch	Internal operation St	ack save	Vector fetch	Internal operation
ø							
Address bus	H'0310	H'0312	H'0314	X SP-	-2 SP-4	Н'0036	χ
		NOP execution		Interrupt	exception hand	dling	
Break request							
	H'0310 NOP						

Figure 5.6 Examples of Address Break Timing

5.5 Interrupt Operation

5.5.1 Interrupt Control Modes and Interrupt Operation

Interrupt operations in the H8S/2138 Series and H8S/2134 Series differ depending on the interrupt control mode.

NMI interrupts are accepted at all times except in the reset state and the hardware standby state. In the case of IRQ interrupts and on-chip supporting module interrupts, an enable bit is provided for each interrupt. Clearing an enable bit to 0 disables the corresponding interrupt request. Interrupt sources for which the enable bits are set to 1 are controlled by the interrupt controller.

Table 5.5 shows the interrupt control modes.

The interrupt controller performs interrupt control according to the interrupt control mode set by the INTM1 and INTM0 bits in SYSCR, the priorities set in ICR, and the masking state indicated by the I and UI bits in the CPU's CCR.

Interrupt	SYSCR INTM1 INTM0		Priority Setting	Interrupt	
Control Mode			Register	Mask Bits	Description
0	0	0	ICR	I	Interrupt mask control is performed by the I bit
					Priority can be set with ICR
1 1		ICR	I, UI	3-level interrupt mask control is performed by the I and UI bits	
					Priority can be set with ICR

Table 5.5 Interrupt Control Modes

Figure 5.7 shows a block diagram of the priority decision circuit.

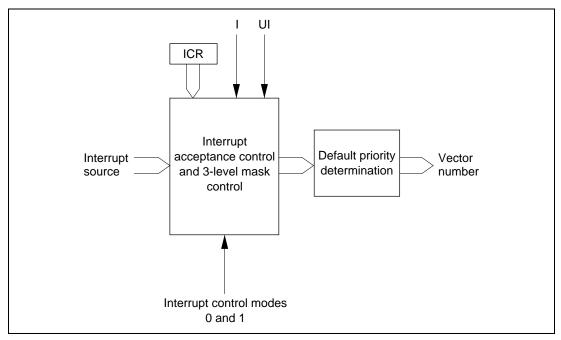


Figure 5.7 Block Diagram of Interrupt Control Operation

Interrupt Acceptance Control and 3-Level Control: In interrupt control modes 0 and 1, interrupt acceptance control and 3-level mask control is performed by means of the I and UI bits in CCR, and ICR (control level).

Table 5.6 shows the interrupts selected in each interrupt control mode.

Table 5.6 Interrupts Selected in Each Interrupt Control Mode (1)

	Interru	upt Mask Bits			
Interrupt Control Mode	I	UI	Selected Interrupts		
0	0	*	All interrupts (control level 1 has priority)		
	1	*	NMI interrupts		
1	0	*	All interrupts (control level 1 has priority)		
	1	0	NMI and control level 1 interrupts		
		1	NMI interrupts		

Legend:

*: Don't care

Default Priority Determination: The priority is determined for the selected interrupt, and a vector number is generated.

If the same value is set for ICR, acceptance of multiple interrupts is enabled, and so only the interrupt source with the highest priority according to the preset default priorities is selected and has a vector number generated.

Interrupt sources with a lower priority than the accepted interrupt source are held pending.

Table 5.7 shows operations and control signal functions in each interrupt control mode.

 Table 5.7
 Operations and Control Signal Functions in Each Interrupt Control Mode

Interrupt	Se	tting	In	•	cceptance evel Contr		Default Priority	
Control Mode	INTM1	INTM0		I	UI	ICR	Determination	T (Trace)
0	0	0	0	IM	—	PR	0	_
1		1	0	IM	IM	PR	0	_

Legend:

O: Interrupt operation control performed

IM: Used as interrupt mask bit

PR: Sets priority

-: Not used

5.5.2 Interrupt Control Mode 0

Enabling and disabling of IRQ interrupts and on-chip supporting module interrupts can be set by means of the I bit in the CPU's CCR, and ICR. Interrupts are enabled when the I bit is cleared to 0, and disabled when set to 1. Control level 1 interrupt sources have higher priority.

Figure 5.8 shows a flowchart of the interrupt acceptance operation in this case.

- 1. If an interrupt source occurs when the corresponding interrupt enable bit is set to 1, an interrupt request is sent to the interrupt controller.
- 2. When interrupt requests are sent to the interrupt controller, a control level 1 interrupt, according to the control level set in ICR, has priority for selection, and other interrupt requests are held pending. If a number of interrupt requests with the same control level setting are generated at the same time, the interrupt request with the highest priority according to the priority system shown in table 5.4 is selected.
- 3. The I bit is then referenced. If the I bit is cleared to 0, the interrupt request is accepted. If the I bit is set to 1, only NMI and address break interrupts are accepted, and other interrupt requests are held pending.
- 4. When an interrupt request is accepted, interrupt exception handling starts after execution of the current instruction has been completed.
- 5. The PC and CCR are saved to the stack area by interrupt exception handling. The PC saved on the stack shows the address of the first instruction to be executed after returning from the interrupt handling routine.
- 6. Next, the I bit in CCR is set to 1. This disables all interrupts except NMI and address break interrupts.
- 7. A vector address is generated for the accepted interrupt, and execution of the interrupt handling routine starts at the address indicated by the contents of that vector address.

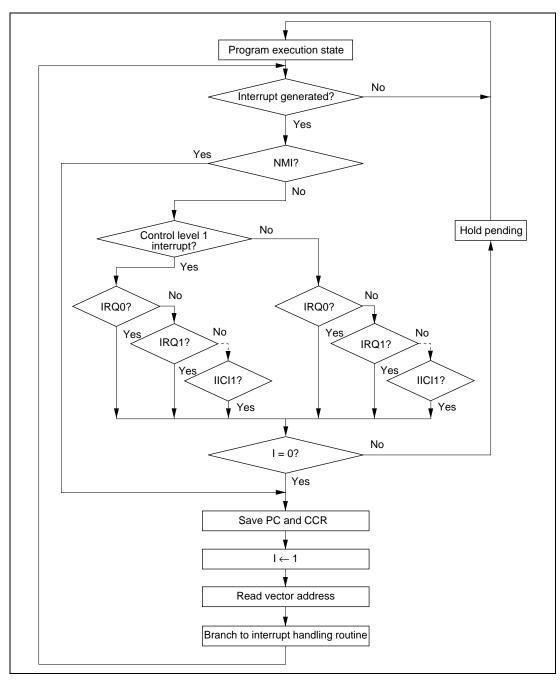


Figure 5.8 Flowchart of Procedure Up to Interrupt Acceptance in Interrupt Control Mode 0

5.5.3 Interrupt Control Mode 1

Three-level masking is implemented for IRQ interrupts and on-chip supporting module interrupts by means of the I and UI bits in the CPU's CCR, and ICR.

- Control level 0 interrupt requests are enabled when the I bit is cleared to 0, and disabled when set to 1.
- Control level 1 interrupt requests are enabled when the I bit or UI bit is cleared to 0, and disabled when both the I bit and the UI bit are set to 1.

For example, if the interrupt enable bit for an interrupt request is set to 1, and H'20, H'00, and H'00 are set in ICRA, ICRB, and ICRC, respectively, (i.e. IRQ2 and IRQ3 interrupts are set to control level 1 and other interrupts to control level 0), the situation is as follows:

- When I = 0, all interrupts are enabled
- (Priority order: NMI > IRQ2 > IRQ3 > IRQ0 > IRQ1 ...)
- When I = 1 and UI = 0, only NMI, IRQ2, and IRQ3 interrupts are enabled
- When I = 1 and UI = 1, only NMI interrupts are enabled

Figure 5.9 shows the state transitions in these cases.

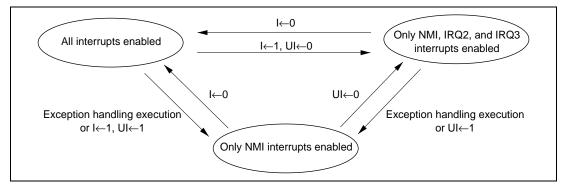


Figure 5.9 Example of State Transitions in Interrupt Control Mode 1

Figure 5.10 shows a flowchart of the interrupt acceptance operation in this case.

- 1. If an interrupt source occurs when the corresponding interrupt enable bit is set to 1, an interrupt request is sent to the interrupt controller.
- 2. When interrupt requests are sent to the interrupt controller, a control level 1 interrupt, according to the control level set in ICR, has priority for selection, and other interrupt requests are held pending. If a number of interrupt requests with the same control level setting are generated at the same time, the interrupt request with the highest priority according to the priority system shown in table 5.4 is selected.
- 3. The I bit is then referenced. If the I bit is cleared to 0, the UI bit has no effect.

An interrupt request set to interrupt control level 0 is accepted when the I bit is cleared to 0. If the I bit is set to 1, only an NMI interrupt is accepted, and other interrupt requests are held pending.

An interrupt request set to interrupt control level 1 has priority over an interrupt request set to interrupt control level 0, and is accepted if the I bit is cleared to 0, or if the I bit is set to 1 and the UI bit is cleared to 0.

When both the I bit and the UI bit are set to 1, only an NMI interrupt is accepted, and other interrupt requests are held pending.

- 4. When an interrupt request is accepted, interrupt exception handling starts after execution of the current instruction has been completed.
- 5. The PC and CCR are saved to the stack area by interrupt exception handling. The PC saved on the stack shows the address of the first instruction to be executed after returning from the interrupt handling routine.
- 6. Next, the I and UI bits in CCR are set to 1. This disables all interrupts except NMI.
- 7. A vector address is generated for the accepted interrupt, and execution of the interrupt handling routine starts at the address indicated by the contents of that vector address.

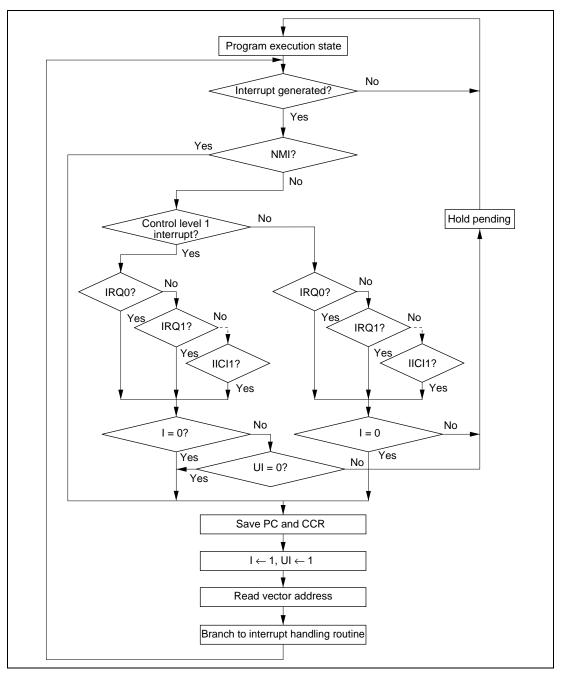


Figure 5.10 Flowchart of Procedure Up to Interrupt Acceptance in Interrupt Control Mode 1

5.5.4 Interrupt Exception Handling Sequence

Figure 5.11 shows the interrupt exception handling sequence. The example shown is for the case where interrupt control mode 0 is set in advanced mode, and the program area and stack area are in on-chip memory.

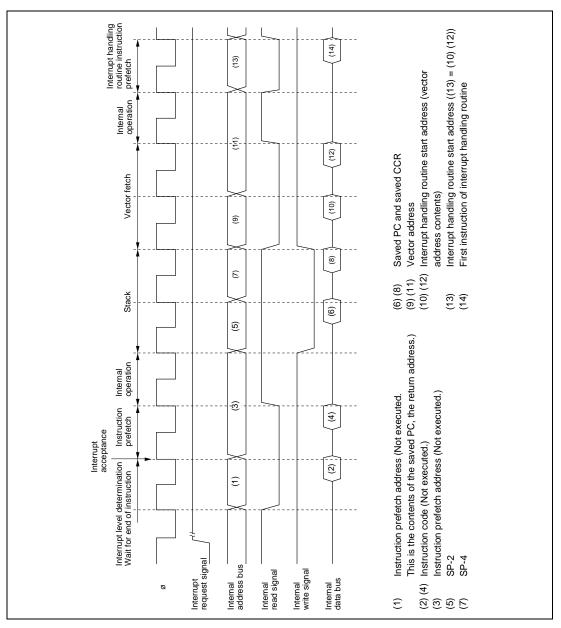


Figure 5.11 Interrupt Exception Handling

5.5.5 Interrupt Response Times

The H8S/2138 Series and H8S/2134 Series are capable of fast word access to on-chip memory, and high-speed processing can be achieved by providing the program area in on-chip ROM and the stack area in on-chip RAM.

Table 5.8 shows interrupt response times—the interval between generation of an interrupt request and execution of the first instruction in the interrupt handling routine. The symbols used in table 5.8 are explained in table 5.9.

		Number of States				
No.	Item	Normal Mode	Advanced Mode			
1	Interrupt priority determination*1	3	3			
2	Number of wait states until executing instruction ends* ²	1 to 19+2·S	1 to 19+2·S			
3	PC, CCR stack save	2·S _κ	2·S _κ			
4	Vector fetch	S,	2·S,			
5	Instruction fetch* ³	2.S	2.S			
6	Internal processing*4	2	2			
Total	(using on-chip memory)	11 to 31	12 to 32			

Table 5.8 Interrupt Response Times

Notes: 1. Two states in case of internal interrupt.

2. Refers to MULXS and DIVXS instructions.

3. Prefetch after interrupt acceptance and interrupt handling routine prefetch.

4. Internal processing after interrupt acceptance and internal processing after vector fetch.

Table 5.9 Number of States in Interrupt Handling Routine Execution

		Object of Access				
			External Device 8-Bit Bus			
	Symbol					
		Internal Memory	2-State Access	3-State Access		
Instruction fetch	S,	1	4	6+2m		
Branch address read	S					
Stack manipulation	S _κ					

Legend:

m: Number of wait states in an external device access

5.6 Usage Notes

5.6.1 Contention between Interrupt Generation and Disabling

When an interrupt enable bit is cleared to 0 to disable interrupts, the disabling becomes effective after execution of the instruction.

In other words, when an interrupt enable bit is cleared to 0 by an instruction such as BCLR or MOV, if an interrupt is generated during execution of the instruction, the interrupt concerned will still be enabled on completion of the instruction, and so interrupt exception handling for that interrupt will be executed on completion of the instruction. However, if there is an interrupt request of higher priority than that interrupt, interrupt exception handling will be executed for the higher-priority interrupt, and the lower-priority interrupt will be ignored.

The same also applies when an interrupt source flag is cleared to 0.

Figure 5.12 shows an example in which the CMIEA bit in 8-bit timer register TCR is cleared to 0.

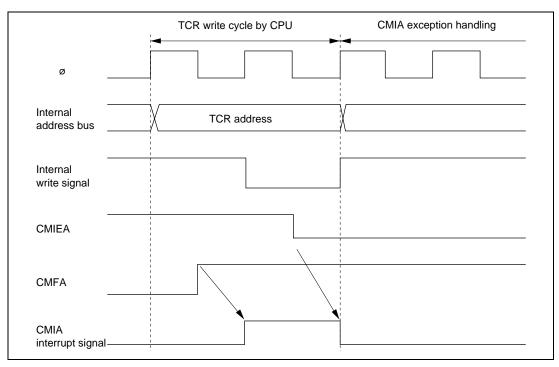


Figure 5.12 Contention between Interrupt Generation and Disabling

The above contention will not occur if an enable bit or interrupt source flag is cleared to 0 while the interrupt is masked.

5.6.2 Instructions that Disable Interrupts

Instructions that disable interrupts are LDC, ANDC, ORC, and XORC. After any of these instructions is executed, all interrupts, including NMI, are disabled, and the next instruction is always executed. When the I bit or UI bit is set by one of these instructions, the new value becomes valid two states after execution of the instruction ends.

5.6.3 Interrupts during Execution of EEPMOV Instruction

Interrupt operation differs between the EEPMOV.B instruction and the EEPMOV.W instruction.

With the EEPMOV.B instruction, an interrupt request (including NMI) issued during the transfer is not accepted until the move is completed.

With the EEPMOV.W instruction, if an interrupt request is issued during the transfer, interrupt exception handling starts at a break in the transfer cycle. The PC value saved on the stack in this case is the address of the next instruction.

Therefore, if an interrupt is generated during execution of an EEPMOV.W instruction, the following coding should be used.

L1: EEPMOV.W MOV.W R4,R4 BNE L1

5.7 DTC Activation by Interrupt

5.7.1 Overview

The DTC can be activated by an interrupt. In this case, the following options are available:

- Interrupt request to CPU
- Activation request to DTC
- Both of the above

For details of interrupt requests that can be used to activate the DTC, see section 7, Data Transfer Controller.

5.7.2 Block Diagram

Figure 5.13 shows a block diagram of the DTC and interrupt controller.

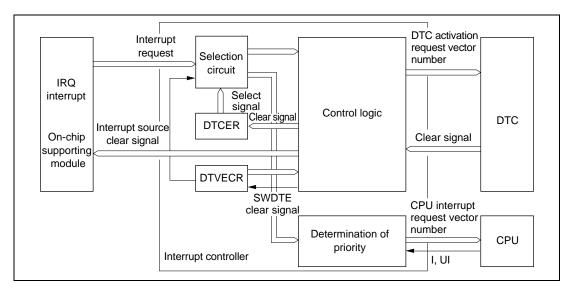


Figure 5.13 Interrupt Control for DTC

5.7.3 Operation

The interrupt controller has three main functions in DTC control.

Selection of Interrupt Source: It is possible to select DTC activation request or CPU interrupt request with the DTCE bit of DTCERA to DTCERE in the DTC.

After a DTC data transfer, the DTCE bit can be cleared to 0 and an interrupt request sent to the CPU in accordance with the specification of the DISEL bit of MRB in the DTC.

When the DTC performs the specified number of data transfers and the transfer counter reaches 0, following the DTC data transfer the DTCE bit is cleared to 0 and an interrupt request is sent to the CPU.

Determination of Priority: The DTC activation source is selected in accordance with the default priority order, and is not affected by mask or priority levels. See section 7.3.3, DTC Vector Table, for the respective priorities.

Operation Order: If the same interrupt is selected as a DTC activation source and a CPU interrupt source, the DTC data transfer is performed first, followed by CPU interrupt exception handling.

Table 5.10 summarizes interrupt source selection and interrupt source clearance control according to the settings of the DTCE bit of DTCERA to DTCERE in the DTC and the DISEL bit of MRB in the DTC.

	Settings			
DTC		Interrupt Source Selection/Clearing C		
DTCE	DISEL	DTC	CPU	
0	*	×	Δ	
1	0	Δ	×	
	1	0	Δ	

Table 5.10 Interrupt Source Selection and Clearing Control

Legend

 A: The relevant interrupt is used. Interrupt source clearing is performed. (The CPU should clear the source flag in the interrupt handling routine.)

O: The relevant interrupt is used. The interrupt source is not cleared.

×: The relevant bit cannot be used.

*: Don't care

Usage Note: SCI, IIC, and A/D converter interrupt sources are cleared when the DTC reads or writes to the prescribed register, and are not dependent upon the DISEL bit.

Section 6 Bus Controller

6.1 Overview

The H8S/2138 Series and H8S/2134 Series have a built-in bus controller (BSC) that allows external address space bus specifications, such as bus width and number of access states, to be set.

The bus controller also has a bus arbitration function, and controls the operation of the internal bus masters: the CPU and data transfer controller (DTC).

6.1.1 Features

The features of the bus controller are listed below.

- Basic bus interface
 - 2-state access or 3-state access can be selected
 - Program wait states can be inserted
- Burst ROM interface
 - External space can be designated as ROM interface space
 - 1-state or 2-state burst access can be selected
- Idle cycle insertion
 - An idle cycle can be inserted when an external write cycle immediately follows an external read cycle
- Bus arbitration function
 - Includes a bus arbiter that arbitrates bus mastership between the CPU and DTC

6.1.2 Block Diagram

Figure 6.1 shows a block diagram of the bus controller.

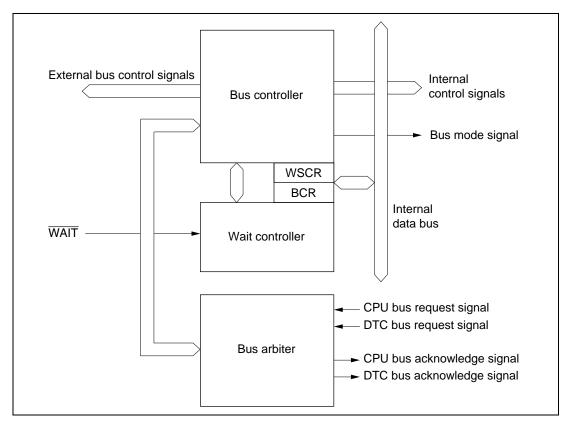


Figure 6.1 Block Diagram of Bus Controller

6.1.3 Pin Configuration

Table 6.1 summarizes the pins of the bus controller.

Name	Symbol	I/O	Function
Address strobe	ĀS	Output	Strobe signal indicating that address output on address bus is enabled (when IOSE bit is 0)
I/O select	ĪOS	Output	I/O select signal (when IOSE bit is 1)
Read	RD	Output	Strobe signal indicating that external space is being read
Write	WR	Output	Strobe signal indicating that external space is being written to, and that data bus is enabled
Wait	WAIT	Input	Wait request signal when external 3-state access space is accessed

Table 6.1Bus Controller Pins

6.1.4 Register Configuration

Table 6.2 summarizes the registers of the bus controller.

Table 6.2 Bus Controller Registers

Name	Abbreviation	R/W	Initial Value	Address*
Bus control register	BCR	R/W	H'D7	H'FFC6
Wait state control register	WSCR	R/W	H'33	H'FFC7

Note: *Lower 16 bits of the address.

6.2 **Register Descriptions**

6.2.1 Bus Control Register (BCR)

Bit	7	6	5	4	3	2	1	0
	ICIS1	ICIS0	BRSTRM	BRSTS1	BRSTS0	_	IOS1	IOS0
Initial value	1	1	0	1	0	1	1	1
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

BCR is an 8-bit readable/writable register that specifies the external memory space access mode, and the extent of the I/O area when the I/O strobe function has been selected for the \overline{AS} pin.

BCR is initialized to H'D7 by a reset and in hardware standby mode. It is not initialized in software standby mode.

Bit 7—Idle Cycle Insert 1 (ICIS1): Reserved. Do not write 0 to this bit.

Bit 6—Idle Cycle Insert 0 (ICIS0): Selects whether or not a one-state idle cycle is to be inserted between bus cycles when successive external read and external write cycles are performed.

Bit 6

ICIS0	Description
0	Idle cycle not inserted in case of successive external read and external write cycles
1	Idle cycle inserted in case of successive external read and external write cycles (Initial value)

Bit 5—Burst ROM Enable (BRSTRM): Selects whether external space is designated as a burst ROM interface space. The selection applies to the entire external space .

Bit 5

BRSTRM	 Description	
0	Basic bus interface	(Initial value)
1	Burst ROM interface	

Bit 4—Burst Cycle Select 1 (BRSTS1): Selects the number of burst cycles for the burst ROM interface.

Bit 4

BRSTS1	Description	
0	Burst cycle comprises 1 state	
1	Burst cycle comprises 2 states	(Initial value)

Bit 3—Burst Cycle Select 0 (BRSTS0): Selects the number of words that can be accessed in a burst ROM interface burst access.

Bit 3

BRSTS0	Description	
0	Max. 4 words in burst access	(Initial value)
1	Max. 8 words in burst access	

Bit 2—Reserved: Do not write 0 to this bit.

Bits 1 and 0—IOS Select 1 and 0 (IOS1, IOS0): See table 6.4.

6.2.2 Wait State Control Register (WSCR)

Bit	7	6	5	4	3	2	1	0
	RAMS	RAM0	ABW	AST	WMS1	WMS0	WC1	WC0
Initial value	0	0	1	1	0	0	1	1
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

WSCR is an 8-bit readable/writable register that specifies the data bus width, number of access states, wait mode, and number of wait states for external memory space. The on-chip memory and internal I/O register bus width and number of access states are fixed, irrespective of the WSCR settings.

WSCR is initialized to H'33 by a reset and in hardware standby mode. It is not initialized in software standby mode.

Bit 7-RAM Select (RAMS)/Bit 6-RAM Area Setting (RAM0): Reserved bits.

Bit 5—Bus Width Control (ABW): Specifies whether the external memory space is 8-bit access space or 16-bit access space.

However, a 16-bit access space cannot be specified for these series, and therefore 0 should not be written to this bit.

Bit 5

ABW	Description							
0	External memory space is designated as 16-bit access space (A 16 cannot be specified for these series)	6-bit access space						
1	External memory space is designated as 8-bit access space	(Initial value)						

Bit 4—Access State Control (AST): Specifies whether the external memory space is 2-state access space or 3-state access space, and simultaneously enables or disables wait state insertion.

Bit 4

AST	Description	
0	External memory space is designated as 2-state access space Wait state insertion in external memory space accesses is disabled	
1	External memory space is designated as 3-state access space Wait state insertion in external memory space accesses is enabled	(Initial value)

Bits 3 and 2—Wait Mode Select 1 and 0 (WMS1, WMS0): These bits select the wait mode when external memory space is accessed while the AST bit is set to 1.

Bit 3	Bit 2		
WMS1 WMS0 Description		Description	
0	0	Program wait mode	(Initial value)
	1	Wait-disabled mode	
1	0	Pin wait mode	
	1	Pin auto-wait mode	

Bit 1	Bit 0	
WC1	WC0	Description
0	0	No program wait states are inserted
	1	1 program wait state is inserted in external memory space accesses
1	0	2 program wait states are inserted in external memory space accesses
	1	3 program wait states are inserted in external memory space accesses (Initial value)

Bits 1 and 0—Wait Count 1 and 0 (WC1, WC0): These bits select the number of program wait states when external memory space is accessed while the AST bit is set to 1.

6.3 Overview of Bus Control

6.3.1 Bus Specifications

The external space bus specifications consist of three elements: bus width, number of access states, and wait mode and number of program wait states.

The bus width and number of access states for on-chip memory and internal I/O registers are fixed, and are not affected by the bus controller.

Bus Width: A bus width of 8 or 16 bits can be selected with the ABW bit. A 16-bit access space cannot be specified for these series.

Number of Access States: Two or three access states can be selected with the AST bit.

When 2-state access space is designated, wait insertion is disabled. The number of access states on the burst ROM interface is determined without regard to the AST bit setting.

Wait Mode and Number of Program Wait States: When 3-state access space is designated by the AST bit, the wait mode and the number of program wait states to be inserted automatically is selected with WMS1, WMS0, WC1, and WC0. From 0 to 3 program wait states can be selected.

Bus Specifications (Basic Bus Interface)

Table 6.3 shows the bus specifications for each basic bus interface area.

Table 6.3 Bus Specifications for Each Area (Basic Bus Interface)

	AST WMS1				Buo opeonia	Ballonio (Bao		
AST		WMS0	WC1	WC0	Bus Width	Access States	Program Wait States	
0	_	_	_	_	Cannot be used in the H8S/2138 Series or H8S/2134 Series.			
0	—	—		_	8	2	0	
1	0	1		_	8	3	0	
	*	*	0	0		3	0	
				1			1	
			1	0			2	
				1			3	
	0	$\begin{array}{c} 0 \\ \hline \\ 0 \\ \hline \\ 1 \\ \end{array}$	$\begin{array}{cccccccccccccccccccccccccccccccccccc$	$\begin{array}{cccccccccccccccccccccccccccccccccccc$	$\begin{array}{cccccccccccccccccccccccccccccccccccc$	AST WMS1 WMS0 WC1 WC0 Bus Width 0 Cannot be us H8S/2134 Set 0 8 1 0 1 8 * * 0 0 1	ASTWMS1WMS0WC1WC0Bus WidthStates0Cannot be used in the H83 H8S/2134 Series. 0 8210183 $-*$ -*003	

Note: * Except when WMS1 = 0 and WMS0 = 1

6.3.2 Advanced Mode

The H8S/2138 and H8S/2134 have 16 address output pins, so there are no pins for output of the upper address bits (A16 to A23) in advanced mode. H'FFF000 to H'FFFE4F can be accessed by designating the $\overline{\text{AS}}$ pin as an I/O strobe pin. The accessible external space is therefore H'FFF000 to H'FFFE4F even when expanded mode with ROM enabled is selected in advanced mode.

The initial state of the external space is basic bus interface, three-state access space. In ROMenabled expanded mode, the space excluding the on-chip ROM, on-chip RAM, and internal I/O registers is external space. The on-chip RAM is enabled when the RAME bit in the system control register (SYSCR) is set to 1; when the RAME bit is cleared to 0, the on-chip RAM is disabled and the corresponding space becomes external space.

6.3.3 Normal Mode

The initial state of the external memory space is basic bus interface, three-state access space. In ROM-disabled expanded mode, the space excluding the on-chip RAM and internal I/O registers is external space. In ROM-enabled expanded mode, the space excluding the on-chip ROM, on-chip RAM, and internal I/O registers is external space. The on-chip RAM is enabled when the RAME bit in the system control register (SYSCR) is set to 1; when the RAME bit is cleared to 0, the on-chip RAM is disabled and the corresponding space becomes external space.

6.3.4 I/O Select Signal

In the H8S/2138 Series and H8S/2134 Series, an I/O select signal (\overline{IOS}) can be output, with the signal output going low when the designated external space is accessed.

Figure 6.2 shows an example of $\overline{\text{IOS}}$ signal output timing.

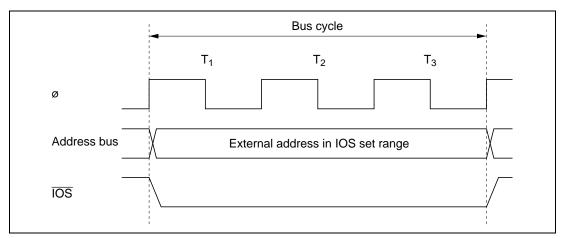


Figure 6.2 IOS Signal Output Timing

Enabling or disabling of \overline{IOS} signal output is controlled by the setting of the IOSE bit in SYSCR. In expanded mode, this pin operates as the \overline{AS} output pin after a reset, and therefore the IOSE bit in SYSCR must be set to 1 in order to use this pin as the \overline{IOS} signal output. See section 8, I/O Ports, for details.

The range of addresses for which the $\overline{\text{IOS}}$ signal is output can be set with bits IOS1 and IOS0 in BCR. The $\overline{\text{IOS}}$ signal address ranges are shown in table 6.4.

IOS1	IOS0	IOS Signal Output Range	
0	0	H'(FF)F000 to H'(FF)F03F	
	1	H'(FF)F000 to H'(FF)F0FF	
1	0	H'(FF)F000 to H'(FF)F3FF	
	1	H'(FF)F000 to H'(FF)FE4F	(Initial value)

Table 6.4 IOS Signal Output Range Settings

6.4 Basic Bus Interface

6.4.1 Overview

The basic bus interface enables direct connection of ROM, SRAM, and so on.

The bus specifications can be selected with the AST bit, and the WMS1, WMS0, WC1, and WC0 bits (see table 6.3).

6.4.2 Data Size and Data Alignment

Data sizes for the CPU and other internal bus masters are byte, word, and longword. The bus controller has a data alignment function, and when accessing external space, controls whether the upper data bus (D15 to D8) or lower data bus (D7 to D0) is used according to the bus specifications for the area being accessed (8-bit access space or 16-bit access space) and the data size.

These series only have an upper data bus, and only 8-bit access space alignment is used. In these series, the upper data bus pins are designated D7 to D0.

8-Bit Access Space: Figure 6.3 illustrates data alignment control for the 8-bit access space. With the 8-bit access space, the upper data bus (D15 to D8) is always used for accesses. The amount of data that can be accessed at one time is one byte: a word access is performed as two byte accesses, and a longword access, as four byte accesses.

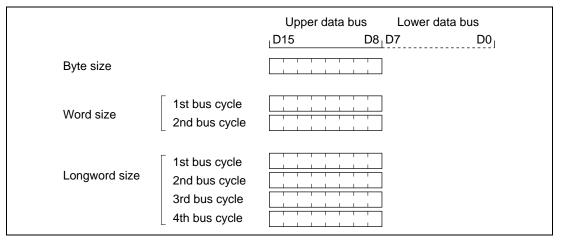


Figure 6.3 Access Sizes and Data Alignment Control (8-Bit Access Space)

16-Bit Access Space (Cannot be Used in the H8S/2138 Series or H8S/2134 Series): Figure 6.4 illustrates data alignment control for the 16-bit access space. With the 16-bit access space, the upper data bus (D15 to D8) and lower data bus (D7 to D0) are used for accesses. The amount of data that can be accessed at one time is one byte or one word, and a longword access is executed as two word accesses.

In byte access, whether the upper or lower data bus is used is determined by whether the address is even or odd. The upper data bus is used for an even address, and the lower data bus for an odd address.

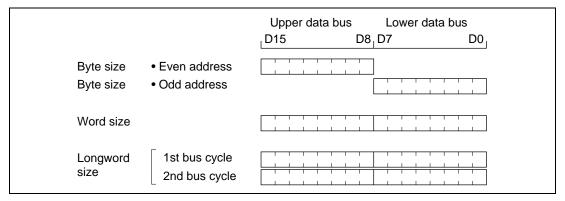


Figure 6.4 Access Sizes and Data Alignment Control (16-Bit Access Space)

6.4.3 Valid Strobes

Table 6.5 shows the data buses used and valid strobes for the access spaces.

In a read, the $\overline{\text{RD}}$ signal is valid without discrimination between the upper and lower halves of the data bus.

In a write, the \overline{HWR} signal is valid for the upper half of the data bus, and the \overline{LWR} signal for the lower half.

These series only have an upper data bus, and only the \overline{RD} and \overline{HWR} signals are valid. In these series, the \overline{HWR} signal pin is designated \overline{WR} .

Area	Access Size	Read/ Write	Address	Valid Strobe	Upper Data Bus (D15 to D8)* ¹	Lower Data Bus (D7 to D0)* ³
8-bit access space	Byte	Read	_	RD	Valid	Port, etc.
		Write	_	HWR* ²	_	Port, etc.
16-bit access space Byte		Read	Even	RD	Valid	Invalid
(Cannot be used in			Odd	_	Invalid	Valid
the H8S/2138 Series or H8S/2134 Series	-	Write	Even	HWR	Valid	Undefined
01 H03/2134 Selles)		Odd	LWR	Undefined	Valid
	Word	Read	_	RD	Valid	Valid
		Write		HWR, LWR	Valid	Valid

Table 6.5 Data Buses Used and Valid Strobes

Notes: Undefined: Undefined data is output.

Invalid: Input state; input value is ignored.

Port, etc.: Pins are used as port or on-chip supporting module input/output pins, and not as data bus pins.

1. The pin names in these series are D7 to D0.

2. The pin name in these series is \overline{WR} .

3. There are no lower data bus pins in these series.

6.4.4 Basic Timing

8-Bit 2-State Access Space: Figure 6.5 shows the bus timing for an 8-bit 2-state access space. When an 8-bit access space is accessed, the upper half (D15 to D8) of the data bus is used.

Wait states cannot be inserted.

These series have no lower data bus (D7 to D0) pins or \overline{LWR} pin. In these series, the upper data bus (D15 to D8) pins are designated D7 to D0, and the \overline{HWR} signal pin is designated \overline{WR} .

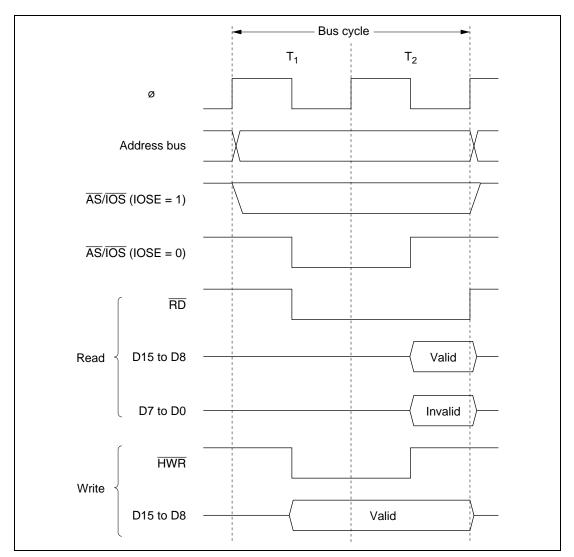


Figure 6.5 Bus Timing for 8-Bit 2-State Access Space

8-Bit 3-State Access Space: Figure 6.6 shows the bus timing for an 8-bit 3-state access space. When an 8-bit access space is accessed, the upper half (D15 to D8) of the data bus is used.

Wait states can be inserted.

These series have no lower data bus (D7 to D0) pins or \overline{LWR} pin. In these series, the upper data bus (D15 to D8) pins are designated D7 to D0, and the \overline{HWR} signal pin is designated \overline{WR} .

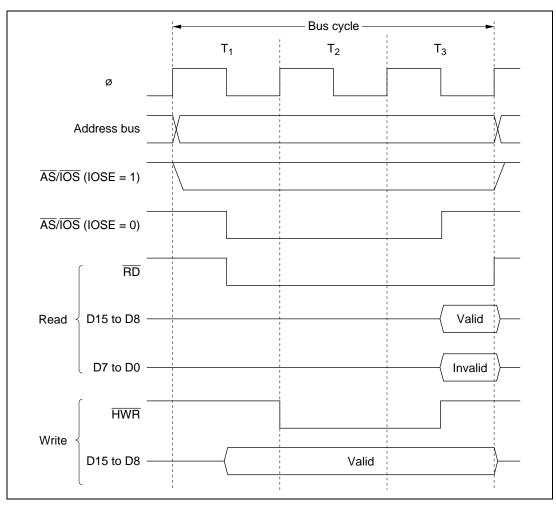


Figure 6.6 Bus Timing for 8-Bit 3-State Access Space

6.4.5 Wait Control

When accessing external space, the MCU can extend the bus cycle by inserting one or more wait states (T_w). There are three ways of inserting wait states: program wait insertion, pin wait insertion using the WAIT pin, and a combination of the two.

Program Wait Mode

In program wait mode, the number of T_w states specified by bits WC1 and WC0 are always inserted between the T_2 and T_3 states when external space is accessed.

Pin Wait Mode

In pin wait mode, the number of T_w states specified by bits WC1 and WC0 are always inserted between the T_2 and T_3 states when external space is accessed. If the WAIT pin is low at the fall of ϕ in the last T_2 or T_w state, another T_w state is inserted. If the WAIT pin is held low, T_w states are inserted until it goes high.

Pin wait mode is useful for inserting four or more wait states, or for changing the number of T_w states for different external devices.

Pin Auto-Wait Mode

In pin auto-wait mode, if the \overline{WAIT} pin is low at the fall of the system clock in the T_2 state, the number of T_w states specified by bits WC1 and WC0 are inserted between the T_2 and T_3 states when external space is accessed. No additional T_w states are inserted even if the \overline{WAIT} pin remains low. Pin auto-wait mode can be used for an easy interface to low-speed memory, simply by routing the chip select signal to the \overline{WAIT} pin.

Figure 6.7 shows an example of wait state insertion timing.

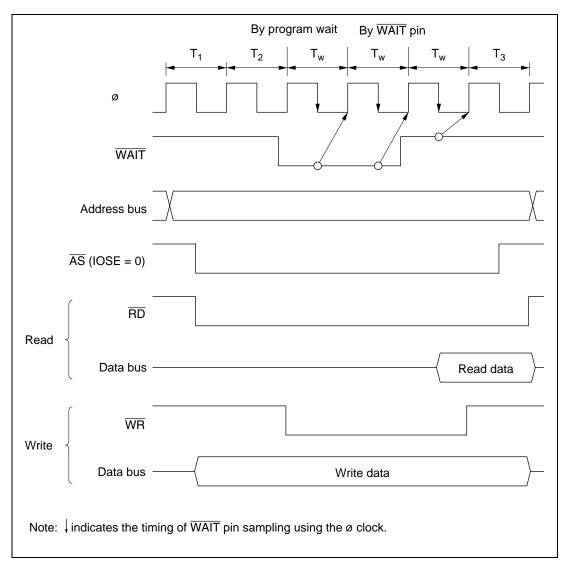


Figure 6.7 Example of Wait State Insertion Timing

The settings after a reset are: 3-state access, insertion of 3 program wait states, and WAIT input disabled.

6.5 Burst ROM Interface

6.5.1 Overview

With the H8S/2138 Series and H8S/2134 Series, external space area 0 can be designated as burst ROM space, and burst ROM interfacing can be performed.

External space can be designated as burst ROM space by means of the BRSTRM bit in BCR. Consecutive burst accesses of a maximum of 4 words or 8 words can be performed for CPU instruction fetches only. One or two states can be selected for burst access.

6.5.2 Basic Timing

The number of states in the initial cycle (full access) of the burst ROM interface is in accordance with the setting of the AST bit. Also, when the AST bit is set to 1, wait state insertion is possible. One or two states can be selected for the burst cycle, according to the setting of the BRSTS1 bit in BCR. Wait states cannot be inserted.

When the BRSTS0 bit in BCR is cleared to 0, burst access of up to 4 words is performed; when the BRSTS0 bit is set to 1, burst access of up to 8 words is performed.

The basic access timing for burst ROM space is shown in figure 6.8 (a) and (b). The timing shown in figure 6.8 (a) is for the case where the AST and BRSTS1 bits are both set to 1, and that in figure 6.8 (b) is for the case where both these bits are cleared to 0.

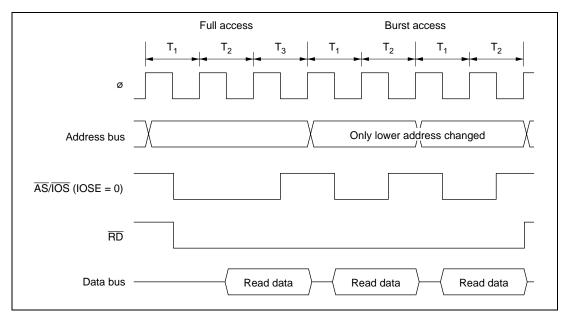


Figure 6.8 (a) Example of Burst ROM Access Timing (When AST = BRSTS1 = 1)

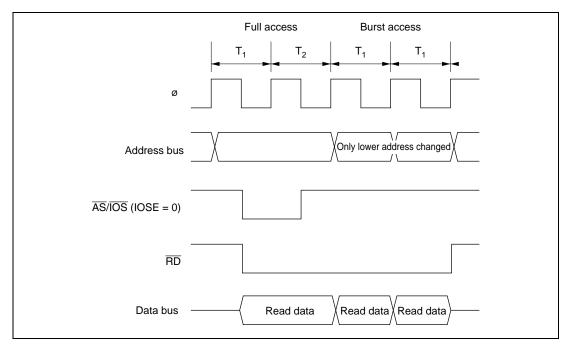


Figure 6.8 (b) Example of Burst ROM Access Timing (When AST = BRSTS1 = 0)

6.5.3 Wait Control

As with the basic bus interface, either program wait insertion or pin wait insertion using the \overline{WAIT} pin can be used in the initial cycle (full access) of the burst ROM interface. See section 6.4.5, Wait Control.

Wait states cannot be inserted in a burst cycle.

6.6 Idle Cycle

6.6.1 Operation

When the H8S/2138 Series or H8S/2134 Series chip accesses external space, it can insert a 1state idle cycle (T_1) between bus cycles when a write cycle occurs immediately after a read cycle. By inserting an idle cycle it is possible, for example, to avoid data collisions between ROM, with a long output floating time, and high-speed memory, I/O interfaces, and so on.

If an external write occurs after an external read while the ICIS0 bit in BCR is set to 1, an idle cycle is inserted at the start of the write cycle. This is enabled in advanced mode and normal mode.

Figure 6.9 shows an example of the operation in this case. In this example, bus cycle A is a read cycle from ROM with a long output floating time, and bus cycle B is a CPU write cycle. In (a), an idle cycle is not inserted, and a collision occurs in cycle B between the read data from ROM and the CPU write data. In (b), an idle cycle is inserted, and a data collision is prevented.

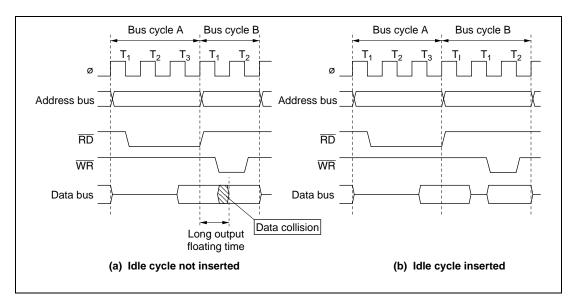


Figure 6.9 Example of Idle Cycle Operation

6.6.2 Pin States in Idle Cycle

Table 6.5 shows pin states in an idle cycle.

Table 6.5	Pin	States	in	Idle	Cycle
-----------	-----	--------	----	------	-------

Pins	Pin State
A15 to A0, IOS	Contents of next bus cycle
D7 to D0	High impedance
ĀS	High
RD	High
WR	High

6.7 Bus Arbitration

6.7.1 Overview

The H8S/2138 Series and H8S/2134 Series have a bus arbiter that arbitrates bus master operations.

There are two bus masters, the CPU and the DTC, which perform read/write operations when they have possession of the bus. Each bus master requests the bus by means of a bus request signal. The bus arbiter determines priorities at the prescribed timing, and permits use of the bus by means of a bus request acknowledge signal. The selected bus master then takes possession of the bus and begins its operation.

6.7.2 Operation

The bus arbiter detects the bus masters' bus request signals, and if the bus is requested, sends a bus request acknowledge signal to the bus master making the request. If there are bus requests from both bus masters, the bus request acknowledge signal is sent to the one with the higher priority. When a bus master receives the bus request acknowledge signal, it takes possession of the bus until that signal is canceled.

The order of priority of the bus masters is as follows:

(High) DTC > CPU (Low)

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6.7.3 Bus Transfer Timing

Even if a bus request is received from a bus master with a higher priority than that of the bus master that has acquired the bus and is currently operating, the bus is not necessarily transferred immediately. There are specific times at which each bus master can relinquish the bus.

CPU: The CPU is the lowest-priority bus master, and if a bus request is received from the DTC, the bus arbiter transfers the bus to the DTC. The timing for transfer of the bus is as follows:

• The bus is transferred at a break between bus cycles. However, if a bus cycle is executed in discrete operations, as in the case of a longword-size access, the bus is not transferred between the operations.

See appendix A.5, Bus States during Instruction Execution, for timings at which the bus is not transferred.

- If the CPU is executing a multiply or divide instruction or similar internal operation, it transfers the bus immediately.
- If the CPU is in sleep mode, it transfers the bus immediately.

DTC: The DTC sends the bus arbiter a request for the bus when an activation request is generated.

The DTC does not release the bus until it has completed a series of processing operations.

Section 7 Data Transfer Controller [H8S/2138 Series]

Provided in the H8S/2138 Series; not provided in the H8S/2134 Series.

7.1 Overview

The H8S/2138 Series includes a data transfer controller (DTC). The DTC can be activated by an interrupt or software, to transfer data.

7.1.1 Features

- Transfer possible over any number of channels
 - Transfer information is stored in memory
 - One activation source can trigger a number of data transfers (chain transfer)
- Wide range of transfer modes
 - Normal, repeat, and block transfer modes available
 - Incrementing, decrementing, and fixing of transfer source and destination addresses can be selected
- Direct specification of 16-Mbyte address space possible
 - 24-bit transfer source and destination addresses can be specified
- Transfer can be set in byte or word units
- A CPU interrupt can be requested for the interrupt that activated the DTC
 - An interrupt request can be issued to the CPU after one data transfer ends
 - An interrupt request can be issued to the CPU after all specified data transfers have ended
- Activation by software is possible
- Module stop mode can be set
 - The initial setting enables DTC registers to be accessed. DTC operation is halted by setting module stop mode

7.1.2 Block Diagram

Figure 7.1 shows a block diagram of the DTC.

The DTC's register information is stored in the on-chip RAM*. A 32-bit bus connects the DTC to the on-chip RAM (1 kbyte), enabling 32-bit/1-state reading and writing of the DTC register information.

Note: * When the DTC is used, the RAME bit in SYSCR must be set to 1.

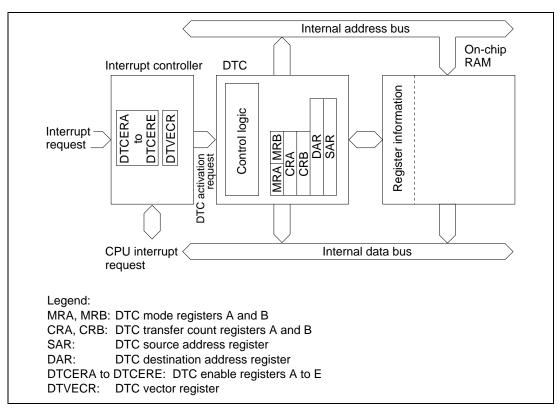


Figure 7.1 Block Diagram of DTC

7.1.3 Register Configuration

Table 7.1 summarizes the DTC registers.

Table 7.1DTC Registers

Name	Abbreviation	R/W	Initial Value	Address*1
DTC mode register A	MRA	* ²	Undefined	* ³
DTC mode register B	MRB	* ²	Undefined	* ³
DTC source address register	SAR	* ²	Undefined	* ³
DTC destination address register	DAR	* ²	Undefined	* ³
DTC transfer count register A	CRA	* ²	Undefined	* ³
DTC transfer count register B	CRB	* ²	Undefined	* ³
DTC enable registers	DTCER* ⁴	R/W	H'00	H'FEEE to H'FEF2
DTC vector register	DTVECR* ⁴	R/W	H'00	H'FEF3
Module stop control register	MSTPCRH	R/W	H'3F	H'FF86
	MSTPCRL	R/W	H'FF	H'FF87

Notes: 1. Lower 16 bits of the address.

- 2. Registers within the DTC cannot be read or written to directly.
- 3. Addresses H'EC00 to H'EFFF contain register information. They cannot be located in external memory space.

When the DTC is used, do not clear the RAME bit in SYSCR to 0.

4. The H8S/2134 Series does not include an on-chip DTC, and therefore the DTCER and DTVECR register addresses should not be accessed by the CPU.

7.2 **Register Descriptions**

7.2.1 DTC Mode Register A (MRA)

Bit	7	6	5	4	3	2	1	0
	SM1	SM0	DM1	DM0	MD1	MD0	DTS	Sz
Initial value	Unde- fined							
Read/Write	—	—		—	—	—		—

MRA is an 8-bit register that controls the DTC operating mode.

Bits 7 and 6—Source Address Mode 1 and 0 (SM1, SM0): These bits specify whether SAR is to be incremented, decremented, or left fixed after a data transfer.

Bit 7	Bit 6					
SM1	SM0	Description				
0		SAR is fixed				
1	0	SAR is incremented after a transfer (by 1 when Sz = 0; by 2 when Sz = 1)				
	1	SAR is decremented after a transfer (by 1 when Sz = 0; by 2 when Sz = 1)				

Bits 5 and 4—Destination Address Mode 1 and 0 (DM1, DM0): These bits specify whether DAR is to be incremented, decremented, or left fixed after a data transfer.

Bit 5	Bit 4	
DM1	DM0	Description
0	_	DAR is fixed
1	0	DAR is incremented after a transfer (by 1 when Sz = 0; by 2 when Sz = 1)
	1	DAR is decremented after a transfer (by 1 when Sz = 0; by 2 when Sz = 1)

Bit 3	Bit 2	
MD1	MD0	Description
0	0	Normal mode
	1	Repeat mode
1	0	Block transfer mode
	1	_

Bits 3 and 2—DTC Mode (MD1, MD0): These bits specify the DTC transfer mode.

Bit 1—DTC Transfer Mode Select (DTS): Specifies whether the source side or the destination side is set to be a repeat area or block area, in repeat mode or block transfer mode.

Bit 1

DTS	Description
0	Destination side is repeat area or block area
1	Source side is repeat area or block area

Bit 0—DTC Data Transfer Size (Sz): Specifies the size of data to be transferred.

Bit 0

Sz	Description
0	Byte-size transfer
1	Word-size transfer

7.2.2 DTC Mode Register B (MRB)

Bit	7	6	5	4	3	2	1	0
	CHNE	DISEL	—	—	—	—	—	—
Initial value	Unde- fined							
Read/Write	_	_	_	_		_		_

MRB is an 8-bit register that controls the DTC operating mode.

Bit 7—DTC Chain Transfer Enable (CHNE): Specifies chain transfer. In chain transfer, multiple data transfers can be performed consecutively in response to a single transfer request. With data transfer for which CHNE is set to 1, there is no determination of the end of the specified number of transfers, clearing of the interrupt source flag, or clearing of DTCER.

Bit 7

CHNE	Description
0	End of DTC data transfer (activation waiting state is entered)
1	DTC chain transfer (new register information is read, then data is transferred)

Bit 6—DTC Interrupt Select (DISEL): Specifies whether interrupt requests to the CPU are disabled or enabled after a data transfer.

Bit 6

DISEL	Description
0	After a data transfer ends, the CPU interrupt is disabled unless the transfer counter is 0 (the DTC clears the interrupt source flag of the activating interrupt to 0)
1	After a data transfer ends, the CPU interrupt is enabled (the DTC does not clear the interrupt source flag of the activating interrupt to 0)

Bits 5 to 0—Reserved: In the H8S/2138 Series these bits have no effect on DTC operation, and should always be written with 0.

7.2.3 DTC Source Address Register (SAR)

Bit	23	22	21	20	19	 4	3	2	1	0
Initial value	Unde-	Unde-	Unde-	Unde-	Unde-	 Unde-Unde-Unde-Unde-Unde				
	fined	fined	fined	fined	fined	fined	fined	fined	fined	fined
Read/write	_	_	—	—	—	 _	—	_	—	—

SAR is a 24-bit register that designates the source address of data to be transferred by the DTC. For word-size transfer, specify an even source address.

7.2.4 DTC Destination Address Register (DAR)

Bit	23	22	21	20	19	 4	3	2	1	0
Initial value	Unde-	Unde-	Unde-	Unde-	Unde-	 Unde-Unde-Unde-Unde-Unde				Unde-
	fined	fined	fined	fined	fined	fined	fined	fined	fined	fined
Read/write	—	—	—	—	—	 —	—	—	—	—

DAR is a 24-bit register that designates the destination address of data to be transferred by the DTC. For word-size transfer, specify an even destination address.

7.2.5 DTC Transfer Count Register A (CRA)

Bit	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Initial value	Unde-															
	fined															
Read/Write	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—
	-			CR	AH			-	-			CR	AL -			_►

CRA is a 16-bit register that designates the number of times data is to be transferred by the DTC.

In normal mode, the entire CRA register functions as a 16-bit transfer counter (1 to 65,536). It is decremented by 1 every time data is transferred, and transfer ends when the count reaches H'0000.

In repeat mode or block transfer mode, CRA is divided into two parts: the upper 8 bits (CRAH) and the lower 8 bits (CRAL). CRAH holds the number of transfers while CRAL functions as an 8-bit transfer counter (1 to 256). CRAL is decremented by 1 every time data is transferred, and the contents of CRAH are transferred when the count reaches H'00. This operation is repeated.

Bit 15 14 13 12 11 10 9 8 7 6 5 4 3 2 1 0 Initial value Unde- Undefined fined Read/Write

7.2.6 DTC Transfer Count Register B (CRB)

CRB is a 16-bit register that designates the number of times data is to be transferred by the DTC in block transfer mode. It functions as a 16-bit transfer counter (1 to 65,536) that is decremented by 1 every time data is transferred, and transfer ends when the count reaches H'0000.

7.2.7 DTC Enable Registers (DTCER)

Bit	7	6	5	4	3	2	1	0
	DTCE7	DTCE6	DTCE5	DTCE4	DTCE3	DTCE2	DTCE1	DTCE0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W							

The DTC enable registers comprise five 8-bit readable/writable registers, DTCERA to DTCERE, with bits corresponding to the interrupt sources that can activate the DTC. These bits enable or disable DTC service for the corresponding interrupt sources.

The DTC enable registers are initialized to H'00 by a reset and in hardware standby mode.

Bit n—DTC Activation Enable (DTCEn)

_ .

Bit n	
DTCEn	Description
0	DTC activation by interrupt is disabled (Initial value
	[Clearing conditions]
	 When data transfer ends with the DISEL bit set to 1
	When the specified number of transfers end
1	DTC activation by interrupt is enabled
	[Holding condition]
	When the DISEL bit is 0 and the specified number of transfers have not ended
	(n = 7 to

A DTCE bit can be set for each interrupt source that can activate the DTC. The correspondence between interrupt sources and DTCE bits is shown in table 7.4, together with the vector number generated by the interrupt controller in each case.

For DTCE bit setting, read/write operations must be performed using bit-manipulation instructions such as BSET and BCLR. For the initial setting only, however, when multiple activation sources are set at one time, it is possible to disable interrupts and write after executing a dummy read on the relevant register.

7.2.8 DTC Vector Register (DTVECR)

Bit	7	6	5	4	3	2	1	0
	SWDTE	DTVEC6	DTVEC5	DTVEC4	DTVEC3	DTVEC2	DTVEC1	DTVEC0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/(W)*	R/W						

Note: * A value of 1 can always be written to the SWDTE bit, but 0 can only be written after 1 is read.

DTVECR is an 8-bit readable/writable register that enables or disables DTC activation by software, and sets a vector number for the software activation interrupt.

DTVECR is initialized to H'00 by a reset and in hardware standby mode.

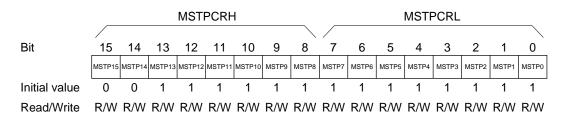
Bit 7—DTC Software Activation Enable (SWDTE): Specifies enabling or disabling of DTC software activation. To clear the SWDTE bit by software, read SWDTE when set to 1, then write 0 in the bit.

Description	
DTC software activation is disabled	(Initial value)
[Clearing condition]	
When the DISEL bit is 0 and the specified number of transfers have not ended	
DTC software activation is enabled	
[Holding conditions]	
 When data transfer ends with the DISEL bit set to 1 	
 When the specified number of transfers end 	
During software-activated data transfer	
	 DTC software activation is disabled [Clearing condition] When the DISEL bit is 0 and the specified number of transfers have not ended DTC software activation is enabled [Holding conditions] When data transfer ends with the DISEL bit set to 1 When the specified number of transfers end

Bits 6 to 0—DTC Software Activation Vectors 6 to 0 (DTVEC6 to DTVEC0): These bits specify a vector number for DTC software activation.

The vector address is $H'0400 + (vector number) \ll 1$ (where $\ll 1$ indicates a 1-bit left shift). For example, if DTVEC6 to DTVEC0 = H'10, the vector address is H'0420.

7.2.9 Module Stop Control Register (MSTPCR)



MSTPCR, comprising two 8-bit readable/writable registers, performs module stop mode control.

When the MSTP14 bit in MSTPCR is set to 1, the DTC operation stops at the end of the bus cycle and a transition is made to module stop mode. Note that 1 cannot be written to the MSTP14 bit when the DTC is being activated. For details, see section 23.5, Module Stop Mode.

MSTPCR is initialized to H'3FFF by a reset and in hardware standby mode. It is not initialized in software standby mode.

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MSTPCRH Bit 6—Module Stop (MSTP14): Specifies the DTC module stop mode.

MSTPCRH Bit 6	I	
MSTP14	Description	
0	DTC module stop mode is cleared	(Initial value)
1	DTC module stop mode is set	

7.3 Operation

7.3.1 Overview

When activated, the DTC reads register information that is already stored in memory and transfers data on the basis of that register information. After the data transfer, it writes updated register information back to memory. Pre-storage of register information in memory makes it possible to transfer data over any required number of channels. Setting the CHNE bit to 1 makes it possible to perform a number of transfers with a single activation.

Figure 7.2 shows a flowchart of DTC operation.

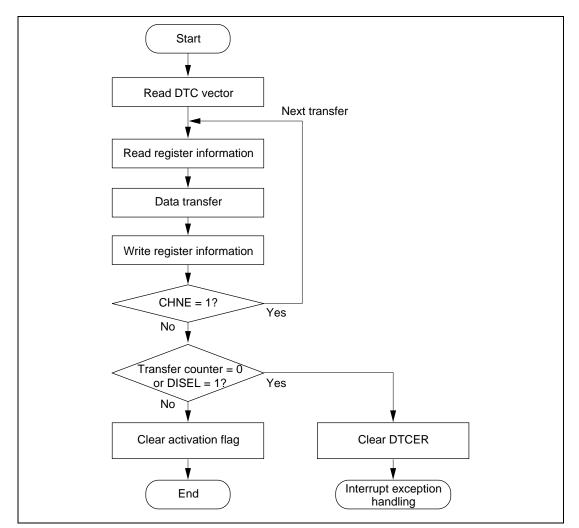


Figure 7.2 Flowchart of DTC Operation

The DTC transfer mode can be normal mode, repeat mode, or block transfer mode.

The 24-bit SAR designates the DTC transfer source address and the 24-bit DAR designates the transfer destination address. After each transfer, SAR and DAR are independently incremented, decremented, or left fixed.

Table 7.2 outlines the functions of the DTC.

Table 7.2DTC Functions

			Addres	s Registers
Transfer Mode	Ac	tivation Source	Transfer Source	Transfer Destination
 Normal mode One transfer request transfers one byte or one word Memory addresses are incremented or decremented by 1 or 2 Up to 65,536 transfers possible Repeat mode One transfer request transfers one byte or one word Memory addresses are incremented or decremented by 1 or 2 After the specified number of transfers (1 to 256), the initial state resumes and operation continues Block transfer mode One transfer request transfers a block of the specified size Block size is from 1 to 256 bytes or words Up to 65,536 transfers possible A block area can be designated at either the source or destination 	•	IRQ FRT ICI, OCI 8-bit timer CMI Host interface IBF SCI TXI or RXI A/D converter ADI IIC IICI Software	24 bits	24 bits

7.3.2 Activation Sources

The DTC operates when activated by an interrupt or by a write to DTVECR by software (software activation). An interrupt request can be directed to the CPU or DTC, as designated by the corresponding DTCER bit. The interrupt request is directed to the DTC when the corresponding bit is set to 1, and to the CPU when the bit is cleared to 0.

At the end of one data transfer (or the last of the consecutive transfers in the case of chain transfer) the interrupt source or the corresponding DTCER bit is cleared. Table 7.3 shows activation sources and DTCER clearing.

The interrupt source flag for RXI0, for example, is the RDRF flag in SCI0.

Activation Source	When DISEL Bit Is 0 and Specified Number of Transfers Have Not Ended	When DISEL Bit Is 1 or Specified Number of Transfers Have Ended
Software activation	SWDTE bit cleared to 0	SWDTE bit held at 1Interrupt request sent to CPU
Interrupt activation	 Corresponding DTCER bit held at 1 Activation source flag cleared to 0 	 Corresponding DTCER bit cleared to 0 Activation source flag held at 1 Activation source interrupt request sent to CPU

Table 7.3 Activation Sources and DTCER Clearing

Figure 7.3 shows a block diagram of activation source control. For details see section 5, Interrupt Controller.

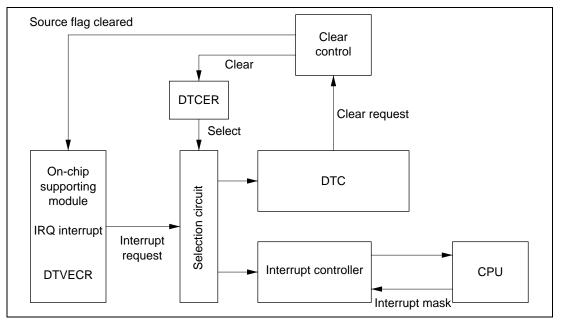


Figure 7.3 Block Diagram of DTC Activation Source Control

When an interrupt has been designated a DTC activation source, existing CPU mask level and interrupt controller priorities have no effect. If there is more than one activation source at the same time, the DTC is activated in accordance with the default priorities.

7.3.3 DTC Vector Table

Figure 7.4 shows the correspondence between DTC vector addresses and register information.

Table 7.4 shows the correspondence between activation sources, vector addresses, and DTCER bits. When the DTC is activated by software, the vector address is obtained from: $H'0400 + DTVECR[6:0] \ll 1$ (where $\ll 1$ indicates a 1-bit left shift). For example, if DTVECR is H'10, the vector address is H'0420.

The DTC reads the start address of the register information from the vector address set for each activation source, and then reads the register information from that start address. The register information can be placed at predetermined addresses in the on-chip RAM. The start address of the register information should be an integral multiple of four.

The configuration of the vector address is the same in both normal and advanced modes, a 2byte unit being used in both cases. These two bytes specify the lower bits of the address in the on-chip RAM.

Interrupt Source	Origin of Interrupt Source	Vector Number	Vector Address	DTCE*	Priority
Write to DTVECR	Software	DTVECR	H'0400 + DTVECR [6:0] << 1	—	High
IRQ0	External pin	16	H'0420	DTCEA7	
IRQ1	_	17	H'0422	DTCEA6	
IRQ2	_	18	H'0424	DTCEA5	
IRQ3	_	19	H'0426	DTCEA4	_
ADI (A/D conversion end)	A/D	28	H'0438	DTCEA3	_
ICIA (FRT input capture A)	FRT	48	H'0460	DTCEA2	_
ICIB (FRT input capture B)	-	49	H'0462	DTCEA1	_
OCIA (FRT output compare A)	-	52	H'0468	DTCEA0	_
OCIB (FRT output compare B)	-	54	H'046A	DTCEB7	_
CMIA0 (TMR0 compare-match A)	TMR0	64	H'0480	DTCEB2	_
CMIB0 (TMR0 compare-match B)	-	65	H'0482	DTCEB1	_
CMIA1 (TMR1 compare-match A)	TMR1	68	H'0488	DTCEB0	_
CMIB1 (TMR1 compare-match B)	-	69	H'048A	DTCEC7	_
CMIAY (TMRY compare-match A)	TMRY	72	H'0490	DTCEC6	_
CMIBY (TMRY compare-match B)	-	73	H'0492	DTCEC5	_
IBF1 (IDR1 reception completed)	HIF	76	H'0498	DTCEC4	_
IBF2 (IDR2 reception completed)	-	77	H'049A	DTCEC3	_
RXI0 (reception completed 0)	SCI channel 0	81	H'04A2	DTCEC2	-
TXI0 (transmit data empty 0)	-	82	H'04A4	DTCEC1	_
RXI1 (reception completed 1)	SCI channel 1	85	H'04AA	DTCEC0	_
TXI1 (transmit data empty 1)	-	86	H'04AC	DTCED7	_
RXI2 (reception completed 2)	SCI channel 2	89	H'04B2	DTCED6	_
TXI2 (transmit data empty 2)	-	90	H'04B4	DTCED5	_
IICI0 (IIC0 1-byte transmission/ reception completed)	IIC0 (option)	92	H'04B8	DTCED4	_
IICI1 (IIC1 1-byte transmission/ reception completed)	IIC1 (option)	94	H'04BC	DTCED3	Low

Table 7.4 Interrupt Sources, DTC Vector Addresses, and Corresponding DTCEs

Note: *DTCE bits with no corresponding interrupt are reserved, and should be written with 0.

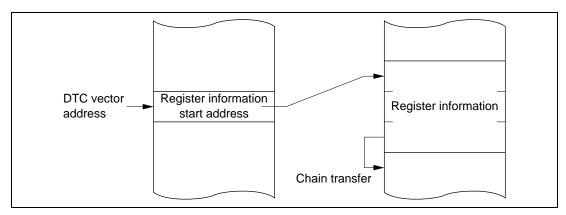


Figure 7.4 Correspondence between DTC Vector Address and Register Information

7.3.4 Location of Register Information in Address Space

Figure 7.5 shows how the register information should be located in the address space.

Locate the MRA, SAR, MRB, DAR, CRA, and CRB registers, in that order, from the start address of the register information (vector address contents). In chain transfer, locate the register information in consecutive areas.

Locate the register information in the on-chip RAM (addresses: H'FFEC00 to H'FFEFFF).

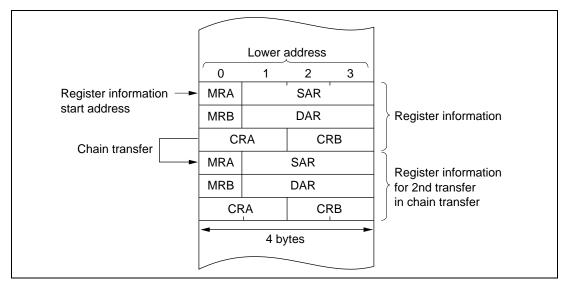


Figure 7.5 Location of DTC Register Information in Address Space

7.3.5 Normal Mode

In normal mode, one operation transfers one byte or one word of data.

From 1 to 65,536 transfers can be specified. Once the specified number of transfers have ended, a CPU interrupt can be requested.

Table 7.5 lists the register information in normal mode and figure 7.6 shows memory mapping in normal mode.

 Table 7.5
 Register Information in Normal Mode

Name	Abbreviation	Function
DTC source address register	SAR	Transfer source address
DTC destination address register	DAR	Transfer destination address
DTC transfer count register A	CRA	Transfer count
DTC transfer count register B	CRB	Not used

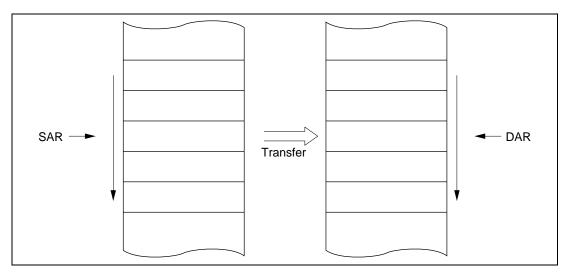


Figure 7.6 Memory Mapping in Normal Mode

7.3.6 Repeat Mode

In repeat mode, one operation transfers one byte or one word of data.

From 1 to 256 transfers can be specified. Once the specified number of transfers have ended, the initial address register state specified by the transfer counter and repeat area resumes and transfer is repeated. In repeat mode the transfer counter does not reach H'00, and therefore CPU interrupts cannot be requested when DISEL = 0.

Table 7.6 lists the register information in repeat mode and figure 7.7 shows memory mapping in repeat mode.

Table 7.6	Register Information in Repeat Mode			
Name	Abbreviation	Function		

Name	Appreviation	Function
DTC source address register	SAR	Transfer source address
DTC destination address register	DAR	Transfer destination address
DTC transfer count register AH	CRAH	Holds number of transfers
DTC transfer count register AL	CRAL	Transfer count
DTC transfer count register B	CRB	Not used

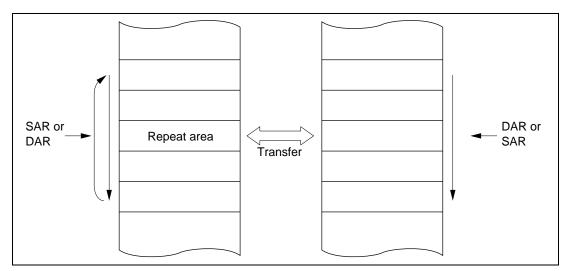


Figure 7.7 Memory Mapping in Repeat Mode

7.3.7 Block Transfer Mode

In block transfer mode, one operation transfers one block of data. Either the transfer source or the transfer destination is specified as a block area.

The block size is 1 to 256. When the transfer of one block ends, the initial state of the block size counter and the address register specified in the block area is restored. The other address register is successively incremented or decremented, or left fixed.

From 1 to 65,536 transfers can be specified. Once the specified number of transfers have ended, a CPU interrupt is requested.

Table 7.7 lists the register information in block transfer mode and figure 7.8 shows memory mapping in block transfer mode.

Naille	ADDIEVIALION	Function
Name	Abbreviation	Function

Table 7.7 Register Information in Block Transfer Mode

DTC source address register	SAR	Transfer source address
DTC destination address register	DAR	Transfer destination address
DTC transfer count register AH	CRAH	Holds block size
DTC transfer count register AL	CRAL	Block size count
DTC transfer count register B	CRB	Transfer counter

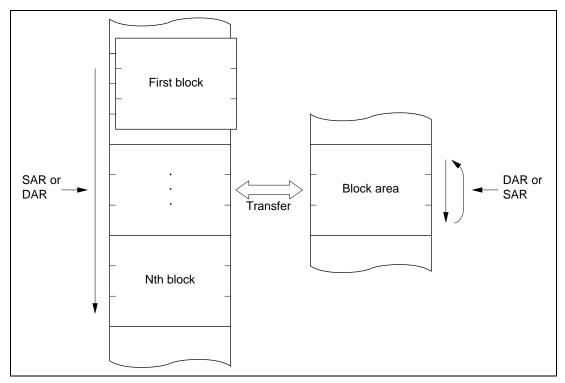


Figure 7.8 Memory Mapping in Block Transfer Mode

7.3.8 Chain Transfer

Setting the CHNE bit to 1 enables a number of data transfers to be performed consecutively in response to a single transfer request. SAR, DAR, CRA, CRB, MRA, and MRB, which define data transfers, can be set independently.

Figure 7.9 shows memory mapping for chain transfer.

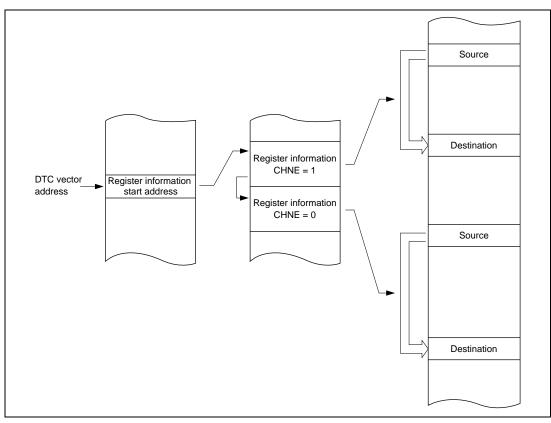


Figure 7.9 Memory Mapping in Chain Transfer

In the case of transfer with CHNE set to 1, an interrupt request to the CPU is not generated at the end of the specified number of transfers or by setting of the DISEL bit to 1, and the interrupt source flag for the activation source is not affected.

7.3.9 Operation Timing

Figures 7.10 to 7.12 show examples of DTC operation timing.

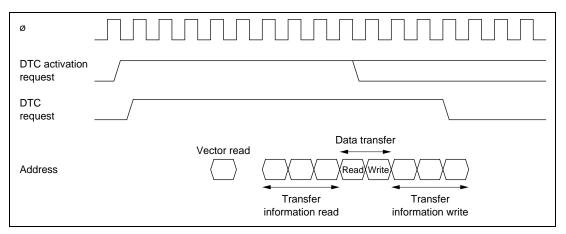


Figure 7.10 DTC Operation Timing (Normal Mode or Repeat Mode)

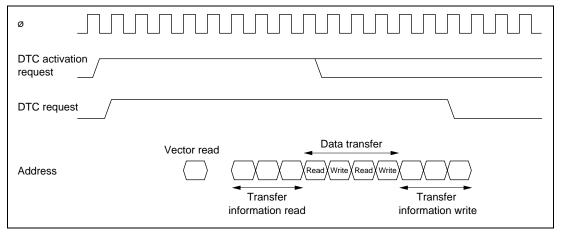


Figure 7.11 DTC Operation Timing (Block Transfer Mode, with Block Size of 2)

ø		Л
DTC activ request	on	
DTC request		
	Data transfer Data transfer	
	Vector read $\underline{}$	
Address	A X X Read Write X X X X Read Write X X	\rangle
		-
	Transfer Transfer Transfer Transfer	
	information information information information	
	read write read write	

Figure 7.12 DTC Operation Timing (Chain Transfer)

7.3.10 Number of DTC Execution States

Table 7.8 lists execution phases for a single DTC data transfer, and table 7.9 shows the number of states required for each execution phase.

Table 7.8 DTC Execution Phases

Mode	Vector Read I	Register Information Read/Write J		Data Write L	Internal Operation M
Normal	1	6	1	1	3
Repeat	1	6	1	1	3
Block transfer	1	6	Ν	Ν	3

N: Block size (initial setting of CRAH and CRAL)

Object of Access			On- On- t of Access Chip RAM Chip RO			al I/O ters	External Devices	
Bus width			32	16	8	3 16	8 2	8
Access sta	tes		1	1	2	2		3
Execution phase	Vector read	S	_	1		_	4	6+2m
	Register information read/write	S	1	_			_	_
	Byte data read	Sκ	1	1	2	2	2	3+m
	Word data read	Sκ	1	1	4	2	4	6+2m
	Byte data write	$S_{\scriptscriptstyle L}$	1	1	2	2	2	3+m
	Word data write	$S_{\scriptscriptstyle L}$	1	1	4	2	4	6+2m
	Internal operation	${\sf S}_{{\scriptscriptstyle M}}$	1	1	1	1	1	1

Table 7.9 Number of States Required for Each Execution Phase

The number of execution states is calculated from the formula below. Note that Σ means the sum of all transfers activated by one activation event (the number for which the CHNE bit is set to one, plus 1).

Number of execution states = $I \cdot S_1 + \Sigma (J \cdot S_3 + K \cdot S_k + L \cdot S_L) + M \cdot S_M$

For example, when the DTC vector address table is located in on-chip ROM, normal mode is set, and data is transferred from the on-chip ROM to an internal I/O register, the time required for the DTC operation is 13 states. The time from activation to the end of the data write is 10 states.

7.3.11 Procedures for Using the DTC

Activation by Interrupt: The procedure for using the DTC with interrupt activation is as follows:

- 1. Set the MRA, MRB, SAR, DAR, CRA, and CRB register information in the on-chip RAM.
- 2. Set the start address of the register information in the DTC vector address.
- 3. Set the corresponding bit in DTCER to 1.
- 4. Set the enable bits for the interrupt sources to be used as the activation sources to 1. The DTC is activated when an interrupt used as an activation source is generated.
- 5. After the end of one data transfer, or after the specified number of data transfers have ended, the DTCE bit is cleared to 0 and a CPU interrupt is requested. If the DTC is to continue transferring data, set the DTCE bit to 1.

Activation by Software: The procedure for using the DTC with software activation is as follows:

- 1. Set the MRA, MRB, SAR, DAR, CRA, and CRB register information in the on-chip RAM.
- 2. Set the start address of the register information in the DTC vector address.
- 3. Check that the SWDTE bit is 0.
- 4. Write 1 in the SWDTE bit and the vector number to DTVECR.
- 5. Check the vector number written to DTVECR.
- 6. After the end of one data transfer, if the DISEL bit is 0 and a CPU interrupt is not requested, the SWDTE bit is cleared to 0. If the DTC is to continue transferring data, set the SWDTE bit to 1. When the DISEL bit is 1, or after the specified number of data transfers have ended, the SWDTE bit is held at 1 and a CPU interrupt is requested.

7.3.12 Examples of Use of the DTC

Normal Mode: An example is shown in which the DTC is used to receive 128 bytes of data via the SCI.

- 1. Set MRA to fixed source address (SM1 = SM0 = 0), incrementing destination address (DM1 = 1, DM0 = 0), normal mode (MD1 = MD0 = 0), and byte size (Sz = 0). The DTS bit can have any value. Set MRB for one data transfer by one interrupt (CHNE = 0, DISEL = 0). Set the SCI RDR address in SAR, the start address of the RAM area where the data will be received in DAR, and 128 (H'0080) in CRA. CRB can be set to any value.
- 2. Set the start address of the register information at the DTC vector address.
- 3. Set the corresponding bit in DTCER to 1.
- 4. Set the SCI to the appropriate receive mode. Set the RIE bit in SCR to 1 to enable the reception complete (RXI) interrupt. Since the generation of a receive error during the SCI reception operation will disable subsequent reception, the CPU should be enabled to accept receive error interrupts.
- 5. Each time reception of one byte of data ends on the SCI, the RDRF flag in SSR is set to 1, an RXI interrupt is generated, and the DTC is activated. The receive data is transferred from RDR to RAM by the DTC. DAR is incremented and CRA is decremented. The RDRF flag is automatically cleared to 0.
- 6. When CRA becomes 0 after the 128 data transfers have ended, the RDRF flag is held at 1, the DTCE bit is cleared to 0, and an RXI interrupt request is sent to the CPU. The interrupt handling routine should perform wrap-up processing.

Software Activation: An example is shown in which the DTC is used to transfer a block of 128 bytes of data by means of software activation. The transfer source address is H'1000 and the destination address is H'2000. The vector number is H'60, so the vector address is H'04C0.

- Set MRA to incrementing source address (SM1 = 1, SM0 = 0), incrementing destination address (DM1 = 1, DM0 = 0), block transfer mode (MD1 = 1, MD0 = 0), and byte size (Sz = 0). The DTS bit can have any value. Set MRB for one block transfer by one interrupt (CHNE = 0). Set the transfer source address (H'1000) in SAR, the destination address (H'2000) in DAR, and 128 (H'8080) in CRA. Set 1 (H'0001) in CRB.
- 2. Set the start address of the register information at the DTC vector address (H'04C0).
- 3. Check that the SWDTE bit in DTVECR is 0. Check that there is currently no transfer activated by software.
- 4. Write 1 to the SWDTE bit and the vector number (H'60) to DTVECR. The write data is H'E0.
- 5. Read DTVECR again and check that it is set to the vector number (H'60). If it is not, this indicates that the write failed. This is presumably because an interrupt occurred between steps 3 and 4 and led to a different software activation. To activate this transfer, go back to step 3.
- 6. If the write was successful, the DTC is activated and a block of 128 bytes of data is transferred.
- 7. After the transfer, an SWDTEND interrupt occurs. The interrupt handling routine should clear the SWDTE bit to 0 and perform other wrap-up processing.

7.4 Interrupts

An interrupt request is issued to the CPU when the DTC finishes the specified number of data transfers, or a data transfer for which the DISEL bit was set to 1. In the case of interrupt activation, the interrupt set as the activation source is generated. These interrupts to the CPU are subject to CPU mask level and interrupt controller priority level control.

In the case of activation by software, a software-activated data transfer end interrupt (SWDTEND) is generated.

When the DISEL bit is 1 and one data transfer has ended, or the specified number of transfers have ended, after data transfer ends, the SWDTE bit is held at 1 and an SWDTEND interrupt is generated. The interrupt handling routine should clear the SWDTE bit to 0.

When the DTC is activated by software, an SWDTEND interrupt is not generated during a data transfer wait or during data transfer even if the SWDTE bit is set to 1.

7.5 Usage Notes

Module Stop: When the MSTP14 bit in MSTPCR is set to 1, the DTC clock stops, and the DTC enters the module stop state. However, 1 cannot be written in the MSTP14 bit while the DTC is operating. When the DTC is placed in the module stop state, the DTCER registers must all be in the cleared state when the MSTP14 bit is set to 1.

On-Chip RAM: The MRA, MRB, SAR, DAR, CRA, and CRB registers are all located in onchip RAM. When the DTC is used, the RAME bit in SYSCR must not be cleared to 0.

DTCE Bit Setting: For DTCE bit setting, read/write operations must be performed using bitmanipulation instructions such as BSET and BCLR. For the initial setting only, however, when multiple activation sources are set at one time, it is possible to disable interrupts and write after executing a dummy read on the relevant register.

Section 8 I/O Ports

8.1 Overview

The H8S/2138 Series and H8S/2134 Series have eight I/O ports (ports 1 to 6, 8, and 9), and one input-only port (port 7).

Tables 8.1 and 8.2 summarize the port functions. The pins of each port also have other functions.

Each port includes a data direction register (DDR) that controls input/output (not provided for the input-only port) and data registers (DR, ODR) that store output data.

Ports 1 to 3, and 6 have a built-in MOS input pull-up function. Ports 1 to 3 and 6 have a MOS input pull-up control register (PCR), in addition to DDR and DR, to control the on/off status of the MOS input pull-ups.

Ports 1 to 6, 8, and 9 can drive a single TTL load and 30 pF capacitive load. All the I/O ports can drive a Darlington transistor when in output mode. Ports 1, 2, and 3 can drive an LED (10 mA sink current).

In the H8S/2138 Series, P52 in port 5 and P97 in port 9 are NMOS push-pull outputs.

Note that the H8S/2134 Series has subset specifications that do not include some supporting modules. For differences in pin functions, see table 8.1, H8S/2138 Series Port Functions, and table 8.2, H8S/2134 Series Port Functions.

			Expa	nded Modes	Single-Chip Mode	
Port	Description	Pins	Mode 1	Mode 2, Mode 3 (EXPE = 1)	Mode 2, Mode 3 (EXPE = 0)	
Port 1	 8-bit I/O port Built-in MOS input pull-ups LED drive capability 	P17 to P10/ A7 to A0/ PW7 to PW0	Lower address output (A7 to A0)	When DDR = 0 (after reset): input port When DDR = 1: lower address output (A7 to A0) or PWM timer output (PW7 to PW0)	I/O port also functioning as PWM timer output (PW7 to PW0)	

Table 8.1 H8S/2138 Series Port Functions

			Expan	ded Modes	Single-Chip Mode
Port	Description	Pins	Mode 1	Mode 2, Mode 3 (EXPE = 1)	Mode 2, Mode 3 (EXPE = 0)
Port 2	 8-bit I/O port Built-in MOS input pull-ups LED drive 	P27/A15/PW15/ CBLANK P26/A14/PW14 P25/A13/PW13	Upper address output (A15 to A8)	When DDR = 0 (after reset): input port or timer connection output	I/O port also functioning as PWM timer output (PW15 to PW8) and timer connection output (CBLANK)
	capability CODEXIN() P24/A12/PW12 When DDR = 1: P23/A11/PW11 upper address P22/A10/PW10 output (A15 to A8) P21/A9/PW9 (PW15 to PW8), P20/A8/PW8 timer connection		When DDR = 1: upper address output (A15 to A8), PWM timer output (PW15 to PW8), timer connection output (CBLANK), or output ports		
Port 3	 8-bit I/O port Built-in MOS input pull-ups LED drive capability 	P37 to P30/ HDB7 to HDB0/ D7 to D0	Data bus input/	output (D7 to D0)	I/O port also functioning as host interface data bus input/output (HDB7 to HDB0)
Port 4	• 8-bit I/O port	P47/PWX1 P46/PWX0 P45/TMRI1/ HIRQ12/CSYNCI P44/TMO1/ HIRQ1/HSYNCO P43/TMCI1/ HIRQ11/HSYNCI P42/TMRI0/ SCK2/SDA1 P41/TMO0/ RxD2/IrRxD P40/TMCI0/ TxD2/IrTxD	I/O port also functioning as 14-bit PWM timer output (PWX1, PWX0), 8-bit timer 0 and 1 input/output (TMCI0, TMRI0, TMO0, TMCI1, TMRI1, TMO1), timer connection input/output (HSYNCO, CSYNCI, HSYNCI), SCI2 input/output (TxD2, RxD2, SCK2), IrDA interface input/output (IrTxD, IrRxD), and I ² C bus interface 1 (option) input/output (SDA1)		I/O port also functioning as 14-bit PWM timer output (PWX1, PWX0), 8-bit timer 0 and 1 input/ output (TMCI0, TMRI0, TMO0, TMCI1, TMRI1, TMO1), timer connection input/output (HSYNCO, CSYNCI, HSYNCI), host interface host CPU interrupt request output (HIRQ12, HIRQ1, HIRQ11), SCI2 input/ output (TxD2, RxD2, SCK2), IrDA interface input/output (IrTxD, IrRxD), and I ² C bus interface 1 (option) input/output (SDA1)

Table 8.1 H8S/2138 Series Port Functions (cont)

			Expanded Modes		Single-Chip Mode
Port	Description	Pins	Mode 1	Mode 2, Mode 3 (EXPE = 1)	Mode 2, Mode 3 (EXPE = 0)
Port 5	• 3-bit I/O port	P52/SCK0/SCL0	I/O port also f	unctioning as SCI0 inp	out/output (TxD0, RxD0, SCK0)
		P51/RxD0	and I ² C bus in	terface 0 (option) inpu	it/output (SCL0)
		P50/TxD0			
Port 6	• 8-bit I/O port	P67/IRQ7/TMOX/ KIN7/CIN7	•	Ũ	interrupt input (IRQ7, IRQ6), A, FTIB, FTIC, FTID, FTOB), 8-
		P66/IRQ6/FTOB/ KIN6/CIN6	connection in		VFBACKI, VSYNCI, VSYNCO,
		P65/FTID/KIN5/ CIN5		ey-sense interrupt inpu D converter input (CIN	
		P64/FTIC/KIN4/ CIN4/CLAMPO			
		P63/FTIB/KIN3/ CIN3/VFBACKI			
		P62/FTIA/TMIY/ KIN2/CIN2/ VSYNCI			
		P61/FTOA/KIN1/CIN 1/VSYNCO			
		P60/FTCI/TMIX/ KIN0/CIN0/ HFBACKI			
Port 7	 8-bit input 	P77/AN7/DA1		U U	onverter analog input (AN7 to
	port	P76/AN6/DA0	AN0) and D/A	converter analog out	put (DA1, DA0)
		P75/AN5			
		P74/AN4			
		P73/AN3			
		P72/AN2			
		P71/AN1			
		P70/AN0			

Table 8.1 H8S/2138 Series Port Functions (cont)

			Expan	ded Modes	Single-Chip Mode	
Port	Description	Pins	Mode 1	Mode 2, Mode 3 (EXPE = 1)	Mode 2, Mode 3 (EXPE = 0)	
Port 8	• 7-bit I/O port	P86/IRQ5/SCK1/SC L1 P85/IRQ4/RxD1 P84/IRQ3/TxD1 P83 P82/HIFSD P81/CS2/GA20 P80/HA0	interrupt input (I SCI1 input/	RQ5, IRQ4, IRQ3), exD1, SCK1), and e 1 (option)	I/O port also functioning as external interrupt input (IRQ5, IRQ4, IRQ3), SCI1 input/output (TxD1, RxD1, SCK1), host interface control input/output (CS2, GA20, HA0, HIFSD), and I ² C bus interface 1 (option) input/output (SCL1)	
Port 9	• 8-bit I/O port	P97/WAIT/SDA0	I/O port also fur expanded data (WAIT) and I ² C (option) input/or	bus control input bus interface 0	I/O port also functioning as I ² C bus interface 0 (option) input/output (SDA0)	
		P96/ø/EXCL	When DDR = 0: input port or EXCL input	When DDR = 0 (after input When DDR = 1: ø or	er reset): input port or EXCL	
			When DDR = 1 (after reset): ø output			
		P95/AS/IOS/CS1		bus control output	I/O port also functioning as	
		P94/WR/IOW	(as/ios , wr , f	RD)	host interface control input $(\overline{CS1}, \overline{IOW}, \overline{IOR})$	
		P93/RD/IOR			(001,1011,1011)	
		P92/IRQ0	I/O port also fur	nctioning as external i	nterrupt input (IRQ0, IRQ1)	
		P91/IRQ1				
		P90/IRQ2/ ADTRG/ECS2	I/O port also fur interrupt input (i converter extern (ADTRG)		I/O port also functioning as external interrupt input (IRQ2), A/D converter external trigger input (ADTRG), and host interface control input (ECS2)	

Table 8.1 H8S/2138 Series Port Functions (cont)

			Expan	ded Modes	Single-Chip Mode
Port	Description	Pins	Mode 1	Mode 2, Mode 3 (EXPE = 1)	Mode 2, Mode 3 (EXPE = 0)
Port 1	 8-bit I/O port Built-in MOS input pull-ups 	P17 to P10/ A7 to A0	Lower address output (A7 to A0)	When DDR = 0 (after reset): input port	I/O port
	 LED drive capability 			When DDR = 1: lower address output (A7 to A0)	
Port 2	 8-bit I/O port Built-in MOS input pull-ups 	P27 to P20/ A15 to A8	Upper address output (A15 to A8)	When DDR = 0 (after reset): input port	I/O port
	LED drive capability			When DDR = 1: upper address output (A15 to A8) or output port (P27 to P24)	
Port 3	 8-bit I/O port Built-in MOS input pull-ups LED drive capability 	P37 to P30/ D7 to D0	Data bus input/	output (D7 to D0)	I/O port
Port 4	• 8-bit I/O port	P47/PWX1	•	•	M timer output (PWX1,
		P46/PWX0	<i>,</i> .		ut (TMCl0, TMRl0, TMO0, utput (TxD2, RxD2, SCK2),
		P45/TMRI1		ace input/output (IrTxD	
		P44/TMO1			
		P43/TMCI1			
		P42/TMRI0/SCK2			
		P41/TMO0/RxD2/ IrRxD			
		P40/TMCI0/ TxD2/IrTxD			
Port 5	• 3-bit I/O port	P52/SCK0	I/O port also fur	nctioning as SCI0 inpu	t/output (TxD0, RxD0, SCK0)
		P51/RxD0			
		P50/TxD0			

Table 8.2 H8S/2134 Series Port Functions

			Expa	nded Modes	Single-Chip Mode		
Port	Description	Pins	Mode 1	Mode 2, Mode 3 (EXPE = 1)	Mode 2, Mode 3 (EXPE = 0)		
Port 6	8-bit I/O port	P67/IRQ7/KIN7/ CIN7 P66/IRQ6/FTOB/	I/O port also fu FRT input/out	unctioning as external i out (FTCI, FTOA, FTIA	interrupt input ($\overline{IRQ7}$, $\overline{IRQ6}$), A, FTIB, FTIC, FTID, FTOB), 8- nterrupt input ($\overline{KIN7}$ to $\overline{KIN0}$),		
		KIN6/CIN6	and expansion	A/D converter input (CIN7 to CIN0)		
		P65/FTID/KIN5/ CIN5					
		P64/FTIC/KIN4/ CIN4					
		P63/FTIB/KIN3/ CIN3					
		P62/FTIA/TMIY/ KIN2/CIN2					
		P61/FTOA/ KIN1 /CIN 1					
		P60/FTCI/KIN0/ CIN0					
Port 7	• 8-bit input	P77/AN7/DA1	Input port also functioning as A/D converter analog input (A				
	port	P76/AN6/DA0	AN0) and D/A converter analog output (DA1, DA0)				
		P75/AN5					
		P74/AN4					
		P73/AN3					
		P72/AN2					
		P71/AN1					
		P70/AN0					
Port 8	• 7-bit I/O port	P86/IRQ5/SCK1	•	-	interrupt input (IRQ5, IRQ4,		
		P85/IRQ4/RxD1	IRQ3) and SC	I1 input/output (TxD1,	RxD1, SCK1)		
		P84/IRQ3/TxD1					
		P83					
		P82					
		P81					
		P80					

Table 8.2 H8S/2134 Series Port Functions (cont)

			Expar	nded Modes	Single-Chip Mode
Port	Description	Pins	Mode 1	Mode 2, Mode 3 (EXPE = 1)	Mode 2, Mode 3 (EXPE = 0)
Port 9	• 8-bit I/O port	P97/WAIT	I/O port also fu expanded data (WAIT)	nctioning as bus control input	I/O port
		P96/ø/EXCL	When DDR = 0: input port or EXCL input	(r reset): input port or EXCL
			When DDR = 1 (after reset): ø output		
		P95/AS/IOS	Expanded data		I/O port
		P94/WR	output(AS/IOS	, WR, RD)	
		P93/RD			
		P92/IRQ0	I/O port also fu	nctioning as external ir	nterrupt input (IRQ0, IRQ1)
		P91/IRQ1			
		P90/IRQ2/ ADTRG	interrupt input (nctioning as external (TRQ2), and A/D mal trigger input	I/O port also functioning as external interrupt input (IRQ2) and A/D converter external trigger input (ADTRG)

Table 8.2 H8S/2134 Series Port Functions (cont)

8.2 Port 1

8.2.1 Overview

Port 1 is an 8-bit I/O port. Port 1 pins also function as address bus output pins (A7 to A0), and as 8-bit PWM output pins (PW7 to PW0) (H8S/2138 Series only). Port 1 functions change according to the operating mode. Port 1 has a built-in MOS input pull-up function that can be controlled by software.

Figure 8.1 shows the port 1 pin configuration.

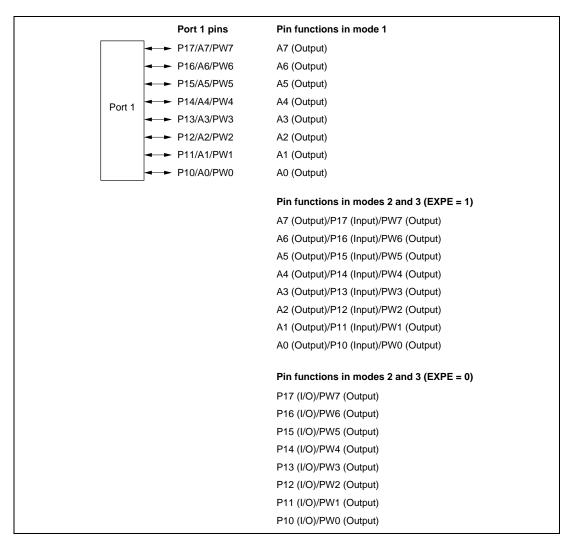


Figure 8.1 Port 1 Pin Functions

8.2.2 Register Configuration

Table 8.3 shows the port 1 register configuration.

Table 8.3Port 1 Registers

Name	Abbreviation	R/W	Initial Value	Address*
Port 1 data direction register	P1DDR	W	H'00	H'FFB0
Port 1 data register	P1DR	R/W	H'00	H'FFB2
Port 1 MOS pull-up control register	P1PCR	R/W	H'00	H'FFAC

Note: *Lower 16 bits of the address.

Port 1 Data Direction Register (P1DDR)

Bit	7	6	5	4	3	2	1	0
	P17DDR	P16DDR	P15DDR	P14DDR	P13DDR	P12DDR	P11DDR	P10DDR
Initial value	0	0	0	0	0	0	0	0
Read/Write	W	W	W	W	W	W	W	W

P1DDR is an 8-bit write-only register, the individual bits of which specify input or output for the pins of port 1. P1DDR cannot be read; if it is, an undefined value will be returned.

P1DDR is initialized to H'00 by a reset and in hardware standby mode. It retains its prior state in software standby mode. The address output pins maintain their output state in a transition to software standby mode.

• Mode 1

The corresponding port 1 pins are address outputs, regardless of the P1DDR setting. In hardware standby mode, the address outputs go to the high-impedance state.

- Modes 2 and 3 (EXPE = 1)
 The corresponding port 1 pins are address outputs or PWM outputs when P1DDR bits are set to 1, and input ports when cleared to 0.
- Modes 2 and 3 (EXPE = 0)

The corresponding port 1 pins are output ports or PWM outputs when P1DDR bits are set to 1, and input ports when cleared to 0.

Port 1 Data Register (P1DR)

Bit	7	6	5	4	3	2	1	0
	P17DR	P16DR	P15DR	P14DR	P13DR	P12DR	P11DR	P10DR
Initial value	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

P1DR is an 8-bit readable/writable register that stores output data for the port 1 pins (P17 to P10). If a port 1 read is performed while P1DDR bits are set to 1, the P1DR values are read, regardless of the actual pin states. If a port 1 read is performed while P1DDR bits are cleared to 0, the pin states are read.

P1DR is initialized to H'00 by a reset and in hardware standby mode. It retains its prior state in software standby mode.

Port 1 MOS Pull-Up Control Register (P1PCR)

Bit	7	6	5	4	3	2	1	0
	P17PCR	P16PCR	P15PCR	P14PCR	P13PCR	P12PCR	P11PCR	P10PCR
Initial value	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

P1PCR is an 8-bit readable/writable register that controls the port 1 built-in MOS input pull-ups on a bit-by-bit basis.

In modes 2 and 3, the MOS input pull-up is turned on when a P1PCR bit is set to 1 while the corresponding P1DDR bit is cleared to 0 (input port setting).

P1PCR is initialized to H'00 by a reset and in hardware standby mode. It retains its prior state in software standby mode.

8.2.3 Pin Functions in Each Mode

Mode 1: In mode 1, port 1 pins automatically function as address outputs. The port 1 pin functions are shown in figure 8.2.

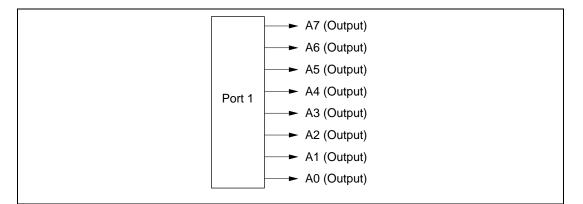


Figure 8.2 Port 1 Pin Functions (Mode 1)

Modes 2 and 3 (EXPE = 1): In modes 2 and 3 (when EXPE = 1), port 1 pins function as address outputs, PWM outputs, or input ports, and input or output can be specified on a bit-by-bit basis. When a bit in P1DDR is set to 1, the corresponding pin functions as an address output or PWM output, and when cleared to 0, as an input port.

The port 1 pin functions are shown in figure 8.3.

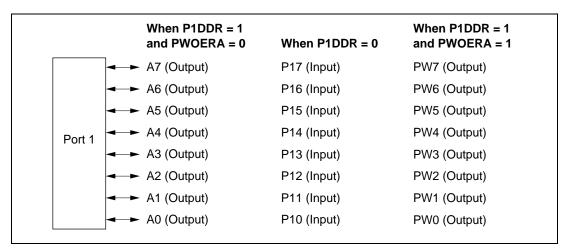


Figure 8.3 Port 1 Pin Functions (Modes 2 and 3 (EXPE = 1))

Modes 2 and 3 (EXPE = 0): In modes 2 and 3 (when EXPE = 0), port 1 pins function as PWM outputs or I/O ports, and input or output can be specified on a bit-by-bit basis. When a bit in P1DDR is set to 1, the corresponding pin functions as a PWM output or output port, and when cleared to 0, as an input port.

The port 1 pin functions are shown in figure 8.4.

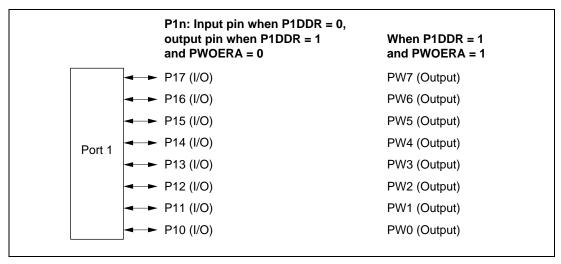


Figure 8.4 Port 1 Pin Functions (Modes 2 and 3 (EXPE = 0))

8.2.4 MOS Input Pull-Up Function

Port 1 has a built-in MOS input pull-up function that can be controlled by software. This MOS input pull-up function can be used in modes 2 and 3, and can be specified as on or off on a bit-by-bit basis.

When a P1DDR bit is cleared to 0 in mode 2 or 3, setting the corresponding P1PCR bit to 1 turns on the MOS input pull-up for that pin.

The MOS input pull-up function is in the off state after a reset and in hardware standby mode. The prior state is retained in software standby mode.

Table 8.4 summarizes the MOS input pull-up states.

Table 8.4MOS Input Pull-Up States (Port 1)

Mode	Reset	Hardware Standby Mode	Software Standby Mode	In Other Operations
1	Off	Off	Off	Off
2, 3	Off	Off	On/Off	On/Off

Legend:

Off: MOS input pull-up is always off.

On/Off: On when P1DDR = 0 and P1PCR = 1; otherwise off.

8.3 Port 2

8.3.1 Overview

Port 2 is an 8-bit I/O port. Port 2 pins also function as address bus output pins (A15 to A8), 8-bit PWM output pins (PW15 to PW8) (H8S/2138 Series only), and the timer connection output pin (CBLANK) (H8S/2138 Series only). Port 2 functions change according to the operating mode. Port 2 has a built-in MOS input pull-up function that can be controlled by software.

Figure 8.5 shows the port 2 pin configuration.

		Port 2 pins	Pin functions in mode 1
		P27/A15/PW15/CBLANK	A15 (Output)
		- P26/A14/PW14	A14 (Output)
		- P25/A13/PW13	A13 (Output)
Port 2		P24/A12/PW12	A12 (Output)
1 011 2		- P23/A11/PW11	A11 (Output)
		- P22/A10/PW10	A10 (Output)
		- P21/A9/PW9	A9 (Output)
	~	- P20/A8/PW8	A8 (Output)
			Pin functions in modes 2 and 3 (EXPE = 1)
			A15 (Output)/P27 (I/O)/PW15 (Output)/CBLANK (Output)
			A14 (Output)/P26 (I/O)/PW14 (Output)
			A13 (Output)/P25 (I/O)/PW13 (Output)
			A12 (Output)/P24 (I/O)/PW12 (Output)
			A11 (Output)/P23 (Input)/PW11 (Output)
			A10 (Output)/P22 (Input)/PW10 (Output)
			A9 (Output)/P21 (Input)/PW9 (Output)
			A8 (Output)/P20 (Input)/PW8 (Output)
			Pin functions in modes 2 and 3 (EXPE = 0)
			P27 (I/O)/PW15 (Output)/CBLANK (Output)
			P26 (I/O)/PW14 (Output)
			P25 (I/O)/PW13 (Output)
			P24 (I/O)/PW12 (Output)
			P23 (I/O)/PW11 (Output)
			P22 (I/O)/PW10 (Output)
			P21 (I/O)/PW9 (Output)
			P20 (I/O)/PW8 (Output)

Figure 8.5 Port 2 Pin Functions

8.3.2 Register Configuration

Table 8.5 shows the port 2 register configuration.

Table 8.5Port 2 Registers

Name	Abbreviation	R/W	Initial Value	Address*
Port 2 data direction register	P2DDR	W	H'00	H'FFB1
Port 2 data register	P2DR	R/W	H'00	H'FFB3
Port 2 MOS pull-up control register	P2PCR	R/W	H'00	H'FFAD

Note: *Lower 16 bits of the address.

Port 2 Data Direction Register (P2DDR)

Bit	7	6	5	4	3	2	1	0
	P27DDR	P26DDR	P25DDR	P24DDR	P23DDR	P22DDR	P21DDR	P20DDR
Initial value	0	0	0	0	0	0	0	0
Read/Write	W	W	W	W	W	W	W	W

P2DDR is an 8-bit write-only register, the individual bits of which specify input or output for the pins of port 2. P2DDR cannot be read; if it is, an undefined value will be returned.

P2DDR is initialized to H'00 by a reset and in hardware standby mode. It retains its prior state in software standby mode. The address output pins maintain their output state in a transition to software standby mode.

• Mode 1

The corresponding port 2 pins are address outputs, regardless of the P2DDR setting. In hardware standby mode, the address outputs go to the high-impedance state.

• Modes 2 and 3 (EXPE = 1)

The corresponding port 2 pins are address outputs or PWM outputs when P2DDR bits are set to 1, and input ports when cleared to 0. P27 to P24 are switched from address outputs to output ports by setting the IOSE bit to 1.

P27 can be used as an on-chip supporting module output pin regardless of the P27DDR setting, but to ensure normal access to external space, P27 should not be set as an on-chip supporting module output pin when port 2 pins are used as address output pins.

• Modes 2 and 3 (EXPE = 0)

The corresponding port 2 pins are output ports or PWM outputs when P2DDR bits are set to 1, and input ports when cleared to 0.

P27 can be used as an on-chip supporting module output pin regardless of the P27DDR setting.

Port 2 Data Register (P2DR)

Bit	7	6	5	4	3	2	1	0
	P27DR	P26DR	P25DR	P24DR	P23DR	P22DR	P21DR	P20DR
Initial value	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

P2DR is an 8-bit readable/writable register that stores output data for the port 2 pins (P27 to P20). If a port 2 read is performed while P2DDR bits are set to 1, the P2DR values are read directly, regardless of the actual pin states. If a port 2 read is performed while P2DDR bits are cleared to 0, the pin states are read.

P2DR is initialized to H'00 by a reset and in hardware standby mode. It retains its prior state in software standby mode.

Port 2 MOS Pull-Up Control Register (P2PCR)

Bit	7	6	5	4	3	2	1	0
	P27PCR	P26PCR	P25PCR	P24PCR	P23PCR	P22PCR	P21PCR	P20PCR
Initial value	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

P2PCR is an 8-bit readable/writable register that controls the port 2 built-in MOS input pull-ups on a bit-by-bit basis.

In modes 2 and 3, the MOS input pull-up is turned on when a P2PCR bit is set to 1 while the corresponding P2DDR bit is cleared to 0 (input port setting).

P2PCR is initialized to H'00 by a reset and in hardware standby mode. It retains its prior state in software standby mode.

8.3.3 Pin Functions in Each Mode

Mode 1: In mode 1, port 2 pins automatically function as address outputs. The port 2 pin functions are shown in figure 8.6.

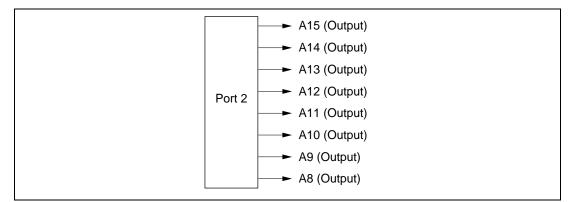


Figure 8.6 Port 2 Pin Functions (Mode 1)

Modes 2 and 3 (EXPE = 1): In modes 2 and 3 (when EXPE = 1), port 2 pins function as address outputs, PWM outputs, or I/O ports, and input or output can be specified on a bit-by-bit basis. When a bit in P2DDR is set to 1, the corresponding pin functions as an address output or PWM output, and when cleared to 0, as an input port. P27 to P24 are switched from address outputs to output ports by setting the IOSE bit to 1. P27 can be used as an on-chip supporting module output pin regardless of the P27DDR setting, but to ensure normal access to external space, P27 should not be set as an on-chip supporting module output pin when port 2 pins are used as address output pins.

The port 2 pin functions are shown in figure 8.7.

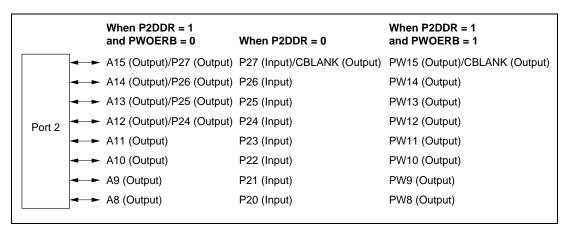


Figure 8.7 Port 2 Pin Functions (Modes 2 and 3 (EXPE = 1))

Modes 2 and 3 (EXPE = 0): In modes 2 and 3 (when EXPE = 0), port 2 pins function as PWM outputs (P27 can also function as the timer connection output (CBLANK)) or I/O ports, and input or output can be specified on a bit-by-bit basis. When a bit in P2DDR is set to 1, the corresponding pin functions as a PWM output or output port, and when cleared to 0, as an input port. P27 can be used as an on-chip supporting module output pin regardless of the P27DDR setting.

The port 2 pin functions are shown in figure 8.8.

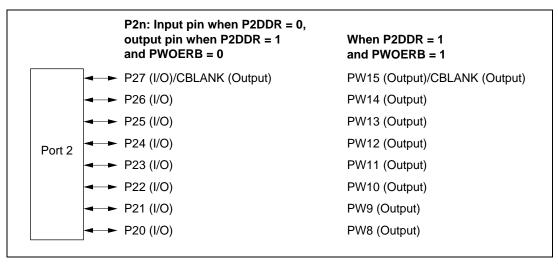


Figure 8.8 Port 2 Pin Functions (Modes 2 and 3 (EXPE = 0))

8.3.4 MOS Input Pull-Up Function

Port 2 has a built-in MOS input pull-up function that can be controlled by software. This MOS input pull-up function can be used in modes 2 and 3, and can be specified as on or off on a bit-by-bit basis.

When a P2DDR bit is cleared to 0 in mode 2 or 3, setting the corresponding P2PCR bit to 1 turns on the MOS input pull-up for that pin.

The MOS input pull-up function is in the off state after a reset and in hardware standby mode. The prior state is retained in software standby mode.

Table 8.6 summarizes the MOS input pull-up states.

Table 8.6MOS Input Pull-Up States (Port 2)

Mode	Reset	Hardware Standby Mode	Software Standby Mode	In Other Operations
1	Off	Off	Off	Off
2, 3	Off	Off	On/Off	On/Off

Legend:

Off: MOS input pull-up is always off.

On/Off: On when P2DDR = 0 and P2PCR = 1; otherwise off.

8.4 Port 3

8.4.1 Overview

Port 3 is an 8-bit I/O port. Port 3 pins also function as host data bus I/O pins (HDB7 to HDB0) (H8S/2138 Series only), and as data bus I/O pins. Port 3 functions change according to the operating mode. Port 3 has a built-in MOS input pull-up function that can be controlled by software.

Figure 8.9 shows the port 3 pin configuration.

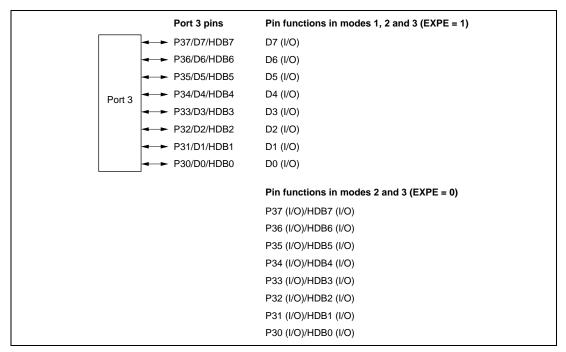


Figure 8.9 Port 3 Pin Functions

8.4.2 Register Configuration

Table 8.7 shows the port 3 register configuration.

Table 8.7Port 3 Registers

Name	Abbreviation	R/W	Initial Value	Address*
Port 3 data direction register	P3DDR	W	H'00	H'FFB4
Port 3 data register	P3DR	R/W	H'00	H'FFB6
Port 3 MOS pull-up control register	P3PCR	R/W	H'00	H'FFAE

Note: *Lower 16 bits of the address.

Port 3 Data Direction Register (P3DDR)

Bit	7	6	5	4	3	2	1	0
	P37DDR	P36DDR	P35DDR	P34DDR	P33DDR	P32DDR	P31DDR	P30DDR
Initial value	0	0	0	0	0	0	0	0
Read/Write	W	W	W	W	W	W	W	W

P3DDR is an 8-bit write-only register, the individual bits of which specify input or output for the pins of port 3. P3DDR cannot be read; if it is, an undefined value will be returned.

P3DDR is initialized to H'00 by a reset and in hardware standby mode. It retains its prior state in software standby mode.

• Modes 1, 2, and 3 (EXPE = 1)

The input/output direction specified by P3DDR is ignored, and pins automatically function as data I/O pins.

After a reset, and in hardware standby mode or software standby mode, the data I/O pins go to the high-impedance state.

• Modes 2 and 3 (EXPE = 0)

The corresponding port 3 pins are output ports when P3DDR bits are set to 1, and input ports when cleared to 0.

Port 3 Data Register (P3DR)

Bit	7	6	5	4	3	2	1	0
	P37DR	P36DR	P35DR	P34DR	P33DR	P32DR	P31DR	P30DR
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W							

P3DR is an 8-bit readable/writable register that stores output data for the port 3 pins (P37 to P30). If a port 3 read is performed while P3DDR bits are set to 1, the P3DR values are read directly, regardless of the actual pin states. If a port 3 read is performed while P3DDR bits are cleared to 0, the pin states are read.

P3DR is initialized to H'00 by a reset and in hardware standby mode. It retains its prior state in software standby mode.

Port 3 MOS Pull-Up Control Register (P3PCR)

Bit	7	6	5	4	3	2	1	0
	P37PCR	P36PCR	P35PCR	P34PCR	P33PCR	P32PCR	P31PCR	P30PCR
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W							

P3PCR is an 8-bit readable/writable register that controls the port 3 built-in MOS input pull-ups on a bit-by-bit basis.

In modes 2 and 3 (when EXPE = 0), the MOS input pull-up is turned on when a P3PCR bit is set to 1 while the corresponding P3DDR bit is cleared to 0 (input port setting).

P3PCR is initialized to H'00 by a reset and in hardware standby mode. It retains its prior state in software standby mode.

The MOS input pull-up function cannot be used in slave mode (when the host interface is enabled).

8.4.3 Pin Functions in Each Mode

Modes 1, 2, and 3 (EXPE = 1): In modes 1, 2, and 3 (when EXPE = 1), port 3 pins automatically function as data I/O pins. The port 3 pin functions are shown in figure 8.10.

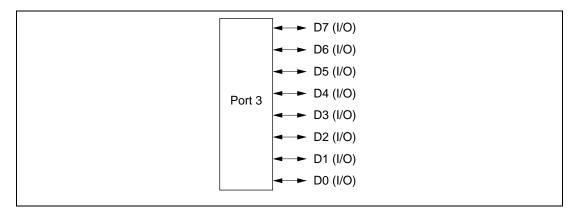


Figure 8.10 Port 3 Pin Functions (Modes 1, 2, and 3 (EXPE = 1))

Modes 2 and 3 (EXPE = 0): In modes 2 and 3 (when EXPE = 0), port 3 functions as host interface data bus I/O pins (HDB7 to HDB0) or as I/O ports. When the HI12E bit is set to 1 in SYSCR2 and a transition is made to slave mode, port 3 functions as the host interface data bus. In slave mode, P3DR and P3DDR should be cleared to H'00. When the HI12E bit is cleared to 0, port 3 functions as an I/O port, and input or output can be specified on a bit-by-bit basis. When a bit in P3DDR is set to 1, the corresponding pin functions as an output port, and when cleared to 0, as an input port.

The port 3 pin functions are shown in figure 8.11.

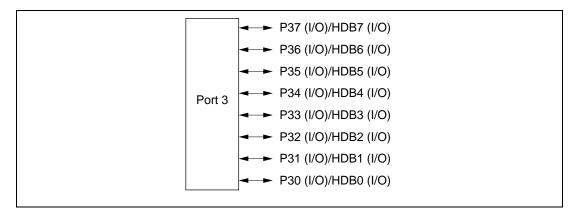


Figure 8.11 Port 3 Pin Functions (Modes 2 and 3 (EXPE = 0))

8.4.4 MOS Input Pull-Up Function

Port 3 has a built-in MOS input pull-up function that can be controlled by software. This MOS input pull-up function can be used in modes 2 and 3 (when EXPE = 0), and can be specified as on or off on a bit-by-bit basis.

When a P3DDR bit is cleared to 0 in mode 2 or 3 (when EXPE = 0), setting the corresponding P3PCR bit to 1 turns on the MOS input pull-up for that pin.

The MOS input pull-up function is in the off state after a reset and in hardware standby mode. The prior state is retained in software standby mode.

Table 8.8 summarizes the MOS input pull-up states.

Table 8.8MOS Input Pull-Up States (Port 3)

Mode	Reset	Hardware Standby Mode	Software Standby Mode	In Other Operations
1, 2, 3 (EXPE = 1) Off	Off	Off	Off
2, 3 (EXPE = 0)	Off	Off	On/Off	On/Off

Legend:

Off: MOS input pull-up is always off.

On/Off: On when P3DDR = 0 and P3PCR = 1; otherwise off.

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8.5 Port 4

8.5.1 Overview

Port 4 is an 8-bit I/O port. Port 4 pins also function as 14-bit PWM output pins (PWX1, PWX0), 8-bit timer 0 and 1 (TMR0, TMR1) I/O pins (TMCI0, TMRI0, TMO0, TMCI1, TMRI1, TMO1), timer connection I/O pins (CSYNCI, HSYNCI, HSYNCO) (H8S/2138 Series only), SCI2 I/O pins (TxD2, RxD2, SCK2), IrDA interface I/O pins (IrTxD, IrRxD), host interface output pins (HIRQ12, HIRQ1, HIRQ11) (H8S/2138 Series only), and the IIC1 I/O pin (SDA1) (option in H8S/2138 Series only). Port 4 pin functions are the same in all operating modes.

Figure 8.12 shows the port 4 pin configuration.

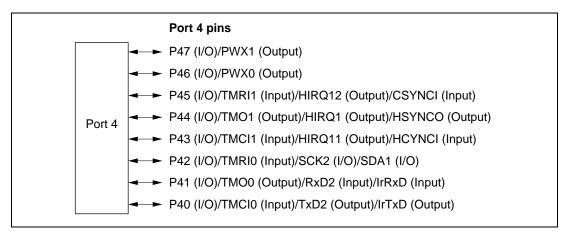


Figure 8.12 Port 4 Pin Functions

8.5.2 Register Configuration

Table 8.9 shows the port 4 register configuration.

Table 8.9Port 4 Registers

Name	Abbreviation	R/W	Initial Value	Address*
Port 4 data direction register	P4DDR	W	H'00	H'FFB5
Port 4 data register	P4DR	R/W	H'00	H'FFB7

Note: *Lower 16 bits of the address.

Port 4 Data Direction Register (P4DDR)

Bit	7	6	5	4	3	2	1	0
	P47DDR	P46DDR	P45DDR	P44DDR	P43DDR	P42DDR	P41DDR	P40DDR
Initial value	0	0	0	0	0	0	0	0
Read/Write	W	W	W	W	W	W	W	W

P4DDR is an 8-bit write-only register, the individual bits of which specify input or output for the pins of port 4. P4DDR cannot be read; if it is, an undefined value will be returned.

When a bit in P4DDR is set to 1, the corresponding pin functions as an output port, and when cleared to 0, as an input port.

P4DDR is initialized to H'00 by a reset and in hardware standby mode. It retains its prior state in software standby mode. As 14-bit PWM and SCI2 are initialized in software standby mode, the pin states are determined by the TMR0, TMR1, HIF, IIC1, P4DDR, and P4DR specifications.

Port 4 Data Register (P4DR)

Bit	7	6	5	4	3	2	1	0
	P47DR	P46DR	P45DR	P44DR	P43DR	P42DR	P41DR	P40DR
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W							

P4DR is an 8-bit readable/writable register that stores output data for the port 4 pins (P47 to P40). If a port 4 read is performed while P4DDR bits are set to 1, the P4DR values are read directly, regardless of the actual pin states. If a port 4 read is performed while P4DDR bits are cleared to 0, the pin states are read.

P4DR is initialized to H'00 by a reset and in hardware standby mode. It retains its prior state in software standby mode.

8.5.3 Pin Functions

Port 4 pins also function as 14-bit PWM output pins (PWX1, PWX0), 8-bit timer 0 and 1 (TMR0, TMR1) I/O pins (TMCI0, TMRI0, TMO0, TMCI1, TMRI1, TMO1), timer connection I/O pins (CSYNCI, HSYNCI, HSYNCO), SCI2 I/O pins (TxD2, RxD2, SCK2), IrDA interface I/O pins (IrTxD, IrRxD), host interface output pins (HIRQ12, HIRQ1, HIRQ11), and the IIC1 I/O pin (SDA1). The port 4 pin functions are shown in table 8.10.

Pin	Selection Meth	od and Pin Fu	nctions							
P47/PWX1	The pin function DACR of 14-bit			according to the	combination of	f bit OEB in				
	OEB		0			1				
	P47DDR	0		1		_				
	Pin function	P47 inpu	t pin	P47 output pin	PWX1	output pin				
P46/PWX0	The pin function DACR of 14-bit			according to the	combination of	f bit OEA in				
	OEA		0			1				
	P46DDR	0		1		_				
	Pin function	P46 input pin		P46 output pin	PWX0	output pin				
HIRQ12/CSYNCI	mode and bit P4 P45DDR				1					
P45/TMRI1/ HIRQ12/CSYNCI	mode and bit P4									
	Operating mode			Not slave mode		ve mode				
	Pin function	P45 inpu		P45 output pin	HIRQ12 output pin					
				nput pin, CSYNC						
P44/TMO1/ HIRQ1/HSYNCO	TMRI1 input pin	When bits CCLR1 and CCLR0 in TCR1 of TMR1 are set to 1, this pin is used as the TMRI1 input pin. It can also be used as the CSYNCI input pin. The pin function is switched as shown below according to the combination of the operating mode, bits OS3 to OS0 in TCSR of TMR1, bit HOE in TCONRO of the timer connection								
	HOE			0		1				
	OS3 to OS0		All 0		Not all 0	_				
	P44DDR	0		1	_					
	Operating mode		Not slave mode	Slave mode	—					
	Pin function	P44	P44	HIRQ1 output	TMO1 output	HSYNCO				

Table 8.10Port 4 Pin Functions

Table 8.10 Port 4 Pin Functions (cont)

P43/TMCI1/ HIRQ11/HSYNCI	The pin functi the operating				according f	to the comb	ination of
	P43DDR	(0			1	
	Operating mode	_	_	Not slav	ve mode	Slave mode	
	Pin function	P43 in	put pin	P43 output pin		HIRQ11	output pin
			TMCI1	input pin,	HSYNCI ir	nput pin	
	input pin.						
P42/TMRI0/ SCK2/SDA1	The pin functi bit ICE in ICC of SCI2, and I	R of IIC1,	bits CKE1		•		
	The pin functi bit ICE in ICC	R of IIC1,	bits CKE1		•		
	The pin functi bit ICE in ICC of SCI2, and I	R of IIC1,	bits CKE1 : R.	and CKE0	•		Ā in SMR
	The pin functi bit ICE in ICC of SCI2, and I ICE	R of IIC1,	bits CKE1 : R.	and CKE0	•	SCI2, bit C/	A in SMR
	The pin functi bit ICE in ICC of SCI2, and I ICE CKE1	R of IIC1, I bit P42DDF	bits CKE1 : R.	and CKE0	in SCR of	SCI2, bit C/	7 in SMR 1 0
	The pin functi bit ICE in ICC of SCI2, and I ICE CKE1 C/Ā	R of IIC1, I bit P42DDF	bits CKE1 : R.	and CKE0 0 D	in SCR of	SCI2, bit C/	A in SMR 1 0 0 0
	The pin functi bit ICE in ICC of SCI2, and I ICE CKE1 C/Ā CKE0	R of IIC1, I bit P42DDF	bits CKE1 R. 0 0 1 P42	and CKE0 0 D	In SCR of	SCI2, bit C/	A in SMR 1 0 0 0

only output, and has direct bus drive capability. When bits CCLR1 and CCLR0 in TCR0 of TMR0 are set to 1, this pin is used as the TMRI0 input pin.

Table 8.10 Port 4 Pin Functions (cont)

Pin function

Pin	Selection Me	thod and Pin F	unctio	ons				
P41/TMO0/RxD2/ IrRxD		on is switched a S0 in TCSR of T			0			
	OS3 to OS0	All 0 Not all 0						
	RE	0			1		0	
	P41DDR	0		1	—		—	
	Pin function	P41 input pin	ou	P41 tput pin	RxD2/Irf input p		TMO0 output pin	
	When this pin cleared to 0.	is used as the T	ГMO0	output pin	, bit RE in	SCR	of SCI2 must be	
P40/TMCI0/TxD2/ IrTxD		on is switched a of SCI2 and bit			according t	o the	combination of	
	TE		C)			1	
	P40DDR	0		1			—	

P40

input pin

 TMCI0 input pin

 When an external clock is selected with bits CKS2 to CKS0 in TCR0 of TMR0, this pin is used as the TMCI0 input pin.

P40

output pin

TxD2/IrTxD

output pin

8.6 Port 5

8.6.1 Overview

Port 5 is a 3-bit I/O port. Port 5 pins also function as SCI0 I/O pins (TxD0, RxD0, SCK0), and the IIC0 I/O pin (SCL0) (option in H8S/2138 Series only). In the H8S/2138 Series, P52 and SCK0 are NMOS push-pull outputs, and SCL0 is an NMOS open-drain output. Port 5 pin functions are the same in all operating modes.

Figure 8.13 shows the port 5 pin configuration.

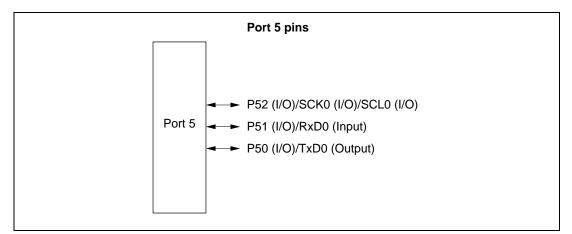


Figure 8.13 Port 5 Pin Functions

8.6.2 Register Configuration

Table 8.11 shows the port 5 register configuration.

Table 8.11Port 5 Registers

Name	Abbreviation	R/W	Initial Value	Address*
Port 5 data direction register	P5DDR	W	H'F8	H'FFB8
Port 5 data register	P5DR	R/W	H'F8	H'FFBA

Note: *Lower 16 bits of the address.

Port 5 Data Direction Register (P5DDR)

Bit	7	6	5	4	3	2	1	0
	—	—	—	—	—	P52DDR	P51DDR	P50DDR
Initial value	1	1	1	1	1	0	0	0
Read/Write	—	—	—	—	—	W	W	W

P5DDR is an 8-bit write-only register, the individual bits of which specify input or output for the pins of port 5. P5DDR cannot be read; if it is, an undefined value will be returned. Bits 7 to 3 are reserved.

Setting a P5DDR bit to 1 makes the corresponding port 5 pin an output pin, while clearing the bit to 0 makes the pin an input pin.

P5DDR is initialized to H'F8 by a reset and in hardware standby mode. It retains its prior state in software standby mode. As SCI0 is initialized, the pin states are determined by the IIC0 ICCR, P5DDR, and P5DR specifications.

Port 5 Data Register (P5DR)

Bit	7	6	5	4	3	2	1	0
	—	—	—	—	—	P52DR	P51DR	P50DR
Initial value	1	1	1	1	1	0	0	0
Read/Write	—	—	—	—	—	R/W	R/W	R/W

P5DR is an 8-bit readable/writable register that stores output data for the port 5 pins (P52 to P50). If a port 5 read is performed while P5DDR bits are set to 1, the P5DR values are read directly, regardless of the actual pin states. If a port 5 read is performed while P5DDR bits are cleared to 0, the pin states are read.

Bits 7 to 3 are reserved; they cannot be modified and are always read as 1.

P5DR is initialized to H'F8 by a reset and in hardware standby mode. It retains its prior state in software standby mode.

8.6.3 Pin Functions

Port 5 pins also function as SCI0 I/O pins (TxD0, RxD0, SCK0) and the IIC0 I/O pin (SCL0). The port 5 pin functions are shown in table 8.12.

Table 8.12Port 5 Pin Functions

Pin	Selection Me	thod and	Pin Functi	ons				
P52/SCK0/SCL0	The pin function is switched as shown below according to the combination of bits CKE1 and CKE0 in SCR of SCI0, bit C/ \overline{A} in SMR of SCI0, bit ICE in ICCR of IIC0, and bit P52DDR.							
	ICE		0					
	CKE1		0					
	C/Ā		0		1	_	0	
	CKE0	(C	1		_	0	
	P52DDR	0	1	—		—	_	
	Pin function	P52 input pin	P52 output pin	SCK0 output pin	SCK0 output pin	SCK0 input pin	SCL0 I/O pin	
	When this pin is used as the SCL0 I/O pin, bits CKE1 and CKE0 in SCR of SCI0 and bit C/\overline{A} in SMR of SCI0 must all be cleared to 0.							
P51/RxD0	SCL0 is an NMOS open-drain output, and has direct bus drive capability. In the H8S/2138 Series, when set as the P52 output pin or SCK0 output pin, this pin is an NMOS push-pull output. The pin function is switched as shown below according to the combination of bit RE in SCR of SCI0 and bit P51DDR.							
	RE		()		1		
	P51DDR	()	1		_	_	
	Pin function	P51 in	put pin	P51 output pin		RxD0 input pin		
P50/TxD0	The pin function is switched as shown below according to the combination of bit TE in SCR of SCI0 and bit P50DDR.							
P50/TxD0					according to	o the comb	ination of	
P50/TxD0			nd bit P50D		according to	o the comb		
P50/TxD0	bit TE in SCR	of SCI0 ar	nd bit P50D	DR.				

8.7 Port 6

8.7.1 Overview

Port 6 is an 8-bit I/O port. Port 6 pins also function as the 16-bit free-running timer (FRT) I/O pins (FTOA, FTOB, FTIA to FTID, FTCI), timer X (TMRX) I/O pins (TMOX, TMIX) (H8S/2138 Series only), the timer Y (TMRY) input pin (TMIY), timer connection I/O pins (HFBACKI, VSYNCI, VSYNCO, VFBACKI, CLAMPO) (H8S/2138 Series only), key-sense interrupt input pins ($\overline{KIN7}$ to $\overline{KIN0}$), expansion A/D converter input pins (CIN7 to CIN0), and external interrupt input pins ($\overline{IRQ7}$, $\overline{IRQ6}$). In the H8S/2138 Series, the port 6 input level can be switched in four stages. Port 6 pin functions are the same in all operating modes.

Figure 8.14 shows the port 6 pin configuration.

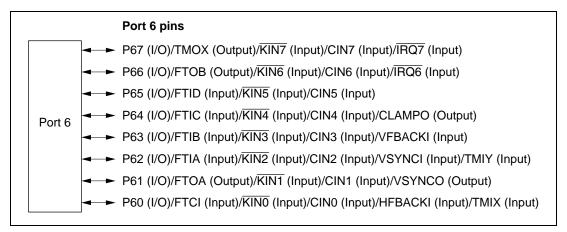


Figure 8.14 Port 6 Pin Functions

8.7.2 Register Configuration

Table 8.13 shows the port 6 register configuration.

Table 8.13Port 6 Registers

Name	Abbreviation	R/W	Initial Value	Address*1
Port 6 data direction register	P6DDR	W	H'00	H'FFB9
Port 6 data register	P6DR	R/W	H'00	H'FFBB
Port 6 MOS pull-up control register	KMPCR	R/W	H'00	H'FFF2* ²
System control register 2	SYSCR2	R/W	H'00	H'FF83

Notes: 1. Lower 16 bits of the address.

2. KMPCR has the same address as TICRR/TCORAY of TMRX/TMRY. To select KMPCR, set the HIF bit to 1 in SYSCR and clear the MSTP2 bit to 0 in MSTPCRL.

Port 6 Data Direction Register (P6DDR)

Bit	7	6	5	4	3	2	1	0
	P67DDR	P66DDR	P65DDR	P64DDR	P63DDR	P62DDR	P61DDR	P60DDR
Initial value	0	0	0	0	0	0	0	0
Read/Write	W	W	W	W	W	W	W	W

P6DDR is an 8-bit write-only register, the individual bits of which specify input or output for the pins of port 6. P6DDR cannot be read; if it is, an undefined value will be returned.

Setting a P6DDR bit to 1 makes the corresponding port 6 pin an output pin, while clearing the bit to 0 makes the pin an input pin.

P6DDR is initialized to H'00 by a reset and in hardware standby mode. It retains its prior state in software standby mode.

Port 6 Data Register (P6DR)

Bit	7	6	5	4	3	2	1	0
	P67DR	P66DR	P65DR	P64DR	P63DR	P62DR	P61DR	P60DR
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W							

P6DR is an 8-bit readable/writable register that stores output data for the port 6 pins (P67 to P60). If a port 6 read is performed while P6DDR bits are set to 1, the P6DR values are read directly, regardless of the actual pin states. If a port 6 read is performed while P6DDR bits are cleared to 0, the pin states are read.

P6DR is initialized to H'00 by a reset and in hardware standby mode. It retains its prior state in software standby mode.

Port 6 MOS Pull-Up Control Register (KMPCR)

Bit	7	6	5	4	3	2	1	0
	KM7PCR	KM6PCR	KM5PCR	KM4PCR	KM3PCR	KM2PCR	KM1PCR	KM0PCR
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W							

KMPCR is an 8-bit readable/writable register that controls the port 6 built-in MOS input pullups on a bit-by-bit basis.

The MOS input pull-up is turned on when a KMPCR bit is set to 1 while the corresponding P6DDR bit is cleared to 0 (input port setting).

KMPCR is initialized to H'00 by a reset and in hardware standby mode. It retains its prior state in software standby mode.

System Control Register 2 (SYSCR2) [H8S/2138 Series Only]

Bit	7	6	5	4	3	2	1	0
	KWUL1	KWUL0	P6PUE	_	SDE	CS4E	CS3E	HI12E
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	—	R/W	R/W	R/W	R/W

SYSCR2 is an 8-bit readable/writable register that controls port 6 input level selection and the operation of host interface functions.

Only bits 7, 6, and 5 are described here. See section 17.2.2, System Control Register 2 (SYSCR2), for information on bits 4 to 0.

SYSCR2 is initialized to H'00 by a reset and in hardware standby mode.

Bits 7 and 6—Key Wakeup Level 1 and 0 (KWUL1, KWUL0): The port 6 input level setting can be changed by software, using these bits. The setting of these bits also changes the input level of the pin functions multiplexed with port 6.

Bit 7	Bit 6		
KWUL1	KWUL0	Description	
0	0	Standard input level is selected as port 6 input level	(Initial value)
	1	Input level 1 is selected as port 6 input level	
1	0	Input level 2 is selected as port 6 input level	
	1	Input level 3 is selected as port 6 input level	

Bit 5—Port 6 Input Pull-Up Extra (P6PUE): Controls and selects the current specification for the port 6 MOS input pull-up function connected by means of KMPCR settings.

Bit 5	
P6PUE	Description
0	Standard current specification is selected for port 6 MOS input pull-up function (Initial value)
1	Current-limit specification is selected for port 6 MOS input pull-up function

8.7.3 Pin Functions

Port 6 pins also function as the 16-bit free-running timer (FRT) I/O pins (FTOA, FTOB, FTIA to FTID, FTCI), timer X (TMRX) I/O pins (TMOX, TMIX), the timer Y (TMRY) input pin (TMIY), timer connection I/O pins (HFBACKI, VSYNCI, VSYNCO, VFBACKI, CLAMPO), key-sense interrupt input pins (KIN7 to KIN0), expansion A/D converter input pins (CIN7 to CIN0), and external interrupt input pins (IRQ7, IRQ6). In the H8S/2138 Series, the port 6 input level can be switched in four stages. The port 6 pin functions are shown in table 8.14.

Table 8.14Port 6 Pin Functions

Pin	Selection Me	thod and Pin Functi	ons				
P67/TMOX/IRQ7/ KIN7/CIN7		on is switched as sho S0 in TCSR of TMRX		0	o the combination of		
	OS3 to OS0	AI	Not all 0				
	P67DDR	0	1				
	Pin function	P67 input pin	P67 ou	tput pin	TMOX output pin		
		IRQ7 input	pin, KIN7 ir	nput pin, C	IN7 input pin		
	This pin is use	ed as the IRQ7 input	pin when b	it IRQ7E is	set to 1 in IER.		
	It can always	be used as the $\overline{KIN7}$	or CIN7 inp	out pin.			
P66/FTOB/IRQ6/ KIN6/CIN6		function is switched as shown below according to the combination in TOCR of the FRT and bit P66DDR.					
	P66DDR	0	1		1		
	Pin function	P66 input pin		tput pin	FTOB output pin		
	1 In function	IRQ6 input					
	This pin is use	ed as the IRQ6 input	pin when b	it IRQ6E is	set to 1 in IER.		
		be used as the $\overline{KIN6}$					
P65/FTID/KIN5/	P65DDR	0			1		
CIN5	Pin function	P65 input p	in	Р	65 output pin		
		FTID input	oin, KIN5 ir	put pin, Cl	N5 input pin		
	T I ' ' ' ' ' ' ' ' ' ' ' ' ' ' ' ' ' ' '			=			

This pin can always be used as the FTID, KIN5, or CIN5 input pin.

Table 8.14 Port 6 Pin Functions (cont)

Pin	Selection Me	thod and Pin F	unctio	าร					
P64/FTIC/KIN4/ CIN4/CLAMPO		on is switched a CONRO of the ti				e combination of it P64DDR.			
	CLOE			1					
	P64DDR	0		1		_			
	Pin function	P64		P	64	CLAMPO			
		input pin output pin output pin							
					put pin, CIN4				
	This pin can a	lways be used a	as the F	TIC, KIN	4, or CIN4 inp	ut pin.			
P63/FTIB/KIN3/	P63DDR	()			1			
CIN3/VFBACKI	Pin function	P63 in	put pin		P63 c	output pin			
		FTIB inpu	ut pin, \		input pin, KIN	3 input pin,			
	This pin can a	Ilways be used a	as the F	TIB, KIN	3, CIN3, or VF	BACKI input pin.			
P62/FTIA/TMIY/ KIN2/CIN2/	P62DDR	0				1			
	Pin function	P62 input pin			P62 c	output pin			
VSYNCI	FTIA input pin, VSYNCI input pin, TMIY input pin, KIN2 input pin, CIN2 input pin								
	This pin can a pin.	Ilways be used a	as the F	TIA, TMI	Y, KIN2, CIN2	, or VSYNCI inpu			
P61/FTOA/KIN1/ CIN1/VSYNCO		CR of the FRT,				e combination of er connection			
	VOE			0		1			
	OEA	()		1	0			
	P61DDR	0		1	—	—			
	Pin function	P61 input pin	-	P61 out pin	FTOA output pin	VSYNCO output pin			
			KIN1	input pin,	CIN1 input pir	<u>ן</u>			
	When this pin be cleared to		/SYNC	O pin, bit	OEA in TOCR	t of the FRT mus			
	This pin can a	Ilways be used a	as the \overline{F}	(IN1 or C	IN1 input pin.				

Table 8.14 Port 6 Pin Functions (cont)

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Pin	Selection Method and Pin Functions						
P60/FTCI/TMIX/ KIN0/CIN0/ HFBACKI	P60DDR	0	1				
	Pin function	P60 input pin	P60 output pin				
HEDAUKI		FTCI input pin, HFBACKI input pin, TMIX input pin, KINO input pin, CINO input pin					
	This pin is used as the FTCI input pin when an external clock is selected with bits CKS1 and CKS0 in TCR of the FRT.						
	It can always be used as the TMIX, \overline{KINO} , CINO, or HFBACKI input pin.						

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8.7.4 MOS Input Pull-Up Function

Port 6 has a built-in MOS input pull-up function that can be controlled by software. This MOS input pull-up function can be used in any operating mode, and can be specified as on or off on a bit-by-bit basis.

When a P6DDR bit is cleared to 0, setting the corresponding KMPCR bit to 1 turns on the MOS input pull-up for that pin. The MOS input pull-up current specification can be changed by means of the P6PUE bit. When a pin is designated as an on-chip supporting module output pin, the MOS input pull-up is always off.

The MOS input pull-up function is in the off state after a reset and in hardware standby mode. The prior state is retained in software standby mode.

Table 8.15 summarizes the MOS input pull-up states.

Table 8.15 MOS Input Pull-Up States (Port 6)

Mode	Reset	Hardware Standby Mode	Software Standby Mode	In Other Operations	
1, 2, 3	Off	Off	On/Off	On/Off	

Legend:

Off: MOS input pull-up is always off.

On/Off: On when P6DDR = 0 and KMPCR = 1; otherwise off.

8.8 Port 7

8.8.1 Overview

Port 7 is an 8-bit input port. Port 7 pins also function as the A/D converter analog input pins (AN0 to AN7) and D/A converter analog output pins (DA0, DA1). Port 7 functions are the same in all operating modes.

Figure 8.15 shows the port 7 pin configuration.

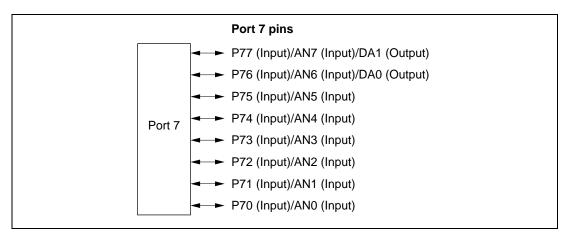


Figure 8.15 Port 7 Pin Functions

8.8.2 Register Configuration

Table 8.16 shows the port 7 register configuration. Port 7 is an input-only port, and does not have a data direction register or data register.

Table 8.16Port 7 Registers

Name	Abbreviation	R/W	Initial Value	Address*
Port 7 input data register	P7PIN	R	Undefined	H'FFBE

Note: *Lower 16 bits of the address.

Port 7 Input Data Register (P7PIN)

Bit	7	6	5	4	3	2	1	0
	P77PIN	P76PIN	P75PIN	P74PIN	P73PIN	P72PIN	P71PIN	P70PIN
Initial value	*	*	*	*	*	*	*	*
Read/Write	R	R	R	R	R	R	R	R

Note: * Determined by the state of pins P77 to P70.

When a P7PIN read is performed, the pin states are always read.

8.8.3 Pin Functions

Port 7 pins also function as the A/D converter analog input pins (AN0 to AN7) and D/A converter analog output pins (DA0, DA1).

8.9 Port 8

8.9.1 Overview

Port 8 is an 8-bit I/O port. Port 8 pins also function as SCI1 I/O pins (TxD1, RxD1, SCK1), the IIC1 I/O pin (SCL1) (option in H8S/2138 Series only), HIF I/O pins ($\overline{CS2}$, GA20, HA0, HIFSD) (H8S/2138 Series only), and external interrupt input pins ($\overline{IRQ5}$ to $\overline{IRQ3}$). Port 8 pin functions are the same in all operating modes. Figure 8.16 shows the port 8 pin configuration.

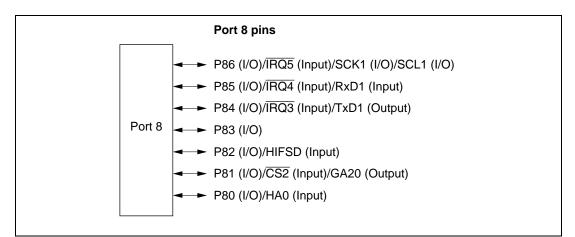


Figure 8.16 Port 8 Pin Functions

8.9.2 Register Configuration

Table 8.17 summarizes the port 8 registers.

Table 8.17Port 8 Registers

Name	Abbreviation	R/W	Initial Value	Address*
Port 8 data direction register	P8DDR	W	H'80	H'FFBD
Port 8 data register	P8DR	R/W	H'80	H'FFBF
	1			

Note: *Lower 16 bits of the address.

Port 8 Data Direction Register (P8DDR)

Bit	7	6	5	4	3	2	1	0
	_	P86DDR	P85DDR	P84DDR	P83DDR	P82DDR	P81DDR	P80DDR
Initial value	1	0	0	0	0	0	0	0
Read/Write	_	W	W	W	W	W	W	W

P8DDR is a 7-bit write-only register, the individual bits of which specify input or output for the pins of port 8.

Setting a P8DDR bit to 1 makes the corresponding port 8 pin an output pin, while clearing the bit to 0 makes the pin an input pin.

P8DDR is initialized to H'80 by a reset and in hardware standby mode. It retains its prior state in software standby mode.

Port 8 Data Register (P8DR)

Bit	7	6	5	4	3	2	1	0
	_	P86DR	P85DR	P84DR	P83DR	P82DR	P81DR	P80DR
Initial value	1	0	0	0	0	0	0	0
Read/Write	_	R/W						

P8DR is a 7-bit readable/writable register that stores output data for the port 8 pins (P86 to P80). If a port 8 read is performed while P8DDR bits are set to 1, the P8DR values are read directly, regardless of the actual pin states. If a port 8 read is performed while P8DDR bits are cleared to 0, the pin states are read.

P8DR is initialized to H'80 by a reset and in hardware standby mode. It retains its prior state in software standby mode.

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8.9.3 **Pin Functions**

Port 8 pins also function as SCI1 I/O pins (TxD1, RxD1, SCK1), the IIC1 I/O pin (SCL1), HIF I/O pins ($\overline{CS2}$, GA20, HA0, HIFSD), and external interrupt input pins ($\overline{IRQ5}$ to $\overline{IRQ3}$). The port 8 pin functions are shown in table 8.18.

Table 8.18 Port 8 Pin Functions

SCL1

P86/IRQ5/SCK1/ The pin function is switched as shown below according to the combination of bits CKE1 and CKE0 in SCR of SCI1, bit C/A in SMR of SCI1, bit ICE in ICCR of IIC1, and bit P86DDR.

ICE	0					1		
CKE1		(0		1	0		
C/A		0		1	-	0		
CKE0	(C	1	—		0		
P86DDR	0	1	_	—	_	_		
Pin function	P86 input pin	P86 output pin	SCK1 output pin	SCK1 input pin	SCL1 I/O pin			
		IRQ5 input pin						

When the IRQ5E bit in IER is set to 1, this pin is used as the IRQ5 input pin. When this pin is used as the SCL1 I/O pin, bits CKE1 and CKE0 in SCR of SCI1 and bit C/A in SMR of SCI1 must all be cleared to 0. SCL1 is an NMOSonly output, and has direct bus drive capability.

P85/IRQ4/RxD1	•	he pin function is switched as shown below according to the combination of it RE in SCR of SCI1 and bit P85DDR.								
	RE	(0 1							
	P85DDR	0	1	—						
	Pin function	P85 input pin	P85 output pin	RxD1 input pin						
	IRQ4 input pin									
	When the IRC	4E bit in IER is set to	o 1, this pin is used as	the IRQ4 input pin.						

Table 8.18 Port 8 Pin Functions (cont)

Pin	Selection Me	thod and Pin Functions								
P84/IRQ3/TxD1	The pin functi bit TE in SCR				elow ac	cordir	ng to tł	ne com	nbir	ation of
	TE			0					1	
	P84DDR	0 1							_	
	Pin function	P84 i	nput pin	Р	84 outp	ut pin		TxD1	out	out pin
				1	RQ3 inp	ut pin	1			
	When the IRC	Q3E bit in	IER is se	et to 1, th	nis pin is	susec	d as th	e IRQ:	3 in	put pin.
P83	The pin functi	on is swit	ched as s	shown b	elow ac	cordir	ng to b	it P83[DDI	र.
	P83DDR		0					1		
	Pin function	P83 input pin					P83	output	t pir	l
P82/HIFSD		on is switched as shown below de, bit SDE in SYSCR2 of the H Not slave mode				and		2DDR.		ation of
	SDE		_			0)	1		
	P82DDR	0		1	0		1			
	Pin function	P82 P82 input pin output		-	-		-	P82 HIFSD Itput pin input pir		-
P81/GA20/CS2	The pin function is switched as shown below according to the combina operating mode, bit CS2E, bit FGA20E in HICR of the HIF, and bit P81 Operating Not slave mode Slave mode									
	mode				0					
	FGA20E CS2E									
							1		_	_
		0		~				~		
	P81DDR Pin function	0 P81	1 P81	0 P81	1 P81			0 P81		1 GA20

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Pin	Selection Met	on Method and Pin Functions						
P80/HA0	The pin function is switched as shown below according to the combination of operating mode and bit P80DDR.							
	Operating mode	Not sla	Slave mode					
	P80DDR	0	1	—				
	Pin function	P80 input pin	HA0 input pin					

Table 8.18 Port 8 Pin Functions (cont)

8.10 Port 9

8.10.1 Overview

Port 9 is an 8-bit I/O port. Port 9 pins also function as external interrupt input pins ($\overline{IRQ0}$ to $\overline{IRQ2}$), the A/D converter external trigger input pin (\overline{ADTRG}), host interface input pins ($\overline{ECS2}$, $\overline{CS1}$, \overline{IOR}) (H8S/2138 Series only), the IIC0 I/O pin (SDA0) (option in H8S/2138 Series only), the subclock input pin (EXCL), bus control signal I/O pins ($\overline{AS}/\overline{IOS}$, \overline{RD} , \overline{WR} , \overline{WAIT}), and the system clock (\emptyset) output pin. In the H8S/2138 Series, P97 is an NMOS push-pull output. SDA0 is an NMOS open-drain output, and has direct bus drive capability.

Figure 8.17 shows the port 9 pin configuration.

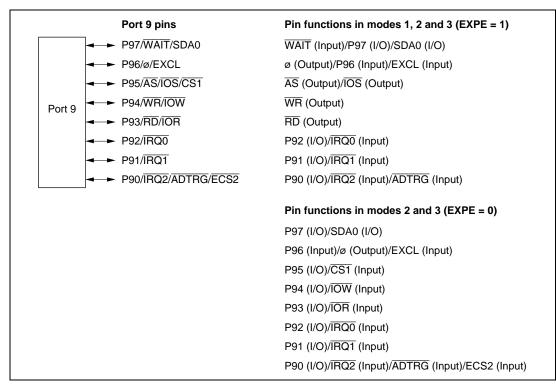


Figure 8.17 Port 9 Pin Functions

8.10.2 Register Configuration

Table 8.19 summarizes the port 9 registers.

Table 8.19 Port 9 Registers

Name	Abbreviation	R/W	Initial Value	Address ^{*1}
Port 9 data direction register	P9DDR	W	H'40/H'00* ²	H'FFC0
Port 9 data register	P9DR	R/W	H'00	H'FFC1

Notes: 1. Lower 16 bits of the address.

2. Initial value depends on the mode.

Port 9 Data Direction Register (P9DDR)

Bit	7	6	5	4	3	2	1	0
	P97DDR	P96DDR	P95DDR	P94DDR	P93DDR	P92DDR	P91DDR	P90DDR
Mode 1								
Initial value	0	1	0	0	0	0	0	0
Read/Write	W	W	W	W	W	W	W	W
Modes 2 and 3								
Initial value	0	0	0	0	0	0	0	0
Read/Write	W	W	W	W	W	W	W	W

P9DDR is an 8-bit write-only register, the individual bits of which specify input or output for the pins of port 9. P9DDR cannot be read; if it is, an undefined value will be returned.

P9DDR is initialized to H'40 (mode 1) or H'00 (modes 2 and 3) by a reset and in hardware standby mode. It retains its prior state in software standby mode.

• Modes 1, 2, and 3 (EXPE = 1)

Pin P97 functions as a bus control input (\overline{WAIT}), the IICO I/O pin (SDA0), or an I/O port, according to the wait mode setting. When P97 functions as an I/O port, it becomes an output port when P97DDR is set to 1, and an input port when P97DDR is cleared to 0.

Pin P96 functions as the ø output pin when P96DDR is set to 1, and as the subclock input (EXCL) or an input port when P96DDR is cleared to 0.

Pins P95 to P93 automatically become bus control outputs ($\overline{AS}/\overline{IOS}$, \overline{WR} , \overline{RD}), regardless of the input/output direction indicated by P95DDR to P93DDR.

Pins P92 and P90 become output ports when P92DDR and P90DDR are set to 1, and input ports when P92DDR and P91DDR are cleared to 0.

• Modes 2 and 3 (EXPE = 0)

When the corresponding P9DDR bits are set to 1, pin P96 functions as the ø output pin and pins P97 and P95 to P90 become output ports. When P9DDR bits are cleared to 0, the corresponding pins become input ports.

Port 9 Data Register (P9DR)

Bit	7	6	5	4	3	2	1	0
	P97DR	P96DR	P95DR	P94DR	P93DR	P92DR	P91DR	P90DR
Initial value	0	*	0	0	0	0	0	0
Read/Write	R/W	R	R/W	R/W	R/W	R/W	R/W	R/W
Note: * Determined by the state of pin P96.								

P9DR is an 8-bit readable/writable register that stores output data for the port 9 pins (P97 to P90). With the exception of P96, if a port 9 read is performed while P9DDR bits are set to 1, the P9DR values are read directly, regardless of the actual pin states. If a port 9 read is performed while P9DDR bits are cleared to 0, the pin states are read.

P9DR is initialized to H'00 by a reset and in hardware standby mode. It retains its prior state in software standby mode.

8.10.3 Pin Functions

Port 9 pins also function as external interrupt input pins ($\overline{IRQ0}$ to $\overline{IRQ2}$), the A/D converter trigger input pin (\overline{ADTRG}), HIF input pins ($\overline{ECS2}$, $\overline{CS1}$, \overline{IOW} , \overline{IOR}), the IIC0 I/O pin (SDA0), the subclock input pin (EXCL), bus control signal I/O pins ($\overline{AS/IOS}$, \overline{RD} , \overline{WR} , \overline{WAIT}), and the system clock (\emptyset) output pin. The pin functions differ between the mode 1, 2, and 3 (EXPE = 1) expanded modes and the mode 2 and 3 (EXPE = 0) single-chip modes. The port 9 pin functions are shown in table 8.20.

Pin	Selection Meth	od and Pi	n Functior	IS					
P97/WAIT/SDA0	The pin function is switched as shown below according to the combination of operating mode, bit WMS1 in WSCR, bit ICE in ICCR of IIC0, and bit P97DDR.								
	Operating mode	М	odes 1, 2,	3 (EXPE =	Mode	Modes 2, 3 (EXPE = 0)			
	WMS1	0			1		_		
	ICE		0	1	—		0	1	
	P97DDR	0	1	_	_	0	1	_	
	Pin function	P97 input pin	P97 output pin	SDA0 I/O pin	WAIT input pin	P97 input pin	P97 output pin	SDA0 I/O pin	
P96/ø/EXCL	In the H8S/2138 Series, when this pin is set as the P97 output pin, it is an NMOS push-pull output. SDA0 is an NMOS open-drain output, and has direct bus drive capability. The pin function is switched as shown below according to the combination of bit EXCLE in LPWRCR and bit P96DDR.								
	P96DDR								
	EXCLE	0			1		0		
	Pin function	P96 input pin			EXCL input pin ø outp			ıt pin	
P95/AS/IOS/CS1	When this pin is used as the EXCL input pin, P96DDR should be cleared to 0. The pin function is switched as shown below according to the combination of operating mode, bit IOSE in SYSCR, bit HI12E in SYSCR2, and bit P95DDR.								
	Operating mode	Modes 1, 2, 3 (EXPE = 1)			Modes 2, 3 (EXPE = 0))	
	HI12E		_		0 1			1	
	P95DDR		—		0	1		—	
	IOSE	0		1	_	_	-	_	
	Pin function	AS output p		OS out pin	P95 input pin	P9 outpu	-	CS1 nput pin	

Table 8.20Port 9 Pin Functions

(E DR nction ou n function is ing mode, bi	it HI12E in S` des 1, 2, 3	0 P94 input pin shown below a YSCR2, and bit	1 P94 output pin ccording to the c	1 IOW input pin combination of		
nction or nction is ing mode, bi ating Mode (E	utput pin s switched as it HI12E in S` des 1, 2, 3	0 P94 input pin shown below a YSCR2, and bit	1 P94 output pin ccording to the o P93DDR.	IOW input pin combination of		
nction ou n function is ing mode, bi ating Moo (E	utput pin s switched as it HI12E in S` des 1, 2, 3	P94 input pin shown below a YSCR2, and bit	P94 output pin ccording to the o P93DDR.	input pin		
n function is ing mode, bi ating Mod (E	utput pin s switched as it HI12E in S` des 1, 2, 3	input pin shown below a YSCR2, and bit	output pin ccording to the o P93DDR.	input pin		
ing mode, bi ating Mod (E	it HI12E in S` des 1, 2, 3	YSCR2, and bit	P93DDR.			
(E		Moc	les 2, 3 (EXPE =	= 0)		
:	_	Modes 1, 2, 3 (EXPE = 1) Modes 2,				
		0		1		
DR	—	0	1	—		
nction RD	output pin	P93 input pin	P93 output pin	IOR input pin		
DR	0		1			
nction	P92 inp	out pin	P92 output pin			
	IRQ0 input pin					
bit IRQ0E in	n IER is set to	o 1, this pin is u	sed as the IRQ0	input pin.		
DR	0		1			
	P91 inp	out pin	P91 out	put pin		
nction	IRQ1 input pin					
	DR	DR 0	DR 0 nction P91 input pin	nction P91 input pin P91 out		

Table 8.20Port 9 Pin Functions (cont)

Table 8.20 Port 9 Pin Functions (cont)

Pin	Selection Me	thod and Pi	n Functions						
P90/IRQ2/ ADTRG/ECS2	The pin function is switched as shown below according to the combination of operating mode, bits HI12E and CS2E in SYSCR2, bit FGA20E in HICR, and bit P90DDR.								
	Operating mode		5 1, 2, 3 E = 1)		Modes 2, 3 (EXPE = 0)				
	HI12E	-	_	Any	one 0	1			
	FGA20E	-	_		1				
	CS2E	-	_			1			
	P90DDR	0	1	0	1	—			
	Pin function	P90 input pin	P90 output pin	P90 input pin	P90 output pin	ECS2 input pin			
		IRQ2 input pin, ADTRG input pin							
	When the IRC	2E bit in IEF	R is set to 1, t	his pin is use	d as the IRQ	2 input pin.			
	When TRGS1	and TRGS(the A/D conv	erter are hoth	n set to 1			

When TRGS1 and TRGS0 in ADCR of the A/D converter are both set to 1, this pin is used as the $\overline{\text{ADTRG}}$ input pin.

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Section 9 8-Bit PWM Timers [H8S/2138 Series]

9.1 Overview

The H8/2138 Series has an on-chip pulse width modulation (PWM) timer module with sixteen outputs. Sixteen output waveforms are generated from a common time base, enabling PWM output with a high carrier frequency to be produced using pulse division. The PWM timer module has sixteen 8-bit PWM data registers (PWDRs), and an output pulse with a duty cycle of 0 to 100% can be obtained as specified by PWDR and the port data register (P1DR or P2DR).

9.1.1 Features

The PWM timer module has the following features.

- Operable at a maximum carrier frequency of 1.25 MHz using pulse division (at 20 MHz operation)
- Duty cycles from 0 to 100% with 1/256 resolution (100% duty realized by port output)
- Direct or inverted PWM output, and PWM output enable/disable control

9.1.2 Block Diagram

Figure 9.1 shows a block diagram of the PWM timer module.

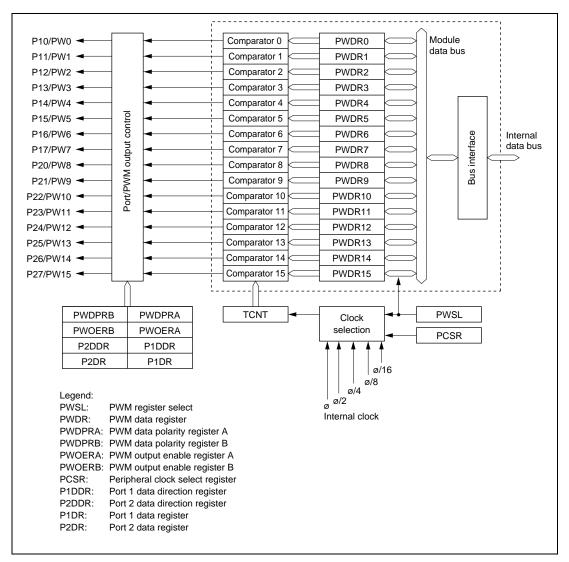


Figure 9.1 Block Diagram of PWM Timer Module

9.1.3 Pin Configuration

Table 9.1 shows the PWM output pin.

Table 9.1Pin Configuration

Name	Abbreviation	I/O	Function
PWM output pin 0 to 15	PW0 to PW15	Output	PWM timer pulse output 0 to 15

9.1.4 Register Configuration

Table 9.2 lists the registers of the PWM timer module.

Table 9.2 PWM Timer Module Registers

Name	Abbreviation	R/W	Initial Value	Address*
PWM register select	PWSL	R/W	H'20	H'FFD6
PWM data registers 0 to 15	PWDR0 to PWDR15	R/W	H'00	H'FFD7
PWM data polarity register A	PWDPRA	R/W	H'00	H'FFD5
PWM data polarity register B	PWDPRB	R/W	H'00	H'FFD4
PWM output enable register A	PWOERA	R/W	H'00	H'FFD3
PWM output enable register B	PWOERB	R/W	H'00	H'FFD2
Port 1 data direction register	P1DDR	W	H'00	H'FFB0
Port 2 data direction register	P2DDR	W	H'00	H'FFB1
Port 1 data register	P1DR	R/W	H'00	H'FFB2
Port 2 data register	P2DR	R/W	H'00	H'FFB3
Peripheral clock select register	PCSR	R/W	H'00	H'FF82
Module stop control register	MSTPCRH	R/W	H'3F	H'FF86
	MSTPCRL	R/W	H'FF	H'FF87

Note: *Lower 16 bits of the address.

9.2 **Register Descriptions**

9.2.1 PWM Register Select (PWSL)

Bit	7	6	5	4	3	2	1	0
	PWCKE	PWCKS	—	—	RS3	RS2	RS1	RS0
Initial value	0	0	1	0	0	0	0	0
Read/Write	R/W	R/W	_	_	R/W	R/W	R/W	R/W

PWSL is an 8-bit readable/writable register used to select the PWM timer input clock and the PWM data register.

PWSL is initialized to H'20 by a reset, and in the standby modes, watch mode, subactive mode, subsleep mode, and module stop mode.

Bits 7 and 6—PWM Clock Enable, PWM Clock Select (PWCKE, PWCKS): These bits, together with bits PWCKA and PWCKB in PCSR, select the internal clock input to TCNT in the PWM timer.

F	PWSL	F	PCSR		
Bit 7	Bit 6	Bit 2	Bit 1		
PWCKE	PWCKS	PWCKB	PWCKA	Description	
0	_	_	_	Clock input is disabled	(Initial value)
1	0	_	_	ø (system clock) is selected	
	1	0	0	ø/2 is selected	
			1	ø/4 is selected	
		1	0	ø/8 is selected	
			1	ø/16 is selected	

The PWM resolution, PWM conversion period, and carrier frequency depend on the selected internal clock, and can be found from the following equations.

Resolution (minimum pulse width) = 1/internal clock frequency PWM conversion period = resolution \times 256 Carrier frequency = 16/PWM conversion period

Thus, with a 20 MHz system clock (ϕ), the resolution, PWM conversion period, and carrier frequency are as shown below.

Internal Clock		PWM Conversion	on			
Frequency	Resolution	Period	Carrier Frequency			
ø	50 ns	12.8 μs	1250 kHz			
ø/2	100 ns	25.6 μs	625 kHz			
ø/4	200 ns	51.2 μs	312.5 kHz			
ø/8	400 ns	102.4 μs	156.3 kHz			
ø/16	800 ns	204.8 μs	78.1 kHz			

Table 9.3Resolution, PWM Conversion Period, and Carrier Frequency when $\emptyset = 20$ MHz

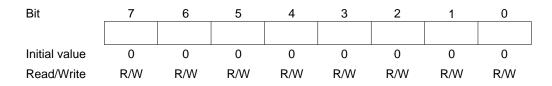
Bit 5—Reserved: This bit is always read as 1 and cannot be modified.

Bit 4—Reserved: This bit is always read as 0 and cannot be modified.

Bits 3 to 0—Register Select (RS3 to RS0): These bits select the PWM data register.

Bit 3	Bit 2	Bit 1	Bit 0	
RS3	RS2	RS1	RS0	Register Selection
0	0	0	0	PWDR0 selected
			1	PWDR1 selected
		1	0	PWDR2 selected
			1	PWDR3 selected
	1	0	0	PWDR4 selected
			1	PWDR5 selected
		1	0	PWDR6 selected
			1	PWDR7 selected
1	0	0	0	PWDR8 selected
			1	PWDR9 selected
		1	0	PWDR10 selected
			1	PWDR11 selected
	1	0	0	PWDR12 selected
			1	PWDR13 selected
		1	0	PWDR14 selected
			1	PWDR15 selected

9.2.2 PWM Data Registers (PWDR0 to PWDR15)



Each PWDR is an 8-bit readable/writable register that specifies the duty cycle of the basic pulse to be output, and the number of additional pulses. The value set in PWDR corresponds to a 0 or 1 ratio in the conversion period. The upper 4 bits specify the duty cycle of the basic pulse as 0/16 to 15/16 with a resolution of 1/16. The lower 4 bits specify how many extra pulses are to be added within the conversion period comprising 16 basic pulses. Thus, a specification of 0/256 to 255/256 is possible for 0/1 ratios within the conversion period. For 256/256 (100%) output, port output should be used.

PWDR is initialized to H'00 by a reset, and in the standby modes, watch mode, subactive mode, subsleep mode, and module stop mode.

PWDPRA								
Bit	7	6	5	4	3	2	1	0
	OS7	OS6	OS5	OS4	OS3	OS2	OS1	OS0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
PWDPRB								
Bit	7	6	5	4	3	2	1	0
	OS15	OS14	OS13	OS12	OS11	OS10	OS9	OS8
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

9.2.3 PWM Data Polarity Registers A and B (PWDPRA and PWDPRB)

Each PWDPR is an 8-bit readable/writable register that controls the polarity of the PWM output. Bits OS0 to OS15 correspond to outputs PW0 to PW15.

PWDPR is initialized to H'00 by a reset and in hardware standby mode.

OS	Description
0	PWM direct output (PWDR value corresponds to high width of output) (Initial value)
1	PWM inverted output (PWDR value corresponds to low width of output)

PWOERA								
Bit	7	6	5	4	3	2	1	0
	OE7	OE6	OE5	OE4	OE3	OE2	OE1	OE0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
PWOERB								
Bit	7	6	5	4	3	2	1	0
	OE15	OE14	OE13	OE12	OE11	OE10	OE9	OE8
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

9.2.4 PWM Output Enable Registers A and B (PWOERA and PWOERB)

Each PWOER is an 8-bit readable/writable register that switches between PWM output and port output. Bits OE15 to OE0 correspond to outputs PW15 to PW0. To set a pin in the output state, a setting in the port direction register is also necessary. Bits P17DDR to P10DDR correspond to outputs PW7 to PW0, and bits P27DDR to P20DDR correspond to outputs PW15 to PW8.

PWOER is initialized to H'00 by a reset and in hardware standby mode.

DDR	OE	Description	
0	0	Port input	(Initial value)
	1	Port input	
1	0	Port output or PWM 256/256 output	
	1	PWM output (0 to 255/256 output)	

9.2.5 Peripheral Clock Select Register (PCSR)

Bit	7	6	5	4	3	2	1	0
	—	—	—	—		PWCKB	PWCKA	—
Initial value	0	0	0	0	0	0	0	0
Read/Write	—	—	—	—	—	R/W	R/W	—

PCSR is an 8-bit readable/writable register that selects the PWM timer input clock.

PCSR is initialized to H'00 by a reset, and in hardware standby mode.

Bits 7 to 3—Reserved: These bits cannot be modified and are always read as 0.

Bits 2 and 1—PWM Clock Select (PWCKB, PWCKA): Together with bits PWCKE and PWCKS in PWSL, these bits select the internal clock input to TCNT in the PWM timer. For details, see section 9.2.1, PWM Register Select (PWSL).

Bit 0—Reserved: Do not set this bit to 1.

9.2.6 Port 1 Data Direction Register (P1DDR)

Bit	7	6	5	4	3	2	1	0
	P17DDR	P16DDR	P15DDR	P14DDR	P13DDR	P12DDR	P11DDR	P10DDR
Initial value	0	0	0	0	0	0	0	0
Read/Write	W	W	W	W	W	W	W	W

P1DDR is an 8-bit write-only register that specifies the input/output direction and PWM output for each pin of port 1 on a bit-by-bit basis.

Port 1 pins are multiplexed with pins PW0 to PW7. The bit corresponding to a pin to be used for PWM output should be set to 1.

For details on P1DDR, see section 8.2, Port 1.

9.2.7 Port 2 Data Direction Register (P2DDR)

Bit	7	6	5	4	3	2	1	0
	P27DDR	P26DDR	P25DDR	P24DDR	P23DDR	P22DDR	P21DDR	P20DDR
Initial value	0	0	0	0	0	0	0	0
Read/Write	W	W	W	W	W	W	W	W

P2DDR is an 8-bit write-only register that specifies the input/output direction and PWM output for each pin of port J on a bit-by-bit basis.

Port 2 pins are multiplexed with pins PW8 to PW15. The bit corresponding to a pin to be used for PWM output should be set to 1.

For details on P2DDR, see section 8.3, Port 2.

9.2.8 Port 1 Data Register (P1DR)

Bit	7	6	5	4	3	2	1	0
	P17DR	P16DR	P15DR	P14DR	P13DR	P12DR	P11DR	P10DR
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W							

P1DR is an 8-bit readable/writable register used to fix PWM output at 1 (when OS = 0) or 0 (when OS = 1).

For details on P1DR, see section 8.2, Port 1.

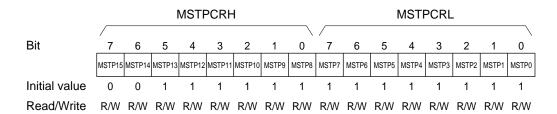
9.2.9 Port 2 Data Register (P2DR)

Bit	7	6	5	4	3	2	1	0
	P27DR	P26DR	P25DR	P24DR	P23DR	P22DR	P21DR	P20DR
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W							

P2DR is an 8-bit readable/writable register used to fix PWM output at 1 (when OS = 0) or 0 (when OS = 1).

For details on P2DR, see section 8.3, Port 2.

9.2.10 Module Stop Control Register (MSTPCR)



MSTPCR comprises two 8-bit readable/writable registers, and is used to perform module stop mode control.

When the MSTP11 bit is set to 1, 8-bit PWM timer operation is halted and a transition is made to module stop mode. For details, see section 23.5, Module Stop Mode.

MSTPCR is initialized to H'3FFF by a reset and in hardware standby mode. It is not initialized in software standby mode.

MSTPCRH Bit 3—Module Stop (MSTP11): Specifies PWM module stop mode.

MSTPCRH Bit 3		
MSTP11	Description	
0	PWM module stop mode is cleared	
1	PWM module stop mode is set	(Initial value)

9.3 Operation

9.3.1 Correspondence between PWM Data Register Contents and Output Waveform

The upper 4 bits of PWDR specify the duty cycle of the basic pulse as 0/16 to 15/16 with a resolution of 1/16, as shown in table 9.4.

Upper 6 Bits	Basic Pulse Waveform (Internal)
000000	0 1 2 3 4 5 6 7 8 9 A B C D E F 0
000001	
000010	
000011	
000100	
000101	
000110	
000111	
:	
111000	
111001	
111010	
111011	
111100	
111101	
111110	
111111	

Table 9.4Duty Cycle of Basic Pulse

The lower 4 bits of PWDR specify the position of pulses added to the 16 basic pulses, as shown in table 9.5. An additional pulse consists of a high period (when OS = 0) with a width equal to the resolution, added before the rising edge of a basic pulse. When the upper 4 bits of PWDR are 0000, there is no rising edge of the basic pulse, but the timing for adding pulses is the same.

Basic Pulse No.																
Lower 4 Bits	0	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15
0000																
0001																Yes
0010								Yes								Yes
0011								Yes				Yes				Yes
0100				Yes				Yes				Yes				Yes
0101				Yes				Yes				Yes		Yes		Yes
0110				Yes		Yes		Yes				Yes		Yes		Yes
0111				Yes												
1000		Yes		Yes		Yes		Yes		Yes		Yes		Yes		Yes
1001		Yes		Yes		Yes		Yes		Yes		Yes		Yes	Yes	Yes
1010		Yes		Yes		Yes	Yes	Yes		Yes		Yes		Yes	Yes	Yes
1011		Yes		Yes		Yes	Yes	Yes		Yes	Yes	Yes		Yes	Yes	Yes
1100		Yes	Yes	Yes		Yes	Yes	Yes		Yes	Yes	Yes		Yes	Yes	Yes
1101		Yes	Yes	Yes		Yes	Yes	Yes		Yes						
1110		Yes		Yes												
1111		Yes														

Table 9.5 Position of Pulses Added to Basic Pulses

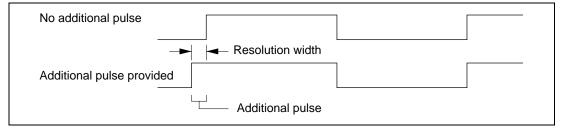


Figure 9.2 Example of Additional Pulse Timing (When Upper 4 Bits of PWDR = 1000)

Section 10 14-Bit PWM D/A

10.1 Overview

The H8S/2138 Series and H8S/2134 Series have an on-chip 14-bit pulse-width modulator (PWM) with two output channels.

Each channel can be connected to an external low-pass filter to operate as a 14-bit D/A converter.

Both channels share the same counter (DACNT) and control register (DACR).

10.1.1 Features

The features of the 14-bit PWM D/A are listed below.

- The pulse is subdivided into multiple base cycles to reduce ripple.
- Two resolution settings and two base cycle settings are available The resolution can be set equal to one or two system clock cycles. The base cycle can be set equal to T × 64 or T × 256, where T is the resolution.
- Four operating rates

The two resolution settings and two base cycle settings combine to give a selection of four operating rates.

10.1.2 Block Diagram

Figure 10.1 shows a block diagram of the PWM D/A module.

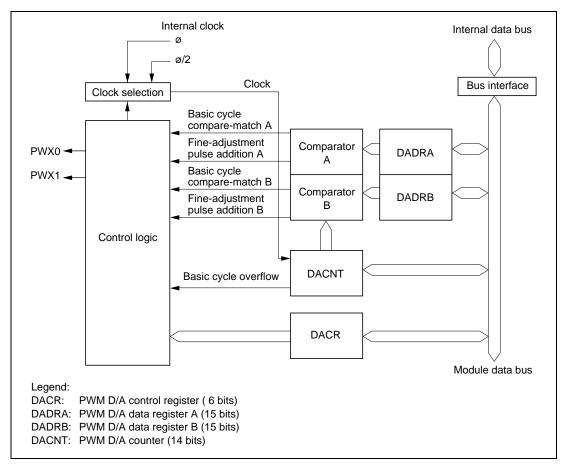


Figure 10.1 PWM D/A Block Diagram

10.1.3 Pin Configuration

Table 10.1 lists the pins used by the PWM D/A module.

Table 10.1 Input and Output Pins

Channel	Name	Abbr.	I/O	Function
A	PWM output pin 0	PWX0	Output	PWM output, channel A
В	PWM output pin 1	PWX1	Output	PWM output, channel B

10.1.4 Register Configuration

Table 10.2 lists the registers of the PWM D/A module.

Table 10.2 Register Configuration

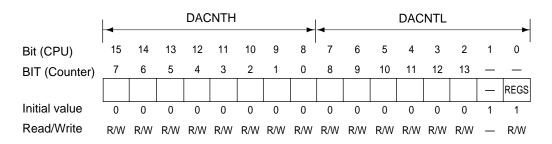
Name	Abbreviation	R/W	Initial value	Address*1
PWM D/A control register	DACR	R/W	H'30	H'FFA0* ²
PWM D/A data register A high	DADRAH	R/W	H'FF	H'FFA0* ²
PWM D/A data register A low	DADRAL	R/W	H'FF	H'FFA1* ²
PWM D/A data register B high	DADRBH	R/W	H'FF	H'FFA6* ²
PWM D/A data register B low	DADRBL	R/W	H'FF	H'FFA7* ²
PWM D/A counter high	DACNTH	R/W	H'00	H'FFA6* ²
PWM D/A counter low	DACNTL	R/W	H'03	H'FFA7* ²
Module stop control register	MSTPCRH	R/W	H'3F	H'FF86
	MSTPCRL	R/W	H'FF	H'FF87

Notes: 1. Lower 16 bits of the address.

2. The same addresses are shared by DADRAH and DACR, and by DADRB and DACNT. Switching is performed by the REGS bit in DACNT or DADRB.

10.2 Register Descriptions

10.2.1 PWM D/A Counter (DACNT)



DACNT is a 14-bit readable/writable up-counter that increments on an input clock pulse. The input clock is selected by the clock select bit (CKS) in DACR. The CPU can read and write the DACNT value, but since DACNT is a 16-bit register, data transfers between it and the CPU are performed using a temporary register (TEMP). See section 10.3, Bus Master Interface, for details.

DACNT functions as the time base for both PWM D/A channels. When a channel operates with 14-bit precision, it uses all DACNT bits. When a channel operates with 12-bit precision, it uses the lower 12 (counter) bits and ignores the upper two (counter) bits.

DACNT is initialized to H'0003 by a reset, in the standby modes, watch mode, subactive mode, subsleep mode, and module stop mode, and by the PWME bit.

Bit 1 of DACNTL (CPU) is not used, and is always read as 1.

DACNTL Bit 0—Register Select (REGS): DADRA and DACR, and DADRB and DACNT, are located at the same addresses. The REGS bit specifies which registers can be accessed. The REGS bit can be accessed regardless of whether DADRB or DACNT is selected.

Bit 0		
REGS	Description	
0	DADRA and DADRB can be accessed	
1	DACR and DACNT can be accessed	(Initial value)

10.2.2 D/A Data Registers A and B (DADRA and DADRB)

	DADRH								DADRL							
									•							
Bit (CPU)	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Bit (Data)	_13	12	11	10	9	8	7	6	5	4	3	2	1	0	_	
DADRA	DA13	DA12	DA11	DA10	DA9	DA8	DA7	DA6	DA5	DA4	DA3	DA2	DA1	DA0	CFS	_
Initial value	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	_
DADRB	DA13	DA12	DA11	DA10	DA9	DA8	DA7	DA6	DA5	DA4	DA3	DA2	DA1	DA0	CFS	REGS
Initial value	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

There are two 16-bit readable/writable D/A data registers: DADRA and DADRB. DADRA corresponds to PWM D/A channel A, and DADRB to PWM D/A channel B. The CPU can read and write the PWM D/A data register values, but since DADRA and DADRB are 16-bit registers, data transfers between them and the CPU are performed using a temporary register (TEMP). See section 10.3, Bus Master Interface, for details.

The least significant (CPU) bit of DADRA is not used and is always read as 1.

DADR is initialized to H'FFFF by a reset, and in the standby modes, watch mode, subactive mode, subsleep mode, and module stop mode.

Bits 15 to 3—PWM D/A Data 13 to 0 (DA13 to DA0): The digital value to be converted to an analog value is set in the upper 14 bits of the PWM D/A data register.

In each base cycle, the DACNT value is continually compared with these upper 14 bits to determine the duty cycle of the output waveform, and to decide whether to output a fine-adjustment pulse equal in width to the resolution. To enable this operation, the data register must be set within a range that depends on the carrier frequency select bit (CFS). If the DADR value is outside this range, the PWM output is held constant.

A channel can be operated with 12-bit precision by keeping the two lowest data bits (DA0 and DA1) cleared to 0 and writing the data to be converted in the upper 12 bits. The two lowest data bits correspond to the two highest counter (DACNT) bits.

Bit 1—Carrier Frequency Select (CFS)

Bit 1		
CFS	Description	
0	Base cycle = resolution (T) \times 64 DADR range = H'0401 to H'FFFD	
1	Base cycle = resolution (T) \times 256 DADR range = H'0103 to H'FFFFF	(Initial value)

DADRA Bit 0—Reserved: This bit cannot be modified and is always read as 1.

DADRB Bit 0—Register Select (REGS): DADRA and DACR, and DADRB and DACNT, are located at the same addresses. The REGS bit specifies which registers can be accessed. The REGS bit can be accessed regardless of whether DADRB or DACNT is selected.

Bit 0		
REGS	Description	
0	DADRA and DADRB can be accessed	
1	DACR and DACNT can be accessed	(Initial value)

10.2.3 PWM D/A Control Register (DACR)

Bit	7	6	5	4	3	2	1	0
	TEST	PWME	_	—	OEB	OEA	OS	CKS
Initial value	0	0	1	1	0	0	0	0
Read/Write	R/W	R/W	_	_	R/W	R/W	R/W	R/W

DACR is an 8-bit readable/writable register that selects test mode, enables the PWM outputs, and selects the output phase and operating speed.

DACR is initialized to H'30 by a reset, and in the standby modes, watch mode, subactive mode, subsleep mode, and module stop mode.

Bit 7—Test Mode (TEST): Selects test mode, which is used in testing the chip. Normally this bit should be cleared to 0.

Bit 7

TEST	Description	
0	PWM (D/A) in user state: normal operation	(Initial value)
1	PWM (D/A) in test state: correct conversion results unobtainable	

Bit 6—PWM Enable (PWME): Starts or stops the PWM D/A counter (DACNT).

Bit 6

PWME	Description	
0	DACNT operates as a 14-bit up-counter	(Initial value)
1	DACNT halts at H'0003	

Bits 5 and 4—Reserved: These bits cannot be modified and are always read as 1.

Bit 3—Output Enable B (OEB): Enables or disables output on PWM D/A channel B.

Bit 3

OEB	Description	
0	PWM (D/A) channel B output (at the PWX1 pin) is disabled	(Initial value)
1	PWM (D/A) channel B output (at the PWX1 pin) is enabled	

Bit 2—Output Enable A (OEA): Enables or disables output on PWM D/A channel A.

Bit 2		
OEA	Description	
0	PWM (D/A) channel A output (at the PWX0 pin) is disabled	(Initial value)
1	PWM (D/A) channel A output (at the PWX0 pin) is enabled	

Bit 1—Output Select (OS): Selects the phase of the PWM D/A output.

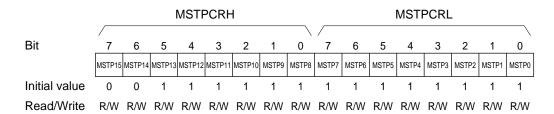
Bit 1 Description 0 Direct PWM output (Initial value) 1 Inverted PWM output

Bit 0—Clock Select (CKS): Selects the PWM D/A resolution. If the system clock (ϕ) frequency is 10 MHz, resolutions of 100 ns and 200 ns can be selected.

Bit 0

CKS	Description	
0	Operates at resolution (T) = system clock cycle time (t_{cyc})	(Initial value)
1	Operates at resolution (T) = system clock cycle time $(t_{_{cyc}}) \times 2$	

10.2.4 Module Stop Control Register (MSTPCR)



MSTPCR comprises two 8-bit readable/writable registers, and is used to perform module stop mode control.

When the MSTP11 bit is set to 1, 14-bit PWM timer operation is halted and a transition is made to module stop mode. For details, see section 23.5, Module Stop Mode.

MSTPCR is initialized to H'3FFF by a reset and in hardware standby mode. It is not initialized in software standby mode.

MSTPCRH Bit 3—Module Stop (MSTP11): Specifies PWMX module stop mode.

MSTPCRH Bit 3		
MSTP11	 Description	
0	PWMX module stop mode is cleared	
1	PWMX module stop mode is set	(Initial value)

10.3 Bus Master Interface

DACNT, DADRA, and DADRB are 16-bit registers. The data bus linking the bus master and the on-chip supporting modules, however, is only 8 bits wide. When the bus master accesses these registers, it therefore uses an 8-bit temporary register (TEMP).

These registers are written and read as follows (taking the example of the CPU interface).

• Write

When the upper byte is written, the upper-byte write data is stored in TEMP. Next, when the lower byte is written, the lower-byte write data and TEMP value are combined, and the combined 16-bit value is written in the register.

• Read

When the upper byte is read, the upper-byte value is transferred to the CPU and the lowerbyte value is transferred to TEMP. Next, when the lower byte is read, the lower-byte value in TEMP is transferred to the CPU.

These registers should always be accessed 16 bits at a time using an MOV instruction (by word access or two consecutive byte accesses), and the upper byte should always be accessed before the lower byte. Correct data will not be transferred if only the upper byte or only the lower byte is accessed. Also note that a bit manipulation instruction cannot be used to access these registers.

Figure 10.2 shows the data flow for access to DACNT. The other registers are accessed similarly.

Example 1: Write to DACNT

MOV.W R0, @DACNT ; Write R0 contents to DACNT

Example 2: Read DADRA

MOV.W @DADRA, R0 ; Copy contents of DADRA to R0

Table 10.3 Read and Write Access Methods for 16-Bit Registers

		Read			
Register Name	Word	Byte	Word	Byte	
DADRA and DADRB	Yes	Yes	Yes	×	
DACNT	Yes	×	Yes	×	

Notes: Yes: Permitted type of access. Word access includes successive byte accesses to the upper byte (first) and lower byte (second).

×: This type of access may give incorrect results.

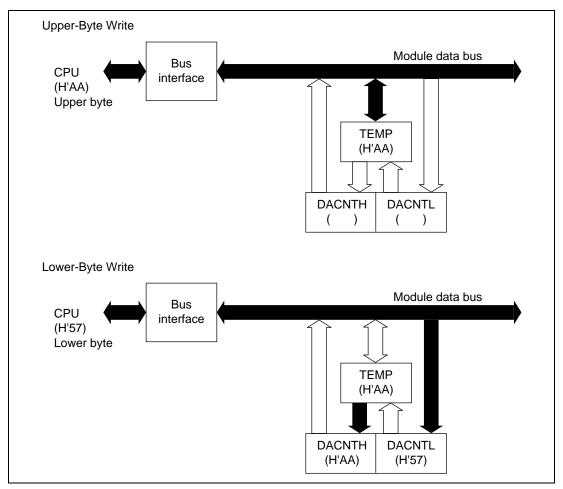


Figure 10.2 (a) Access to DACNT (CPU Writes H'AA57 to DACNT)

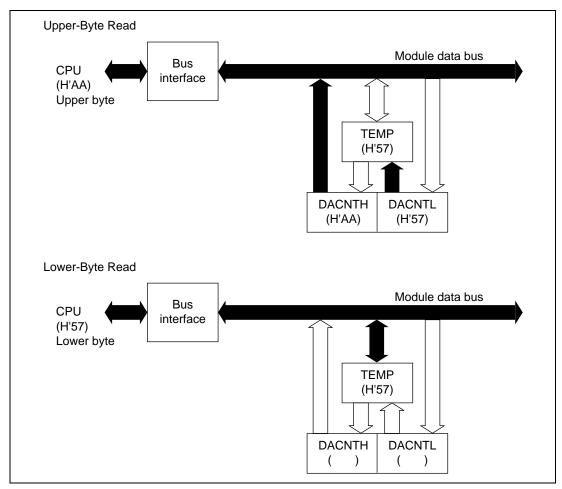


Figure 10.2 (b) Access to DACNT (CPU Reads H'AA57 from DACNT)

10.4 Operation

A PWM waveform like the one shown in figure 10.3 is output from the PWMX pin. When OS = 0, the value in DADR corresponds to the total width (T_L) of the low (0) pulses output in one conversion cycle (256 pulses when CFS = 0, 64 pulses when CFS = 1). When OS = 1, the output waveform is inverted and the DADR value corresponds to the total width (T_H) of the high (1) output pulses. Figure 10.4 shows the types of waveform output available.

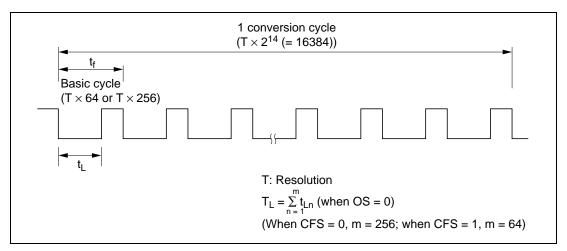


Figure 10.3 PWM D/A Operation

Table 10.4 summarizes the relationships of the CKS, CFS, and OS bit settings to the resolution, base cycle, and conversion cycle. The PWM output remains flat unless DADR contains at least a certain minimum value. Table 10.4 indicates the range of DADR settings that give an output waveform like the one in figure 10.3, and lists the conversion cycle length when low-order DADR bits are kept cleared to 0, reducing the conversion precision to 12 bits or 10 bits.

							Fixed D	A	DR	Bit	s	
									Bit	Da	ta	_
	Resolution T (µs)		Base CycleConversion (µs) Cycle (µs)		-	(if OS = 0) (if OS = 1)	Precision (Bits)	3	2	1	0	Conversion Cycle* (µs)
0	0.1	0	6.4	1638.4	1.	Always low (or high) (DADR = H'0001 to H'03FD)	14					1638.4
					2.	(Data value) × T (DADR = H'0401 to H'FFFD)	12			0	0	409.6
							10	0	0	0	0	102.4
		1	25.6	1638.4	1.	Always low (or high) (DADR = H'0003 to H'00FF)	14					1638.4
					2.	(Data value) × T (DADR = H'0103 to H'FFFF)	12			0	0	409.6
							10	0	0	0	0	102.4
1	0.2	0	12.8	3276.8	1.	Always low (or high) (DADR = H'0001 to H'03FD)	14					3276.8
					2.	(Data value) × T (DADR = H'0401 to H'FFFD)	12			0	0	819.2
							10	0	0	0	0	204.8
		1	51.2	3276.8	1.	Always low (or high) (DADR = H'0003 to H'00FF)	14					3276.8
					2.	(Data value) × T (DADR = H'0103 to H'FFFF)	12			0	0	819.2
							10	0	0	0	0	204.8

Table 10.4 Settings and Operation (Examples when ø = 10 MHz)

Note: *This column indicates the conversion cycle when specific DADR bits are fixed.

1. OS = 0 (DADR corresponds to T_1)

a. CFS = 0 [base cycle = resolution (T) × 64]

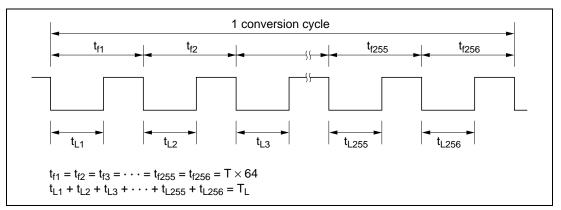


Figure 10.4 (1) Output Waveform

b. CFS = 1 [base cycle = resolution (T) × 256]

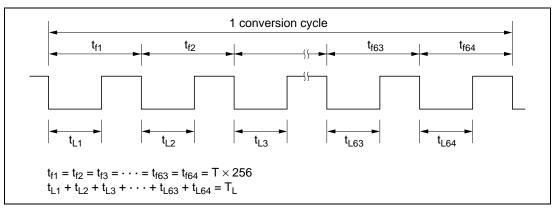


Figure 10.4 (2) Output Waveform

2. OS = 1 (DADR corresponds to T_{H})

a. CFS = 0 [base cycle = resolution (T) × 64]

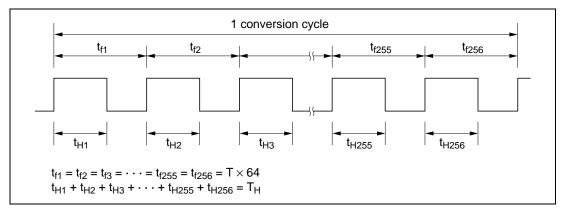


Figure 10.4 (3) Output Waveform

b. CFS = 1 [base cycle = resolution (T) \times 256]

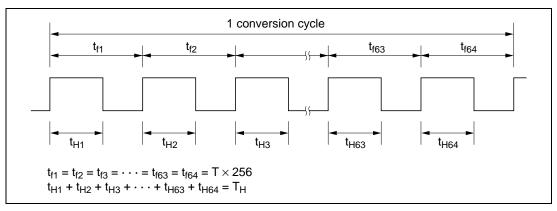


Figure 10.4 (4) Output Waveform

Section 11 16-Bit Free-Running Timer

11.1 Overview

The H8S/2138 Series and H8S/2134 Series have a single-channel on-chip 16-bit free-running timer (FRT) module that uses a 16-bit free-running counter as a time base. Applications of the FRT module include rectangular-wave output (up to two independent waveforms), input pulse width measurement, and measurement of external clock periods.

11.1.1 Features

The features of the free-running timer module are listed below.

- Selection of four clock sources
 - The free-running counter can be driven by an internal clock source ($\emptyset/2$, $\emptyset/8$, or $\emptyset/32$), or an external clock input (enabling use as an external event counter).
- Two independent comparators
 - Each comparator can generate an independent waveform.
- Four input capture channels
 - The current count can be captured on the rising or falling edge (selectable) of an input signal.
 - The four input capture registers can be used separately, or in a buffer mode.
- Counter can be cleared under program control
 - The free-running counters can be cleared on compare-match A.
- Seven independent interrupts
 - Two compare-match interrupts, four input capture interrupts, and one overflow interrupt can be requested independently.
- Special functions provided by automatic addition function
 - The contents of OCRAR and OCRAF can be added to the contents of OCRA automatically, enabling a periodic waveform to be generated without software intervention.
 - The contents of ICRD can be added automatically to the contents of OCRDM \times 2, enabling input capture operations in this interval to be restricted.

11.1.2 Block Diagram

Figure 11.1 shows a block diagram of the free-running timer.

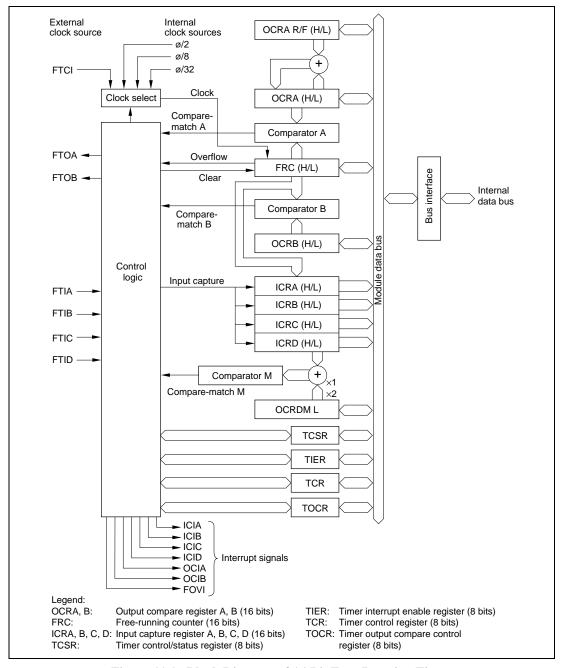


Figure 11.1 Block Diagram of 16-Bit Free-Running Timer

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11.1.3 Input and Output Pins

Table 11.1 lists the input and output pins of the free-running timer module.

Table 11.1 Input and Output Pins of Free-Running Timer Module

Name	Abbreviation	I/O	Function
Counter clock input	FTCI	Input	FRC counter clock input
Output compare A	FTOA	Output	Output compare A output
Output compare B	FTOB	Output	Output compare B output
Input capture A	FTIA	Input	Input capture A input
Input capture B	FTIB	Input	Input capture B input
Input capture C	FTIC	Input	Input capture C input
Input capture D	FTID	Input	Input capture D input

11.1.4 Register Configuration

Table 11.2 lists the registers of the free-running timer module.

Table 11.2 Register Configuration

Name	Abbreviation	R/W	Initial Value	Address*1
Timer interrupt enable register	TIER	R/W	H'01	H'FF90
Timer control/status register	TCSR	R/(W)* ²	H'00	H'FF91
Free-running counter	FRC	R/W	H'0000	H'FF92
Output compare register A	OCRA	R/W	H'FFFF	H'FF94* ³
Output compare register B	OCRB	R/W	H'FFFF	H'FF94* ³
Timer control register	TCR	R/W	H'00	H'FF96
Timer output compare control register	TOCR	R/W	H'00	H'FF97
Input capture register A	ICRA	R	H'0000	H'FF98* ⁴
Input capture register B	ICRB	R	H'0000	H'FF9A* ⁴
Input capture register C	ICRC	R	H'0000	H'FF9C*4
Input capture register D	ICRD	R	H'0000	H'FF9E
Output compare register AR	OCRAR	R/W	H'FFFF	H'FF98* ⁴
Output compare register AF	OCRAF	R/W	H'FFFF	H'FF9A* ⁴
Output compare register DM	OCRDM	R/W	H'0000	H'FF9C*4
Module stop control register	MSTPCRH	R/W	H'3F	H'FF86
	MSTPCRL	R/W	H'FF	H'FF87

Notes: 1. Lower 16 bits of the address.

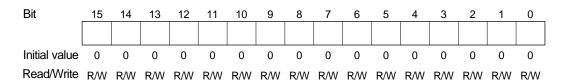
2. Bits 7 to 1 are read-only; only 0 can be written to clear the flags. Bit 0 is readable/writable.

3. OCRA and OCRB share the same address. Access is controlled by the OCRS bit in TOCR.

4. ICRA, ICRB, and ICRC share the same addresses with OCRAR, OCRAF, and OCRDM. Access is controlled by the ICRS bit in TOCR.

11.2 Register Descriptions

11.2.1 Free-Running Counter (FRC)



FRC is a 16-bit readable/writable up-counter that increments on an internal pulse generated from a clock source. The clock source is selected by bits CKS1 and CKS0 in TCR.

FRC can also be cleared by compare-match A.

When FRC overflows from H'FFFF to H'0000, the overflow flag (OVF) in TCSR is set to 1.

FRC is initialized to H'0000 by a reset and in hardware standby mode.

11.2.2 Output Compare Registers A and B (OCRA, OCRB)

Bit	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Initial value	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
Read/Write	R/W															

OCRA and OCRB are 16-bit readable/writable registers, the contents of which are continually compared with the value in the FRC. When a match is detected, the corresponding output compare flags (OCFA or OCFB) is set in TCSR.

In addition, if the output enable bit (OEA or OEB) in TOCR is set to 1, when OCR and FRC values match, the logic level selected by the output level bit (OLVLA or OLVLB) in TOCR is output at the output compare pin (FTOA or FTOB). Following a reset, the FTOA and FTOB output levels are 0 until the first compare-match.

OCR is initialized to H'FFFF by a reset and in hardware standby mode.

11.2.3	Input	Capture	Registers	A to	D (ICI	RA to ICRD)
--------	-------	---------	------------------	------	--------	-------------

Bit	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Initial value	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Read/Write	R	R	R	R	R	R	R	R	R	R	R	R	R	R	R	R

There are four input capture registers, A to D, each of which is a 16-bit read-only register.

When the rising or falling edge of the signal at an input capture input pin (FTIA to FTID) is detected, the current FRC value is copied to the corresponding input capture register (ICRA to ICRD). At the same time, the corresponding input capture flag (ICFA to ICFD) in TCSR is set to 1. The input capture edge is selected by the input edge select bits (IEDGA to IEDGD) in TCR.

ICRC and ICRD can be used as ICRA and ICRB buffer registers, respectively, and made to perform buffer operations, by means of buffer enable bits A and B (BUFEA, BUFEB) in TCR.

Figure 11.2 shows the connections when ICRC is specified as the ICRA buffer register (BUFEA = 1). When ICRC is used as the ICRA buffer, both rising and falling edges can be specified as transitions of the external input signal by setting IEDGA _ IEDGC. When IEDGA = IEDGC, either the rising or falling edge is designated. See table 11.3.

Note: The FRC contents are transferred to the input capture register regardless of the value of the input capture flag (ICF).

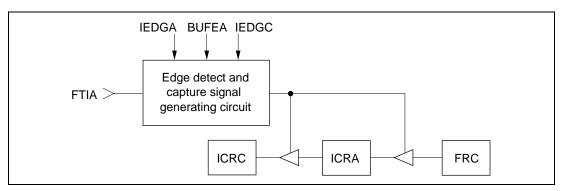


Figure 11.2 Input Capture Buffering (Example)

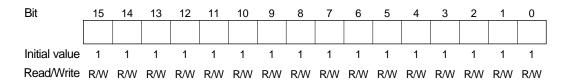
IEDGA	IEDGC	Description					
0	0	Captured on falling edge of input capture A (FTIA) (Initial value	ıe)				
	1	Captured on both rising and falling edges of input capture A (FTIA)					
1	0						
	1	Captured on rising edge of input capture A (FTIA)	_				

Table 11.3 Buffered Input Capture Edge Selection (Example)

To ensure input capture, the width of the input capture pulse should be at least 1.5 system clock periods $(1.5\emptyset)$. When triggering is enabled on both edges, the input capture pulse width should be at least 2.5 system clock periods.

ICR is initialized to H'0000 by a reset and in hardware standby mode.

11.2.4 Output Compare Registers AR and AF (OCRAR, OCRAF)



OCRAR and OCRAF are 16-bit readable/writable registers.

When the OCRAMS bit in TOCR is set to 1, the operation of OCRA is changed to include the use of OCRAR and OCRAF. The contents of OCRAR and OCRAF are automatically added alternately to OCRA, and the result is written to OCRA. The write operation is performed on the occurrence of compare-match A. In the first compare-match A after the OCRAMS bit is set to 1, OCRAF is added.

The operation due to compare-match A varies according to whether the compare-match follows addition of OCRAR or OCRAF. The value of the OLVLA bit in TOCR is ignored, and 1 is output on a compare-match A following addition of OCRAF, while 0 is output on a compare-match A following addition of OCRAF.

When the OCRA automatically addition function is used, do not set internal clock $\phi/2$ as the FRC counter input clock together with an OCRAR (or OCRAF) value of H'0001 or less.

OCRAR and OCRAF are initialized to H'FFFF by a reset and in hardware standby mode.

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11.2.5 Output Compare Register DM (OCRDM)

Bit	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Initial value	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Read/Write	R	R	R	R	R	R	R	R	R/W							

OCRDM is a 16-bit readable/writable register in which the upper 8 bits are fixed at H'00.

When the ICRDMS bit in TOCR is set to 1 and the contents of OCRDM are other than H'0000, the operation of ICRD is changed to include the use of OCRDM. The point at which input capture D occurs is taken as the start of a mask interval. Next, twice the contents of OCRDM is added to the contents of ICRD, and the result is compared with the FRC value. The point at which the values match is taken as the end of the mask interval. New input capture D events are disabled during the mask interval.

A mask interval is not generated when the ICRDMS bit is set to 1 and the contents of OCRDM are H'0000.

OCRDM is initialized to H'0000 by a reset and in hardware standby mode.

11.2.6 Timer Interrupt Enable Register (TIER)

Bit	7	6	5	4	3	2	1	0
	ICIAE	ICIBE	ICICE	ICIDE	OCIAE	OCIBE	OVIE	—
Initial value	0	0	0	0	0	0	0	1
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	_

TIER is an 8-bit readable/writable register that enables and disables interrupts.

TIER is initialized to H'01 by a reset and in hardware standby mode.

Bit 7—Input Capture Interrupt A Enable (ICIAE): Selects whether to request input capture interrupt A (ICIA) when input capture flag A (ICFA) in TCSR is set to 1.

Bit 7

ICIAE	Description	
0	Input capture interrupt request A (ICIA) is disabled	(Initial value)
1	Input capture interrupt request A (ICIA) is enabled	

Bit 6—Input Capture Interrupt B Enable (ICIBE): Selects whether to request input capture interrupt B (ICIB) when input capture flag B (ICFB) in TCSR is set to 1.

Bit 6

ICIBE	Description	
0	Input capture interrupt request B (ICIB) is disabled	(Initial value)
1	Input capture interrupt request B (ICIB) is enabled	

Bit 5—Input Capture Interrupt C Enable (ICICE): Selects whether to request input capture interrupt C (ICIC) when input capture flag C (ICFC) in TCSR is set to 1.

Bit 5		
ICICE	Description	
0	Input capture interrupt request C (ICIC) is disabled	(Initial value)
1	Input capture interrupt request C (ICIC) is enabled	

Bit 4—Input Capture Interrupt D Enable (ICIDE): Selects whether to request input capture interrupt D (ICID) when input capture flag D (ICFD) in TCSR is set to 1.

Bit 4

ICIDE	Description	
0	Input capture interrupt request D (ICID) is disabled	(Initial value)
1	Input capture interrupt request D (ICID) is enabled	

Bit 3—Output Compare Interrupt A Enable (OCIAE): Selects whether to request output compare interrupt A (OCIA) when output compare flag A (OCFA) in TCSR is set to 1.

Bit 3

OCIAE	Description	
0	Output compare interrupt request A (OCIA) is disabled	(Initial value)
1	Output compare interrupt request A (OCIA) is enabled	

Bit 2—Output Compare Interrupt B Enable (OCIBE): Selects whether to request output compare interrupt B (OCIB) when output compare flag B (OCFB) in TCSR is set to 1.

Bit 2

OCIBE	Description	
0	Output compare interrupt request B (OCIB) is disabled	(Initial value)
1	Output compare interrupt request B (OCIB) is enabled	

Bit 1—Timer Overflow Interrupt Enable (OVIE): Selects whether to request a free-running timer overflow interrupt (FOVI) when the timer overflow flag (OVF) in TCSR is set to 1.

OVIE	Description	
0	Timer overflow interrupt request (FOVI) is disabled	(Initial value)
1	Timer overflow interrupt request (FOVI) is enabled	

Bit 0—Reserved: This bit cannot be modified and is always read as 1.

11.2.7 Timer Control/Status Register (TCSR)

Bit	7	6	5	4	3	2	1	0
	ICFA	ICFB	ICFC	ICFD	OCFA	OCFB	OVF	CCLRA
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/(W)*	R/W						

Note: * Only 0 can be written in bits 7 to 1 to clear these flags.

TCSR is an 8-bit register used for counter clear selection and control of interrupt request signals.

TCSR is initialized to H'00 by a reset and in hardware standby mode.

Timing is described in section 11.3, Operation.

Bit 7—Input Capture Flag A (ICFA): This status flag indicates that the FRC value has been transferred to ICRA by means of an input capture signal. When BUFEA = 1, ICFA indicates that the old ICRA value has been moved into ICRC and the new FRC value has been transferred to ICRA.

ICFA must be cleared by software. It is set by hardware, however, and cannot be set by software.

Bit 7

ICFA	Description	
0	[Clearing condition]	(Initial value)
	Read ICFA when ICFA = 1, then write 0 in ICFA	
1	[Setting condition]	
	When an input capture signal causes the FRC value to be transferred to ICRA	

Bit 6—Input Capture Flag B (ICFB): This status flag indicates that the FRC value has been transferred to ICRB by means of an input capture signal. When BUFEB = 1, ICFB indicates that the old ICRB value has been moved into ICRD and the new FRC value has been transferred to ICRB.

ICFB must be cleared by software. It is set by hardware, however, and cannot be set by software.

Bit 6		
ICFB	Description	
0	[Clearing condition]	(Initial value)
	Read ICFB when ICFB = 1, then write 0 in ICFB	
1	[Setting condition]	
	When an input capture signal causes the FRC value to be transferred	d to ICRB

Bit 5—Input Capture Flag C (ICFC): This status flag indicates that the FRC value has been transferred to ICRC by means of an input capture signal. When BUFEA = 1, on occurrence of the signal transition in FTIC (input capture signal) specified by the IEDGC bit, ICFC is set but data is not transferred to ICRC. Therefore, in buffer operation, ICFC can be used as an external interrupt signal (by setting the ICICE bit to 1).

ICFC must be cleared by software. It is set by hardware, however, and cannot be set by software.

Bit 5		
ICFC	Description	
0	[Clearing condition]	(Initial value)
	Read ICFC when ICFC = 1, then write 0 in ICFC	
1	[Setting condition]	
	When an input capture signal is received	

Bit 4—Input Capture Flag D (ICFD): This status flag indicates that the FRC value has been transferred to ICRD by means of an input capture signal. When BUFEB = 1, on occurrence of the signal transition in FTID (input capture signal) specified by the IEDGD bit, ICFD is set but data is not transferred to ICRD. Therefore, in buffer operation, ICFD can be used as an external interrupt by setting the ICIDE bit to 1.

ICFD must be cleared by software. It is set by hardware, however, and cannot be set by software.

Bit 4

ICFD	Description	
0	[Clearing condition]	(Initial value)
	Read ICFD when ICFD = 1, then write 0 in ICFD	
1	[Setting condition]	
	When an input capture signal is received	

Bit 3—Output Compare Flag A (OCFA): This status flag indicates that the FRC value matches the OCRA value. This flag must be cleared by software. It is set by hardware, however, and cannot be set by software.

 Bit 3
 Description

 0
 [Clearing condition]
 (Initial value)

 Read OCFA when OCFA = 1, then write 0 in OCFA
 1

 1
 [Setting condition]
 When FRC = OCRA

Bit 2—Output Compare Flag B (OCFB): This status flag indicates that the FRC value matches the OCRB value. This flag must be cleared by software. It is set by hardware, however, and cannot be set by software.

Bit 2

OCFB	Description	
0	[Clearing condition]	(Initial value)
	Read OCFB when OCFB = 1, then write 0 in OCFB	
1	[Setting condition]	
	When FRC = OCRB	

Bit 1—Timer Overflow Flag (OVF): This status flag indicates that the FRC has overflowed (changed from H'FFFF to H'0000). This flag must be cleared by software. It is set by hardware, however, and cannot be set by software.

Bit 1

OVF	Description	
0	[Clearing condition]	(Initial value)
	Read OVF when OVF = 1, then write 0 in OVF	
1	[Setting condition]	
	When FRC changes from H'FFFF to H'0000	

Bit 0—Counter Clear A (CCLRA): This bit selects whether the FRC is to be cleared at compare-match A (when the FRC and OCRA values match).

Bit 0

CCLRA	Description	
0	FRC clearing is disabled	(Initial value)
1	FRC is cleared at compare-match A	

11.2.8 Timer Control Register (TCR)

Bit	7	6	5	4	3	2	1	0
	CMIEB	CMIEA	OVIE	CCLR1	CCLR0	CKS2	CKS1	CKS0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

TCR is an 8-bit readable/writable register that selects the rising or falling edge of the input capture signals, enables the input capture buffer mode, and selects the FRC clock source.

TCR is initialized to H'00 by a reset and in hardware standby mode

Bit 7—Input Edge Select A (IEDGA): Selects the rising or falling edge of the input capture A signal (FTIA).

Bit 7

IEDGA	Description	
0	Capture on the falling edge of FTIA	(Initial value)
1	Capture on the rising edge of FTIA	

Bit 6—Input Edge Select B (IEDGB): Selects the rising or falling edge of the input capture B signal (FTIB).

Bit 6

IEDGB	Description	
0	Capture on the falling edge of FTIB	(Initial value)
1	Capture on the rising edge of FTIB	

Bit 5—Input Edge Select C (IEDGC): Selects the rising or falling edge of the input capture C signal (FTIC).

Bit 5

IEDGC	Description	
0	Capture on the falling edge of FTIC	(Initial value)
1	Capture on the rising edge of FTIC	

Bit 4—Input Edge Select D (IEDGD): Selects the rising or falling edge of the input capture D signal (FTID).

Bit 4

IEDGD	Description	
0	Capture on the falling edge of FTID	(Initial value)
1	Capture on the rising edge of FTID	

Bit 3—Buffer Enable A (BUFEA): Selects whether ICRC is to be used as a buffer register for ICRA.

Bit 3

BUFEA	Description	
0	ICRC is not used as a buffer register for input capture A	(Initial value)
1	ICRC is used as a buffer register for input capture A	

Bit 2—Buffer Enable B (BUFEB): Selects whether ICRD is to be used as a buffer register for ICRB.

Bit	2
-----	---

BUFEB Description 0 ICRD is not used as a buffer register for input capture B (Initial value) 1 ICRD is used as a buffer register for input capture B

Bits 1 and 0—Clock Select (CKS1, CKS0): Select external clock input or one of three internal clock sources for the FRC. External clock pulses are counted on the rising edge of signals input to the external clock input pin (FTCI).

Bit 1	Bit 0			
CKS1	CKS0	Description		
0	0	ø/2 internal clock source	(Initial value)	
	1	ø/8 internal clock source		
1	0	ø/32 internal clock source		
	1	External clock source (rising edge)		

11.2.9 Timer Output Compare Control Register (TOCR)

Bit	7	6	5	4	3	2	1	0
	ICRDMS	OCRAMS	ICRS	OCRS	OEA	OEB	OLVLA	OLVLB
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

TOCR is an 8-bit readable/writable register that enables output from the output compare pins, selects the output levels, switches access between output compare registers A and B, controls the ICRD and OCRA operating mode, and switches access to input capture registers A, B, and C.

TOCR is initialized to H'00 by a reset and in hardware standby mode.

Bit 7—Input Capture D Mode Select (ICRDMS): Specifies whether ICRD is used in the normal operating mode or in the operating mode using OCRDM.

Bit 7		
ICRDMS	Description	
0	The normal operating mode is specified for ICRD	(Initial value)
1	The operating mode using OCRDM is specified for ICRD	

Bit 6—Output Compare A Mode Select (OCRAMS): Specifies whether OCRA is used in the normal operating mode or in the operating mode using OCRAR and OCRAF.

OCRAMS	Description	
0	The normal operating mode is specified for OCRA	(Initial value)
1	The operating mode using OCRAR and OCRAF is specified for OCRA	

Bit 5—Input Capture Register Select (ICRS): The same addresses are shared by ICRA and OCRAR, by ICRB and OCRAF, and by ICRC and OCRDM. The ICRS bit determines which registers are selected when the shared addresses are read or written to. The operation of ICRA, ICRB, and ICRC is not affected.

Bit	5
-----	---

ICRS	Description	
0	The ICRA, ICRB, and ICRC registers are selected	(Initial value)
1	The OCRAR, OCRAF, and OCRDM registers are selected	

Bit 4—Output Compare Register Select (OCRS): OCRA and OCRB share the same address. When this address is accessed, the OCRS bit selects which register is accessed. This bit does not affect the operation of OCRA or OCRB.

Bit 4

OCRS	Description	
0	The OCRA register is selected	(Initial value)
1	The OCRB register is selected	

Bit 3—Output Enable A (OEA): Enables or disables output of the output compare A signal (FTOA).

Bit 3

OEA	Description	
0	Output compare A output is disabled	(Initial value)
1	Output compare A output is enabled	

Bit 2—Output Enable B (OEB): Enables or disables output of the output compare B signal (FTOB).

Bit 2		
OEB	Description	
0	Output compare B output is disabled	(Initial value)
1	Output compare B output is enabled	

Bit 1—Output Level A (OLVLA): Selects the logic level to be output at the FTOA pin in response to compare-match A (signal indicating a match between the FRC and OCRA values). When the OCRAMS bit is 1, this bit is ignored.

Bit 1

OLVLA	Description	
0	0 output at compare-match A	(Initial value)
1	1 output at compare-match A	

Bit 0—Output Level B (OLVLB): Selects the logic level to be output at the FTOB pin in response to compare-match B (signal indicating a match between the FRC and OCRB values).

Bit 0

OLVLB	Description	
0	0 output at compare-match B	(Initial value)
1	1 output at compare-match B	

11.2.10 Module Stop Control Register (MSTPCR)

		MSTPCRH					MSTPCRL									
Bit	7	6	5	4	3	2	1	0	7	6	5	4	3	2	1	0
	MSTP15	MSTP14	MSTP13	MSTP12	MSTP11	MSTP10	MSTP9	MSTP8	MSTP7	MSTP6	MSTP5	MSTP4	MSTP3	MSTP2	MSTP1	MSTP0
Initial value	0	0	1	1	1	1	1	1	1	1	1	1	1	1	1	1
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

MSTPCR, comprising two 8-bit readable/writable registers, performs module stop mode control.

When the MSTP13 bit is set to 1, FRT operation is stopped at the end of the bus cycle, and module stop mode is entered. For details, see section 23.5, Module Stop Mode.

MSTPCR is initialized to H'3FFF by a reset and in hardware standby mode. It is not initialized in software standby mode.

MSTPCRH Bit 5—Module Stop (MSTP13): Specifies the FRT module stop mode.

Bit	5
-----	---

MSTPCRH	Description	
0	FRT module stop mode is cleared	
1	FRT module stop mode is set	(Initial value)

11.3 Operation

11.3.1 FRC Increment Timing

FRC increments on a pulse generated once for each period of the selected (internal or external) clock source.

Internal Clock: Any of three internal clocks ($\phi/2$, $\phi/8$, or $\phi/32$) created by division of the system clock (ϕ) can be selected by making the appropriate setting in bits CKS1 and CKS0 in TCR. Figure 11.3 shows the increment timing.

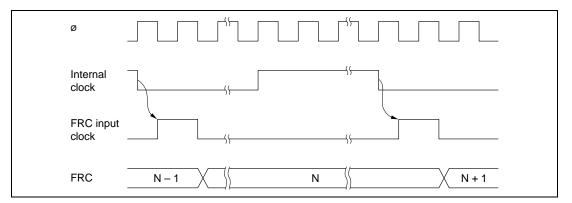


Figure 11.3 Increment Timing with Internal Clock Source

External Clock: If external clock input is selected by bits CKS1 and CKS0 in TCR, FRC increments on the rising edge of the external clock signal.

The pulse width of the external clock signal must be at least 1.5 system clock (\emptyset) periods. The counter will not increment correctly if the pulse width is shorter than 1.5 system clock periods. Figure 11.4 shows the increment timing.

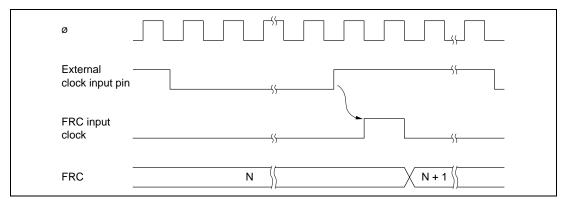


Figure 11.4 Increment Timing with External Clock Source

11.3.2 Output Compare Output Timing

When a compare-match occurs, the logic level selected by the output level bit (OLVLA or OLVLB) in TOCR is output at the output compare pin (FTOA or FTOB). Figure 11.5 shows the timing of this operation for compare-match A.

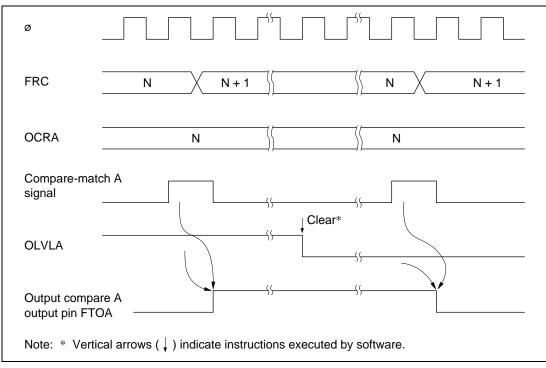


Figure 11.5 Timing of Output Compare A Output

11.3.3 FRC Clear Timing

FRC can be cleared when compare-match A occurs. Figure 11.6 shows the timing of this operation.

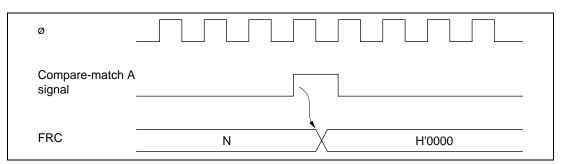


Figure 11.6 Clearing of FRC by Compare-Match A

11.3.4 Input Capture Input Timing

Input Capture Input Timing: An internal input capture signal is generated from the rising or falling edge of the signal at the input capture pin, as selected by the corresponding IEDGx (x = A to D) bit in TCR. Figure 11.7 shows the usual input capture timing when the rising edge is selected (IEDGx = 1).

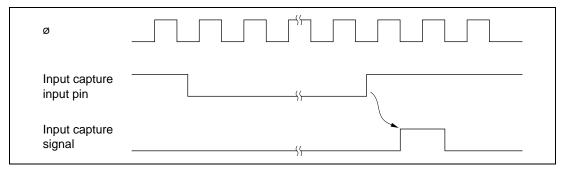


Figure 11.7 Input Capture Signal Timing (Usual Case)

If the upper byte of ICRA/B/C/D is being read when the corresponding input capture signal arrives, the internal input capture signal is delayed by one system clock (\emptyset) period. Figure 11.8 shows the timing for this case.

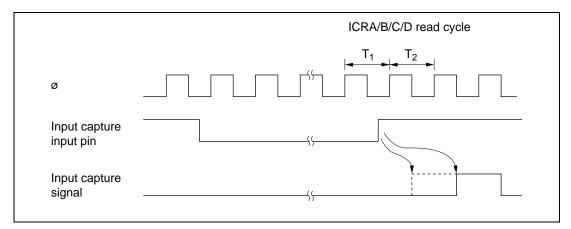


Figure 11.8 Input Capture Signal Timing (Input Capture Input when ICRA/B/C/D is Read)

Buffered Input Capture Input Timing: ICRC and ICRD can operate as buffers for ICRA and ICRB.

Figure 11.9 shows how input capture operates when ICRA and ICRC are used in buffer mode and IEDGA and IEDGC are set to different values (IEDGA = 0 and IEDGC = 1, or IEDG A = 1 and IEDGC = 0), so that input capture is performed on both the rising and falling edges of FTIA.

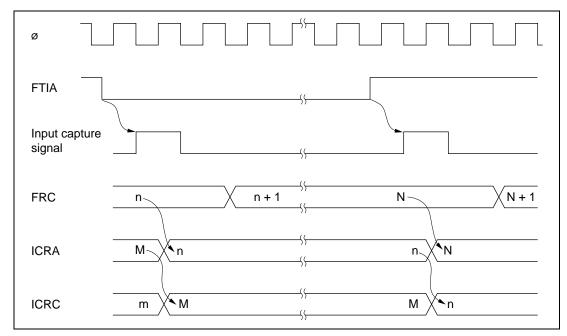


Figure 11.9 Buffered Input Capture Timing (Usual Case)

When ICRC or ICRD is used as a buffer register, its input capture flag is set by the selected transition of its input capture signal. For example, if ICRC is used to buffer ICRA, when the edge transition selected by the IEDGC bit occurs on the FTIC input capture line, ICFC will be set, and if the ICIEC bit is set, an interrupt will be requested. The FRC value will not be transferred to ICRC, however.

In buffered input capture, if the upper byte of either of the two registers to which data will be transferred (ICRA and ICRC, or ICRB and ICRD) is being read when the input signal arrives, input capture is delayed by one system clock (\emptyset) period. Figure 11.10 shows the timing when BUFEA = 1.

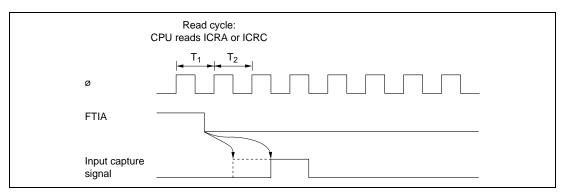


Figure 11.10 Buffered Input Capture Timing (Input Capture Input when ICRA or ICRC is Read)

11.3.5 Timing of Input Capture Flag (ICF) Setting

The input capture flag ICFx (x = A, B, C, D) is set to 1 by the internal input capture signal. The FRC value is simultaneously transferred to the corresponding input capture register (ICRx). Figure 11.11 shows the timing of this operation.

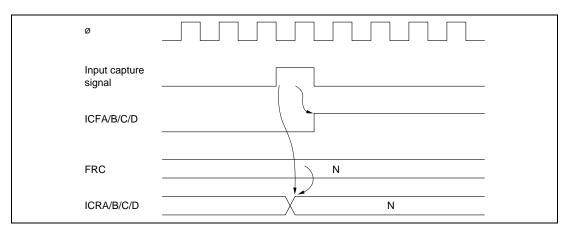


Figure 11.11 Setting of Input Capture Flag (ICFA/B/C/D)

11.3.6 Setting of Output Compare Flags A and B (OCFA, OCFB)

The output compare flags are set to 1 by an internal compare-match signal generated when the FRC value matches the OCRA or OCRB value. This compare-match signal is generated at the last state in which the two values match, just before FRC increments to a new value.

Accordingly, when the FRC and OCR values match, the compare-match signal is not generated until the next period of the clock source. Figure 11.12 shows the timing of the setting of OCFA and OCFB.

Ø	
FRC	N X + 1
OCRA or OCRB	N
Compare-match signal	
OCFA or OCFB	

Figure 11.12 Setting of Output Compare Flag (OCFA, OCFB)

11.3.7 Setting of FRC Overflow Flag (OVF)

The FRC overflow flag (OVF) is set to 1 when FRC overflows (changes from H'FFFF to H'0000). Figure 11.13 shows the timing of this operation.

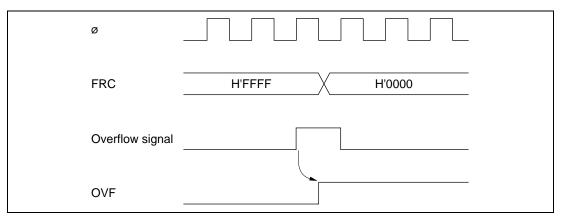


Figure 11.13 Setting of Overflow Flag (OVF)

11.3.8 Automatic Addition of OCRA and OCRAR/OCRAF

When the OCRAMS bit in TOCR is set to 1, the contents of OCRAR and OCRAF are automatically added to OCRA alternately, and when an OCRA compare-match occurs a write to OCRA is performed. The OCRA write timing is shown in figure 11.14.

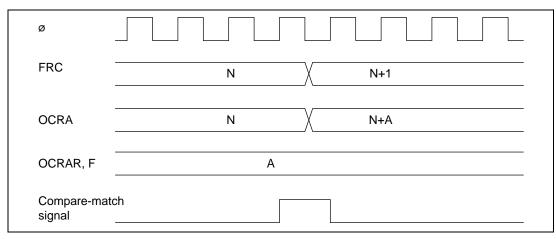


Figure 11.14 OCRA Automatic Addition Timing

11.3.9 ICRD and OCRDM Mask Signal Generation

When the ICRDMS bit in TOCR is set to 1 and the contents of OCRDM are other than H'0000, a signal that masks the ICRD input capture function is generated.

The mask signal is set by the input capture signal. The mask signal setting timing is shown in figure 11.15.

The mask signal is cleared by the sum of the ICRD contents and twice the OCRDM contents, and an FRC compare-match. The mask signal clearing timing is shown in figure 11.16.

Ø	
Input capture signal	
Input capture mask signal	

Figure 11.15 Input Capture Mask Signal Setting Timing

Ø	
FRC	N X N+1
ICRD + OCRDM × 2	Ν
Compare-mato signal	h
Input capture mask signal	

Figure 11.16 Input Capture Mask Signal Clearing Timing

11.4 Interrupts

The free-running timer can request seven interrupts (three types): input capture A to D (ICIA, ICIB, ICIC, ICID), output compare A and B (OCIA and OCIB), and overflow (FOVI). Each interrupt can be enabled or disabled by an enable bit in TIER. Independent signals are sent to the interrupt controller for each interrupt. Table 11.4 lists information about these interrupts.

Interrupt	Description	DTC Activation	Priority
ICIA	Requested by ICFA	Possible	High
ICIB	Requested by ICFB	Possible	
ICIC	Requested by ICFC	Not possible	
ICID	Requested by ICFD	Not possible	
OCIA	Requested by OCFA	Possible	
OCIB	Requested by OCFB	Possible	
FOVI	Requested by OVF	Not possible	Low

 Table 11.4
 Free-Running Timer Interrupts

11.5 Sample Application

In the example below, the free-running timer is used to generate pulse outputs with a 50% duty cycle and arbitrary phase relationship. The programming is as follows:

- The CCLRA bit in TCSR is set to 1.
- Each time a compare-match interrupt occurs, software inverts the corresponding output level bit in TOCR (OLVLA or OLVLB).

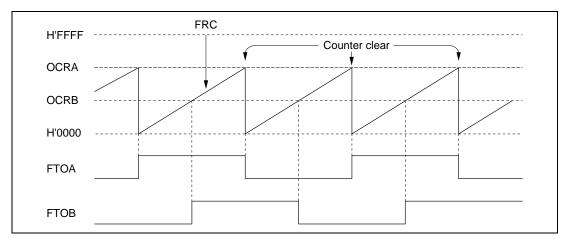


Figure 11.17 Pulse Output (Example)

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11.6 Usage Notes

Application programmers should note that the following types of contention can occur in the free-running timer.

Contention between FRC Write and Clear: If an internal counter clear signal is generated during the state after an FRC write cycle, the clear signal takes priority and the write is not performed.

Figure 11.18 shows this type of contention.

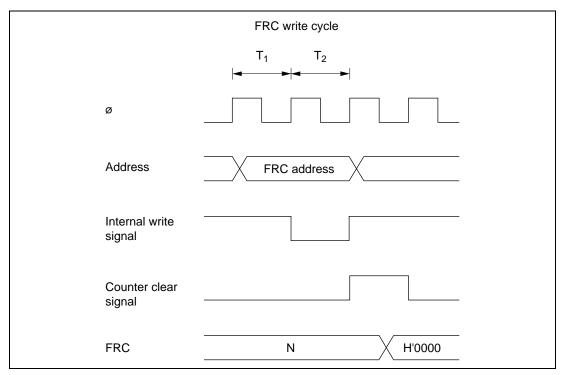


Figure 11.18 FRC Write-Clear Contention

Contention between FRC Write and Increment: If an FRC increment pulse is generated during the state after an FRC write cycle, the write takes priority and FRC is not incremented.

Figure 11.19 shows this type of contention.

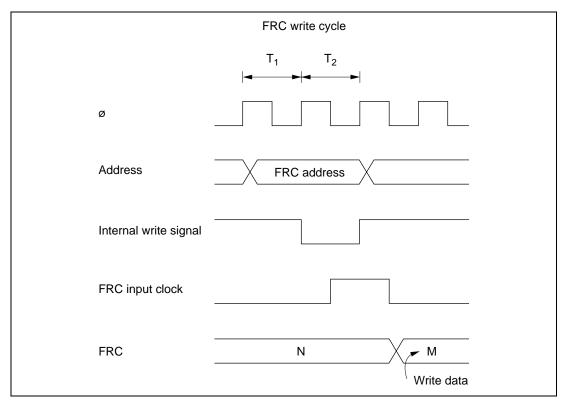


Figure 11.19 FRC Write-Increment Contention

Contention between OCR Write and Compare-Match: If a compare-match occurs during the state after an OCRA or OCRB write cycle, the write takes priority and the compare-match signal is inhibited.

Figure 11.20 shows this type of contention.

If automatic addition of OCRAR/OCRAF to OCRA is selected, and a compare-match occurs in the cycle following the OCRA, OCRAR and OCRAF write cycle, the OCRA, OCRAR and OCRAF write takes priority and the compare-match signal is inhibited. Consequently, the result of the automatic addition is not written to OCRA.

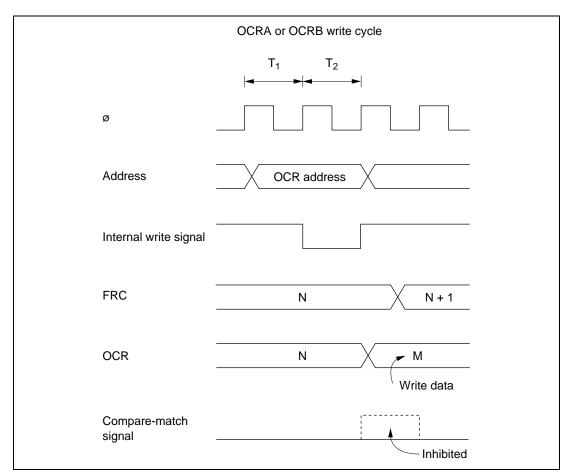


Figure 11.20 Contention between OCR Write and Compare-Match (When Automatic Addition Function Is Not Used)

Switching of Internal Clock and FRC Operation: When the internal clock is changed, the changeover may cause FRC to increment. This depends on the time at which the clock select bits (CKS1 and CKS0) are rewritten, as shown in table 11.5.

When an internal clock is used, the FRC clock is generated on detection of the falling edge of the internal clock scaled from the system clock (ϕ). If the clock is changed when the old source is high and the new source is low, as in case no. 3 in table 11.5, the changeover is regarded as a falling edge that triggers the FRC increment clock pulse.

Switching between an internal and external clock can also cause FRC to increment.

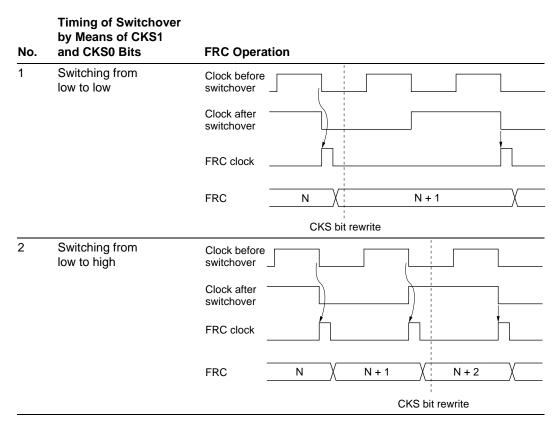


 Table 11.5
 Switching of Internal Clock and FRC Operation

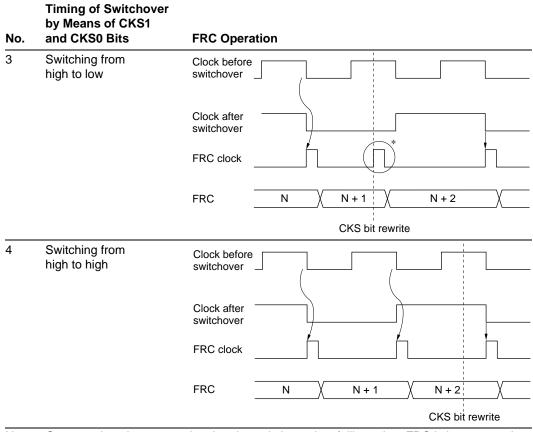
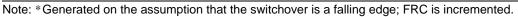


 Table 11.5
 Switching of Internal Clock and FRC Operation (cont)



Section 12 8-Bit Timers

12.1 Overview

The H8S/2138 Series and H8S/2134 Series include an 8-bit timer module with two channels (TMR0 and TMR1). Each channel has an 8-bit counter (TCNT) and two time constant registers (TCORA and TCORB) that are constantly compared with the TCNT value to detect comparematches. The 8-bit timer module can be used as a multifunction timer in a variety of applications, such as generation of a rectangular-wave output with an arbitrary duty cycle.

The H8S/2138 Series also has two similar 8-bit timer channels (TMRX and TMRY), and the H8S/2134 Series has one (TMRY). These channels can be used in a connected configuration using the timer connection function. TMRX and TMRY have greater input/output and interrupt function related restrictions than TMR0 and TMR1.

12.1.1 Features

- Selection of clock sources
 - TMR0, TMR1: The counter input clock can be selected from six internal clocks and an external clock (enabling use as an external event counter).
 - TMRX, TMRY: The counter input clock can be selected from three internal clocks and an external clock (enabling use as an external event counter).
- Selection of three ways to clear the counters
 - The counters can be cleared on compare-match A or B, or by an external reset signal.
- Timer output controlled by two compare-match signals
 - The timer output signal in each channel is controlled by two independent compare-match signals, enabling the timer to be used for various applications, such as the generation of pulse output or PWM output with an arbitrary duty cycle.
 - (Note: TMRY does not have a timer output pin.)
- Cascading of the two channels (TMR0, TMR1)
 - Operation as a 16-bit timer can be performed using channel 0 as the upper half and channel 1 as the lower half (16-bit count mode).
 - Channel 1 can be used to count channel 0 compare-match occurrences (compare-match count mode).
- Multiple interrupt sources for each channel
 - TMR0, TMR1, TMRY: Two compare-match interrupts and one overflow interrupt can be requested independently.
 - TMRX: One input capture source is available.

12.1.2 Block Diagram

Figure 12.1 shows a block diagram of the 8-bit timer module (TMR0 and TMR1).

TMRX and TMRY have a similar configuration, but cannot be cascaded. TMRX also has an input capture function. For details, see section 13, Timer Connection.

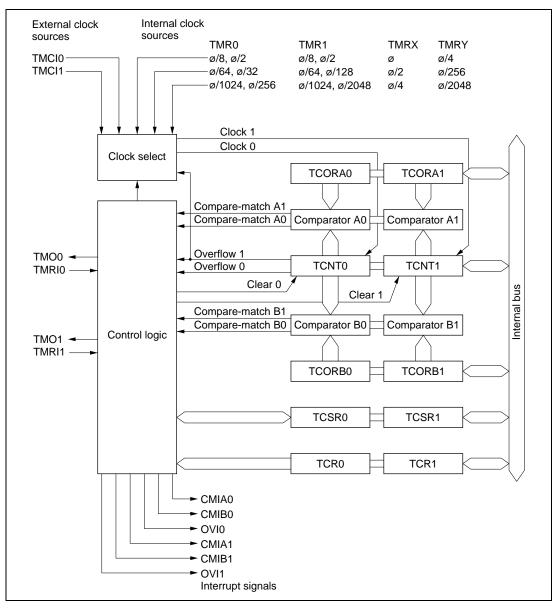


Figure 12.1 Block Diagram of 8-Bit Timer Module

12.1.3 Pin Configuration

Table 12.1 summarizes the input and output pins of the 8-bit timer module.

Table 12.1	8-Bit Timer Input and Output Pins

Channel	Name	Symbol*	I/O	Function
0	Timer output	TMO0	Output	Output controlled by compare-match
	Timer clock input	TMCI0	Input	External clock input for the counter
	Timer reset input	TMRI0	Input	External reset input for the counter
1	Timer output	TMO1	Output	Output controlled by compare-match
	Timer clock input	TMCI1	Input	External clock input for the counter
	Timer reset input	TMRI1	Input	External reset input for the counter
Х	Timer output	ТМОХ	Output	Output controlled by compare-match
	Timer clock/ reset input	HFBACKI/TMIX (TMCIX/TMRIX)		External clock/reset input for the counter
Y	Timer clock/reset input	VSYNCI/TMIY (TMCIY/TMRIY)	Input	External clock/reset input for the counter

Note: *The abbreviations TMO, TMCI, and TMRI are used in the text, omitting the channel number.

Channel X and Y I/O pins have the same internal configuration as channels 0 and 1, and therefore the same abbreviations are used.

12.1.4 Register Configuration

Table 12.2 summarizes the registers of the 8-bit timer module.

Table 12.2	8-Bit Timer	Registers
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Channel	Name	Abbreviation* ³	R/W	Initial value	Address*1
0	Timer control register 0	TCR0	R/W	H'00	H'FFC8
	Timer control/status register 0	TCSR0	R/(W)* ²	H'00	H'FFCA
	Time constant register A0	TCORA0	R/W	H'FF	H'FFCC
	Time constant register B0	TCORB0	R/W	H'FF	H'FFCE
	Time counter 0	TCNT0	R/W	H'00	H'FFD0
1	Timer control register 1	TCR1	R/W	H'00	H'FFC9
	Timer control/status register 1	TCSR1	R/(W)* ²	H'10	H'FFCB
	Time constant register A1	TCORA1	R/W	H'FF	H'FFCD
	Time constant register B1	TCORB1	R/W	H'FF	H'FFCF
	Timer counter 1	TCNT1	R/W	H'00	H'FFD1
Common	Serial/timer control register	STCR	R/W	H'00	H'FFC3
	Module stop control register	MSTPCRH	R/W	H'3F	H'FF86
		MSTPCRL	R/W	H'FF	H'FF87
	Timer connection register S	TCONRS	R/W	H'00	H'FFFE
Х	Timer control register X	TCRX	R/W	H'00	H'FFF0
	Timer control/status register X	TCSRX	R/(W)* ²	H'00	H'FFF1
	Time constant register AX	TCORAX	R/W	H'FF	H'FFF6
	Time constant register BX	TCORBX	R/W	H'FF	H'FFF7
	Timer counter X	TCNTX	R/W	H'00	H'FFF4
	Time constant register C	TCORC	R/W	H'FF	H'FFF5
	Input capture register R	TICRR	R	H'00	H'FFF2
	Input capture register F	TICRF	R	H'00	H'FFF3
Y	Timer control register Y	TCRY	R/W	H'00	H'FFF0
	Timer control/status register Y	TCSRY	R/(W)* ²	H'00	H'FFF1
	Time constant register AY	TCORAY	R/W	H'FF	H'FFF2
	Time constant register BY	TCORBY	R/W	H'FF	H'FFF3
	Timer counter Y	TCNTY	R/W	H'00	H'FFF4
	Timer input select register	TISR	R/W	H'FE	H'FFF5

Notes: 1. Lower 16 bits of the address.

2. Only 0 can be written in bits 7 to 5, to clear these flags.

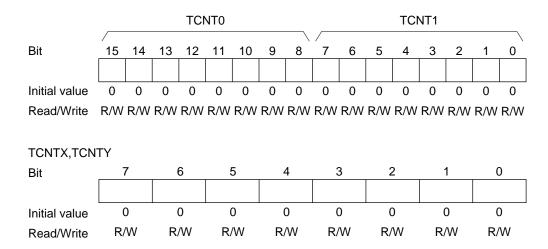
3. The abbreviations TCR, TCSR, TCORA, TCORB, and TCNT are used in the text, omitting the channel designation (0, 1, X, or Y).

Each pair of registers for channel 0 and channel 1 comprises a 16-bit register with the upper 8 bits for channel 0 and the lower 8 bits for channel 1, so they can be accessed together by word access. (Access is not divided into two 8-bit accesses.)

Certain of the channel X and channel Y registers are assigned to the same address. The TMRX/Y bit in TCONRS determines which register is accessed.

12.2 Register Descriptions

12.2.1 Timer Counter (TCNT)



Each TCNT is an 8-bit readable/writable up-counter.

TCNT0 and TCNT1 comprise a single 16-bit register, so they can be accessed together by word access.

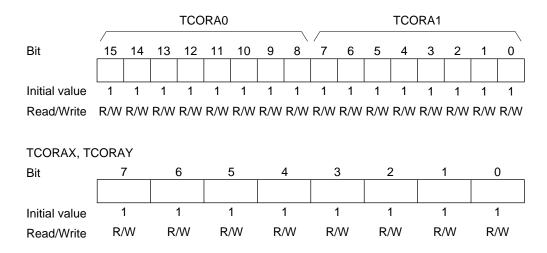
TCNT increments on pulses generated from an internal or external clock source. This clock source is selected by clock select bits CKS2 to CKS0 in TCR.

TCNT can be cleared by an external reset input signal or compare-match signal. Counter clear bits CCLR1 and CCLR0 in TCR select the method of clearing.

When TCNT overflows from H'FF to H'00, the overflow flag (OVF) in TCSR is set to 1.

The timer counters are initialized to H'00 by a reset and in hardware standby mode.

12.2.2 Time Constant Register A (TCORA)



TCORA is an 8-bit readable/writable register.

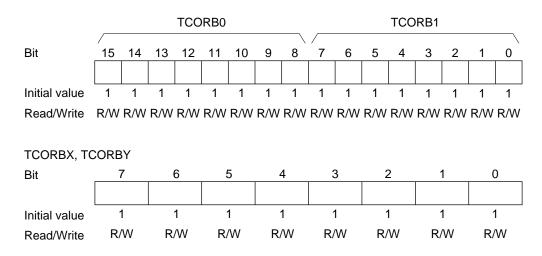
TCORA0 and TCORA1 comprise a single 16-bit register, so they can be accessed together by word access.

TCORA is continually compared with the value in TCNT. When a match is detected, the corresponding compare-match flag A (CMFA) in TCSR is set. Note, however, that comparison is disabled during the T2 state of a TCORA write cycle.

The timer output can be freely controlled by these compare-match signals and the settings of output select bits OS1 and OS0 in TCSR.

TCORA is initialized to H'FF by a reset and in hardware standby mode.

12.2.3 Time Constant Register B (TCORB)



TCORB is an 8-bit readable/writable register. TCORB0 and TCORB1 comprise a single 16-bit register, so they can be accessed together by word access.

TCORB is continually compared with the value in TCNT. When a match is detected, the corresponding compare-match flag B (CMFB) in TCSR is set. Note, however, that comparison is disabled during the T2 state of a TCORB write cycle.

The timer output can be freely controlled by these compare-match signals and the settings of output select bits OS3 and OS2 in TCSR.

TCORB is initialized to H'FF by a reset and in hardware standby mode.

12.2.4 Timer Control Register (TCR)

Bit	7	6	5	4	3	2	1	0
	IEDGA	IEDGB	IEDGC	IEDGD	BUFEA	BUFEB	CKS1	CKS0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

TCR is an 8-bit readable/writable register that selects the clock source and the time at which TCNT is cleared, and enables interrupts.

TCR is initialized to H'00 by a reset and in hardware standby mode.

For details of the timing, see section 12.3, Operation.

Bit 7—Compare-Match Interrupt Enable B (CMIEB): Selects whether the CMFB interrupt request (CMIB) is enabled or disabled when the CMFB flag in TCSR is set to 1.

Note that a CMIB interrupt is not requested by TMRX, regardless of the CMIEB value.

Bit 7		
CMIEB	Description	
0	CMFB interrupt request (CMIB) is disabled	(Initial value)
1	CMFB interrupt request (CMIB) is enabled	

Bit 6—Compare-Match Interrupt Enable A (CMIEA): Selects whether the CMFA interrupt request (CMIA) is enabled or disabled when the CMFA flag in TCSR is set to 1.

Note that a CMIA interrupt is not requested by TMRX, regardless of the CMIEA value.

Bit 6

CMIEA	Description	
0	CMFA interrupt request (CMIA) is disabled	(Initial value)
1	CMFA interrupt request (CMIA) is enabled	

Bit 5—Timer Overflow Interrupt Enable (OVIE): Selects whether the OVF interrupt request (OVI) is enabled or disabled when the OVF flag in TCSR is set to 1.

Note that an OVI interrupt is not requested by TMRX, regardless of the OVIE value.

Bit 5		
OVIE	Description	
0	OVF interrupt request (OVI) is disabled	(Initial value)
1	OVF interrupt request (OVI) is enabled	

Bits 4 and 3—Counter Clear 1 and 0 (CCLR1, CCLR0): These bits select the method by which the timer counter is cleared: by compare-match A or B, or by an external reset input.

Bit 4	Bit 3		
CCLR1	CCLR0	Description	
0	0	Clearing is disabled	(Initial value)
	1	Cleared on compare-match A	
1	0	Cleared on compare-match B	
	1	Cleared on rising edge of external reset input	

Bits 2 to 0—Clock Select 2 to 0 (CKS2 to CKS0): These bits select whether the clock input to TCNT is an internal or external clock.

The input clock can be selected from either six or three clocks, all divided from the system clock (Ø). The falling edge of the selected internal clock triggers the count.

When use of an external clock is selected, three types of count can be selected: at the rising edge, the falling edge, and both rising and falling edges.

Some functions differ between channel 0 and channel 1, because of the cascading function.

		TCR		STCR				
	Bit 2	Bit 1	Bit 0	Bit 1	Bit 0			
Channel	CKS2	CKS1	CKS0	ICKS1	ICKS0	Description		
0	0	0	0	_	_	Clock input disabled (Initial value)		
	0	0	1	_	0	ø/8 internal clock source, counted on the falling edge		
	0	0	1	—	1	ø/2 internal clock source, counted on the falling edg		
	0	1	0	_	0	ø/64 internal clock source, counted on the falling edge		
	0	1	0	_	1	Ø/32 internal clock source, counted on the falling edge		
	0	1	1	_	0	ø/1024 internal clock source, counted on the falling edge		
	0	1	1	_	1	Ø/256 internal clock source, counted on the falling edge		
	1	0	0	_	_	Counted on TCNT1 overflow signal*		
1	0	0	0	_	_	Clock input disabled (Initial value)		
	0	0	1	0		ø/8 internal clock source, counted on the falling edge		
	0	0	1	1	_	ø/2 internal clock source, counted on the falling edge		
	0	1	0	0	—	ø/64 internal clock source, counted on the falling edge		
	0	1	0	1	_	Ø/128 internal clock source, counted on the falling edge		
	0	1	1	0	—	ø/1024 internal clock source, counted on the falling edge		
	0	1	1	1	—	ø/2048 internal clock source, counted on the falling edge		
	1	0	0	_	_	Counted on TCNT0 compare-match A*		

	TCR		STCR					
	Bit 2	Bit 1	Bit 0	Bit 1	Bit 0			
Channel	CKS2	CKS1	CKS0	ICKS1	ICKS0	Description		
Х	0	0	0	_	—	Clock input disabled (Initial value)		
	0	0	1	_	—	Counted on ø internal clock source		
	0	1	0	_	_	ø/2 internal clock source, counted on the falling edge		
	0	1	1	_	_	ø/4 internal clock source, counted on the falling edge		
	1	0	0	_	_	Clock input disabled		
Y	0	0	0	_	_	Clock input disabled (Initial value)		
	0	0	1	_	_	ø/4 internal clock source, counted on the falling edge		
	0	1	0	_	_	ø/256 internal clock source, counted on the falling edge		
	0	1	1	_	_	ø/2048 internal clock source, counted on the falling edge		
	1	0	0	—	—	Clock input disabled		
Common	1	0	1	—	—	External clock source, counted at rising edge		
	1	1	0	_	—	External clock source, counted at falling edge		
	1	1	1	_	_	External clock source, counted at both rising and falling edges		

Note: *If the count input of channel 0 is the TCNT1 overflow signal and that of channel 1 is the TCNT0 compare-match signal, no incrementing clock will be generated. Do not use this setting.

12.2.5 Timer Control/Status Register (TCSR)

TCSR0								
Bit	7	6	5	4	3	2	1	0
	CMFB	CMFA	OVF	ADTE	OS3	OS2	OS1	OS0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/(W)*	R/(W)*	R/(W)*	R/W	R/W	R/W	R/W	R/W
TCSR1								
Bit	7	6	5	4	3	2	1	0
	CMFB	CMFA	OVF	—	OS3	OS2	OS1	OS0
Initial value	0	0	0	1	0	0	0	0
Read/Write	R/(W)*	R/(W)*	R/(W)*	—	R/W	R/W	R/W	R/W
TCSRX								
Bit	7	6	5	4	3	2	1	0
	CMFB	CMFA	OVF	ICF	OS3	OS2	OS1	OS0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/(W)*	R/(W)*	R/(W)*	R/(W)*	R/W	R/W	R/W	R/W
TCSRY								
Bit	7	6	5	4	3	2	1	0
	CMFB	CMFA	OVF	ICIE	OS3	OS2	OS1	OS0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/(W)*	R/(W)*	R/(W)*	R/W	R/W	R/W	R/W	R/W

Note: * Only 0 can be written in bits 7 to 5, and in bit 4 in TCSRX, to clear these flags.

TCSR is an 8-bit register that indicates compare-match and overflow statuses (and input capture status in TMRX only), and controls compare-match output.

TCSR0, TCSRX, and TCSRY are initialized to H'00, and TCSR1 is initialized to H'10, by a reset and in hardware standby mode.

Bit 7—Compare-Match Flag B (CMFB): Status flag indicating whether the values of TCNT and TCORB match.

Bit 7

CMFB	Description	
0	[Clearing conditions]	(Initial value)
	• Read CMFB when CMFB = 1, then write 0 in CMFB	
	When the DTC is activated by a CMIB interrupt	
1	[Setting condition]	
	When TCNT = TCORB	

Bit 6—Compare-match Flag A (CMFA): Status flag indicating whether the values of TCNT and TCORA match.

Bit 6

CMFA	Description	
0	[Clearing conditions]	(Initial value)
	• Read CMFA when CMFA = 1, then write 0 in CMFA	
	 When the DTC is activated by a CMIA interrupt 	
1	[Setting condition]	
	When TCNT = TCORA	

Bit 5 — Timer Overflow Flag (OVF): Status flag indicating that TCNT has overflowed (changed from H'FF to H'00).

Bit 5

OVF	Description	
0	[Clearing condition]	(Initial value)
	Read OVF when $OVF = 1$, then write 0 in OVF	
1	[Setting condition]	
	When TCNT overflows from H'FF to H'00	

TCSR0

Bit 4—A/D Trigger Enable (ADTE): Enables or disables A/D converter start requests by compare-match A.

Bit 4

ADTE	Description	
0	A/D converter start requests by compare-match A are disabled	(Initial value)
1	A/D converter start requests by compare-match A are enabled	

TCSR1

Bit 4—Reserved: This bit cannot be modified and is always read as 1.

TCSRX

Bit 4—Input Capture Flag (ICF): Status flag that indicates detection of a rising edge followed by a falling edge in the external reset signal after the ICST bit in TCONRI has been set to 1.

Bit 4

ICF	Description	
0	[Clearing condition] (Initial value	ue)
	Read ICF when ICF = 1, then write 0 in ICF	
1	[Setting condition]	
	When a rising edge followed by a falling edge is detected in the external reset sigr after the ICST bit in TCONRI has been set to 1	nal

TCSRY

Bit 4—Input Capture Interrupt Enable (ICIE): Selects enabling or disabling of the interrupt request by ICF (ICIX) when the ICF bit in TCSRX is set to 1.

Bit 4

ICIE	Description	
0	Interrupt request by ICF (ICIX) is disabled	(Initial value)
1	Interrupt request by ICF (ICIX) is enabled	

Bits 3 to 0—Output Select 3 to 0 (OS3 to OS0): These bits specify how the timer output level is to be changed by a compare-match of TCOR and TCNT.

OS3 and OS2 select the effect of compare-match B on the output level, OS1 and OS0 select the effect of compare-match A on the output level, and both of them can be controlled independently.

Note, however, that priorities are set such that: trigger output > 1 output > 0 output. If comparematches occur simultaneously, the output changes according to the compare-match with the higher priority.

Timer output is disabled when bits OS3 to OS0 are all 0.

Bit 3	Bit 2		
OS3	OS2	Description	
0	0	No change when compare-match B occurs	(Initial value)
	1	0 is output when compare-match B occurs	
1	0	1 is output when compare-match B occurs	
	1	Output is inverted when compare-match B occurs (toggle output)

After a reset, the timer output is 0 until the first compare-match occurs.

Bit 1	Bit 0	
OS1	OS0	Description

OS1	OS0	Description	
0	0	No change when compare-match A occurs	(Initial value)
	1	0 is output when compare-match A occurs	
1	0	1 is output when compare-match A occurs	
	1	Output is inverted when compare-match A occurs (toggle output)

12.2.6 Serial/Timer Control Register (STCR)

Bit	7	6	5	4	3	2	1	0
	IICS	IICX1	IICX0	IICE	FLSHE	—	ICKS1	ICKS0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

STCR is an 8-bit readable/writable register that controls register access, the IIC operating mode (when the on-chip IIC option is included), and on-chip flash memory (in F-ZTAT versions), and also selects the TCNT input clock.

For details on functions not related to the 8-bit timers, see section 3.2.4, Serial/Timer Control Register (STCR), and the descriptions of the relevant modules. If a module controlled by STCR is not used, do not write 1 to the corresponding bit.

STCR is initialized to H'00 by a reset and in hardware standby mode.

Bits 7 to 4—I²C Control (IICS, IICX1, IICX0, IICE): These bits control the operation of the I²C bus interface when the IIC option is included on-chip. See section 16, I²C Bus Interface, for details.

Bit 3—Flash Memory Control Register Enable (FLSHE): Controls the operation of the flash memory in F-ZTAT versions. See section 21, ROM, for details.

Bit 2—Reserved: Do not write 1 to this bit.

Bits 1 and 0—Internal Clock Select 1 and 0 (ICKS1, ICKS0): These bits, together with bits CKS2 to CKS0 in TCR, select the clock to be input to TCNT. For details, see section 12.2.4, Timer Control Register.

12.2.7 System Control Register (SYSCR)

Bit	7	6	5	4	3	2	1	0
	CS2E	IOSE	INTM1	INTM0	XRST	NMIEG	HIE	RAME
Initial value	0	0	0	0	1	0	0	1
Read/Write	R/W	R/W	R	R/W	R	R/W	R/W	R/W

Only bit 1 is described here. For details on functions not related to the 8-bit timers, see sections 3.2.2 and 5.2.1, System Control Register (SYSCR), and the descriptions of the relevant modules.

Bit 1—Host Interface Enable (HIE): Controls CPU access to 8-bit timer (channel X and Y) data registers and control registers, and timer connection control registers.

Bit 1	
HIE	Description
0	CPU access to 8-bit timer (channel X and Y) data registers and control (Initial value) registers, and timer connection control registers, is enabled
1	CPU access to 8-bit timer (channel X and Y) data registers and control registers, and timer connection control registers, is disabled

12.2.8 Timer Connection Register S (TCONRS)

Bit	7	6	5	4	3	2	1	0
	TMRX/Y	ISGENE	HOMOD1	HOMODO	VOMOD1	VOMOD0	CLMOD1	CLMOD0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W							

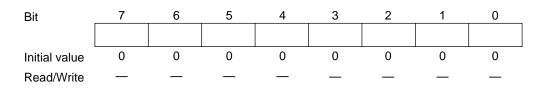
TCONRS is an 8-bit readable/writable register that controls access to the TMRX and TMRY registers and timer connection operation.

TCONRS is initialized to H'00 by a reset and in hardware standby mode.

Bit 7—TMRX/TMRY Access Select (TMRX/Y): The TMRX and TMRY registers can only be accessed when the HIE bit in SYSCR is cleared to 0. In the H8S/2138 Series, some of the TMRX registers and the TMRY registers are assigned to the same memory space addresses (H'FFF0 to H'FFF5), and the TMRX/Y bit determines which registers are accessed. In the H8S/2134 Series, there is no control of TMRY register access by this bit.

Bit 7	Accessible Registers								
TMRX/Y	H'FFF0	H'FFF1	H'FFF2	H'FFF3	H'FFF4	H'FFF5	H'FFF6	H'FFF7	
0	TMRX	TMRX	TMRX	TMRX	TMRX	TMRX	TMRX	TMRX	
(Initial value)	TCRX	TCSRX	TICRR	TICRF	TCNTX	TCORC	TCORAX	(TCORBX	
1	TMRY	TMRY	TMRY	TMRY	TMRY	TMRY			
	TCRY	TCSRY	TCORAY	/ TCORBY	' TCNTY	TISR			

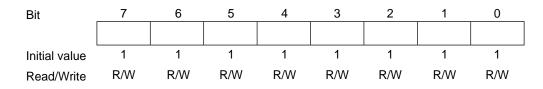
12.2.9 Input Capture Register (TICR) [TMRX Additional Function]



TICR is an 8-bit internal register to which the contents of TCNT are transferred on the falling edge of external reset input. The CPU cannot read or write to TICR directly.

The TICR function is used in timer connection. For details, see section 13, Timer Connection.

12.2.10 Time Constant Register C (TCORC) [TMRX Additional Function]



TCORC is an 8-bit readable/writable register. The sum of the contents of TCORC and TICR is continually compared with the value in TCNT. When a match is detected, a compare-match C signal is generated. Note, however, that comparison is disabled during the T2 state of a TCORC write cycle and a TICR input capture cycle.

TCORC is initialized to H'FF by a reset and in hardware standby mode.

The TCORC function is used in timer connection. For details, see section 13, Timer Connection.

12.2.11 Input Capture Registers R and F (TICRR, TICRF) [TMRX Additional Functions]

Bit	7	6	5	4	3	2	1	0	
Initial value	0	0	0	0	0	0	0	0	-
Read/Write	R	R	R	R	R	R	R	R	

TICRR and TICRF are 8-bit read-only registers. When the ICST bit in TCONRI is set to 1, TICRR and TICRF capture the contents of TCNT successively on the rise and fall of the external reset input. When one capture operation ends, the ICST bit is cleared to 0.

TICRR and TICRF are each initialized to H'00 by a reset and in hardware standby mode.

The TICRR and TICRF functions are used in timer connection. For details, see section 13, Timer Connection.

12.2.12 Timer Input Select Register (TISR) [TMRY Additional Function]

Bit	7	6	5	4	3	2	1	0
	—	—	_	—		—	_	IS
Initial value	1	1	1	1	1	1	1	0
Read/Write	—	—	—	—	—	—	—	R/W

TISR is an 8-bit readable/writable register that selects the external clock/reset signal source for the counter.

TISR is initialized to H'FE by a reset and in hardware standby mode.

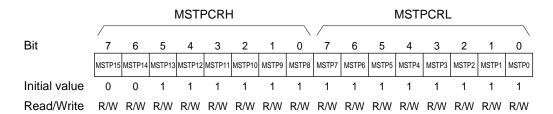
Bits 7 to 1—Reserved: Do not write 0 to these bits.

Bit 0—Input Select (IS): Selects the internal synchronization signal (IVG signal) or the timer clock/reset input pin (VSYNCI/TMIY (TMCIY/TMRIY)) as the external clock/reset signal source for the counter.

Bit 0

IS	Description	
0	IVG signal is selected (H8S/2138 Series) External clock/reset input is disabled (H8S/2134 Series)	(Initial value)
1	VSYNCI/TMIY (TMCIY/TMRIY) is selected	

12.2.13 Module Stop Control Register (MSTPCR)



MSTPCR comprises two 8-bit readable/writable registers, and is used to perform module stop mode control.

When the MSTP12 bit or MSTP8 bit is set to 1, 8-bit timer operation is halted on channels 0 and 1 or channels X and Y, respectively, and a transition is made to module stop mode. For details, see section 23.5, Module Stop Mode.

MSTPCR is initialized to H'3FFF by a reset and in hardware standby mode. It is not initialized in software standby mode.

MSTPCRH Bit 4—Module Stop (MSTP12): Specifies 8-bit timer (channel 0/1) module stop mode.

MSTPCRH Bit 4		
MSTP12	 Description	
0	8-bit timer (channel 0/1) module stop mode is cleared	
1	8-bit timer (channel 0/1) module stop mode is set	(Initial value)

MSTPCRH Bit 0—Module Stop (MSTP8): Specifies 8-bit timer (channel X/Y) and timer connection module stop mode.

MSTPCRH Bit 0				
MSTP8	Description			
0	8-bit timer (channel X/Y) and timer connection module stop mode is cleared			
1	8-bit timer (channel X/Y) and timer connection module stop mode is set	(Initial value)		

12.3 Operation

12.3.1 TCNT Incrementation Timing

TCNT is incremented by input clock pulses (either internal or external).

Internal Clock: An internal clock created by dividing the system clock (ϕ) can be selected by setting bits CKS2 to CKS0 in TCR. Figure 12.2 shows the count timing.

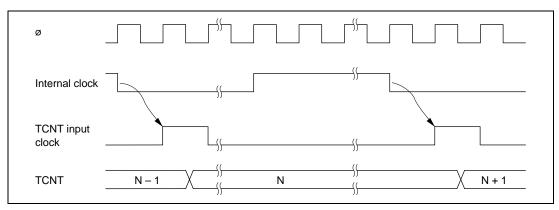


Figure 12.2 Count Timing for Internal Clock Input

External Clock: Three incrementation methods can be selected by setting bits CKS2 to CKS0 in TCR: at the rising edge, the falling edge, and both rising and falling edges.

Note that the external clock pulse width must be at least 1.5 states for incrementation at a single edge, and at least 2.5 states for incrementation at both edges. The counter will not increment correctly if the pulse width is less than these values.

Figure 12.3 shows the timing of incrementation at both edges of an external clock signal.

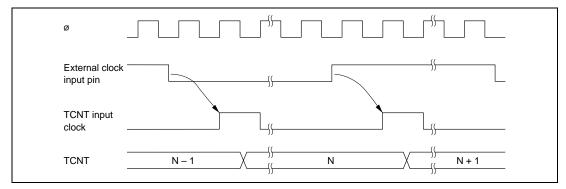


Figure 12.3 Count Timing for External Clock Input

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12.3.2 Compare-Match Timing

Setting of Compare-Match Flags A and B (CMFA, CMFB): The CMFA and CMFB flags in TCSR are set to 1 by a compare-match signal generated when the TCOR and TCNT values match. The compare-match signal is generated at the last state in which the match is true, just before the timer counter is updated.

Therefore, when TCOR and TCNT match, the compare-match signal is not generated until the next incrementation clock input. Figure 12.4 shows this timing.

Ø		
TCNT	N X N + 1	
TCOR	N	
Compare-match signal		
CMF		

Figure 12.4 Timing of CMF Setting

Timer Output Timing: When compare-match A or B occurs, the timer output changes as specified by the output select bits (OS3 to OS0) in TCSR. Depending on these bits, the output can remain the same, be set to 0, be set to 1, or toggle.

Figure 12.5 shows the timing when the output is set to toggle at compare-match A.

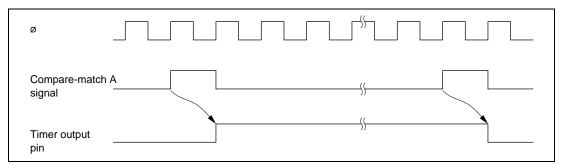


Figure 12.5 Timing of Timer Output

Timing of Compare-Match Clear: TCNT is cleared when compare-match A or B occurs, depending on the setting of the CCLR1 and CCLR0 bits in TCR. Figure 12.6 shows the timing of this operation.

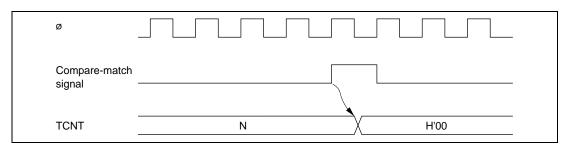


Figure 12.6 Timing of Compare-Match Clear

12.3.3 TCNT External Reset Timing

TCNT is cleared at the rising edge of an external reset input, depending on the settings of the CCLR1 and CCLR0 bits in TCR. The width of the clearing pulse must be at least 1.5 states. Figure 12.7 shows the timing of this operation.

Ø	
External reset input pin	
Clear signal	
TCNT	N – 1 N H'00

Figure 12.7 Timing of Clearing by External Reset Input

12.3.4 Timing of Overflow Flag (OVF) Setting

OVF in TCSR is set to 1 when the timer count overflows (changes from H'FF to H'00). Figure 12.8 shows the timing of this operation.

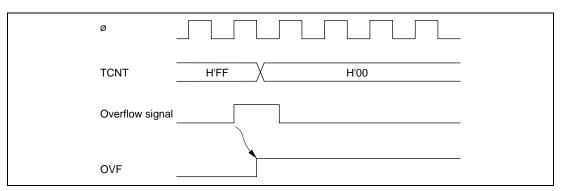


Figure 12.8 Timing of OVF Setting

12.3.5 Operation with Cascaded Connection

If bits CKS2 to CKS0 in either TCR0 or TCR1 are set to B'100, the 8-bit timers of the two channels are cascaded. With this configuration, a single 16-bit timer can be used (16-bit timer mode) or compare-matches of 8-bit channel 0 can be counted by the timer of channel 1 (compare-match count mode). In this case, the timer operates as described below.

16-Bit Count Mode: When bits CKS2 to CKS0 in TCR0 are set to B'100, the timer functions as a single 16-bit timer with channel 0 occupying the upper 8 bits and channel 1 occupying the lower 8 bits.

- Setting of compare-match flags
 - The CMF flag in TCSR0 is set to 1 when a 16-bit compare-match occurs.
 - The CMF flag in TCSR1 is set to 1 when a lower 8-bit compare-match occurs.
- Counter clear specification
 - If the CCLR1 and CCLR0 bits in TCR0 have been set for counter clear at comparematch, the 16-bit counter (TCNT0 and TCNT1 together) is cleared when a 16-bit compare-match occurs. The 16-bit counter (TCNT0 and TCNT1 together) is cleared even if counter clear by the TMRI0 pin has also been set.
 - The settings of the CCLR1 and CCLR0 bits in TCR1 are ignored. The lower 8 bits cannot be cleared independently.
- Pin output
 - Control of output from the TMO0 pin by bits OS3 to OS0 in TCSR0 is in accordance with the 16-bit compare-match conditions.

 Control of output from the TMO1 pin by bits OS3 to OS0 in TCSR1 is in accordance with the lower 8-bit compare-match conditions.

Compare-Match Count Mode: When bits CKS2 to CKS0 in TCR1 are B'100, TCNT1 counts compare-match A's for channel 0.

Channels 0 and 1 are controlled independently. Conditions such as setting of the CMF flag, generation of interrupts, output from the TMO pin, and counter clearing are in accordance with the settings for each channel.

Usage Note: If the 16-bit count mode and compare-match count mode are set simultaneously, the input clock pulses for TCNT0 and TCNT1 are not generated and thus the counters will stop operating. Simultaneous setting of these two modes should therefore be avoided.

12.4 Interrupt Sources

The TMR0, TMR1, and TMRY 8-bit timers can generate three types of interrupt: comparematch A and B (CMIA and CMIB), and overflow (OVI). TMRX can generate only an ICIX interrupt. An interrupt is requested when the corresponding interrupt enable bit is set in TCR or TCSR. Independent signals are sent to the interrupt controller for each interrupt. It is also possible to activate the DTC by means of CMIA and CMIB interrupts from TMR0, TMR1 and TMRY.

An overview of 8-bit timer interrupt sources is given in tables 12.3 to 12.5.

Table 12.3 TMR0 and TMR1 8-Bit Timer Interrupt Sources

Interrupt source	Description	DTC Activation	Interrupt Priority
CMIA	Requested by CMFA	Possible	High
CMIB	Requested by CMFB	Possible	
OVI	Requested by OVF	Not possible	Low

Table 12.4 TMRX 8-Bit Timer Interrupt Source

Interrupt source	Description	DTC Activation
ICIX	Requested by ICF	Not possible

Interrupt source	Description	DTC Activation	Interrupt Priority
CMIA	Requested by CMFA	Possible	High
CMIB	Requested by CMFB	Possible	
OVI	Requested by OVF	Not possible	Low

12.5 8-Bit Timer Application Example

In the example below, the 8-bit timer is used to generate a pulse output with a selected duty cycle, as shown in figure 12.9. The control bits are set as follows:

- In TCR, CCLR1 is cleared to 0 and CCLR0 is set to 1 so that the timer counter is cleared by a TCORA compare-match.
- In TCSR, bits OS3 to OS0 are set to B'0110, causing 1 output at a TCORA compare-match and 0 output at a TCORB compare-match.

With these settings, the 8-bit timer provides output of pulses at a rate determined by TCORA with a pulse width determined by TCORB. No software intervention is required.

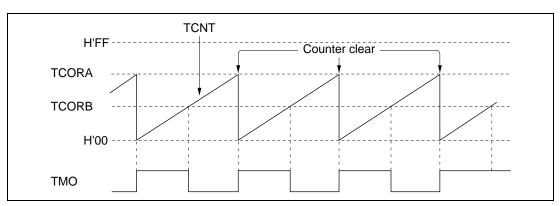


Figure 12.9 Pulse Output (Example)

12.6 Usage Notes

Application programmers should note that the following kinds of contention can occur in the 8bit timer module.

12.6.1 Contention between TCNT Write and Clear

If a timer counter clock pulse is generated during the T2 state of a TCNT write cycle, the clear takes priority, so that the counter is cleared and the write is not performed. Figure 12.10 shows this operation.

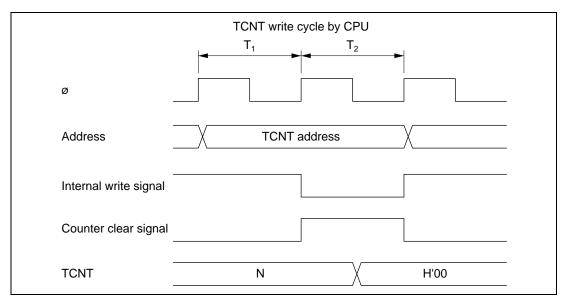


Figure 12.10 Contention between TCNT Write and Clear

12.6.2 Contention between TCNT Write and Increment

If a timer counter clock pulse is generated during the T2 state of a TCNT write cycle, the write takes priority and the counter is not incremented. Figure 12.11 shows this operation.

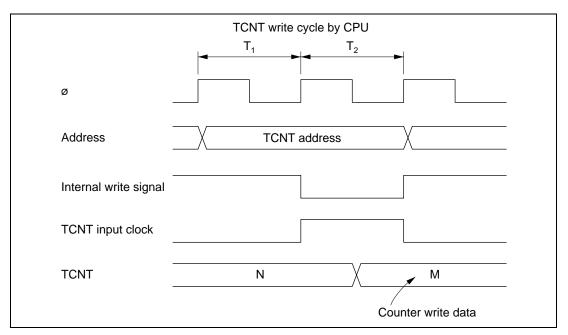


Figure 12.11 Contention between TCNT Write and Increment

12.6.3 Contention between TCOR Write and Compare-Match

During the T2 state of a TCOR write cycle, the TCOR write has priority even if a comparematch occurs and the compare-match signal is disabled. Figure 12.12 shows this operation.

With TMRX, an ICR input capture contends with a compare-match in the same way as with a write to TCORC. In this case, the input capture has priority and the compare-match signal is inhibited.

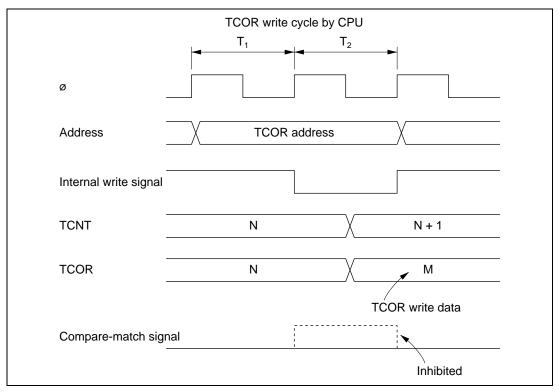


Figure 12.12 Contention between TCOR Write and Compare-Match

12.6.4 Contention between Compare-Matches A and B

If compare-matches A and B occur at the same time, the 8-bit timer operates in accordance with the priorities for the output states set for compare-match A and compare-match B, as shown in table 12.6.

Output Setting	Priority
Toggle output	High
1 output	
0 output	
No change	Low

Table 12.6 Timer Output Priorities

12.6.5 Switching of Internal Clocks and TCNT Operation

TCNT may increment erroneously when the internal clock is switched over. Table 12.7 shows the relationship between the timing at which the internal clock is switched (by writing to the CKS1 and CKS0 bits) and the TCNT operation

When the TCNT clock is generated from an internal clock, the falling edge of the internal clock pulse is detected. If clock switching causes a change from high to low level, as shown in no. 3 in table 12.7, a TCNT clock pulse is generated on the assumption that the switchover is a falling edge. This increments TCNT.

Erroneous incrementation can also happen when switching between internal and external clocks.

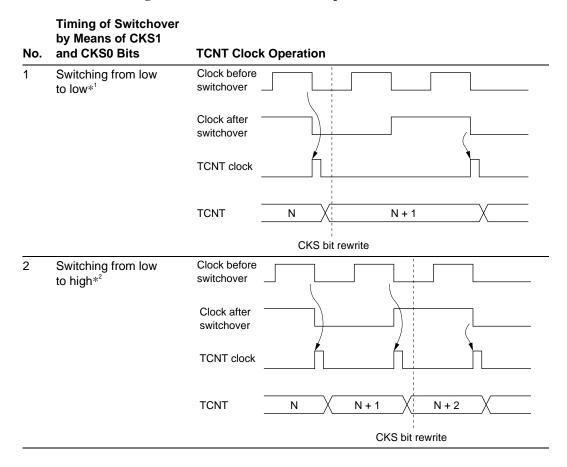


Table 12.7 Switching of Internal Clock and TCNT Operation

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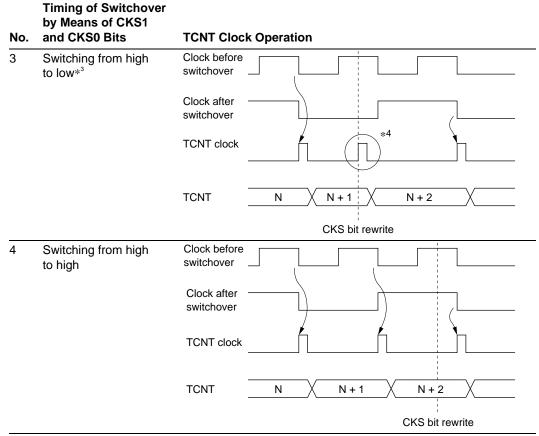


 Table 12.7
 Switching of Internal Clock and TCNT Operation (cont)

Notes: 1. Includes switching from low to stop, and from stop to low.

- 2. Includes switching from stop to high.
- 3. Includes switching from high to stop.
- 4. Generated on the assumption that the switchover is a falling edge; TCNT is incremented.

Section 13 Timer Connection [H8S/2138 Series]

Provided in the H8S/2138 Series; not provided in the H8S/2134 Series.

13.1 Overview

The H8S/2138 Series allows interconnection between a combination of input signals, the input/output of the single free-running timer (FRT) channel and the three 8-bit timer channels (TMR1, TMRX, and TMRY). This capability can be used to implement complex functions such as PWM decoding and clamp waveform output. All the timers are initially set for independent operation.

13.1.1 Features

The features of the timer connection facility are as follows.

- Five input pins and four output pins, all of which can be designated for phase inversion. Positive logic is assumed for all signals used within the timer connection facility.
- An edge-detection circuit is connected to the input pins, simplifying signal input detection.
- TMRX can be used for PWM input signal decoding and clamp waveform generation.
- An external clock signal divided by TMR1 can be used as the FRT capture input signal.
- An internal synchronization signal can be generated using the FRT and TMRY.
- A signal generated/modified using an input signal and timer connection can be selected and output.

13.1.2 Block Diagram

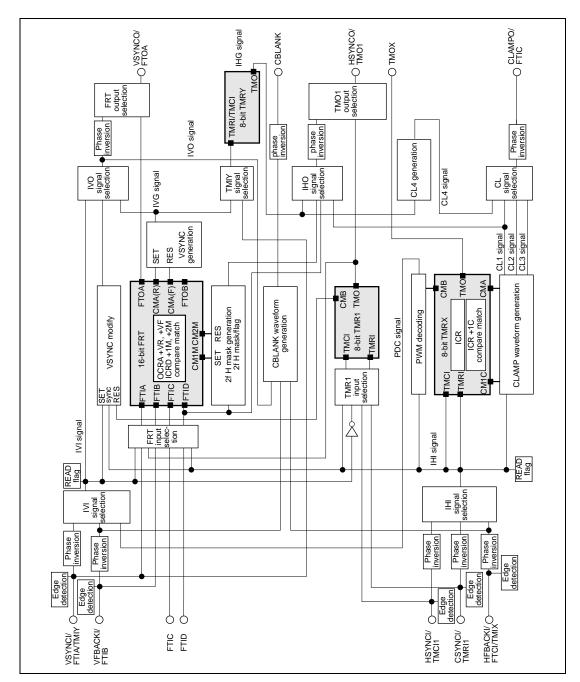
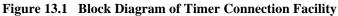


Figure 13.1 shows a block diagram of the timer connection facility.



13.1.3 Input and Output Pins

Table 13.1 lists the timer connection input and output pins.

Table 13.1 Timer Connection Input and Output Pins

Name	Abbreviation	Input/ Output	Function
Vertical synchronization signal input pin	VSYNCI	Input	Vertical synchronization signal input pin or FTIA input pin/TMIY input pin
Horizontal synchronization signal input pin	HSYNCI	Input	Horizontal synchronization signal input pin or TMCI1 input pin
Composite synchronization signal input pin	CSYNCI	Input	Composite synchronization signal input pin or TMRI1 input pin
Spare vertical synchronization signal input pin	VFBACKI	Input	Spare vertical synchronization signal input pin or FTIB input pin
Spare horizontal synchronization signal input pin	HFBACKI	Input	Spare horizontal synchronization signal input pin or FTCI input pin/TMIX input pin
Vertical synchronization signal output pin	VSYNCO	Output	Vertical synchronization signal output pin or FTOA output pin
Horizontal synchronization signal output pin	HSYNCO	Output	Horizontal synchronization signal output pin or TMO1 output pin
Clamp waveform output pin	CLAMPO	Output	Clamp waveform output pin or FTIC input pin
Blanking waveform output pin	CBLANK	Output	Blanking waveform output pin

13.1.4 Register Configuration

Table 13.2 lists the timer connection registers. Timer connection registers can only be accessed when the HIE bit in SYSCR is 0.

Table 13.2 Register Configuration

Name	Abbreviation	R/W	Initial Value	Address*1
Timer connection register I	TCONRI	R/W	H'00	H'FFFC
Timer connection register O	TCONRO	R/W	H'00	H'FFFD
Timer connection register S	TCONRS	R/W	H'00	H'FFFE
Edge sense register	SEDGR	R/(W)* ²	H'00* ³	H'FFFF
Module stop control register	MSTPRH	R/W	H'3F	H'FF86
	MSTPRL	R/W	H'FF	H'FF87

Notes: 1. Lower 16 bits of the address.

2. Bits 7 to 2: Only 0 can be written to clear the flags.

3. Bits 1 and 0: Undefined (reflect the pin states).

13.2 Register Descriptions

13.2.1 Timer Connection Register I (TCONRI)

Bit	7	6	5	4	3	2	1	0
	SIMOD1	SIMOD0	SCONE	ICST	HFINV	VFINV	HIINV	VIINV
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

TCONRI is an 8-bit readable/writable register that controls connection between timers, the signal source for synchronization signal input, phase inversion, etc.

TCONR1 is initialized to H'00 by a reset and in hardware standby mode.

Bit 7	Bit 6	Description				
SIMOD1	SIMOD0	Mode	IHI Signal	IVI Signal		
0	0	No signal (Initial value) HFBACKI input	VFBACKI input		
	1	S-on-G mode	CSYNCI input	PDC input		
1	0	Composite mode	HSYNCI input	PDC input		
	1	Separate mode	HSYNCI input	VSYNCI input		

Bits 7 and 6—Input Synchronization Mode Select 1 and 0 (SIMOD1, SIMOD0): These bits select the signal source of the IHI and IVI signals.

Bit 5—Synchronization Signal Connection Enable (SCONE): Selects the signal source of the FRT FTI input and the TMR1 TMCI1/TMRI1 input.

Bit 5	Description							
SCONE	Mode	FTIA	FTIB	FTIC	FTID	TMCI1	TMRI1	
0	Normal connection (Initial value)	FTIA input	FTIB input	FTIC input	FTID input	TMCI1 input	TMRI1 input	
1	Synchronization signal connection mode	IVI signal	TMO1 signal	VFBACKI input	IHI signal	IHI signal	IVI inverse signal	

Bit 4—Input Capture Start Bit (ICST): The TMRX external reset input (TMRIX) is connected to the IHI signal. TMRX has input capture registers (TICR, TICRR, and TICRF). TICRR and TICRF can measure the width of a short pulse by means of a single capture operation under the control of the ICST bit. When a rising edge followed by a falling edge is detected on TMRIX after the ICST bit is set to 1, the contents of TCNT at those points are captured into TICRR and TICRF, respectively, and the ICST bit is cleared to 0.

Bit 4		
ICST	Description	
0	The TICRR and TICRF input capture functions are stopped	(Initial value)
	[Clearing condition] When a rising edge followed by a falling edge is detected on TMRIX	
1	The TICRR and TICRF input capture functions are operating (Waiting for detection of a rising edge followed by a falling edge on TI	MRIX)
	[Setting condition] When 1 is written in ICST after reading ICST = 0	

Bits 3 to 0—Input Synchronization Signal Inversion (HFINV, VFINV, HIINV, VIINV): These bits select inversion of the input phase of the spare horizontal synchronization signal (HFBACKI), the spare vertical synchronization signal (VFBACKI), the horizontal synchronization signal and composite synchronization signal (HSYNCI, CSYNCI), and the vertical synchronization signal (VSYNCI).

Bit 3

HFINV	Description	
0	The HFBACKI pin state is used directly as the HFBACKI input	(Initial value)
1	The HFBACKI pin state is inverted before use as the HFBACKI input	

Bit 2

VFINV	Description	
0	The VFBACKI pin state is used directly as the VFBACKI input	(Initial value)
1	The VFBACKI pin state is inverted before use as the VFBACKI input	

Bit 1

HIINV	Description	
0	The HSYNCI and CSYNCI pin states are used directly as the HSYNCI and CSYNCI inputs (Ini	tial value)
1	The HSYNCI and CSYNCI pin states are inverted before use as the HSYNC CSYNCI inputs	CI and

Bit 0

VIINV	Description	
0	The VSYNCI pin state is used directly as the VSYNCI input	(Initial value)
1	The VSYNCI pin state is inverted before use as the VSYNCI input	

13.2.2 Timer Connection Register O (TCONRO)

Bit	7	6	5	4	3	2	1	0
	HOE	VOE	CLOE	CBOE	HOINV	VOINV	CLOINV	CBOINV
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

TCONRO is an 8-bit readable/writable register that controls output signal output, phase inversion, etc.

TCONRO is initialized to H'00 by a reset and in hardware standby mode.

Bits 7 and 4—Output Enable (HOE, VOE, CLOE, CBOE): These bits control enabling/disabling of horizontal synchronization signal (HSYNCO), vertical synchronization signal (VSYNCO), clamp waveform (CLAMPO), and blanking waveform (CBLANK) output. When output is disabled, the state of the relevant pin is determined by the port DR and DDR, FRT, TMR, and PWM settings.

Output enabling/disabling control does not affect the port, FRT, or TMR input functions, but some FRT and TMR input signal sources are determined by the SCONE bit in TCONRI.

Bit 7		
HOE	Description	
0	The P44/TMO1/HIRQ1/HSYNCO pin functions as the P44/TMO1/ HIRQ1 pin	(Initial value)
1	The P44/TMO1/HIRQ1/HSYNCO pin functions as the HSYNCO pin	

Bit 6

VOE	Description	
0	The P61/FTOA/KIN1/CIN1/VSYNCO pin functions as the P61/FTOA/ KIN1/CIN1 pin	(Initial value)
1	The P61/FTOA/KIN1/CIN1/VSYNCO pin functions as the VSYNCO pin	

Bit 5

CLOE	Description	
0	The P64/FTIC/KIN4/CIN4/CLAMPO pin functions as the P64/FTIC/KIN4/CIN4 pin	(Initial value)
1	The P64/FTIC/KIN4/CIN4/CLAMPO pin functions as the CLAMPO pin	

Bit 4		
CBOE	Description	
0	The P27/A15/PW15/CBLANK pin functions as the P27/A15/PW15 pin	(Initial value)
1	In mode 1 (expanded mode with on-chip ROM disabled): The P27/A15/PW15/CBLANK pin functions as the A15 pin	
	In modes 2 and 3 (modes with on-chip ROM enabled): The P27/A15/PW15/CBLANK pin functions as the CBLANK pin	

Bits 3 to 0—Output Synchronization Signal Inversion (HOINV, VOINV, CLOINV, CBOINV): These bits select inversion of the output phase of the horizontal synchronization signal (HSYNCO), the vertical synchronization signal (VSYNCO), the clamp waveform (CLAMPO), and the blank waveform (CBLANK).

Bit 3

HOINV	Description	
0	The IHO signal is used directly as the HSYNCO output	(Initial value)
1	The IHO signal is inverted before use as the HSYNCO output	

Bit 2

VOINV	Description	
0	The IVO signal is used directly as the VSYNCO output	(Initial value)
1	The IVO signal is inverted before use as the VSYNCO output	

Bit 1

CLOINV	Description	
0	The CLO signal (CL1, CL2, CL3, or CL4 signal) is used directly as the CLAMPO output	(Initial value)
1	The CLO signal (CL1, CL2, CL3, or CL4 signal) is inverted before use as the CLAMPO output	

Bit 0

CBOINV	Description	
0	The CBLANK signal is used directly as the CBLANK output	(Initial value)
1	The CBLANK signal is inverted before use as the CBLANK output	

13.2.3 Timer Connection Register S (TCONRS)

Bit	7	6	5	4	3	2	1	0
	TMRX/Y	ISGENE	HOMOD1	номоро	VOMOD1	VOMOD0	CLMOD1	CLMOD0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W							

TCONRS is an 8-bit readable/writable register that selects 8-bit timer TMRX/TMRY access and the synchronization signal output signal source and generation method.

TCONRS is initialized to H'00 by a reset and in hardware standby mode.

Bit 7—TMRX/TMRY Access Select (TMRX/Y): The TMRX and TMRY registers can only be accessed when the HIE bit in SYSCR is cleared to 0. In the H8S/2138 Series, some of the TMRX registers and the TMRY registers are assigned to the same memory space addresses (H'FFF0 to H'FFF5), and the TMRX/Y bit determines which registers are accessed. In the H8S/2134 Series, there is no control of TMRY register access by this bit.

Bit 7

TMRX/Y	Description	
0	The TMRX registers are accessed at addresses H'FFF0 to H'FFF5	(Initial value)
1	The TMRY registers are accessed at addresses H'FFF0 to H'FFF5	

Bit 6—Internal Synchronization Signal Select (ISGENE): Selects internal synchronization signals (IHG, IVG, and CL4 signals) as the signal sources for the IHO, IVO, and CLO signals.

Bits 5 and 4—Horizontal Synchronization Output Mode Select 1 and 0 (HOMOD1,
HOMOD0): These bits select the signal source and generation method for the IHO signal.

Bit 6	Bit 5	Bit 4	
ISGENE	VOMOD1	VOMOD0	Description
0	0	0	The IHI signal (without 2fH modification) (Initial value) is selected
		1	The IHI signal (with 2fH modification) is selected
	1	0	The CL1 signal is selected
		1	_
1	0	0	The IHG signal is selected
		1	_
	1	0	_
		1	_

Bits 3 and 2—Vertical Synchronization Output Mode Select 1 and 0 (VOMOD1,

VOMOD0): These bits select the signal source and generation method for the IVO signal.

Bit 6	Bit 3	Bit 2	
ISGENE	VOMOD1	VOMOD0	Description
0	0	0	The IVI signal (without fall modification or IHI synchronization) is selected(Initial value)
		1	The IVI signal (without fall modification, with IHI synchronization) is selected
	1	0	The IVI signal (with fall modification, without IHI synchronization) is selected
		1	The IVI signal (with fall modification and IHI synchronization) is selected
1	0	0	The IVG signal is selected
		1	_
	1	0	—
		1	_

Bits 1 and 0—Clamp Waveform Mode Select 1 and 0 (CLMOD1, CLMOD0): These bits
select the signal source for the CLO signal (clamp waveform).

Bit 6	Bit 1	Bit 0		
ISGENE	CLMOD1	CLMOD2	Description	
0	0	0	The CL1 signal is selected	(Initial value)
		1	The CL2 signal is selected	
	1	0	The CL3 signal is selected	
		1		
1	0	0	The CL4 signal is selected	
		1		
	1	0		
		1		

13.2.4 Edge Sense Register (SEDGR)

Bit	7	6	5	4	3	2	1	0
	VEDG	HEDG	CEDG	HFEDG	VFEDG	PREQF	IHI	IVI
Initial value	0	0	0	0	0	0	*2	*2
Read/Write	R/(W) ^{*1}	R/(W) ^{*1}	R/(W) ^{*1}	$R/(W)^{*1}$	R/(W) ^{*1}	R/(W) ^{*1}	R	R

Notes: 1. Only 0 can be written, to clear the flags.

2. The initial value is undefined since it depends on the pin states.

SEDGR is an 8-bit readable/writable register used to detect a rising edge on the timer connection input pins and the occurrence of 2fH modification, and to determine the phase of the IVI and IHI signals.

The upper 6 bits of SEDGR are initialized to 0 by a reset and in hardware standby mode. The initial value of the lower 2 bits is undefined, since it depends on the pin states.

Bit 7—VSYNCI Edge (VEDG): Detects a rising edge on the VSYNCI pin.

Bit 7		
VEDG	Description	
0	[Clearing condition] When 0 is written in VEDG after reading VEDG = 1	(Initial value)
1	[Setting condition] When a rising edge is detected on the VSYNCI pin	

Bit 6—HSYNCI Edge (HEDG): Detects a rising edge on the HSYNCI pin.

Bit 6		
HEDG	Description	
0	[Clearing condition] When 0 is written in HEDG after reading HEDG = 1	(Initial value)
1	[Setting condition] When a rising edge is detected on the HSYNCI pin	

Bit 5—CSYNCI Edge (CEDG): Detects a rising edge on the CSYNCI pin.

Bit 5				
CEDG	Description			
0	[Clearing condition] When 0 is written in CEDG after reading CEDG = 1	(Initial value)		
1	[Setting condition] When a rising edge is detected on the CSYNCI pin			

Bit 4—HFBACKI Edge (HFEDG): Detects a rising edge on the HFBACKI pin.

Bit 4

HFEDG	Description	
0	[Clearing condition] When 0 is written in HFEDG after reading HFEDG = 1	(Initial value)
1	[Setting condition] When a rising edge is detected on the HFBACKI pin	

Bit 3—VFBACKI Edge (VFEDG): Detects a rising edge on the VFBACKI pin.

Bit 3

VFEDG	Description	
0	[Clearing condition] When 0 is written in VFEDG after reading VFEDG = 1	(Initial value)
1	[Setting condition] When a rising edge is detected on the VFBACKI pin	

Bit 2—Pre-Equalization Flag (PREQF): Detects the occurrence of an IHI signal 2fH modification condition. The generation of a falling/rising edge in the IHI signal during a mask interval is expressed as the occurrence of a 2fH modification condition. For details, see section 13.3.4, IHI Signal 2fH Modification.

Bit 2

PREQF	Description	
0	[Clearing condition] When 0 is written in PREQF after reading PREQF = 1	(Initial value)
1	[Setting condition] When an IHI signal 2fH modification condition is detected	

Bit 1—IHI Signal Level (IHI): Indicates the current level of the IHI signal. Signal source and phase inversion selection for the IHI signal depends on the contents of TCONRI. Read this bit to determine whether the input signal is positive or negative, then maintain the IHI signal at positive phase by modifying TCONRI.

Bit 1

IHI	Description
0	The IHI signal is low
1	The IHI signal is high

Bit 0—IVI Signal Level (IVI): Indicates the current level of the IVI signal. Signal source and phase inversion selection for the IVI signal depends on the contents of TCONRI. Read this bit to determine whether the input signal is positive or negative, then maintain the IVI signal at positive phase by modifying TCONRI.

Bit 0

IVI	Description
0	The IVI signal is low
1	The IVI signal is high

13.2.5 Module Stop Control Register (MSTPCR)

		MSTPCRH				MSTPCRL										
Bit	7	6	5	4	3	2	1	0	7	6	5	4	3	2	1	0
	MSTP15	MSTP14	MSTP13	MSTP12	MSTP11	MSTP10	MSTP9	MSTP8	MSTP7	MSTP6	MSTP5	MSTP4	MSTP3	MSTP2	MSTP1	MSTP0
Initial value	0	0	1	1	1	1	1	1	1	1	1	1	1	1	1	1
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

MSTPCR, comprising two 8-bit readable/writable registers, performs module stop mode control. When the MSTP13, MSTP12, and MSTP8 bits are set to 1, the 16-bit free-running timer, 8-bit timer channels 0 and 1, and 8-bit timer channels X and Y and timer connection, respectively, halt and enter module stop mode. See section 23.5., Module Stop Mode, for details.

MSTPCR is initialized to H'3FFF by a reset and in hardware standby mode. It is not initialized in software standby mode.

MSTPCRH Bit 5-Module Stop (MSTP13): Specifies FRT module stop mode.

MSTPCRH Bit 5	I	
MSTP13	Description	
0	FRT module stop mode is cleared	
1	FRT module stop mode is set	(Initial value)

MSTPCRH Bit 4—Module Stop (MSTP12): Specifies 8-bit timer channel 0 and 1 module stop mode.

MSTPCRH Bit 4	1	
MSTP12	Description	
0	8-bit timer channel 0 and 1 module stop mode is cleared	
1	8-bit timer channel 0 and 1 module stop mode is set	(Initial value)

MSTPCRH Bit 0—Module Stop (MSTP8): Specifies 8-bit timer channel X and Y and timer connection module stop mode.

MSTPCRH Bit 0	
MSTP8	Description
0	8-bit timer channel X and Y and timer connection module stop mode is cleared
1	8-bit timer channel X and Y and timer connection module stop mode is (Initial value) set

13.3 Operation

13.3.1 PWM Decoding (PDC Signal Generation)

The timer connection facility and TMRX can be used to decode a PWM signal in which 0 and 1 are represented by the pulse width. To do this, a signal in which a rising edge is generated at regular intervals must be selected as the IHI signal.

The timer counter (TCNT) in TMRX is set to count the internal clock pulses and to be cleared on the rising edge of the external reset signal (IHI signal). The value to be used as the threshold for deciding the pulse width is written in TCORB. The PWM decoder contains a delay latch which uses the IHI signal as data and compare-match signal B (CMB) as a clock, and the state of the IHI signal (the result of the pulse width decision) at the compare-match signal B timing after TCNT is reset by the rise of the IHI signal is output as the PDC signal. The pulse width setting using TICRR and TICRF of TMRX can be used to determine the pulse width decision threshold. Examples of TCR and TCORB settings are shown in tables 13.3 and 13.4, and the timing chart is shown in figure 13.2.

Bit(s)	Abbreviation	Contents	Description
7	CMIEB	0	Interrupts due to compare-match and overflow
6	CMIEA	0	— are disabled
5	OVIE	0	
4 and 3	CCLR1, CCLR0	11	TCNT is cleared by the rising edge of the external reset signal (IHI signal)
2 to 0	CKS2 to CKS0	001	Incremented on internal clock: ø

Table 13.3 Examples of TCR Settings

	ø:10 MHz	ø: 12 MHz	ø: 16 MHz	ø: 20 MHz
H'07	0.8 µs	0.67 µs	0.5 µs	0.4 µs
H'0F	1.6 µs	1.33 µs	1 µs	0.8 µs
H'1F	3.2 µs	2.67 µs	2 µs	1.6 µs
H'3F	6.4 µs	5.33 µs	4 µs	3.2 µs
H'7F	12.8 µs	10.67 µs	8 µs	6.4 µs

 Table 13.4
 Examples of TCORB (Pulse Width Threshold) Settings

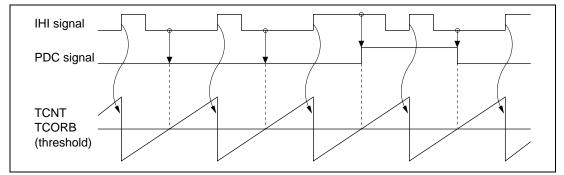


Figure 13.2 Timing Chart for PWM Decoding

13.3.2 Clamp Waveform Generation (CL1/CL2/CL3 Signal Generation)

The timer connection facility and TMRX can be used to generate signals with different duty cycles and rising/falling edges (clamp waveforms) in synchronization with the input signal (IHI signal). Three clamp waveforms can be generated: the CL1, CL2, and CL3 signals. In addition, the CL4 signal can be generated using TMRY.

The CL1 signal rises simultaneously with the rise of the IHI signal, and when the CL1 signal is high, the CL2 signal rises simultaneously with the fall of the IHI signal. The fall of both the CL1 and the CL2 signal can be specified by TCORA.

The rise of the CL3 signal can be specified as simultaneous with the sampling of the fall of the IHI signal using the system clock, and the fall of the CL3 signal can be specified by TCORC.

The CL3 signal can also fall when the IHI signal rises.

TCNT in TMRX is set to count internal clock pulses and to be cleared on the rising edge of the external reset signal (IHI signal).

The value to be used as the CL1 signal pulse width is written in TCORA. Write a value of H'02 or more in TCORA when internal clock ϕ is selected as the TMRX counter clock, and a value or H'01 or more when $\phi/2$ is selected. When internal clock ϕ is selected, the CL1 signal pulse width is (TCORA set value + 3 ± 0.5). When the CL2 signal is used, the setting must be made so that this pulse width is greater than the IHI signal pulse width.

The value to be used as the CL3 signal pulse width is written in TCORC. The TICR register in TMRX captures the value of TCNT at the inverse of the external reset signal edge (in this case, the falling edge of the IHI signal). The timing of the fall of the CL3 signal is determined by the sum of the contents of TICR and TCORC. Caution is required if the rising edge of the IHI signal precedes the fall timing set by the contents of TCORC, since the IHI signal will cause the CL3 signal to fall.

Examples of TMRX TCR settings are the same as those in table 13.3. The clamp waveform timing charts are shown in figures 13.3 and 13.4.

Since the rise of the CL1 and CL2 signals is synchronized with the edge of the IHI signal, and their fall is synchronized with the system clock, the pulse width variation is equivalent to the resolution of the system clock.

Both the rise and the fall of the CL3 signal are synchronized with the system clock and the pulse width is fixed, but there is a variation in the phase relationship with the IHI signal equivalent to the resolution of the system clock.

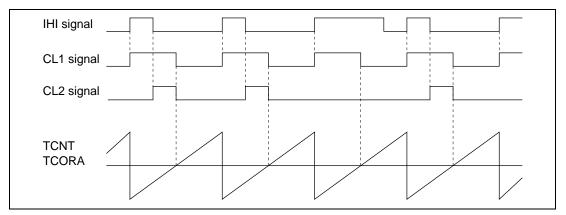


Figure 13.3 Timing Chart for Clamp Waveform Generation (CL1 and CL2 Signals)

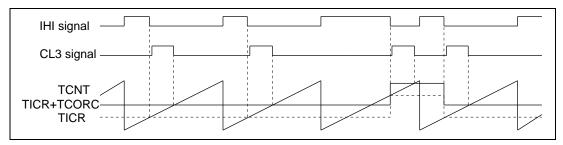


Figure 13.4 Timing Chart for Clamp Waveform Generation (CL3 Signal)

13.3.3 Measurement of 8-Bit Timer Divided Waveform Period

The timer connection facility, TMR1, and the free-running timer (FRT) can be used to measure the period of an IHI signal divided waveform. Since TMR1 can be cleared by a rising edge of the IVI signal, the rise and fall of the IHI signal divided waveform can be virtually synchronized with the IVI signal. This enables period measurement to be carried out efficiently.

To measure the period of an IHI signal divided waveform, TCNT in TMR1 is set to count the external clock (IHI signal) pulses and to be cleared on the rising edge of the external reset signal (IVI signal). The value to be used as the division factor is written in TCORA, and the TMO output method is specified by the OS bits in TCSR. Examples of TCR and TCSR settings are shown in table 13.5, and the timing chart for measurement of the IVI signal and IHI signal divided waveform periods is shown in figure 13.5. The period of the IHI signal divided waveform is given by (ICRD(3) – ICRD(2)) × the resolution.

Register	Bit(s)	Abbreviation	Contents	Description
TCR in TMR1	7	CMIEB	0	Interrupts due to compare-match and overflow are disabled
	6	CMIEA	0	-
	5	OVIE	0	-
	4 and 3	CCLR1, CCLR0	11	TCNT is cleared by the rising edge of the external reset signal (IVI signal)
	2 to 0	CKS2 to CKS0	101	TCNT is incremented on the rising edge of the external clock (IHI signal)
TCSR in TMR1	3 to 0	OS3 to OS0	0011	Not changed by compare-match B; output inverted by compare-match A (toggle output): division by 512
			1001	or when TCORB < TCORA, 1 output on compare-match B, and 0 output on compare-match A: division by 256
TCR in FRT	6	IEDGB	0/1	0: FRC value is transferred to ICRB on falling edge of input capture input B (IHI divided signal waveform)
				1: FRC value is transferred to ICRB on rising edge of input capture input B (IHI divided signal waveform)
	1 and 0	CKS1, CKS0	01	FRC is incremented on internal clock: Ø/8
TCSR in FRT	0	CCLRA	0	FRC clearing is disabled

Table 13.5 Examples of TCR and TCSR Settings

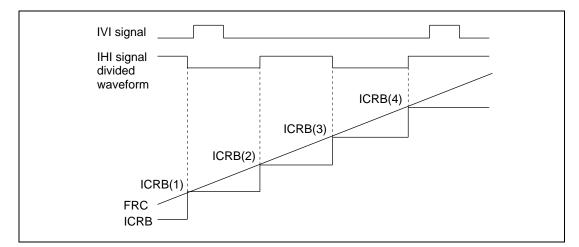


Figure 13.5 Timing Chart for Measurement of IVI Signal and IHI Signal Divided Waveform Periods

13.3.4 IHI Signal and 2fH Modification

By using the timer connection FRT, even if there is a part of the IHI signal with twice the frequency, this can be eliminated. In order for this function to operate properly, the duty cycle of the IHI signal must be approximately 30% or less, or approximately 70% or above.

The 8-bit OCRDM contents or twice the OCRDM contents can be added automatically to the data captured in ICRD in the FRT, and compare-matches generated at these points. The interval between the two compare-matches is called a mask interval. A value equivalent to approximately 1/3 the IHI signal period is written in OCRDM. ICRD is set so that capture is performed on the rise of the IHI signal.

Since the IHI signal supplied to the IHO signal selection circuit is normally set on the rise of the IHI signal and reset on the fall, its waveform is the same as that of the original IHI signal. When 2fH modification is selected, IHI signal edge detection is disabled during mask intervals. Capture is also disabled during these intervals.

Examples of FRT TCR settings are shown in table 13.6, and the 2fH modification timing chart is shown in figure 13.6.

Register	Bit(s)	Abbreviation	Contents	Description
TCR in FRT	4	IEDGD	1	FRC value is transferred to ICRD on the rising edge of input capture input D (IHI signal)
	1 and 0	CKS1, CKS0	01	FRC is incremented on internal clock: ø/8
TCSR in FRT	0	CCLRA	0	FRC clearing is disabled
TCOR in FRT	7	ICRDMS	1	ICRD is set to the operating mode in which OCRDM is used
OCRDM in FRT	7 to 0	OCRDM7 to 0	H'01 to H'FF	Specifies the period during which ICRD operation is masked



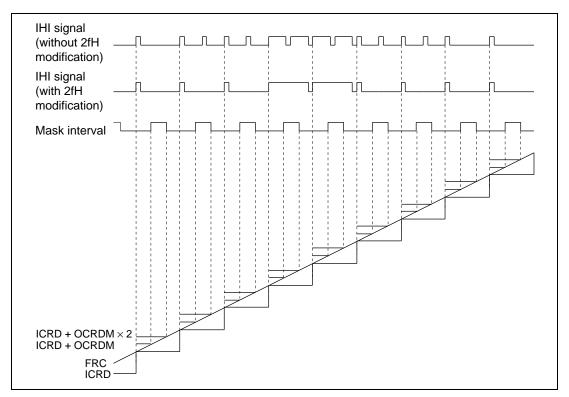


Figure 13.6 2fH Modification Timing Chart

13.3.5 IVI Signal Fall Modification and IHI Synchronization

By using the timer connection TMR1, the fall of the IVI signal can be shifted backward by the specified number of IHI signal waveforms. Also, the fall of the IVI signal can be synchronized with the rise of the IHI signal.

To perform 8-bit timer divided waveform period measurement, TCNT in TMR1 is set to count external clock (IHI signal) pulses, and to be cleared on the rising edge of the external reset signal (inverse of the IVI signal). The number of IHI signal pulses until the fall of the IVI signal is written in TCORB.

Since the IVI signal supplied to the IVO signal selection circuit is normally set on the rise of the IVI signal and reset on the fall, its waveform is the same as that of the original IVI signal. When fall modification is selected, a reset is performed on a TMR1 TCORB compare-match.

The fall of the waveform generated in this way can be synchronized with the rise of the IHI signal, regardless of whether or not fall modification is selected.

Examples of TMR1 TCORB, TCR, and TCSR settings are shown in table 13.7, and the fall modification/IHI synchronization timing chart is shown in figure 13.7.

Register	Bit(s)	Abbreviation	Contents	Description
TCR in TMR1	7	CMIEB	0	Interrupts due to compare-match and overflow are disabled
	6	CMIEA	0	_
	5	OVIE	0	_
	4 and 3	CCLR1, CCLR0	11	TCNT is cleared by the rising edge of the external reset signal (inverse of the IVI signal)
	2 to 0	CKS2 to CKS0	101	TCNT is incremented on the rising edge of the external clock (IHI signal)
TCSR in TMR1	3 to 0	OS3 to OS0	0011	Not changed by compare-match B; output inverted by compare-match A (toggle output)
			1001	or when TCORB \leq TCORA, 1 output on compare-match B, 0 output on compare-match A
TOCRB in TM	IR1		H'03 (example)	Compare-match on the 4th (example) rise of the IHI signal after the rise of the inverse of the IVI signal

Table 13.7 Examples of TCORB, TCR, and TCSR Settings

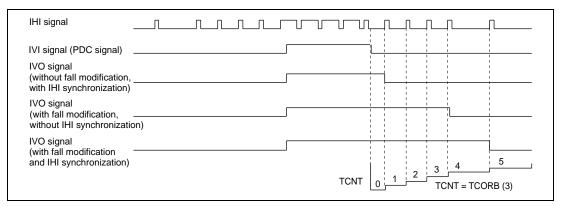


Figure 13.7 Fall Modification/IHI Synchronization Timing Chart

13.3.6 Internal Synchronization Signal Generation (IHG/IVG/CL4 Signal Generation)

By using the timer connection FRT and TMRY, it is possible to automatically generate internal signals (IHG and IVG signals) corresponding to the IHI and IVI signals. As the IHG signal is synchronized with the rise of the IVG signal, the IHG signal period must be made a divisor of the IVG signal period in order to keep it constant. In addition, the CL4 signal can be generated in synchronization with the IHG signal.

The contents of OCRA in the FRT are updated by the automatic addition of the contents of OCRAR or OCRAF, alternately, each time a compare-match occurs. A value corresponding to the 0 interval of the IVG signal is written in OCRAR, and a value corresponding to the 1 interval of the IVG signal is written in OCRAF. The IVG signal is set by a compare-match after an OCRAR addition, and reset by a compare-match after an OCRAF addition.

The IHG signal is the TMRY 8-bit timer output. TMRY is set to count internal clock pulses, and to be cleared on TCORA compare-match, to fix the period and set the timer output. TCORB is set so as to reset the timer output. The IVG signal is connected as the TMRY reset input (TMRI), and the rise of the IVG signal can be treated in the same way as a TCORA compare-match.

The CL4 signal is a waveform that rises within one system clock period after the fall of the IHG signal, and has a 1 interval of 6 system clock periods.

Examples of settings of TCORA, TCORB, TCR, and TCSR in TMRY, and OCRAR, OCRAF, and TCR in the FRT, are shown in table 13.8, and the IHG signal/IVG signal timing chart is shown in figure 13.8.

Register	Bit(s)	Abbreviation	Contents	Description	
TCR in TMRY	7	CMIEB	0	Interrupts due to compare-match and overflow are disabled	
	6	CMIEA	0	_	
	5	OVIE	0	_	
	4 and 3	CCLR1, CCLR0	01	TCNT is cleared by	compare-match A
	2 to 0	CKS2 to CKS0	001	TCNT is incremented on internal clock: ø/4	
TCSR in TMRY	3 to 0	OS3 to OS0	0110	0 output on compare-match B 1 output on compare-match A	
TOCRA in TMRY			H'3F (example)	IHG signal period = $\emptyset \times 256$	
TOCRB in TMRY			H'03 (example)	IHG signal 1 interva	$l = \emptyset \times 16$
TCR in FRT	1 and 0	CKS1, CKS0	01	FRC is incremented on internal clock: Ø/	
OCRAR in FRT			H'7FEF (example)	IVG signal 0 interval = ø × 262016	IVG signal period = $\phi \times 262144$ (1024 times IHG signal)
OCRAF in FRT			H'000F (example)	IVG signal 1 interval = $\emptyset \times 128$	_
TOCR in FRT	6	OCRAMS	1	OCRA is set to the which OCRAR and	

Table 13.8 Examples of OCRAR, OCRAF, TOCR, TCORA, TCORB, TCR, and TCSR Settings

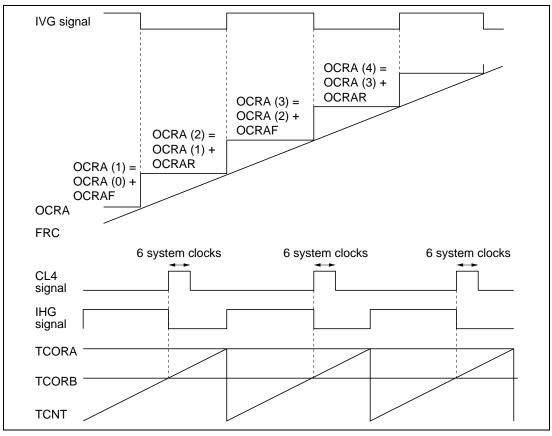


Figure 13.8 IVG Signal/IHG Signal/CL4 Signal Timing Chart

13.3.7 HSYNCO Output

With the HSYNCO output, the meaning of the signal source to be selected and use or non-use of modification varies according to the IHI signal source and the waveform required by external circuitry. The meaning of the HSYNCO output in each mode is shown in table 13.9.

Table 13.9 Meani	ng of HSYNCO	Output in Each Mode
------------------	--------------	---------------------

Mode	IHI Signal	IHO Signal	Meaning of IHO Signal
No signal	HFBACKI input	IHI signal (without 2fH modification)	HFBACKI input is output directly
		IHI signal (with 2fH modification)	Meaningless unless there is a double-frequency part in the HFBACKI input
		CL1 signal	HFBACKI input 1 interval is changed before output
		IHG signal	Internal synchronization signal is output
S-on-G mode	CSYNCI input	IHI signal (without 2fH modification)	CSYNCI input (composite synchronization signal) is output directly
		IHI signal (with 2fH modification)	Double-frequency part of CSYNCI input (composite synchronization signal) is eliminated before output
		CL1 signal	CSYNCI input (composite synchronization signal) horizontal synchronization signal part is separated before output
		IHG signal	Internal synchronization signal is output
Composite mode	HSYNCI input	IHI signal (without 2fH modification)	HSYNCI input (composite synchronization signal) is output directly
		IHI signal (with 2fH modification)	Double-frequency part of HSYNCI input (composite synchronization signal) is eliminated before output
		CL1 signal	HSYNCI input (composite synchronization signal) horizontal synchronization signal part is separated before output
		IHG signal	Internal synchronization signal is output
Separate mode	HSYNCI input	IHI signal (without 2fH modification)	HSYNCI input (horizontal synchronization signal) is output directly
		IHI signal (with 2fH modification)	Meaningless unless there is a double-frequency part in the HSYNCI input (horizontal synchronization signal)
		CL1 signal	HSYNCI input (horizontal synchronization signal) 1 interval is changed before output
		IHG signal	Internal synchronization signal is output

13.3.8 VSYNCO Output

With the VSYNCO output, the meaning of the signal source to be selected and use or non-use of modification varies according to the IVI signal source and the waveform required by external circuitry. The meaning of the VSYNCO output in each mode is shown in table 13.10.

Mode	IVI Signal	IVO Signal	Meaning of IVO Signal
No signal	VFBACKI input	IVI signal (without fall modification or IHI synchronization)	VFBACKI input is output directly
		IVI signal (without fall modification, with IHI synchronization)	Meaningless unless VFBACKI input is synchronized with HFBACKI input
		IVI signal (with fall modification, without IHI synchronization)	VFBACKI input fall is modified before output
		IVI signal (with fall modification and IHI synchronization)	VFBACKI input fall is modified and signal is synchronized with HFBACKI input before output
		IVG signal	Internal synchronization signal is output
S-on-G mode or composite mode	PDC signal	IVI signal (without fall modification or IHI synchronization)	CSYNCI/HSYNCI input (composite synchronization signal) vertical synchronization signal part is separated before output
		IVI signal (without fall modification, with IHI synchronization)	CSYNCI/HSYNCI input (composite synchronization signal) vertical synchronization signal part is separated, and signal is synchronized with CSYNCI/HSYNCI input before output
		IVI signal (with fall modification, without IHI synchronization)	CSYNCI/HSYNCI input (composite synchronization signal) vertical synchronization signal part is separated, and fall is modified before output
		IVI signal (with fall modification and IHI synchronization)	CSYNCI/HSYNCI input (composite synchronization signal) vertical synchronization signal part is separated, fall is modified, and signal is synchronized with CSYNCI/HSYNCI input before output
		IVG signal	Internal synchronization signal is output

Mode	IVI Signal	IVO Signal	Meaning of IVO Signal
Separate mode	VSYNCI input	IVI signal (without fall modification or IHI synchronization)	VSYNCI input (vertical synchronization signal) is output directly
		IVI signal (without fall modification, with IHI synchronization)	Meaningless unless VSYNCI input (vertical synchronization signal) is synchronized with HSYNCI input (horizontal synchronization signal)
		IVI signal (with fall modification, without IHI synchronization)	VSYNCI input (vertical synchronization signal) fall is modified before output
		IVI signal (with fall modification and IHI synchronization)	VSYNCI input (vertical synchronization signal) fall is modified and signal is synchronized with HSYNCI input (horizontal synchronization signal) before output
		IVG signal	Internal synchronization signal is output

Table 13.10 Meaning of VSYNCO Output in Each Mode (cont)

13.3.9 CBLANK Output

Using the signals generated/selected with timer connection, it is possible to generate a waveform based on the composite synchronization signal (blanking waveform).

One kind of blanking waveform is generated by combining HFBACKI and VFBACKI inputs, with the phase polarity made positive by means of bits HFINV and VFINV in TCONRI, with the IVO signal.

The composition logic is shown in figure 13.9.

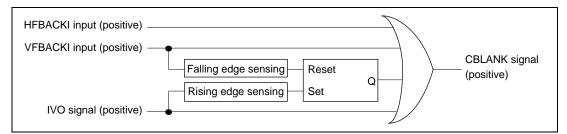


Figure 13.9 CBLANK Output Waveform Generation

Section 14 Watchdog Timer (WDT)

14.1 Overview

The H8S/2138 Series and H8S/2134 Series have an on-chip watchdog timer with two channels (WDT0, WDT1) for monitoring system operation. The WDT outputs an overflow signal if a system crash prevents the CPU from writing to the timer counter, allowing it to overflow. At the same time, the WDT can also generate an internal reset signal or internal NMI interrupt signal.

When this watchdog function is not needed, the WDT can be used as an interval timer. In interval timer mode, an interval timer interrupt is generated each time the counter overflows.

14.1.1 Features

WDT features are listed below.

- Switchable between watchdog timer mode and interval timer mode
 WOVI interrupt generation in interval timer mode
- Internal reset or internal interrupt generated when the timer counter overflows
 Choice of internal reset or NMI interrupt generation in watchdog timer mode
- Choice of 8 (WDT0) or 16 (WDT1) counter input clocks
 - Maximum WDT interval: system clock period × 131072 × 256
 - Subclock can be selected for the WDT1 input counter
 - Maximum interval when the subclock is selected: subclock period $\times 256 \times 256$

14.1.2 Block Diagram

Figures 14.1 (a) and (b) show block diagrams of WDT0 and WDT1.

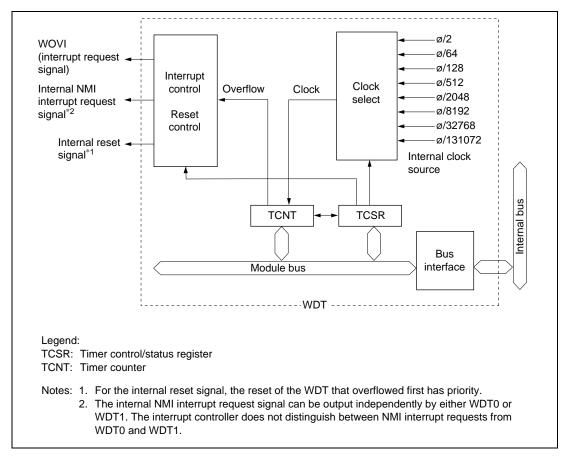


Figure 14.1 (a) Block Diagram of WDT0

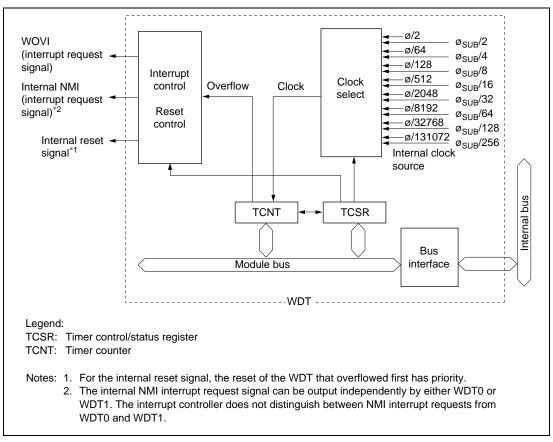


Figure 14.1 (b) Block Diagram of WDT1

14.1.3 Pin Configuration

Table 14.1 describes the WDT input pin.

Table 14.1 WDT Pin

Name	Symbol	I/O	Function
External subclock input pin	EXCL	Input	WDT1 prescaler counter input clock

14.1.4 Register Configuration

The WDT has four registers, as summarized in table 14.2. These registers control clock selection, WDT mode switching, the reset signal, etc.

Table 14.2 WDT Registers

					Add	lress*1
Channel	Name	Abbreviation	R/W	Initial Value	Write* ²	Read
0	Timer control/status register 0	TCSR0	R/(W)* ³	H'00	H'FFA8	H'FFA8
	Timer counter 0	TCNT0	R/W	H'00	H'FFA8	H'FFA9
1	Timer control/status register 1	TCSR1	R/(W)* ³	H'00	H'FFEA	H'FFEA
	Timer counter 1	TCNT1	R/W	H'00	H'FFEA	H'FFEB
Common	System control register	SYSCR	R/W	H'09	H'FFC4	H'FFC4

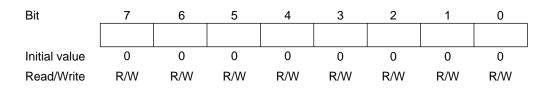
Notes: 1. Lower 16 bits of the address.

2. For details of write operations, see section 14.2.4, Notes on Register Access.

3. Only 0 can be written in bit 7, to clear the flag.

14.2 Register Descriptions

14.2.1 Timer Counter (TCNT)



TCNT is an 8-bit readable/writable* up-counter.

When the TME bit is set to 1 in TCSR, TCNT starts counting pulses generated from the internal clock source selected by bits CKS2 to CKS0 in TCSR. When the TCNT value overflows (changes from H'FF to H'00), the OVF flag in TCSR is set to 1, and an internal reset, NMI interrupt, interval timer interrupt (WOVI), etc., can be generated, according to the mode selected by the WT/ $\overline{\text{IT}}$ bit and RST/ $\overline{\text{NMI}}$ bit.

TCNT is initialized to H'00 by a reset, in hardware standby mode, or when the TME bit is cleared to 0. It is not initialized in software standby mode.

Note: * TCNT is write-protected by a password to prevent accidental overwriting. For details see section 14.2.4, Notes on Register Access.

14.2.2 Timer Control/Status Register (TCSR)

• TCSR0

Bit	7	6	5	4	3	2	1	0
	OVF	WT/IT	TME	RSTS	RST/NMI	CKS2	CKS1	CKS0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/(W)*	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Note: * Only 0 can be written, to clear the flag.

• TCSR1

Bit	7	6	5	4	3	2	1	0
	OVF	WT/IT	TME	PSS	RST/NMI	CKS2	CKS1	CKS0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/(W)*	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Note: * Only 0 can be written, to clear the flag.

TCSR is an 8-bit readable/writable* register. Its functions include selecting the clock source to be input to TCNT, and the timer mode.

TCR is initialized to H'00 by a reset and in hardware standby mode. It is not initialized in software standby mode.

Note: * TCSR is write-protected by a password to prevent accidental overwriting. For details see section 14.2.4, Notes on Register Access.

Bit 7—Overflow Flag (OVF): A status flag that indicates that TCNT has overflowed from H'FF to H'00.

Bit 7

OVF	Description	
0	[Clearing conditions]	
	• Write 0 in the TME bit	(Initial value)
	• Read TCSR when OVF = 1, then write 0 in OVFA	
1	[Setting condition]	
	When TCNT overflows (changes from H'FF to H'00) (When internal reset request generation is selected in watchdog til cleared automatically by the internal reset.)	mer mode, OVF is

Bit 6—Timer Mode Select (WT/IT): Selects whether the WDT is used as a watchdog timer or interval timer. If used as an interval timer, the WDT generates an interval timer interrupt request (WOVI) when TCNT overflows. If used as a watchdog timer, the WDT generates a reset or NMI interrupt when TCNT overflows.

Bit 6

WT/IT	Description	
0	Interval timer: Sends the CPU an interval timer interrupt request (WOVI) when TCNT overflows	(Initial value)
1	Watchdog timer: Generates a reset or NMI interrupt when TCNT overflows	

Bit 5—Timer Enable (TME): Selects whether TCNT runs or is halted.

Bit 5

ТМЕ	Description	
0	TCNT is initialized to H'00 and halted	(Initial value)
1	TCNT counts	

TCSR0 Bit 4—Reset Select (RSTS): Reserved. This bit should not be set to 1.

TCSR1 Bit 4—Prescaler Select (PSS): Selects the input clock source for TCNT in WDT1. For details, see the description of the CKS2 to CKS0 bits below.

WDT1 TCSR Bit 4		
PSS	 Description	
0	TCNT counts ø-based prescaler (PSM) divided clock pulses	(Initial value)
1	TCNT counts øSUB-based prescaler (PSS) divided clock pulses	

Bit 3—Reset or NMI (RST/NMI): Specifies whether an internal reset or NMI interrupt is requested on TCNT overflow in watchdog timer mode.

Bit 3

RST/NMI	Description	
0	An NMI interrupt is requested	(Initial value)
1	An internal reset is requested	

Bits 2 to 0—Clock Select 2 to 0 (CKS2 to CKS0): These bits select an internal clock source, obtained by dividing the system clock (Ø), or subclock (ØSUB) for input to TCNT.

• WDT0 input clock selection

Bit 2	Bit 1	Bit 0	Description				
CKS2	CKS1	CKS0	Clock	Overflow Period* (when ø = 20 MHz)			
0	0	0	ø/2 (Initial value)	25.6 µs			
		1	ø/64	819.2 µs			
	1	0	ø/128	1.6 ms			
		1	ø/512	6.6 ms			
1	0	0	ø/2048	26.2 ms			
		1	ø/8192	104.9 ms			
	1	0	ø/32768	419.4 ms			
		1	ø/131072	1.68 s			

Note: *The overflow period is the time from when TCNT starts counting up from H'00 until overflow occurs.

Bit 4	Bit 2	Bit 1	Bit 0	Description		
PSS	CKS2	CKS1	CKS0	Clock	Overflow Period* (when $\emptyset = 20 \text{ MHz}$ and $\emptyset_{SUB} = 32.768 \text{ kHz}$)	
0	0	0	0	ø/2 (Initial value)	25.6 µs	
			1	ø/64	819.2 µs	
		1	0	ø/128	1.6 ms	
			1	ø/512	6.6 ms	
	1	0	0	ø/2048	26.2 ms	
			1	ø/8192	104.9 ms	
		1	0	ø/32768	419.4 ms	
			1	ø/131072	1.68 s	
1	0	0	0	øSUB/2	15.6 ms	
			1	øSUB/4	31.3 ms	
		1	0	øSUB/8	62.5 ms	
			1	øSUB/16	125 ms	
	1	0	0	øSUB/32	250 ms	
			1	øSUB/64	500 ms	
		1	0	øSUB/128	1 s	
			1	øSUB/256	2 s	

• WDT1 input clock selection

Note: *The overflow period is the time from when TCNT starts counting up from H'00 until overflow occurs.

14.2.3 System Control Register (SYSCR)

Bit	7	6	5	4	3	2	1	0
	CS2E	IOSE	INTM1	INTM0	XRST	NMIEG	HIE	RAME
Initial value	0	0	0	0	1	0	0	1
Read/Write	R/W	R/W	R	R/W	R	R/W	R/W	R/W

Only bit 3 is described here. For details on functions not related to the watchdog timer, see sections 3.2.2 and 5.2.1, System Control Register (SYSCR), and the descriptions of the relevant modules.

Bit 3—External Reset (XRST): Indicates the reset source. When the watchdog timer is used, a reset can be generated by watchdog timer overflow in addition to external reset input. XRST is a read-only bit. It is set to 1 by an external reset, and when the RST/NMI bit is 1, is cleared to 0 by an internal reset due to watchdog timer overflow.

Bit 3

XRST	 Description	
0	Reset is generated by watchdog timer overflow	
1	Reset is generated by external reset input	(Initial value)

14.2.4 Notes on Register Access

The watchdog timer's TCNT and TCSR registers differ from other registers in being more difficult to write to. The procedures for writing to and reading these registers are given below.

Writing to TCNT and TCSR (Example of WDT0): These registers must be written to by a word transfer instruction. They cannot be written to with byte transfer instructions.

Figure 14.2 shows the format of data written to TCNT and TCSR. TCNT and TCSR both have the same write address. For a write to TCNT, the upper byte of the written word must contain H'5A and the lower byte must contain the write data. For a write to TCSR, the upper byte of the written word must contain H'A5 and the lower byte must contain the write data. This transfers the write data from the lower byte to TCNT or TCSR.

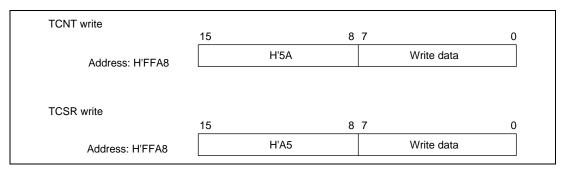


Figure 14.2 Format of Data Written to TCNT and TCSR (Example of WDT0)

Reading TCNT and TCSR (Example of WDT0): These registers are read in the same way as other registers. The read addresses are H'FFA8 for TCSR, and H'FFA9 for TCNT.

14.3 Operation

14.3.1 Watchdog Timer Operation

To use the WDT as a watchdog timer, set the WT/\overline{IT} and TME bits in TCSR to 1. Software must prevent TCNT overflows by rewriting the TCNT value (normally by writing H'00) before overflow occurs. This ensures that TCNT does not overflow while the system is operating normally. If TCNT overflows without being rewritten because of a system crash or other error, an internal reset or NMI interrupt request is generated.

When the RST/ $\overline{\text{NMI}}$ bit is set to 1, the chip is reset for 518 system clock periods (518 ø) by a counter overflow. This is illustrated in figure 14.3.

When the RST/ $\overline{\text{NMI}}$ bit cleared to 0, an NMI interrupt request is generated by a counter overflow.

An internal reset request from the watchdog timer and reset input from the $\overline{\text{RES}}$ pin are handled via the same vector. The reset source can be identified from the value of the XRST bit in SYSCR.

If a reset caused by an input signal from the $\overline{\text{RES}}$ pin and a reset caused by WDT overflow occur simultaneously, the $\overline{\text{RES}}$ pin reset has priority, and the XRST bit in SYSCR is set to 1.

An NMI interrupt request from the watchdog timer and an interrupt request from the NMI pin are handled via the same vector. Simultaneous handling of a watchdog timer NMI interrupt request and an NMI pin interrupt request must therefore be avoided.

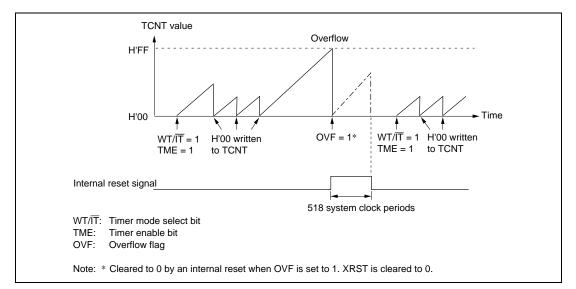


Figure 14.3 Operation in Watchdog Timer Mode

14.3.2 Interval Timer Operation

To use the WDT as an interval timer, clear the WT/\overline{IT} bit in TCSR to 0 and set the TME bit to 1. An interval timer interrupt (WOVI) is generated each time TCNT overflows, provided that the WDT is operating as an interval timer, as shown in figure 14.4. This function can be used to generate interrupt requests at regular intervals.

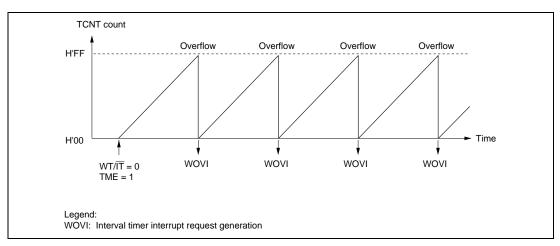


Figure 14.4 Operation in Interval Timer Mode

14.3.3 Timing of Setting of Overflow Flag (OVF)

The OVF flag is set to 1 if TCNT overflows during interval timer operation. At the same time, an interval timer interrupt (WOVI) is requested. This timing is shown in figure 14.5.

If NMI request generation is selected in watchdog timer mode, when TCNT overflows the OVF bit in TCSR is set to 1 and at the same time an NMI interrupt is requested.

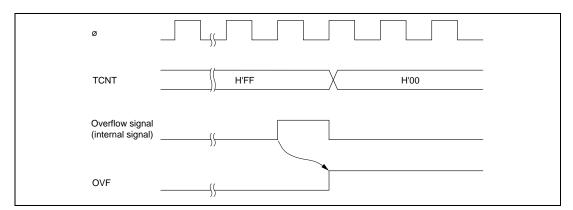


Figure 14.5 Timing of OVF Setting

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14.4 Interrupts

During interval timer mode operation, an overflow generates an interval timer interrupt (WOVI). The interval timer interrupt is requested whenever the OVF flag is set to 1 in TCSR. OVF must be cleared to 0 in the interrupt handling routine. When NMI interrupt request generation is selected in watchdog timer mode, an overflow generates an NMI interrupt request.

14.5 Usage Notes

14.5.1 Contention between Timer Counter (TCNT) Write and Increment

If a timer counter clock pulse is generated during the T_2 state of a TCNT write cycle, the write takes priority and the timer counter is not incremented. Figure 14.6 shows this operation.

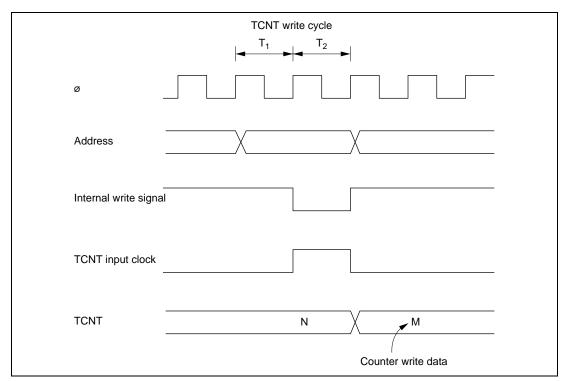


Figure 14.6 Contention between TCNT Write and Increment

14.5.2 Changing Value of CKS2 to CKS0

If bits CKS2 to CKS0 in TCSR are written to while the WDT is operating, errors could occur in the incrementation. Software must stop the watchdog timer (by clearing the TME bit to 0) before changing the value of bits CKS2 to CKS0.

14.5.3 Switching between Watchdog Timer Mode and Interval Timer Mode

If the mode is switched from watchdog timer to interval timer, or vice versa, while the WDT is operating, errors could occur in the incrementation. Software must stop the watchdog timer (by clearing the TME bit to 0) before switching the mode.

14.5.4 Counter Value in Transitions between High-Speed Mode, Subactive Mode, and Watch Mode

If the mode is switched between high-speed mode and subactive mode or between high-speed mode and watch mode when WDT1 is used as a realtime clock counter, an error will occur in the counter value when the internal clock is switched.

When the mode is switched from high-speed mode to subactive mode or watch mode, the increment timing is delayed by approximately 2 or 3 clock cycles when the WDT1 control clock is switched from the main clock to the subclock.

Also, since the main clock oscillator is halted during subclock operation, when the mode is switched from watch mode or subactive mode to high-speed mode, the clock is not supplied until internal oscillation stabilizes. As a result, after oscillation is started, counter incrementing is halted during the oscillation stabilization time set by bits STS2 to STS0 in SBYCR, and there is a corresponding discrepancy in the counter value.

Caution is therefore required when using WDT1 as the realtime clock counter.

No error occurs in the counter value while WDT1 is operating in the same mode.

Section 15 Serial Communication Interface (SCI, IrDA)

15.1 Overview

The H8S/2138 Series and H8S/2134 Series are equipped with a 3-channel serial communication interface (SCI). The SCI can handle both asynchronous and clocked synchronous serial communication. A function is also provided for serial communication between processors (multiprocessor communication).

One of the three SCI channels can transmit and receive IrDA communication waveforms based on IrDA specification version 1.0.

15.1.1 Features

SCI features are listed below.

- Choice of asynchronous or synchronous serial communication mode Asynchronous mode
 - Serial data communication is executed using an asynchronous system in which synchronization is achieved character by character

Serial data communication can be carried out with standard asynchronous communication chips such as a Universal Asynchronous Receiver/Transmitter (UART) or Asynchronous Communication Interface Adapter (ACIA)

- A multiprocessor communication function is provided that enables serial data communication with a number of processors
- Choice of 12 serial data transfer formats

Data length:	7 or 8 bits
Stop bit length:	1 or 2 bits
Parity:	Even, odd, or none
Multiprocessor bit:	1 or 0

- Receive error detection: Parity, overrun, and framing errors
- Break detection: Break can be detected by reading the RxD pin level directly in case of a framing error

Synchronous mode

— Serial data communication is synchronized with a clock

Serial data communication can be carried out with other chips that have a synchronous communication function

— One serial data transfer format

Data length: 8 bits

- Receive error detection: Overrun errors detected

- Full-duplex communication capability
 - The transmitter and receiver are mutually independent, enabling transmission and reception to be executed simultaneously
 - Double-buffering is used in both the transmitter and the receiver, enabling continuous transmission and continuous reception of serial data
- LSB-first or MSB-first transfer can be selected
 - This selection can be made regardless of the communication mode (with the exception of 7-bit data transfer in asynchronous mode)*

Note: * LSB-first transfer is used in the examples in this section.

- Built-in baud rate generator allows any bit rate to be selected
- Choice of serial clock source: internal clock from baud rate generator or external clock from SCK pin
- Four interrupt sources
 - Four interrupt sources (transmit-data-empty, transmit-end, receive-data-full, and receive error) that can issue requests independently
 - The transmit-data-empty interrupt and receive-data-full interrupt can activate the data transfer controller (DTC) to execute data transfer

15.1.2 Block Diagram

Figure 15.1 shows a block diagram of the SCI.

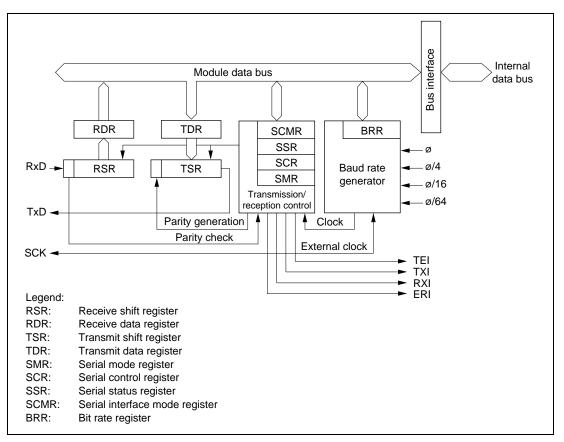


Figure 15.1 Block Diagram of SCI

15.1.3 Pin Configuration

Table 15.1 shows the serial pins used by the SCI.

Table 15.1 SCI Pins

Channel	Pin Name	Symbol*	I/O	Function
0	Serial clock pin 0	SCK0	I/O	SCI0 clock input/output
	Receive data pin 0	RxD0	Input	SCI0 receive data input
	Transmit data pin 0	TxD0	Output	SCI0 transmit data output
1	Serial clock pin 1	SCK1	I/O	SCI1 clock input/output
	Receive data pin 1	RxD1	Input	SCI1 receive data input
	Transmit data pin 1	TxD1	Output	SCI1 transmit data output
2	Serial clock pin 2	SCK2	I/O	SCI2 clock input/output
	Receive data pin 2	RxD2/IrRxD	Input	SCI2 receive data input (normal/IrDA)
	Transmit data pin 2	TxD2/lrTxD	Output	SCI2 transmit data output (normal/IrDA)

Note: *The abbreviations SCK, RxD, and TxD are used in the text, omitting the channel number.

15.1.4 Register Configuration

The SCI has the internal registers shown in table 15.2. These registers are used to specify asynchronous mode or synchronous mode, the data format, and the bit rate, and to control the transmitter/receiver.

Channel	Name	Abbreviation	R/W	Initial Value	Address*1
0	Serial mode register 0	SMR0	R/W	H'00	H'FFD8* ³
	Bit rate register 0	BRR0	R/W	H'FF	H'FFD9* ³
	Serial control register 0	SCR0	R/W	H'00	H'FFDA
	Transmit data register 0	TDR0	R/W	H'FF	H'FFDB
	Serial status register 0	SSR0	R/(W)* ²	H'84	H'FFDC
	Receive data register 0	RDR0	R	H'00	H'FFDD
	Serial interface mode register 0	SCMR0	R/W	H'F2	H'FFDE* ³
1	Serial mode register 1	SMR1	R/W	H'00	H'FF88* ³
	Bit rate register 1	BRR1	R/W	H'FF	H'FF89* ³
	Serial control register 1	SCR1	R/W	H'00	H'FF8A
	Transmit data register 1	TDR1	R/W	H'FF	H'FF8B
	Serial status register 1	SSR1	R/(W)* ²	H'84	H'FF8C
	Receive data register 1	RDR1	R	H'00	H'FF8D
	Serial interface mode register 1	SCMR1	R/W	H'F2	H'FF8E* ³
2	Serial mode register 2	SMR2	R/W	H'00	H'FFA0* ³
	Bit rate register 2	BRR2	R/W	H'FF	H'FFA1* ³
	Serial control register 2	SCR2	R/W	H'00	H'FFA2
	Transmit data register 2	TDR2	R/W	H'FF	H'FFA3
	Serial status register 2	SSR2	R/(W)* ²	H'84	H'FFA4
	Receive data register 2	RDR2	R	H'00	H'FFA5
	Serial interface mode register 2	SCMR2	R/W	H'F2	H'FFA6* ³
	Keyboard comparator control register	KBCOMP	R/W	H'00	H'FEE4
Common	Module stop control register	MSTPCRH	R/W	H'3F	H'FF86
		MSTPCRL	R/W	H'FF	H'FF87

Table 15.2 SCI Registers

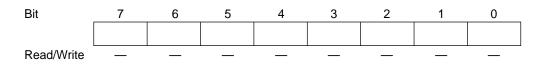
Notes: 1. Lower 16 bits of the address.

2. Only 0 can be written, to clear flags.

3. Some serial communication interface registers are assigned to the same addresses as other registers. In this case, register selection is performed by the IICE bit in the serial timer control register (STCR).

15.2 Register Descriptions

15.2.1 Receive Shift Register (RSR)

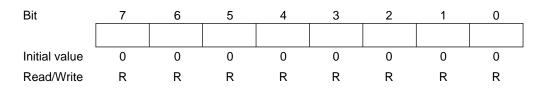


RSR is a register used to receive serial data.

The SCI sets serial data input from the RxD pin in RSR in the order received, starting with the LSB (bit 0), and converts it to parallel data. When one byte of data has been received, it is transferred to RDR automatically.

RSR cannot be directly read or written to by the CPU.

15.2.2 Receive Data Register (RDR)



RDR is a register that stores received serial data.

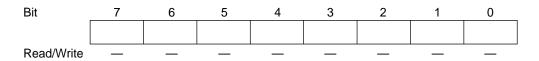
When the SCI has received one byte of serial data, it transfers the received serial data from RSR to RDR where it is stored, and completes the receive operation. After this, RSR is receive-enabled.

Since RSR and RDR function as a double buffer in this way, continuous receive operations can be performed.

RDR is a read-only register, and cannot be written to by the CPU.

RDR is initialized to H'00 by a reset, and in standby mode, watch mode, subactive mode, subsleep mode, and module stop mode.

15.2.3 Transmit Shift Register (TSR)



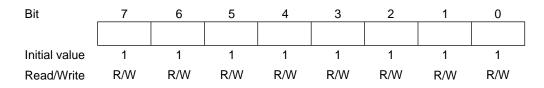
TSR is a register used to transmit serial data.

To perform serial data transmission, the SCI first transfers transmit data from TDR to TSR, then sends the data to the TxD pin starting with the LSB (bit 0).

When transmission of one byte is completed, the next transmit data is transferred from TDR to TSR, and transmission started, automatically. However, data transfer from TDR to TSR is not performed if the TDRE bit in SSR is set to 1.

TSR cannot be directly read or written to by the CPU.

15.2.4 Transmit Data Register (TDR)



TDR is an 8-bit register that stores data for serial transmission.

When the SCI detects that TSR is empty, it transfers the transmit data written in TDR to TSR and starts serial transmission. Continuous serial transmission can be carried out by writing the next transmit data to TDR during serial transmission of the data in TSR.

TDR can be read or written to by the CPU at all times.

TDR is initialized to H'FF by a reset, and in standby mode, watch mode, subactive mode, subsleep mode, and module stop mode.

15.2.5 Serial Mode Register (SMR)

Bit	7	6	5	4	3	2	1	0
	C/Ā	CHR	PE	O/Ē	STOP	MP	CKS1	CKS0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

SMR is an 8-bit register used to set the SCI's serial transfer format and select the baud rate generator clock source.

SMR can be read or written to by the CPU at all times.

SMR is initialized to H'00 by a reset, and in standby mode, watch mode, subactive mode, subsleep mode, and module stop mode.

Bit 7—Communication Mode (C/\overline{A}): Selects asynchronous mode or synchronous mode as the SCI operating mode.

Bit 7		
C/A	Description	
0	Asynchronous mode	(Initial value)
1	Synchronous mode	

Bit 6—Character Length (CHR): Selects 7 or 8 bits as the data length in asynchronous mode. In synchronous mode, a fixed data length of 8 bits is used regardless of the CHR setting.

Bit 6

CHR	Description	
0	8-bit data	(Initial value)
1	7-bit data*	

Note: *When 7-bit data is selected, the MSB (bit 7) of TDR is not transmitted, and LSB-first/MSBfirst selection is not available.

Bit 5—Parity Enable (PE): In asynchronous mode, selects whether or not parity bit addition is performed in transmission, and parity bit checking in reception. In synchronous mode, or when a multiprocessor format is used, parity bit addition and checking is not performed, regardless of the PE bit setting.

PE	Description	
0	Parity bit addition and checking disabled	(Initial value)
1	Parity bit addition and checking enabled*	

Note: *When the PE bit is set to 1, the parity (even or odd) specified by the O/E bit is added to transmit data before transmission. In reception, the parity bit is checked for the parity (even or odd) specified by the O/\overline{E} bit.

Bit 4—Parity Mode (O/\overline{E}) : Selects either even or odd parity for use in parity addition and checking.

The O/\overline{E} bit setting is only valid when the PE bit is set to 1, enabling parity bit addition and checking, in asynchronous mode. The O/\overline{E} bit setting is invalid in synchronous mode, when parity bit addition and checking is disabled in asynchronous mode, and when a multiprocessor format is used.

Bit 4

O/Ē	Description	
0	Even parity*1	(Initial value)
1	Odd parity* ²	
Notes: 1	 When even parity is set, parity bit addition is performed in tra- total number of 1 bits in the transmit character plus the parit 	
	In reception, a check is performed to see if the total number character plus the parity bit is even.	of 1 bits in the receive
2	2. When odd parity is set, parity bit addition is performed in tra number of 1 bits in the transmit character plus the parity bit	
	In reception, a check is performed to see if the total number character plus the parity bit is odd.	of 1 bits in the receive

Bit 3—Stop Bit Length (STOP): Selects 1 or 2 bits as the stop bit length in asynchronous mode. The STOP bit setting is only valid in asynchronous mode. If synchronous mode is set the STOP bit setting is invalid since stop bits are not added.

Bit 3

STOP	Description	
0	1 stop bit*1	(Initial value)
1	2 stop bits* ²	
Notes: 1	 In transmission, a single 1 bit (stop bit) is added to the before it is sent. 	e end of a transmit character
 In transmission, two 1 bits (stop bits) are added to the end of a transmit chara before it is sent. 		e end of a transmit character

In reception, only the first stop bit is checked, regardless of the STOP bit setting. If the second stop bit is 1, it is treated as a stop bit; if it is 0, it is treated as the start bit of the next transmit character.

Bit 2—Multiprocessor Mode (MP): Selects multiprocessor format. When multiprocessor format is selected, the PE bit and O/\overline{E} bit parity settings are invalid. The MP bit setting is only valid in asynchronous mode; it is invalid in synchronous mode.

For details of the multiprocessor communication function, see section 15.3.3, Multiprocessor Communication Function.

Bit 2	
-------	--

MP	Description	
0	Multiprocessor function disabled	(Initial value)
1	Multiprocessor format selected	

Bits 1 and 0—Clock Select 1 and 0 (CKS1, CKS0): These bits select the clock source for the baud rate generator. The clock source can be selected from ϕ , $\phi/4$, $\phi/16$, and $\phi/64$, according to the setting of bits CKS1 and CKS0.

For the relation between the clock source, the bit rate register setting, and the baud rate, see section 15.2.8, Bit Rate Register.

Bit 1	Bit 0		
CKS1	CKS0	Description	
0	0	ø clock	(Initial value)
	1	ø/4 clock	
1	0	ø/16 clock	
	1	ø/64 clock	

15.2.6 Serial Control Register (SCR)

Bit	7	6	5	4	3	2	1	0
	TIE	RIE	TE	RE	MPIE	TEIE	CKE1	CKE0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

SCR is a register that performs enabling or disabling of SCI transfer operations, serial clock output in asynchronous mode, and interrupt requests, and selection of the serial clock source.

SCR can be read or written to by the CPU at all times.

SCR is initialized to H'00 by a reset, and in standby mode, watch mode, subactive mode, subsleep mode, and module stop mode.

Bit 7—Transmit Interrupt Enable (TIE): Enables or disables transmit-data-empty interrupt (TXI) request generation when serial transmit data is transferred from TDR to TSR and the TDRE flag in SSR is set to 1.

Bit 7

TIE	Description	
0	Transmit-data-empty interrupt (TXI) request disabled*	(Initial value)
1	Transmit-data-empty interrupt (TXI) request enabled	

Note: *TXI interrupt request cancellation can be performed by reading 1 from the TDRE flag, then clearing it to 0, or clearing the TIE bit to 0.

Bit 6—Receive Interrupt Enable (RIE): Enables or disables receive-data-full interrupt (RXI) request and receive-error interrupt (ERI) request generation when serial receive data is transferred from RSR to RDR and the RDRF flag in SSR is set to 1.

Bit 6

RIE	Description
0	Receive-data-full interrupt (RXI) request and receive-error interrupt (ERI) request disabled* (Initial value)
1	Receive-data-full interrupt (RXI) request and receive-error interrupt (ERI) request enabled
Note: *I	RXI and ERI interrupt request cancellation can be performed by reading 1 from the RDRF.

FER, PER, or ORER flag, then clearing the flag to 0, or clearing the RIE bit to 0.

Bit 5—Transmit Enable (TE): Enables or disables the start of serial transmission by the SCI.

Bit 5

TE	 Description	
0	Transmission disabled*1	(Initial value)
1	Transmission enabled* ²	
	The TDRE flag in SSR is fixed at 1. In this state, serial transmission is started when transmit data is written the TDRE flag in SSR is cleared to 0. SMR setting must be performed to decide the transmission format befor TE bit to 1.	

Bit 4—Receive Enable (RE): Enables or disables the start of serial reception by the SCI.

RE	Description	
0	Reception disabled*1	(Initial value)
1	Reception enabled* ²	
Notes: 1.	Clearing the RE bit to 0 does not affect the RDRF, FER, PER, a retain their states.	and ORER flags, which
2.	Serial reception is started in this state when a start bit is detected mode or serial clock input is detected in synchronous mode. SMR setting must be performed to decide the reception format bit to 1.	

Bit 3—Multiprocessor Interrupt Enable (MPIE): Enables or disables multiprocessor interrupts. The MPIE bit setting is only valid in asynchronous mode when receiving with the MP bit in SMR set to 1.

The MPIE bit setting is invalid in synchronous mode or when the MP bit is cleared to 0.

MPIE	Description	
0	Multiprocessor interrupts disabled (normal reception performed)	(Initial value)
	[Clearing conditions]	
	When the MPIE bit is cleared to 0	
	• When data with MPB = 1 is received	
1	Multiprocessor interrupts enabled*	
	Receive interrupt (RXI) requests, receive-error interrupt (ERI) reques of the RDRF, FER, and ORER flags in SSR are disabled until data w multiprocessor bit set to 1 is received.	, 0

receive data transfer from RSR to RDR, receive error detection, and setting of the RDRF, FER, and ORER flags in SSR , is not performed. When receive data with MPB = 1 is received, the MPB bit in SSR is set to 1, the MPIE bit is cleared to 0 automatically, and generation of RXI and ERI interrupts (when the TIE and RIE bits in SCR are set to 1) and FER and ORER flag setting is enabled.

Bit 2—Transmit End Interrupt Enable (TEIE): Enables or disables transmit-end interrupt (TEI) request generation if there is no valid transmit data in TDR when the MSB is transmitted.

Bit	2
-----	---

TEIE	Description	
0	Transmit-end interrupt (TEI) request disabled*	(Initial value)
1	Transmit-end interrupt (TEI) request enabled*	

Note: *TEI cancellation can be performed by reading 1 from the TDRE flag in SSR, then clearing it to 0 and clearing the TEND flag to 0, or clearing the TEIE bit to 0.

Bits 1 and 0—Clock Enable 1 and 0 (CKE1, CKE0): These bits are used to select the SCI clock source and enable or disable clock output from the SCK pin. The combination of the CKE1 and CKE0 bits determines whether the SCK pin functions as an I/O port, the serial clock output pin, or the serial clock input pin.

The setting of the CKE0 bit, however, is only valid for internal clock operation (CKE1 = 0) in asynchronous mode. The CKE0 bit setting is invalid in synchronous mode, and in the case of external clock operation (CKE1 = 1). The setting of bits CKE1 and CKE0 must be carried out before the SCI's operating mode is determined using SMR.

Bit 1	Bit 0		
CKE1	CKE0	Description	
0	0	Asynchronous mode	Internal clock/SCK pin functions as I/O port*1
		Synchronous mode	Internal clock/SCK pin functions as serial clock output*1
	1	Asynchronous mode	Internal clock/SCK pin functions as clock output*2
		Synchronous mode	Internal clock/SCK pin functions as serial clock output
1	0	Asynchronous mode	External clock/SCK pin functions as clock input*3
		Synchronous mode	External clock/SCK pin functions as serial clock input
	1	Asynchronous mode	External clock/SCK pin functions as clock input*3
		Synchronous mode	External clock/SCK pin functions as serial clock input

For details of clock source selection, see table 15.9 in section 15.3, Operation.

Notes: 1. Initial value

D:4 4

2. Outputs a clock of the same frequency as the bit rate.

3. Inputs a clock with a frequency 16 times the bit rate.

15.2.7 Serial Status Register (SSR)

Bit	7	6	5	4	3	2	1	0
	TDRE	RDRF	ORER	FER	PER	TEND	MPB	MPBT
Initial value	1	0	0	0	0	1	0	0
Read/Write	R/(W)*	R/(W)*	R/(W)*	R/(W)*	R/(W)*	R	R	R/W

Note: Only 0 can be written, to clear the flag.

SSR is an 8-bit register containing status flags that indicate the operating status of the SCI, and multiprocessor bits.

SSR can be read or written to by the CPU at all times. However, 1 cannot be written to flags TDRE, RDRF, ORER, PER, and FER. Also note that in order to clear these flags they must be read as 1 beforehand. The TEND flag and MPB flag are read-only flags and cannot be modified.

SSR is initialized to H'84 by a reset, and in standby mode, watch mode, subactive mode, subsleep mode, and module stop mode.

Bit 7—Transmit Data Register Empty (TDRE): Indicates that data has been transferred from TDR to TSR and the next serial data can be written to TDR.

Bit 7	
TDRE	Description
0	[Clearing conditions]
	 When 0 is written in TDRE after reading TDRE = 1
	 When the DTC is activated by a TXI interrupt and writes data to TDR
1	[Setting conditions] (Initial value)
	When the TE bit in SCR is 0
	 When data is transferred from TDR to TSR and data can be written to TDR

Bit 6—Receive Data Register Full (RDRF): Indicates that the received data is stored in RDR.

RDRF	Description
0	[Clearing conditions] (Initial value)
	 When 0 is written in RDRF after reading RDRF = 1
	 When the DTC is activated by an RXI interrupt and reads data from RDR
1	[Setting condition]
	When serial reception ends normally and receive data is transferred from RSR to RDR
Note:	RDR and the RDRF flag are not affected and retain their previous values when an error is detected during reception or when the RE bit in SCR is cleared to 0.
	If reception of the next data is completed while the RDRF flag is still set to 1, an overrun error will occur and the receive data will be lost.

Bit 5—Overrun Error (ORER): Indicates that an overrun error occurred during reception, causing abnormal termination.

Bit 5

ORER	Description
0	[Clearing condition] (Initial value)*
	When 0 is written in ORER after reading ORER = 1
1	[Setting condition]
	When the next serial reception is completed while RDRF = 1^{*^2}
Notes: 1.	The ORER flag is not affected and retains its previous state when the RE bit in SCR is cleared to 0.
2.	The receive data prior to the overrun error is retained in RDR, and the data received subsequently is lost. Also, subsequent serial reception cannot be continued while the ORER flag is set to 1. In synchronous mode, serial transmission cannot be continued, either.

Bit 4—Framing Error (FER): Indicates that a framing error occurred during reception in asynchronous mode, causing abnormal termination.

Bit 4

FER	Description
0	[Clearing condition] (Initial value)* ¹
	When 0 is written in FER after reading $FER = 1$
1	[Setting condition]
	When the SCI checks the stop bit at the end of the receive data when reception ends, and the stop bit is 0 \ast^2
Notes:	 The FER flag is not affected and retains its previous state when the RE bit in SCR is cleared to 0.
:	2. In 2-stop-bit mode, only the first stop bit is checked for a value of 0; the second stop bit is not checked. If a framing error occurs, the receive data is transferred to RDR but the RDRF flag is not set. Also, subsequent serial reception cannot be continued while the FER flag is set to 1. In synchronous mode, serial transmission cannot be continued, either.

Bit 3—Parity Error (PER): Indicates that a parity error occurred during reception using parity addition in asynchronous mode, causing abnormal termination.

Bit 3			
PER		Description	
0		[Clearing condition]	(Initial value)*1
		When 0 is written in PER after reading PER = 1	
1		[Setting condition] When, in reception, the number of 1 bits in the receive data plus the not match the parity setting (even or odd) specified by the O/\overline{E} bit in	
Notes:	1.	The PER flag is not affected and retains its previous state when the cleared to 0.	RE bit in SCR is
	2.	If a parity error occurs, the receive data is transferred to RDR but the set. Also, subsequent serial reception cannot be continued while the 1. In synchronous mode, serial transmission cannot be continued, end	PER flag is set to

Bit 2—Transmit End (TEND): Indicates that there is no valid data in TDR when the last bit of the transmit character is sent, and transmission has been ended.

The TEND flag is read-only and cannot be modified.

Bit 2	
TEND	Description
0	[Clearing conditions]
	 When 0 is written in TDRE after reading TDRE = 1
	 When the DTC is activated by a TXI interrupt and writes data to TDR
1	[Setting conditions] (Initial value
	When the TE bit in SCR is 0
	 When TDRE = 1 at transmission of the last bit of a 1-byte serial transmit character

Bit 1—Multiprocessor Bit (MPB): When reception is performed using a multiprocessor format in asynchronous mode, MPB stores the multiprocessor bit in the receive data.

MPB is a read-only bit, and cannot be modified.

Bit 1		
MPB	Description	
0	[Clearing condition] When data with a 0 multiprocessor bit is received	(Initial value)*
1	[Setting condition] When data with a 1 multiprocessor bit is received	

Note: * Retains its previous state when the RE bit in SCR is cleared to 0 with multiprocessor format.

Bit 0—Multiprocessor Bit Transfer (MPBT): When transmission is performed using a multiprocessor format in asynchronous mode, MPBT stores the multiprocessor bit to be added to the transmit data.

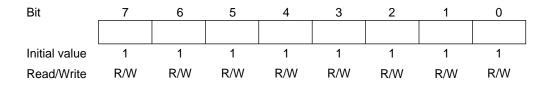
The MPBT bit setting is invalid when a multiprocessor format is not used, when not transmitting, and in synchronous mode.

Bit 0

D¹/ 4

MPBT	Description	
0	Data with a 0 multiprocessor bit is transmitted	(Initial value)
1	Data with a 1 multiprocessor bit is transmitted	

15.2.8 Bit Rate Register (BRR)



BRR is an 8-bit register that sets the serial transfer bit rate in accordance with the baud rate generator operating clock selected by bits CKS1 and CKS0 in SMR.

BRR can be read or written to by the CPU at all times.

BRR is initialized to H'FF by a reset, and in standby mode, watch mode, subactive mode, subsleep mode, and module stop mode.

As baud rate generator control is performed independently for each channel, different values can be set for each channel.

Table 15.3 shows sample BRR settings in asynchronous mode, and table 15.4 shows sample BRR settings in synchronous mode.

	Operating Frequency ø (MHz)												
		ø = 2 N	lHz	ø	ø = 2.097152 MHz			ø = 2.4576 MHz			ø = 3 MHz		
Bit Rate (bits/s)	n	N	Error (%)	n	N	Error (%)	n	N	Error (%)	n	N	Error (%)	
110	1	141	0.03	1	148	-0.04	1	174	-0.26	1	212	0.03	
150	1	103	0.16	1	108	0.21	1	127	0.00	1	155	0.16	
300	0	207	0.16	0	217	0.21	0	255	0.00	1	77	0.16	
600	0	103	0.16	0	108	0.21	0	127	0.00	0	155	0.16	
1200	0	51	0.16	0	54	-0.70	0	63	0.00	0	77	0.16	
2400	0	25	0.16	0	26	1.14	0	31	0.00	0	38	0.16	
4800	0	12	0.16	0	13	-2.48	0	15	0.00	0	19	-2.34	
9600		—	—	0	6	-2.48	0	7	0.00	0	9	-2.34	
19200		—	—	—	—	—	0	3	0.00	0	4	-2.34	
31250	0	1	0.00	—	_	_	—	_	_	0	2	0.00	
38400	_	_	_	_	_	_	0	1	0.00	_	_	_	

 Table 15.3
 BRR Settings for Various Bit Rates (Asynchronous Mode)

	ø = 3.6864 MHz				ø = 4 MHz			ø = 4.915	2 MHz		ø = 5 MHz		
Bit Rate (bits/s)	n	N	Error (%)	n	N	Error (%)	n	N	Error (%)	n	N	Error (%)	
110	2	64	0.70	2	70	0.03	2	86	0.31	2	88	-0.25	
150	1	191	0.00	1	207	0.16	1	255	0.00	2	64	0.16	
300	1	95	0.00	1	103	0.16	1	127	0.00	1	129	0.16	
600	0	191	0.00	0	207	0.16	0	255	0.00	1	64	0.16	
1200	0	95	0.00	0	103	0.16	0	127	0.00	0	129	0.16	
2400	0	47	0.00	0	51	0.16	0	63	0.00	0	64	0.16	
4800	0	23	0.00	0	25	0.16	0	31	0.00	0	32	-1.36	
9600	0	11	0.00	0	12	0.16	0	15	0.00	0	15	1.73	
19200	0	5	0.00	_	_	—	0	7	0.00	0	7	1.73	
31250	_	—		0	3	0.00	0	4	-1.70	0	4	0.00	
38400	0	2	0.00	—	_	—	0	3	0.00	0	3	1.73	

Operating Frequency ø (MHz)												
ø = 6 MHz				ø = 6.144 MHz			ø = 7.3728 MHz			ø = 8 MHz		
n	N	Error (%)	n	N	Error (%)	n	N	Error (%)	n	N	Error (%)	
2	106	-0.44	2	108	0.08	2	130	-0.07	2	141	0.03	
2	77	0.16	2	79	0.00	2	95	0.00	2	103	0.16	
1	155	0.16	1	159	0.00	1	191	0.00	1	207	0.16	
1	77	0.16	1	79	0.00	1	95	0.00	1	103	0.16	
0	155	0.16	0	159	0.00	0	191	0.00	0	207	0.16	
0	77	0.16	0	79	0.00	0	95	0.00	0	103	0.16	
0	38	0.16	0	39	0.00	0	47	0.00	0	51	0.16	
0	19	-2.34	0	19	0.00	0	23	0.00	0	25	0.16	
0	9	-2.34	0	9	0.00	0	11	0.00	0	12	0.16	
0	5	0.00	0	5	2.40	_	—	—	0	7	0.00	
0	4	-2.34	0	4	0.00	0	5	0.00	_	_	_	
	2 2 1 0 0 0 0 0 0 0 0 0	n N 2 106 2 77 1 155 1 77 0 155 0 77 0 38 0 19 0 9 0 5	n Error (%) 2 106 -0.44 2 77 0.16 1 155 0.16 1 77 0.16 1 77 0.16 0 155 0.16 0 155 0.16 0 38 0.16 0 38 0.16 0 19 -2.34 0 9 -2.34 0 5 0.00	n Error (%) n 2 106 -0.44 2 2 77 0.16 2 1 155 0.16 1 1 77 0.16 1 0 155 0.16 1 0 155 0.16 0 0 777 0.16 0 0 38 0.16 0 0 19 -2.34 0 0 9 -2.34 0 0 5 0.00 0		Ø = 6 MHz Ø = 6.144 MHz Ø = 6 MHz Ø = 6.144 MHz Ø = 0.144 Ø = 0.144 Ø = 0.144 Ø = 0.08 Ø = 0.144 Ø = 0.00 Ø = 0.144 Ø = 0.00 Ø = 0.144 Ø = 0.00 Ø = 0.164 Ø = 0.00 Ø = 0.00 Ø = 0.00 Ø = 0.00 Ø = 0.00 Ø = 0.00 Ø = 0.00 Ø = 0.00 Ø = 0.00		$\omega = 6 \text{ MHz}$ $\omega = 6.144 \text{ MHz}$ $\omega = 7.3728$ n N (%) n N (%) n N 2 106 -0.44 2 108 0.08 2 130 2 77 0.16 2 79 0.00 2 95 1 155 0.16 1 159 0.00 1 191 1 77 0.16 1 79 0.00 1 95 0 155 0.16 1 79 0.00 1 95 0 155 0.16 0 159 0.00 1 95 0 155 0.16 0 79 0.00 95 95 0 38 0.16 339 0.00 0 47 0 19 -2.34 0 19 0.00 0 11 0 5 0.00 0 5 2.40				

 Table 15.3
 BRR Settings for Various Bit Rates (Asynchronous Mode) (cont)

e											
ø = 9.8304 MHz			ø = 10 MHz			ø = 12 MHz			ø = 12.288 MHz		
n	N	Error (%)	n	N	Error (%)	n	N	Error (%)	n	N	Error (%)
2	174	-0.26	2	177	-0.25	2	212	0.03	2	217	0.08
2	127	0.00	2	129	0.16	2	155	0.16	2	159	0.00
1	255	0.00	2	64	0.16	2	77	0.16	2	79	0.00
1	127	0.00	1	129	0.16	1	155	0.16	1	159	0.00
0	255	0.00	1	64	0.16	1	77	0.16	1	79	0.00
0	127	0.00	0	129	0.16	0	155	0.16	0	159	0.00
0	63	0.00	0	64	0.16	0	77	0.16	0	79	0.00
0	31	0.00	0	32	-1.36	0	38	0.16	0	39	0.00
0	15	0.00	0	15	1.73	0	19	-2.34	0	19	0.00
0	9	-1.70	0	9	0.00	0	11	0.00	0	11	2.40
0	7	0.00	0	7	1.73	0	9	-2.34	0	9	0.00
	2 2 1 0 0 0 0 0 0 0 0 0	2 174 2 127 1 255 1 127 0 255 0 127 0 63 0 31 0 15 0 9	n N (%) 2 174 -0.26 2 127 0.00 1 255 0.00 1 127 0.00 0 255 0.00 0 127 0.00 0 127 0.00 0 63 0.00 0 31 0.00 0 15 0.00 0 9 -1.70	n (%) n 2 174 -0.26 2 2 127 0.00 2 1 255 0.00 2 1 127 0.00 1 0 255 0.00 1 0 127 0.00 0 0 63 0.00 0 0 31 0.00 0 0 15 0.00 0 0 9 -1.70 0	n N (%) n N 2 174 -0.26 2 177 2 127 0.00 2 129 1 255 0.00 2 64 1 127 0.00 1 129 0 255 0.00 1 64 0 127 0.00 0 129 0 63 0.00 0 64 0 31 0.00 0 32 0 63 0.00 0 54 0 31 0.00 0 32 0 15 0.00 0 15 0 9 -1.70 0 9	n N (%) n N (%) 2 174 -0.26 2 177 -0.25 2 127 0.00 2 129 0.16 1 255 0.00 2 64 0.16 1 127 0.00 1 129 0.16 0 255 0.00 1 644 0.16 0 127 0.00 0 129 0.16 0 127 0.00 0 129 0.16 0 127 0.00 0 644 0.16 0 63 0.00 0 644 0.16 0 31 0.00 0 32 -1.36 0 15 0.00 0 15 1.73 0 9 -1.70 0 9 0.00	nN(%)nN(%)n2174 -0.26 2177 -0.25 221270.0021290.16212550.002640.16211270.0011290.16102550.001640.16101270.0001290.1600310.00032 -1.36 00150.000151.73009 -1.70 090.000	n N (%) n N (%) n N 2 174 -0.26 2 177 -0.25 2 212 2 127 0.00 2 129 0.16 2 155 1 255 0.00 2 64 0.16 2 77 1 127 0.00 1 129 0.16 1 155 0 255 0.00 1 644 0.16 1 77 0 127 0.00 0 129 0.16 0 155 0 255 0.00 1 644 0.16 0 155 0 63 0.00 0 129 0.16 0 77 0 31 0.00 0 32 -1.36 0 38 0 15 0.00 0 15 1.73 0 19 0 9	n N (%) n N (%) n N (%) 2 174 -0.26 2 177 -0.25 2 212 0.03 2 127 0.00 2 129 0.16 2 155 0.16 1 255 0.00 2 64 0.16 2 77 0.16 1 127 0.00 1 129 0.16 1 155 0.16 1 127 0.00 1 644 0.16 1 77 0.16 0 255 0.00 1 644 0.16 1 77 0.16 0 127 0.00 0 129 0.16 0 155 0.16 0 63 0.00 0 64 0.16 0 77 0.16 0 31 0.00 0 32 -1.36 0 38 0.16	nN(%)nN(%)nN(%)n2174 -0.26 2177 -0.25 22120.03221270.0021290.1621550.16212550.002640.162770.16211270.0011290.1611550.16102550.001640.161770.16101270.0001290.1601550.1600630.000640.160380.1600150.000151.73019 -2.34 009 -1.70 090.000110.000	nN(%)nN(%)nN(%)nN2174 -0.26 2177 -0.25 22120.03221721270.0021290.1621550.16215912550.002640.162770.1627911270.0011290.1611550.16115902550.001640.161770.1617901270.0001290.1601550.1601590310.000640.160770.160390150.000151.73019 -2.34 01909 -1.70 090.000110.00011

	Operating Frequency ø (MHz)												
		ø = 14 I	٨Hz	1	ø = 14.7456 MHz			ø = 16 MHz			ø = 17.2032 MHz		
Bit Rate (bits/s)	n	N	Error (%)	n	N	Error (%)	n	N	Error (%)	n	N	Error (%)	
110	2	248	-0.17	3	64	0.70	3	70	0.03	3	75	0.48	
150	2	181	0.16	2	191	0.00	2	207	0.16	2	223	0.00	
300	2	90	0.16	2	95	0.00	2	103	0.16	2	111	0.00	
600	1	181	0.16	1	191	0.00	1	207	0.16	1	223	0.00	
1200	1	90	0.16	1	95	0.00	1	103	0.16	1	111	0.00	
2400	0	181	0.16	0	191	0.00	0	207	0.16	0	223	0.00	
4800	0	90	0.16	0	95	0.00	0	103	0.16	0	111	0.00	
9600	0	45	-0.93	0	47	0.00	0	51	0.16	0	55	0.00	
19200	0	22	-0.93	0	23	0.00	0	25	0.16	0	27	0.00	
31250	0	13	0.00	0	14	-1.70	0	15	0.00	0	16	1.20	
38400	_	_	_	0	11	0.00	0	12	0.16	0	13	0.00	

 Table 15.3
 BRR Settings for Various Bit Rates (Asynchronous Mode) (cont)

		ø = 18 MHz				ø = 19.6608 MHz			ø = 20 MHz		
Bit Rate (bits/s)	n	N	Error (%)	n	N	Error (%)	n	N	Error (%)		
110	3	79	-0.12	3	86	0.31	3	88	-0.25		
150	2	233	0.16	2	255	0.00	3	64	0.16		
300	2	116	0.16	2	127	0.00	2	129	0.16		
600	1	233	0.16	1	255	0.00	2	64	0.16		
1200	1	116	0.16	1	127	0.00	1	129	0.16		
2400	0	233	0.16	0	255	0.00	1	64	0.16		
4800	0	116	0.16	0	127	0.00	0	129	0.16		
9600	0	58	-0.69	0	63	0.00	0	64	0.16		
19200	0	28	1.02	0	31	0.00	0	32	-1.36		
31250	0	17	0.00	0	19	-1.70	0	19	0.00		
38400	0	14	-2.34	0	15	0.00	0	15	1.73		
	-		-	-	-		-	-			

	Operating Frequency Ø (MHZ)											
Bit Rate	Ø	ø = 2 MHz		ø = 4 MHz		= 8 MHz	ø	= 10 MHz	ø	= 16 MHz	ø	= 20 MHz
(bits/s)	n	Ν	n	Ν	n	Ν	n	Ν	n	Ν	n	Ν
110	3	70	_	_								
250	2	124	2	249	3	124	—	_	3	249		
500	1	249	2	124	2	249	—	_	3	124	—	_
1 k	1	124	1	249	2	124	_	_	2	249	_	_
2.5 k	0	199	1	99	1	199	1	249	2	99	2	124
5 k	0	99	0	199	1	99	1	124	1	199	1	249
10 k	0	49	0	99	0	199	0	249	1	99	1	124
25 k	0	19	0	39	0	79	0	99	0	159	0	199
50 k	0	9	0	19	0	39	0	49	0	79	0	99
100 k	0	4	0	9	0	19	0	24	0	39	0	49
250 k	0	1	0	3	0	7	0	9	0	15	0	19
500 k	0	0*	0	1	0	3	0	4	0	7	0	9
1 M			0	0*	0	1			0	3	0	4
2.5 M							0	0*			0	1
5 M											0	0*

 Table 15.4
 BRR Settings for Various Bit Rates (Synchronous Mode)

Note: As far as possible, the setting should be made so that the error is no more than 1%.

Legend:

Blank: Cannot be set.

- —: Can be set, but there will be a degree of error.
- *: Continuous transfer is not possible.

The BRR setting is found from the following equations.

Asynchronous mode:

$$\mathsf{N} = \frac{\phi}{64 \times 2^{2\mathsf{n}-1} \times \mathsf{B}} \times 10^6 - 1$$

Synchronous mode:

$$\mathsf{N} = \frac{\phi}{8 \times 2^{2\mathsf{n}-1} \times \mathsf{B}} \times 10^6 - 1$$

Where B: Bit rate (bits/s)

- N: BRR setting for baud rate generator ($0 \le N \le 255$)
- ø: Operating frequency (MHz)
- n: Baud rate generator input clock (n = 0 to 3)(See the table below for the relation between n and the clock.)

		SMR Setting					
n	Clock	CKS1	CKS0				
0	Ø	0	0				
1	ø/4	0	1				
2	ø/16	1	0				
3	ø/64	1	1				

The bit rate error in asynchronous mode is found from the following equation:

Error (%) =
$$\left\{ \frac{\phi \times 10^6}{(N+1) \times B \times 64 \times 2^{2n-1}} - 1 \right\} \times 100$$

Table 15.5 shows the maximum bit rate for each frequency in asynchronous mode. Tables 15.6 and 15.7 show the maximum bit rates with external clock input.

ø (MHz)	Maximum Bit Rate (bits/s)	n	Ν	
2	62500	0	0	
2.097152	65536	0	0	
2.4576	76800	0	0	
3	93750	0	0	
3.6864	115200	0	0	
4	125000	0	0	
4.9152	153600	0	0	
5	156250	0	0	
6	187500	0	0	
6.144	192000	0	0	
7.3728	230400	0	0	
8	250000	0	0	
9.8304	307200	0	0	
10	312500	0	0	
12	375000	0	0	
12.288	384000	0	0	
14	437500	0	0	
14.7456	460800	0	0	
16	500000	0	0	
17.2032	537600	0	0	
18	562500	0	0	
19.6608	614400	0	0	
20	625000	0	0	

 Table 15.5
 Maximum Bit Rate for Each Frequency (Asynchronous Mode)

ø (MHz)	External Input Clock (MHz)	Maximum Bit Rate (bits/s)			
2	0.5000	31250			
2.097152	0.5243	32768			
2.4576	0.6144	38400			
3	0.7500	46875			
3.6864	0.9216	57600			
4	1.0000	62500			
4.9152	1.2288	76800			
5	1.2500	78125			
6	1.5000	93750			
6.144	1.5360	96000			
7.3728	1.8432	115200			
8	2.0000	125000			
9.8304	2.4576	153600			
10	2.5000	156250			
12	3.0000	187500			
12.288	3.0720	192000			
14	3.5000	218750			
14.7456	3.6864	230400			
16	4.0000	250000			
17.2032	4.3008	268800			
18	4.5000	281250			
19.6608	4.9152	307200			
20	5.0000	312500			

 Table 15.6
 Maximum Bit Rate with External Clock Input (Asynchronous Mode)

ø (MHz)	External Input Clock (MHz)	Maximum Bit Rate (bits/s)
2	0.3333	333333.3
4	0.6667	666666.7
6	1.0000	100000.0
8	1.3333	133333.3
10	1.6667	1666666.7
12	2.0000	2000000.0
14	2.3333	2333333.3
16	2.6667	2666666.7
18	3.0000	300000.0
20	3.3333	3333333.3

 Table 15.7
 Maximum Bit Rate with External Clock Input (Synchronous Mode)

15.2.9 Serial Interface Mode Register (SCMR)

Bit	7	6	5	4	3	2	1	0
	—	_	—		SDIR	SINV	—	SMIF
Initial value	1	1	1	1	0	0	1	0
Read/Write	—	—	—	—	R/W	R/W	—	R/W

SCMR is an 8-bit readable/writable register used to select SCI functions.

SCMR is initialized to H'F2 by a reset, and in standby mode, watch mode, subactive mode, subsleep mode, and module stop mode.

Bits 7 to 4—Reserved: These bits cannot be modified and are always read as 1.

Bit 3—Data Transfer Direction (SDIR): Selects the serial/parallel conversion format.

Bit 3

SDIR	Description	
0	TDR contents are transmitted LSB-first	(Initial value)
	Receive data is stored in RDR LSB-first	
1	TDR contents are transmitted MSB-first	
	Receive data is stored in RDR MSB-first	

Bit 2—Data Invert (SINV): Specifies inversion of the data logic level. The SINV bit does not affect the logic level of the parity bit(s): parity bit inversion requires inversion of the O/\overline{E} bit in SMR.

Bit 2

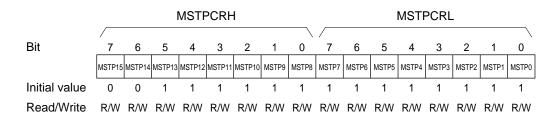
SINV	Description	
0	TDR contents are transmitted without modification	(Initial value)
	Receive data is stored in RDR without modification	
1	TDR contents are inverted before being transmitted	
	Receive data is stored in RDR in inverted form	

Bit 1—Reserved: This bit cannot be modified and is always read as 1.

Bit 0—Serial Communication Interface Mode Select (SMIF): Reserved bit. 1 should not be written in this bit.

Bit 0		
SMIF	Description	
0	Normal SCI mode	(Initial value)
1	Reserved mode	

15.2.10 Module Stop Control Register (MSTPCR)



MSTPCR, comprising two 8-bit readable/writable registers, performs module stop mode control. When bit MSTP7, MSTP6, or MSTP5 is set to 1, SCI0, SCI1, or SCI2 operation, respectively, stops at the end of the bus cycle and a transition is made to module stop mode. For details, see section 23.5, Module Stop Mode.

MSTPCR is initialized to H'3FFF by a reset and in hardware standby mode. It is not initialized in software standby mode.

Bit 7—Module Stop (MSTP7): Specifies the SCI0 module stop mode.

MSTPCRL

Bit 7

MSTP7	Description	
0	SCI0 module stop mode is cleared	
1	SCI0 module stop mode is set	(Initial value)

Bit 6—Module Stop (MSTP6): Specifies the SCI1 module stop mode.

MSTPCRL

Bit 6

MSTP6	Description	
0	SCI1 module stop mode is cleared	
1	SCI1 module stop mode is set	(Initial value)

Bit 5—Module Stop (MSTP5): Specifies the SCI2 module stop mode.

MSTPCRL

Bit 5

MSTP5	Description	
0	SCI2 module stop mode is cleared	
1	SCI2 module stop mode is set	(Initial value)

15.2.11 Keyboard Comparator Control Register (KBCOMP)

Bit	7	6	5	4	3	2	1	0
	lrE	IrCKS2	lrCKS1	IrCKS0	KBADE	KBCH2	KBCH1	KBCH0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

KBCOMP is an 8-bit readable/writable register that selects the functions of SCI2 and the A/D converter.

KBCOMP is initialized to H'00 by a reset and in hardware standby mode.

Bit 7—IrDA Enable (IrE): Specifies normal SCI operation or IrDA operation for SCI2 input/output.

lrE	Description	
0	The TxD2/IrTxD and RxD2/IrRxD pins function as TxD2 and RxD2	(Initial value)
1	The TxD2/IrTxD and RxD2/IrRxD pins function as IrTxD and IrRxD	

Bits 6 to 4—IrDA Clock Select 2 to 0 (IrCKS2 to IrCKS0): These bits specify the high pulse width in IrTxD output pulse encoding when the IrDA function is enabled.

Bit 6	Bit 5	Bit 4		
IrCKS2	IrCKS1	IrCKS0	Description	
0	0	0	$B\times 3/16$ (3/16 of the bit rate)	(Initial value)
		1	ø/2	
	1	0	ø/4	
		1	ø/8	
1	0	0	ø/16	
		1	ø/32	
	1	0	ø/64	
		1	ø/128	

Bits 3 to 0—Keyboard Comparator Control: See the description in section 20, A/D converter.

15.3 Operation

15.3.1 Overview

The SCI can carry out serial communication in two modes: asynchronous mode in which synchronization is achieved character by character, and synchronous mode in which synchronization is achieved with clock pulses.

Selection of asynchronous or synchronous mode and the transmission format is made using SMR as shown in table 15.8. The SCI clock is determined by a combination of the C/\overline{A} bit in SMR and the CKE1 and CKE0 bits in SCR, as shown in table 15.9.

Asynchronous Mode

- Data length: Choice of 7 or 8 bits
- Choice of parity addition, multiprocessor bit addition, and addition of 1 or 2 stop bits (the combination of these parameters determines the transfer format and character length)
- Detection of framing, parity, and overrun errors, and breaks, during reception
- Choice of internal or external clock as SCI clock source
 - When internal clock is selected:

The SCI operates on the baud rate generator clock and a clock with the same frequency as the bit rate can be output

— When external clock is selected:

A clock with a frequency of 16 times the bit rate must be input (the built-in baud rate generator is not used)

Synchronous Mode

- Transfer format: Fixed 8-bit data
- Detection of overrun errors during reception
- Choice of internal or external clock as SCI clock source
 - When internal clock is selected:
 - The SCI operates on the baud rate generator clock and a serial clock is output off-chip
 - When external clock is selected:

The built-in baud rate generator is not used, and the SCI operates on the input serial clock

	5	SMR Sett	tings			SCI Transfer Format				
Bit 7 C/Ā	Bit 6 CHR	Bit 2 MP	Bit 5 PE	Bit 3 STOP	_ _ Mode	Data Length	Multi- processor Bit	Parity Bit	Stop Bit Length	
0 0 <u>1</u>	0	0	0	0	Asynchronous	8-bit data	No	No	1 bit	
				1	mode				2 bits	
			1	0	_	7-bit data		Yes	1 bit	
				1	_				2 bits	
	1		0	0	_				1 bit	
				1	_				2 bits	
			1	0	-			Yes	1 bit	
				1	_				2 bits	
	0	1	_	0	Asynchronous	8-bit data	Yes	No	1 bit	
		1 mode (mul	mode (multi-				2 bits			
	1		_	0	processor _format)	7-bit data			1 bit	
			_	1	_ioimaty				2 bits	
1	_	_	_	_	Synchronous mode	8-bit data	No		None	

Table 15.8 SMR Settings and Serial Transfer Format Selection

 Table 15.9
 SMR and SCR Settings and SCI Clock Source Selection

SMR	SCR Setting			SCI Transfer Clock			
Bit 7	Bit 1	Bit 0	_	Clock			
C/A	CKE1	CKE0	Mode	Source	SCK Pin Function		
0	0	0	Asynchronous	Internal	SCI does not use SCK pin		
		1	mode		Outputs clock with same frequency as bit rate		
	1	0	_	External	Inputs clock with frequency of 16 times		
		1	_		the bit rate		
1	0	0	Synchronous	Internal	Outputs serial clock		
		1	mode				
	1	0	_	External	Inputs serial clock		
		1	_				

15.3.2 Operation in Asynchronous Mode

In asynchronous mode, characters are sent or received, each preceded by a start bit indicating the start of communication and followed by one or two stop bits indicating the end of communication. Serial communication is thus carried out with synchronization established on a character-by-character basis.

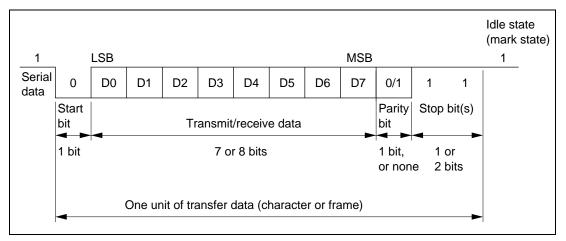
Inside the SCI, the transmitter and receiver are independent units, enabling full-duplex communication. Both the transmitter and the receiver also have a double-buffered structure, so that data can be read or written during transmission or reception, enabling continuous data transfer.

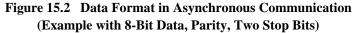
Figure 15.2 shows the general format for asynchronous serial communication.

In asynchronous serial communication, the transmission line is usually held in the mark state (high level). The SCI monitors the transmission line, and when it goes to the space state (low level), recognizes a start bit and starts serial communication.

One serial communication character consists of a start bit (low level), followed by data (in LSB-first order), a parity bit (high or low level), and finally one or two stop bits (high level).

In asynchronous mode, the SCI performs synchronization at the falling edge of the start bit in reception. The SCI samples the data on the 8th pulse of a clock with a frequency of 16 times the length of one bit, so that the transfer data is latched at the center of each bit.





Data Transfer Format: Table 15.10 shows the data transfer formats that can be used in asynchronous mode. Any of 12 transfer formats can be selected by settings in SMR.

	SMR	Setting	gs		Serial Transfer Format and Frame Length		
CHR	PE	MP	STOP	1	2 3 4 5 6 7 8 9 10 11 12		
0	0	0	0	S	8-bit data STOP		
0	0	0	1	S	8-bit data STOP STOP		
0	1	0	0	S	8-bit data P STOP		
0	1	0	1	S	8-bit data P STOP STOP		
1	0	0	0	S	7-bit data STOP		
1	0	0	1	S	7-bit data STOP STOP		
1	1	0	0	S	7-bit data P STOP		
1	1	0	1	S	7-bit data P STOP STOP		
0	_	1	0	S	8-bit data MPB STOP		
0	_	1	1	S	8-bit data MPB STOP STOP		
1	_	1	0	S	7-bit data MPB STOP		
1	_	1	1	S	7-bit data MPB STOP STOP		

 Table 15.10 Serial Transfer Formats (Asynchronous Mode)

Legend:

S: Start bit

STOP: Stop bit

P: Parity bit

MPB: Multiprocessor bit

Clock: Either an internal clock generated by the built-in baud rate generator or an external clock input at the SCK pin can be selected as the SCI's serial clock, according to the setting of the C/\overline{A} bit in SMR and the CKE1 and CKE0 bits in SCR. For details of SCI clock source selection, see table 15.9.

When an external clock is input at the SCK pin, the clock frequency should be 16 times the bit rate used.

When the SCI is operated on an internal clock, the clock can be output from the SCK pin. The frequency of the clock output in this case is equal to the bit rate, and the phase is such that the rising edge of the clock is at the center of each transmit data bit, as shown in figure 15.3.

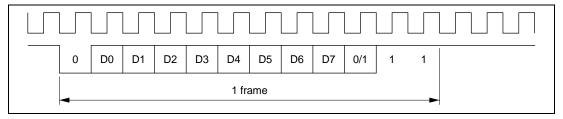


Figure 15.3 Relation between Output Clock and Transfer Data Phase (Asynchronous Mode)

Data Transfer Operations

SCI Initialization (Asynchronous Mode): Before transmitting and receiving data, first clear the TE and RE bits in SCR to 0, then initialize the SCI as described below.

When the operating mode, transfer format, etc., is changed, the TE and RE bits must be cleared to 0 before making the change using the following procedure. When the TE bit is cleared to 0, the TDRE flag is set to 1 and TSR is initialized. Note that clearing the RE bit to 0 does not change the contents of the RDRF, PER, FER, and ORER flags, or the contents of RDR.

When an external clock is used the clock should not be stopped during operation, including initialization, since operation is uncertain.

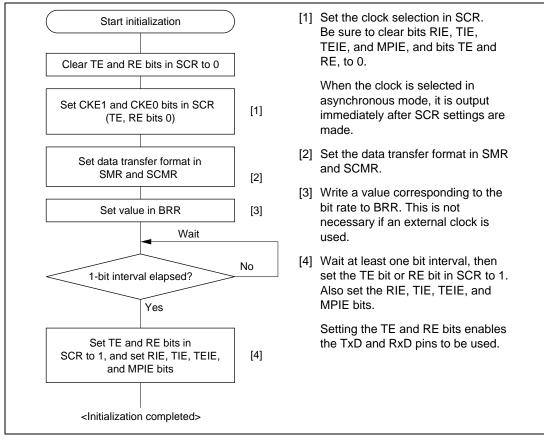


Figure 15.4 shows a sample SCI initialization flowchart.

Figure 15.4 Sample SCI Initialization Flowchart

Serial Data Transmission (Asynchronous Mode): Figure 15.5 shows a sample flowchart for serial transmission.

 Initialization
 [1]
 [1]
 SCI initialization: The TxD pin is automatically designated as the transmit data output pin. After the TE bit is set to 1, one frame of 1s is output and transmission is enabled.

No

No

No

No

[3]

[4]

The following procedure should be used for serial data transmission.

TDRE = 1?

Write transmit data to TDR and clear TDRE flag in SSR to 0

All data transmitted?

Read TEND flag in SSR

TEND = 1?

Break output?

Clear DR to 0 and set DDR to 1

Clear TE bit in SCR to 0

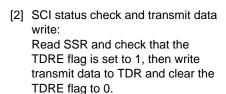
<End>

Yes

Yes

Yes

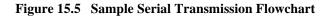
Yes



 [3] Serial transmission continuation procedure: To continue serial transmission,

read 1 from the TDRE flag to confirm that writing is possible, then write data to TDR, and then clear the TDRE flag to 0. Checking and clearing of the TDRE flag is automatic when the DTC is activated by a transmit-data-empty interrupt (TXI) request, and data is written to TDR.

 [4] Break output at the end of serial transmission: To output a break in serial transmission, set DDR for the port corresponding to the TxD pin to 1, clear DR to 0, then clear the TE bit in SCR to 0.



In serial transmission, the SCI operates as described below.

- 1. The SCI monitors the TDRE flag in SSR, and if it is 0, recognizes that data has been written to TDR, and transfers the data from TDR to TSR.
- 2. After transferring data from TDR to TSR, the SCI sets the TDRE flag to 1 and starts transmission.
 - If the TIE bit is set to 1 at this time, a transmit data empty interrupt (TXI) is generated.

The serial transmit data is sent from the TxD pin in the following order.

a. Start bit:

One 0-bit is output.

b. Transmit data:

8-bit or 7-bit data is output in LSB-first order.

c. Parity bit or multiprocessor bit:

One parity bit (even or odd parity), or one multiprocessor bit is output. A format in which neither a parity bit nor a multiprocessor bit is output can also be selected.

d. Stop bit(s):

One or two 1-bits (stop bits) are output.

e. Mark state:

1 is output continuously until the start bit that starts the next transmission is sent.

3. The SCI checks the TDRE flag at the timing for sending the stop bit.

If the TDRE flag is cleared to 0, the data is transferred from TDR to TSR, the stop bit is sent, and then serial transmission of the next frame is started.

If the TDRE flag is set to 1, the TEND flag in SSR is set to 1, the stop bit is sent, and then the mark state is entered in which 1 is output continuously. If the TEIE bit in SCR is set to 1 at this time, a TEI interrupt request is generated.

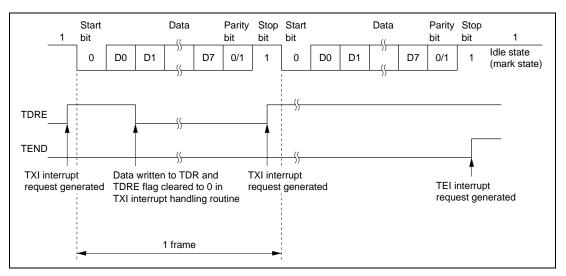


Figure 15.6 shows an example of the operation for transmission in asynchronous mode.

Figure 15.6 Example of Operation in Transmission in Asynchronous Mode (Example with 8-Bit Data, Parity, One Stop Bit)

Serial Data Reception (Asynchronous Mode): Figure 15.7 shows a sample flowchart for serial reception.

The following procedure should be used for serial data reception.

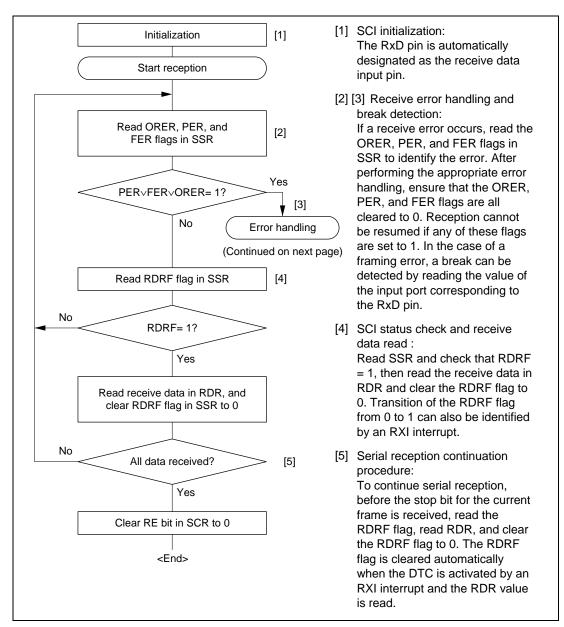
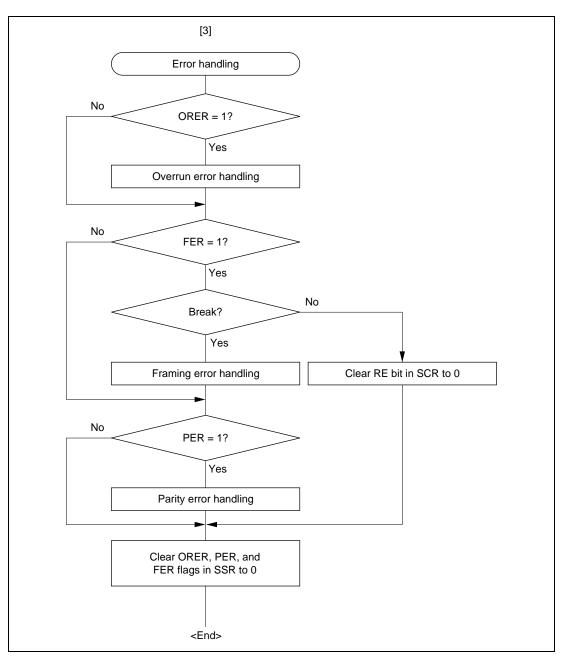


Figure 15.7 Sample Serial Reception Data Flowchart





In serial reception, the SCI operates as described below.

- 1. The SCI monitors the transmission line, and if a 0 stop bit is detected, performs internal synchronization and starts reception.
- 2. The received data is stored in RSR in LSB-to-MSB order.
- 3. The parity bit and stop bit are received.

After receiving these bits, the SCI carries out the following checks.

a. Parity check:

The SCI checks whether the number of 1 bits in the receive data agrees with the parity (even or odd) set in the O/\overline{E} bit in SMR.

b. Stop bit check:

The SCI checks whether the stop bit is 1.

If there are two stop bits, only the first is checked.

c. Status check:

The SCI checks whether the RDRF flag is 0, indicating that the receive data can be transferred from RSR to RDR.

If all the above checks are passed, the RDRF flag is set to 1, and the receive data is stored in RDR.

If a receive error* is detected in the error check, the operation is as shown in table 15.11.

- Note: * Subsequent receive operations cannot be performed when a receive error has occurred. Also note that the RDRF flag is not set to 1 in reception, and so the error flags must be cleared to 0.
- 4. If the RIE bit in SCR is set to 1 when the RDRF flag changes to 1, a receive-data-full interrupt (RXI) request is generated.

Also, if the RIE bit in SCR is set to 1 when the ORER, PER, or FER flag changes to 1, a receive-error interrupt (ERI) request is generated.

Receive Error	Abbreviation	Occurrence Condition	Data Transfer
Overrun error	ORER	When the next data reception is completed while the RDRF flag in SSR is set to 1	Receive data is not transferred from RSR to RDR
Framing error	FER	When the stop bit is 0	Receive data is transferred from RSR to RDR
Parity error	PER	When the received data differs from the parity (even or odd) set in SMR	Receive data is transferred from RSR to RDR

Table 15.11 Receive Errors and Conditions for Occurrence

Figure 15.8 shows an example of the operation for reception in asynchronous mode.

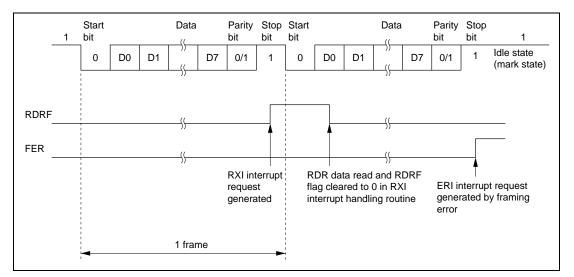


Figure 15.8 Example of SCI Operation in Reception (Example with 8-Bit Data, Parity, One Stop Bit)

15.3.3 Multiprocessor Communication Function

The multiprocessor communication function performs serial communication using a multiprocessor format, in which a multiprocessor bit is added to the transfer data, in asynchronous mode. Use of this function enables data transfer to be performed among a number of processors sharing transmission lines.

When multiprocessor communication is carried out, each receiving station is addressed by a unique ID code.

The serial communication cycle consists of two component cycles: an ID transmission cycle which specifies the receiving station, and a data transmission cycle. The multiprocessor bit is used to differentiate between the ID transmission cycle and the data transmission cycle.

The transmitting station first sends the ID of the receiving station with which it wants to perform serial communication as data with a 1 multiprocessor bit added. It then sends transmit data as data with a 0 multiprocessor bit added.

The receiving station skips the data until data with a 1 multiprocessor bit is sent.

When data with a 1 multiprocessor bit is received, the receiving station compares that data with its own ID. The station whose ID matches then receives the data sent next. Stations whose ID does not match continue to skip the data until data with a 1 multiprocessor bit is again received. In this way, data communication is carried out among a number of processors.

Figure 15.9 shows an example of inter-processor communication using a multiprocessor format.

Data Transfer Format: There are four data transfer formats.

When a multiprocessor format is specified, the parity bit specification is invalid.

For details, see table 15.10.

Clock: See the section on asynchronous mode.

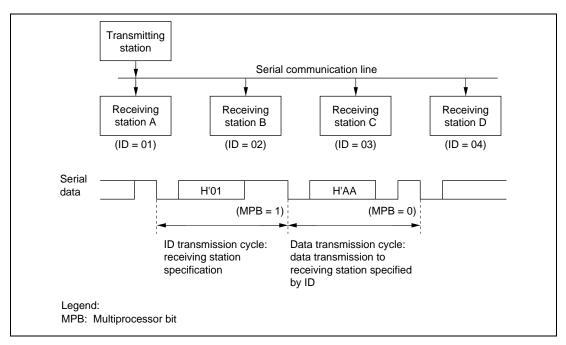
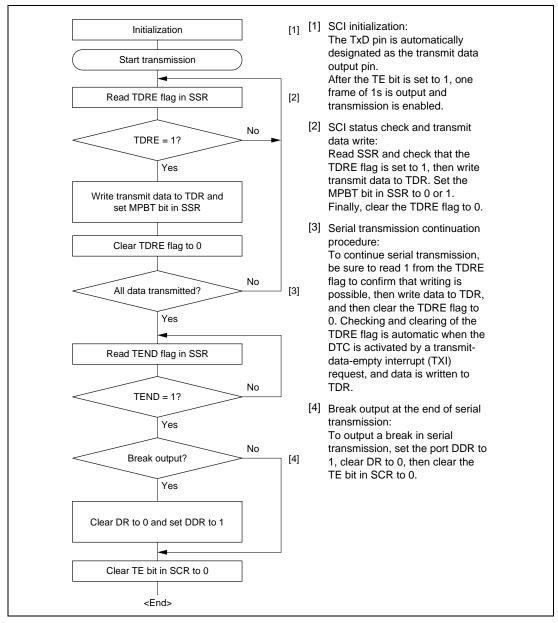


Figure 15.9 Example of Inter-Processor Communication Using Multiprocessor Format (Transmission of Data H'AA to Receiving Station A)

Data Transfer Operations

Multiprocessor Serial Data Transmission: Figure 15.10 shows a sample flowchart for multiprocessor serial data transmission.

The following procedure should be used for multiprocessor serial data transmission.





In serial transmission, the SCI operates as described below.

- 1. The SCI monitors the TDRE flag in SSR, and if it is 0, recognizes that data has been written to TDR, and transfers the data from TDR to TSR.
- 2. After transferring data from TDR to TSR, the SCI sets the TDRE flag to 1 and starts transmission.
 - If the TIE bit is set to 1 at this time, a transmit-data-empty interrupt (TXI) is generated.

The serial transmit data is sent from the TxD pin in the following order.

a. Start bit:

One 0-bit is output.

b. Transmit data:

8-bit or 7-bit data is output in LSB-first order.

c. Multiprocessor bit

One multiprocessor bit (MPBT value) is output.

d. Stop bit(s):

One or two 1-bits (stop bits) are output.

e. Mark state:

1 is output continuously until the start bit that starts the next transmission is sent.

3. The SCI checks the TDRE flag at the timing for sending the stop bit.

If the TDRE flag is cleared to 0, data is transferred from TDR to TSR, the stop bit is sent, and then serial transmission of the next frame is started.

If the TDRE flag is set to 1, the TEND flag in SSR is set to 1, the stop bit is sent, and then the mark state is entered in which 1 is output continuously. If the TEIE bit in SCR is set to 1 at this time, a transmit-end interrupt (TEI) request is generated.

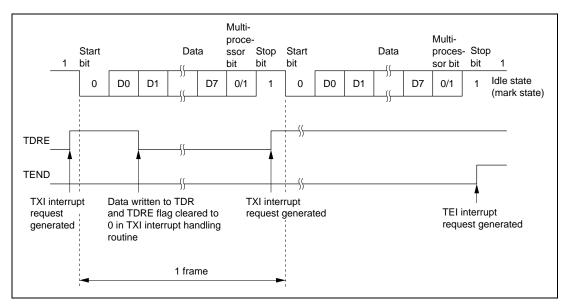
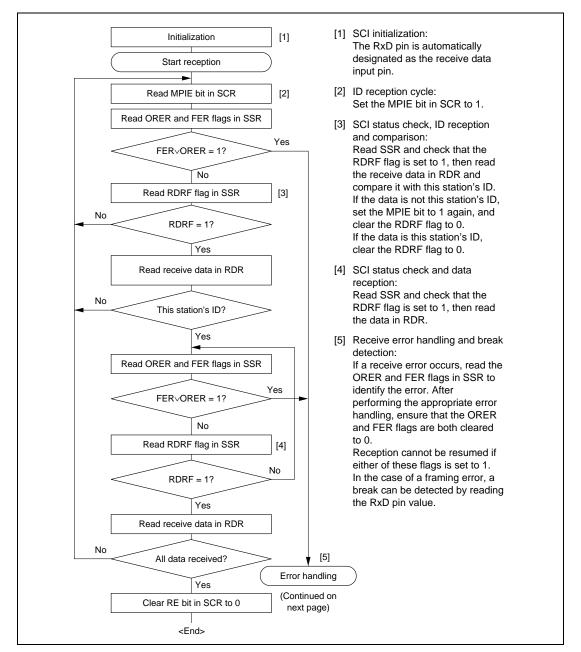


Figure 15.11 shows an example of SCI operation for transmission using a multiprocessor format.

Figure 15.11 Example of SCI Operation in Transmission (Example with 8-Bit Data, Multiprocessor Bit, One Stop Bit)

Multiprocessor Serial Data Reception: Figure 15.12 shows a sample flowchart for multiprocessor serial reception.



The following procedure should be used for multiprocessor serial data reception.

Figure 15.12 Sample Multiprocessor Serial Reception Flowchart

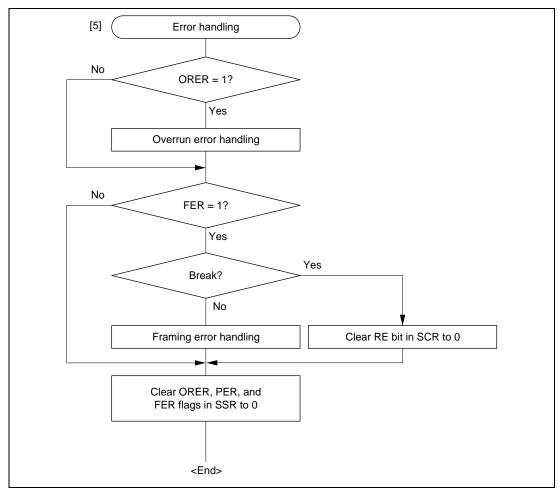


Figure 15.12 Sample Multiprocessor Serial Reception Flowchart (cont)

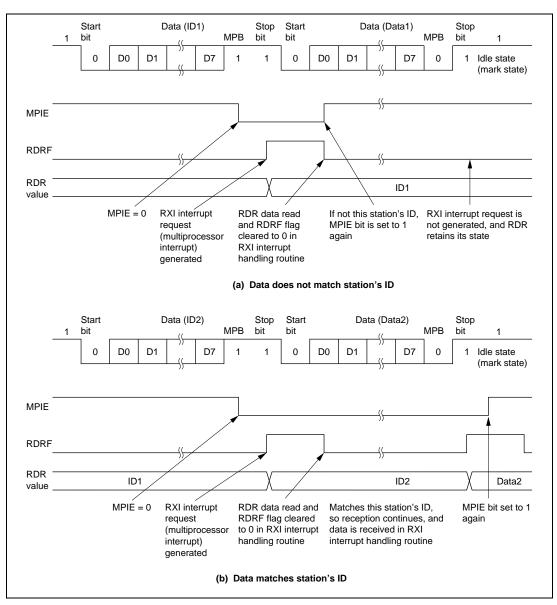


Figure 15.13 shows an example of SCI operation for multiprocessor format reception.

Figure 15.13 Example of SCI Operation in Reception (Example with 8-Bit Data, Multiprocessor Bit, One Stop Bit)

15.3.4 Operation in Synchronous Mode

In synchronous mode, data is transmitted or received in synchronization with clock pulses, making it suitable for high-speed serial communication.

Inside the SCI, the transmitter and receiver are independent units, enabling full-duplex communication by use of a common clock. Both the transmitter and the receiver also have a double-buffered structure, so that data can be read or written during transmission or reception, enabling continuous data transfer.

Figure 15.14 shows the general format for synchronous serial communication.

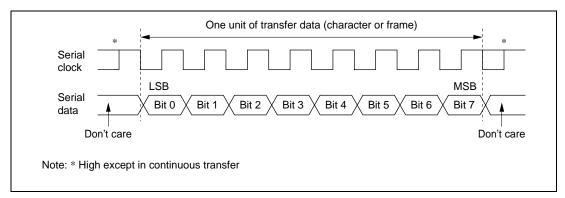


Figure 15.14 Data Format in Synchronous Communication

In synchronous serial communication, data on the transmission line is output from one falling edge of the serial clock to the next. Data is guaranteed valid at the rising edge of the serial clock.

In synchronous serial communication, one character consists of data output starting with the LSB and ending with the MSB. After the MSB is output, the transmission line holds the MSB state.

In synchronous mode, the SCI receives data in synchronization with the rising edge of the serial clock.

Data Transfer Format: A fixed 8-bit data format is used.

No parity or multiprocessor bits are added.

Clock: Either an internal clock generated by the built-in baud rate generator or an external serial clock input at the SCK pin can be selected, according to the setting of the C/\overline{A} bit in SMR and the CKE1 and CKE0 bits in SCR. For details on SCI clock source selection, see table 15.9.

When the SCI is operated on an internal clock, the serial clock is output from the SCK pin.

Eight serial clock pulses are output in the transfer of one character, and when no transfer is performed the clock is fixed high. When only receive operations are performed, however, the serial clock is output until an overrun error occurs or the RE bit is cleared to 0. To perform receive operations in units of one character, select an external clock as the clock source.

Data Transfer Operations

SCI Initialization (Synchronous Mode): Before transmitting and receiving data, first clear the TE and RE bits in SCR to 0, then initialize the SCI as described below.

When the operating mode, transfer format, etc., is changed, the TE and RE bits must be cleared to 0 before making the change using the following procedure. When the TE bit is cleared to 0, the TDRE flag is set to 1 and TSR is initialized. Note that clearing the RE bit to 0 does not change the settings of the RDRF, PER, FER, and ORER flags, or the contents of RDR.

Figure 15.15 shows a sample SCI initialization flowchart.

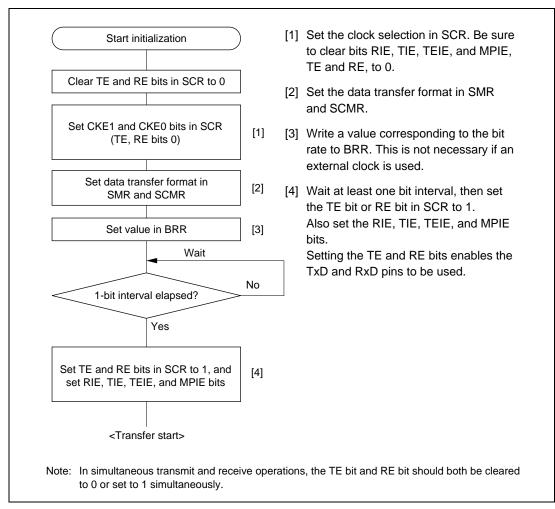
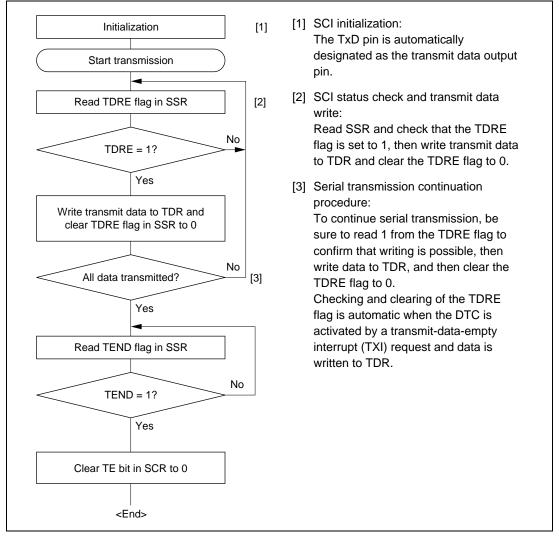


Figure 15.15 Sample SCI Initialization Flowchart

Serial Data Transmission (Synchronous Mode): Figure 15.16 shows a sample flowchart for serial transmission.



The following procedure should be used for serial data transmission.

Figure 15.16 Sample Serial Transmission Flowchart

In serial transmission, the SCI operates as described below.

- 1. The SCI monitors the TDRE flag in SSR, and if it is 0, recognizes that data has been written to TDR, and transfers the data from TDR to TSR.
- 2. After transferring data from TDR to TSR, the SCI sets the TDRE flag to 1 and starts transmission. If the TIE bit is set to 1 at this time, a transmit-data-empty interrupt (TXI) is generated.

When clock output mode has been set, the SCI outputs 8 serial clock pulses. When use of an external clock has been specified, data is output synchronized with the input clock. The serial transmit data is sent from the TxD pin starting with the LSB (bit 0) and ending with the MSB (bit 7).

3. The SCI checks the TDRE flag at the timing for sending the MSB (bit 7).

If the TDRE flag is cleared to 0, data is transferred from TDR to TSR, and serial transmission of the next frame is started.

If the TDRE flag is set to 1, the TEND flag in SSR is set to 1, the MSB (bit 7) is sent, and the TxD pin maintains its state.

If the TEIE bit in SCR is set to 1 at this time, a transmit-end interrupt (TEI) request is generated.

4. After completion of serial transmission, the SCK pin is held in a constant state.

Figure 15.17 shows an example of SCI operation in transmission.

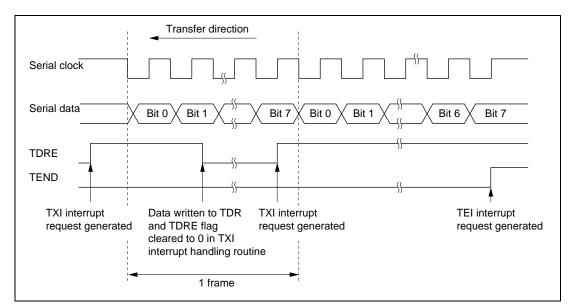


Figure 15.17 Example of SCI Operation in Transmission

Serial Data Reception (Synchronous Mode): Figure 15.18 shows a sample flowchart for serial reception.

The following procedure should be used for serial data reception.

When changing the operating mode from asynchronous to synchronous, be sure to check that the ORER, PER, and FER flags are all cleared to 0.

The RDRF flag will not be set if the FER or PER flag is set to 1, and neither transmit nor receive operations will be possible.

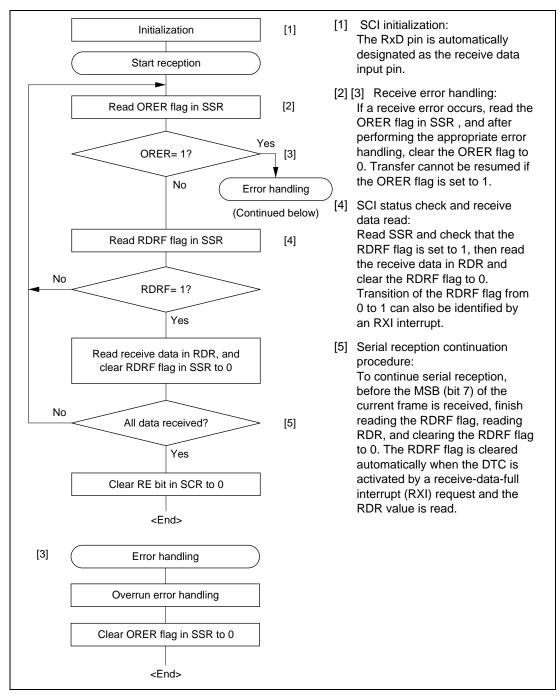


Figure 15.18 Sample Serial Reception Flowchart

In serial reception, the SCI operates as described below.

- 1. The SCI performs internal initialization in synchronization with serial clock input or output.
- 2. The received data is stored in RSR in LSB-to-MSB order.

After reception, the SCI checks whether the RDRF flag is 0 and the receive data can be transferred from RSR to RDR.

If this check is passed, the RDRF flag is set to 1, and the receive data is stored in RDR. If a receive error is detected in the error check, the operation is as shown in table 15.11. Neither transmit nor receive operations can be performed subsequently when a receive error

has been found in the error check.

3. If the RIE bit in SCR is set to 1 when the RDRF flag changes to 1, a receive-data-full interrupt (RXI) request is generated.

Also, if the RIE bit in SCR is set to 1 when the ORER flag changes to 1, a receive-error interrupt (ERI) request is generated.

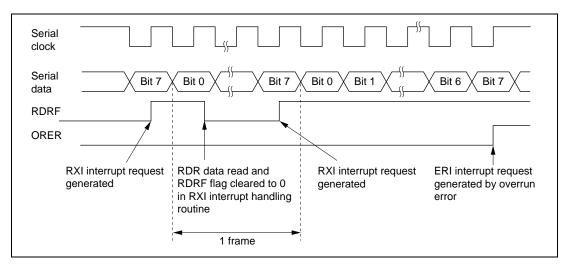


Figure 15.19 shows an example of SCI operation in reception.

Figure 15.19 Example of SCI Operation in Reception

Simultaneous Serial Data Transmission and Reception (Synchronous Mode): Figure 15.20 shows a sample flowchart for simultaneous serial transmit and receive operations.

The following procedure should be used for simultaneous serial data transmit and receive operations.

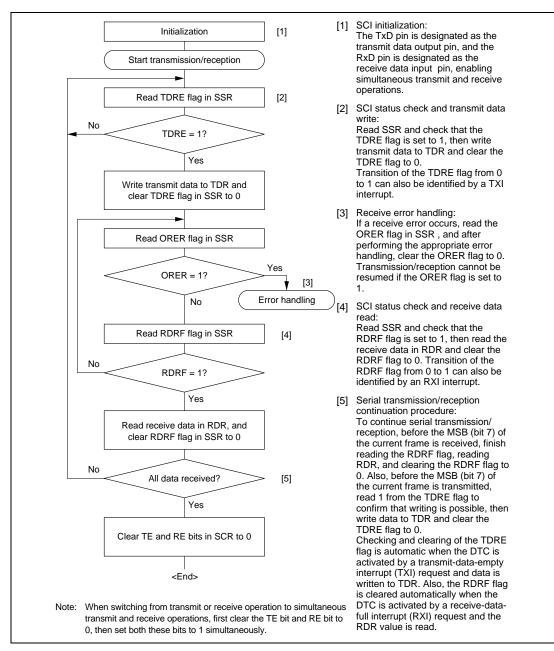


Figure 15.20 Sample Flowchart of Simultaneous Serial Transmit and Receive Operations

15.3.5 IrDA Operation

Figure 15.21 shows a block diagram of the IrDA function.

When the IrDA function is enabled with bit IrE in KBCOMP, the SCI channel 2 TxD2 and RxD2 signals are subjected to waveform encoding/decoding conforming to IrDA specification version 1.0 (IrTxD and IrRxD pins). By connecting these pins to an infrared transceiver/receiver, it is possible to implement infrared transmission/reception conforming to the IrDA specification version 1.0 system.

In the IrDA specification version 1.0 system, communication is started at a transfer rate of 9600 bps, and subsequently the transfer rate can be varied as necessary. As the IrDA interface in the H8S/2138 Series and H8S/2134 Series does not include a function for varying the transfer rate automatically, the transfer rate setting must be changed by software.

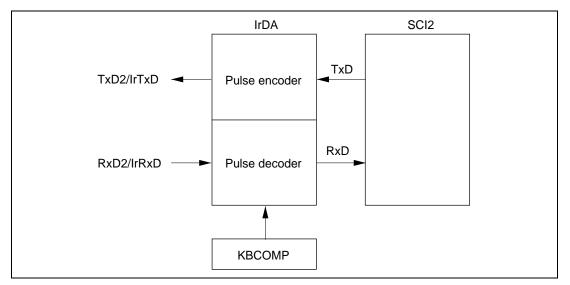


Figure 15.21 Block Diagram of IrDA Function

Transmission: In transmission, the output signal (UART frame) from the SCI is converted to an IR frame by the IrDA interface (see figure 15.22).

When the serial data is 0, a high-level pulses of 3/16 the bit rate (interval equivalent to the width of one bit) is output (initial value). The high-level pulse can be varied according to the setting of bits IrCKS2 to IrCKS0 in KBCOMP.

The high-level pulse width is fixed at a minimum of $1.41 \,\mu$ s, and a maximum of $(3/16 + 2.5\%) \times$ bit rate or $(3/16 \times \text{bit rate}) + 1.08 \,\mu$ s. When system clock ø is 20 MHz, 1.6 μ s can be set as the minimum high-level pulse width at 1.41 μ s or above.

When the serial data is 1, no pulse is output.

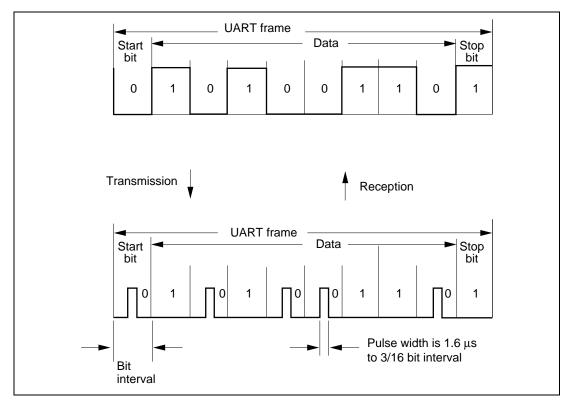


Figure 15.22 IrDA Transmit/Receive Operations

Reception: In reception, IR frame data is converted to a UART frame by the IrDA interface, and input to the SCI.

When a high-level pulse is detected, 0 data is output, and if there is no pulse during a one-bit interval, 1 data is output. Note that a pulse shorter than the minimum pulse width of $1.41 \,\mu s$ will be identified as a 0 signal.

High-Level Pulse Width Selection: Table 15.12 shows possible settings for bits IrCKS2 to IrCKS0 (minimum pulse width), and H8S/2138 Series and H8S/2134 Series operating frequencies and bit rates, for making the pulse width shorter than 3/16 times the bit rate in transmission.

Operating Frequency	2400	9600	19200	38400	57600	115200
ø (MHz)	78.13	19.53	9.77	4.88	3.26	1.63
2	010	010	010	010	010	_
2.097152	010	010	010	010	010	_
2.4576	010	010	010	010	010	_
3	011	011	011	011	011	_
3.6864	011	011	011	011	011	011
4.9152	011	011	011	011	011	011
5	011	011	011	011	011	011
6	100	100	100	100	100	100
6.144	100	100	100	100	100	100
7.3728	100	100	100	100	100	100
8	100	100	100	100	100	100
9.8304	100	100	100	100	100	100
10	100	100	100	100	100	100
12	101	101	101	101	101	101
12.288	101	101	101	101	101	101
14	101	101	101	101	101	101
14.7456	101	101	101	101	101	101
16	101	101	101	101	101	101
16.9344	101	101	101	101	101	101
17.2032	101	101	101	101	101	101
18	101	101	101	101	101	101
19.6608	101	101	101	101	101	101
20	101	101	101	101	101	101

Table 15.12 Bit IrCKS2 to IrCKS0 Settings

Legend:

—: An SCI bit rate setting cannot be mode.

15.4 SCI Interrupts

The SCI has four interrupt sources: the transmit-end interrupt (TEI) request, receive-error interrupt (ERI) request, receive-data-full interrupt (RXI) request, and transmit-data-empty interrupt (TXI) request. Table 15.13 shows the interrupt sources and their relative priorities. Individual interrupt sources can be enabled or disabled with the TIE, RIE, and TEIE bits in SCR. Each kind of interrupt request is sent to the interrupt controller independently.

When the TDRE flag in SSR is set to 1, a TXI interrupt request is generated. When the TEND flag in SSR is set to 1, a TEI interrupt request is generated. A TXI interrupt can activate the DTC to perform data transfer. The TDRE flag is cleared to 0 automatically when data transfer is performed by the DTC. The DTC cannot be activated by a TEI interrupt request.

When the RDRF flag in SSR is set to 1, an RXI interrupt request is generated. When the ORER, PER, or FER flag in SSR is set to 1, an ERI interrupt request is generated. An RXI interrupt can activate the DTC to perform data transfer. The RDRF flag is cleared to 0 automatically when data transfer is performed by the DTC. The DTC cannot be activated by an ERI interrupt request.

Interrupt	t		
Source	Description	DTC Activation	Priority*
ERI	Receive error (ORER, FER, or PER)	Not possible	High
RXI	Receive data register full (RDRF)	Possible	
TXI	Transmit data register empty (TDRE)	Possible	
TEI	Transmit end (TEND)	Not possible	
ERI	Receive error (ORER, PER, or PER)	Not possible	
RXI	Receive data register full (RDRF)	Possible	
TXI	Transmit data register empty (TDRE)	Possible	
TEI	Transmit end (TEND)	Not possible	
ERI	Receive error (ORER, PER, or PER)	Not possible	
RXI	Receive data register full (RDRF)	Possible	
TXI	Transmit data register empty (TDRE)	Possible	
TEI	Transmit end (TEND)	Not possible	Low
	Source ERI RXI TXI TEI ERI RXI TEI ERI RXI TEI ERI RXI TXI	ERIReceive error (ORER, FER, or PER)RXIReceive data register full (RDRF)TXITransmit data register empty (TDRE)TEITransmit end (TEND)ERIReceive error (ORER, PER, or PER)RXIReceive data register full (RDRF)TXITransmit end (TEND)ERIReceive data register full (RDRF)TXITransmit data register empty (TDRE)TEITransmit end (TEND)ERIReceive error (ORER, PER, or PER)RXIReceive data register full (RDRF)TXITransmit data register full (RDRF)TXITransmit data register full (RDRF)TXITransmit data register full (RDRF)TXITransmit data register empty (TDRE)	SourceDescriptionDTC ActivationERIReceive error (ORER, FER, or PER)Not possibleRXIReceive data register full (RDRF)PossibleTXITransmit data register empty (TDRE)PossibleTEITransmit end (TEND)Not possibleERIReceive error (ORER, PER, or PER)Not possibleRXIReceive data register full (RDRF)PossibleTXITransmit data register full (RDRF)PossibleTXITransmit data register full (RDRF)PossibleTXITransmit data register empty (TDRE)PossibleERIReceive error (ORER, PER, or PER)Not possibleERIReceive error (ORER, PER, or PER)Not possibleERIReceive error (ORER, PER, or PER)Not possibleEXIReceive data register full (RDRF)PossibleTXITransmit data register full (RDRF)PossibleTXITransmit data register full (RDRF)PossibleTXITransmit data register full (RDRF)Possible

Table 15.13 SCI Interrupt Sources

Note: *The table shows the initial state immediately after a reset. Relative channel priorities can be changed by the interrupt controller.

The TEI interrupt is requested when the TEND flag is set to 1 while the TEIE bit is set to 1. The TEND flag is cleared at the same time as the TDRE flag. Consequently, if a TEI interrupt and a TXI interrupt are requested simultaneously, the TXI interrupt will have priority for acceptance, and the TDRE flag and TEND flag may be cleared. Note that the TEI interrupt will not be accepted in this case.

15.5 Usage Notes

The following points should be noted when using the SCI.

Relation between Writes to TDR and the TDRE Flag

The TDRE flag in SSR is a status flag that indicates that transmit data has been transferred from TDR to TSR. When the SCI transfers data from TDR to TSR, the TDRE flag is set to 1.

Data can be written to TDR regardless of the state of the TDRE flag. However, if new data is written to TDR when the TDRE flag is cleared to 0, the data stored in TDR will be lost since it has not yet been transferred to TSR. It is therefore essential to check that the TDRE flag is set to 1 before writing transmit data to TDR.

Operation when Multiple Receive Errors Occur Simultaneously

If a number of receive errors occur at the same time, the state of the status flags in SSR is as shown in table 15.14. If there is an overrun error, data is not transferred from RSR to RDR, and the receive data is lost.

	SSR St	atus Flags Receive Data		Receive Data Transfer	nsfer		
RDRF	ORER	FER	PER	RSR to RDR	Receive Errors		
1	1	0	0	Х	Overrun error		
0	0	1	0	0	Framing error		
0	0	0	1	0	Parity error		
1	1	1	0	Х	Overrun error + framing error		
1	1	0	1	Х	Overrun error + parity error		
0	0	1	1	0	Framing error + parity error		
1	1	1	1	Х	Overrun error + framing error + parity error		

Table 15.14 State of SSR Status Flags and Transfer of Receive Data

Notes: O: Receive data is transferred from RSR to RDR.

X: Receive data is not transferred from RSR to RDR.

Break Detection and Processing: When a framing error (FER) is detected, a break can be detected by reading the RxD pin value directly. In a break, the input from the RxD pin becomes all 0s, and so the FER flag is set, and the parity error flag (PER) may also be set.

Note that, since the SCI continues the receive operation after receiving a break, even if the FER flag is cleared to 0, it will be set to 1 again.

Sending a Break: The TxD pin has a dual function as an I/O port whose direction (input or output) is determined by DR and DDR. This feature can be used to send a break.

Between serial transmission initialization and setting of the TE bit to 1, the mark state is replaced by the value of DR (the pin does not function as the TxD pin until the TE bit is set to 1). Consequently, DDR and DR for the port corresponding to the TxD pin should first be set to 1.

To send a break during serial transmission, first clear DR to 0, then clear the TE bit to 0.

When the TE bit is cleared to 0, the transmitter is initialized regardless of the current transmission state, the TxD pin becomes an I/O port, and 0 is output from the TxD pin.

Receive Error Flags and Transmit Operations (Synchronous Mode Only):

Transmission cannot be started when a receive error flag (ORER, PER, or FER) is set to 1, even if the TDRE flag is cleared to 0. Be sure to clear the receive error flags to 0 before starting transmission.

Note also that receive error flags cannot be cleared to 0 even if the RE bit is cleared to 0.

Receive Data Sampling Timing and Reception Margin in Asynchronous Mode: In asynchronous mode, the SCI operates on a base clock with a frequency of 16 times the transfer rate.

In reception, the SCI samples the falling edge of the start bit using the base clock, and performs internal synchronization. Receive data is latched internally at the rising edge of the 8th pulse of the base clock. This is illustrated in figure 15.23.

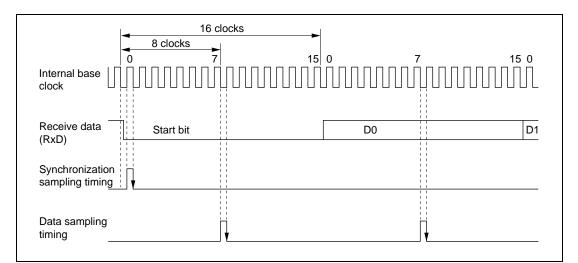


Figure 15.23 Receive Data Sampling Timing in Asynchronous Mode

Thus the receive margin in asynchronous mode is given by equation (1) below.

$$M = \left| \left(0.5 - \frac{1}{2N} \right) - (L - 0.5)F - \frac{|D - 0.5|}{N} (1 + F) \right| \times 100\%$$
(1)

Where M: Receive margin (%)

- N: Ratio of bit rate to clock (N = 16)
- D: Clock duty (D = 0 to 1.0)
- L: Frame length (L = 9 to 12)
- F: Absolute value of clock rate deviation

Assuming values of F = 0 and D = 0.5 in equation (1), a receive margin of 46.875% is given by equation (2) below.

When D = 0.5 and F = 0,

However, this is only a theoretical value, and a margin of 20% to 30% should be allowed in system design.

Restrictions on Use of DTC

- When an external clock source is used as the serial clock, the transmit clock should not be input until at least 5 ø clock cycles after TDR is updated by the DTC. Misoperation may occur if the transmit clock is input within 4 clock cycles after TDR is updated. (Figure 15.24)
- When RDR is read by the DTC, be sure to set the activation source to the relevant SCI receive-data-full interrupt (RXI).

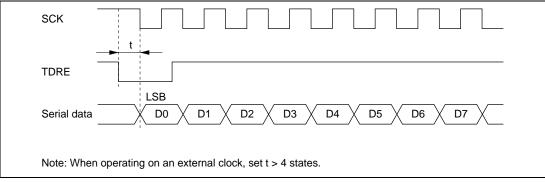


Figure 15.24 Example of Synchronous Transmission by DTC

Section 16 I²C Bus Interface [H8S/2138 Series Option]

A two-channel I^2C bus interface is available as an option in the H8S/2138 Series. The I^2C bus interface is not available for the H8S/2134 Series. Observe the following notes when using this option.

1. For mask-ROM versions, a W is added to the part number in products in which this optional function is used.

Examples: HD6432137WF

2. The product number is identical for F-ZTAT versions. However, be sure to inform your Hitachi sales representative if you will be using this option.

16.1 Overview

A two-channel I^2C bus interface is available for the H8S/2138 Series as an option. The I^2C bus interface conforms to and provides a subset of the Philips I^2C bus (inter-IC bus) interface functions. The register configuration that controls the I^2C bus differs partly from the Philips configuration, however.

Each I^2C bus interface channel uses only one data line (SDA) and one clock line (SCL) to transfer data, saving board and connector space.

16.1.1 Features

- Selection of addressing format or non-addressing format
 - I²C bus format: addressing format with acknowledge bit, for master/slave operation
 - Serial format: non-addressing format without acknowledge bit, for master operation only
- Conforms to Philips I²C bus interface (I²C bus format)
- Two ways of setting slave address (I²C bus format)
- Start and stop conditions generated automatically in master mode (I²C bus format)
- Selection of acknowledge output levels when receiving (I²C bus format)
- Automatic loading of acknowledge bit when transmitting (I²C bus format)
- Wait function in master mode (I²C bus format)

A wait can be inserted by driving the SCL pin low after data transfer, excluding acknowledgement. The wait can be cleared by clearing the interrupt flag.

- Wait function in slave mode (I²C bus format) A wait request can be generated by driving the SCL pin low after data transfer, excluding acknowledgement. The wait request is cleared when the next transfer becomes possible.
- Three interrupt sources

- Data transfer end (including transmission mode transition with I²C bus format and address reception after loss of master arbitration)
- Address match: when any slave address matches or the general call address is received in slave receive mode (I²C bus format)
- Stop condition detection
- Selection of 16 internal clocks (in master mode)
- Direct bus drive (with SCL and SDA pins)
 - Two pins—P52/SCL0 and P97/SDA0—(normally NMOS push-pull outputs) function as NMOS open-drain outputs when the bus drive function is selected.
 - Two pins—P86/SCL1 and P42/SDA1—(normally CMOS pins) function as NMOS-only outputs when the bus drive function is selected.
- Automatic switching from formatless mode to I²C bus format (channel 0 only)
 - Formatless operation (no start/stop conditions, non-addressing mode) in slave mode
 - Operation using a common data pin (SDA) and independent clock pins (VSYNCI, SCL)
 - Automatic switching from formatless mode to I²C bus format on the fall of the SCL pin

16.1.2 Block Diagram

Figure 16.1 shows a block diagram of the I²C bus interface.

Figure 16.2 shows an example of I/O pin connections to external circuits. Channel 0 I/O pins and channel 1 I/O pins differ in structure, and have different specifications for permissible applied voltages. For details, see section 24, Electrical Characteristics.

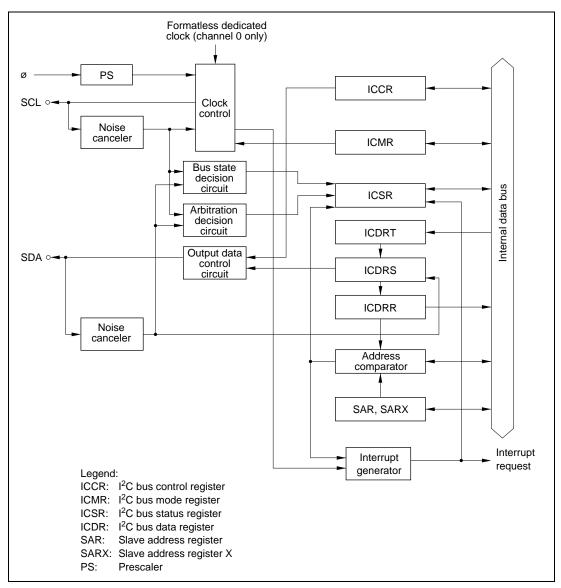


Figure 16.1 Block Diagram of I²C Bus Interface

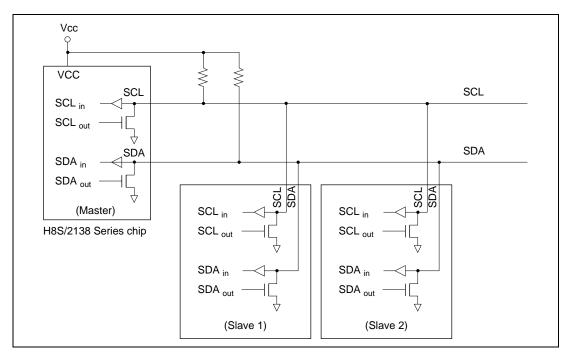


Figure 16.2 I²C Bus Interface Connections (Example: H8S/2138 Series Chip as Master)

16.1.3 Input/Output Pins

Table 16.1 summarizes the input/output pins used by the I²C bus interface.

Table 16.1	I ² C Bus Interfa	ace Pins
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Channel	Name	Abbreviation*	I/O	Function
0	Serial clock	SCL0	I/O	IIC0 serial clock input/output
	Serial data	SDA0	I/O	IIC0 serial data input/output
	Formatless serial clock	VSYNCI	Input	IIC0 formatless serial clock input
1	Serial clock	SCL1	I/O	IIC1 serial clock input/output
_	Serial data	SDA1	I/O	IIC1 serial data input/output

Note: * In the text, the channel subscript is omitted, and only SCL and SDA are used.

16.1.4 Register Configuration

Table 16.2 summarizes the registers of the I^2C bus interface.

Channel	Name	Abbreviation	R/W	Initial Value	Address*1
0	I ² C bus control register	ICCR0	R/W	H'01	H'FFD8
	I ² C bus status register	ICSR0	R/W	H'00	H'FFD9
	I ² C bus data register	ICDR0	R/W	_	H'FFDE* ²
	I ² C bus mode register	ICMR0	R/W	H'00	H'FFDF* ²
	Slave address register	SAR0	R/W	H'00	H'FFDF* ²
	Second slave address register	SARX0	R/W	H'01	H'FFDE* ²
1	I ² C bus control register	ICCR1	R/W	H'01	H'FF88
	I ² C bus status register	ICSR1	R/W	H'00	H'FF89
	I ² C bus data register	ICDR1	R/W	_	H'FF8E* ²
	I ² C bus mode register	ICMR1	R/W	H'00	H'FF8F* ²
	Slave address register	SAR1	R/W	H'00	H'FF8F* ²
	Second slave address register	SARX1	R/W	H'01	H'FF8E* ²
Common	Serial/timer control register	STCR	R/W	H'00	H'FFC3
	DDC switch register	DDCSWR	R/W	H'0F	H'FEE6
	Module stop control register	MSTPCRH	R/W	H'3F	H'FF86
		MSTPCRL	R/W	H'FF	H'FF87

 Table 16.2
 Register Configuration

Notes: 1. Lower 16 bits of the address.

2. The register that can be written or read depends on the ICE bit in the I^2C bus control register. The slave address register can be accessed when ICE = 0, and the I^2C bus mode register can be accessed when ICE = 1.

The I²C bus interface registers are assigned to the same addresses as other registers. Register selection is performed by means of the IICE bit in the serial/timer control register (STCR).

16.2 **Register Descriptions**

16.2.1 I²C Bus Data Register (ICDR)

Bit	7	6	5	4	3	2	1	0
	ICDR7	ICDR6	ICDR5	ICDR4	ICDR3	ICDR2	ICDR1	ICDR0
Initial value					_		_	_
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
• ICDRR								
Bit	7	6	5	4	3	2	1	0
	ICDRR7	ICDRR6	ICDRR5	ICDRR4	ICDRR3	ICDRR2	ICDRR1	ICDRR0
Initial value	_	_			_	_		_
Read/Write	R	R	R	R	R	R	R	R
• ICDRS								
Bit	7	6	5	4	3	2	1	0
	ICDRS7	ICDRS6	ICDRR5	ICDRS4	ICDRS3	ICDRS2	ICDRS1	ICDRS0
Initial value	_						_	
Read/Write	—	—	—	—	—	—	—	—
• ICDRT								
Bit	7	6	5	4	3	2	1	0
	ICDRT7	ICDRT6	ICDRT5	ICDRT4	ICDRT3	ICDRT2	ICDRT1	ICDRT0
Initial value	—	—	—	—	—	—	—	—
Read/Write	W	W	W	W	W	W	W	W
• TDRE, RDR Bit	F (internal	flags)						_
Initial value							TDRE 0	RDRF 0
Read/Write							0	0
Reau/wille								_

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ICDR is an 8-bit readable/writable register that is used as a transmit data register when transmitting and a receive data register when receiving. ICDR is divided internally into a shift register (ICDRS), receive buffer (ICDRR), and transmit buffer (ICDRT). ICDRS cannot be read or written by the CPU, ICDRR is read-only, and ICDRT is write-only. Data transfers among the three registers are performed automatically in coordination with changes in the bus state, and affect the status of internal flags such as TDRE and RDRF.

If IIC is in transmit mode and the next data is in ICDRT (the TDRE flag is 0) following transmission/reception of one frame of data using ICDRS, data is transferred automatically from ICDRT to ICDRS. If IIC is in receive mode and no previous data remains in ICDRR (the RDRF flag is 0) following transmission/reception of one frame of data using ICDRS, data is transferred automatically from ICDRS to ICDRR.

If the number of bits in a frame, excluding the acknowledge bit, is less than 8, transmit data and receive data are stored differently. Transmit data should be written justified toward the MSB side when MLS = 0, and toward the LSB side when MLS = 1. Receive data bits read from the LSB side should be treated as valid when MLS = 0, and bits read from the MSB side when MLS = 1.

ICDR is assigned to the same address as SARX, and can be written and read only when the ICE bit is set to 1 in ICCR.

The value of ICDR is undefined after a reset.

The TDRE and RDRF flags are set and cleared under the conditions shown below. Setting the TDRE and RDRF flags affects the status of the interrupt flags.

TDRE	Description									
0	The next transmit data is in ICDR (ICDRT), or transmission cannot (Initial value) be started									
	[Clearing conditions]									
	 When transmit data is written in ICDR (ICDRT) in transmit mode (TRS = 1) 									
	 When a stop condition is detected in the bus line state after a stop condition is issued with the I²C bus format or serial format selected 									
	 When a stop condition is detected with the I²C bus format selected 									
	 In receive mode (TRS = 0) 									
	(A 0 write to TRS during transfer is valid after reception of a frame containing an acknowledge bit)									
1	The next transmit data can be written in ICDR (ICDRT)									
	[Setting conditions]									
	 In transmit mode (TRS = 1), when a start condition is detected in the bus line state after a start condition is issued in master mode with the I²C bus format or serial format selected 									
	 When using formatless mode in transmit mode (TRS = 1) 									
	 When data is transferred from ICDRT to ICDRS 									
	(Data transfer from ICDRT to ICDRS when TRS = 1 and TDRE = 0, and ICDRS is empty)									
	 When a switch is made from receive mode (TRS = 0) to transmit mode (TRS = 1) after detection of a start condition 									
RDRF	Description									
	The data in ICDR (ICDRR) is invalid (Initial value)									
0	[Clearing condition]									
. <u></u>	When ICDR (ICDRR) receive data is read in receive mode									
1	The ICDR (ICDRR) receive data can be read									
	[Setting condition]									
	When data is transferred from ICDRS to ICDRR									
	(Data transfer from ICDRS to ICDRR in case of normal termination with TRS = 0 and RDRF = 0)									

16.2.2 Slave Address Register (SAR)

Bit	7	6	5	4	3	2	1	0
	SVA6	SVA5	SVA4	SVA3	SVA2	SVA1	SVA0	FS
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W						

SAR is an 8-bit readable/writable register that stores the slave address and selects the communication format. When the chip is in slave mode (and the addressing format is selected), if the upper 7 bits of SAR match the upper 7 bits of the first frame received after a start condition, the chip operates as the slave device specified by the master device. SAR is assigned to the same address as ICMR, and can be written and read only when the ICE bit is cleared to 0 in ICCR.

SAR is initialized to H'00 by a reset and in hardware standby mode.

Bits 7 to 1—Slave Address (SVA6 to SVA0): Set a unique address in bits SVA6 to SVA0, differing from the addresses of other slave devices connected to the I²C bus.

Bit 0—Format Select (FS): Used together with the FSX bit in SARX and the SW bit in DDCSWR to select the communication format.

- I²C bus format: addressing format with acknowledge bit
- Synchronous serial format: non-addressing format without acknowledge bit, for master mode only
- Formatless mode (channel 0 only): non-addressing format with or without acknowledge bit, slave mode only, start/stop conditions not detected

The FS bit also specifies whether or not SAR slave address recognition is performed in slave	
mode.	

DDCSWR Bit 6	SAR Bit 0	SARX Bit 0	
SW	FS	FSX	Operating Mode
0	0	0	I ² C bus format
			SAR and SARX slave addresses recognized
		1	I ² C bus format (Initial value)
			SAR slave address recognized
			SARX slave address ignored
	1	0	I ² C bus format
			SAR slave address ignored
			SARX slave address recognized
		1	Synchronous serial format
			 SAR and SARX slave addresses ignored
1	0	0	Formatless mode (start/stop conditions not detected)
	0	1	Acknowledge bit used
	1	0	
	1	1	Formatless mode* (start/stop conditions not detected)
			No acknowledge bit

Note: *Do not set this mode when automatic switching to the I²C bus format is performed by means of the DDCSWR setting.

16.2.3 Second Slave Address Register (SARX)

Bit	7	6	5	4	3	2	1	0
	SVAX6	SVAX5	SVAX4	SVAX3	SVAX2	SVAX1	SVAX0	FSX
Initial value	0	0	0	0	0	0	0	1
Read/Write	R/W	R/W						

SARX is an 8-bit readable/writable register that stores the second slave address and selects the communication format. When the chip is in slave mode (and the addressing format is selected), if the upper 7 bits of SARX match the upper 7 bits of the first frame received after a start condition, the chip operates as the slave device specified by the master device. SARX is assigned to the same address as ICDR, and can be written and read only when the ICE bit is cleared to 0 in ICCR.

SARX is initialized to H'01 by a reset and in hardware standby mode.

Bits 7 to 1—Second Slave Address (SVAX6 to SVAX0): Set a unique address in bits SVAX6 to SVAX0, differing from the addresses of other slave devices connected to the I²C bus.

Bit 0—Format Select X (FSX): Used together with the FS bit in SAR and the SW bit in DDCSWR to select the communication format.

- I²C bus format: addressing format with acknowledge bit
- Synchronous serial format: non-addressing format without acknowledge bit, for master mode only
- Formatless mode: non-addressing format with or without acknowledge bit, slave mode only, start/stop conditions not detected

The FSX bit also specifies whether or not SARX slave address recognition is performed in slave mode. For details, see the description of the FS bit in SAR.

16.2.4 I²C Bus Mode Register (ICMR)

Bit	7	6	5	4	3	2	1	0
	MLS	WAIT	CKS2	CKS1	CKS0	BC2	BC1	BC0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

ICMR is an 8-bit readable/writable register that selects whether the MSB or LSB is transferred first, performs master mode wait control, and selects the master mode transfer clock frequency and the transfer bit count. ICMR is assigned to the same address as SAR. ICMR can be written and read only when the ICE bit is set to 1 in ICCR.

ICMR is initialized to H'00 by a reset and in hardware standby mode.

Bit 7—MSB-First/LSB-First Select (MLS): Selects whether data is transferred MSB-first or LSB-first.

If the number of bits in a frame, excluding the acknowledge bit, is less than 8, transmit data and receive data are stored differently. Transmit data should be written justified toward the MSB side when MLS = 0, and toward the LSB side when MLS = 1. Receive data bits read from the LSB side should be treated as valid when MLS = 0, and bits read from the MSB side when MLS = 1.

Do not set this bit to 1 when the I²C bus format is used.

Bit 7		
MLS	Description	
0	MSB-first	(Initial value)
1	LSB-first	

Bit 6—Wait Insertion Bit (WAIT): Selects whether to insert a wait between the transfer of data and the acknowledge bit, in master mode with the I²C bus format. When WAIT is set to 1, after the fall of the clock for the final data bit, the IRIC flag is set to 1 in ICCR, and a wait state begins (with SCL at the low level). When the IRIC flag is cleared to 0 in ICCR, the wait ends and the acknowledge bit is transferred. If WAIT is cleared to 0, data and acknowledge bits are transferred consecutively with no wait inserted.

The IRIC flag in ICCR is set to 1 on completion of the acknowledge bit transfer, regardless of the WAIT setting.

The setting of this bit is invalid in slave mode.

Bit 6		
WAIT	Description	
0	Data and acknowledge bits transferred consecutively	(Initial value)
1	Wait inserted between data and acknowledge bits	

Bits 5 to 3—Serial Clock Select (CKS2 to CKS0): These bits, together with the IICX1 (channel 1) or IICX0 (channel 0) bit in the STCR register, select the serial clock frequency in master mode. They should be set according to the required transfer rate.

STCR Bit 5 or 6	Bit 5	Bit 4	Bit 3				Transfer R	ate	
IICX	CKS2	CKS1	CKS0	Clock	ø = 5 MHz	ø = 8 MHz	ø = 10 MHz	ø = 16 MHz	ø = 20 MHz
0	0	0	0	ø/28	179 kHz	286 kHz	357 kHz	571 kHz*	714 kHz*
			1	ø/40	125 kHz	200 kHz	250 kHz	400 kHz	500 kHz*
		1	0	ø/48	104 kHz	167 kHz	208 kHz	333 kHz	417 kHz*
			1	ø/64	78.1 kHz	125 kHz	156 kHz	250 kHz	313 kHz
	1	0	0	ø/80	62.5 kHz	100 kHz	125 kHz	200 kHz	250 kHz
			1	ø/100	50.0 kHz	80.0 kHz	100 kHz	160 kHz	200 kHz
		1	0	ø/112	44.6 kHz	71.4 kHz	89.3 kHz	143 kHz	179 kHz
			1	ø/128	39.1 kHz	62.5 kHz	78.1 kHz	125 kHz	156 kHz
1	0	0	0	ø/56	89.3 kHz	143 kHz	179 kHz	286 kHz	357 kHz
			1	ø/80	62.5 kHz	100 kHz	125 kHz	200 kHz	250 kHz
		1	0	ø/96	52.1 kHz	83.3 kHz	104 kHz	167 kHz	208 kHz
			1	ø/128	39.1 kHz	62.5 kHz	78.1 kHz	125 kHz	156 kHz
	1	0	0	ø/160	31.3 kHz	50.0 kHz	62.5 kHz	100 kHz	125 kHz
			1	ø/200	25.0 kHz	40.0 kHz	50.0 kHz	80.0 kHz	100 kHz
		1	0	ø/224	22.3 kHz	35.7 kHz	44.6 kHz	71.4 kHz	89.3 kHz
			1	ø/256	19.5 kHz	31.3 kHz	39.1 kHz	62.5 kHz	78.1 kHz

Note: *Outside the I²C bus interface specification range (normal mode: max. 100 kHz; high-speed mode: max. 400 kHz).

Bits 2 to 0—Bit Counter (BC2 to BC0): Bits BC2 to BC0 specify the number of bits to be transferred next. With the I²C bus format (when the FS bit in SAR or the FSX bit in SARX is 0), the data is transferred with one addition acknowledge bit. Bit BC2 to BC0 settings should be made during an interval between transfer frames. If bits BC2 to BC0 are set to a value other than 000, the setting should be made while the SCL line is low.

Bit 2	Bit 1	Bit 0	Bits/Frame						
BC2	BC1	BC0	Synchronous Serial Format	I ² C Bus Format					
0	0	0	8	9	(Initial value)				
		1	1	2					
	1	0	2	3					
		1	3	4					
1	0	0	4	5					
		1	5	6					
	1	0	6	7					
		1	7	8					

The bit counter is initialized to 000 by a reset and when a start condition is detected. The value returns to 000 at the end of a data transfer, including the acknowledge bit.

Bit	7	6	5	4	3	2	1	0
	ICE	IEIC	MST	TRS	ACKE	BBSY	IRIC	SCP
Initial value	0	0	0	0	0	0	0	1
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/(W)*	W

16.2.5 I²C Bus Control Register (ICCR)

Note: * Only 0 can be written, to clear the flag.

ICCR is an 8-bit readable/writable register that enables or disables the I^2C bus interface, enables or disables interrupts, selects master or slave mode and transmission or reception, enables or disables acknowledgement, confirms the I^2C bus interface bus status, issues start/stop conditions, and performs interrupt flag confirmation.

ICCR is initialized to H'01 by a reset and in hardware standby mode.

Bit 7—I²C Bus Interface Enable (ICE): Selects whether or not the I²C bus interface is to be used. When ICE is set to 1, port pins function as SCL and SDA input/output pins and transfer operations are enabled. When ICE is cleared to 0, the I²C bus interface module is disabled.

The SAR and SARX registers can be accessed when ICE is 0. The ICMR and ICDR registers can be accessed when ICE is 1.

Bit 7

ICE	Description							
0	I ² C bus interface module disabled, with SCL and SDA signal pins (Initial value) set to port function							
	SAR and SARX can be accessed							
1	I ² C bus interface module enabled for transfer operations (pins SCL and SCA are driving the bus)	;						
	ICMR and ICDR can be accessed							

Bit 6—I²C Bus Interface Interrupt Enable (IEIC): Enables or disables interrupts from the I²C bus interface to the CPU.

Bit (6
-------	---

IEIC	Description	
0	Interrupts disabled	(Initial value)
1	Interrupts enabled	

Bit 5—Master/Slave Select (MST)

Bit 4—Transmit/Receive Select (TRS)

MST selects whether the I²C bus interface operates in master mode or slave mode.

TRS selects whether the I²C bus interface operates in transmit mode or receive mode.

In master mode with the I²C bus format, when arbitration is lost, MST and TRS are both reset by hardware, causing a transition to slave receive mode. In slave receive mode with the addressing format (FS = 0 or FSX = 0), hardware automatically selects transmit or receive mode according to the R/W bit in the first frame after a start condition.

Modification of the TRS bit during transfer is deferred until transfer of the frame containing the acknowledge bit is completed, and the changeover is made after completion of the transfer.

MST and TRS select the operating mode as follows.

Bit 5	Bit 4		
MST	TRS	Operating Mode	
0	0	Slave receive mode	(Initial value)
	1	Slave transmit mode	
1	0	Master receive mode	
	1	Master transmit mode	

Bit 5

MST	Description							
0	Slave mode (Initial valu	e)						
	[Clearing conditions]							
	1. When 0 is written by software							
	 When bus arbitration is lost after transmission is started in I²C bus format master mode 							
1	Master mode							
	[Setting conditions]							
	1. When 1 is written by software (in cases other than clearing condition 2)							
	2. When 1 is written in MST after reading MST = 0 (in case of clearing condition 2)						

Bit 4								
TRS	Description							
0	Receive mode (Initial value							
	[Clearing conditions]							
	 When 0 is written by software (in cases other than setting condition 3) 							
	 When 0 is written in TRS after reading TRS = 1 (in case of clearing condition 3) 							
	 When bus arbitration is lost after transmission is started in I²C bus format master mode 							
	4. When the SW bit in DDCSWR changes from 1 to 0							
1	Transmit mode							
	[Setting conditions]							
	1. When 1 is written by software (in cases other than clearing conditions 3 and 4)							
	 When 1 is written in TRS after reading TRS = 0 (in case of clearing conditions 3 and 4) 							
	 When a 1 is received as the R/W bit of the first frame in I²C bus format slave mode 							

Bit 3—Acknowledge Bit Judgement Selection (ACKE): Specifies whether the value of the acknowledge bit returned from the receiving device when using the I^2C bus format is to be ignored and continuous transfer is performed, or transfer is to be aborted and error handling, etc., performed if the acknowledge bit is 1. When the ACKE bit is 0, the value of the received acknowledge bit is not indicated by the ACKB bit, which is always 0.

In the H8S/2138 Series, the DTC can be used to perform continuous transfer. The DTC is activated when the IRTR interrupt flag is set to 1 (IRTR is one of two interrupt flags, the other being IRIC). When the ACKE bit is 0, the TDRE, IRIC, and IRTR flags are set on completion of data transmission, regardless of the value of the acknowledge bit. When the ACKE bit is 1, the TDRE, IRIC, and IRTR flags are set on completion of data transmission when the acknowledge bit is 0, and the IRIC flag alone is set on completion of data transmission when the acknowledge bit is 1.

When the DTC is activated, the TDRE, IRIC, and IRTR flags are cleared to 0 after the specified number of data transfers have been executed. Consequently, interrupts are not generated during continuous data transfer, but if data transmission is completed with a 1 acknowledge bit when the ACKE bit is set to 1, the DTC is not activated and an interrupt is generated, if enabled.

Depending on the receiving device, the acknowledge bit may be significant, in indicating completion of processing of the received data, for instance, or may be fixed at 1 and have no significance.

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Bit 3		
ACKE	Description	
0	The value of the acknowledge bit is ignored, and continuous transfer is performed	(Initial value)
1	If the acknowledge bit is 1, continuous transfer is interrupted	

Bit 2—Bus Busy (BBSY): The BBSY flag can be read to check whether the I²C bus (SCL, SDA) is busy or free. In master mode, this bit is also used to issue start and stop conditions.

A high-to-low transition of SDA while SCL is high is recognized as a start condition, setting BBSY to 1. A low-to-high transition of SDA while SCL is high is recognized as a stop condition, clearing BBSY to 0.

To issue a start condition, use a MOV instruction to write 1 in BBSY and 0 in SCP. A retransmit start condition is issued in the same way. To issue a stop condition, use a MOV instruction to write 0 in BBSY and 0 in SCP. It is not possible to write to BBSY in slave mode; the I^2C bus interface must be set to master transmit mode before issuing a start condition. MST and TRS should both be set to 1 before writing 1 in BBSY and 0 in SCP.

Bit 2		
BBSY	Description	
0	Bus is free	(Initial value)
	[Clearing condition]	
	When a stop condition is detected	
1	Bus is busy	
	[Setting condition]	
	When a start condition is detected	

Bit 1—I²C Bus Interface Interrupt Request Flag (IRIC): Indicates that the I²C bus interface has issued an interrupt request to the CPU. IRIC is set to 1 at the end of a data transfer, when a slave address or general call address is detected in slave receive mode, when bus arbitration is lost in master transmit mode, and when a stop condition is detected. IRIC is set at different times depending on the FS bit in SAR and the WAIT bit in ICMR. See section 16.3.6, IRIC Setting Timing and SCL Control. The conditions under which IRIC is set also differ depending on the setting of the ACKE bit in ICCR.

IRIC is cleared by reading IRIC after it has been set to 1, then writing 0 in IRIC.

When the DTC is used, IRIC is cleared automatically and transfer can be performed continuously without CPU intervention.

Bit 1	 Deceniation
	Description
0	Waiting for transfer, or transfer in progress (Initial value)
	[Clearing conditions]
	1. When 0 is written in IRIC after reading IRIC = 1
	2. When ICDR is written or read by the DTC
	(When the TDRE or RDRF flag is cleared to 0)
	(This is not always a clearing condition; see the description of DTC operation for details)
1	Interrupt requested
	[Setting conditions]
	I ² C bus format master mode
	 When a start condition is detected in the bus line state after a start condition i issued
	(when the TDRE flag is set to 1 because of first frame transmission)
	 When a wait is inserted between the data and acknowledge bit when WAIT = 1
	At the end of data transfer (at the rise of the 9th transmit/receive clock pulse, and, when a wait is
	inserted, at the fall of the 8th transmit/receive clock pulse)
	 When a slave address is received after bus arbitration is lost (when the AL flag is set to 1)
	When 1 is received as the acknowledge bit when the ACKE bit is 1 (when the ACKB bit is set to 1)
	I ² C bus format slave mode
	 When the slave address (SVA, SVAX) matches (when the AAS and AASX flags are set to 1)
	and at the end of data transfer up to the subsequent retransmission start condition or stop condition detection (when the TDRE or RDRF flag is set to 1)
	 When the general call address is detected (when FS = 0 and the ADZ flag is set to 1)
	and at the end of data transfer up to the subsequent retransmission start condition or stop condition detection (when the TDRE or RDRF flag is set to 1)
	 When 1 is received as the acknowledge bit when the ACKE bit is 1 (when the ACKB bit is set to 1)
	 When a stop condition is detected (when the STOP or ESTP flag is set to 1)
	Synchronous serial format, and formatless mode
	 At the end of data transfer (when the TDRE or RDRF flag is set to 1)
	2. When a start condition is detected with serial format selected
	2. When the SW bit is get to 1 in DDCSWP

3. When the SW bit is set to 1 in $\ensuremath{\mathsf{DDCSWR}}$

When, with the I^2C bus format selected, IRIC is set to 1 and an interrupt is generated, other flags must be checked in order to identify the source that set IRIC to 1. Although each source has a corresponding flag, caution is needed at the end of a transfer.

When the TDRE or RDRF internal flag is set, the readable IRTR flag may or may not be set. The IRTR flag (the DTC start request flag) is not set at the end of a data transfer up to detection of a retransmission start condition or stop condition after a slave address (SVA) or general call address match in I²C bus format slave mode.

Even when the IRIC flag and IRTR flag are set, the TDRE or RDRF internal flag may not be set. The IRIC and IRTR flags are not cleared at the end of the specified number of transfers in continuous transfer using the DTC. The TDRE or RDRF flag is cleared, however, since the specified number of ICDR reads or writes have been completed.

Table 16.3 shows the relationship between the flags and the transfer states.

MST	TRS	BBSY	ESTP	STOP	IRTR	AASX	AL	AAS	ADZ	ACKB	State
1/0	1/0	0	0	0	0	0	0	0	0	0	Idle state (flag clearing required)
1	1	0	0	0	0	0	0	0	0	0	Start condition issuance
1	1	1	0	0	1	0	0	0	0	0	Start condition established
1	1/0	1	0	0	0	0	0	0	0	0/1	Master mode wait
1	1/0	1	0	0	1	0	0	0	0	0/1	Master mode transmit/receive end
0	0	1	0	0	0	1/0	1	1/0	1/0	0	Arbitration lost
0	0	1	0	0	0	0	0	1	0	0	SAR match by first frame in slave mode
0	0	1	0	0	0	0	0	1	1	0	General call address match
0	0	1	0	0	0	1	0	0	0	0	SARX match
0	1/0	1	0	0	0	0	0	0	0	0/1	Slave mode transmit/receive end (except after SARX match)
0	1/0	1	0	0	1	1	0	0	0	0	Slave mode
0	1	1	0	0	0	1	0	0	0	1	transmit/receive end (after SARX match)
0	1/0	0	1/0	1/0	0	0	0	0	0	0/1	Stop condition detected

Bit 0—Start Condition/Stop Condition Prohibit (SCP): Controls the issuing of start and stop conditions in master mode. To issue a start condition, write 1 in BBSY and 0 in SCP. A retransmit start condition is issued in the same way. To issue a stop condition, write 0 in BBSY and 0 in SCP. This bit is always read as 1. If 1 is written, the data is not stored.

Bit 0		
SCP	Description	
0	Writing 0 issues a start or stop condition, in combination with the	BBSY flag
1	Reading always returns a value of 1	(Initial value)
	Writing is ignored	

16.2.6 I²C Bus Status Register (ICSR)

Bit	7	6	5	4	3	2	1	0
	ESTP	STOP	IRTR	AASX	AL	AAS	ADZ	ACKB
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/(W)*	R/W						

Note: * Only 0 can be written, to clear the flags.

ICSR is an 8-bit readable/writable register that performs flag confirmation and acknowledge confirmation and control.

ICSR is initialized to H'00 by a reset and in hardware standby mode.

Bit 7—Error Stop Condition Detection Flag (ESTP): Indicates that a stop condition has been detected during frame transfer in I^2C bus format slave mode.

Bit 7		
ESTP	Description	
0	No error stop condition	(Initial value)
	[Clearing conditions]	
	1. When 0 is written in ESTP after reading ESTP = 1	
	2. When the IRIC flag is cleared to 0	
1	In I ² C bus format slave mode	
	Error stop condition detected	
	[Setting condition]	
	When a stop condition is detected during frame transfer	
	In other modes	
	No meaning	

Bit 6—Normal Stop Condition Detection Flag (STOP): Indicates that a stop condition has been detected after completion of frame transfer in I²C bus format slave mode.

Bit 6

STOP	Description
0	No normal stop condition (Initial value)
	[Clearing conditions]
	1. When 0 is written in STOP after reading STOP = 1
	2. When the IRIC flag is cleared to 0
1	In I ² C bus format slave mode
	Normal stop condition detected
	[Setting condition]
	When a stop condition is detected after completion of frame transfer
	In other modes
	No meaning

Bit 5— I^2C Bus Interface Continuous Transmission/Reception Interrupt Request Flag (IRTR): Indicates that the I^2C bus interface has issued an interrupt request to the CPU, and the

source is completion of reception/transmission of one frame in continuous transmission/reception for which DTC activation is possible. When the IRTR flag is set to 1, the IRIC flag is also set to 1 at the same time.

IRTR flag setting is performed when the TDRE or RDRF flag is set to 1. IRTR is cleared by reading IRTR after it has been set to 1, then writing 0 in IRTR. IRTR is also cleared automatically when the IRIC flag is cleared to 0.

Bit 5		
IRTR	Description	
0	Waiting for transfer, or transfer in progress	(Initial value)
	[Clearing conditions]	
	1. When 0 is written in IRTR after reading IRTR = 1	
	2. When the IRIC flag is cleared to 0	
1	Continuous transfer state	
	[Setting condition]	
	In I ² C bus interface slave mode	
	When the TDRE or RDRF flag is set to 1 when AASX = 1	
	In other modes	
	When the TDRE or RDRF flag is set to 1	

Bit 4—Second Slave Address Recognition Flag (AASX): In I²C bus format slave receive mode, this flag is set to 1 if the first frame following a start condition matches bits SVAX6 to SVAX0 in SARX.

AASX is cleared by reading AASX after it has been set to 1, then writing 0 in AASX. AASX is also cleared automatically when a start condition is detected.

Bit 4	
AASX	Description
0	Second slave address not recognized (Initial value)
	[Clearing conditions]
	 When 0 is written in AASX after reading AASX = 1
	2. When a start condition is detected
	3. In master mode
1	Second slave address recognized
	[Setting condition]
	When the second slave address is detected in slave receive mode while $FSX = 0$

Bit 3—Arbitration Lost (AL): This flag indicates that arbitration was lost in master mode. The I^2C bus interface monitors the bus. When two or more master devices attempt to seize the bus at nearly the same time, if the I^2C bus interface detects data differing from the data it sent, it sets AL to 1 to indicate that the bus has been taken by another master.

AL is cleared by reading AL after it has been set to 1, then writing 0 in AL. In addition, AL is reset automatically by write access to ICDR in transmit mode, or read access to ICDR in receive mode.

Bit 3

AL	Description			
0	Bus arbitration won	(Initial value)		
	[Clearing conditions]			
	 When ICDR data is written (transmit mode) or read (receive mode) 			
	2. When 0 is written in AL after reading AL = 1			
1	Arbitration lost			
	[Setting conditions]			
	 If the internal SDA and SDA pin disagree at the rise of SCL ir mode 	n master transmit		
	2. If the internal SCL line is high at the fall of SCL in master tran	smit mode		

Bit 2—Slave Address Recognition Flag (AAS): In I²C bus format slave receive mode, this flag is set to 1 if the first frame following a start condition matches bits SVA6 to SVA0 in SAR, or if the general call address (H'00) is detected.

AAS is cleared by reading AAS after it has been set to 1, then writing 0 in AAS. In addition, AAS is reset automatically by write access to ICDR in transmit mode, or read access to ICDR in receive mode.

AAS	Description			
0	Slave address or general call address not recognized	(Initial value)		
	[Clearing conditions]			
	 When ICDR data is written (transmit mode) or read (receive mode) 			
	2. When 0 is written in AAS after reading AAS = 1			
	3. In master mode			
1	Slave address or general call address recognized			
	[Setting condition]			
	When the slave address or general call address is detected in slaw while $FS = 0$	ve receive mode		

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Bit 1—General Call Address Recognition Flag (ADZ): In I²C bus format slave receive mode, this flag is set to 1 if the first frame following a start condition is the general call address (H'00).

ADZ is cleared by reading ADZ after it has been set to 1, then writing 0 in ADZ. In addition, ADZ is reset automatically by write access to ICDR in transmit mode, or read access to ICDR in receive mode.

Bit 1

ADZ	Description	
0	General call address not recognized	(Initial value)
	[Clearing conditions]	
	 When ICDR data is written (transmit mode) or read (receive mode) 	
	2. When 0 is written in ADZ after reading $ADZ = 1$	
	3. In master mode	
1	General call address recognized	
	[Setting condition]	
	When the general call address is detected in slave receive mode while $FSX = 0$ or $FS = 0$	

Bit 0-Acknowledge Bit (ACKB): Stores acknowledge data. In transmit mode, after the receiving device receives data, it returns acknowledge data, and this data is loaded into ACKB. In receive mode, after data has been received, the acknowledge data set in this bit is sent to the transmitting device.

When this bit is read, in transmission (when TRS = 1), the value loaded from the bus line (returned by the receiving device) is read. In reception (when TRS = 0), the value set by internal software is read.

Dit	
ACKB	Description
0	Receive mod

Rit 0

AOND	Description		
0	Receive mode: 0 is output at acknowledge output timing	(Initial value)	
	Transmit mode: Indicates that the receiving device has acknowledged the data (signal is 0)		
1	Receive mode: 1 is output at acknowledge output timing		
	Transmit mode: Indicates that the receiving device has not acknowledged the data (signal is 1)		

16.2.7 Serial/Timer Control Register (STCR)

Bit	7	6	5	4	3	2	1	0
		IICX1	IICX0	IICE	FLSHE	—	ICKS1	ICKS0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

STCR is an 8-bit readable/writable register that controls register access, the I²C interface operating mode (when the on-chip IIC option is included), and on-chip flash memory (F-ZTAT versions), and selects the TCNT input clock source. For details of functions not related to the I²C bus interface, see section 3.2.4, Serial/Timer Control Register (STCR), and the descriptions of the relevant modules. If a module controlled by STCR is not used, do not write 1 to the corresponding bit.

STCR is initialized to H'00 by a reset and in hardware standby mode.

Bit 7—Reserved: Do not write 1 to this bit.

Bit 6—I²C Transfer Select 1 (IICX1): This bit, together with bits CKS2 to CKS0 in ICMR of IIC1, selects the transfer rate in master mode. For details, see section 16.2.4, I²C Bus Mode Register (ICMR).

Bit 5—I²C Transfer Select 0 (IICX0): This bit, together with bits CKS2 to CKS0 in ICMR of IIC0, selects the transfer rate in master mode. For details, see section 16.2.4, I²C Bus Mode Register (ICMR).

Bit 4—I²C Master Enable (IICE): Controls CPU access to the I²C bus interface data and control registers (ICCR, ICSR, ICDR/SARX, ICMR/SAR).

Bit 4

IICE	Description	
0	CPU access to I ² C bus interface data and control registers is disabled	(Initial value)
1	CPU access to I ² C bus interface data and control registers is enabled	

Bit 3—Flash Memory Control Register Enable (FLSHE): Controls the operation of the flash memory in F-ZTAT versions. For details, see section 22, ROM.

Bit 2—Reserved: Do not write 1 to this bit.

Bits 1 and 0—Internal Clock Source Select 1 and 0 (ICKS1, ICSK0): These bits, together with bits CKS2 to CKS0 in TCR, select the clock input to the timer counters (TCNT). For details, see section 12.2.4, Timer Control Register (TCR).

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16.2.8 DDC Switch Register (DDCSWR)

Bit	7	6	5	4	3	2	1	0
	SWE	SW	IE	IF	CLR3	CLR2	CLR1	CLR0
Initial value	0	0	0	0	1	1	1	1
Read/Write	R/W	R/W	R/W	R/(W)*1	W*2	W*2	W*2	W*2

Notes: 1. Only 0 can be written, to clear the flag. 2. Always read as 1.

DDCSWR is an 8-bit readable/writable register that controls the IIC channel 0 automatic format switching function.

DDCSWR is initialized to H'0F by a reset and in hardware standby mode.

Bit 7—DDC Mode Switch Enable (SWE): Selects the function for automatically switching IIC channel 0 from formatless mode to the I^2C bus format.

Bit 7

SWE	Description	
0	Automatic switching of IIC channel 0 from formatless mode to I ² C bus format is disabled	(Initial value)
1	Automatic switching of IIC channel 0 from formatless mode to I ² C bus format is enabled	

Bit 6—DDC Mode Switch (SW): Selects either formatless mode or the I²C bus format for IIC channel 0.

Bit 6

SW	Description	
0	IIC channel 0 is used with the I ² C bus format	(Initial value)
	[Clearing conditions]	
	1. When 0 is written by software	
	2. When a falling edge is detected on the SCL pin when SWE = 1	
1	IIC channel 0 is used in formatless mode	
	[Setting condition]	
	When 1 is written in SW after reading SW = 0	

Bit 5—DDC Mode Switch Interrupt Enable Bit (IE): Enables or disables an interrupt request to the CPU when automatic format switching is executed for IIC channel 0.

Bit 5

IE	Description	
0	Interrupt when automatic format switching is executed is disabled	(Initial value)
1	Interrupt when automatic format switching is executed is enabled	

Bit 4—DDC Mode Switch Interrupt Flag (IF): Flag that indicates an interrupt request to the CPU when automatic format switching is executed for IIC channel 0.

Bit 4

IF	Description					
0	No interrupt is requested when automatic format switching is executed (Initial value)					
	[Clearing condition]					
	When 0 is written in IF after reading $IF = 1$					
1	An interrupt is requested when automatic format switching is executed					
	[Setting condition]					
	When a falling edge is detected on the SCL pin when SWE = 1					

Bits 3 to 0—IIC Clear 3 to 0 (CLR3 to CLR0): These bits control initialization of the internal state of IIC0 and IIC1.

These bits can only be written to; if read they will always return a value of 1.

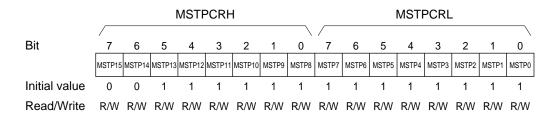
When a write operation is performed on these bits, a clear signal is generated for the internal latch circuit of the corresponding module(s), and the internal state of the IIC module(s) is initialized.

The write data for these bits is not retained. To perform IIC clearance, bits CLR3 to CLR0 must be written to simultaneously using an MOV instruction. Do not use a bit manipulation instruction such as BCLR.

Bit 3	Bit 2	Bit 1	Bit 0	
CLR3	CLR2	CLR1	CLR0	Description
0	0	_	_	Setting prohibited
	1	0	0	Setting prohibited
			1	IIC0 internal latch cleared
		1	0	IIC1 internal latch cleared
			1	IIC0 and IIC1 internal latches cleared
1	—	—	—	Invalid setting

When clearing is required again, all the bits must be written to in accordance with the setting.

16.2.9 Module Stop Control Register (MSTPCR)



MSTPCR comprises two 8-bit readable/writable registers, and is used to perform module stop mode control.

When the MSTP4 or MSTP3 bit is set to 1, operation of the corresponding IIC channel is halted at the end of the bus cycle, and a transition is made to module stop mode. For details, see section 23.5, Module Stop Mode.

MSTPCR is initialized to H'3FFF by a reset and in hardware standby mode. It is not initialized in software standby mode.

MSTPCRL Bit 4—Module Stop (MSTP4): Specifies IIC channel 0 module stop mode.

MSTPCRL Bit 4	-	
MSTP4	Description	
0	IIC channel 0 module stop mode is cleared	
1	IIC channel 0 module stop mode is set	(Initial value)

MSTPCRL Bit 3—Module Stop (MSTP3): Specifies IIC channel 1 module stop mode.

MSTPCRL

DIUS		
MSTP3	Description	
0	IIC channel 1 module stop mode is cleared	
1	IIC channel 1 module stop mode is set	(Initial value)

16.3 Operation

16.3.1 I²C Bus Data Format

The I²C bus interface has serial and I²C bus formats.

The I^2C bus formats are addressing formats with an acknowledge bit. These are shown in figures 16.3 (a) and (b). The first frame following a start condition always consists of 8 bits.

IIC channel 0 only is capable of formatless operation, as shown in figure 16.3 (c).

The serial format is a non-addressing format with no acknowledge bit. This is shown in figure 16.4.

Figure 16.5 shows the I²C bus timing.

The symbols used in figures 16.3 to 16.5 are explained in table 16.4.

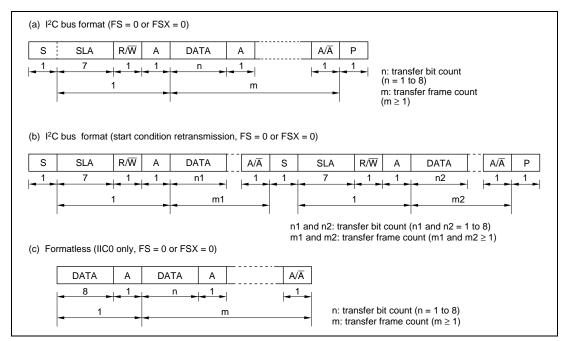


Figure 16.3 I²C Bus Data Formats (I²C Bus Formats)

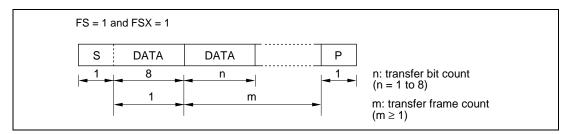


Figure 16.4 I²C Bus Data Format (Serial Format)

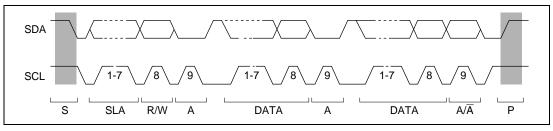


Figure 16.5 I²C Bus Timing

Table 16.4	I ² C Bus Data I	Format Symbols
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Legend	
S	Start condition. The master device drives SDA from high to low while SCL is high
SLA	Slave address, by which the master device selects a slave device
R/W	Indicates the direction of data transfer: from the slave device to the master device when R/\overline{W} is 1, or from the master device to the slave device when R/\overline{W} is 0
A	Acknowledge. The receiving device (the slave in master transmit mode, or the master in master receive mode) drives SDA low to acknowledge a transfer
DATA	Transferred data. The bit length is set by bits BC2 to BC0 in ICMR. The MSB-first or LSB-first format is selected by bit MLS in ICMR
Р	Stop condition. The master device drives SDA from low to high while SCL is high

16.3.2 Master Transmit Operation

In I^2C bus format master transmit mode, the master device outputs the transmit clock and transmit data, and the slave device returns an acknowledge signal. The transmission procedure and operations are described below.

- [1] Set the ICE bit in ICCR to 1. Set bits MLS, WAIT, and CKS2 to CKS0 in ICMR, and bit IICX in STCR, according to the operating mode.
- [2] Read the BBSY flag in ICCR to confirm that the bus is free, then set bits MST and TRS to 1 in ICCR to select master transmit mode. Next, write 1 to BBSY and 0 to SCP. This changes SDA from high to low when SCL is high, and generates the start condition. The TDRE internal flag is then set to 1, and the IRIC and IRTR flags are also set to 1. If the IEIC bit in ICCR has been set to 1, an interrupt request is sent to the CPU.
- [3] With the I²C bus format (when the FS bit in SAR or the FSX bit in SARX is 0), the first frame data following the start condition indicates the 7-bit slave address and transmit/receive direction. Write the data (slave address + R/W) to ICDR. The TDRE internal flag is then cleared to 0. The written address data is transferred to ICDRS, and the TDRE internal flag is set to 1 again. This is identified as indicating the end of the transfer, and so the IRIC flag is cleared to 0. The master device sequentially sends the transmit clock and the data written to ICDR using the timing shown in figure 16.6. The selected slave device (i.e. the slave device with the matching slave address) drives SDA low at the 9th transmit clock pulse and returns an acknowledge signal.
- [4] When one frame of data has been transmitted, the IRIC flag is set to 1 at the rise of the 9th transmit clock pulse. If the TDRE internal flag has been set to 1, after one frame has been transmitted SCL is automatically fixed low in synchronization with the internal clock until the next transmit data is written.
- [5] To continue transfer, write the next data to be transmitted into ICDR. After the data has been transferred to ICDRS and the TDRE internal flag has been set to 1, clear the IRIC flag to 0. Transmission of the next frame is performed in synchronization with the internal clock.

Data can be transmitted sequentially by repeating steps [4] and [5]. To end transmission, clear the IRIC flag, write H'FF dummy data to ICDR after the last data has been transmitted (when ICDRT does not contain the next transmit data), and then write 0 to BBSY and SCP in ICCR when the IRIC flag is set again. This changes SDA from low to high when SCL is high, and generates the stop condition.

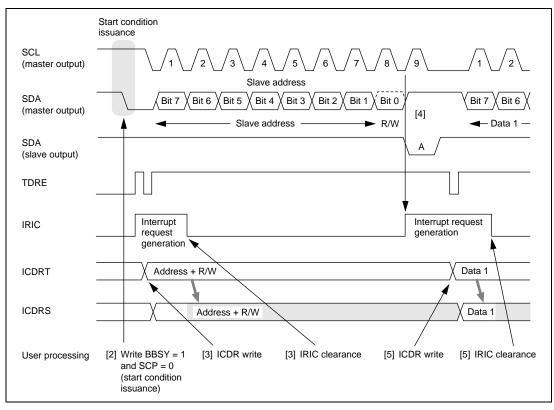


Figure 16.6 Example of Master Transmit Mode Operation Timing (MLS = WAIT = 0)

To transmit data continuously:

- [6] Before the rise of the 9th transmit clock pulse for the data being transmitted, clear the IRIC flag to 0 and then write the next transmit data to ICDR.
- [7] When one frame of data has been transmitted, the IRIC flag in ICCR is set to 1 at the rise of the 9th transmit clock pulse. At the same time, the next transmit data written into ICDR (ICDRT) is transferred to ICDRS, the TDRE internal flag is set to 1, and then the next frame is transmitted in synchronization with the internal clock.

Data can be transmitted continuously by repeating steps [6] and [7].

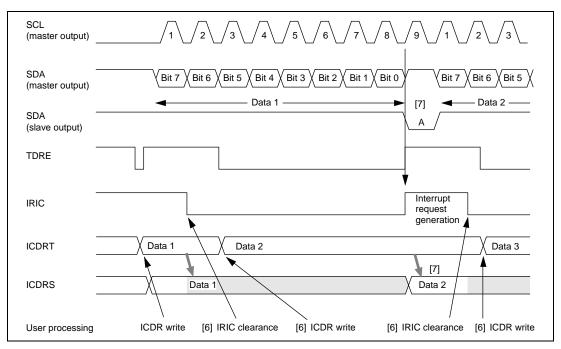


Figure 16.7 Example of Master Transmit Mode Continuous Transmit Operation Timing (MLS = WAIT = 0)

16.3.3 Master Receive Operation

In master receive mode, the master device outputs the receive clock, receives data, and returns an acknowledge signal. The slave device transmits data. The reception procedure and operations in master receive mode are described below.

- [1] Clear the TRS bit in ICCR to 0 to switch from transmit mode to receive mode. Also clear the ACKB bit in ICSR to 0 (acknowledge data setting).
- [2] When ICDR is read (dummy data read), reception is started, and the receive clock is output, and data received, in synchronization with the internal clock. In order to determine the end of reception, the IRIC flag in ICCR must be cleared beforehand.
- [3] The master device drives SDA at the 9th receive clock pulse to return an acknowledge signal. When one frame of data has been received, the IRIC flag in ICCR is set to 1 at the rise of the 9th receive clock pulse. If the IEIC bit in ICCR has been set to 1, an interrupt request is sent to the CPU. If the RDRF internal flag has been cleared to 0, it is set to 1, and the receive operation continues. If reception of the next frame ends before the ICDR read/IRIC flag clearing in [4] is performed, SCL is automatically fixed low in synchronization with the internal clock.
- [4] Read ICDR and clear the IRIC flag in ICCR to 0. The RDRF flag is cleared to 0.

Data can be received continuously by repeating steps [3] and [4]. As the RDRF internal flag is cleared to 0 when reception is started after initially switching from master transmit mode to master receive mode, reception of the next frame of data is started automatically. To halt reception, the TRS bit must be set to 1 before the rise of the receive clock for the next frame.

To halt reception, set the TSR bit to 1, read ICDR, then write 0 to BBSY and SCP in ICCR. This changes SDA from low to high when SCL is high, and generates the stop condition.

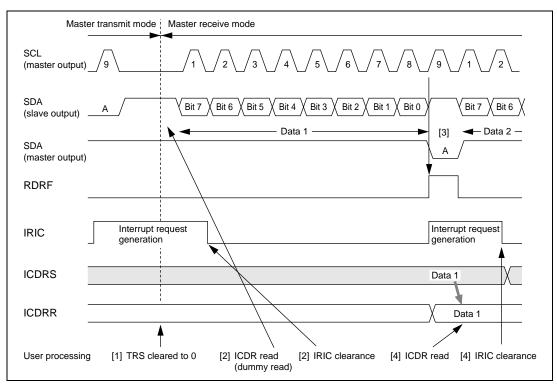


Figure 16.8 Example of Master Receive Mode Operation Timing (MLS = WAIT = ACKB = 0)

16.3.4 Slave Receive Operation

In slave receive mode, the master device outputs the transmit clock and transmit data, and the slave device returns an acknowledge signal. The reception procedure and operations in slave receive mode are described below.

- [1] Set the ICE bit in ICCR to 1. Set the MLS bit in ICMR and the MST and TRS bits in ICCR according to the operating mode.
- [2] When the start condition output by the master device is detected, the BBSY flag in ICCR is set to 1.
- [3] When the slave address matches in the first frame following the start condition, the device operates as the slave device specified by the master device. If the 8th data bit (R/W) is 0, the TRS bit in ICCR remains cleared to 0, and slave receive operation is performed.
- [4] At the 9th clock pulse of the receive frame, the slave device drives SDA low and returns an acknowledge signal. At the same time, the IRIC flag in ICCR is set to 1. If the IEIC bit in ICCR has been set to 1, an interrupt request is sent to the CPU. If the RDRF internal flag has been cleared to 0, it is set to 1, and the receive operation continues. If the RDRF internal flag has been set to 1, the slave device drives SCL low from the fall of the receive clock until data is read into ICDR.
- [5] Read ICDR and clear the IRIC flag in ICCR to 0. The RDRF flag is cleared to 0.

Receive operations can be performed continuously by repeating steps [4] and [5]. When SDA is changed from low to high when SCL is high, and the stop condition is detected, the BBSY flag in ICCR is cleared to 0.

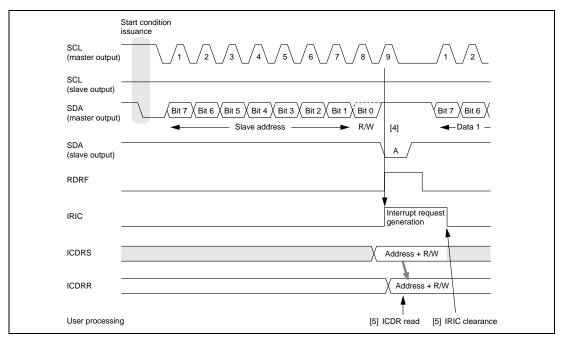


Figure 16.9 Example of Slave Receive Mode Operation Timing (1) (MLS = ACKB = 0)

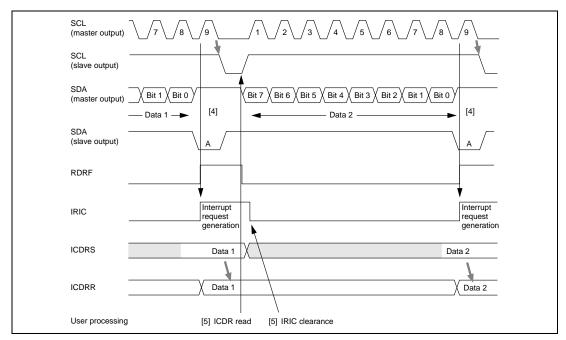


Figure 16.10 Example of Slave Receive Mode Operation Timing (2) (MLS = ACKB = 0)

16.3.5 Slave Transmit Operation

In slave transmit mode, the slave device outputs the transmit data, while the master device outputs the receive clock and returns an acknowledge signal. The transmission procedure and operations in slave transmit mode are described below.

- [1] Set the ICE bit in ICCR to 1. Set the MLS bit in ICMR and the MST and TRS bits in ICCR according to the operating mode.
- [2] When the slave address matches in the first frame following detection of the start condition, the slave device drives SDA low at the 9th clock pulse and returns an acknowledge signal. At the same time, the IRIC flag in ICCR is set to 1. If the IEIC bit in ICCR has been set to 1, an interrupt request is sent to the CPU. If the 8th data bit (R/W) is 1, the TRS bit in ICCR is set to 1, and the mode changes to slave transmit mode automatically. The TDRF flag is set to 1. The slave device drives SCL low from the fall of the transmit clock until ICDR data is written.
- [3] After clearing the IRIC flag to 0, write data to ICDR. The TDRE internal flag is cleared to 0. The written data is transferred to ICDRS, and the TDRE internal flag and the IRIC and IRTR flags are set to 1 again. After clearing the IRIC flag to 0, write the next data to ICDR. The slave device sequentially sends the data written into ICDR in accordance with the clock output by the master device at the timing shown in figure 16.11.
- [4] When one frame of data has been transmitted, the IRIC flag in ICCR is set to 1 at the rise of the 9th transmit clock pulse. If the TDRE internal flag has been set to 1, this slave device drives SCL low from the fall of the transmit clock until data is written to ICDR. The master device drives SDA low at the 9th clock pulse, and returns an acknowledge signal. As this acknowledge signal is stored in the ACKB bit in ICSR, this bit can be used to determine whether the transfer operation was performed normally. When the TDRE internal flag is 0, the data written into ICDR is transferred to ICDRS, transmission is started, and the TDRE internal flag and the IRIC and IRTR flags are set to 1 again.
- [5] To continue transmission, clear the IRIC flag to 0, then write the next data to be transmitted into ICDR. The TDRE flag is cleared to 0.

Transmit operations can be performed continuously by repeating steps [4] and [5]. To end transmission, write H'FF to ICDR to release SDA on the slave side. When SDA is changed from low to high when SCL is high, and the stop condition is detected, the BBSY flag in ICCR is cleared to 0.

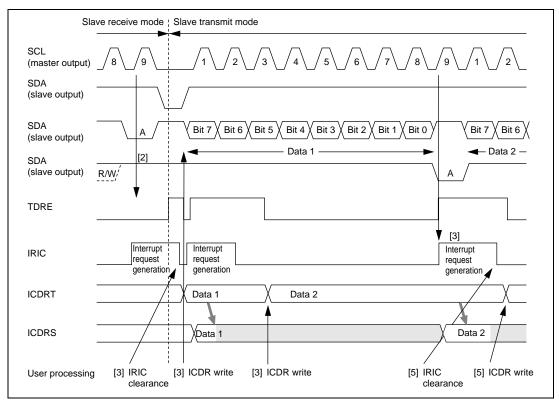


Figure 16.11 Example of Slave Transmit Mode Operation Timing (MLS = 0)

16.3.6 IRIC Setting Timing and SCL Control

The interrupt request flag (IRIC) is set at different times depending on the WAIT bit in ICMR, the FS bit in SAR, and the FSX bit in SARX. If the TDRE or RDRF internal flag is set to 1, SCL is automatically held low after one frame has been transferred; this timing is synchronized with the internal clock. Figure 16.12 shows the IRIC set timing and SCL control.

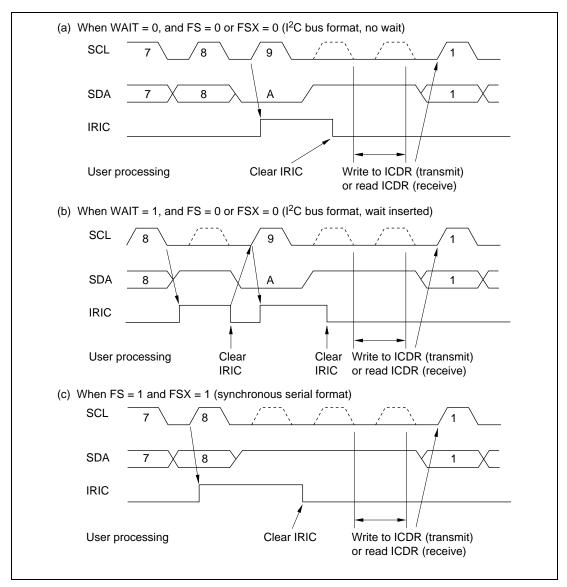


Figure 16.12 IRIC Setting Timing and SCL Control

16.3.7 Automatic Switching from Formatless Mode to I²C Bus Format

Setting the SW bit to 1 in DDCSWR enables formatless mode to be selected as the IIC0 operating mode. Switching from formatless mode to the I^2C bus format (slave mode) is performed automatically when a falling edge is detected on the SCL pin.

The following four preconditions are necessary for this operation:

- A common data pin (SDA) for formatless and I²C bus format operation
- Separate clock pins for formatless operation (VSYNCI) and I²C bus format operation (SCL)
- A fixed 1 level for the SCL pin during format operation
- Settings of bits other than TRS in ICCR that allow I²C bus format operation

Automatic switching is performed from formatless mode to the I^2C bus format when the SW bit in DDCSWR is automatically cleared to 0 on detection of a falling edge on the SCL pin. Switching from the I^2C bus format to formatless mode is achieved by having software set the SW bit in DDCSWR to 1.

In formatless mode, bits (such as MSL and TRS) that control the I^2C bus interface operating mode must not be modified. When switching from the I^2C bus format to formatless mode, set the TRS bit to 1 or clear it to 0 according to the transmit data (transmission or reception) in formatless mode, then set the SW bit to 1. After automatic switching from formatless mode to the I^2C bus format (slave mode), in order to wait for slave address reception, the TRS bit is automatically cleared to 0.

If a falling edge is detected on the SCL pin during formatless operation, I^2C bus interface operation is deferred until a stop condition is detected.

16.3.8 Operation Using the DTC

The I²C bus format provides for selection of the slave device and transfer direction by means of the slave address and the R/W bit, confirmation of reception with the acknowledge bit, indication of the last frame, and so on. Therefore, continuous data transfer using the DTC must be carried out in conjunction with CPU processing by means of interrupts.

Table 16.5 shows some examples of processing using the DTC. These examples assume that the number of transfer data bytes is known in slave mode.

Item	Master Transmit Mode	Master Receive Mode	Slave Transmit Mode	Slave Receive Mode
Slave address + R/W bit transmission/ reception	Transmission by DTC (ICDR write)	Transmission by CPU (ICDR write)	Reception by CPU (ICDR read)	Reception by CPU (ICDR read)
Dummy data read	—	Processing by CPU (ICDR read)	_	_
Actual data transmission/ reception	Transmission by DTC (ICDR write)	Reception by DTC (ICDR read)	Transmission by DTC (ICDR write)	Reception by DTC (ICDR read)
Dummy data (H'FF) write	—	—	Processing by DTC (ICDR write)	_
Last frame processing	Not necessary	Reception by CPU (ICDR read)	Not necessary	Reception by CPU (ICDR read)
Transfer request processing after last frame processing	1st time: Clearing by CPU 2nd time: End condition issuance by CPU	Not necessary	Automatic clearing on detection of end condition during transmission of dummy data (H'FF)	
Setting of number of DTC transfer data frames	Transmission: Actual data count + 1 (+1 equivalent to slave address + R/W bits)	Reception: Actual data count	Transmission: Actual data count + 1 (+1 equivalent to dummy data (H'FF))	Reception: Actual data count

 Table 16.5
 Examples of Operation Using the DTC

16.3.9 Noise Canceler

The logic levels at the SCL and SDA pins are routed through noise cancelers before being latched internally. Figure 16.13 shows a block diagram of the noise canceler circuit.

The noise canceler consists of two cascaded latches and a match detector. The SCL (or SDA) input signal is sampled on the system clock, but is not passed forward to the next circuit unless the outputs of both latches agree. If they do not agree, the previous value is held.

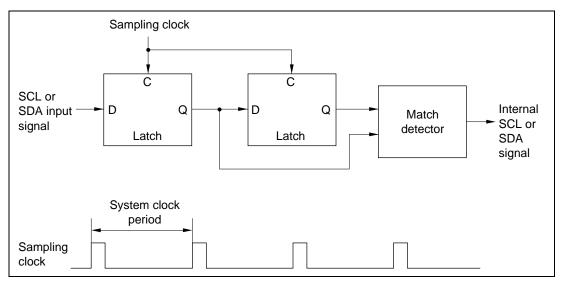
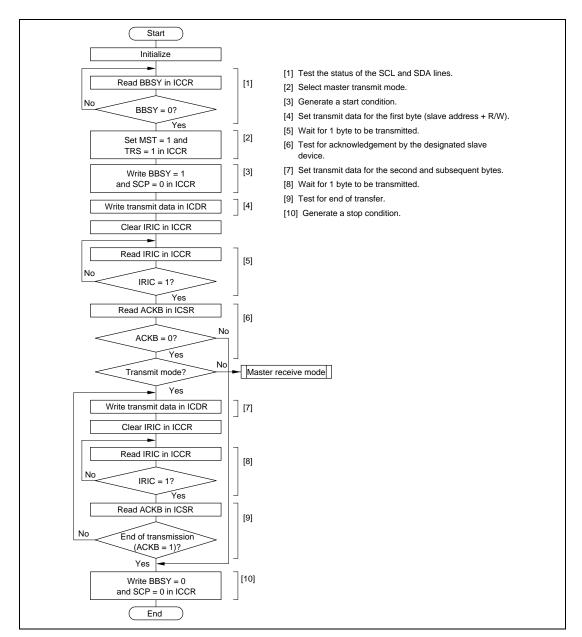


Figure 16.13 Block Diagram of Noise Canceler

16.3.10 Sample Flowcharts



Figures 16.14 to 16.17 show sample flowcharts for using the I²C bus interface in each mode.

Figure 16.14 Flowchart for Master Transmit Mode (Example)

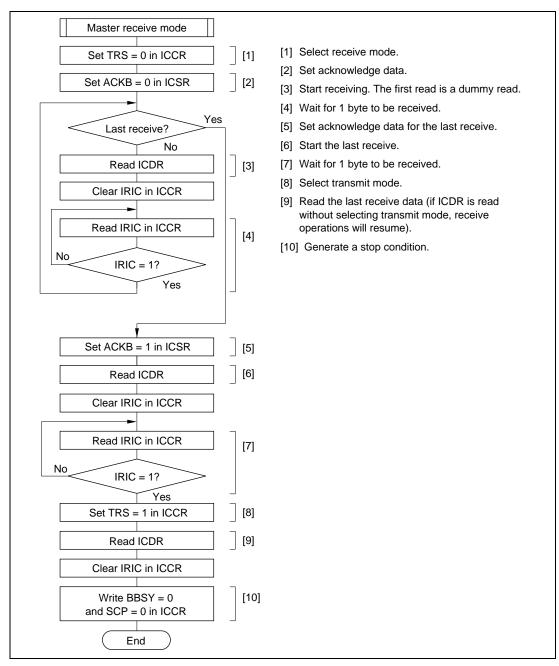


Figure 16.15 Flowchart for Master Receive Mode (Example)

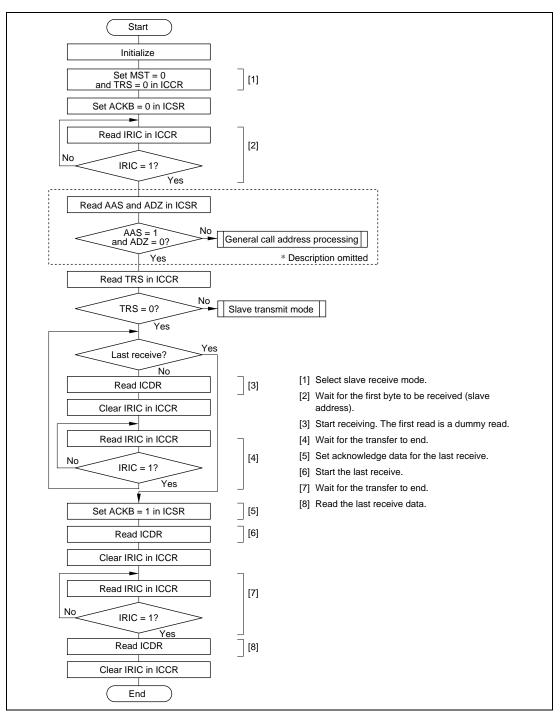


Figure 16.16 Flowchart for Slave Receive Mode (Example)

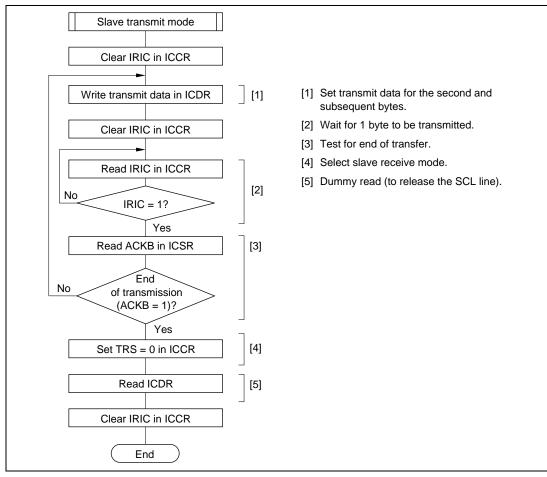


Figure 16.17 Flowchart for Slave Transmit Mode (Example)

16.3.11 Initialization of Internal State

The IIC has a function for forcible initialization of its internal state if a deadlock occurs during communication.

Initialization is executed in accordance with the setting of bits CLR3 to CLR0 in the DDCSWR register. For details see section 16.2.8, DDC Switch Register (DDCSWR).

Scope of Initialization: The initialization executed by this function covers the following items:

- TDRE and RDRF internal flags
- Transmit/receive sequencer and internal operating clock counter
- Internal latches for retaining the output state of the SCL and SDA pins (wait, clock, data output, etc.)

The following items are not initialized:

- Actual register values (ICDR, SAR, SARX, ICMR, ICCR, ICSR, DDCSWR, STCR)
- Internal latches used to retain register read information for setting/clearing flags in the ICMR, ICCR, ICSR, and DDCSWR registers
- The value of the ICMR register bit counter (BC2 to BC0)
- Generated interrupt sources (interrupt sources transferred to the interrupt controller)

Notes on Initialization:

- Interrupt flags and interrupt sources are not cleared, and so flag clearing measures must be taken as necessary.
- Basically, other register flags are not cleared either, and so flag clearing measures must be taken as necessary.
- The write data for bits CLR3 to CLR0 is not retained. To perform IIC clearance, bits CLR3 to CLR0 must be written to simultaneously using an MOV instruction. Do not use a bit manipulation instruction such as BCLR. Similarly, when clearing is required again, all the bits must be written to simultaneously in accordance with the setting.
- If a flag clearing setting is made during transmission/reception, the IIC module will stop transmitting/receiving at that point and the SCL and SDA pins will be released. When transmission/reception is started again, register initialization, etc., must be carried out as necessary to enable correct communication as a system.

The value of the BBSY bit cannot be modified directly by this module clear function, but since the stop condition pin waveform is generated according to the state and release timing of the SCL and SDA pins, the BBSY bit may be cleared as a result. Similarly, state switching of other bits and flags may also have an effect.

To prevent problems caused by these factors, the following procedure should be used when initializing the IIC state.

- 1. Execute initialization of the internal state according to the setting of bits CLR3 to CLR0.
- 2. Execute a stop condition issuance instruction (write 0 to BBSY and SCP) to clear the BBST bit to 0, and wait for two transfer rate clock cycles.
- 3. Re-execute initialization of the internal state according to the setting of bits CLR3 to CLR0.
- 4. Initialize (re-set) the IIC registers.

16.4 Usage Notes

- In master mode, if an instruction to generate a start condition is immediately followed by an instruction to generate a stop condition, neither condition will be output correctly. To output consecutive start and stop conditions, after issuing the instruction that generates the start condition, read the relevant ports, check that SCL and SDA are both low, then issue the instruction that generates the stop condition. Note that SCL may not yet have gone low when BBSY is cleared to 0.
- Either of the following two conditions will start the next transfer. Pay attention to these conditions when reading or writing to ICDR.
 - Write access to ICDR when ICE = 1 and TRS = 1 (including automatic transfer from ICDRT to ICDRS)
 - Read access to ICDR when ICE = 1 and TRS = 0 (including automatic transfer from ICDRS to ICDRR)
- Table 16.6 shows the timing of SCL and SDA output in synchronization with the internal clock. Timings on the bus are determined by the rise and fall times of signals affected by the bus load capacitance, series resistance, and parallel resistance.

Item	Symbol	Output Timing	Unit	Notes
SCL output cycle time	t _{sclo}	$28t_{_{cyc}}$ to $256t_{_{cyc}}$	ns	Figure 24.25
SCL output high pulse width	t _{sclho}	0.5t _{sclo}	ns	(reference)
SCL output low pulse width	t _{scllo}	0.5t _{sclo}	ns	-
SDA output bus free time	t _{bufo}	$0.5t_{\scriptscriptstyle SCLO} - 1t_{\scriptscriptstyle cyc}$	ns	-
Start condition output hold time	t _{staho}	$0.5t_{\scriptscriptstyle SCLO} - 1t_{\scriptscriptstyle cyc}$	ns	-
Retransmission start condition output setup time	t _{staso}	1t _{sclo}	ns	-
Stop condition output setup time	t _{stoso}	$0.5t_{sclo} + 2t_{cyc}$	ns	-
Data output setup time (master)	t _{sdaso}	$1t_{scllo} - 3t_{cyc}$	ns	-
Data output setup time (slave)		$1t_{scll} - (6t_{cyc} \text{ or } 12t_{cyc}^*)$		
Data output hold time	t _{sdaho}	3t _{cyc}	ns	-

Table 16.6 I²C Bus Timing (SCL and SDA Output)

Note: $*6t_{cvc}$ when IICX is 0, $12t_{cvc}$ when 1.

- SCL and SDA input is sampled in synchronization with the internal clock. The AC timing therefore depends on the system clock cycle t_{cyc}, as shown in table 24.10 in section 24, Electrical Characteristics. Note that the I²C bus interface AC timing specifications will not be met with a system clock frequency of less than 5 MHz.
- The I²C bus interface specification for the SCL rise time t_{sr} is under 1000 ns (300 ns for highspeed mode). In master mode, the I²C bus interface monitors the SCL line and synchronizes one bit at a time during communication. If t_{sr} (the time for SCL to go from low to V_{IH}) exceeds the time determined by the input clock of the I²C bus interface, the high period of SCL is extended. The SCL rise time is determined by the pull-up resistance and load capacitance of the SCL line. To insure proper operation at the set transfer rate, adjust the pull-up resistance and load capacitance so that the SCL rise time does not exceed the values given in the table below.

		Time Indication									
IICX	t _{cyc} Indication		I ² C Bus Specification (Max.)	ø = 5 MHz	ø = 8 MHz	ø = 10 MHz	ø = 16 MHz	ø = 20 MHz			
0	7.5t _{cyc}	Normal mode	1000 ns	1000 ns	937 ns	750 ns	468 ns	375 ns			
		High-speed mode	e 300 ns	300 ns	300 ns	300 ns	300 ns	300 ns			
1	17.5t _{cyc}	Normal mode	1000 ns	1000 ns	1000 ns	1000 ns	1000 ns	875 ns			
		High-speed mode	e 300 ns	300 ns	300 ns	300 ns	300 ns	300 ns			

Table 16.7 Permissible SCL Rise Time (t_{sR}) Values

• The I²C bus interface specifications for the SCL and SDA rise and fall times are under 1000 ns and 300 ns. The I²C bus interface SCL and SDA output timing is prescribed by t_{seve} and t_{eve}, as shown in table 16.6. However, because of the rise and fall times, the I²C bus interface specifications may not be satisfied at the maximum transfer rate. Table 16.8 shows output timing calculations for different operating frequencies, including the worst-case influence of rise and fall times.

 t_{BUFO} fails to meet the I²C bus interface specifications at any frequency. The solution is either (a) to provide coding to secure the necessary interval (approximately 1 µs) between issuance of a stop condition and issuance of a start condition, or (b) to select devices whose input timing permits this output timing for use as slave devices connected to the I²C bus.

 t_{scllo} in high-speed mode and t_{sTASO} in standard mode fail to satisfy the I²C bus interface specifications for worst-case calculations of t_{sr}/t_{sr} . Possible solutions that should be investigated include (a) adjusting the rise and fall times by means of a pull-up resistor and capacitive load, (b) reducing the transfer rate to meet the specifications, or (c) selecting devices whose input timing permits this output timing for use as slave devices connected to the I²C bus.

		Time Indication (at Maximum Transfer Rate) [ns]										
Item	t _{cyc} Indication		t _{sr} /t _{sr} Influence (Max.)	I ² C Bus Specifi- cation (Min.)	ø = 5 MHz	ø = 8 MHz	ø = 10 MHz	ø = 16 MHz	ø = 20 MHz			
t _{sclho}	0.5t _{sclo} (-t _{sr})	Standard mode	-1000	4000	4000	4000	4000	4000	4000			
		High-speed mode	-300	600	950	950	950	950	950			
t _{scllo}	0.5t _{sclo} (–t _{sf})	Standard mode	-250	4700	4750	4750	4750	4750	4750			
		High-speed mode	-250	1300	1000* ¹	1000*1	1000* ¹	1000*1	1000*1			
BUFO	$0.5t_{sclo}-1t_{cy}$, _c Standard mode	-1000	4700	3800* ¹	3875* ¹	3900* ¹	3938* ¹	3950* ¹			
	(t _{sr})	High-speed mode	-300	1300	750* ¹	825* ¹	850* ¹	888* ¹	900* ¹			
STAHO	0.5t _{sclo} -1t _{cy}	_{/c} Standard mode	-250	4000	4550	4625	4650	4688	4700			
	(-t _{sf})	High-speed mode	-250	600	800	875	900	938	950			
STASO	1t _{sclo} (-t _{sr})	Standard mode	-1000	4700	9000	9000	9000	9000	9000			
		High-speed mode	-300	600	2200	2200	2200	2200	2200			
STOSO	0.5t _{sclo} + 2t _{cyc}	Standard mode	-1000	4000	4400	4250	4200	4125	4100			
	(t _{sr})	High-speed mode	-300	600	1350	1200	1150	1075	1050			
sdaso (master)	1t _{scllo} * ³ – 3t _{cyc}	Standard mode	-1000	250	3100	3325	3400	3513	3550			
	(t _{sr})	High-speed mode	-300	100	400	625	700	813	850			
sdaso (slave)	1t _{scll} * ³ – 12t _{cyc} * ²	Standard mode	-1000	250	1300	2200	2500	2950	3100			
	$(-t_{sr})$	High-speed mode	-300	100	-1400* ¹	-500* ¹	-200* ¹	250	400			

Table 16.8 I^2C Bus Timing (with Maximum Influence of t_{sr}/t_{sr})

			Time Indication (at Maximum Transfer Rate) [ns]									
ltem	t _{cyc} Indication		t _s /t _{sr} Influence (Max.)	I ² C Bus Specifi- cation (Min.)	ø = 5 MHz	ø = 8 MHz	ø = 10 MHz	ø = 16 MHz	ø = 20 MHz			
t _{sdaho}	3t _{cyc}	Standard mode	0	0	600	375	300	188	150			
		High-speed mode	0	0	600	375	300	188	150			

Table 16.8I²C Bus Timing (with Maximum Influence of t_{sr}/t_{st}) (cont)

Notes: 1. Does not meet the I²C bus interface specification. Remedial action such as the following is necessary: (a) secure a start/stop condition issuance interval; (b) adjust the rise and fall times by means of a pull-up resistor and capacitive load; (c) reduce the transfer rate; (d) select slave devices whose input timing permits this output timing.

The values in the above table will vary depending on the settings of the IICX bit and bits CKS0 to CKS2. Depending on the frequency it may not be possible to achieve the maximum transfer rate; therefore, whether or not the I²C bus interface specifications are met must be determined in accordance with the actual setting conditions.

2. Value when the IICX bit is set to 1. When the IICX bit is cleared to 0, the value is $(t_{scll} - 6t_{eve})$.

3. Calculated using the I²C bus specification values (standard mode: 4700 ns min.; highspeed mode: 1300 ns min.).

• Note on ICDR Read at End of Master Reception

To halt reception at the end of a receive operation in master receive mode, set the TRS bit to 1 and write 0 to BBSY and SCP in ICCR. This changes SDA from low to high when SCL is high, and generates the stop condition. After this, receive data can be read by means of an ICDR read, but if data remains in the buffer the ICDRS receive data will not be transferred to ICDR, and so it will not be possible to read the second byte of data.

If it is necessary to read the second byte of data, issue the stop condition in master receive mode (i.e. with the TRS bit cleared to 0). When reading the receive data, first confirm that the BBSY bit in the ICCR register is cleared to 0, the stop condition has been generated, and the bus has been released, then read the ICDR register with TRS cleared to 0.

Note that if the receive data (ICDR data) is read in the interval between execution of the instruction for issuance of the stop condition (writing of 0 to BBSY and SCP in ICCR) and the actual generation of the stop condition, the clock may not be output correctly in subsequent master transmission.

Clearing of the MST bit after completion of master transmission/reception, or other modifications of IIC control bits to change the transmit/receive operating mode or settings, must be carried out during interval (a) in figure 16.18 (after confirming that the BBSY bit has been cleared to 0 in the ICCR register).

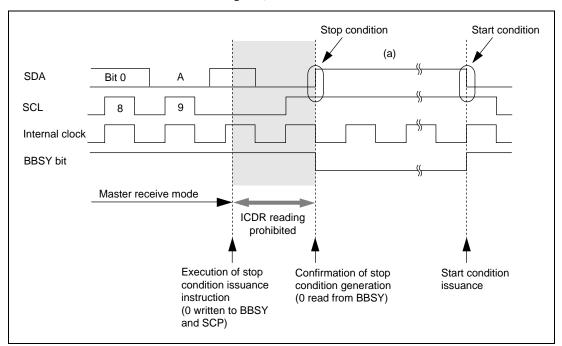


Figure 16.18 Points for Attention Concerning Reading of Master Receive Data

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Section 17 Host Interface

Provided in the H8S/2138 Series; not provided in the H8S/2134 Series.

17.1 Overview

The H8S/2138 Series has an on-chip host interface (HIF) that enables connection to an ISA bus, widely used as the internal bus in personal computers. The host interface provides a dualchannel parallel interface between the on-chip CPU and a host processor. The host interface is available only when the HI12E bit is set to 1 in SYSCR2. This mode is called slave mode, because it is designed for a master-slave communication system in which the H8S/2138 Series chip is slaved to a host processor.

17.1.1 Features

The features of the host interface are summarized below.

The host interface consists of 4-byte data registers, 2-byte status registers, a 1-byte control register, fast A20 gate logic, and a host interrupt request circuit. Communication is carried out via five control signals from the host processor ($\overline{CS1}$, $\overline{CS2}$ or $\overline{ECS2}$, HA0, \overline{IOR} , and \overline{IOW}), four output signals to the host processor (GA20, HIRQ1, HIRQ11, and HIRQ12), and an 8-bit bidirectional command/data bus (HDB7 to HDB0). The $\overline{CS1}$ and $\overline{CS2}$ (or $\overline{ECS2}$) signals select one of the two interface channels.

17.1.2 Block Diagram

Figure 17.1 shows a block diagram of the host interface.

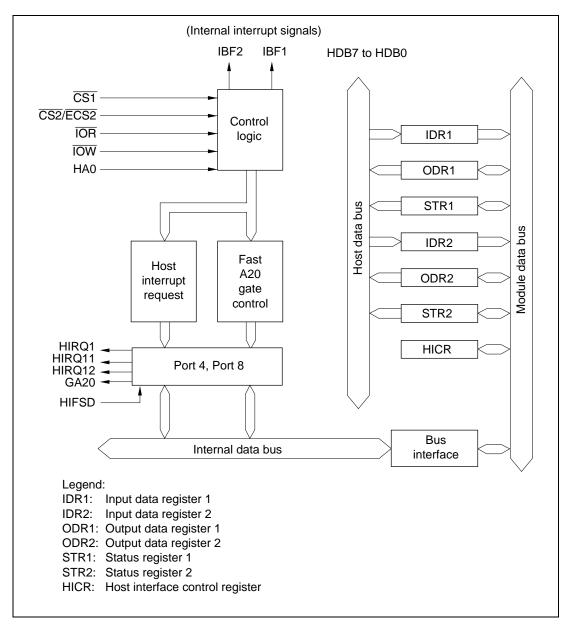


Figure 17.1 Block Diagram of Host Interface

17.1.3 Input and Output Pins

Table 17.1 lists the input and output pins of the host interface module.

Name	Abbreviation	Port	I/O	Function
I/O read	IOR	P93	Input	Host interface read signal
I/O write	ĪOW	P94	Input	Host interface write signal
Chip select 1	CS1	P95	Input	Host interface chip select signal for IDR1, ODR1, STR1
Chip select 2*	CS2	P81	Input	Host interface chip select signal for IDR2,
	ECS2	P90	_	ODR2, STR2
Command/data	HA0	P80	Input	Host interface address select signal.
				In host read access, this signal selects the status registers (STR1, STR2) or data registers (ODR1, ODR2). In host write access to the data registers (IDR1, IDR2), this signal indicates whether the host is writing a command or data.
Data bus	HDB7 to HDB0	P37 to P30	I/O	Host interface data bus
Host interrupt 1	HIRQ1	P44	Output	Interrupt output 1 to host
Host interrupt 11	HIRQ11	P43	Output	Interrupt output 11 to host
Host interrupt 12	HIRQ12	P45	Output	Interrupt output 12 to host
Gate A20	GA20	P81	Output	A20 gate control signal output
HIF shutdown	HIFSD	P82	Input	Host interface shutdown control signal

Note: *Selection of $\overline{CS2}$ or $\overline{ECS2}$ is by means of the CS2E bit in STCR and the FGA20E bit in HICR. Host interface channel 2 and the $\overline{CS2}$ pin can be used when CS2E = 1. When CS2E = 1, $\overline{CS2}$ is used when FGA20E =0, and $\overline{ECS2}$ is used when FGA20E = 1. In this manual, both are referred to as $\overline{CS2}$.

17.1.4 Register Configuration

Table 17.2 lists the host interface registers. Host interface registers HICR, IDR1, IDR2, ODR1, ODR2, STR1, and STR2 can only be accessed when the HIE bit is set to 1 in SYSCR.

Table 17.2	Host Interface Registers
-------------------	--------------------------

		R/W		Initial	Slave	Master Address* ⁴		
Name	Abbreviation	Slave	Host	Value	Address*3	CS1	CS2	HA0
System control register	SYSCR	R/W* ¹	_	H'09	H'FFC4	_	_	_
System control register 2	SYSCR2	R/W	_	H'00	H'FF83		_	_
Host interface control register	HICR	R/W	_	H'F8	H'FFF0	_	—	_
Input data register 1	IDR1	R	W	_	H'FFF4	0	1	0/1*5
Output data register 1	ODR1	R/W	R	_	H'FFF5	0	1	0
Status register 1	STR1	R/(W)* ²	R	H'00	H'FFF6	0	1	1
Input data register 2	IDR2	R	W	_	H'FFFC	1	0	0/1*5
Output data register 2	ODR2	R/W	R	_	H'FFFD	1	0	0
Status register 2	STR2	R/(W)* ²	R	H'00	H'FFFE	1	0	1
Module stop control	MSTPCRH	R/W	—	H'3F	H'FF86	_	—	—
register	MSTPCRL	R/W	_	H'FF	H'FF87	_	_	_

Notes: 1. Bits 5 and 3 are read-only bits.

2. The user-defined bits (bits 7 to 4 and 2) are read/write accessible from the slave processor.

- 3. Address when accessed from the slave processor. The lower 16 bits of the address are shown.
- 4. Pin inputs used in access from the host processor.
- 5. The HA0 input discriminates between writing of commands and data.

17.2 Register Descriptions

17.2.1 System Control Register (SYSCR)

Bit	7	6	5	4	3	2	1	0
	CS2E	IOSE	INTM1	INTM0	XRST	NMIEG	HIE	RAME
Initial value	0	0	0	0	1	0	0	1
Read/Write	R/W	R/W	R	R/W	R	R/W	R/W	R/W

SYSCR is an 8-bit readable/writable register which controls H8S/2138 Series chip operations. Of the host interface registers, HICR, IDR1, ODR1, STR1, IDR2, ODR2, and STR2 can only be accessed when the HIE bit is set to 1. The host interface $\overline{CS2}$ and $\overline{ECS2}$ pins are controlled by the CS2E bit in SYSCR and the FGA20E bit in HICR. See section 3.2.2, System Control Register (SYSCR), and section 5.2.1, System Control Register (SYSCR), for information on other SYSCR bits. SYSCR is initialized to H'09 by a reset and in hardware standby mode.

Bit 7—CS2 Enable Bit (CS2E): Used together with the FGA20E bit in HICR to select the pin that performs the $\overline{CS2}$ function.

SYSCR Bit 7	HICR Bit 0		
CS2E	FGA20E	Description	
0	0	$\overline{\text{CS2}}$ pin function halted ($\overline{\text{CS2}}$ fixed high internally)	(Initial value)
	1	_	
1	0	CS2 pin function selected for P81/CS2 pin	
_	1	CS2 pin function selected for P90/ECS2 pin	

Bit 1—Host Interface Enable (HIE): Enables or disables CPU access to the host interface registers. When enabled, the host interface registers (HICR, IDR1, ODR1, STR1, IDR2, ODR2, and STR2) can be accessed.

Bit 1

HIE	Description
0	Host interface register (HICR, IDR1, ODR1, STR1, IDR2, ODR2, STR2), CPU access is disabled (Initial value)
1	Host interface register (HICR, IDR1, ODR1, STR1, IDR2, ODR2, STR2), CPU access is enabled

17.2.2 System Control Register 2 (SYSCR2)

Bit	7	6	5	4	3	2	1	0
	KWUL1	KWUL0	P6PUE	_	SDE	CS4E	CS3E	HI12E
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	_	R/W	R/W	R/W	R/W

SYSCR2 is an 8-bit readable/writable register which controls chip operations. Host interface functions are enabled or disabled by the HI12E bit in SYSCR2. SYSCR2 is initialized to H'00 by a reset and in hardware standby mode.

Bits 7 and 6—Key Wakeup Level 1 and 0 (KWUL1, KWUL0): The port 6 input level can be set and changed by software. For details see section 8, I/O Ports.

Bit 5—Port 6 Input Pull-Up Extra (P6PUE): Controls and selects the current specification for the port 6 MOS input pull-up function connected by means of KMPCR settings. For details see section 8, I/O Ports.

Bit 4—Reserved: Do not write 1 to this bit.

Bit 3—Shutdown Enable (SDE): Enables or disables the host interface pin shutdown function. When this function is enabled, host interface pin functions can be halted, and the pins placed in the high-impedance state, according to the state of the HIFSD pin.

Bit 3

SDE	Description	
0	Host interface pin shutdown function disabled	(Initial value)
1	Host interface pin shutdown function enabled	

Bit 2—CS4 Enable (CS4E): Reserved. Do not write 1 to this bit.

Bit 1—CS3 Enable (CS3E): Reserved. Do not write 1 to this bit.

Bit 0—Host Interface Enable Bit (HI12E): Enables or disables host interface functions in single-chip mode. When the host interface functions are enabled, slave mode is entered and processing is performed for data transfer between the slave and host.

Description	
Host interface functions are disabled	(Initial value)
Host interface functions are enabled	
	Host interface functions are disabled

17.2.3 Host Interface Control Register (HICR)

Bit	7	6	5	4	3	2	1	0
	_	_	—	_	_	IBFIE2	IBFIE1	FGA20E
Initial value	1	1	1	1	1	0	0	0
Slave Read/Write	_	—	—	—	—	R/W	R/W	R/W
Host Read/Write	_	_	_	_	_	_	_	_

HICR is an 8-bit readable/writable register which controls host interface interrupts and the fast A20 gate function. HICR is initialized to H'F8 by a reset and in hardware standby mode.

Bits 7 to 3—Reserved: These bits cannot be modified and are always read as 1.

Bit 2—Input Data Register Full Interrupt Enable 2 (IBFIE2): Enables or disables the IBF2 interrupt to the internal CPU.

Bit	2
-----	---

IBFIE2	 Description	
0	Input data register (IDR2) receive complete interrupt is disabled	(Initial value)
1	Input data register (IDR2) receive complete interrupt is enabled	

Bit 1— Input Data Register Full Interrupt Enable 1 (IBFIE1): Enables or disables the IBF1 interrupt to the internal CPU.

Bit 1

IBFIE1	Description	
0	Input data register (IDR1) receive complete interrupt is disabled	(Initial value)
1	Input data register (IDR1) receive complete interrupt is enabled	

Bit 0—Fast Gate A20 Enable (FGA20E): Enables or disables the fast A20 gate function. When the fast A20 gate is disabled, a regular-speed A20 gate signal can be implemented by using firmware to manipulate the P81 output.

Bit	0
-----	---

FGA20E	_ Description	
0	Fast A20 gate function is disabled	(Initial value)
1	Fast A20 gate function is enabled	

17.2.4 Input Data Register 1 (IDR1)

Bit	7	6	5	4	3	2	1	0
	IDR7	IDR6	IDR5	IDR4	IDR3	IDR2	IDR1	IDR0
Initial value	_	_	_		_	_	_	_
Slave Read/Write	R	R	R	R	R	R	R	R
Host Read/Write	W	W	W	W	W	W	W	W

IDR1 is an 8-bit read-only register to the slave processor, and an 8-bit write-only register to the host processor. When $\overline{CS1}$ is low, information on the host data bus is written into IDR1 at the rising edge of \overline{IOW} . The HA0 state is also latched into the C/ \overline{D} bit in STR1 to indicate whether the written information is a command or data.

The initial values of IDR1 after a reset and in standby mode are undetermined.

17.2.5 Output Data Register 1 (ODR1)

Bit	7	6	5	4	3	2	1	0
	ODR7	ODR6	ODR5	ODR4	ODR3	ODR2	ODR1	ODR0
Initial value	—				_		_	_
Slave Read/Write	R/W							
Host Read/Write	R	R	R	R	R	R	R	R

ODR1 is an 8-bit readable/writable register to the slave processor, and an 8-bit read-only register to the host processor. The ODR1 contents are output on the host data bus when HA0 is low, $\overline{CS1}$ is low, and \overline{IOR} is low.

The initial values of ODR1 after a reset and in standby mode are undetermined.

17.2.6 Status Register 1 (STR1)

Bit	7	6	5	4	3	2	1	0
	DBU	DBU	DBU	DBU	C/D	DBU	IBF	OBF
Initial value	0	0	0	0	0	0	0	0
Slave Read/Write	R/W	R/W	R/W	R/W	R	R/W	R	R/(W)*
Host Read/Write	R	R	R	R	R	R	R	R

Note: * Only 0 can be written, to clear the flag.

STR1 is an 8-bit register that indicates status information during host interface processing. Bits 3, 1, and 0 are read-only bits to both the host and slave processors.

STR1 is initialized to H'00 by a reset and in hardware standby mode.

Bits 7 to 4 and Bit 2—Defined by User (DBU): The user can use these bits as necessary.

Bit 3—Command/Data (C/\overline{D}): Receives the HA0 input when the host processor writes to IDR1, and indicates whether IDR1 contains data or a command.

Bit 3		
C/D	Description	
0	Contents of input data register (IDR1) are data	(Initial value)
1	Contents of input data register (IDR1) are a command	

Bit 1—Input Buffer Full (IBF): Set to 1 when the host processor writes to IDR1. This bit is an internal interrupt source to the slave processor. IBF is cleared to 0 when the slave processor reads IDR1.

The IBF flag setting and clearing conditions are different when the fast A20 gate is used. For details see table 17.8, Fast A20 Gate Output Signals.

Bit 1

IBF	Description	
0	[Clearing condition]	
	When the slave processor reads IDR1	(Initial value)
1	[Setting condition]	
	When the host processor writes to IDR1	

Bit 0—Output Buffer Full (OBF): Set to 1 when the slave processor writes to ODR1. Cleared to 0 when the host processor reads ODR1.

Bit 0

OBF	Description
0	[Clearing condition]
	When the host processor reads ODR1 or the slave writes 0 in the OBF bit (Initial value)
1	[Setting condition]
	When the slave processor writes to ODR1

Table 17.3 shows the conditions for setting and clearing the STR1 flags.

Flag	Setting Condition	Clearing Condition
C/D	Rising edge of host's write signal (\overline{IOW}) when HA0 is high	Rising edge of host's write signal (IOW) when HA0 is low
IBF*	Rising edge of host's write signal (IOW) when writing to IDR1	Falling edge of slave's internal read signal (RD) when reading IDR1
OBF	Falling edge of slave's internal write signal (WR) when writing to ODR1	Rising edge of host's read signal (IOR) when reading ODR1

Note: *The IBF flag setting and clearing conditions are different when the fast A20 gate is used. For details see table 17.8, Fast A20 Gate Output Signals.

17.2.7 Input Data Register 2 (IDR2)

Bit	7	6	5	4	3	2	1	0
	IDR7	IDR6	IDR5	IDR4	IDR3	IDR2	IDR1	IDR0
Initial value	—	_	_	_	_		_	_
Slave Read/Write	R	R	R	R	R	R	R	R
Host Read/Write	W	W	W	W	W	W	W	W

IDR2 is an 8-bit read-only register to the slave processor, and an 8-bit write-only register to the host processor. When $\overline{CS2}$ is low, information on the host data bus is written into IDR2 at the rising edge of \overline{IOW} . The HA0 state is also latched into the C/ \overline{D} bit in STR2 to indicate whether the written information is a command or data.

The initial values of IDR2 after a reset and in standby mode are undetermined.

17.2.8 Output Data Register 2 (ODR2)

Bit	7	6	5	4	3	2	1	0
	ODR7	ODR6	ODR5	ODR4	ODR3	ODR2	ODR1	ODR0
Initial value	_	_					_	_
Slave Read/Write	R/W							
Host Read/Write	R	R	R	R	R	R	R	R

ODR2 is an 8-bit readable/writable register to the slave processor, and an 8-bit read-only register to the host processor. The ODR2 contents are output on the host data bus when HA0 is low, $\overline{CS2}$ is low, and \overline{IOR} is low.

The initial values of ODR2 after a reset and in standby mode are undetermined.

17.2.9 Status Register 2 (STR2)

Bit	7	6	5	4	3	2	1	0
	DBU	DBU	DBU	DBU	C/D	DBU	IBF	OBF
Initial value	0	0	0	0	0	0	0	0
Slave Read/Write	R/W	R/W	R/W	R/W	R	R/W	R	R/(W)*
Host Read/Write	R	R	R	R	R	R	R	R

Note: * Only 0 can be written, to clear the flag.

STR2 is an 8-bit register that indicates status information during host interface processing. Bits 3, 1, and 0 are read-only bits to both the host and slave processors.

STR2 is initialized to H'00 by a reset and in hardware standby mode.

Bits 7 to 4 and Bit 2—Defined by User (DBU): The user can use these bits as necessary.

Bit 3—Command/Data (C/\overline{D}): Receives the HA0 input when the host processor writes to IDR2, and indicates whether IDR2 contains data or a command.

Bit 3

C/D	Description	
0	Contents of input data register (IDR2) are data	(Initial value)
1	Contents of input data register (IDR2) are a command	

Bit 1—Input Buffer Full (IBF): Set to 1 when the host processor writes to IDR2. This bit is an internal interrupt source to the slave processor. IBF is cleared to 0 when the slave processor reads IDR2.

The IBF flag setting and clearing conditions are different when the fast A20 gate is used. For details see table 17.8, Fast A20 Gate Output Signals.

Bit 1		
IBF	Description	
0	[Clearing condition]	
	When the slave processor reads IDR2	(Initial value)
1	[Setting condition]	
	When the host processor writes to IDR2	

Bit 0—Output Buffer Full (OBF): Set to 1 when the slave processor writes to ODR2. Cleared to 0 when the host processor reads ODR2. The IBF flag setting and clearing conditions are different when the fast A20 gate is used. For details see table 17.8, Fast A20 Gate Output Signals.

Bit 0

OBF	Description
0	[Clearing condition]
	When the host processor reads ODR2 or the slave writes 0 in the OBF bit (Initial value)
1	[Setting condition]
	When the slave processor writes to ODR2

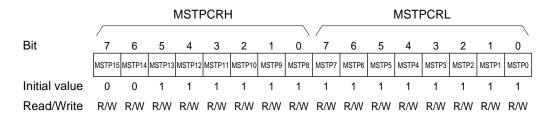
Table 17.4 shows the conditions for setting and clearing the STR2 flags.

Table 17.4 Set/Clear Timing for STR2 Flags

Flag	Setting Condition	Clearing Condition
C/D	Rising edge of host's write signal (IOW) when HA0 is high	Rising edge of host's write signal (\overline{IOW}) when HA0 is low
IBF*	Rising edge of host's write signal (IOW) when writing to IDR2	Falling edge of slave's internal read signal (RD) when reading IDR2
OBF	Falling edge of slave's internal write signal (\overline{WR}) when writing to ODR2	Rising edge of host's read signal (IOR) when reading ODR2

Note: *The IBF flag setting and clearing conditions are different when the fast A20 gate is used. For details see table 17.8, Fast A20 Gate Output Signals.

17.2.10 Module Stop Control Register (MSTPCR)



MSTPCR, comprising two 8-bit readable/writable registers, performs module stop mode control. When the MSTP2 bit is set to 1, the host interface halts and enters module stop mode. See section 23.5, Module Stop Mode, for details.

MSTPCR is initialized to H'3FFF by a reset and in hardware standby mode. It is not initialized in software standby mode.

MSTPCRL Bit 2-Module Stop (MSTP2): Specifies host interface module stop mode.

MSTPCRL Bit 2		
MSTP2	Description	
0	Host interface module stop mode is cleared	
1	Host interface module stop mode is set	(Initial value)

17.3 Operation

17.3.1 Host Interface Operation

The host interface is activated by setting the HI12E bit (bit 0) to 1 in SYSCR2 in single-chip mode, establishing slave mode. Activation of the host interface (entry to slave mode) appropriates the related I/O lines in port 3 (data), port 8 or 9 (control) and port 4 (host interrupt requests) for interface use.

Table 17.5 shows HIF host interface channel selection and pin operation.

HI12E	CS2E	Operation
0		Host interface functions halted
1	0	Host interface channel 1 only operating
		Operation of channel 2 halted
		(No operation as $\overline{\text{CS2}}$ or $\overline{\text{ECS2}}$ input. Pins P43, P81, and P90 operate as I/O ports.)
	1	Host interface channel 1 and 2 functions operating

 Table 17.5
 Host Interface Channel Selection and Pin Operation

For host read/write timing, see section 24.3.4, On-Chip Supporting Module Timing.

17.3.2 Control States

Table 17.6 indicates the slave operations carried out in response to host interface signals from the host processor.

CS2	CS1	IOR	IOW	HA0	Operation
1	0	0	0	0	Setting prohibited
				1	Setting prohibited
			1	0	Data read from output data register 1 (ODR1)
				1	Status read from status register 1 (STR1)
		1	0	0	Data write to input data register 1 (IDR1)
				1	Command write to input data register 1 (IDR1)
			1	0	Idle state
				1	Idle state
)	1	0	0	0	Setting prohibited
				1	Setting prohibited
			1	0	Data read from output data register 2 (ODR2)
				1	Status read from status register 2 (STR2)
		1	0	0	Data write to input data register 2 (IDR2)
				1	Command write to input data register 2 (IDR2)
			1	0	Idle state
				1	Idle state

 Table 17.6
 Host Interface Operation

17.3.3 A20 Gate

The A20 gate signal can mask address A20 to emulate an addressing mode used by personal computers with an 8086*-family CPU. In slave mode, a regular-speed A20 gate signal can be output under firmware control, or a fast A20 gate signal can be output under hardware control. Fast A20 gate output is enabled by setting the FGA20E bit (bit 0) to 1 in HICR (H'FFF0).

Note: * Intel microprocessor.

Regular A20 Gate Operation: Output of the A20 gate signal can be controlled by an H'D1 command followed by data. When the slave processor receives data, it normally uses an interrupt routine activated by the IBF1 interrupt to read IDR1. If the data follows an H'D1 command, software copies bit 1 of the data and outputs it at the gate A20 pin.

Fast A20 Gate Operation: When the FGA20E bit is set to 1, P81/GA20 is used for output of a fast A20 gate signal. Bit P81DDR must be set to 1 to assign this pin for output. The initial output from this pin will be a logic 1, which is the initial value. Afterward, the host processor can manipulate the output from this pin by sending commands and data. This function is available only when register IDR1 is accessed using $\overline{CS1}$. Slave logic decodes the commands input from the host processor. When an H'D1 host command is detected, bit 1 of the data following the host command is output from the GA20 output pin. This operation does not depend on firmware or interrupts, and is faster than the regular processing using interrupts. Table 17.7 lists the conditions that set and clear GA20 (P81). Figure 17.2 shows the GA20 output in flowchart form. Table 17.8 indicates the GA20 output signal values.

Table 17.7 GA20 (P81) Set/Clear Timing

Pin Name	Setting Condition	Clearing Condition
GA20 (P81)	Rising edge of the host's write signal (IOW) when bit 1 of the written data is 1 and the data follows an H'D1 host command	Rising edge of the host's write signal (IOW) when bit 1 of the written data is 0 and the data follows an H'D1 host command
		Also, when bit FGA20E in HICR is cleared to 0

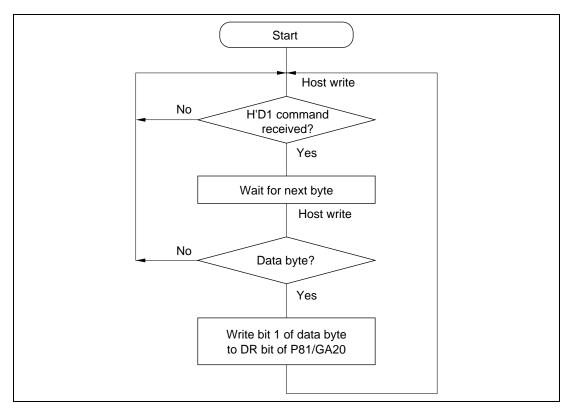


Figure 17.2 GA20 Output

HA0	Data/Command	Internal CPU Interrupt Flag (IBF)	GA20 (P81)	Remarks
			· /	
1	H'D1 command	0	Q	Turn-on sequence
0	1 data* ¹	0	1	
1	H'FF command	0	Q (1)	
1	H'D1 command	0	Q	Turn-off sequence
0	0 data* ²	0	0	
1	H'FF command	0	Q (0)	
1	H'D1 command	0	Q	Turn-on sequence
0	1 data* ¹	0	1	(abbreviated form)
1/0	Command other than H'FF	1	Q (1)	
	and H'D1			
1	H'D1 command	0	Q	Turn-off sequence
0	0 data* ²	0	0	(abbreviated form)
1/0	Command other than H'FF	1	Q (0)	
	and H'D1		. ,	
1	H'D1 command	0	Q	Cancelled sequence
1	Command other than H'D1	1	Q	
1	H'D1 command	0	Q	Retriggered sequence
1	H'D1 command	0	Q	
1	H'D1 command	0	Q	Consecutively executed
0	Any data	0	1/0	sequences
1	H'D1 command	0	Q(1/0)	

Table 17.8 Fast A20 Gate Output Signal

Notes: 1. Arbitrary data with bit 1 set to 1.

2. Arbitrary data with bit 1 cleared to 0.

17.3.4 Host Interface Pin Shutdown Function

Host interface output can be placed in the high-impedance state according to the state of the HIFSD pin. Setting the SDE bit to 1 in the SYSCR2 register enables the HIFSD pin is slave mode. The HIF constantly monitors the HIFSD pin, and when this pin goes low, places the host interface output pins (HIRQ1, HIRQ11, HIRQ12, and GA20) in the high-impedance state. At the same time, the host interface input pins ($\overline{CS1}$, $\overline{CS2}$ or $\overline{ECS2}$, \overline{IOW} , \overline{IOR} , and HA0) are disabled (fixed at the high input state internally) regardless of the pin states, and the signals of the multiplexed functions of these pins (input block) are similarly fixed internally. As a result, the host interface I/O pins (HDB7 to HDB0) also go to the high-impedance state.

This state is maintained while the HIFSD pin is low, and when the HIFSD pin returns to the high-level state, the pins are restored to their normal operation as host interface pins.

Table 17.9 shows the scope of HIF pin shutdown in slave mode.

		Scope of Shutdown in		
Abbreviation	Port	Slave Mode	I/O	Selection Conditions
IOR	P93	0	Input	Slave mode
ĪOW	P94	0	Input	Slave mode
CS1	P95	0	Input	Slave mode
CS2	P81	Δ	Input	Slave mode and CS2E = 1 and FGA20E = 0
ECS2	P90	Δ	Input	Slave mode and CS2E = 1 and FGA20E = 1
HA0	P80	0	Input	Slave mode
HDB7 to	P37 to	0	I/O	Slave mode
HDB0	P30			
HIRQ11	P43	Δ	Output	Slave mode and CS2E = 1 and P43DDR = 1
HIRQ1	P44	Δ	Output	Slave mode and P44DDR = 1
HIRQ12	P45	Δ	Output	Slave mode and P45DDR = 1
GA20	P81	Δ	Output	Slave mode and FGA20E = 1
HIFSD	P82		Input	Slave mode and SDE = 1

Table 17.9 Scope of HIF Pin Shutdown in Slave Mode

Notes: Slave mode: Single-chip mode and HI12E = 1

O: Pins shut down by shutdown function

The IRQ2/ADTRG input signal is also fixed in the case of P90 shutdown, the TMCI1/HSYNCI signal in the case of P43 shutdown, and the TMRI/CSYNCI in the case of P45 shutdown.

Δ: Pins shut down only when the HIF function is selected by means of a register setting

-: Pin not shut down

17.4 Interrupts

17.4.1 IBF1, IBF2

The host interface can issue two interrupt requests to the slave CPU: IBF1 and IBF2. They are input buffer full interrupts for input data registers IDR1 and IDR2 respectively. Each interrupt is enabled when the corresponding enable bit is set.

Table 17.10 Input Buffer Full Interrupts

Interrupt	Description
IBF1	Requested when IBFIE1 is set to 1 and IDR1 is full
IBF2	Requested when IBFIE2 is set to 1 and IDR2 is full

17.4.2 HIRQ11, HIRQ1, and HIRQ12

In slave mode (single-chip mode, with HI12E = 1 in SYSCR2), bits P45DR to P43DR in the port 4 data register (P4DR) can be used as host interrupt request latches.

These three P4DR bits are cleared to 0 by the host processor's read signal (\overline{IOR}). If $\overline{CS1}$ and HA0 are low, when \overline{IOR} goes low and the host reads ODR1, HIRQ1 and HIRQ12 are cleared to 0. If $\overline{CS2}$ and HA0 are low, when \overline{IOR} goes low and the host reads ODR2, HIRQ11 is cleared to 0. To generate a host interrupt request, normally on-chip firmware writes 1 in the corresponding bit. In processing the interrupt, the host's interrupt handling routine reads the output data register (ODR1 or ODR2), and this clears the host interrupt latch to 0.

Table 17.11 indicates how these bits are set and cleared. Figure 17.3 shows the processing in flowchart form.

Host Interrupt Signal	Setting Condition	Clearing Condition
HIRQ11 (P43)	Slave CPU reads 0 from bit P43DR, then writes 1	Slave CPU writes 0 in bit P43DR, or host reads output data register 2
HIRQ1 (P44)	Slave CPU reads 0 from bit P44DR, then writes 1	Slave CPU writes 0 in bit P44DR, or host reads output data register 1
HIRQ12 (P45)	Slave CPU reads 0 from bit P45DR, then writes 1	Slave CPU writes 0 in bit P45DR, or host reads output data register 1

Table 17.11 HIRQ Setting/Clearing Conditions

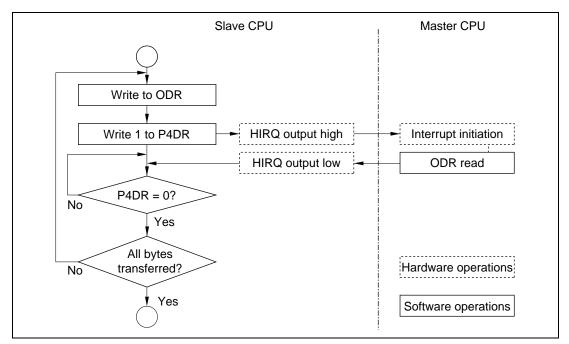


Figure 17.3 HIRQ Output Flowchart

HIRQ Setting/Clearing Contention: If there is contention between a P4DR read/write by the CPU and P4DR (HIRQ11, HIRQ1, HIRQ12) clearing by the host, clearing by the host is held pending during the P4DR read/write by the CPU. P4DR clearing is executed after completion of the read/write.

17.5 Usage Note

The host interface provides buffering of asynchronous data from the host and slave processors, but an interface protocol must be followed to implement necessary functions and avoid data contention. For example, if the host and slave processors try to access the same input or output data register simultaneously, the data will be corrupted. Interrupts can be used to design a simple and effective protocol.

Also, if $\overline{CS1}$ and $\overline{CS2}$ or $\overline{ECS2}$ are driven low simultaneously in attempting IDR or ODR access, signal contention will occur within the chip, and a through-current may result. This usage must therefore be avoided.

Section 18 D/A Converter

18.1 Overview

The H8S/2138 Series and H8S/2134 Series have an on-chip D/A converter module with two channels.

18.1.1 Features

Features of the D/A converter module are listed below.

- Eight-bit resolution
- Two-channel output
- Maximum conversion time: 10 µs (with 20-pF load capacitance)
- Output voltage: 0 V to AV_{cc}
- D/A output retention in software standby mode

18.1.2 Block Diagram

Figure 18.1 shows a block diagram of the D/A converter.

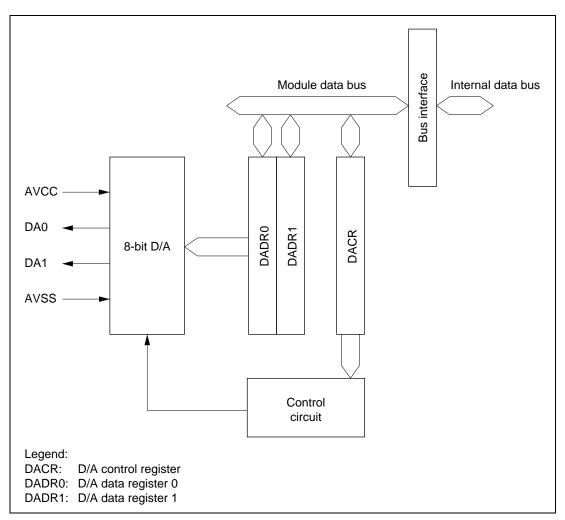


Figure 18.1 Block Diagram of D/A Converter

18.1.3 Input and Output Pins

Table 18.1 lists the input and output pins used by the D/A converter module.

Table 18.1 Input and Output Pins of D/A Converter Module

Name	Abbreviation	I/O	Function
Analog supply voltage	AVCC	Input	Power supply for analog circuits
Analog ground	AVSS	Input	Ground and reference voltage for analog circuits
Analog output 0	DA0	Output	Analog output channel 0
Analog output 1	DA1	Output	Analog output channel 1

18.1.4 Register Configuration

Table 18.2 lists the registers of the D/A converter module.

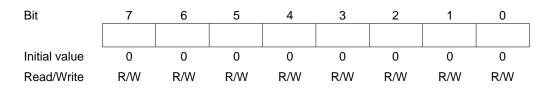
Table 18.2D/A Converter Registers

Name	Abbreviation	R/W	Initial Value	Address*
D/A data register 0	DADR0	R/W	H'00	H'FFF8
D/A data register 1	DADR1	R/W	H'00	H'FFF9
D/A control register	DACR	R/W	H'1F	H'FFFA
Module stop control register	MSTPCRH	R/W	H'3F	H'FF86
	MSTPCRL	R/W	H'FF	H'FF87

Note: * Lower 16 bits of the address.

18.2 Register Descriptions

18.2.1 D/A Data Registers 0 and 1 (DADR0, DADR1)



D/A data registers 0 and 1 (DADR0 and DADR1) are 8-bit readable/writable registers that store data to be converted. When analog output is enabled, the value in the D/A data register is converted and output continuously at the analog output pin.

The D/A data registers are initialized to H'00 by a reset and in hardware standby mode.

18.2.2 D/A Control Register (DACR)

Bit	7	6	5	4	3	2	1	0
	DAOE1	DAOE0	DAE	—	—	—	_	—
Initial value	0	0	0	1	1	1	1	1
Read/Write	R/W	R/W	R/W	—	—	_	_	_

DACR is an 8-bit readable/writable register that controls the operation of the D/A converter module.

DACR is initialized to H'1F by a reset and in hardware standby mode.

Bit 7-D/A Output Enable 1 (DAOE1): Controls D/A conversion and analog output.

Bit 7 DAOE1	Description		
0	Analog output DA1 is disabled	(Initial value)	
1	D/A conversion is enabled on channel 1. Analog output DA1 is enabled		

Bit 6—D/A Output Enable 0 (DAOE0): Controls D/A conversion and analog output	lt.
--	-----

Bit 6 DAOE0	Description		
0	Analog output DA0 is disabled	(Initial value)	
1	D/A conversion is enabled on channel 0. Analog output DA0 is enabled		

Bit 5—D/A Enable (DAE): Controls D/A conversion, in combination with bits DAOE0 and DAOE1. D/A conversion is controlled independently on channels 0 and 1 when DAE = 0. Channels 0 and 1 are controlled together when DAE = 1.

Output of the converted results is always controlled independently by DAOE0 and DAOE1.

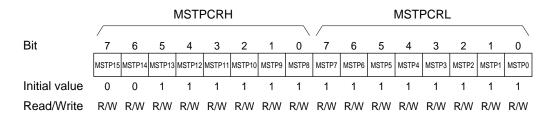
Bit 7 DAOE1	Bit 6 DAOE0	Bit 5 DAE	D/A conversion	
0	0	*	Disabled on channels 0 and 1	
	1	0	Enabled on channel 0 Disabled on channel 1	
		1	Enabled on channels 0 and 1	
1	0	0	Disabled on channel 0 Enabled on channel 1	
		1	Enabled on channels 0 and 1	
	1	*	Enabled on channels 0 and 1	

*: Don't care

If the H8S/2138 Series chip enters software standby mode while D/A conversion is enabled, the D/A output is retained and the analog power supply current is the same as during D/A conversion. If it is necessary to reduce the analog power supply current in software standby mode, disable D/A output by clearing both the DAOE0, DAOE1 and DAE bits to 0.

Bits 4 to 0—Reserved: These bits cannot be modified and are always read as 1.

18.2.3 Module Stop Control Register (MSTPCR)



MSTPCR, comprising two 8-bit readable/writable registers, performs module stop mode control. When the MSTP10 bit is set to 1, the D/A converter halts and enters module stop mode at the end of the bus cycle. See section 23.5, Module Stop Mode, for details.

MSTPCR is initialized to H'3FFF by a reset and in hardware standby mode. It is not initialized in software standby mode.

Bit 10—Module Stop (MSTP10): Specifies D/A converter module stop mode.

MSTPCRH Bit 2		
MSTP10	Description	
0	D/A converter module stop mode is cleared	
1	D/A converter module stop mode is set	(Initial value)

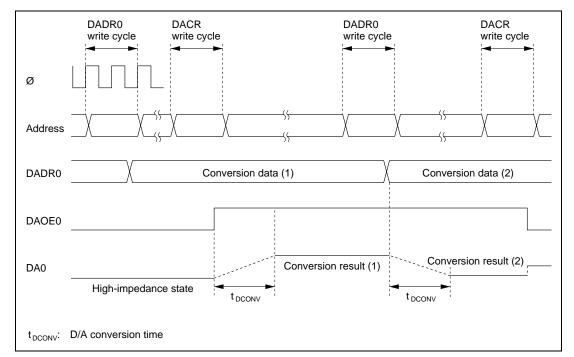
18.3 Operation

The D/A converter module has two built-in D/A converter circuits that can operate independently.

D/A conversion is performed continuously whenever enabled by the D/A control register (DACR). When a new value is written in DADR0 or DADR1, conversion of the new value begins immediately. The converted result is output by setting the DAOE0 or DAOE1 bit to 1.

An example of conversion on channel 0 is given next. Figure 18.2 shows the timing.

- Software writes the data to be converted in DADR0.
- D/A conversion begins when the DAOE0 bit in DACR is set to 1. After the elapse of the conversion time, analog output appears at the DA0 pin. Output of the converted result begins after the conversion time. The output value is AVcc × (DADR value)/256. This output continues until a new value is written in DADR0 or the DAOE0 bit is cleared to 0.
- If a new value is written in DADR0, conversion begins immediately. Output of the converted result begins after the conversion time.



• When the DAOE0 bit is cleared to 0, DA0 becomes an input pin.

Figure 18.2 D/A Conversion (Example)

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Section 19 A/D Converter

19.1 Overview

The H8S/2138 Series and H8S/2134 Series incorporate a 10-bit successive-approximations A/D converter that allows up to eight analog input channels to be selected.

In addition to the eight analog input channels, up to 8 channels of digital input can be selected for A/D conversion. Since the conversion precision falls to the equivalent of 6-bit resolution when digital input is selected, digital input is ideal for use by a comparator identifying multivalued inputs, for example.

19.1.1 Features

A/D converter features are listed below.

- 10-bit resolution
- Eight (analog) or 8 (digital) input channels
- Settable analog conversion voltage range
 - The analog conversion voltage range is set using the analog power supply voltage pin (AVcc) as the analog reference voltage
- High-speed conversion
 - Minimum conversion time: 6.7 µs per channel (at 20 MHz operation)
- Choice of single mode or scan mode
 - Single mode: Single-channel A/D conversion
 - Scan mode: Continuous A/D conversion on 1 to 4 channels
- Four data registers
 - Conversion results are held in a 16-bit data register for each channel
- Sample and hold function
- Three kinds of conversion start
 - Choice of software or timer conversion start trigger (8-bit timer), or ADTRG pin
- A/D conversion end interrupt generation
 - An A/D conversion end interrupt (ADI) request can be generated at the end of A/D conversion

19.1.2 Block Diagram

Figure 19.1 shows a block diagram of the A/D converter.

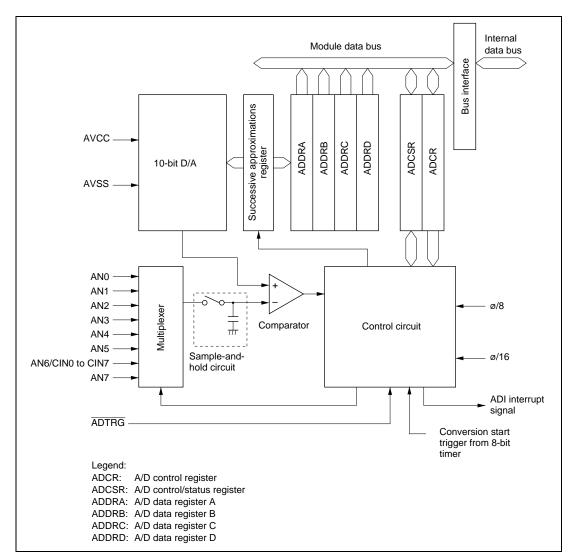


Figure 19.1 Block Diagram of A/D Converter

19.1.3 Pin Configuration

Table 19.1 summarizes the input pins used by the A/D converter.

The AVCC and AVSS pins are the power supply pins for the analog block in the A/D converter.

Table 19.1 A/D Converter Pins

Pin Name	Symbol	I/O	Function Analog block power supply	
Analog power supply pin	AVCC	Input		
Analog ground pin	AVSS	Input	Analog block ground and A/D conversion reference voltage	
Analog input pin 0	AN0	Input	Analog input channel 0	
Analog input pin 1	AN1	Input	Analog input channel 1	
Analog input pin 2	AN2	Input	Analog input channel 2	
Analog input pin 3	AN3	Input	Analog input channel 3	
Analog input pin 4	AN4	Input	Analog input channel 4	
Analog input pin 5	AN5	Input	Analog input channel 5	
Analog input pin 6	AN6	Input	Analog input channel 6	
Analog input pin 7	AN7	Input	Analog input channel 7	
A/D external trigger input pin	ADTRG	Input	External trigger input for starting A/D conversion	
Expansion A/D input pins 0 to 7	CIN0 to CIN7	Input	Expansion A/D conversion input (digital input pin) channels 0 to 7	

19.1.4 Register Configuration

Table 19.2 summarizes the registers of the A/D converter.

Table 19.2 A/D Converter Registers

Name	Abbreviation	R/W	Initial Value	Address*1
A/D data register AH	ADDRAH	R	H'00	H'FFE0
A/D data register AL	ADDRAL	R	H'00	H'FFE1
A/D data register BH	ADDRBH	R	H'00	H'FFE2
A/D data register BL	ADDRBL	R	H'00	H'FFE3
A/D data register CH	ADDRCH	R	H'00	H'FFE4
A/D data register CL	ADDRCL	R	H'00	H'FFE5
A/D data register DH	ADDRDH	R	H'00	H'FFE6
A/D data register DL	ADDRDL	R	H'00	H'FFE7
A/D control/status register	ADCSR	R/(W)* ²	H'00	H'FFE8
A/D control register	ADCR	R/W	H'3F	H'FFE9
Module stop control register	MSTPCRH	R/W	H'3F	H'FF86
	MSTPCRL	R/W	H'FF	H'FF87
Keyboard comparator control register	KBCOMP	R/W	H'00	H'FEE4

Notes: 1. Lower 16 bits of the address.

2. Only 0 can be written in bit 7, to clear the flag.

19.2 Register Descriptions

19.2.1 A/D Data Registers A to D (ADDRA to ADDRD)

Bit			-			-	-	-		6	-		-		1	0
	AD9	AD8	AD7	AD6	AD5	AD4	AD3	AD2	AD1	AD0	_		_	_	_	—
Initial value	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Read/Write	R	R	R	R	R	R	R	R	R	R	R	R	R	R	R	R

There are four 16-bit read-only ADDR registers, ADDRA to ADDRD, used to store the results of A/D conversion.

The 10-bit data resulting from A/D conversion is transferred to the ADDR register for the selected channel and stored there. The upper 8 bits of the converted data are transferred to the upper byte (bits 15 to 8) of ADDR, and the lower 2 bits are transferred to the lower byte (bits 7 and 6) and stored. Bits 5 to 0 are always read as 0.

The correspondence between the analog input channels and ADDR registers is shown in table 19.3.

The ADDR registers can always be read by the CPU. The upper byte can be read directly, but for the lower byte, data transfer is performed via a temporary register (TEMP). For details, see section 19.3, Interface to Bus Master.

The ADDR registers are initialized to H'0000 by a reset, and in standby mode, watch mode, subactive mode, subsleep mode, and module stop mode.

Table 19.3	Analog Input Channels and	Corresponding ADDR Registers
------------	---------------------------	------------------------------

An	alog Input Channel		
Group 0	Group 1	A/D Data Register	
AN0	AN4	ADDRA	
AN1	AN5	ADDRB	
AN2	AN6 or CIN0 to CIN7	ADDRC	
AN3	AN7	ADDRD	

19.2.2 A/D Control/Status Register (ADCSR)

Bit	7	6	5	4	3	2	1	0
	ADF	ADIE	ADST	SCAN	CKS	CH2	CH1	CH0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/(W)*	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Note: * Only 0 can be written in bit 7, to clear the flag.

ADCSR is an 8-bit readable/writable register that controls A/D conversion operations.

ADCSR is initialized to H'00 by a reset, and in standby mode, watch mode, subactive mode, subsleep mode, and module stop mode.

Bit 7—A/D End Flag (ADF): Status flag that indicates the end of A/D conversion.

Bit 7		
ADF	Description	
0	[Clearing conditions]	(Initial value)
	• When 0 is written in the ADF flag after reading ADF = 1	
	When the DTC is activated by an ADI interrupt and ADDR is read	
1	[Setting conditions]	
	Single mode: When A/D conversion ends	
	• Scan mode: When A/D conversion ends on all specified channels	

Bit 6—A/D Interrupt Enable (ADIE): Selects enabling or disabling of interrupt (ADI) requests at the end of A/D conversion.

Bit 6

ADIE	Description	
0	A/D conversion end interrupt (ADI) request is disabled	(Initial value)
1	A/D conversion end interrupt (ADI) request is enabled	

Bit 5—A/D Start (ADST): Selects starting or stopping of A/D conversion. Holds a value of 1 during A/D conversion.

The ADST bit can be set to 1 by software, a timer conversion start trigger, or the A/D external trigger input pin ($\overline{\text{ADTRG}}$).

Bit 5

ADST	Description	
0	A/D conversion stopped (Initial	value)
1	Single mode: A/D conversion is started. Cleared to 0 automatically when conver on the specified channel ends	sion
	Scan mode: A/D conversion is started. Conversion continues sequentially on th selected channels until ADST is cleared to 0 by software, a reset, transition to standby mode or module stop mode	

Bit 4—Scan Mode (SCAN): Selects single mode or scan mode as the A/D conversion operating mode. See section 19.4, Operation, for single mode and scan mode operation. Only set the SCAN bit while conversion is stopped.

Bit 4

SCAN	Description	
0	Single mode	(Initial value)
1	Scan mode	

Bit 3—Clock Select (CKS): Sets the A/D conversion time. Only change the conversion time while ADST = 0.

Bit 3

скѕ	Description	
0	Conversion time = 266 states (max.)	(Initial value)
1	Conversion time = 134 states (max.)	

Bits 2 to 0—Channel Select 2 to 0 (CH2 to CH0): Together with the SCAN bit, these bits select the analog input channel(s).

One analog input channel can be switched to digital input.

Only set the input channel while conversion is stopped.

Group Selection	Cha	nnel Selection	Description				
CH2	CH1	CH0	Single Mode	Scan Mode			
0	0	0	AN0 (Initial value)	AN0			
		1	AN1	AN0, AN1			
	1	0	AN2	AN0 to AN2			
		1	AN3	AN0 to AN3			
1	0	0	AN4	AN4			
		1	AN5	AN4, AN5			
	1	0	AN6 or CIN0 to CIN7	AN4, AN5, AN6 or CIN0 to CIN7			
		1	AN7	AN4, AN5, AN6 or CIN0 to CIN7			
				AN7			

19.2.3 A/D Control Register (ADCR)

Bit	7	6	5	4	3	2	1	0	
	TRGS1	TRGS0	—	—	—	_	_	_	
Initial value	0	0	1	1	1	1	1	1	-
Read/Write	R/W	R/W	_	_	_	—	_	_	

ADCR is an 8-bit readable/writable register that enables or disables external triggering of A/D conversion operations.

ADCR is initialized to H'3F by a reset, and in standby mode, watch mode, subactive mode, subsleep mode, and module stop mode.

Bits 7 and 6—Timer Trigger Select 1 and 0 (TRGS1, TRGS0): These bits select enabling or disabling of the start of A/D conversion by a trigger signal. Only set bits TRGS1 and TRGS0 while conversion is stopped.

Bit 7	Bit 6		
TRGS1	TRGS0	Description	
0	0	Start of A/D conversion by external trigger is disabled (Initial val	ue)
	1	Start of A/D conversion by external trigger is disabled	
1	0	Start of A/D conversion by external trigger (8-bit timer) is enabled	
	1	Start of A/D conversion by external trigger pin is enabled	

Bits 5 to 0—Reserved: These bits cannot be modified and are always read as 1.

19.2.4 Keyboard Comparator Control Register (KBCOMP)

Bit	7	6	5	4	3	2	1	0
	IrE	IrCKS2	IrCKS1	IrCKS0	KBADE	KBCH2	KBCH1	KBCH0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

KBCOMP is an 8-bit readable/writable register that controls the SCI2 IrDA function and selects the CIN input channels for A/D conversion.

KBCOMP is initialized to H'00 by a reset and in hardware standby mode.

Bits 7 to 4—IrDA Control: See the description in section 15.2.11, Keyboard Comparator Control Register (KBCOMP).

Bit 3—Keyboard A/D Enable: Selects either analog input pin (AN6) or digital input pin (CIN0 to CIN7) for A/D converter channel 6 input. If digital input pins are selected, input on A/D converter channel 7 will not be converted correctly.

Bits 2 to 0—Keyboard A/D Channel Select 2 to 0 (KBCH2 to KBCH0): These bits select the channels for A/D conversion from among the digital input pins. Only set the input channel while A/D conversion is stopped.

Bit 3	Bit 2	Bit 1	Bit 0	A/D Converter	A/D Converter
KBADE	KBCH2	KBCH1	KBCH0	Channel 6 Input	Channel 7 Input
0	_	_	_	AN6	AN7
1	0	0	0	CIN0	Undefined
			1	CIN1	Undefined
		1	0	CIN2	Undefined
			1	CIN3	Undefined
	1	0	0	CIN4	Undefined
			1	CIN5	Undefined
		1	0	CIN6	Undefined
			1	CIN7	Undefined

19.2.5 Module Stop Control Register (MSTPCR)

	MSTPCRH						MSTPCRL									
									/							
Bit	7	6	5	4	3	2	1	0	7	6	5	4	3	2	1	0
	MSTP15	MSTP14	MSTP13	MSTP12	MSTP11	MSTP10	MSTP9	MSTP8	MSTP7	MSTP6	MSTP5	MSTP4	MSTP3	MSTP2	MSTP1	MSTP0
Initial value	0	0	1	1	1	1	1	1	1	1	1	1	1	1	1	1
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

MSTPCR, comprising two 8-bit readable/writable registers, performs module stop mode control.

When the MSTP9 bit in MSTPCR is set to 1, A/D converter operation stops at the end of the bus cycle and a transition is made to module stop mode. Registers cannot be read or written to in module stop mode. For details, see section 23.5, Module Stop Mode.

MSTPCR is initialized to H'3FFF by a reset and in hardware standby mode. It is not initialized in software standby mode.

MSTPCRH Bit 1—Module Stop (MSTP9): Specifies the A/D converter module stop mode.

MSTPCRH Bit 1	1	
MSTP9	Description	
0	A/D converter module stop mode is cleared	
1	A/D converter module stop mode is set	(Initial value)

19.3 Interface to Bus Master

ADDRA to ADDRD are 16-bit registers, but the data bus to the bus master is only 8 bits wide. Therefore, in accesses by the bus master, the upper byte is accessed directly, but the lower byte is accessed via a temporary register (TEMP).

A data read from ADDR is performed as follows. When the upper byte is read, the upper byte value is transferred to the CPU and the lower byte value is transferred to TEMP. Next, when the lower byte is read, the TEMP contents are transferred to the CPU.

When reading ADDR, always read the upper byte before the lower byte. It is possible to read only the upper byte, but if only the lower byte is read, incorrect data may be obtained.

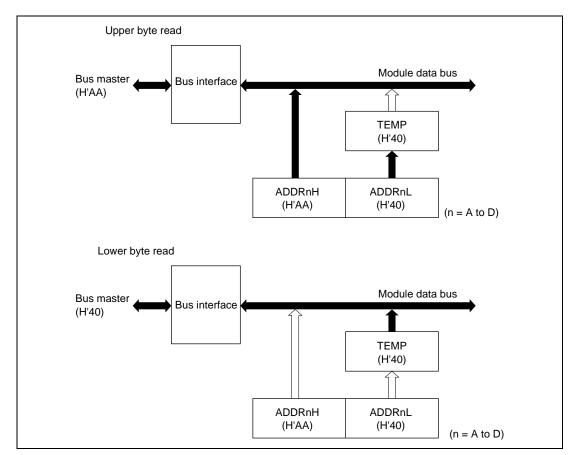


Figure 19.2 shows the data flow for ADDR access.

Figure 19.2 ADDR Access Operation (Reading H'AA40)

19.4 Operation

The A/D converter operates by successive approximations with 10-bit resolution. It has two operating modes: single mode and scan mode.

19.4.1 Single Mode (SCAN = 0)

Single mode is selected when A/D conversion is to be performed on a single channel only. A/D conversion is started when the ADST bit is set to 1 by software, or by external trigger input. The ADST bit remains set to 1 during A/D conversion, and is automatically cleared to 0 when conversion ends.

On completion of conversion, the ADF flag is set to 1. If the ADIE bit is set to 1 at this time, an ADI interrupt request is generated. The ADF flag is cleared by writing 0 after reading ADCSR.

When the operating mode or analog input channel must be changed during analog conversion, to prevent incorrect operation, first clear the ADST bit to 0 in ADCSR to halt A/D conversion. After making the necessary changes, set the ADST bit to 1 to start A/D conversion again. The ADST bit can be set at the same time as the operating mode or input channel is changed.

Typical operations when channel 1 (AN1) is selected in single mode are described next. Figure 19.3 shows a timing diagram for this example.

- 1. Single mode is selected (SCAN = 0), input channel AN1 is selected (CH1 = 0, CH0 = 1), the A/D interrupt is enabled (ADIE = 1), and A/D conversion is started (ADST = 1).
- 2. When A/D conversion is completed, the result is transferred to ADDRB. At the same time the ADF flag is set to 1, the ADST bit is cleared to 0, and the A/D converter becomes idle.
- 3. Since ADF = 1 and ADIE = 1, an ADI interrupt is requested.
- 4. The A/D interrupt handling routine starts.
- 5. The routine reads ADCSR, then writes 0 to the ADF flag.
- 6. The routine reads and processes the conversion result (ADDRB).
- 7. Execution of the A/D interrupt handling routine ends. After that, if the ADST bit is set to 1, A/D conversion starts again and steps 2 to 7 are repeated.

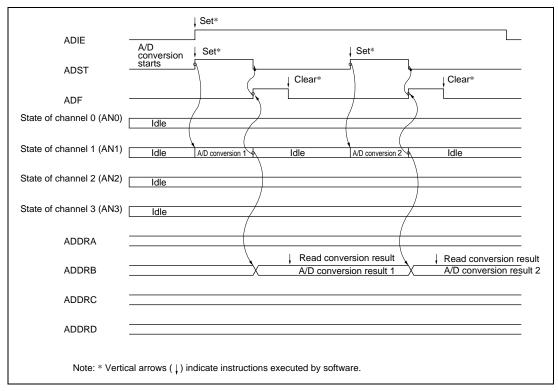


Figure 19.3 Example of A/D Converter Operation (Single Mode, Channel 1 Selected)

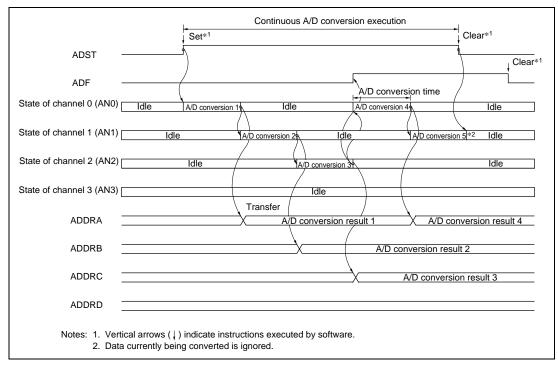
19.4.2 Scan Mode (SCAN = 1)

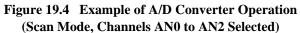
Scan mode is useful for monitoring analog inputs in a group of one or more channels. When the ADST bit is set to 1 by software, or by timer or external trigger input, A/D conversion starts on the first channel in the group (AN0 when CH2 = 0; AN4 when CH2 = 1). When two or more channels are selected, after conversion of the first channel ends, conversion of the second channel (AN1 or AN5) starts immediately. A/D conversion continues cyclically on the selected channels until the ADST bit is cleared to 0. The conversion results are transferred for storage into the ADDR registers corresponding to the channels.

When the operating mode or analog input channel must be changed during analog conversion, to prevent incorrect operation, first clear the ADST bit to 0 in ADCSR to halt A/D conversion. After making the necessary changes, set the ADST bit to 1 to start A/D conversion again. The ADST bit can be set at the same time as the operating mode or input channel is changed.

Typical operations when three channels (AN0 to AN2) are selected in scan mode are described next. Figure 19.4 shows a timing diagram for this example.

- 1. Scan mode is selected (SCAN = 1), scan group 0 is selected (CH2 = 0), analog input channels AN0 to AN2 are selected (CH1 = 1, CH0 = 0), and A/D conversion is started (ADST = 1)
- 2. When A/D conversion of the first channel (AN0) is completed, the result is transferred to ADDRA. Next, conversion of the second channel (AN1) starts automatically.
- 3. Conversion proceeds in the same way through the third channel (AN2).
- 4. When conversion of all the selected channels (AN0 to AN2) is completed, the ADF flag is set to 1 and conversion of the first channel (AN0) starts again. If the ADIE bit is set to 1 at this time, an ADI interrupt is requested after A/D conversion ends.
- 5. Steps 2 to 4 are repeated as long as the ADST bit remains set to 1. When the ADST bit is cleared to 0, A/D conversion stops. After that, if the ADST bit is set to 1, A/D conversion starts again from the first channel (AN0).





19.4.3 Input Sampling and A/D Conversion Time

The A/D converter has a built-in sample-and-hold circuit. The A/D converter samples the analog input at a time t_{D} after the ADST bit is set to 1, then starts conversion. Figure 19.5 shows the A/D conversion timing. Table 19.4 indicates the A/D conversion time.

As indicated in figure 19.5, the A/D conversion time includes t_D and the input sampling time. The length of t_D varies depending on the timing of the write access to ADCSR. The total conversion time therefore varies within the ranges indicated in table 19.4.

In scan mode, the values given in table 19.4 apply to the first conversion time. In the second and subsequent conversions the conversion time is fixed at 256 states when CKS = 0 or 128 states when CKS = 1.

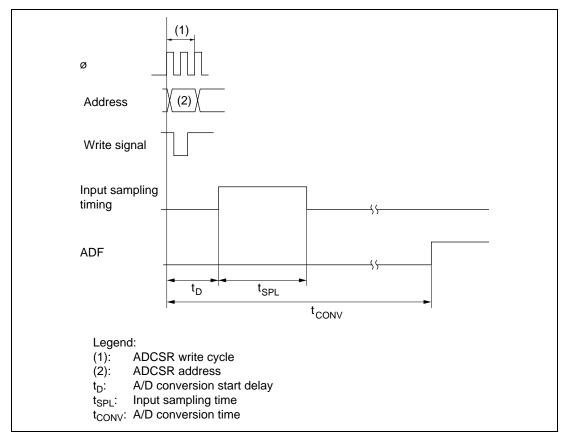


Figure 19.5 A/D Conversion Timing

Table 19.4 A/D Conversion Time (Single Mode)

			CKS =	= 0	CKS = 1		
Item	Symbol	Min	Тур	Max	Min	Тур	Max
A/D conversion start delay	t _D	10	—	17	6	—	9
Input sampling time	t _{spl}	_	63	—		31	_
A/D conversion time	t _{conv}	259		266	131	_	134

Note: Values in the table are the number of states.

19.4.4 External Trigger Input Timing

A/D conversion can be externally triggered. When the TRGS1 and TRGS0 bits are set to 11 in ADCR, external trigger input is enabled at the $\overline{\text{ADTRG}}$ pin. A falling edge at the $\overline{\text{ADTRG}}$ pin sets the ADST bit to 1 in ADCSR, starting A/D conversion. Other operations, in both single and scan modes, are the same as when the ADST bit is set to 1 by software. Figure 19.6 shows the timing.

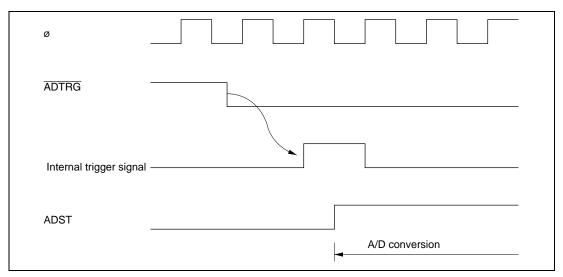


Figure 19.6 External Trigger Input Timing

19.5 Interrupts

The A/D converter generates an interrupt (ADI) at the end of A/D conversion. The ADI interrupt request can be enabled or disabled by the ADIE bit in ADCSR.

19.6 Usage Notes

The following points should be noted when using the A/D converter.

Setting Range of Analog Power Supply and Other Pins:

1. Analog input voltage range

The voltage applied to the ANn analog input pins during A/D conversion should be in the range $AV_{ss} \le ANn \le AV_{cc}$ (n = 0 to 7).

- 2. Digital input voltage range The voltage applied to the CINn digital input pins should be in the range $AV_{ss} \le CINn \le AV_{cc}$ and $V_{ss} \le CINn \le V_{cc}$ (n = 0 to 7).
- 3. Relation between AV_{cc} , AV_{ss} and V_{cc} , V_{ss} As the relationship between AV_{cc} , AV_{ss} and V_{cc} , V_{ss} , set $AV_{ss} = V_{ss}$. If the A/D converter is not used, the AVCC and AVSS pins must on no account be left open.

If conditions 1 to 3 above are not met, the reliability of the device may be adversely affected.

Notes on Board Design: In board design, digital circuitry and analog circuitry should be as mutually isolated as possible, and layout in which digital circuit signal lines and analog circuit signal lines cross or are in close proximity should be avoided as far as possible. Failure to do so may result in incorrect operation of the analog circuitry due to inductance, adversely affecting A/D conversion values.

Also, digital circuitry must be isolated from the analog input signals (AN0 to AN7), and analog power supply (AVCC) by the analog ground (AVSS). Also, the analog ground (AVSS) should be connected at one point to a stable digital ground (VSS) on the board.

Notes on Noise Countermeasures: A protection circuit connected to prevent damage due to an abnormal voltage such as an excessive surge at the analog input pins (AN0 to AN7) should be connected between AVCC and AVSS as shown in figure 19.7.

Also, the bypass capacitors connected to AVCC and the filter capacitor connected to AN0 to AN7 must be connected to AVSS.

If a filter capacitor is connected as shown in figure 19.7, the input currents at the analog input pins (AN0 to AN7) are averaged, and so an error may arise. Also, when A/D conversion is performed frequently, as in scan mode, if the current charged and discharged by the capacitance

of the sample-and-hold circuit in the A/D converter exceeds the current input via the input impedance (R_{in}), an error will arise in the analog input pin voltage. Careful consideration is therefore required when deciding the circuit constants.

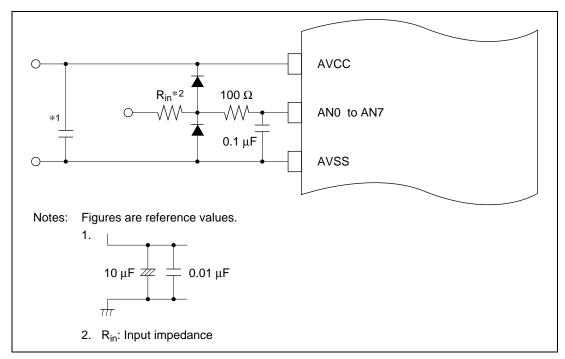


Figure 19.7 Example of Analog Input Protection Circuit

Table 19.5 Analog Pin Specifications

Item	Min	Мах	Unit
Analog input capacitance	_	20	pF
Permissible signal source impedance	_	10*	kΩ

Note: * When V_{cc} = 4.0 V to 5.5 V and ø ≤ 12 MHz

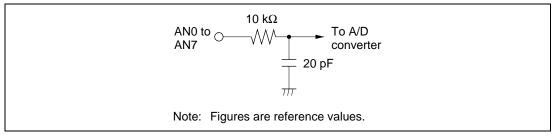


Figure 19.8 Analog Input Pin Equivalent Circuit

A/D Conversion Precision Definitions: H8S/2138 Series and H8S/2134 Series A/D conversion precision definitions are given below.

• Resolution

The number of A/D converter digital output codes

Offset error

The deviation of the analog input voltage value from the ideal A/D conversion characteristic when the digital output changes from the minimum voltage value B'0000000000 (H'000) to B'0000000001 (H'001) (see figure 19.10).

• Full-scale error

The deviation of the analog input voltage value from the ideal A/D conversion characteristic when the digital output changes from B'111111110 (H'3FE) to B'111111111 (H'3FF) (see figure 19.10).

• Quantization error

The deviation inherent in the A/D converter, given by 1/2 LSB (see figure 19.9).

• Nonlinearity error

The error with respect to the ideal A/D conversion characteristic between the zero voltage and the full-scale voltage. Does not include the offset error, full-scale error, or quantization error.

Absolute precision

The deviation between the digital value and the analog input value. Includes the offset error, full-scale error, quantization error, and nonlinearity error.

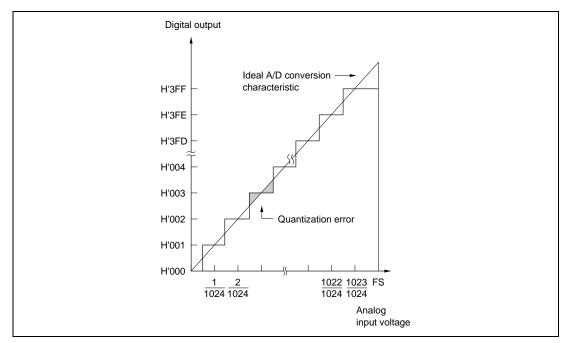


Figure 19.9 A/D Conversion Precision Definitions (1)

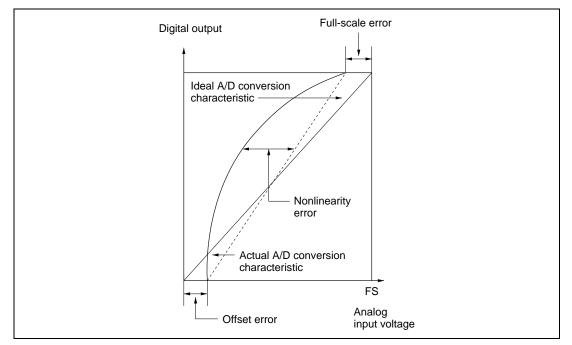


Figure 19.10 A/D Conversion Precision Definitions (2)

Permissible Signal Source Impedance: H8S/2138 Series and H8S/2134 Series analog input is designed so that conversion precision is guaranteed for an input signal for which the signal source impedance is 10 k Ω (Vcc = 4.0 to 5.5 V, when $\phi \le 12$ MHz or CKS = 0) or less. This specification is provided to enable the A/D converter's sample-and-hold circuit input capacitance to be charged within the sampling time; if the sensor output impedance exceeds 10 k Ω (Vcc = 4.0 to 5.5 V, when $\phi \le 12$ MHz or CKS = 0), charging may be insufficient and it may not be possible to guarantee the A/D conversion precision.

However, if a large capacitance is provided externally, the input load will essentially comprise only the internal input resistance of 10 k Ω , and the signal source impedance is ignored.

But since a low-pass filter effect is obtained in this case, it may not be possible to follow an analog signal with a large differential coefficient (e.g., $5 \text{ mV/}\mu\text{sec}$ or greater).

When converting a high-speed analog signal, a low-impedance buffer should be inserted.

Influences on Absolute Precision: Adding capacitance results in coupling with GND, and therefore noise in GND may adversely affect absolute precision. Be sure to make the connection to an electrically stable GND such as AV_{ss} .

Care is also required to insure that filter circuits do not communicate with digital signals on the mounting board, so acting as antennas.

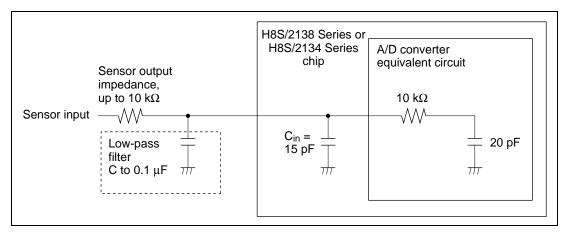


Figure 19.11 Example of Analog Input Circuit

Section 20 RAM

20.1 Overview

The H8S/2138, H8S/2134 and H8S/2133 have 4 kbytes of on-chip high-speed static RAM, and the H8S/2137, H8S/2132, and H8S/2130 have 2 kbytes. The on-chip RAM is connected to the CPU by a 16-bit data bus, enabling both byte data and word data to be accessed in one state. This makes it possible to perform fast word data transfer.

The on-chip RAM can be enabled or disabled by means of the RAM enable bit (RAME) in the system control register (SYSCR).

20.1.1 Block Diagram

Figure 20.1 shows a block diagram of the on-chip RAM.

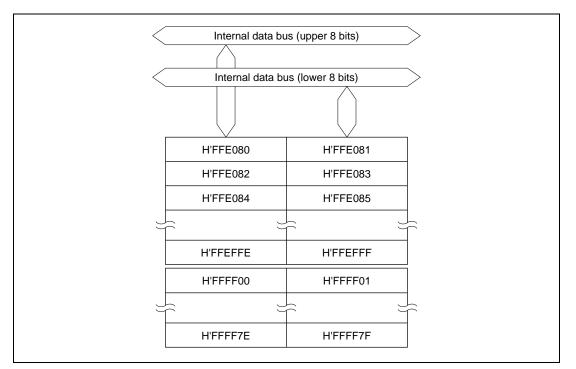


Figure 20.1 Block Diagram of RAM (H8S/2138, H8S/2134, H8S/2133)

20.1.2 Register Configuration

The on-chip RAM is controlled by SYSCR. Table 20.1 shows the register configuration.

Table 20.1Register Configuration

Name	Abbreviation	R/W	Initial Value	Address*
System control register	SYSCR	R/W	H'09	H'FFC4

Note: *Lower 16 bits of the address.

20.2 System Control Register (SYSCR)

Bit	7	6	5	4	3	2	1	0
	CS2E	IOSE	INTM1	INTM0	XRST	NMIEG	HIE	RAME
Initial value	0	0	0	0	1	0	0	1
Read/Write	R/W	R/W	R	R/W	R	R/W	R/W	R/W

The on-chip RAM is enabled or disabled by the RAME bit in SYSCR. For details of other bits in SYSCR, see section 3.2.2, System Control Register (SYSCR).

Bit 0—RAM Enable (RAME): Enables or disables the on-chip RAM. The RAME bit is initialized when the reset state is released. It is not initialized in software standby mode.

Bit 0		
RAME	Description	
0	On-chip RAM is disabled	
1	On-chip RAM is enabled	(Initial value)

20.3 Operation

20.3.1 Expanded Mode (Modes 1, 2, and 3 (EXPE = 1))

When the RAME bit is set to 1, accesses to H8S/2138, H8S/2134, and H8S/2133 addresses H'(FF)E080 to H'(FF)EFFF and H'(FF)FF00 to H'(FF)FF7F, and H8S/2137, H8S/2132, and H8S/2130 addresses H'(FF)E880 to H'(FF)EFFF and H'(FF)FF00 to H'(FF)FF7F, are directed to the on-chip RAM. When the RAME bit is cleared to 0, accesses to addresses H'(FF)E080 to H'(FF)EFFF and H'(FF)FF00 to H'(FF)FF7F, are directed to the off-chip address space.

Since the on-chip RAM is connected to the bus master by a 16-bit data bus, it can be written to and read in byte or word units. Each type of access is performed in one state.

Even addresses use the upper 8 bits, and odd addresses use the lower 8 bits. Word data must start at an even address.

20.3.2 Single-Chip Mode (Modes 2 and 3 (EXPE = 0))

When the RAME bit is set to 1, accesses to H8S/2138, H8S/2134, and H8S/2133 addresses H'(FF)E080 to H'(FF)EFFF and H'(FF)FF00 to H'(FF)FF7F, and H8S/2137, H8S/2132, and H8S/2130 addresses H'(FF)E880 to H'(FF)EFFF and H'(FF)FF00 to H'(FF)FF7F, are directed to the on-chip RAM. When the RAME bit is cleared to 0, the on-chip RAM is not accessed. A read will always return H'FF, and writes are invalid.

Since the on-chip RAM is connected to the bus master by a 16-bit data bus, it can be written to and read in byte or word units. Each type of access is performed in one state.

Even addresses use the upper 8 bits, and odd addresses use the lower 8 bits. Word data must start at an even address.

Section 21 ROM

21.1 Overview

The H8S/2138 and H8S/2134 have 128 kbytes of on-chip ROM (flash memory or mask ROM), the H8S/2133 has 96 kbytes, the H8S/2137 and H8S/2132 have 64 kbytes, and the H8S/2130 has 32 kbytes. The ROM is connected to the CPU by a 16-bit data bus. The CPU accesses both byte and word data in one state, enabling faster instruction fetches and higher processing speed.

The mode pins (MD1 and MD0) and the EXPE bit in MDCR can be set to enable or disable the on-chip ROM.

The flash memory versions of the H8S/2138, H8S/2134, and H8S/2132 can be erased and programmed on-board as well as with a general-purpose PROM programmer.

21.1.1 Block Diagram

Figure 21.1 shows a block diagram of the ROM.

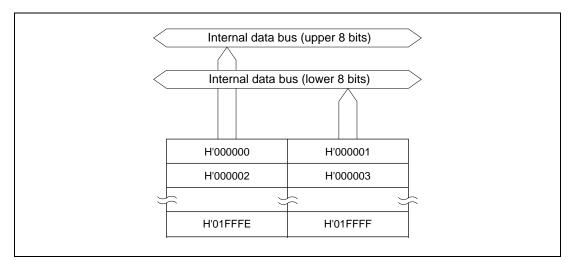


Figure 21.1 ROM Block Diagram (H8S/2138, H8S/2134)

21.1.2 Register Configuration

The H8S/2138 Series and H8S/2134 Series on-chip ROM is controlled by the operating mode and register MDCR. The register configuration is shown in table 21.1.

Table 21.1 ROM Register

Register Name	Abbreviation	R/W	Initial Value	Address*
Mode control register	MDCR	R/W	Undefined Depends on the operating mode	H'FFC5

Note: *Lower 16 bits of the address.

21.2 **Register Descriptions**

21.2.1 Mode Control Register (MDCR)

Bit	7	6	5	4	3	2	1	0
	EXPE	—	_	_	_	_	MDS1	MDS0
Initial value	*	0	0	0	0	0	*	*
Read/Write	R/W*	—	—	—	—	—	R	R

Note: * Determined by the MD1 and MD0 pins.

MDCR is an 8-bit register used to set the H8S/2138 Series or H8S/2134 Series operating mode and monitor the current operating mode.

The EXPE bit is initialized in accordance with the mode pin states by a reset and in hardware standby mode.

Bit 7—Expanded Mode Enable (EXPE): Sets expanded mode. In mode 1, EXPE is fixed at 1 and cannot be modified. In modes 2 and 3, EXPE has an initial value of 0 and can be read or written.

Bit 7 EXPE	Description
0	Single-chip mode selected
1	Expanded mode selected

Bits 6 to 2—Reserved: These bits cannot be modified and are always read as 0.

Bits 1 and 0—Mode Select 1 and 0 (MDS1, MDS0): These bits indicate values that reflects the input levels of mode pins MD1 and MD0 (the current operating mode). Bits MDS1 and MDS0 correspond to pins MD1 and MD0, respectively. These are read-only bits, and cannot be modified. When MDCR is read, the input levels of mode pins MD1 and MD0 are latched in these bits.

21.3 Operation

The on-chip ROM is connected to the CPU by a 16-bit data bus, and both byte and word data is accessed in one state. Even addresses are connected to the upper 8 bits, and odd addresses to the lower 8 bits. Word data must start at an even address.

The mode pins (MD1 and MD0) and the EXPE bit in MDCR can be set to enable or disable the on-chip ROM, as shown in table 21.2.

In normal mode, the maximum amount of ROM that can be used is 56 kbytes.

		Mode I	Pins	MDCR		
Operatin	g Mode	MD1	MD0	EXPE	On-Chip ROM	
Mode 1	Normal expanded mode with on-chip ROM disabled	0	1	1	Disabled	
Mode 2	Advanced single-chip mode		0	0	Enabled*	
	Advanced expanded mode with on-chip ROM enabled			1		
Mode 3	3 Normal single-chip mode		1	0	Enabled	
Normal expanded mode with on-chip ROM enabled				1	(max. 56 kbytes)	

Table 21.2Operating Modes and ROM

Note: *128 kbytes in the H8S/2138 and H8S/2134, 96 kbytes in the H8S/2133, 64 kbytes in the H8S/2137 and H8S/2132, and 32 kbytes in the H8S/2130.

21.4 Overview of Flash Memory

21.4.1 Features

The features of the flash memory are summarized below.

- Four flash memory operating modes
 - Program mode
 - Erase mode
 - Program-verify mode
 - Erase-verify mode
- Programming/erase methods

The flash memory is programmed 32 bytes at a time. Erasing is performed by block erase (in single-block units). When erasing multiple blocks, the individual blocks must be erased sequentially. Block erasing can be performed as required on 1-kbyte, 8-kbyte, 16-kbyte, 28-kbyte, and 32-kbyte blocks.

• Programming/erase times

The flash memory programming time is 10 ms (typ.) for simultaneous 32-byte programming, equivalent to 300 μ s (typ.) per byte, and the erase time is 100 ms (typ.) per block.

- Reprogramming capability The flash memory can be reprogrammed up to 100 times.
- On-board programming modes

There are two modes in which flash memory can be programmed/erased/verified on-board:

- Boot mode
- User program mode
- Automatic bit rate adjustment

With data transfer in boot mode, the bit rate of the H8S/2138 Series or H8S/2134 Series chip can be automatically adjusted to match the transfer bit rate of the host.

• Protect modes

There are three protect modes, hardware, software, and error protect, which allow protected status to be designated for flash memory program/erase/verify operations.

• Writer mode

Flash memory can be programmed/erased in writer mode, using a PROM programmer, as well as in on-board programming mode.

21.4.2 Block Diagram

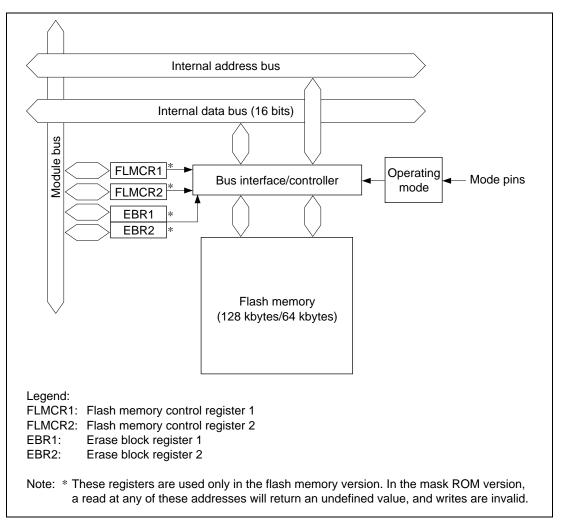


Figure 21.2 Block Diagram of Flash Memory

21.4.3 Flash Memory Operating Modes

Mode Transitions: When the mode pins are set in the reset state and a reset-start is executed, the MCU enters one of the operating modes shown in figure 21.3. In user mode, flash memory can be read but not programmed or erased.

Flash memory can be programmed and erased in boot mode, user program mode, and writer mode.

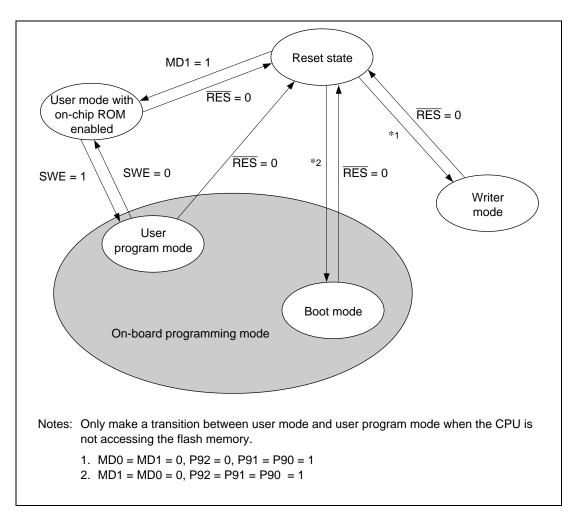


Figure 21.3 Flash Memory Mode Transitions

On-Board Programming Modes

Boot mode

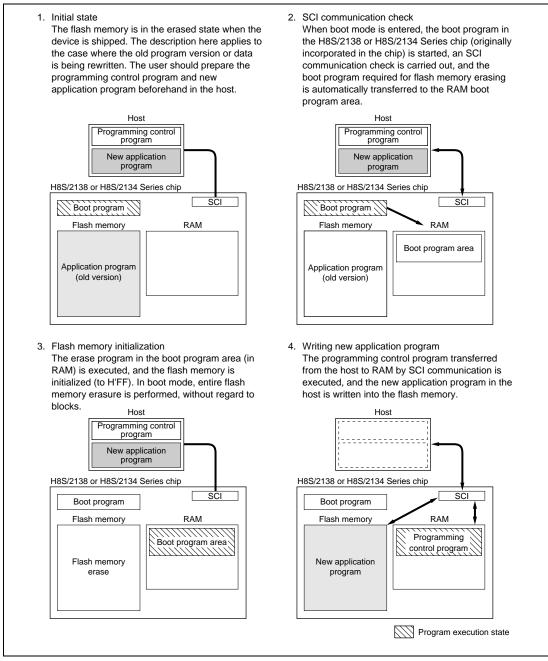


Figure 21.4 Boot Mode

• User program mode

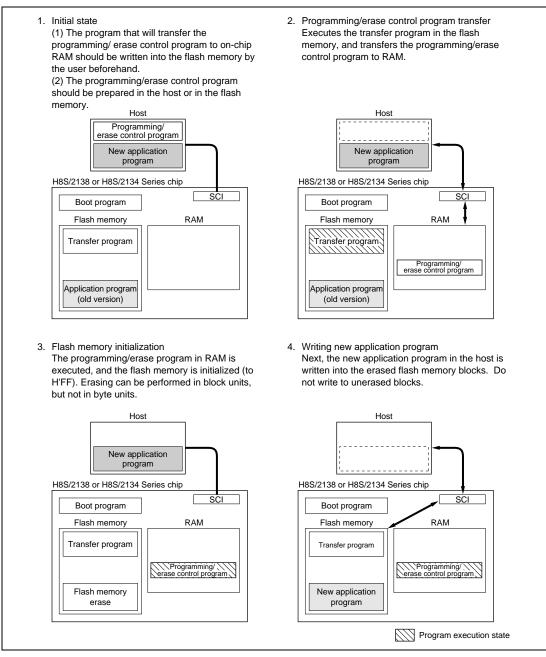


Figure 21.5 User Program Mode (Example)

Differences between Boot Mode and User Program Mode

	Boot Mode	User Program Mode
Entire memory erase	Yes	Yes
Block erase	No	Yes
Programming control program* ¹	*2	* ^{2, 3}

Notes: 1. To be provided by the user, in accordance with the recommended algorithm.

2. Program/program-verify

3. Erase/erase-verify

Block Configuration: The flash memory is divided into two 32-kbyte blocks (128-kbyte version only), two 8-kbyte blocks, one 16-kbyte block, one 28-kbyte block, and four 1-kbyte blocks.

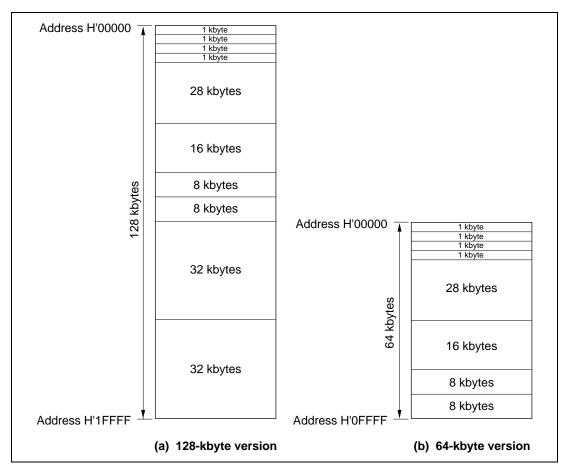


Figure 21.6 Flash Memory Block Configuration

21.4.4 Pin Configuration

The flash memory is controlled by means of the pins shown in table 21.3.

Pin Name	Abbreviation	I/O	Function
Reset	RES	Input	Reset
Mode 1	MD1	Input	Sets MCU operating mode
Mode 0	MD0	Input	Sets MCU operating mode
Port 92	P92	Input	Sets MCU operating mode when MD1 = MD0 = 0
Port 91	P91	Input	Sets MCU operating mode when MD1 = MD0 = 0
Port 90	P90	Input	Sets MCU operating mode when MD1 = MD0 = 0
Transmit data	TxD1	Output	Serial transmit data output
Receive data	RxD1	Input	Serial receive data input

Table 21.3 Flash Memory Pins

21.4.5 Register Configuration

The registers used to control the on-chip flash memory when enabled are shown in table 21.4. In order for these registers to be accessed, the FLSHE bit must be set to 1 in STCR.

Table 21.4	Flash Memor	y Registers
-------------------	-------------	-------------

Register Name	Abbreviation	R/W	Initial Value	Address*1
Flash memory control register 1	FLMCR1* ⁵	R/W* ³	H'00	H'FF80* ²
Flash memory control register 2	FLMCR2* ^⁵	R/W* ³	H'00* ⁴	H'FF81* ²
Erase block register 1	EBR1*⁵	R/W*3	H'00* ⁴	H'FF82* ²
Erase block register 2	EBR2*⁵	R/W* ³	H'00* ⁴	H'FF83* ²
Serial/timer control register	STCR	R/W	H'00	H'FFC3

Notes: 1. Lower 16 bits of the address.

2. Flash memory registers share addresses with other registers. Register selection is performed by the FLSHE bit in the serial/timer control register (STCR).

3. In modes in which the on-chip flash memory is disabled, a read will return H'00, and writes are invalid.

4. The SWE bit in FLMCR1 is not set, these registers are initialized to H'00.

 FLMCR1, FLMCR2, EBR1, and EBR2 are 8-bit registers. Only byte accesses are valid for these registers, the access requiring 2 states. These registers are used only in the flash memory version. In the mask ROM version, a read at any of these addresses will return an undefined value, and writes are invalid.

21.5 Register Descriptions

Rit 6

Bit	7	6	5	4	3	2	1	0
	FWE	SWE	_	_	EV	PV	E	Р
Initial value	1	0	0	0	0	0	0	0
Read/Write	R	R/W	_	_	R/W	R/W	R/W	R/W

21.5.1 Flash Memory Control Register 1 (FLMCR1)

FLMCR1 is an 8-bit register used for flash memory operating mode control. Program-verify mode or erase-verify mode is entered by setting SWE to 1. Program mode is entered by setting SWE to 1, then setting the PSU bit in FLMCR2, and finally setting the P bit. Erase mode is entered by setting SWE to 1, then setting the ESU bit in FLMCR2, and finally setting the E bit. FLMCR1 is initialized to H'80 by a reset, and in hardware standby mode, software standby mode, subactive mode, subsleep mode, and watch mode. When on-chip flash memory is disabled, a read will return H'00, and writes are invalid.

Writes to the EV and PV bits in FLMCR1 are enabled only when SWE=1; writes to the E bit only when SWE = 1, and ESU = 1; and writes to the P bit only when SWE = 1, and PSU = 1.

Bit 7—Flash Write Enable (FWE): Controls programming and erasing of the on-chip flash memory. This bit cannot be modified and is always read as 1.

Bit 6—Software Write Enable (SWE): Enables or disables flash memory programming. SWE should be set before setting bits ESU, PSU, EV, PV, E, P, and EB9 to EB0, and should not be cleared at the same time as these bits.

ыго		
SWE	Description	
0	Writes disabled	(Initial value)
1	Writes enabled	

Bit 5 and 4—Reserved: These bits cannot be modified and are always read as 0.

Bit 3—Erase-Verify (EV): Selects erase-verify mode transition or clearing. Do not set the SWE, ESU, PSU, PV, E, or P bit at the same time.

Bit 3		
EV	Description	
0	Erase-verify mode cleared	(Initial value)
1	Transition to erase-verify mode	
	[Setting condition]	
	When SWE = 1	

Bit 2—Program-Verify (PV): Selects program-verify mode transition or clearing. Do not set the SWE, ESU, PSU, EV, E, or P bit at the same time.

Bit 2

PV	Description					
0	Program-verify mode cleared	(Initial value)				
1	Transition to program-verify mode					
	[Setting condition]					
	When SWE = 1					

Bit 1—Erase (E): Selects erase mode transition or clearing. Do not set the SWE, ESU, PSU, EV, PV, or P bit at the same time.

Bit 1

E	Description	
0	Erase mode cleared	(Initial value)
1	Transition to erase mode	
	[Setting condition]	
	When SWE = 1, and ESU = 1	

Bit 0—Program (P): Selects program mode transition or clearing. Do not set the SWE, PSU, ESU, EV, PV, or E bit at the same time.

Bit 0

Р	Description	
0	Program mode cleared	(Initial value)
1	Transition to program mode	
	[Setting condition]	
	When SWE = 1, and PSU = 1	

21.5.2 Flash Memory Control Register 2 (FLMCR2)

Bit	7	6	5	4	3	2	1	0
	FLER	_	—	—	—	_	ESU	PSU
Initial value	0	0	0	0	0	0	0	0
Read/Write	R	—	—	—	—	—	R/W	R/W

FLMCR2 is an 8-bit register that monitors the presence or absence of flash memory program/erase protection (error protection) and performs setup for flash memory program/erase mode. FLMCR2 is initialized to H'00 by a reset, and in hardware standby mode. The ESU and PSU bits are cleared to 0 in software standby mode, subactive mode, subsleep mode, and watch mode.

When on-chip flash memory is disabled, a read will return H'00, and writes are invalid.

Bit 7—Flash Memory Error (FLER): Indicates that an error has occurred during an operation on flash memory (programming or erasing). When FLER is set to 1, flash memory goes to the error-protection state.

Bit 7		
FLER	Description	
0	Flash memory is operating normally value)	(Initial
	Flash memory program/erase protection (error protection) is disabled	
	[Clearing condition]	
	Reset or hardware standby mode	
1	An error has occurred during flash memory programming/erasing	
	Flash memory program/erase protection (error protection) is enabled	
	[Setting condition]	
	See section 21.8.3, Error Protection	

Bits 6 to 2—Reserved: These bits cannot be modified and are always read as 0.

Bit 1—Erase Setup (ESU): Prepares for a transition to erase mode. Set this bit to 1 before setting the E bit to 1 in FLMCR1. Do not set the SWE, PSU, EV, PV, E, or P bit at the same time.

Bit 1		
ESU	Description	
0	Erase setup cleared	(Initial value)
1	Erase setup	
	[Setting condition]	
	When SWE = 1	

Bit 0—Program Setup (PSU): Prepares for a transition to program mode. Set this bit to 1 before setting the P bit to 1 in FLMCR1. Do not set the SWE, ESU, EV, PV, E, or P bit at the same time.

Bit 0

PSU	Description	
0	Program setup cleared	(Initial value)
1	Program setup	
	[Setting condition]	
	When SWE = 1	

21.5.3 Erase Block Registers 1 and 2 (EBR1, EBR2)

Bit	7	6	5	4	3	2	1	0
EBR1	—	_	—	—	_	—	EB9/*2	EB8/*2
Initial value	0	0	0	0	0	0	0	0
Read/Write	—	_	_	_	_	_	R/W* ^{1,} * ²	R/W* ^{1,} * ²
Bit	7	6	5	4	3	2	1	0
EBR2	EB7	EB6	EB5	EB4	EB3	EB2	EB1	EB0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W* ¹	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Notes: 1. In normal mode, these bits cannot be modified and are always read as 0.

2. Bits EB8 and EB9 are not present in the 64-kbyte versions; they cannot be modified and are always read as 0.

EBR1 and EBR2 are registers that specify the flash memory erase area block by block; bits 1 and 2 in EBR1 (128 kB versions only) and bits 7 to 0 in EBR2 are readable/writable bits. EBR1 and EBR2 are each initialized to H'00 by a reset, in hardware standby mode, software standby mode, subactive mode, subsleep mode, and watch mode, and the SWE bit in FLMCR1 is not set. When a bit in EBR1 or EBR2 is set, the corresponding block can be erased. Other blocks are erase-protected. Set only one bit in EBR1 or EBR2 (more than one bit cannot be set). When on-chip flash memory is disabled, a read will return H'00, and writes are invalid.

The flash memory block configuration is shown in table 21.5.

Table 21.5 Flash Memory Erase Blocks

Bloc	ck (Size)	
128-kbyte Versions	64-kbyte Versions	Address
EB0 (1 kbyte)	EB0 (1 kbyte)	H'(00)0000 to H'(00)03FF
EB1 (1 kbyte)	EB1 (1 kbyte)	H'(00)0400 to H'(00)07FF
EB2 (1 kbyte)	EB2 (1 kbyte)	H'(00)0800 to H'(00)0BFF
EB3 (1 kbyte)	EB3 (1 kbytes)	H'(00)0C00 to H'(00)0FFF
EB4 (28 kbytes)	EB4 (28 kbytes)	H'(00)1000 to H'(00)7FFF
EB5 (16 kbytes)	EB5 (16 kbytes)	H'(00)8000 to H'(00)BFFF
EB6 (8 kbytes)	EB6 (8 kbytes)	H'(00)C000 to H'(00)DFFF
EB7 (8 kbytes)	EB7 (8 kbytes)	H'00E000 to H'00FFFF
EB8 (32 kbytes)	_	H'010000 to H'017FFF
EB9 (32 kbytes)	—	H'018000 to H'01FFFF

21.5.4 Serial/Timer Control Register (STCR)

Bit	7	6	5	4	3	2	1	0
	IICS	IICX1	IICX0	IICE	FLSHE		ICKS1	ICKS0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

STCR is an 8-bit readable/writable register that controls register access, the IIC operating mode (when the on-chip IIC option is included), and on-chip flash memory control (in F-ZTAT versions), and also selects the TCNT input clock. For details on functions not related to on-chip flash memory, see section 3.2.4, Serial/Timer Control Register (STCR), and descriptions of individual modules. If a module controlled by STCR is not used, do not write 1 to the corresponding bit.

STCR is initialized to H'00 by a reset and in hardware standby mode.

Bits 7 to 4—I²C Control (IICS, IICX1, IICX0, IICE): When the on-chip IIC option is included, these bits control the operation of the I²C bus interface. For details, see section 16, I²C Bus Interface.

Bit 3—Flash Memory Control Register Enable (FLSHE): Setting the FLSHE bit to 1 enables read/write access to the flash memory control registers. If FLSHE is cleared to 0, the flash memory control registers are deselected. In this case, the flash memory control register contents are retained.

Bit 3

FLSHE	Description	
0	Flash memory control registers deselected	(Initial value)
1	Flash memory control registers selected	

Bit 2—Reserved: Do not write 1 to this bit.

Bits 1 and 0—Internal Clock Select 1 and 0 (ICKS1, ICKS0): These bits control 8-bit timer operation. See section 12, 8-Bit Timers, for details.

21.6 On-Board Programming Modes

When pins are set to on-board programming mode, program/erase/verify operations can be performed on the on-chip flash memory. There are two on-board programming modes: boot mode and user program mode. The pin settings for transition to each of these modes are shown in table 21.6. For a diagram of the transitions to the various flash memory modes, see figure 21.3.

Only advanced mode setting is possible for boot mode.

In the case of user program mode, established in advanced mode or normal mode, depending on the setting of the MD0 pin. In normal mode, only programming of a 56-kbyte area of flash memory is possible.

Table 21.6 Setting On-Board Programming Modes

Mode						
Mode Name	CPU Operating Mode	MD1	MD0	P92	P91	P90
Boot mode	Advanced mode	0	0	1*	1*	1*
User program mode	Advanced mode	1	0		_	—
	Normal mode		1		—	—

Note: *Can be used as I/O ports after boot mode is initiated.

21.6.1 Boot Mode

When boot mode is used, the flash memory programming control program must be prepared in the host beforehand. The channel 1 SCI to be used is set to asynchronous mode.

When a reset-start is executed after the H8S/2138 or H8S/2134 Series MCU's pins have been set to boot mode, the boot program built into the MCU is started and the programming control program prepared in the host is serially transmitted to the MCU via the SCI. In the MCU, the programming control program received via the SCI is written into the programming control program area in on-chip RAM. After the transfer is completed, control branches to the start address of the programming control program area and the programming control program execution state is entered (flash memory programming is performed).

The transferred programming control program must therefore include coding that follows the programming algorithm given later.

The system configuration in boot mode is shown in figure 21.7, and the boot program mode execution procedure in figure 21.8.

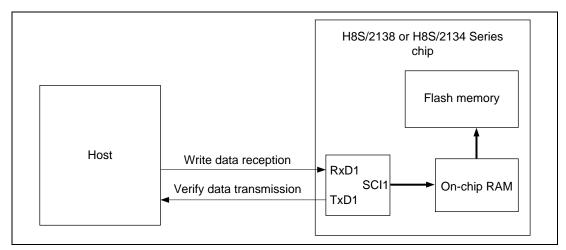


Figure 21.7 System Configuration in Boot Mode

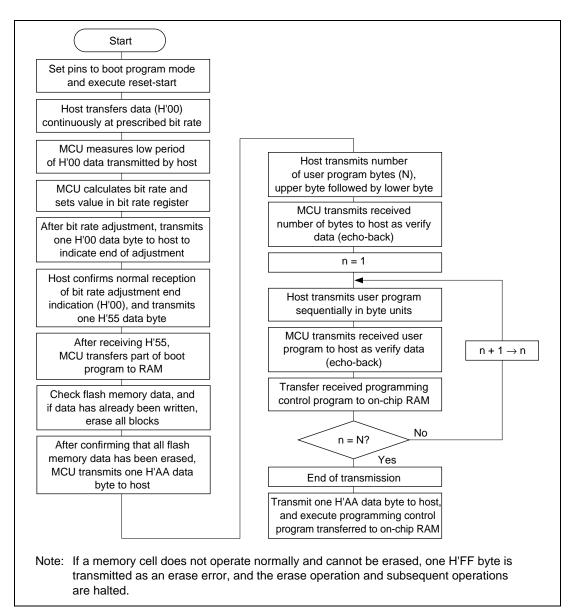
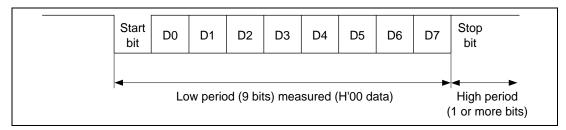


Figure 21.8 Boot Mode Execution Procedure

Automatic SCI Bit Rate Adjustment





When boot mode is initiated, the H8S/2138 or H8S/2134 Series MCU measures the low period of the asynchronous SCI communication data (H'00) transmitted continuously from the host. The SCI transmit/receive format should be set as follows: 8-bit data, 1 stop bit, no parity. The MCU calculates the bit rate of the transmission from the host from the measured low period, and transmits one H'00 byte to the host to indicate the end of bit rate adjustment. The host should confirm that this adjustment end indication (H'00) has been received normally, and transmit one H'55 byte to the MCU. If reception cannot be performed normally, initiate boot mode again (reset), and repeat the above operations. Depending on the host's transmission bit rate and the MCU's system clock frequency, there will be a discrepancy between the bit rates of the host and the MCU. To ensure correct SCI operation, the host's transfer bit rate should be set to (2400, 4800, or 9600) bps.

Table 21.7 shows typical host transfer bit rates and system clock frequencies for which automatic adjustment of the MCU's bit rate is possible. The boot program should be executed within this system clock range.

Table 21.7System Clock Frequencies for which Automatic Adjustment of H8S/2138 or
H8S/2134 Series Bit Rate is Possible

Host Bit Rate	System Clock Frequency for which Automatic Adjustment of H8S/2138 or H8S/2134 Series Bit Rate is Possible		
9600 bps	8 MHz to 20 MHz		
4800 bps	4 MHz to 20 MHz		
2400 bps	2 MHz to 18 MHz		

On-Chip RAM Area Divisions in Boot Mode: In boot mode, the 128-byte area from H'(FF)FF00 to H'(FF)FF7F is reserved for use by the boot program, as shown in figure 21.10. The area to which the programming control program is transferred is H'(FF)E080 to H'(FF)EFFF (3968 bytes) in the 128-kbyte versions, or H'(FF)E880 to H'(FF)EFFF (1920 bytes) in the 64-kbyte versions. The boot program area can be used when the programming control program transferred into RAM enters the execution state. A stack area should be set up as required.

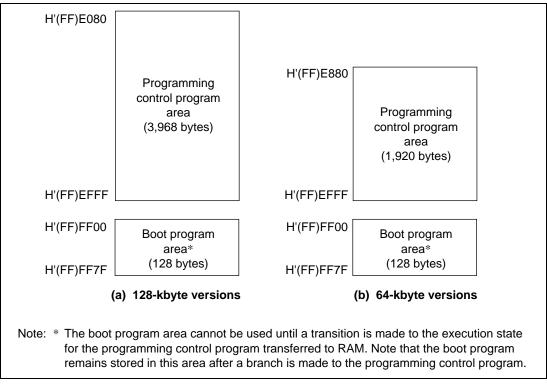


Figure 21.10 RAM Areas in Boot Mode

Notes on Use of User Mode:

- When the chip comes out of reset in boot mode, it measures the low period of the input at the SCI's RxD1 pin. The reset should end with RxD1 high. After the reset ends, it takes about 100 states for the chip to get ready to measure the low period of the RxD1 input.
- In boot mode, if any data has been programmed into the flash memory (if all data is not 1), all flash memory blocks are erased. Boot mode is for use when user program mode is unavailable, such as the first time on-board programming is performed, or if the program activated in user program mode is accidentally erased.
- Interrupts cannot be used while the flash memory is being programmed or erased.
- The RxD1 and TxD1 pins should be pulled up on the board.
- Before branching to the programming control program (RAM area H'(FF)E080 (128-kbyte versions) or H'(FF)E880 (64-kbyte versions)), the chip terminates transmit and receive operations by the on-chip SCI (channel 1) (by clearing the RE and TE bits in SCR to 0), but the adjusted bit rate value remains set in BRR. The transmit data output pin, TxD1, goes to the high-level output state (P84DDR = 1, P84DR = 1).

The contents of the CPU's internal general registers are undefined at this time, so these registers must be initialized immediately after branching to the programming control program. In particular, since the stack pointer (SP) is used implicitly in subroutine calls, etc., a stack area must be specified for use by the programming control program. The initial values of other on-chip registers are not changed.

• Boot mode can be entered by making the pin settings shown in table 21.6 and executing a reset-start.

When the chip detects the boot mode setting at reset release^{*1}, P92, P91, and P90 can be used as I/O ports.

Boot mode can be cleared by driving the reset pin low, waiting at least 20 states, then setting the mode pins, and executing reset release*¹. Boot mode can also be cleared by a WDT overflow reset.

The mode pin input levels must not be changed in boot mode.

• If the mode pin input levels are changed (for example, from low to high) during a reset, the state of ports with multiplexed address functions and bus control output pins (\overline{AS} , \overline{RD} , \overline{WR}) will change according to the change in the microcomputer's operating mode^{*2}.

Therefore, care must be taken to make pin settings to prevent these pins from becoming output signal pins during a reset, or to prevent collision with signals outside the microcomputer.

- Notes: 1. Mode pin input must satisfy the mode programming setup time ($t_{MDS} = 4$ states) with respect to the reset release timing.
 - 2. Ports with multiplexed address functions will output a low level as the address signal if mode pin setting is for mode 1 is entered during a reset. In other modes, the port pins go to the high-impedance state. The bus control output signals will output a high

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level if mode pin setting is for mode 1 is entered during a reset. In other modes, the port pins go to the high-impedance state.

21.6.2 User Program Mode

When set to user program mode, the chip can program and erase its flash memory by executing a user program/erase control program. Therefore, on-board reprogramming of the on-chip flash memory can be carried out by providing on-board supply of programming data, and storing a program/erase control program in part of the program area as necessary.

To select user program mode, select a mode that enables the on-chip flash memory (mode 2 or 3). In this mode, on-chip supporting modules other than flash memory operate as they normally would in mode 2 and 3.

The flash memory itself cannot be read while the SWE bit is set to 1 to perform programming or erasing, so the control program that performs programming and erasing should be run in on-chip RAM or external memory.

Figure 21.11 shows the procedure for executing the program/erase control program when transferred to on-chip RAM.

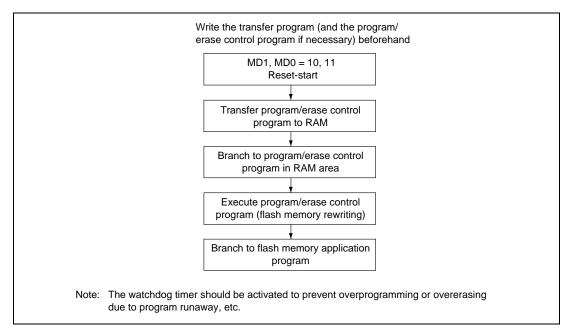


Figure 21.11 User Program Mode Execution Procedure

21.7 Programming/Erasing Flash Memory

In the on-board programming modes, flash memory programming and erasing is performed by software, using the CPU. There are four flash memory operating modes: program mode, erase mode, program-verify mode, and erase-verify mode. Transitions to these modes can be made by setting the PSU and ESU bits in FLMCR2, and the P, E, PV, and EV bits in FLMCR1.

The flash memory cannot be read while being programmed or erased. Therefore, the program that controls flash memory programming/erasing (the programming control program) should be located and executed in on-chip RAM or external memory.

- Notes: 1. Operation is not guaranteed if setting/resetting of the SWE, EV, PV, E, and P bits in FLMCR1, and the ESU and PSU bits in FLMCR2, is executed by a program in flash memory.
 - 2. Perform programming in the erased state. Do not perform additional programming on previously programmed addresses.

21.7.1 Program Mode

Follow the procedure shown in the program/program-verify flowchart in figure 21.12 to write data or programs to flash memory. Performing program operations according to this flowchart will enable data or programs to be written to flash memory without subjecting the device to voltage stress or sacrificing program data reliability. Programming should be carried out 32 bytes at a time.

The wait times (x, y, z, α , β , γ , ϵ , η) after setting/clearing individual bits in flash memory control registers 1 and 2 (FLMCR1, FLMCR2) and the maximum number of writes (N) are shown in table 24.13 in section 24.6, Flash Memory Characteristics.

Following the elapse of (x) µs or more after the SWE bit is set to 1 in flash memory control register 1 (FLMCR1), 32-byte program data is stored in the program data area and reprogram data area, and the 32-byte data in the reprogram data area written consecutively to the write addresses. The lower 8 bits of the first address written to must be H'00, H'20, H'40, H'60, H'80, H'A0, H'C0, or H'E0. Thirty-two consecutive byte data transfers are performed. The program address and program data are latched in the flash memory. A 32-byte data transfer must be performed even if writing fewer than 32 bytes; in this case, H'FF data must be written to the extra addresses.

Next, the watchdog timer is set to prevent overprogramming in the event of program runaway, etc. Set a value greater than $(y + z + \alpha + \beta) \mu s$ as the WDT overflow period. After this, preparation for program mode (program setup) is carried out by setting the PSU bit in FLMCR2, and after the elapse of $(y) \mu s$ or more, the operating mode is switched to program mode by setting the P bit in FLMCR1. The time during which the P bit is set is the flash memory

programming time. Make a program setting so that the time for one programming operation is within the range of (z) μ s.

21.7.2 Program-Verify Mode

In program-verify mode, the data written in program mode is read to check whether it has been correctly written in the flash memory.

After the elapse of a given programming time, the programming mode is exited (the P bit in FLMCR1 is cleared, then the PSU bit in FLMCR2 is cleared at least (α) µs later). The watchdog timer is cleared after the elapse of (β) µs or more, and the operating mode is switched to program-verify mode by setting the PV bit in FLMCR1. Before reading in program-verify mode, a dummy write of H'FF data should be made to the addresses to be read. The dummy write should be executed after the elapse of (γ) µs or more. When the flash memory is read in this state (verify data is read in 16-bit units), the data at the latched address is read. Wait at least (ε) µs after the dummy write before performing this read operation. Next, the originally written data is compared with the verify data, and reprogram data is computed (see figure 21.12) and transferred to the reprogram data area. After 32 bytes of data have been verified, exit program-verify mode, wait for at least (η) µs, then clear the SWE bit in FLMCR1. If reprogramming is necessary, set program mode again, and repeat the program/program-verify sequence as before. However, ensure that the program/program-verify sequence is not repeated more than (N) times on the same bits.

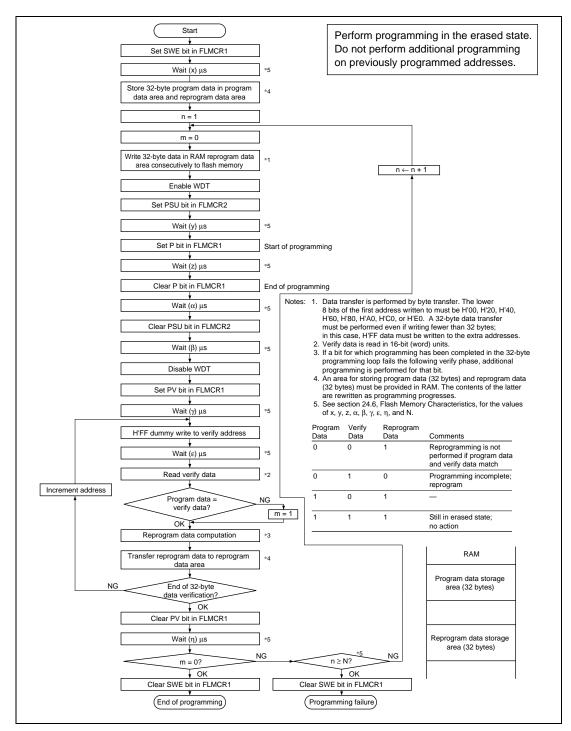


Figure 21.12 Program/Program-Verify Flowchart

21.7.3 Erase Mode

Flash memory erasing should be performed block by block following the procedure shown in the erase/erase-verify flowchart (single-block erase) shown in figure 21.13.

The wait times (x, y, z, α , β , γ , ϵ , η) after setting/clearing individual bits in flash memory control registers 1 and 2 (FLMCR1, FLMCR2) and the maximum number of erases (N) are shown in table 24.13 in section 24.6, Flash Memory Characteristics.

To perform data or program erasure, make a 1 bit setting for the flash memory area to be erased in erase block register 1 or 2 (EBR1 or EBR2) at least (x) μ s after setting the SWE bit to 1 in flash memory control register 1 (FLMCR1). Next, the watchdog timer is set to prevent overerasing in the event of program runaway, etc. Set a value greater than (y + z + α + β) ms as the WDT overflow period. After this, preparation for erase mode (erase setup) is carried out by setting the ESU bit in FLMCR2, and after the elapse of (y) μ s or more, the operating mode is switched to erase mode by setting the E bit in FLMCR1. The time during which the E bit is set is the flash memory erase time. Ensure that the erase time does not exceed (z) ms.

Note: With flash memory erasing, preprogramming (setting all data in the memory to be erased to 0) is not necessary before starting the erase procedure.

21.7.4 Erase-Verify Mode

In erase-verify mode, data is read after memory has been erased to check whether it has been correctly erased.

After the elapse of the erase time, erase mode is exited (the E bit in FLMCR1 is cleared, then the ESU bit in FLMCR2 is cleared at least (α) µs later), the watchdog timer is cleared after the elapse of (β) µs or more, and the operating mode is switched to erase-verify mode by setting the EV bit in FLMCR1. Before reading in erase-verify mode, a dummy write of H'FF data should be made to the addresses to be read. The dummy write should be executed after the elapse of (γ) µs or more. When the flash memory is read in this state (verify data is read in 16-bit units), the data at the latched address is read. Wait at least (ϵ) µs after the dummy write before performing this read operation. If the read data has been erased (all 1), a dummy write is performed to the next address, and erase-verify is performed. If the read data has not been erased, set erase mode again, and repeat the erase/erase-verify sequence in the same way. However, ensure that the erase/erase-verify mode, and wait for at least (η) µs. If erasure has been completed on all the erase blocks, clear the SWE bit in FLMCR1. If there are any unerased blocks, make a 1 bit setting in EBR1 or EBR2 for the flash memory area to be erased, and repeat the erase/erase-verify sequence in the same way.

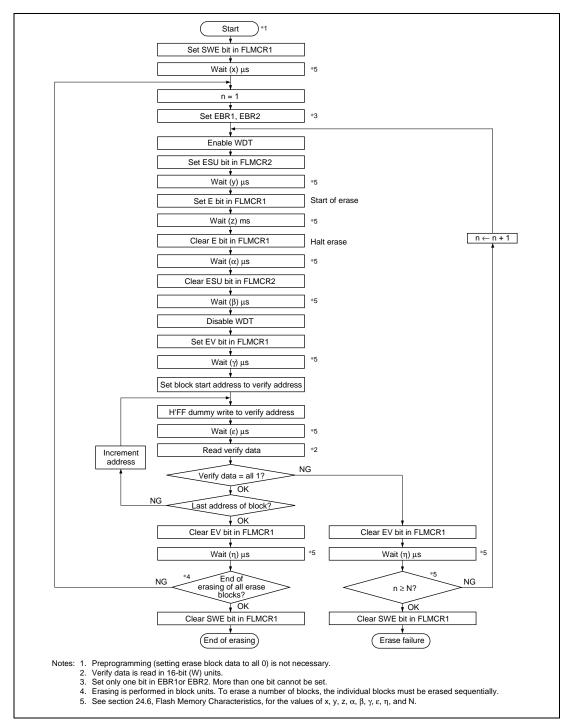


Figure 21.13 Erase/Erase-Verify Flowchart (Single-Block Erase)

21.8 Flash Memory Protection

There are three kinds of flash memory program/erase protection: hardware protection, software protection, and error protection.

21.8.1 Hardware Protection

Hardware protection refers to a state in which programming/erasing of flash memory is forcibly disabled or aborted. Hardware protection is reset by settings in flash memory control registers 1 and 2 (FLMCR1, FLMCR2) and erase block registers 1 and 2 (EBR1, EBR2). (See table 21.8.)

		Functions		
Item	Description	Program	Erase	
Reset/standby protection	 In a reset (including a WDT overflow reset), software standby mode, subactive mode, subsleep mode, and watch mode, FLMCR1, FLMCR2, EBR1, and EBR2 are initialized, and the program/erase-protected state is entered. In a reset via the RES pin, the reset state is not entered unless the RES pin is held low until oscillation stabilizes after powering on. In the case of a reset during operation, hold the RES pin low for the RES pulse width specified in the AC Characteristics section. 	Yes	Yes	

Table 21.8 Hardware Protection

21.8.2 Software Protection

Software protection can be implemented by setting the SWE bit in FLMCR1 and erase block registers 1 and 2 (EBR1, EBR2). When software protection is in effect, setting the P or E bit in flash memory control register 1 (FLMCR1) does not cause a transition to program mode or erase mode. (See table 21.9.)

		Functions		
Item	Description	Program	Erase	
SWE bit protection	 Clearing the SWE bit to 0 in FLMCR1 sets the program/erase-protected state for all blocks. (Execute in on-chip RAM or external memory.) 	Yes	Yes	
Block specification protection	 Erase protection can be set for individual blocks by settings in erase block registers 1 and 2 (EBR1, EBR2). Setting EBR1 and EBR2 to H'00 places all blocks in the erase-protected state. 	_	Yes	

Table 21.9 Software Protection

21.8.3 Error Protection

In error protection, an error is detected when MCU runaway occurs during flash memory programming/erasing, or operation is not performed in accordance with the program/erase algorithm, and the program/erase operation is aborted. Aborting the program/erase operation prevents damage to the flash memory due to overprogramming or overerasing.

If the MCU malfunctions during flash memory programming/erasing, the FLER bit is set to 1 in FLMCR2 and the error protection state is entered. The FLMCR1, FLMCR2, EBR1, and EBR2 settings are retained, but program mode or erase mode is aborted at the point at which the error occurred. Program mode or erase mode cannot be re-entered by re-setting the P or E bit. However, PV and EV bit setting is enabled, and a transition can be made to verify mode.

FLER bit setting conditions are as follows:

- When flash memory is read during programming/erasing (including a vector read or instruction fetch)
- Immediately after exception handling (excluding a reset) during programming/erasing
- When a SLEEP instruction (transition to software standby, sleep, subactive, subsleep, or watch mode) is executed during programming/erasing
- When the bus is released during programming/erasing

Error protection is released only by a reset and in hardware standby mode.

Figure 21.14 shows the flash memory state transition diagram.

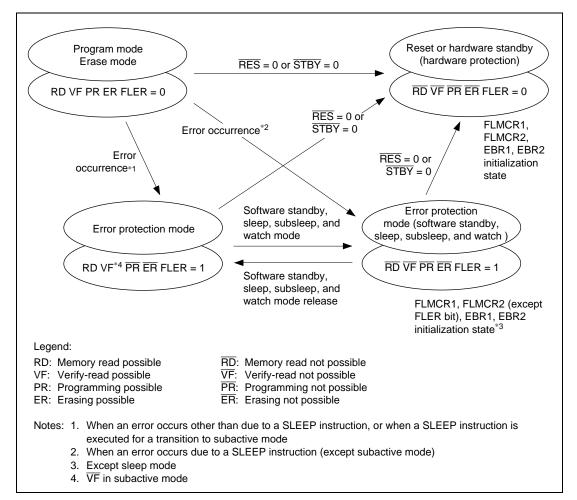


Figure 21.14 Flash Memory State Transitions

21.9 Interrupt Handling when Programming/Erasing Flash Memory

All interrupts, including NMI input is disabled when flash memory is being programmed or erased (when the P or E bit is set in FLMCR1), and while the boot program is executing in boot $mode^{*1}$, to give priority to the program or erase operation. There are three reasons for this:

- 1. Interrupt during programming or erasing might cause a violation of the programming or erasing algorithm, with the result that normal operation could not be assured.
- 2. In the interrupt exception handling sequence during programming or erasing, the vector would not be read correctly*², possibly resulting in MCU runaway.
- 3. If interrupt occurred during boot program execution, it would not be possible to execute the normal boot mode sequence.

For these reasons, in on-board programming mode alone there are conditions for disabling interrupt, as an exception to the general rule. However, this provision does not guarantee normal erasing and programming or MCU operation. All interrupt requests, including NMI input, must therefore be disabled inside and outside the MCU when programming or erasing flash memory. Interrupt is also disabled in the error-protection state while the P or E bit remains set in FLMCR1.

Notes: 1. Interrupt requests must be disabled inside and outside the MCU until the programming control program has completed programming.

- 2. The vector may not be read correctly in this case for the following two reasons:
 - If flash memory is read while being programmed or erased (while the P or E bit is set in FLMCR1), correct read data will not be obtained (undetermined values will be returned).
 - If the interrupt entry in the vector table has not been programmed yet, interrupt exception handling will not be executed correctly.

21.10 Flash Memory Writer Mode

21.10.1 Writer Mode Setting

Programs and data can be written and erased in writer mode as well as in the on-board programming modes. In writer mode, the on-chip ROM can be freely programmed using a PROM programmer that supports Hitachi microcomputer device types with 128-kbyte or 64-kbyte on-chip flash memory. Flash memory read mode, auto-program mode, auto-erase mode, and status read mode are supported with these device types. In auto-program mode, auto-erase mode, and status read mode, a status polling procedure is used, and in status read mode, detailed internal signals are output after execution of an auto-program or auto-erase operation.

Table 21.10 shows writer mode pin settings.

Pin Names	Setting/External Circuit Connection
Mode pins: MD1, MD0	Low-level input to MD1, MD0
STBY pin	High-level input (Hardware standby mode not set)
RES pin	Power-on reset circuit
XTAL and EXTAL pins	Oscillation circuit
Other setting pins: P97, P92, P91, P90, P67	Low-level input to P92, P67, high-level input to P97, P91, P90

Table 21.10 Writer Mode Pin Settings

21.10.2 Socket Adapters and Memory Map

In writer mode, a socket adapter is mounted on the writer programmer to match the package concerned. Socket adapters are available for each writer manufacturer supporting Hitachi microcomputer device types with 128-kbyte or 64-kbyte on-chip flash memory.

Figure 21.15 shows the memory map in writer mode. For pin names in writer mode, see section 1.3.2, Pin Functions in Each Operating Mode.

MCU mode	H8S/2138 H8S/2134	Writer mode	MCU mode	H8S/2132	Writer mode
H'000000		H'00000	H'000000		H'00000
				On-chip	
	On shin			ROM area	
	On-chip ROM area		H'00FFFF		H'0FFFF
	INOM alea			Undefined value	
				output	
H'01FFFF		_ H'1FFFF		;	H'1FFFF

Figure 21.15 Memory Map in Writer Mode

21.10.3 Writer Mode Operation

Table 21.11 shows how the different operating modes are set when using writer mode, and table 21.12 lists the commands used in writer mode. Details of each mode are given below.

• Memory Read Mode

Memory read mode supports byte reads.

- Auto-Program Mode Auto-program mode supports programming of 128 bytes at a time. Status polling is used to confirm the end of auto-programming.
- Auto-Erase Mode

Auto-erase mode supports automatic erasing of the entire flash memory. Status polling is used to confirm the end of auto-erasing.

• Status Read Mode

Status polling is used for auto-programming and auto-erasing, and normal termination can be confirmed by reading the FO6 signal. In status read mode, error information is output if an error occurs.

Table 21.11 Settings for Each Operating Mode in Writer Mode

	Pin Names					
Mode	CE	ŌĒ	WE	FO0 to FO7	FA0 to FA17	
Read	L	L	Н	Data output	Ain	
Output disable	L	Н	Н	Hi-z	Х	
Command write	L	Н	L	Data input	Ain* ²	
Chip disable*1	Н	Х	Х	Hi-z	Х	

Notes: 1. Chip disable is not a standby state; internally, it is an operation state.2. Ain indicates that there is also address input in auto-program mode.

Table 21.12 Writer Mode Commands

	Number 1st Cycle				2nd Cycle		
Command Name	of Cycles	Mode	Address	Data	Mode	Address	Data
Memory read mode	1 + n	Write	Х	H'00	Read	RA	Dout
Auto-program mode	129	Write	Х	H'40	Write	WA	Din
Auto-erase mode	2	Write	Х	H'20	Write	Х	H'20
Status read mode	2	Write	Х	H'71	Write	Х	H'71

Notes: 1. In auto-program mode, 129 cycles are required for command writing by a simultaneous 128-byte write.

2. In memory read mode, the number of cycles depends on the number of address write cycles (n).

21.10.4 Memory Read Mode

- After the end of an auto-program, auto-erase, or status read operation, the command wait state is entered. To read memory contents, a transition must be made to memory read mode by means of a command write before the read is executed.
- Command writes can be performed in memory read mode, just as in the command wait state.
- Once memory read mode has been entered, consecutive reads can be performed.
- After power-on, memory read mode is entered.

Table 21.13	AC Characteristics in Memory Read Mode
	(Conditions: $V_{cc} = 5.0 \text{ V} \pm 10\%$, $V_{ss} = 0 \text{ V}$, $T_a = 25^{\circ}\text{C} \pm 5^{\circ}\text{C}$)

Item	Symbol	Min	Max	Unit	Notes
Command write cycle	t _{nxtc}	20		μs	
CE hold time	t _{ceh}	0		ns	
CE setup time	t _{ces}	0		ns	
Data hold time	t _{dh}	50		ns	
Data setup time	t _{ds}	50		ns	
Write pulse width	t _{wep}	70		ns	
WE rise time	t _r		30	ns	
WE fall time	t _f		30	ns	

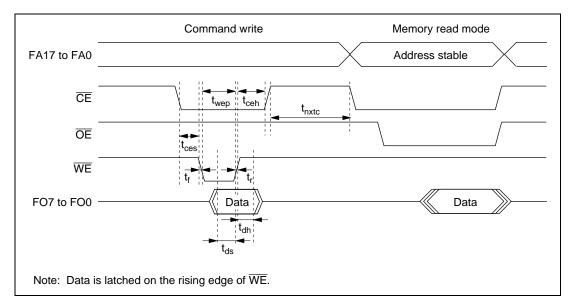


Figure 21.16 Memory Read Mode Timing Waveforms after Command Write

Item	Symbol	Min	Max	Unit	Notes
Command write cycle	t _{nxtc}	20		μs	
CE hold time	t _{ceh}	0		ns	
CE setup time	t _{ces}	0		ns	
Data hold time	t _{dh}	50		ns	
Data setup time	t _{ds}	50		ns	
Write pulse width	t _{wep}	70		ns	
WE rise time	t,		30	ns	
WE fall time	t _r		30	ns	

Table 21.14AC Characteristics when Entering Another Mode from Memory Read Mode
(Conditions: $V_{cc} = 5.0 \text{ V} \pm 10\%$, $V_{ss} = 0 \text{ V}$, $T_a = 25^{\circ}\text{C} \pm 5^{\circ}\text{C}$)

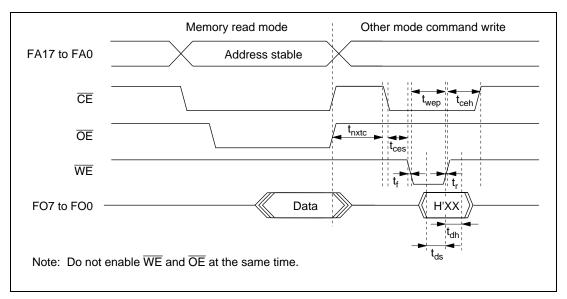


Figure 21.17 Timing Waveforms when Entering Another Mode from Memory Read Mode

Item	Symbol	Min	Max	Unit	Notes
Access time	t _{acc}		20	μs	
CE output delay time	t _{ce}		150	ns	
\overline{OE} output delay time	t _{oe}		150	ns	
Output disable delay time	t _{df}		100	ns	
Data output hold time	t _{oh}	5		ns	

Table 21.15AC Characteristics in Memory Read Mode(Conditions: $V_{cc} = 5.0 \text{ V} \pm 10\%$, $V_{ss} = 0 \text{ V}$, $T_a = 25^{\circ}C \pm 5^{\circ}C$)

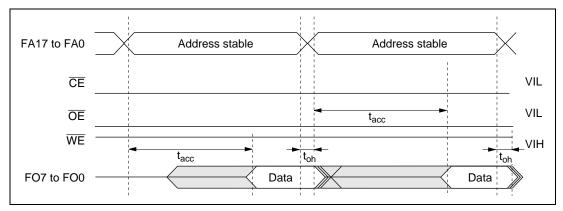


Figure 21.18 Timing Waveforms for $\overline{CE}/\overline{OE}$ Enable State Read

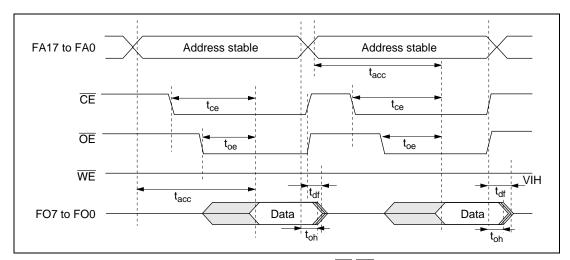


Figure 21.19 Timing Waveforms for $\overline{CE}/\overline{OE}$ Clocked Read

21.10.5 Auto-Program Mode

AC Characteristics

Table 21.16 AC Characteristics in Auto-Program Mode

(Conditions: $V_{cc} = 5.0 \text{ V} \pm 10\%, V_{ss} = 0 \text{ V}, T_a = 25^{\circ}\text{C} \pm 5^{\circ}\text{C}$)

Item	Symbol	Min	Max	Unit	Notes
Command write cycle	t _{nxtc}	20		μs	
CE hold time	t _{ceh}	0		ns	
CE setup time	t _{ces}	0		ns	
Data hold time	t _{dh}	50		ns	
Data setup time	t _{ds}	50		ns	
Write pulse width	t _{wep}	70		ns	
Status polling start time	t _{wsts}	1		ms	
Status polling access time	t _{spa}		150	ns	
Address setup time	t _{as}	0		ns	
Address hold time	t _{ah}	60		ns	
Memory write time	t _{write}	1	3000	ms	
WE rise time	t,		30	ns	
WE fall time	t _r		30	ns	

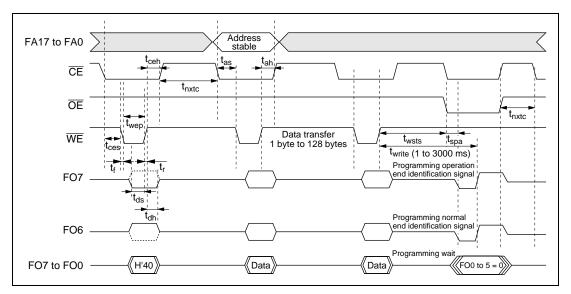


Figure 21.20 Auto-Program Mode Timing Waveforms

Notes on Use of Auto-Program Mode

- In auto-program mode, 128 bytes are programmed simultaneously. This should be carried out by executing 128 consecutive byte transfers.
- A 128-byte data transfer is necessary even when programming fewer than 128 bytes. In this case, H'FF data must be written to the extra addresses.
- The lower 8 bits of the transfer address must be H'00 or H'80. If a value other than an effective address is input, processing will switch to a memory write operation but a write error will be flagged.
- Memory address transfer is performed in the second cycle (figure 21.20). Do not perform transfer after the second cycle.
- Do not perform a command write during a programming operation.
- Perform one auto-programming operation for a 128-byte block for each address. Characteristics are not guaranteed for two or more programming operations.
- Confirm normal end of auto-programming by checking FO6. Alternatively, status read mode can also be used for this purpose (FO7 status polling uses the auto-program operation end identification pin).
- The status polling FO6 and FO7 pin information is retained until the next command write. Until the next command write is performed, reading is possible by enabling \overline{CE} and \overline{OE} .

21.10.6 Auto-Erase Mode

AC Characteristics

Table 21.17 AC Characteristics in Auto-Erase Mode (Conditions: $V_{cc} = 5.0 V \pm 10\%$, $V_{ss} = 0 V$, $T_a = 25^{\circ}C \pm 5^{\circ}C$)

Item	Symbol	Min	Max	Unit	Notes
Command write cycle	t _{nxtc}	20		μs	
CE hold time	t _{ceh}	0		ns	
CE setup time	t _{ces}	0		ns	
Data hold time	t _{dh}	50		ns	
Data setup time	t _{ds}	50		ns	
Write pulse width	t _{wep}	70		ns	
Status polling start time	t _{ests}	1		ms	
Status polling access time	t _{spa}		150	ns	
Memory erase time	t _{erase}	100	40000	ms	
WE rise time	t,		30	ns	
WE fall time	t,		30	ns	

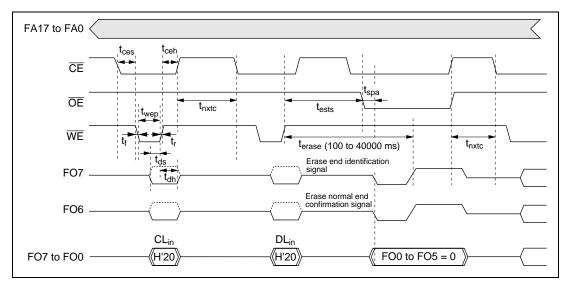


Figure 21.21 Auto-Erase Mode Timing Waveforms

Notes on Use of Erase-Program Mode

- Auto-erase mode supports only entire memory erasing.
- Do not perform a command write during auto-erasing.
- Confirm normal end of auto-erasing by checking FO6. Alternatively, status read mode can also be used for this purpose (FO7 status polling uses the auto-erase operation end identification pin).
- The status polling FO6 and FO7 pin information is retained until the next command write. Until the next command write is performed, reading is possible by enabling \overline{CE} and \overline{OE} .

21.10.7 Status Read Mode

- Status read mode is used to identify what type of abnormal end has occurred. Use this mode when an abnormal end occurs in auto-program mode or auto-erase mode.
- The return code is retained until a command write for other than status read mode is performed.

Table 21.18 AC Characteristics in Status Read Mode

(Conditions: $V_{cc} = 5.0 \text{ V} \pm 10\%$, $V_{ss} = 0 \text{ V}$, $T_a = 25^{\circ}C \pm 5^{\circ}C$)

Item	Symbol	Min	Max	Unit	Notes
Command write cycle	t _{nxtc}	20		μs	
CE hold time	t _{ceh}	0		ns	
CE setup time	t _{ces}	0		ns	
Data hold time	t _{dh}	50		ns	
Data setup time	t _{ds}	50		ns	
Write pulse width	t _{wep}	70		ns	
OE output delay time	t _{oe}		150	ns	
Disable delay time	t _{df}		100	ns	
CE output delay time	t _{ce}		150	ns	
WE rise time	t _r		30	ns	
WE fall time	t _f		30	ns	

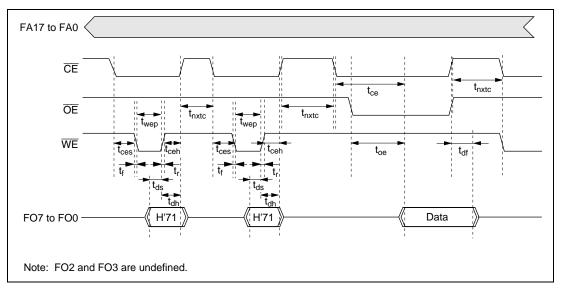


Figure 21.22 Status Read Mode Timing Waveforms

Table 21.19 Status Read Mode Return Commands	Table 21.19	Commands
--	-------------	----------

Pin Name	F07	FO6	FO5	FO4	FO3	FO2	FO1	FO0
Attribute	Normal end identification	Command error	Programming error	gErase error	_	_	Programming or erase count exceeded	Effective address error
Initial value	0	0	0	0	0	0	0	0
Indications	Normal end: 0	Command error: 1	Programming error: 1	gErase error: 1	_	_	Count exceeded: 1	Effective address
	Abnormal end: 1	Otherwise: 0	Otherwise: 0	Otherwise: 0			Otherwise: 0	error: 1 Otherwise: 0

Note: FO2 and FO3 are undefined.

21.10.8 Status Polling

- The FO7 status polling flag indicates the operating status in auto-program or auto-erase mode.
- The FO6 status polling flag indicates a normal or abnormal end in auto-program or autoerase mode.

Table 21.20 Status Polling Output Truth Table

Pin Names	Internal Operation in Progress	Abnormal End	_	Normal End
FO7	0	1	0	1
FO6	0	0	1	1
FO0 to FO5	0	0	0	0

21.10.9 Writer Mode Transition Time

Commands cannot be accepted during the oscillation stabilization period or the writer mode setup period. After the writer mode setup time, a transition is made to memory read mode.

 Table 21.21
 Command Wait State Transition Time Specifications

Item	Symbol	Min	Max	Unit	Notes
Standby release (oscillation stabilization time)	t _{osc1}	20	—	ms	
PROM mode setup time	t _{bmv}	10	_	ms	
V _{cc} hold time	t _{dwn}	0	_	ms	

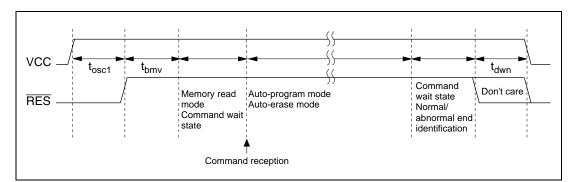


Figure 21.23 Oscillation Stabilization Time, Writer Mode Setup Time, and Power Supply Fall Sequence

21.10.10 Notes On Memory Programming

- When programming addresses which have previously been programmed, carry out autoerasing before auto-programming.
- When performing programming using writer mode on a chip that has been programmed/erased in an on-board programming mode, auto-erasing is recommended before carrying out auto-programming.
- Notes: 1. The flash memory is initially in the erased state when the device is shipped by Hitachi. For other chips for which the erasure history is unknown, it is recommended that auto-erasing be executed to check and supplement the initialization (erase) level.
 - 2. Auto-programming should be performed once only on the same address block.

21.11 Flash Memory Programming and Erasing Precautions

Precautions concerning the use of on-board programming mode and writer mode are summarized below.

Use the specified voltages and timing for programming and erasing: Applied voltages in excess of the rating can permanently damage the device. Use a PROM programmer that supports Hitachi microcomputer device types with 128-kbyte or 64-kbyte on-chip flash memory.

Do not select the HN28F101 setting for the PROM programmer, and only use the specified socket adapter. Incorrect use will result in damaging the device.

Powering on and off: When applying or disconnecting V_{cc} , fix the \overline{RES} pin low and place the flash memory in the hardware protection state.

The power-on and power-off timing requirements should also be satisfied in the event of a power failure and subsequent recovery.

Use the recommended algorithm when programming and erasing flash memory: The recommended algorithm enables programming and erasing to be carried out without subjecting the device to voltage stress or sacrificing program data reliability. When setting the P or E bit in FLMCR1, the watchdog timer should be set beforehand as a precaution against program runaway, etc.

Do not set or clear the SWE bit during program execution in flash memory: Clear the SWE bit before executing a program or reading data in flash memory. When the SWE bit is set, data in flash memory can be rewritten, but flash memory should only be accessed for verify operations (verification during programming/erasing).

Do not use interrupts while flash memory is being programmed or erased: All interrupt requests, including NMI, should be disabled to give priority to program/erase operations.

Do not perform additional programming. Erase the memory before reprogramming. In onboard programming, perform only one programming operation on a 32-byte programming unit block. In writer mode, too, perform only one programming operation on a 128-byte programming unit block. Programming should be carried out with the entire programming unit block erased.

Before programming, check that the chip is correctly mounted in the PROM programmer.

Overcurrent damage to the device can result if the index marks on the PROM programmer socket, socket adapter, and chip are not correctly aligned.

Do not touch the socket adapter or chip during programming. Touching either of these can cause contact faults and write errors.

Section 22 Clock Pulse Generator

22.1 Overview

The H8S/2138 Series and H8S/2134 Series have a built-in clock pulse generator (CPG) that generates the system clock (\emptyset), the bus master clock, and internal clocks.

The clock pulse generator consists of an oscillator circuit, a duty adjustment circuit, clock selection circuit, medium-speed clock divider, bus master clock selection circuit, subclock input circuit, and waveform shaping circuit.

22.1.1 Block Diagram

Figure 22.1 shows a block diagram of the clock pulse generator.

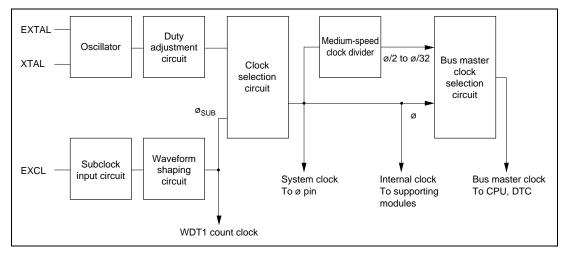


Figure 22.1 Block Diagram of Clock Pulse Generator

22.1.2 Register Configuration

The clock pulse generator is controlled by the standby control register (SBYCR) and low-power control register (LPWRCR). Table 22.1 shows the register configuration.

Table 22.1 CPG Registers

Name	Abbreviation	R/W	Initial Value	Address*
Standby control register	SBYCR	R/W	H'00	H'FF84
Low-power control register	LPWRCR	R/W	H'00	H'FF85

Note: *Lower 16 bits of the address.

22.2 Register Descriptions

22.2.1 Standby Control Register (SBYCR)

Bit	7	6	5	4	3	2	1	0
	SSBY	STS2	STS1	STS0	—	SCK2	SCK1	SCK0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	—	R/W	R/W	R/W

SBYCR is an 8-bit readable/writable register that performs power-down mode control.

Only bits 0 to 2 are described here. For a description of the other bits, see section 23.2.1, Standby Control Register (SBYCR).

SBYCR is initialized to H'00 by a reset and in hardware standby mode. It is not initialized in software standby mode.

Bits 2 to 0—System Clock Select 2 to 0 (SCK2 to SCK0): These bits select the bus master clock for high-speed mode and medium-speed mode.

When operating the device after a transition to subactive mode or watch mode bits SCK2 to SCK0 should all be cleared to 0.

Bit 2	Bit 1	Bit 0		
SCK2	SCK1	SCK0	Description	
0	0	0	Bus master is in high-speed mode	(Initial value)
		1	Medium-speed clock is ø/2	
	1	0	Medium-speed clock is ø/4	
		1	Medium-speed clock is ø/8	
1	0	0	Medium-speed clock is ø/16	
		1	Medium-speed clock is ø/32	
	1	—	_	

22.2.2 Low-Power Control Register (LPWRCR)

Bit	7	6	5	4	3	2	1	0
	DTON	LSON	NESEL	EXCLE	—	—	—	—
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	_	_	_	_

LPWRCR is an 8-bit readable/writable register that performs power-down mode control.

Only bit 4 is described here. For a description of the other bits, see section 23.2.2, Low-Power Control Register (LPWRCR).

LPWRCR is initialized to H'00 by a reset and in hardware standby mode. It is not initialized in software standby mode.

Bit 4—Subclock Input Enable (EXCLE): Controls subclock input from the EXCL pin.

Bit 4

EXCLE	Description	
0	Subclock input from EXCL pin is disabled	(Initial value)
1	Subclock input from EXCL pin is enabled	

22.3 Oscillator

Clock pulses can be supplied by connecting a crystal resonator, or by input of an external clock.

22.3.1 Connecting a Crystal Resonator

Circuit Configuration: A crystal resonator can be connected as shown in the example in figure 22.2. Select the damping resistance R_d according to table 22.2. An AT-cut parallel-resonance crystal should be used.

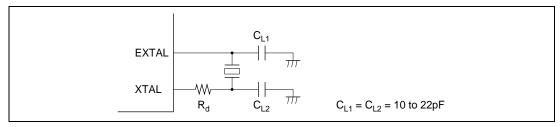


Figure 22.2 Connection of Crystal Resonator (Example)

Table 22.2 Damping Resistance Value

Frequency (MHz)	2	4	8	10	12	16	20
R _d (Ω)	1k	500	200	0	0	0	0

Crystal resonator: Figure 22.3 shows the equivalent circuit of the crystal resonator. Use a crystal resonator that has the characteristics shown in table 22.3 and the same frequency as the system clock (ϕ).

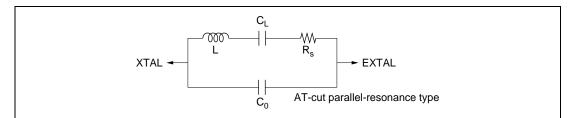


Figure 22.3 Crystal Resonator Equivalent Circuit

Table 22.3 Crystal Resonator Parameters

Frequency (MHz)	2	4	8	10	12	16	20	
R _s max (Ω)	500	120	80	70	60	50	40	
C _o max (pF)	7	7	7	7	7	7	7	

Note on Board Design: When a crystal resonator is connected, the following points should be noted.

Other signal lines should be routed away from the oscillator circuit to prevent induction from interfering with correct oscillation. See figure 22.4.

When designing the board, place the crystal resonator and its load capacitors as close as possible to the XTAL and EXTAL pins.

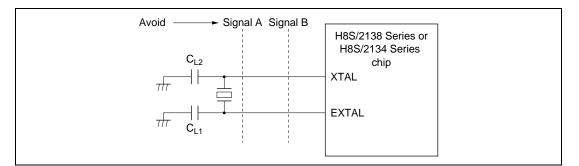


Figure 22.4 Example of Incorrect Board Design

22.3.2 External Clock Input

Circuit Configuration: An external clock signal can be input as shown in the examples in figure 22.5. If the XTAL pin is left open, make sure that stray capacitance is no more than 10 pF.

In example (b), make sure that the external clock is held high in standby mode, subactive mode, subsleep mode, and watch mode.

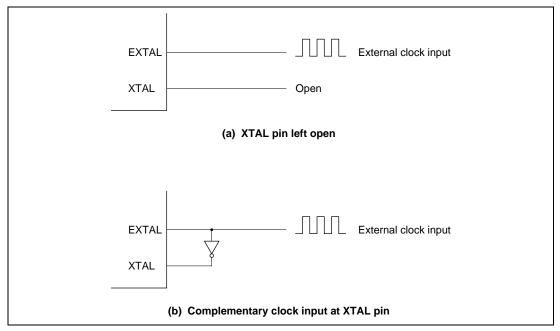


Figure 22.5 External Clock Input (Examples)

External Clock: The external clock signal should have the same frequency as the system clock (*ø*).

Table 22.4 and figure 22.6 show the input conditions for the external clock.

Table 22.4 External Clock Input Conditions

		$V_{cc} = 2$	2.7 to 5.5 V	$V_{cc} = \xi$	5.0 V ±10%				
ltem	Symbol	Min	Max	Min	Max	Unit	Test Conditions		
External clock input low pulse width		40	_	20	_	ns	Figure 22.6		
External clock input high pulse width		40	_	20	_	ns	_		
External clock rise time	t _{EXr}	_	10	_	5	ns	_		
External clock fall time	\mathbf{t}_{EXf}	_	10	_	5	ns			
Clock low pulse width	t _{c∟}	0.4	0.6	0.4	0.6	$\mathbf{t}_{_{\mathrm{cyc}}}$	$ø \ge 5 \text{ MHz}$ Figure 24.4		
		80	_	80	_	ns	ø < 5 MHz		
Clock high pulse width	t _{ch}	0.4	0.6	0.4	0.6	$\mathbf{t}_{_{\mathrm{cyc}}}$	ø≥5 MHz		
		80	—	80	_	ns	ø < 5 MHz		

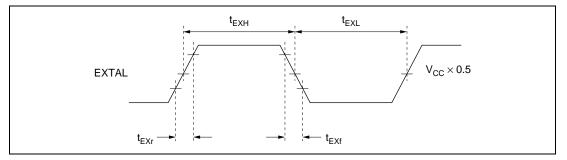


Figure 22.6 External Clock Input Timing

Table 22.5 shows the external clock output settling delay time, and figure 22.7 shows the external clock output settling delay timing. The oscillator and duty adjustment circuit have a function for adjusting the waveform of the external clock input at the EXTAL pin. When the prescribed clock signal is input at the EXTAL pin, internal clock signal output is fixed after the elapse of the external clock output settling delay time (t_{DEXT}). As the clock signal output is not fixed during the t_{DEXT} period, the reset signal should be driven low to maintain the reset state.

Table 22.5 External Clock Output Settling Delay Time

Conditions: $V_{cc} = 2.7$ V to 5.5 V, $AV_{cc} = 2.7$ V to 5.5 V, $V_{ss} = AV_{ss} = 0$ V

ltem	Symbol	Min	Max	Unit	Notes
External clock output settling delay time	t _{dext} *	500	_	μs	Figure 22.7

Note: $*t_{\text{DEXT}}$ includes $\overline{\text{RES}}$ pulse width (t_{RESW}).

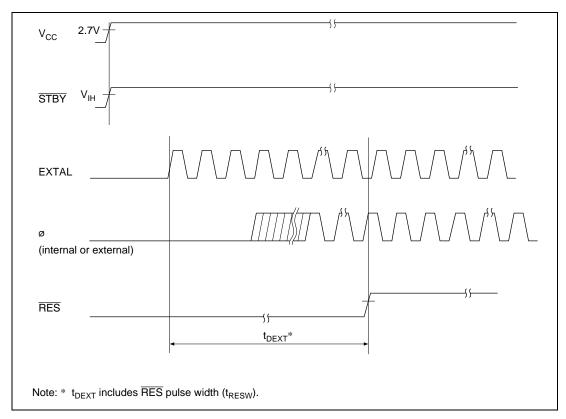


Figure 22.7 External Clock Output Settling Delay Timing

22.4 Duty Adjustment Circuit

When the oscillator frequency is 5 MHz or higher, the duty adjustment circuit adjusts the duty cycle of the clock signal from the oscillator to generate the system clock (ϕ).

22.5 Medium-Speed Clock Divider

The medium-speed clock divider divides the system clock to generate $\emptyset/2$, $\emptyset/4$, $\emptyset/8$, $\emptyset/16$, and $\emptyset/32$ clocks.

22.6 Bus Master Clock Selection Circuit

The bus master clock selection circuit selects the system clock (\emptyset) or one of the medium-speed clocks ($\emptyset/2$, $\emptyset/4$, $\emptyset/8$, $\emptyset/16$, or $\emptyset/32$) to be supplied to the bus master, according to the settings of bits SCK2 to SCK0 in SBYCR.

22.7 Subclock Input Circuit

The subclock input circuit controls the subclock input from the EXCL pin.

Inputting the Subclock: When a subclock is used, a 32.768 kHz external clock should be input from the EXCL pin. In this case, clear bit P96DDR to 0 in P9DDR and set bit EXCLE to 1 in LPWRCR.

The subclock input conditions are shown in table 22.6 and figure 22.8.

			V _{cc} = 2.7 to	5.5 V		
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Subclock input low pulse width	t_{EXCLL}	_	15.26	—	μs	Figure 22.8
Subclock input high pulse width	e t _{exclh}	_	15.26		μs	
Subclock input rise time	$t_{\scriptscriptstyle EXCLr}$		—	10	ns	
Subclock input fall time	t_{EXCLf}		_	10	ns	

Table 22.6 Subclock Input Conditions

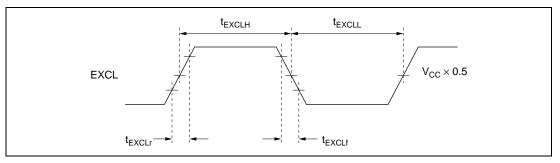


Figure 22.8 Subclock Input Timing

When Subclock is not Needed: Do not enable subclock input when the subclock is not needed

22.8 Subclock Waveform Shaping Circuit

To eliminate noise in the subclock input from the EXCL pin, this circuit samples the clock using a clock obtained by dividing the ø clock. The sampling frequency is set with the NESEL bit in LPWRCR. For details, see section 23.2.2, Low-Power Control Register (LPWRCR). The clock is not sampled in subactive mode, subsleep mode, or watch mode.

Section 23 Power-Down State

23.1 Overview

In addition to the normal program execution state, the H8S/2138 Series and H8S/2134 Series have a power-down state in which operation of the CPU and oscillator is halted and power dissipation is reduced. Low-power operation can be achieved by individually controlling the CPU, on-chip supporting modules, and so on.

The H8S/2138 Series and H8S/2134 Series operating modes are as follows:

- 1. High-speed mode
- 2. Medium-speed mode
- 3. Subactive mode
- 4. Sleep mode
- 5. Subsleep mode
- 6. Watch mode
- 7. Module stop mode
- 8. Software standby mode
- 9. Hardware standby mode

Of these, 2 to 9 are power-down modes. Sleep mode and subsleep mode are CPU modes, medium-speed mode is a CPU and bus master mode, subactive mode is a CPU, bus master, and on-chip supporting module mode, and module stop mode is an on-chip supporting module mode (including bus masters other than the CPU). Certain combinations of these modes can be set.

After a reset, the MCU is in high-speed mode and module stop mode (excluding the DTC).

Table 23.1 shows the internal chip states in each mode, and table 23.2 shows the conditions for transition to the various modes. Figure 23.1 shows a mode transition diagram.

Function		High- Speed	Medium- Speed	Sleep	Module Stop	Watch	Subactive	Subsleep	Software Standby	Hardware Standby
System clock oscillator		Function- ing	Function- ing	Function- ing	Function- ing	Halted	Halted	Halted	Halted	Halted
Subclock ir	nput	Function- ing	Function- ing	Function- ing	Function- ing	Function- ing	Function- ing	Function- ing	Halted	Halted
CPU operation	Instruc- tions	Function- ing	Medium- speed	Halted	Function- ing	Halted	Subclock operation	Halted	Halted	Halted
	Registers			Retained	-	Retained	_	Retained	Retained	Undefined
External interrupts	NMI	Function- ing	Function- ing	Function- ing	Function- ing	Function- ing	Function- ing	Function- ing	Function- ing	Halted
	IRQ0									
	IRQ1									
	IRQ2									
On-chip supporting module	DTC	Function- ing	Medium- speed	Function- ing	Function- ing/halted (retained)	Halted (retained)	Halted (retained)	Halted (retained)	Halted (retained)	Halted (reset)
operation	WDT1	Function- ing	Function- ing	Function- ing	Function- ing	Subclock operation	Subclock operation	Subclock operation	Halted (retained)	Halted (reset)
	WDT0					Halted	_			
	TMR0, 1				Function- ing/halted	(retained)				
	FRT				(retained)		Halted	Halted	-	
	TMRX, Y						(retained)	(retained)		
	Timer connec- tion									
	IIC0									
	IIC1									
	SCI0				Function- ing/halted	Halted (reset)	Halted (reset)	Halted (reset)	Halted (reset)	-
	SCI1				(reset)					
	SCI2									
	PWM									
	PWMX									
	HIF									
	D/A									
	A/D	-								
	RAM	Function- ing	Function- ing	Function- ing (DTC)	Function- ing	Retained	Function- ing	Retained	Retained	Retained
	I/O	Function- ing	Function- ing	Function- ing	Function- ing	Retained	Function- ing	Retained	Retained	High impedanc

Table 23.1 H8S/2138 Series and H8S/2134 Series Internal States in Each Mode

Note: "Halted (retained)" means that internal register values are retained. The internal state is operation suspended.

"Halted (reset)" means that internal register values and internal states are initialized. In module stop mode, only modules for which a stop setting has been made are halted (reset or retained).

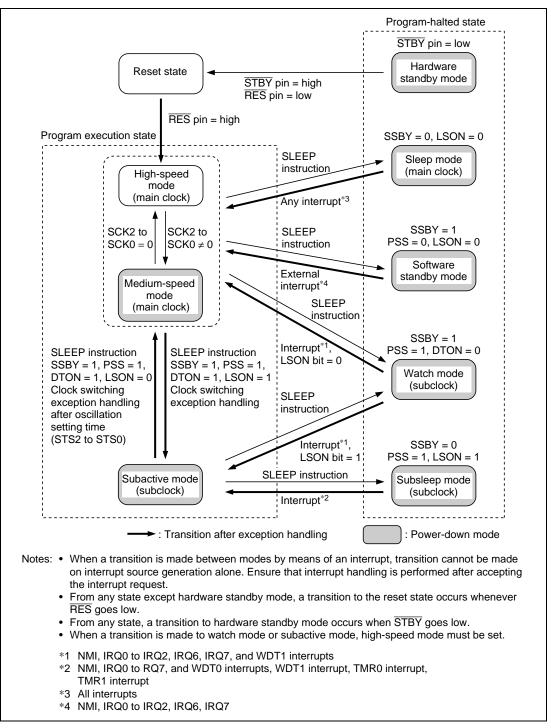


Figure 23.1 Mode Transitions

Table 23.2 Power-Down Mode Transition Conditions

	а		I Bit State			
State before Transition	SSBY	PSS	LSON	DTON	State after Transition by SLEEP Instruction	
High-speed/ medium-speed	0	*	0	*	Sleep	High-speed/ medium-speed
	0	*	1	*	_	
	1	0	0	*	Software standby	High-speed/ medium-speed
	1	0	1	*		
	1	1	0	0	Watch	High-speed
	1	1	1	0	Watch	Subactive
	1	1	0	1	_	_
	1	1	1	1	Subactive	_
Subactive	0	0	*	*	_	_
	0	1	0	*	_	_
	0	1	1	*	Subsleep	Subactive
	1	0	*	*	_	_
	1	1	0	0	Watch	High-speed
	1	1	1	0	Watch	Subactive
	1	1	0	1	High-speed	_
	1	1	1	1		

*: Don't care

-: Do not set.

23.1.1 Register Configuration

The power-down state is controlled by the SBYCR, LPWRCR, TCSR (WDT1), and MSTPCR registers. Table 23.3 summarizes these registers.

Table 23.3	Power-Down	State Registers
-------------------	-------------------	-----------------

Name	Abbreviation	R/W	Initial Value	Address*
Standby control register	SBYCR	R/W	H'00	H'FF84
Low-power control register	LPWRCR	R/W	H'00	H'FF85
Timer control/status register (WDT1)	TCSR	R/W	H'00	H'FFEA
Module stop control register	MSTPCRH	R/W	H'3F	H'FF86
	MSTPCRL	R/W	H'FF	H'FF87

Note: * Lower 16 bits of the address.

23.2 Register Descriptions

23.2.1 Standby Control Register (SBYCR)

Bit	7	6	5	4	3	2	1	0
	SSBY	STS2	STS1	STS0	—	SCK2	SCK1	SCK0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	—	R/W	R/W	R/W

SBYCR is an 8-bit readable/writable register that performs power-down mode control.

SBYCR is initialized to H'00 by a reset and in hardware standby mode. It is not initialized in software standby mode.

Bit 7—Software Standby (SSBY): Determines the operating mode, in combination with other control bits, when a power-down mode transition is made by executing a SLEEP instruction. The SSBY setting is not changed by a mode transition due to an interrupt, etc.

Bit 7		
SSBY	Description	
0	Transition to sleep mode after execution of SLEEP instruction in high-speed mode or medium-speed mode	(Initial value)
	Transition to subsleep mode after execution of SLEEP instruction in subactive mode	
1	Transition to software standby mode, subactive mode, or watch mod of SLEEP instruction in high-speed mode or medium-speed mode	e after execution
	Transition to watch mode or high-speed mode after execution of SLE subactive mode	EP instruction in

Bits 6 to 4—Standby Timer Select 2 to 0 (STS2 to STS0): These bits select the time the MCU waits for the clock to stabilize when software standby mode, watch mode, or subactive mode is cleared and a transition is made to high-speed mode or medium-speed mode by means of a specific interrupt or instruction. With crystal oscillation, refer to table 23.4 and make a selection according to the operating frequency so that the standby time is at least 8 ms (the oscillation settling time). With an external clock, any selection can be made.

Bit 6	Bit 5	Bit 4		
STS2	STS1	STS0	Description	
0	0	0	Standby time = 8192 states	(Initial value)
		1	Standby time = 16384 states	
	1	0	Standby time = 32768 states	
		1	Standby time = 65536 states	
1	0	0	Standby time = 131072 states	
		1	Standby time = 262144 states	
	1	0	Reserved	
		1	Standby time = 16 states*	

Note: Do not used this setting in the on-chip flash memory version.

Bit 3—Reserved: This bit cannot be modified and is always read as 0.

Bits 2 to 0—System Clock Select (SCK2 to SCK0): These bits select the clock for the bus master in high-speed mode and medium-speed mode. When operating the device after a transition to subactive mode or watch mode, bits SCK2 to SCK0 should all be cleared to 0.

Bit 2	Bit 1	Bit 0		
SCK2	SCK1	SCK0	Description	
0	0	0	Bus master is in high-speed mode	(Initial value)
		1	Medium-speed clock is ø/2	
	1	0	Medium-speed clock is ø/4	
		1	Medium-speed clock is ø/8	
1	0	0	Medium-speed clock is ø/16	
		1	Medium-speed clock is ø/32	
	1	_		

23.2.2 Low-Power Control Register (LPWRCR)

Bit	7	6	5	4	3	2	1	0
	DTON	LSON	NESEL	EXCLE	—	—	—	—
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	—	—	—	—

LPWRCR is an 8-bit readable/writable register that performs power-down mode control.

LPWRCR is initialized to H'00 by a reset and in hardware standby mode. It is not initialized in software standby mode.

Bit 7—Direct-Transfer On Flag (DTON): Specifies whether a direct transition is made between high-speed mode, medium-speed mode, and subactive mode when making a power-down transition by executing a SLEEP instruction. The operating mode to which the transition is made after SLEEP instruction execution is determined by a combination of other control bits.

Bit 7

DTON	Description						
0	When a SLEEP instruction is executed in high-speed mode or medium-speed mode, a transition is made to sleep mode, software standby mode, or watch mode*						
	When a SLEEP instruction is executed in subactive mode, a transition is made to subsleep mode or watch mode (Initial value)						
1	When a SLEEP instruction is executed in high-speed mode or medium-speed mode, a transition is made directly to subactive mode*, or a transition is made to sleep mode or software standby mode						
	When a SLEEP instruction is executed in subactive mode, a transition is made directly to high-speed mode, or a transition is made to subsleep mode						

Note: *When a transition is made to watch mode or subactive mode, high-speed mode must be set.

Bit 6—Low-Speed On Flag (LSON): Determines the operating mode in combination with other control bits when making a power-down transition by executing a SLEEP instruction. Also controls whether a transition is made to high-speed mode or to subactive mode when watch mode is cleared.

Bit 6

LSON	Description					
0	When a SLEEP instruction is executed in high-speed mode or medium-speed mode, a transition is made to sleep mode, software standby mode, or watch mode*					
	When a SLEEP instruction is executed in subactive mode, a transition is made to watch mode, or directly to high-speed mode					
	After watch mode is cleared, a transition is made to high-speed mode (Initial value)					
1	When a SLEEP instruction is executed in high-speed mode a transition is made to watch mode or subactive mode*					
	When a SLEEP instruction is executed in subactive mode, a transition is made to subsleep mode or watch mode					
	After watch mode is cleared, a transition is made to subactive mode					

Note: *When a transition is made to watch mode or subactive mode, high-speed mode must be set.

Bit 5—Noise Elimination Sampling Frequency Select (NESEL): Selects the frequency at which the subclock (\emptyset SUB) input from the EXCL pin is sampled with the clock (\emptyset) generated by the system clock oscillator. When $\emptyset = 5$ MHz or higher, clear this bit to 0.

Bit 5

NESEL	Description	
0	Sampling at ø divided by 32	(Initial value)
1	Sampling at ø divided by 4	

Bit 4-Subclock Input Enable (EXCLE): Controls subclock input from the EXCL pin.

Bit 4		
EXCLE	Description	
0	Subclock input from EXCL pin is disabled	(Initial value)
1	Subclock input from EXCL pin is enabled	

Bits 3 to 0—Reserved: These bits cannot be modified and are always read as 0.

23.2.3 Timer Control/Status Register (TCSR)

TCSR1

Bit	7	6	5	4	3	2	1	0
	OVF	WT/IT	TME	PSS	RST/NMI	CKS2	CKS1	CKS0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/(W)*	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Note: * Only 0 can be written in bit 7, to clear the flag.

TCSR1 is an 8-bit readable/writable register that performs selection of the WDT1 TCNT input clock, mode, etc.

Only bit 4 is described here. For details of the other bits, see section 14.2.2, Timer Control/Status Register (TCSR).

TCSR is initialized to H'00 by a reset and in hardware standby mode. It is not initialized in software standby mode.

Bit 4—Prescaler Select (PSS): Selects the WDT1 TCNT input clock.

This bit also controls the operation in a power-down mode transition. The operating mode to which a transition is made after execution of a SLEEP instruction is determined in combination with other control bits.

For details, see the description of Clock Select 2 to 0 in section 14.2.2, Timer Control/Status Register (TCSR).

Description
TCNT counts ø-based prescaler (PSM) divided clock pulses
When a SLEEP instruction is executed in high-speed mode or medium-speed mode, a transition is made to sleep mode or software standby mode (Initial value)
TCNT counts øSUB-based prescaler (PSM) divided clock pulses
When a SLEEP instruction is executed in high-speed mode or medium-speed mode, a transition is made to sleep mode, watch mode*, or subactive mode*
When a SLEEP instruction is executed in subactive mode, a transition is made to subsleep mode, watch mode, or high-speed mode

Note: * When a transition is made to watch mode or subactive mode, high-speed mode must be set.

23.2.4 Module Stop Control Register (MSTPCR)

	MSTPCRH						MSTPCRL									
									/							
Bit	7	6	5	4	3	2	1	0	7	6	5	4	3	2	1	0
	MSTP15	MSTP14	MSTP13	MSTP12	MSTP11	MSTP10	MSTP9	MSTP8	MSTP7	MSTP6	MSTP5	MSTP4	MSTP3	MSTP2	MSTP1	MSTP0
Initial value	0	0	1	1	1	1	1	1	1	1	1	1	1	1	1	1
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

MSTPCR comprises two 8-bit readable/writable registers that perform module stop mode control.

MSTPCR is initialized to H'3FFF by a reset and in hardware standby mode. It is not initialized in software standby mode.

MSTRCRH and MSTPCRL Bits 7 to 0—Module Stop (MSTP 15 to MSTP 0): These bits specify module stop mode. See table 23.3 for the method of selecting on-chip supporting modules.

Bits 7 to 0	-	
MSTP15 to MSTP0	Description	
0	Module stop mode is cleared	(Initial value of MSTP15, MSTP14)
1	Module stop mode is set	(Initial value of MSTP13 to MSTP0)

23.3 Medium-Speed Mode

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When the SCK2 to SCK0 bits in SBYCR are set to 1 in high-speed mode, the operating mode changes to medium-speed mode at the end of the bus cycle. In medium-speed mode, the CPU operates on the operating clock ($\phi/2$, $\phi/4$, $\phi/8$, $\phi/16$, or $\phi/32$) specified by the SCK2 to SCK0 bits. The bus master other than the CPU (the DTC) also operates in medium-speed mode. On-chip supporting modules other than the bus masters always operate on the high-speed clock (ϕ).

In medium-speed mode, a bus access is executed in the specified number of states with respect to the bus master operating clock. For example, if $\phi/4$ is selected as the operating clock, on-chip memory is accessed in 4 states, and internal I/O registers in 8 states.

Medium-speed mode is cleared by clearing all of bits SCK2 to SCK0 to 0. A transition is made to high-speed mode and medium-speed mode is cleared at the end of the current bus cycle.

If a SLEEP instruction is executed when the SSBY bit in SBYCR and the LSON bit in LPWRCR are cleared to 0, a transition is made to sleep mode. When sleep mode is cleared by an interrupt, medium-speed mode is restored.

If a SLEEP instruction is executed when the SSBY bit in SBYCR is set to 1, and the LSON bit in LPWRCR and the PSS bit in TCSR (WDT1) are both cleared to 0, a transition is made to software standby mode. When software standby mode is cleared by an external interrupt, medium-speed mode is restored.

When the $\overline{\text{RES}}$ pin is driven low, a transition is made to the reset state, and medium-speed mode is cleared. The same applies in the case of a reset caused by overflow of the watchdog timer.

When the $\overline{\text{STBY}}$ pin is driven low, a transition is made to hardware standby mode.

Figure 23.2 shows the timing for transition to and clearance of medium-speed mode.

Medium-speed mode
ø, supporting module
Bus master clock
Internal address SBYCR SBYCR
Internal write signal

Figure 23.2 Medium-Speed Mode Transition and Clearance Timing

23.4 Sleep Mode

23.4.1 Sleep Mode

If a SLEEP instruction is executed when the SSBY bit in SBYCR and the LSON bit in LPWRCR are both cleared to 0, the CPU enters sleep mode. In sleep mode, CPU operation stops but the contents of the CPU's internal registers are retained. Other supporting modules do not stop.

23.4.2 Clearing Sleep Mode

Sleep mode is cleared by any interrupt, or with the $\overline{\text{RES}}$ pin or $\overline{\text{STBY}}$ pin.

Clearing with an Interrupt: When an interrupt request signal is input, sleep mode is cleared and interrupt exception handling is started. Sleep mode will not be cleared if interrupts are disabled, or if interrupts other than NMI have been masked by the CPU.

Clearing with the $\overline{\text{RES}}$ **Pin:** When the $\overline{\text{RES}}$ pin is driven low, the reset state is entered. When the $\overline{\text{RES}}$ pin is driven high after the prescribed reset input period, the CPU begins reset exception handling.

Clearing with the STBY Pin: When the **STBY** pin is driven low, a transition is made to hardware standby mode.

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23.5 Module Stop Mode

23.5.1 Module Stop Mode

Module stop mode can be set for individual on-chip supporting modules.

When the corresponding MSTP bit in MSTPCR is set to 1, module operation stops at the end of the bus cycle and a transition is made to module stop mode. The CPU continues operating independently.

Table 23.4 shows MSTP bits and the corresponding on-chip supporting modules.

When the corresponding MSTP bit is cleared to 0, module stop mode is cleared and the module starts operating again at the end of the bus cycle. In module stop mode, the internal states of modules other than the SCI, A/D converter, 8-bit PWM module, and 14-bit PWM module, are retained.

After reset release, all modules other than the DTC are in module stop mode.

When an on-chip supporting module is in module stop mode, read/write access to its registers is disabled.

Register	Bit	Module
MSTPCRH	MSTP15	_
	MSTP14*	Data transfer controller (DTC)
	MSTP13	16-bit free-running timer (FRT)
	MSTP12	8-bit timers (TMR0, TMR1)
	MSTP11	8-bit PWM timer (PWM), 14-bit PWM timer (PWMX)
	MSTP10	D/A converter
	MSTP9	A/D converter
	MSTP8	8-bit timers (TMRX, TMRY), timer connection
MSTPCRL	MSTP7	Serial communication interface 0 (SCI0)
	MSTP6	Serial communication interface 1 (SCI1)
	MSTP5	Serial communication interface 2 (SCI2)
	MSTP4*	I ² C bus interface (IIC) channel 0 (option)
	MSTP3*	I ² C bus interface (IIC) channel 1 (option)
	MSTP2*	Host interface (HIF)
	MSTP1*	_
	MSTP0*	_

Table 23.4 MSTP Bits and Corresponding On-Chip Supporting Modules

Note: Bits 1 and 0 can be read or written to, but do not affect operation.

* Must be set to 1 in the H8S/2134 Series.

23.5.2 Usage Note

If there is conflict between DTC module stop mode setting and a DTC bus request, the bus request has priority and the MSTP bit will not be set to 1.

Write 1 to the MSTP bit again after the DTC bus cycle.

When using an H8S/2134 Series MCU, the MSTP bits for nonexistent modules must not be set to 1.

23.6 Software Standby Mode

23.6.1 Software Standby Mode

If a SLEEP instruction is executed when the SSBY bit in SBYCR is set to 1, the LSON bit in LPWRCR is cleared to 0, and the PSS bit in TCSR (WDT1) is cleared to 0, software standby mode is entered. In this mode, the CPU, on-chip supporting modules, and oscillator all stop. However, the contents of the CPU's internal registers, RAM data, and the states of on-chip supporting modules other than the SCI, PWM, and PWMX, and of the I/O ports, are retained.

In this mode the oscillator stops, and therefore power dissipation is significantly reduced.

23.6.2 Clearing Software Standby Mode

Software standby mode is cleared by an external interrupt (NMI pin, or pin $\overline{IRQ0}$, $\overline{IRQ1}$, $\overline{IRQ2}$, $\overline{IRQ6}$, or $\overline{IRQ7}$), or by means of the \overline{RES} pin or \overline{STBY} pin.

Clearing with an Interrupt: When an NMI, IRQ0, IRQ1, IRQ2, IRQ6, or IRQ7 interrupt request signal is input, clock oscillation starts, and after the elapse of the time set in bits STS2 to STS0 in SYSCR, stable clocks are supplied to the entire chip, software standby mode is cleared, and interrupt exception handling is started.

Software standby mode cannot be cleared with an IRQ0, IRQ1, IRQ2, IRQ6, or IRQ7 interrupt if the corresponding enable bit has been cleared to 0 or has been masked by the CPU.

Clearing with the RES Pin: When the RES pin is driven low, clock oscillation is started. At the same time as clock oscillation starts, clocks are supplied to the entire chip. Note that the RES pin must be held low until clock oscillation stabilizes. When the RES pin goes high, the CPU begins reset exception handling.

Clearing with the STBY Pin: When the STBY pin is driven low, a transition is made to hardware standby mode.

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23.6.3 Setting Oscillation Settling Time after Clearing Software Standby Mode

Bits STS2 to STS0 in SBYCR should be set as described below.

Using a Crystal Oscillator: Set bits STS2 to STS0 so that the standby time is at least 8 ms (the oscillation settling time).

Table 23.5 shows the standby times for different operating frequencies and settings of bits STS2 to STS0.

STS2	STS1	STS0	Standby Time	20 MHz	16 MHz	12 MHz	10 MHz	8 MHz	6 MHz	4 MHz	2 MHz	Unit
0	0	0	8192 states	0.41	0.51	0.65	0.8	1.0	1.3	2.0	4.1	ms
		1	16384 states	0.82	1.0	1.3	1.6	2.0	2.7	4.1	8.2	-
	1	0	32768 states	1.6	2.0	2.7	3.3	4.1	5.5	8.2	16.4	-
		1	65536 states	3.3	4.1	5.5	6.6	8.2	10.9	16.4	32.8	-
1	0	0	131072 states	6.6	8.2	10.9	13.1	16.4	21.8	32.8	65.5	-
		1	262144 states	13.1	16.4	21.8	26.2	32.8	43.6	65.6	131.2	-
	1	0	Reserved	_	_	_	_	_	_	_	_	μs
		1	16 states*	0.8	1.0	1.3	1.6	2.0	1.7	4.0	8.0	

Table 23.5 Oscillation Settling Time Settings

: Recommended time setting

*: Don't care

Note: Do not used this setting in the on-chip flash memory version.

Using an External Clock: Any value can be set. Normally, use of the minimum time is recommended.

23.6.4 Software Standby Mode Application Example

Figure 23.3 shows an example in which a transition is made to software standby mode at the falling edge on the NMI pin, and software standby mode is cleared at the rising edge on the NMI pin.

In this example, an NMI interrupt is accepted with the NMIEG bit in SYSCR cleared to 0 (falling edge specification), then the NMIEG bit is set to 1 (rising edge specification), the SSBY bit is set to 1, and a SLEEP instruction is executed, causing a transition to software standby mode.

Software standby mode is then cleared at the rising edge on the NMI pin.

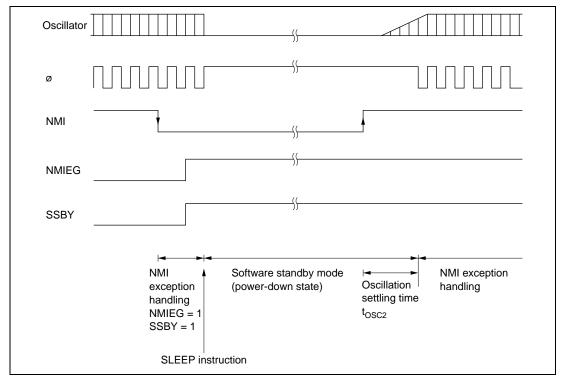


Figure 23.3 Software Standby Mode Application Example

23.6.5 Usage Note

In software standby mode, I/O port states are retained. Therefore, there is no reduction in current dissipation for the output current when a high-level signal is output.

Current dissipation increases while waiting for oscillation to settle.

23.7 Hardware Standby Mode

23.7.1 Hardware Standby Mode

When the $\overline{\text{STBY}}$ pin is driven low, a transition is made to hardware standby mode from any mode.

In hardware standby mode, all functions enter the reset state and stop operation, resulting in a significant reduction in power dissipation. As long as the prescribed voltage is supplied, on-chip RAM data is retained. I/O ports are set to the high-impedance state.

In order to retain on-chip RAM data, the RAME bit in SYSCR should be cleared to 0 before driving the $\overline{\text{STBY}}$ pin low.

Do not change the state of the mode pins (MD1 and MD0) while the chip is in hardware standby mode.

Hardware standby mode is cleared by means of the $\overline{\text{STBY}}$ pin and the $\overline{\text{RES}}$ pin. When the $\overline{\text{STBY}}$ pin is driven high while the $\overline{\text{RES}}$ pin is low, the reset state is set and clock oscillation is started. Ensure that the $\overline{\text{RES}}$ pin is held low until the clock oscillation settles (at least 8 ms—the oscillation settling time—when using a crystal oscillator). When the $\overline{\text{RES}}$ pin is subsequently driven high, a transition is made to the program execution state via the reset exception handling state.

23.7.2 Hardware Standby Mode Timing

Figure 23.4 shows an example of hardware standby mode timing.

When the $\overline{\text{STBY}}$ pin is driven low after the $\overline{\text{RES}}$ pin has been driven low, a transition is made to hardware standby mode. Hardware standby mode is cleared by driving the $\overline{\text{STBY}}$ pin high, waiting for the oscillation settling time, then changing the $\overline{\text{RES}}$ pin from low to high.

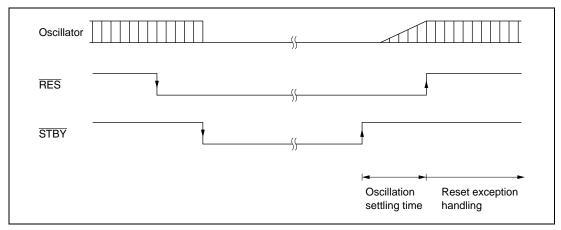


Figure 23.4 Hardware Standby Mode Timing

23.8 Watch Mode

23.8.1 Watch Mode

If a SLEEP instruction is executed in high-speed mode or subactive mode when the SSBY in SBYCR is set to 1, the DTON bit in LPWRCR is cleared to 0, and the PSS bit in TCSR (WDT1) is set to 1, the CPU makes a transition to watch mode.

In this mode, the CPU and all on-chip supporting modules except WDT1 stop. As long as the prescribed voltage is supplied, the contents of some of the CPU's internal registers and on-chip RAM are retained, and I/O ports retain their states prior to the transition.

23.8.2 Clearing Watch Mode

Watch mode is cleared by an interrupt (WOVI1 interrupt, NMI pin, or pin $\overline{IRQ0}$, $\overline{IRQ1}$, $\overline{IRQ2}$, $\overline{IRQ6}$, or $\overline{IRQ7}$), or by means of the \overline{RES} pin or \overline{STBY} pin.

Clearing with an Interrupt: When an interrupt request signal is input, watch mode is cleared and a transition is made to high-speed mode or medium-speed mode if the LSON bit in LPWRCR is cleared to 0, or to subactive mode if the LSON bit is set to 1. When making a transition to high-speed mode, after the elapse of the time set in bits STS2 to STS0 in SBYCR, stable clocks are supplied to the entire chip, and interrupt exception handling is started.

Watch mode cannot be cleared with an IRQ0, IRQ1, IRQ2, IRQ6, or IRQ7 interrupt if the corresponding enable bit has been cleared to 0, or with an on-chip supporting module interrupt if acceptance of the relevant interrupt has been disabled by the interrupt enable register or masked by the CPU.

See section 23.6.3, Setting Oscillation Settling Time after Clearing Software Standby Mode, for the oscillation settling time setting when making a transition from watch mode to high-speed mode.

Clearing with the $\overline{\text{RES}}$ **Pin:** See "Clearing with the $\overline{\text{RES}}$ Pin" in section 23.6.2, Clearing Software Standby Mode.

Clearing with the $\overline{\text{STBY}}$ **Pin:** When the $\overline{\text{STBY}}$ pin is driven low, a transition is made to hardware standby mode.

23.9 Subsleep Mode

23.9.1 Subsleep Mode

If a SLEEP instruction is executed in subactive mode when the SSBY in SBYCR is cleared to 0, the LSON bit in LPWRCR is set to 1, and the PSS bit in TCSR (WDT1) is set to 1, the CPU makes a transition to subsleep mode.

In this mode, the CPU and all on-chip supporting modules except TMR0, TMR1, WDT0, and WDT1 stop. As long as the prescribed voltage is supplied, the contents of some of the CPU's internal registers and on-chip RAM are retained, and I/O ports retain their states prior to the transition.

23.9.2 Clearing Subsleep Mode

Subsleep mode is cleared by an interrupt (on-chip supporting module interrupt, NMI pin, or pin $\overline{IRQ0}$ to $\overline{IRQ7}$), or by means of the \overline{RES} pin or \overline{STBY} pin.

Clearing with an Interrupt: When an interrupt request signal is input, subsleep mode is cleared and interrupt exception handling is started. Subsleep mode cannot be cleared with an IRQ0 to IRQ7 interrupt if the corresponding enable bit has been cleared to 0, or with an on-chip supporting module interrupt if acceptance of the relevant interrupt has been disabled by the interrupt enable register or masked by the CPU.

Clearing with the $\overline{\text{RES}}$ **Pin:** See "Clearing with the $\overline{\text{RES}}$ Pin" in section 23.6.2, Clearing Software Standby Mode.

Clearing with the $\overline{\text{STBY}}$ **Pin:** When the $\overline{\text{STBY}}$ pin is driven low, a transition is made to hardware standby mode

23.10 Subactive Mode

23.10.1 Subactive Mode

If a SLEEP instruction is executed in high-speed mode when the SSBY bit in SBYCR, the DTON bit in LPWRCR, and the PSS bit in TCSR (WDT1) are all set to 1, the CPU makes a transition to subactive mode. When an interrupt is generated in watch mode, if the LSON bit in LPWRCR is set to 1, a transition is made to subactive mode. When an interrupt is generated in subsleep mode, a transition is made to subactive mode.

In subactive mode, the CPU performs sequential program execution at low speed on the subclock. In this mode, all on-chip supporting modules except TMR0, TMR1, WDT0, and WDT1 stop.

When operating the device in subactive mode, bits SCK2 to SCK0 in SBYCR must all be cleared to 0.

23.10.2 Clearing Subactive Mode

Subsleep mode is cleared by a SLEEP instruction, or by means of the $\overline{\text{RES}}$ pin or $\overline{\text{STBY}}$ pin.

Clearing with a SLEEP Instruction: When a SLEEP instruction is executed while the SSBY bit in SBYCR is set to 1, the DTON bit in LPWRCR is cleared to 0, and the PSS bit in TCSR (WDT1) is set to 1, subactive mode is cleared and a transition is made to watch mode. When a SLEEP instruction is executed while the SSBY bit in SBYCR is cleared to 0, the LSON bit in LPWRCR is set to 1, and the PSS bit in TCSR (WDT1) is set to 1, a transition is made to subsleep mode. When a SLEEP instruction is executed while the SSBY bit in SBYCR is cleared to 1, a transition is made to subsleep mode. When a SLEEP instruction is executed while the SSBY bit in SBYCR is set to 1, the DTON bit is set to 1 and the LSON bit is cleared to 0 in LPWRCR, and the PSS bit in TCSR (WDT1) is set to 1, a transition is made directly to high-speed mode.

Fort details of direct transition, see section 23.11, Direct Transition.

Clearing with the RES Pin: See "Clearing with the RES Pin" in section 23.6.2, Clearing Software Standby Mode.

Clearing with the $\overline{\text{STBY}}$ **Pin:** When the $\overline{\text{STBY}}$ pin is driven low, a transition is made to hardware standby mode

23.11 Direct Transition

23.11.1 Overview of Direct Transition

There are three operating modes in which the CPU executes programs: high-speed mode, medium-speed mode, and subactive mode. A transition between high-speed mode and subactive mode without halting the program is called a direct transition. A direct transition can be carried out by setting the DTON bit in LPWRCR to 1 and executing a SLEEP instruction. After the transition, direct transition interrupt exception handling is started.

Direct Transition from High-Speed Mode to Subactive Mode: If a SLEEP instruction is executed in high-speed mode while the SSBY bit in SBYCR, the LSON bit and DTON bit in LPWRCR, and the PSS bit in TSCR (WDT1) are all set to 1, a transition is made to subactive mode.

Direct Transition from Subactive Mode to High-Speed Mode: If a SLEEP instruction is executed in subactive mode while the SSBY bit in SBYCR is set to 1, the LSON bit is cleared to 0 and the DTON bit is set to 1 in LPWRCR, and the PSS bit in TSCR (WDT1) is set to 1, after the elapse of the time set in bits STS2 to STS0 in SBYCR, a transition is made to directly to high-speed mode.

Section 24 Electrical Characteristics

24.1 Absolute Maximum Ratings

Table 24.1 lists the absolute maximum ratings.

Table 24.1 Absolute Maximum Ratings

- Preliminary -

Item	Symbol	Value	Unit
Power supply voltage	V _{cc}	-0.3 to +7.0	V
Input voltage (except ports 6 and 7)		-0.3 to V_{cc} +0.3	V
Input voltage (CIN input not selected for port 6)	V_{in}	–0.3 to V_{cc} +0.3	V
Input voltage (CIN input selected for port 6)	V_{in}	Lower voltage of –0.3 to $V_{\rm cc}$ +0.3 and $AV_{\rm cc}$ +0.3	V
Input voltage (port 7)	V _{in}	–0.3 to AV _{cc} + 0.3	V
Analog power supply voltage	AV_{cc}	-0.3 to +7.0	V
Analog input voltage	V _{an}	–0.3 to AV _{cc} +0.3	V
Operating temperature	T_{opr}	Regular specifications: -20 to +75*	°C
		Wide-range specifications: -40 to +85*	°C
Operating temperature (flash memory programming/erasing)	T_{opr}	Regular specifications: 0 to +75	°C
		Wide-range specifications: 0 to +85	°C
Storage temperature	T_{stg}	-55 to +125	°C

Caution: Permanent damage to the chip may result if absolute maximum ratings are exceeded.

24.2 DC Characteristics

Table 24.2 lists the DC characteristics. Table 24.3 lists the permissible output currents.

Table 24.2DC Characteristics (1)- Preliminary -
Conditions: $V_{cc} = 5.0 \text{ V} \pm 10\%$, $AV_{cc}*^1 = 5.0 \text{ V} \pm 10\%$, $V_{ss} = AV_{ss}*^1 = 0 \text{ V}$, $T_a = -20 \text{ to } +75^{\circ}\text{C}*^9$ (regular specifications), $T_a = -40 \text{ to } +85^{\circ}\text{C}*^9$ (wide-range specifications)

ltem			Symbol	Min	Тур	Max	Unit	Test Conditions
Schmitt trigger input	$\frac{P67 \text{ to } P60^{*^2} *^6}{IRQ2} \text{ to } IRQ0^{*^3},$ IRQ5 to IRQ3	(1)	V_T	1.0	_	_	V	
voltage			V_{T}^{+}	_	_	$V_{cc} imes 0.7$	V	_
			$V_T^+ - V_T^-$	0.4	_	_	V	_
••	P67 to P60 (KWUL = 00)		V _T ⁻	1.0	_	_	V	H8S/2138 Series only
voltage (in level switching)* ⁶			V _T ⁺	_	_	$V_{cc} imes 0.7$	V	
Switching)*			$V_{\scriptscriptstyle T}{}^{\scriptscriptstyle +}-V_{\scriptscriptstyle T}{}^{\scriptscriptstyle -}$	0.4	_	_	V	_
	P67 to P60 (KWUL = 01)	V _T ⁻	$V_{cc} imes 0.3$	_	_	V	_	
			V _T ⁻ V _T ⁺	_		$V_{cc} imes 0.7$	V	_
			$V_{\scriptscriptstyle T}{}^{\scriptscriptstyle +}-V_{\scriptscriptstyle T}{}^{\scriptscriptstyle -}$	$V_{cc} imes 0.05$		_	V	_
	P67 to P60		V _T ⁻	$V_{cc} imes 0.4$	_	_	V	-
	(KWUL = 10)		V_{T}^{+}	_	—	$V_{cc} imes 0.8$	V	-
			$V_{T}^{+} - V_{T}^{-}$	$V_{cc} imes 0.03$	_	_	V	-
	P67 to P60 (KWUL = 11)		V_	$V_{cc} imes 0.45$	_	_	V	_
			V _T ⁺	_	_	$V_{cc} imes 0.9$	V	_
			$V_{\rm T}^{+}-V_{\rm T}^{-}$	0.05	_	_	V	_
Input high voltage	RES, STBY, NMI, MD1, MD0	(2)	$V_{\rm IH}$	$V_{cc} - 0.7$		V _{cc} +0.3	V	
	EXTAL			$V_{cc} imes 0.7$	_	V _{cc} +0.3	V	-
	Port 7			2.0	_	AV _{cc} +0.3	V	-
	Input pins except (1) and (2) above		_	2.0	_	V _{cc} +0.3	V	-

Table 24.2DC Characteristics (1) (cont)- Preliminary -
Preliminary -
Conditions: $V_{cc} = 5.0 \text{ V} \pm 10\%$, $AV_{cc}^{*1} = 5.0 \text{ V} \pm 10\%$, $V_{ss} = AV_{ss}^{*1} = 0 \text{ V}$, $T_a = -20 \text{ to } +75^{\circ}\text{C}^{*9}$ (regular specifications), $T_a = -40 \text{ to } +85^{\circ}\text{C}^{*9}$ (wide-range specifications)

Item		Symbol	Min	Тур	Мах	Unit	Test Conditions
Input low voltage	RES, STBY, (3) MD1, MD0	V _{IL}	-0.3	—	0.5	V	
	NMI, EXTAL, input pins except (1) and (3) above	_	-0.3	—	0.8	V	_
Output high voltage	All output pins (except P97, and P52* ⁴)* ⁵	V _{oh}	V _{cc} –0.5		_	V	I _{он} = –200 µА
			3.5	—	_	V	I _{он} = –1 mA
	P97, P52* ⁴		2.5		—	V	I _{он} = —1 mA
Output low	All output pins* ⁵	V _{oL}	_	—	0.4	V	I _{oL} = 1.6 mA
voltage	Ports 1 to 3		_	—	1.0	V	I _{oL} = 10 mA
Input leakage	RES	$\Omega I_{in} \Omega$	_		10.0	μA	$V_{in} = 0.5 \text{ to}$ $V_{cc} - 0.5 \text{ V}$
current	STBY, NMI, MD1, MD0	_	_	—	1.0	μA	_
	Port 7		_	—	1.0	μA	$V_{in} = 0.5 \text{ to}$ AV _{cc} - 0.5 V
Three-state leakage current (off state)	Ports 1 to 6 Ports 8, 9	$\Omega I_{_{TSI}} \Omega$	_	—	1.0	μA	V_{in} = 0.5 to V_{cc} – 0.5 V
Input pull-	Ports 1 to 3	$-I_{P}$	50	_	300	μA	$V_{in} = 0 V$
up MOS current	Port 6	_	60	_	500	μA	_
	Port 6 (P6PUE = 0)	_	60	—	500	μA	V _{in} = 0 V H8S/2138
	Port 6 (P6PUE = 1)		15		150	μA	Series only
Input capacitance	RES (4)	\mathbf{C}_{in}			80	pF	$V_{in} = 0 V$ f = 1 MHz
	NMI		_	_	50	pF	T _a = 25°C
	P52, P97, P42, P86		_	_	20	pF	
	Input pins except (4) above	_			15	pF	_

 $\begin{array}{ll} \mbox{Table 24.2} & DC \mbox{ Characteristics (1) (cont)} & -\mbox{ Preliminary } -\mbox{ Conditions:} V_{\rm CC} = 5.0 \ V \pm 10\%, \mbox{ AV}_{\rm CC}{}^{*1} = 5.0 \ V \pm 10\%, \ V_{\rm ss} = \mbox{ AV}_{\rm ss}{}^{*1} = 0 \ V, \ T_{\rm a} = -20 \ to \ +75^{\circ} \mbox{ C}^{*9} \ (regular \ specifications), \ T_{\rm a} = -40 \ to \ +85^{\circ} \mbox{ C}^{*9} \ (wide-range \ specifications) \ \end{array}$

Item		Symbol	Min	Тур	Max	Unit	Test Conditions
Current dissipation* ⁷	Normal operation I _{cc}	I _{cc}	_	75	100	mA	f = 20 MHz, H8S/2134 Series
				85	120	mA	f = 20 MHz, H8S/2138 Series
	Sleep mode		_	60	85	mA	f = 20 MHz, H8S/2134 Series
				70	100	mA	f = 20 MHz, H8S/2138 Series
	Standby mode*8		_	0.01	5.0	μA	$T_a \le 50^{\circ}C$
			_		20.0	μA	50°C < T _a
Analog power	During A/D, D/A conversion	AI_{cc}	_	3.2	7.0	mA	
supply current	Idle		_	0.01	5.0	μΑ	AV _{cc} = 2.0 V to 5.5 V
Analog power supply voltage*1		AV_{cc}	4.5	_	5.5	V	Operating
			2.0	_	5.5	V	Idle/not used
RAM standb	y voltage	V_{RAM}	2.0	_	_	V	

Notes: 1. Do not leave the AVCC, and AVSS pins open even if the A/D converter and D/A converter are not used.

Even if the A/D converter and D/A converter are not used, apply a value in the range 2.0 V to 5.5 V to AVCC by connection to the power supply (V_{cc}), or some other method.

2. P67 to P60 include supporting module inputs multiplexed on those pins.

3. IRQ2 includes the ADTRG signal multiplexed on that pin.

 In the H8S/2138 Series, P52/SCK0/SCL0 and P97/SDA0 are NMOS push-pull outputs. An external pull-up resistor is necessary to provide high-level output from SCL0 and SDA0 (ICE = 1). P52/SCK0 and P97 (ICE = 0) high levels are driven by NMOS.

5. In the H8S/2138 Series, When ICE = 0. Low-level output when the bus drive function is selected is determined separately.

 The upper limit of the port 6 applied voltage is V_{cc} + 0.3 V when CIN input is not selected, and the lower of V_{cc} + 0.3 V and AV_{cc} + 0.3 V when CIN input is selected. When a pin is in output mode, the output voltage is equivalent to the applied voltage.

7. Current dissipation values are for V_{IH} min = V_{cc} - 0.5 V and V_{IL} max = 0.5 V with all output pins unloaded and the on-chip pull-up MOSs in the off state.

8. The values are for V_{_{RAM}} \le V_{_{CC}} < 4.5 V, V_{_{IH}} min = V_{_{CC}} \times 0.9, and V_{_{IL}} max = 0.3 V.

For flash memory program/erase operations, the applicable range is T_a = 0 to +75°C (regular specifications) or T_a = 0 to +85°C (wide-range specifications).

$\begin{array}{ll} \mbox{Table 24.2} & DC \mbox{ Characteristics (2)} & - \mbox{ Preliminary } - \mbox{ Conditions:} V_{\rm CC} = 4.0 \ V \ to \ 5.5 \ V^{*7}, \mbox{ AV}_{\rm CC} ^{*1} = 4.0 \ V \ to \ 5.5 \ V, \ V_{\rm ss} = \mbox{ AV}_{\rm ss} ^{*1} = 0 \ V, \\ T_{a} = -20 \ to \ +75^{\circ} \mbox{ C}^{*7} \ (regular \ specifications), \ T_{a} = -40 \ to \ +85^{\circ} \mbox{ C}^{*7} \ (wide-range \ specifications) \end{array}$

ltem			Symbol	Min	Тур	Max	Unit	Test Conditions
Schmitt trigger input	$\frac{P67 \text{ to } P60^{*^2} *^6}{IRQ2} \text{ to } \overline{IRQ0}^{*^3},$	(1)	V _T	1.0	—	_	V	V _{cc} = 4.5 V to 5.5 V
voltage	IRQ5 to IRQ3		V_{T}^{+}	_	_	$V_{cc} imes 0.7$	V	_
			$ \frac{V_{T}^{+} - V_{T}^{-}}{V_{T}^{+}} \\ \frac{V_{T}^{+}}{V_{T}^{+} - V_{T}^{-}} $	0.4	_	_	V	_
			V _T ⁻	0.8			V	V _{cc} < 4.5 V
			V_{T}^{+}	_	—	$V_{cc} imes 0.7$	V	_
			$V_{\rm T}^{^+}-V_{\rm T}^{^-}$	0.3	—	_	V	
Schmitt trigger input	P67 to P60 (KWUL = 00)		V _T ⁻	0.8	—	—	V	H8S/2138 Series only
voltage (in level			V_{T}^{*}	_	—	$V_{cc} imes 0.7$	V	V _{cc} = 4.0 V to 4.5 V
switching)*6			$V_{T}^{+} - V_{T}^{-}$	0.3		_	V	_
	P67 to P60		V_{T}^{-}	$V_{cc} imes 0.3$	—	_	V	
	(KWUL = 01)		V_{τ}^{+}	_	—	$V_{cc} imes 0.7$	V	
			$V_{\rm T}^{^+}-V_{\rm T}^{^-}$	$V_{cc} \times 0.05$		_	V	_
	P67 to P60		V	$V_{cc} \times 0.4$		_	V	_
	(KWUL = 10)		$\frac{V_{T}^{+} - V_{T}^{-}}{V_{T}^{-}}$	—	—	$V_{cc} imes 0.8$	V	
			$V_{\rm T}^{^+}-V_{\rm T}^{^-}$	$V_{cc} \times 0.03$	_	_	V	-
	P67 to P60	•	V _T ⁻	$V_{cc} \times 0.45$		_	V	_
	(KWUL = 11)		V_{T}^{+}	—	_	$V_{cc} imes 0.9$	V	_
			$V_T^+ - V_T^-$	0.05		_	V	
Input high voltage	RES, STBY, NMI, MD1, MD0	(2)	V _{IH}	$V_{cc} - 0.7$	_	V _{cc} +0.3	V	
	EXTAL			$V_{cc} \times 0.7$	—	V _{cc} +0.3	V	-
	Port 7	•		2.0		AV _{cc} +0.3	V	_
	Input pins except (1) and (2) above		_	2.0	_	V _{cc} +0.3	V	_
Input low voltage	RES, STBY, MD1, MD0	(3)	V	-0.3	_	0.5	V	
	NMI, EXTAL, input pins except (1) and (3) above			-0.3	_	0.8	V	

Table 24.2DC Characteristics (2) (cont)– Preliminary –Conditions: $V_{cc} = 4.0 \text{ V}$ to 5.5 V^{*7} , $AV_{cc}^{*1} = 4.0 \text{ V}$ to 5.5 V, $V_{ss} = AV_{ss}^{*1} = 0 \text{ V}$, $T_a = -20$ to $+75^{\circ}C^{*7}$ (regular specifications), $T_a = -40$ to $+85^{\circ}C^{*7}$ (wide-range specifications)

ltem		Symbol	Min	Тур	Max	Unit	Test Conditions
Output high voltage	All output pins (except P97, and	V _{OH}	V _{cc} –0.5			V	I _{oH} = -200 μA
	P52* ⁴)* ⁵		3.5	—	—	V	$I_{oH} = -1 \text{ mA},$ $V_{cc} =$ 4.5 V to 5.5 V
			3.0	—		V	$I_{_{OH}} = -1 \text{ mA},$ $V_{_{CC}} < 4.5 \text{ V}$
	P97, P52* ⁴	_	2.0	_	_	V	I _{он} = -1 mA
Output low	All output pins*5	V _{ol}	_	_	0.4	V	I _{oL} = 1.6 mA
voltage	Ports 1 to 3	_	_	_	1.0	V	I _{oL} = 10 mA
Input	RES	$\Omega I_{in} \Omega$	_	_	10.0	μA	$V_{in} = 0.5 \text{ to}$
leakage current	STBY, NMI, MD1, MD0	_	_	—	1.0	μA	⁻ V _{cc} – 0.5 V
	Port 7	_	_		1.0	μA	$V_{in} = 0.5 \text{ to}$ AV _{cc} - 0.5 V
Three-state leakage current (off state)	Ports 1 to 6 Ports 8, 9	$\Omega I_{_{TSI}} \Omega$	_	_	1.0	μA	V_{in} = 0.5 to V_{cc} - 0.5 V
Input pull- up MOS current	Ports 1 to 3	_P	50	—	300	μA	$V_{in} = 0 V,$ $V_{cc} = 4.5 V to 5.5 V$
	Port 6	_	60	—	500	μA	-
	Ports 1 to 3	_	30	_	200	μΑ	V _{in} = 0 V, V _{cc} < 4.5 V
	Port 6	_	40	—	400	μA	-
	Port 6 (P6PUE = 0)	_	60		500	μA	$V_{in} = 0 V,$ $V_{cc} = 4.5 V \text{ to } 5.5 V$
	Port 6 (P6PUE = 1)	_	15		150	μA	H8S/2138 Series only
	Port 6 (P6PUE = 0)	_	40	—	400	μA	$V_{in} = 0 V,$ $V_{cc} = 4.0 V \text{ to } 4.5 V$
	Port 6 (P6PUE = 1)	_	10	—	110	μA	H8S/2138 Series only

Table 24.2DC Characteristics (2) (cont)– Preliminary –Conditions: $V_{cc} = 4.0$ V to 5.5 V*7, AV_{cc} *1 = 4.0 V to 5.5 V, $V_{ss} = AV_{ss}$ *1 = 0 V, $T_a = -20$ to $+75^{\circ}C^{*7}$ (regular specifications), $T_a = -40$ to $+85^{\circ}C^{*7}$ (wide-range specifications)

Item			Symbol	Min	Тур	Max	Unit	Test Conditions
Input capacitance	RES	(4)	\mathbf{C}_{in}	—	—	80	pF	$V_{in} = 0 V,$ f = 1 MHz,
	NMI	_		_	_	50	pF	$T_a = 25^{\circ}C$
	P52, P97, P42, P86	-		_	_	20	pF	_
	Input pins except (4) above		_	—	—	15	pF	
Current dissipation*8	Normal operation		I _{cc}	_	65	85	mA	f = 16 MHz, H8S/2134 Series
				—	70	100	mA	f = 16 MHz, H8S/2138 Series
	Sleep mode		_	_	50	70	mA	f = 16 MHz, H8S/2134 Series
				—	60	85	mA	f = 16 MHz, H8S/2138 Series
	Standby mode*9		_	_	0.01	5.0	μA	$T_a \le 50^{\circ}C$
				—	—	20.0	μA	50°C < T _a
Analog power	During A/D, D/A conversion		AI_{cc}	—	3.2	7.0	mA	
supply current	Idle		_	_	0.01	5.0	μA	AV _{cc} = 2.0 V to 5.5 V
Analog power s	upply voltage*1		AV_{cc}	4.0	_	5.5	V	Operating
				2.0	_	5.5	V	Idle/not used
RAM standby vo	oltage		V_{RAM}	2.0	_	_	V	

Notes: 1. Do not leave the AVCC, and AVSS pins open even if the A/D converter and D/A converter are not used.

Even if the A/D converter and D/A converter are not used, apply a value in the range 2.0 V to 5.5 V to AVCC by connection to the power supply (V_{cc}), or some other method.

- 2. P67 to P60 include supporting module inputs multiplexed on those pins.
- 3. IRQ2 includes the ADTRG signal multiplexed on that pin.
- In the H8S/2138 Series, P52/SCK0/SCL0 and P97/SDA0 are NMOS push-pull outputs. An external pull-up resistor is necessary to provide high-level output from SCL0 and SDA0 (ICE = 1). P52/SCK0 and P97 (ICE = 0) high levels are driven by NMOS.
- 5. In the H8S/2138 Series, When ICE = 0. Low-level output when the bus drive function is selected is determined separately.
- 6. The upper limit of the port 6 applied voltage is V_{cc} + 0.3 V when CIN input is not selected, and the lower of V_{cc} + 0.3 V and AV_{cc} + 0.3 V when CIN input is selected. When a pin is in output mode, the output voltage is equivalent to the applied voltage.
- 7. Ranges of V_{cc} = 4.5 to 5.5 V, T_a = 0 to +75°C (regular specifications), and T_a = 0 to +85°C (wide-range specifications) must be observed for flash memory programming/erasing.
- 8. Current dissipation values are for V_µ min = V_{cc} 0.5 V and V_µ max = 0.5 V with all output pins unloaded and the on-chip pull-up MOSs in the off state.
- 9. The values are for V_{_{RAM}} \leq V_{_{CC}} < 4.5 V, V $_{_{IH}}$ min = V $_{_{CC}} \times 0.9,$ and V $_{_{IL}}$ max = 0.3 V.

Table 24.2	DC Characteristics (3)	– Preliminary –
	Conditions (Mask ROM vers	sion): $V_{cc} = 2.7 V$ to 5.5 V, $AV_{cc}^{*1} = 2.7 V$ to 5.5 V,
		$V_{ss} = AV_{ss}^{*1} = 0 V, T_{a} = -20 to +75^{\circ}C$
	(Flash memory version):	$V_{cc} = 3.0 V \text{ to } 5.5 V^{*7}, AV_{cc}^{*1} = 3.0 V \text{ to } 5.5 V,$
		$V_{ss} = AV_{ss}^{*1} = 0 V, T_a = -20 to +75^{\circ}C^{*7}$

Item			Symbol	Min	Тур	Мах	Unit	Test Conditions
	$\frac{P67 \text{ to } P60^{*^2} *^6}{IRQ2} \text{ to } \overline{IRQ0}^{*^3},$	(1)	V _T ⁻	$V_{cc} imes 0.2$	_	—	V	
voltage	IRQ5 to IRQ3		V_{T}^{+}	_	—	$V_{cc} imes 0.7$	V	_
			$V_{T}^{+} - V_{T}^{-}$	$V_{cc} \times 0.05$ $V_{cc} \times 0.2$		_	V	_
	P67 to P60 (KWUL = 00)	_	V _T ⁻	$V_{cc} imes 0.2$	_	_	V	H8S/2138 Series only
voltage (in level switching)* ⁶			V _T ⁺	_	—	$V_{cc} imes 0.7$	V	_
switching)*			$V_{\scriptscriptstyle T}{}^{\scriptscriptstyle +}-V_{\scriptscriptstyle T}{}^{\scriptscriptstyle -}$	$V_{cc} imes 0.05$	_	_	V	
	P67 to P60	-	V_	$V_{cc} imes 0.3$	_	_	V	_
	(KWUL = 01)		V_{T}^{+}	_	_	$V_{cc} imes 0.7$	V	_
			$V_{\scriptscriptstyle T}{}^{\scriptscriptstyle +}-V_{\scriptscriptstyle T}{}^{\scriptscriptstyle -}$	$V_{cc} imes 0.05$		_	V	_
	P67 to P60	-	V _T ⁻	$V_{cc} imes 0.4$	—	_	V	_
	(KWUL = 10)		V_{T}^{+}	_	—	$V_{cc} imes 0.8$	V	_
			$V_{T}^{+}-V_{T}^{-}$	$V_{cc} imes 0.03$	—	_	V	_
	P67 to P60	-	V_{T}^{-}	$V_{cc} imes 0.45$	_	_	V	_
	(KWUL = 11)		V _T ⁺	_	_	$V_{cc} imes 0.9$	V	_
			$V_{T}^{+}-V_{T}^{-}$	0.05	—	_	V	_
Input high voltage	RES, STBY, NMI, MD1, MD0	(2)	V _{IH}	$V_{cc} imes 0.9$	_	V _{cc} +0.3	V	
	EXTAL	-		$V_{cc} imes 0.7$	_	V _{cc} +0.3	V	_
	Port 7	-		$V_{cc} imes 0.7$	—	AV _{cc} +0.3	V	_
	Input pins except (1) and (2) above		_	$V_{cc} \times 0.7$	_	V _{cc} +0.3	V	_
Input low voltage	RES, STBY, MD1, MD0	(3)	V _{IL}	-0.3	_	$V_{cc} \times 0.1$	V	
	NMI, EXTAL, input pins except		_	-0.3	_	$V_{cc} \times 0.2$	V	V _{cc} < 4.0 V
	(1) and (3) above					0.8	V	V _{cc} = 4.0 V to 5.5 V

Table 24.2	DC Characteristics (3) (cont	t) – Preliminary –
	Conditions (Mask ROM ver	sion): $V_{cc} = 2.7 \text{ V}$ to 5.5 V, $AV_{cc}^{*1} = 2.7 \text{ V}$ to 5.5 V,
		$V_{ss} = AV_{ss}^{*1} = 0 V, T_a = -20 to +75^{\circ}C$
	(Flash memory version):	$V_{cc} = 3.0 \text{ V to } 5.5 \text{ V}^{*7}, \text{AV}_{cc}^{*1} = 3.0 \text{ V to } 5.5 \text{ V},$
		$V_{ss} = AV_{ss}^{*1} = 0 V, T_a = -20 to +75^{\circ}C^{*7}$

ltem		Symb	ol Min	Тур	Мах	Unit	Test Conditions
Output high voltage	All output pins (except P97, and	V _{oh}	$V_{cc} - 0.5$		_	V	I _{oH} = -200 μA
	P52* ⁴)* ⁵		V _{cc} - 1.0		_	V	I _{он} = –1 mA (V _{сс} < 4.0 V)
	P97, P52* ⁴		1.0	_		V	I _{он} = -1 mA
Output low	All output pins*5	V _{ol}	_	_	0.4	V	I _{oL} = 1.6mA
voltage	Ports 1 to 3		_		1.0	V	$\begin{split} I_{_{OL}} &= 5 \text{ mA} \\ (V_{_{CC}} < 4.0 \text{ V}), \\ I_{_{OL}} &= 10 \text{ mA} \\ (4.0 \text{ V} \leq V_{_{CC}} \leq 5.5 \text{ V}) \end{split}$
Input	RES	$\Omega I_{in} \Omega$	_		10.0	μΑ	$V_{in} = 0.5 \text{ to}$
leakage current	STBY, NMI, MD1 MD0	3	_	—	1.0	μA	⁻ V _{cc} – 0.5 V
	Port 7		_		1.0	μΑ	$V_{in} = 0.5 \text{ to}$ AV _{cc} - 0.5 V
Three-state leakage current (off state)	Ports 1 to 6 Ports 8, 9	$\Omega I_{TSI} \Omega$	—	_	1.0	μA	V_{in} = 0.5 to V_{cc} - 0.5 V
Input pull- up MOS	Ports 1 to 3	_P	10	—	150	μA	$V_{in} = 0 V,$ $V_{cc} = 2.7 V to$
current	Port 6		30	_	250	μΑ	-3.6 V
	Port 6 (P6PUE =	0)	30		250	μΑ	$V_{in} = 0 V,$ $V_{cc} = 2.7 V \text{ to } 3.6 V$
	Port 6 (P6PUE =	1)	3		70	μΑ	H8S/2138 Series only
Input capacitance	RES	(4) C _{in}	—		80	pF	$V_{in} = 0 V,$ f = 1 MHz,
	NMI		_	_	50	pF	$T_a = 25^{\circ}C$
	P52, P97, P42, P86		_		20	pF	-
	Input pins except (4) above		_		15	pF	-

Table 24.2	DC Characteristics (3) (cont)	– Preliminary –
	Conditions (Mask ROM versi	(on): $V_{cc} = 2.7 \text{ V to } 5.5 \text{ V}, \text{AV}_{cc}^{*^1} = 2.7 \text{ V to } 5.5 \text{ V},$
		$V_{ss} = AV_{ss}^{*1} = 0 V, T_a = -20 to +75^{\circ}C$
	(Flash memory version):	$V_{cc} = 3.0 \text{ V to } 5.5 \text{ V}^{*7}, \text{AV}_{cc}^{*1} = 3.0 \text{ V to } 5.5 \text{ V},$
		$V_{ss} = AV_{ss}^{*1} = 0 V, T_a = -20 \text{ to } +75^{\circ}C^{*7}$

ltem		Symbol	Min	Тур	Max	Unit	Test Conditions
Current dissipation* ⁸	Normal operation	I _{cc}	—	45	60	mA	f = 10 MHz, H8S/2134 Series
			_	50	70	mA	f = 10 MHz, H8S/2138 Series
	Sleep mode		—	35	50	mA	f = 10 MHz, H8S/2134 Series
			_	40	60	mA	f = 10 MHz, H8S/2138 Series
	Standby mode*9		_	0.01	5.0	μA	$T_a \le 50^{\circ}C$
			_		20.0	μA	50°C < T _a
Analog power	During A/D, D/A conversion	AI_{cc}	—	3.2	7.0	mA	
supply current	Idle		_	0.01	5.0	μA	AV _{cc} = 2.0 V to 5.5 V
Analog power supply voltage*1		AV_{cc}	2.7	_	5.5	V	Operating
			2.0		5.5	V	Idle/not used
RAM standb	y voltage	V_{RAM}	2.0	_	_	V	

Notes: 1. Do not leave the AVCC, and AVSS pins open even if the A/D converter and D/A converter are not used.

Even if the A/D converter and D/A converter are not used, apply a value in the range 2.0 V to 5.5 V to AVCC by connection to the power supply (V_{cc}), or some other method.

- 2. P67 to P60 include supporting module inputs multiplexed on those pins.
- 3. IRQ2 includes the ADTRG signal multiplexed on that pin.

 In the H8S/2138 Series, P52/SCK0/SCL0 and P97/SDA0 are NMOS push-pull outputs. An external pull-up resistor is necessary to provide high-level output from SCL0 and SDA0 (ICE = 1). P52/SCK0 and P97 (ICE = 0) high levels are driven by NMOS.

5. In the H8S/2138 Series, When ICE = 0. Low-level output when the bus drive function is selected is determined separately.

6. The upper limit of the port 6 applied voltage is V_{cc} + 0.3 V when CIN input is not selected, and the lower of V_{cc} + 0.3 V and AV_{cc} + 0.3 V when CIN input is selected. When a pin is in output mode, the output voltage is equivalent to the applied voltage.

- 7. For flash memory program/erase operations, the applicable ranges are V_{cc} = 3.0 V to 3.6 V, T_a = 0 to +75°C.
- 8. Current dissipation values are for V_{IH} min = V_{cc} 0.5 V and V_{IL} max = 0.5 V with all output pins unloaded and the on-chip pull-up MOSs in the off state.
- 9. The values are for V_{_{RAM}} \le V_{_{CC}} < 2.7 V, V_{_{IH}} min = V_{_{CC}} \times 0.9, and V_{_{IL}} max = 0.3 V.

650

– Preliminary –

Table 24.3Permissible Output Currents

Conditions: $V_{cc} = 4.0$ V to 5.5 V, $V_{ss} = 0$ V, Ta = -20 to +75°	C (regular
specifications), $T_a = -40$ to $+85^{\circ}C$ (wide-range specifications)	5)

Item		Symbol	Min	Тур	Max	Unit
Permissible output low current (per pin)	SCL1, SCL0, SDA1, SDA0	I _{ol}	—	_	20	mA
	Ports 1, 2, 3	_	_	_	10	mA
	Other output pins	_	_	_	2	mA
Permissible output	Total of ports 1, 2, and 3	$\Sigma {\rm I_{ol}}$	_	_	80	mA
low current (total)	Total of all output pins, including the above	-	—	_	120	mA
Permissible output high current (per pin)	All output pins	— І _{он}	—	_	2	mA
Permissible output high current (total)	Total of all output pins	$\Sigma - \mathbf{I}_{\rm OH}$	_	—	40	mA

Notes: 1. To protect chip reliability, do not exceed the output current values in table 24.3.

2. When driving a Darlington pair or LED, always insert a current-limiting resistor in the output line, as show in figures 24.1 and 24.2.

Table 24.3Permissible Output Currents (cont)– Preliminary –Conditions: $V_{cc} = 2.7$ V to 5.5 V, $V_{ss} = 0$ V, $T_a = -20$ to $+75^{\circ}$ C

Item		Symbol	Min	Тур	Max	Unit
Permissible output low current (per pin)	I _{ol}	_	_	10	mA	
	Ports 1, 2, 3	-			2	mA
	Other output pins	_	_	_	1	mA
Permissible output	Total of ports 1, 2, and 3	$\Sigma I_{\rm ol}$	_	_	40	mA
low current (total)	Total of all output pins, including the above	_	—	_	60	mA
Permissible output high current (per pin)	All output pins	— І _{он}	_	_	2	mA
Permissible output high current (total)	Total of all output pins	$\Sigma - I_{\rm OH}$	_	_	30	mA

Notes: 1. To protect chip reliability, do not exceed the output current values in table 24.3.

2. When driving a Darlington pair or LED, always insert a current-limiting resistor in the output line, as show in figures 24.1 and 24.2.

Table 24.4Bus Drive Characteristics- Preliminary -
Conditions:Conditions: $V_{cc} = 2.7$ V to 5.5 V, $V_{ss} = 0$ V, Ta = -20 to $+75^{\circ}$ C
Applicable Pins: SCL1, SCL0, SDA1, SDA0 (bus drive function selected)

Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Schmitt trigger input voltage	V _T ⁻	$V_{cc} imes 0.3$	_		V	V_{cc} = 2.7 V to 5.5 V
	V_{T}^{+}	_	_	$V_{cc} imes 0.7$	_	V_{cc} = 2.7 V to 5.5 V
	$V_{\rm T}^{^+}-V_{\rm T}^{^-}$	$V_{cc} imes 0.05$	_	_	_	V_{cc} = 2.7 V to 5.5 V
Input high voltage	V _{IH}	$V_{cc} imes 0.7$	_	V _{cc} + 0.5	V	V_{cc} = 2.7 V to 5.5 V
Input low voltage	V	-0.5	_	$V_{cc} imes 0.3$	_	V_{cc} = 2.7 V to 5.5 V
Output low voltage	V_{ol}	_	_	0.8	V	$I_{_{OL}} = 16 \text{ mA},$ $V_{_{CC}} = 4.5 \text{ V to } 5.5 \text{ V}$
		_	_	0.5	_	I _{oL} = 8 mA
		_	_	0.4	_	I _{oL} = 3 mA
Input capacitance	C_{in}	_	_	20	pF	$V_{in} = 0 V, f = 1 MHz,$ $T_a = 25^{\circ}C$
Three-state leakage current (off state)	e I _{tsi}	_	_	1.0	μA	V_{in} = 0.5 to V_{cc} – 0.5 V
SCL, SDA output fall time	t _{of}	20 + 0.1Cb	_	250	ns	V_{cc} = 2.7 V to 5.5 V

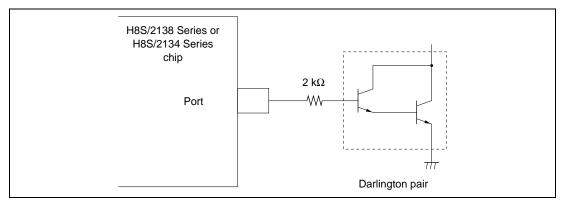


Figure 24.1 Darlington Pair Drive Circuit (Example)

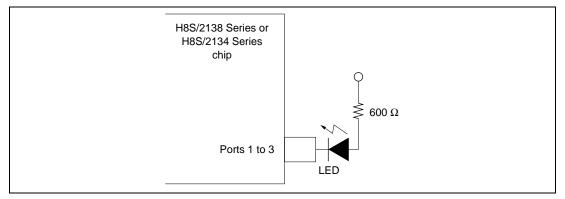


Figure 24.2 LED Drive Circuit (Example)

24.3 AC Characteristics

Figure 24.3 shows the test conditions for the AC characteristics.

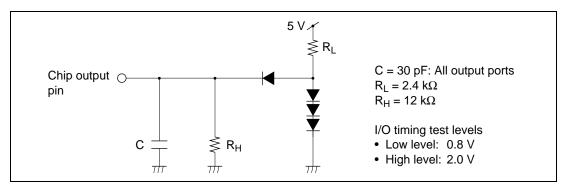


Figure 24.3 Output Load Circuit

24.3.1 Clock Timing

Table 24.5 shows the clock timing. The clock timing specified here covers clock (Ø) output and clock pulse generator (crystal) and external clock input (EXTAL pin) oscillation settling times. For details of external clock input (EXTAL pin and EXCL pin) timing, see section 22, Clock Pulse Generator.

Table 24.5Clock Timing

- Preliminary -

Condition A:V_{cc} = 5.0 V ± 10%, V_{ss} = 0 V, ϕ = 2 MHz to maximum operating frequency, T_a = -20 to +75°C (regular specifications),

 $T_a = -40$ to $+85^{\circ}C$ (wide-range specifications)

Condition B:V_{cc} = 4.0 V to 5.5V, V_{ss} = 0 V, \emptyset = 2 MHz to maximum operating frequency, T_a = -20 to +75°C (regular specifications),

 $T_a = -40$ to $+85^{\circ}C$ (wide-range specifications)

Condition C:V_{CC} = 2.7 V to 5.5V*, V_{ss} = 0 V, ϕ = 2 MHz to maximum operating frequency, T_a = -20 to +75°C

			Condition A 20 MHz		Condition B		Condition C 10 MHz		Test
ltem	Symbol	Min	Max	Min	Max	Min	Max	Unit	Conditions
Clock cycle time	t _{cyc}	50	500	62.5	500	100	500	ns	Figure 24.4
Clock high pulse width	t _{сн}	17	_	20	_	30	_	ns	Figure 24.4
Clock low pulse width	t _{cL}	17	—	20	_	30	—	ns	_
Clock rise time	t _{cr}	_	8	—	10	—	20	ns	
Clock fall time	t _{cf}	_	8	_	10	_	20	ns	
Oscillation settling time at reset (crystal)	t _{osc1}	10	_	10	_	20	_	ms	Figure 24.5 Figure 24.6
Oscillation settling time in software standby (crystal)	t _{osc2}	8	_	8	_	8	_	ms	_
External clock output stabilization delay time	t _{dext}	500	_	500	_	500	_	μs	_

Note: * For the low-voltage F-ZTAT version, V_{cc} = 3.0 V to 5.5 V.

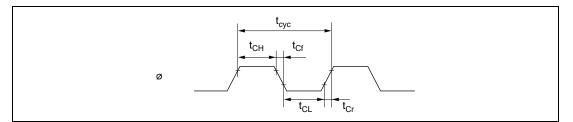


Figure 24.4 System Clock Timing

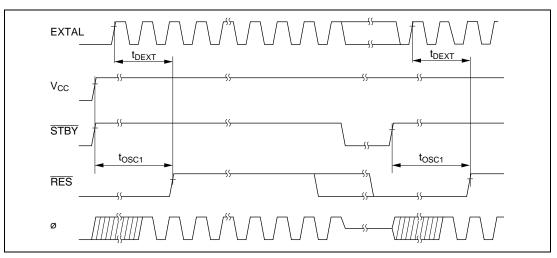


Figure 24.5 Oscillation Settling Timing

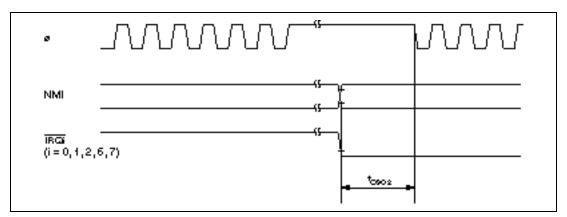


Figure 24.6 Oscillation Setting Timing (Exiting Software Standby Mode)

24.3.2 Control Signal Timing

Table 24.6 shows the control signal timing. The only external interrupts that can operate on the subclock ($\phi = 32.768$ kHz) are NMI and IRQ0, IRQ1, IRQ2, IRQ6, and IRQ7.

Table 24.6Control Signal Timing- Preliminary -Condition A:V_{cc} = 5.0 V ± 10%, V_{ss} = 0 V, Ø = 32.768 kHz, 2 MHz to maximum
operating frequency, T_a = -20 to +75°C (regular specifications),
T_a = -40 to +85°C (wide-range specifications)
Condition B:V_{cc} = 4.0 V to 5.5V, V_{ss} = 0 V, Ø = 32.768 kHz, 2 MHz to
maximum operating frequency, T_a = -20 to +75°C (regular specifications),
T_a = -40 to +85°C (wide-range specifications)
Condition C:V_{cc} = 2.7 V to 5.5V*, V_{ss} = 0 V, Ø = 32.768 kHz, 2 MHz to
maximum operating frequency, T_a = -20 to +75°C

		Condition A		Cond	Condition B		Condition C		
		20	MHz	16	MHz	10	MHz		Test
ltem	Symbol	Min	Max	Min	Max	Min	Max	Unit	Conditions
RES setup time	t _{ress}	200	_	200	_	300	_	ns	Figure 24.7
RES pulse width	t _{resw}	20	_	20	_	20	_	t _{cyc}	_
NMI setup time (NMI)	t _{nmis}	150	_	150	_	250	_	ns	Figure 24.8
NMI hold time (NMI)	t _{nmih}	10	_	10	_	10	_		
NMI pulse width (exiting software standby mode)	t _{nmiw}	200	_	200	_	200	_	ns	_
IRQ setup time (IRQ7 to IRQ0)	t _{iros}	150	—	150	—	250	—	ns	_
IRQ hold time (IRQ7 to IRQ0)	t _{irqh}	10	_	10	_	10	_	ns	_
IRQ pulse width (IRQ7, IRQ6, IRQ2 to IRQ0) (exiting software standby mode)	t _{iRQW}	200	_	200		200		ns	_

Note: *For the low-voltage F-ZTAT version, V_{cc} = 3.0 V to 5.5 V.

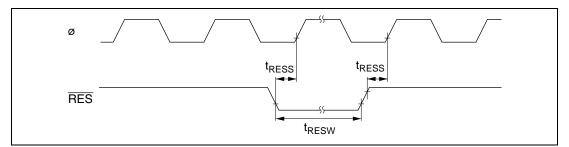


Figure 24.7 Reset Input Timing

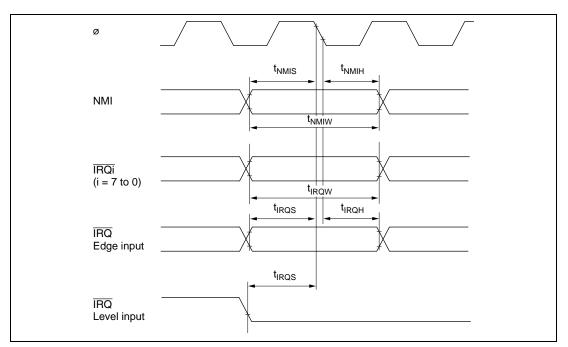


Figure 24.8 Interrupt Input Timing

24.3.3 Bus Timing

Table 24.7 shows the bus timing. Operation in external expansion mode is not guaranteed when operating on the subclock ($\phi = 32.768$ kHz).

Table 24.7 Bus Timing

- Preliminary -

Condition A:V_{cc} = 5.0 V ± 10%, V_{ss} = 0 V, \emptyset = 2 MHz to maximum operating frequency,T_a = -20 to +75°C (regular specifications), T_a = -40 to +85°C (wide-range specifications) Condition B:V_{cc} = 4.0 V to 5.5V, V_{ss} = 0 V, \emptyset = 2 MHz to maximum operating

frequency, $T_a = -20$ to $+75^{\circ}C$ (regular specifications),

 $T_a = -40$ to $+85^{\circ}C$ (wide-range specifications)

Condition C:V_{cc} = 2.7 V to 5.5V*, V_{ss} = 0 V, ϕ = 2 MHz to maximum operating frequency,T_a = -20 to +75°C

		Cond	ition A	Cond	lition B	Cond	ition C			
		20 MHz		16 MHz		10	MHz		Test	
ltem	Symbol	Min	Max	Min	Мах	Min	Мах	Unit	Conditions	
Address delay time	t _{AD}	—	20	—	30	—	40	ns	Figure 24.9 to	
Address setup time	t _{AS}	0.5 × t _{cyc} – 15		0.5 × t _{cyc} – 20		$0.5 \times t_{_{cyc}} - 30$	_	ns	figure 24.13	
Address hold time	t _{AH}	0.5 × t _{cyc} – 10	_	0.5 × t _{cyc} – 15	_	$0.5 \times t_{_{cyc}} - 20$	_	ns	_	
CS delay time (IOS)	$t_{\rm CSD}$	_	20	_	30	_	40	ns	_	
AS delay time	\mathbf{t}_{ASD}	_	30	_	45	_	60	ns	_	
RD delay time 1	t _{RSD1}	_	30	_	45	_	60	ns	-	
RD delay time 2	$t_{_{RSD2}}$	_	30	—	45	—	60	ns	-	
Read data setup time	$\mathbf{t}_{_{\mathrm{RDS}}}$	15	—	20	_	35	_	ns	_	
Read data hold time	t _{RDH}	0	—	0	_	0	_	ns	_	
Read data access time 1	t _{ACC1}	—	1.0 × t _{cyc} – 30	—	1.0 × t _{cyc} – 40	_	$1.0 \times t_{cyc} - 60$	ns	_	
Read data access time 2	t _{ACC2}	_	$1.5 \times t_{_{cyc}} - 25$	_	1.5 × t _{cyc} – 35	_	$1.5 \times t_{_{cyc}} - 50$	ns	_	

Table 24.7Bus Timing (cont)

- Preliminary -

Condition A:V_{cc} = 5.0 V \pm 10%, V_{ss} = 0 V, \emptyset = 2 MHz to maximum operating frequency,T_a = -20 to +75°C (regular specifications),

 $T_a = -40$ to $+85^{\circ}C$ (wide-range specifications)

Condition B:V_{cc} = 4.0 V to 5.5V, V_{ss} = 0 V, \emptyset = 2 MHz to maximum operating frequency,T_a = -20 to +75°C (regular specifications),

 $T_a = -40$ to +85°C (wide-range specifications)

Condition C:V_{cc} = 2.7 V to 5.5V*, V_{ss} = 0 V, \emptyset = 2 MHz to maximum operating frequency,T_a = -20 to +75°C

		Condition A 20 MHz		Cond	lition B	Cond	ition C		
				16	MHz	10	MHz		Test
Item	Symbol	Min	Max	Min	Max	Min	Max	Unit	Conditions
Read data access time 3	t _{ACC3}	_	$2.0 imes t_{cyc} - 30$	_	$2.0 imes t_{_{cyc}} - 40$	_	$2.0 imes t_{ m cyc} - 60$	ns	Figure 24.9 to
Read data access time 4	t _{ACC4}	—	$2.5 \times t_{_{cyc}} - 25$	_	2.5 × t _{cyc} – 35	—	$2.5 imes t_{ m cyc} - 50$	ns	figure 24.13
Read data access time 5	t _{ACC5}	—	$3.0 imes t_{_{cyc}} - 30$	—	$3.0 imes t_{_{cyc}} - 40$	—	$3.0 imes t_{ m cyc} - 60$	ns	
WR delay time 1	\mathbf{t}_{WRD1}	—	30	—	45	—	60	ns	_
WR delay time 2	$\mathbf{t}_{_{\mathrm{WRD2}}}$	—	30	_	45	_	60	ns	_
WR pulse width 1	t _{wsw1}	$1.0 \times t_{_{cyc}} - 20$	_	1.0 × t _{cyc} – 30	_	1.0× t _{cyc} – 40	_	ns	_
WR pulse width 2	t _{wsw2}	1.5 × t _{cyc} – 20	_	1.5 × t _{cyc} – 30	_	1.5 × t _{cyc} – 40	_	ns	_
Write data delay time	\mathbf{t}_{wdd}	—	30	—	45	—	60	ns	_
Write data setup time	\mathbf{t}_{WDS}	0	—	0	—	0	—	ns	
Write data hold time	\mathbf{t}_{WDH}	10	_	15	_	20	_	ns	
WAIT setup time	t _{wrs}	30		45		60		ns	_
WAIT hold time	t _{wth}	5	_	5	_	10	_	ns	_

Note: *For the low-voltage F-ZTAT version, V_{cc} = 3.0 V to 5.5 V.

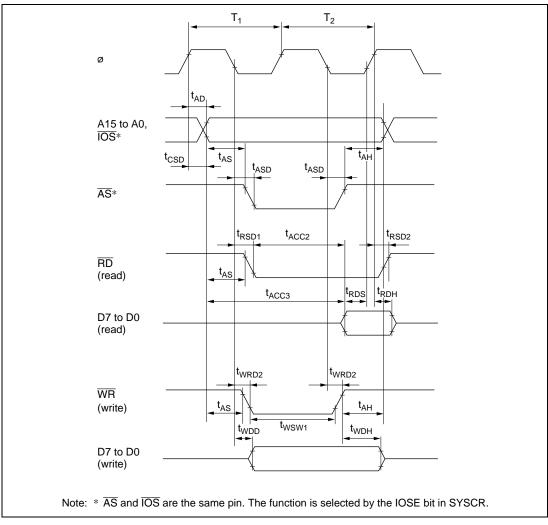


Figure 24.9 Basic Bus Timing (Two-State Access)

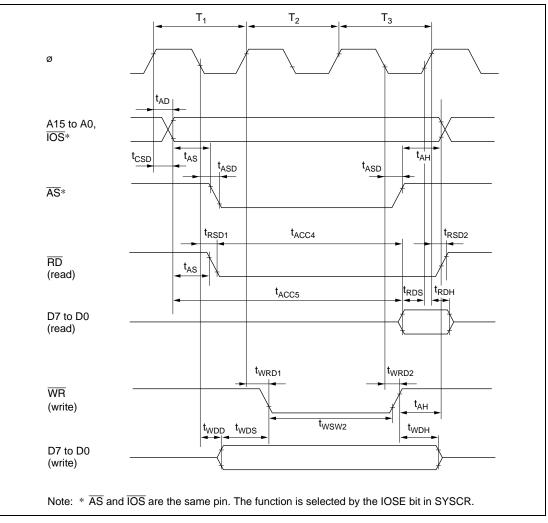


Figure 24.10 Basic Bus Timing (Three-State Access)

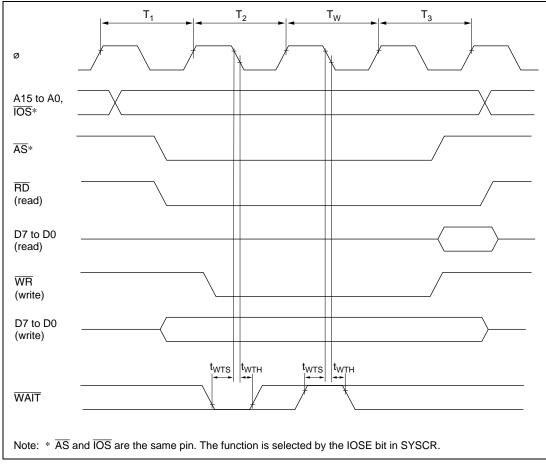


Figure 24.11 Basic Bus Timing (Three-State Access with One Wait State)

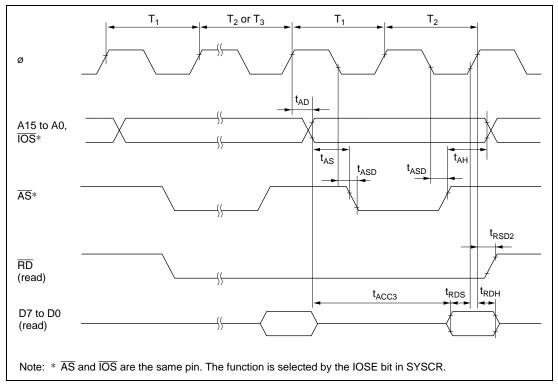


Figure 24.12 Burst ROM Access Timing (Two-State Access)

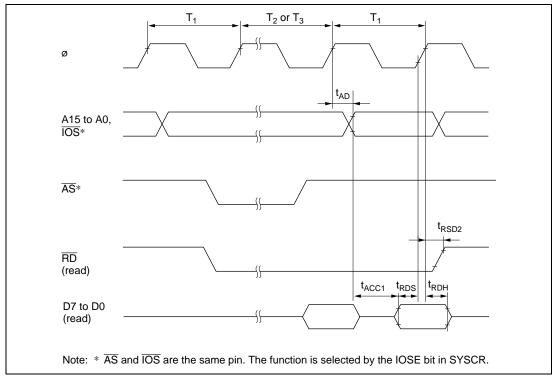


Figure 24.13 Burst ROM Access Timing (One-State Access)

24.3.4 Timing of On-Chip Supporting Modules

Tables 24.8 and 24.9 show the on-chip supporting module timing. The only on-chip supporting modules that can operate in subclock operation ($\phi = 32.768$ kHz) are the I/O ports, external interrupts (NMI and IRQ0, 1, 2, 6, and 7), the watchdog timer, and the 8-bit timer (channels 0 and 1).

Table 24.8Timing of On-Chip Supporting Modules (1)- Preliminary -
Condition A:V_{cc} = 5.0 V ± 10%, V_{ss} = 0 V, ø = 32.768 kHz*¹, 2 MHz to
maximum operating frequency, T_a = -20 to +75°C (regular specifications),
T_a = -40 to +85°C (wide-range specifications)
Condition B:V_{cc} = 4.0 V to 5.5V, V_{ss} = 0 V, ø = 32.768 kHz*¹, 2 MHz to
maximum operating frequency, T_a = -20 to +75°C (regular specifications),
T_a = -40 to +85°C (wide-range specifications)
Condition C:V_{cc} = 2.7 V to 5.5V*², V_{ss} = 0 V, ø = 32.768 kHz*¹, 2 MHz to
maximum operating frequency, T_a = -20 to +75°C

				Cond	aition A	Cond	aition B	Cond	lition C		
				20	MHz	16	MHz	10	MHz		Test
ltem			Symbol	Min	Max	Min	Max	Min	Max	Unit	Conditions
I/O ports	Output data dela time		t _{PWD}	_	50	—	50	_	100	ns	Figure 24.14
	Input data setup time		t _{PRS}	30	_	30	_	50	_		
	Input dat time	a hold	t _{PRH}	30	_	30	_	50	_		
FRT	Timer ou time	itput delay	/ t _{FTOD}	—	50	—	50	—	100	ns	Figure 24.15
	Timer inp time	out setup	t _{FTIS}	30	—	30	—	50	—		
	Timer clock input setup time		t _{FTCS}	30	_	30	_	50	—		Figure 24.16
	Timer clock	Single edge	t _{FTCWH}	1.5	_	1.5	_	1.5	_	t _{cyc}	_
pulse width		Both edges	$\mathbf{t}_{\text{FTCWL}}$	2.5	_	2.5	_	2.5	_		

Condition A Condition B Condition C

Table 24.8Timing of On-Chip Supporting Modules (1) (cont)- Preliminary -
Preliminary -
Condition A:V_{CC} = 5.0 V ± 10%, V_{ss} = 0 V, Ø = 32.768 kHz*¹, 2 MHz to
maximum operating frequency, $T_a = -20$ to $+75^{\circ}$ C (regular specifications),
 $T_a = -40$ to $+85^{\circ}$ C (wide-range specifications)
Condition B:V_{CC} = 4.0 V to 5.5V, $V_{ss} = 0$ V, Ø = 32.768 kHz*¹, 2 MHz to
maximum operating frequency, $T_a = -20$ to $+75^{\circ}$ C (regular specifications),
 $T_a = -40$ to $+85^{\circ}$ C (wide-range specifications)
Condition C:V_{CC} = 2.7 V to $5.5V^{*2}$, $V_{ss} = 0$ V, Ø = 32.768 kHz*¹, 2 MHz to
maximum operating frequency, $T_a = -20$ to $+75^{\circ}$ C

				Condition A		Condition B		Condition C			
				20 MHz		16 MHz		10 MHz			Test
ltem			Symbol	Min	Max	Min	Max	Min	Max	Unit	Conditions
TMR	Timer output delay time		t _{tmod}	_	50	—	50	_	100	ns	Figure 24.17
	Timer reset input setup time		\mathbf{t}_{TMRS}	30	—	30	—	50	_		Figure 24.19
	Timer clock input setup time		t _{TMCS}	30	_	30	_	50	_		Figure 24.18
	Timer clock pulse width	Single edge	t _{тмсwн}	1.5	_	1.5	_	1.5	_	t _{cyc}	_
		Both edges	t _{TMCWL}	2.5	_	2.5	_	2.5	_		
PWM, PWMX	Pulse output delay time		t _{PWOD}	_	50	_	50	_	100	ns	Figure 24.20
SCI	Input clock cycle	Asynchro- nous	t _{Scyc}	4	_	4	_	4	_	t _{cyc}	Figure 24.21
		Synchro- nous	_	6	_	6	_	6	_		
	Input clock pulse width		t _{sckw}	0.4	0.6	0.4	0.6	0.4	0.6	t _{scyc}	_
	Input clock rise time		t _{SCKr}	—	1.5	_	1.5	_	1.5	$\mathbf{t}_{_{\mathrm{cyc}}}$	-
	Input clock fall time		t _{sckf}	—	1.5	—	1.5	—	1.5		

Condition A Condition B Condition C

Table 24.8Timing of On-Chip Supporting Modules (1) (cont)– Preliminary –
Condition A:V_{cc} = 5.0 V ± 10%, V_{ss} = 0 V, Ø = 32.768 kHz*¹, 2 MHz to
maximum operating frequency, $T_a = -20$ to +75°C (regular specifications),
 $T_a = -40$ to +85°C (wide-range specifications)
Condition B:V_{cc} = 4.0 V to 5.5V, V_{ss} = 0 V, Ø = 32.768 kHz*¹, 2 MHz to
maximum operating frequency, $T_a = -20$ to +75°C (regular specifications),
 $T_a = -40$ to +85°C (wide-range specifications)
Condition C:V_{cc} = 2.7 V to 5.5V*², V_{ss} = 0 V, Ø = 32.768 kHz*¹, 2 MHz to
maximum operating frequency, $T_a = -20$ to +75°C

			Cone	dition A	Cone	dition B	Cond	dition C		
			20	MHz	16	MHz	10	MHz		Test
ltem		Symbol	Min	Max	Min	Max	Min	Max	Unit	Conditions
SCI	Transmit data delay time (synchronous)	t _{TXD}	_	50	_	50	_	100	ns	Figure 24.22
	Receive data setup time (synchronous)	t _{RXS}	50	_	50	_	100	_	ns	-
	Receive data hold time (synchronous)	t _{RXH}	50	_	50	_	100	_	ns	-
A/D converter	Trigger input setup time	$t_{\rm TRGS}$	30	_	30	_	50	_	ns	Figure 24.23

Notes: 1. Only supporting modules that can be used in subclock operation.

2. For the low-voltage F-ZTAT version, V $_{\rm cc}$ = 3.0 V to 5.5 V.

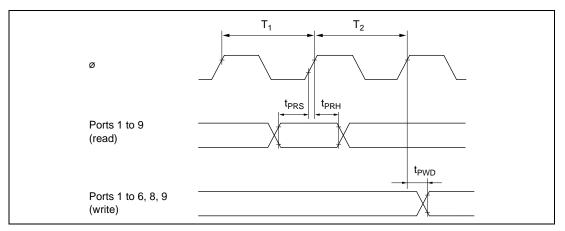


Figure 24.14 I/O Port Input/Output Timing

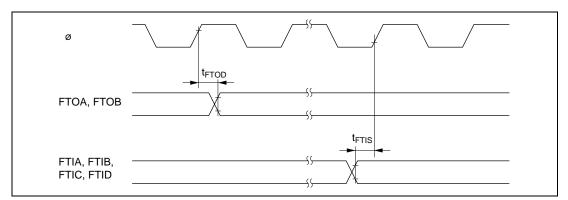


Figure 24.15 FRT Input/Output Timing

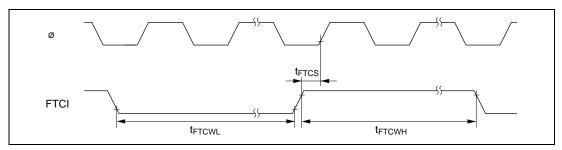


Figure 24.16 FRT Clock Input Timing

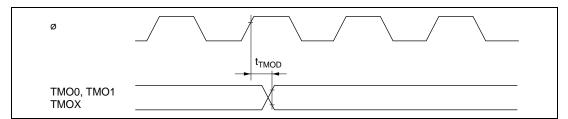


Figure 24.17 8-Bit Timer Output Timing

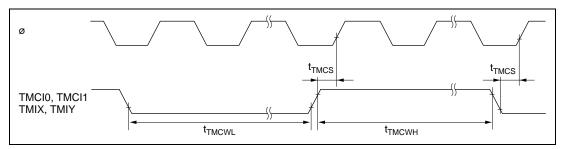


Figure 24.18 8-Bit Timer Clock Input Timing

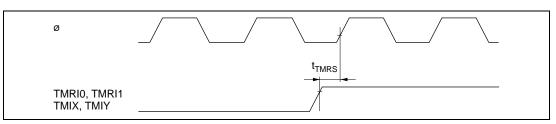


Figure 24.19 8-Bit Timer Reset Input Timing

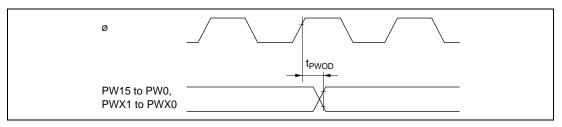


Figure 24.20 PWM, PWMX Output Timing

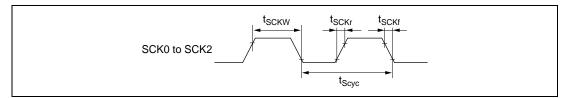


Figure 24.21 SCK Clock Input Timing

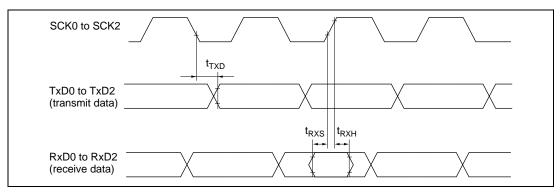


Figure 24.22 SCI Input/Output Timing (Synchronous Mode)

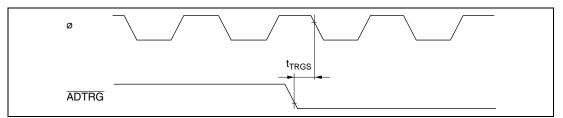


Figure 24.23 A/D Converter External Trigger Input Timing

Table 24.8Timing of On-Chip Supporting Modules (2)– Preliminary –
Condition A: $V_{cc} = 5.0 V \pm 10\%$, $V_{ss} = 0 V$, $\emptyset = 2$ MHz to maximum operating
frequency, $T_a = -20$ to $+75^{\circ}C$ (regular specifications),
 $T_a = -40$ to $+85^{\circ}C$ (wide-range specifications)
Condition B: $V_{cc} = 4.0 V$ to 5.5V, $V_{ss} = 0 V$, $\emptyset = 2$ MHz to maximum operating
frequency, $T_a = -20$ to $+75^{\circ}C$ (regular specifications),
 $T_a = -40$ to $+85^{\circ}C$ (wide-range specifications)

Condition C:V_{CC} = 2.7 V to 5.5V*, V_{ss} = 0 V, ϕ = 2 MHz to maximum operating frequency, T_a = -20 to +75°C

				Cond	dition A	Cond	dition B	Cond	dition C		
				20	MHz	16	MHz	10	MHz		Test
Item			Symbol	Min	Max	Min	Max	Min	Max	Unit	Conditions
HIF read cycle	CS/HA	0 setup	$\mathbf{t}_{_{\mathrm{HAR}}}$	10	_	10	_	10	_	ns	Figure 24.24
	CS/HA	0 hold time	t _{HRA}	10	—	10	—	10	—	ns	_
	IOR pu	Ilse width	t _{HRPW}	120	—	120	—	220	—	ns	_
	HDB d	elay time	t _{HRD}	_	100	_	100	_	200	ns	_
	HDB h	old time	t _{HRF}	0	25	0	25	0	40	ns	_
	HIRQ o	delay time	t _{HIRQ}	_	120	_	120	_	200	ns	_
HIF write cycle	<u>C</u> S/HA item	0 setup	$\mathbf{t}_{\mathrm{HAW}}$	10	—	10	—	10	—	ns	_
	CS/HA	0 hold time	t _{HWA}	10	—	10	—	10	—	ns	
	IOW pr	ulse width	t _{HWPW}	60	—	60	—	100	—	ns	_
	HDB setup time	Fast A20 gate not used	t _{HDW}	30	_	30	_	50	_	ns	_
		Fast A20 gate used	-	45	_	55	_	85	_	ns	_
	HDB h	old time	t _{HWD}	15	—	15	—	25	—	ns	_
	GA20 (delay time	t _{HGA}	_	90	_	90	_	180	ns	_

 $\frac{\text{GA20 delay time}}{\text{Note: *For the low-voltage F-ZTAT version, V}_{\text{CC}} = 3.0 \text{ V to 5.5 V.}}$

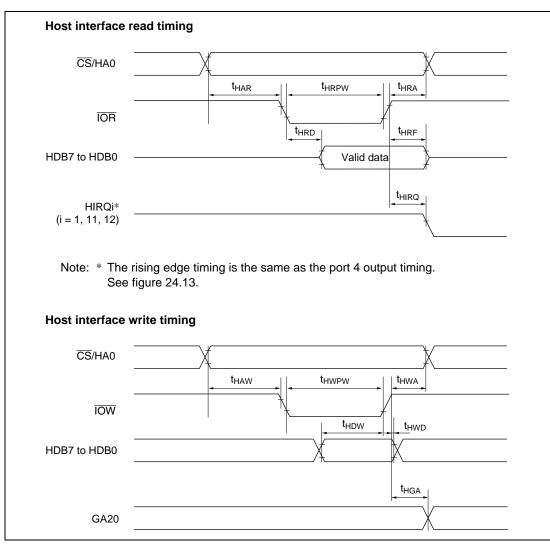


Figure 24.24 Host Interface Timing

Table 24.10 I²C Bus Timing

- Preliminary -

Conditions: $V_{cc} = 2.7$ V to 5.5 V, $V_{ss} = 0$ V, $\emptyset = 5$ MHz to maximum operating frequency, $T_a = -20$ to $+75^{\circ}C$

			Ratings				
Item	Symbol	Min	Тур	Max	Unit	Test Conditions	Notes
SCL clock cycle time	t _{scl}	12	—	_	t _{cyc}		Figure 24.25
SCL clock high pulse width	t _{sclh}	3	_	_	t _{cyc}		-
SCL clock low pulse width	t _{scll}	5	—	_	t _{cyc}		-
SCL, SDA input rise time	t _{sr}	_	—	7.5*	t _{cyc}		-
SCL, SDA input fall time	t _{sf}	_	—	300	ns		-
SCL, SDA input spike pulse elimination time	t _{sp}	_	_	1	t _{cyc}		-
SDA input bus free time	t _{BUF}	5	—	_	t _{cyc}		-
Start condition input hold time	t _{stah}	3	—	_	t _{cyc}		-
Retransmission start condition input setup time	t _{stas}	3	_	_	t _{cyc}		-
Stop condition input setup time	t _{stos}	3	_	_	t _{cyc}		-
Data input setup time	t_{sdas}	0.5	—	_	t _{cyc}		-
Data input hold time	t _{sdah}	0	—	_	ns		-
SCL, SDA capacitive load	C _b		_	400	pF		-

Note: *17.5t_{cyc} can be set according to the clock selected for use by the I²C module. For details, see section 16.4, Usage Notes.

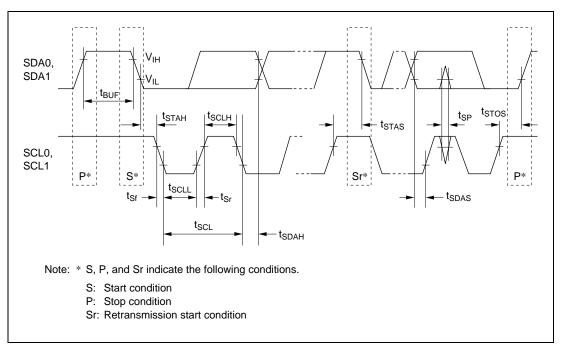


Figure 24.25 I²C Bus Interface Input/Output Timing (Option)

24.4 A/D Conversion Characteristics

Tables 24.10 and 24.11 list the A/D conversion characteristics.

Table 24.10 A/D Conversion Characteristics

 $\begin{array}{ll} (AN7 \ to \ AN0 \ Input: 134/266-State \ Conversion) & - \ Preliminary - Condition \ A:V_{\rm cc} = 5.0 \ V \pm 10\%, \ AV_{\rm cc} = 5.0 \ V \pm 10\%, \ V_{\rm ss} = AV_{\rm ss} = 0 \ V, \ \emptyset = 2 \\ MHz \ to \ maximum \ operating \ frequency, \ T_{\rm a} = -20 \ to +75^{\circ}C \ (regular \ specifications), \ T_{\rm a} = -40 \ to +85^{\circ}C \ (wide-range \ specifications) \\ Condition \ B:V_{\rm cc} = 4.0 \ V \ to \ 5.5 \ V, \ AV_{\rm cc} = 4.0 \ V \ to \ 5.5 \ V, \ S_{\rm ss} = AV_{\rm ss} = 0 \ V, \ \emptyset = 2 \\ MHz \ to \ maximum \ operating \ frequency, \ T_{\rm a} = -20 \ to +75^{\circ}C \ (regular \ specifications), \ T_{\rm a} = -40 \ to +85^{\circ}C \ (wide-range \ specifications) \\ Condition \ C:V_{\rm cc} = 2.7 \ V \ to \ 5.5 \ V^{*5}, \ AV_{\rm cc} = 2.7 \ V \ to \ 5.5 \ V^{*5}, \ V_{\rm ss} = AV_{\rm ss} = 0 \ V, \ \emptyset = 2 \\ MHz \ to \ maximum \ operating \ frequency, \ T_{\rm a} = -20 \ to +75^{\circ}C \\ \end{array}$

		Conditio	on A		Conditio	on B		Conditio	on C	
		20 MH	lz		16 MH	Iz		10 MH	Iz	-
Item	Min	Тур	Max	Min	Тур	Max	Min	Тур	Мах	Unit
Resolution	10	10	10	10	10	10	10	10	10	Bits
Conversion time	—	—	6.7	_	—	8.4	—	_	13.4	μs
Analog input capacitance	_	—	20	—	—	20	—	—	20	pF
Permissible signal- source	_	—	10* ³	—	—	10* ³	—	—	10* ¹	kΩ
impedance			5* ⁴	-		5 ^{*4}	-		5* ²	_
Nonlinearity error	—	—	±3.0		—	±3.0	_	—	±7.0	LSB
Offset error		—	±3.5		—	±3.5	—		±7.5	LSB
Full-scale error		—	±3.5		—	±3.5	_		±7.5	LSB
Quantization error		—	±0.5		—	±0.5			±0.5	LSB
Absolute accuracy	—	—	±4.0	_	—	±4.0	_	—	±8.0	LSB

Notes: 1. When 4.0 V \leq AV_{cc} \leq 5.5 V

2. When 2.7 V \leq AV $_{cc}$ < 4.0 V

3. When conversion time \geq 11. 17 μs (CKS = 1 and ø \leq 12 MHz, or CKS = 0)

4. When conversion time < 11. 17 μ s (CKS = 1 and \emptyset > 12 MHz)

5. For the low-voltage F-ZTAT version, V $_{\rm cc}$ = 3.0 V to 5.5 V and AV $_{\rm cc}$ = 3.0 V to 5.5 V.

Table 24.11 A/D Conversion Characteristics

 $\begin{array}{ll} ({\rm CIN7\ to\ CIN0\ Input:\ 134/266-State\ Conversion}) & -{\rm Preliminary} - {\rm Condition\ A:V_{\rm CC}} = 5.0\ V \pm 10\%,\ AV_{\rm cc} = 5.0\ V \pm 10\%,\ V_{\rm ss} = {\rm AV}_{\rm ss} = 0\ V,\ \emptyset = 2\\ {\rm MHz\ to\ maximum\ operating\ frequency,\ T_a} = -20\ to\ +75^\circ{\rm C\ (regular\ specifications)}\\ {\rm Condition\ B:V_{\rm cc}} = 4.0\ V\ to\ 5.5\ V,\ AV_{\rm cc} = 4.0\ V\ to\ 5.5\ V,\ V_{\rm ss} = {\rm AV}_{\rm ss} = 0\ V,\ \emptyset = 2\\ {\rm MHz\ to\ maximum\ operating\ frequency,\ T_a} = -20\ to\ +75^\circ{\rm C\ (regular\ specifications)}\\ {\rm Condition\ B:V_{\rm cc}} = 4.0\ V\ to\ 5.5\ V,\ AV_{\rm cc} = 4.0\ V\ to\ 5.5\ V,\ V_{\rm ss} = {\rm AV}_{\rm ss} = 0\ V,\ \emptyset = 2\\ {\rm MHz\ to\ maximum\ operating\ frequency,\ T_a} = -20\ to\ +75^\circ{\rm C\ (regular\ specifications)}\\ {\rm Condition\ C:V_{\rm cc}} = 2.7\ V\ to\ 5.5\ V^{*5},\ AV_{\rm ss} = {\rm AV}_{\rm ss} = 0\ V,\ \emptyset = 2\\ {\rm MHz\ to\ maximum\ operating\ frequency,\ T_a} = -20\ to\ +75^\circ{\rm C\ (regular\ specifications)}\\ {\rm Condition\ C:V_{\rm cc}} = 2.7\ V\ to\ 5.5\ V^{*5},\ AV_{\rm ss} = {\rm AV}_{\rm ss} = 0\ V,\ \emptyset = 2\\ {\rm MHz\ to\ maximum\ operating\ frequency,\ T_a} = -20\ to\ +75^\circ{\rm C\ (regular\ specifications)}\\ {\rm Condition\ C:V_{\rm cc}} = 2.7\ V\ to\ 5.5\ V^{*5},\ V_{\rm ss} = {\rm AV}_{\rm ss} = 0\ V,\ \emptyset = 2\\ {\rm MHz\ to\ maximum\ operating\ frequency,\ T_a} = -20\ to\ +75^\circ{\rm C\ (regular\ specifications)}\\ {\rm Condition\ C:V_{\rm cc}} = 2.7\ V\ to\ 5.5\ V^{*5},\ V_{\rm ss} = {\rm AV}_{\rm ss} = 0\ V,\ \emptyset = 2\\ {\rm MHz\ to\ maximum\ operating\ frequency,\ T_a} = -20\ to\ +75^\circ{\rm C\ specifications}\\ {\rm Condition\ C:V_{\rm cc}} = 2.7\ V\ to\ 5.5\ V^{*5},\ V_{\rm ss} = {\rm AV}_{\rm ss} = 0\ V,\ \emptyset = 2\\ {\rm MHz\ to\ maximum\ operating\ frequency,\ T_a} = -20\ to\ +75^\circ{\rm C\ specifications}\\ {\rm Condition\ C:V_{\rm cc}} = 2.7\ V\ to\ 5.5\ V^{*5},\ V_{\rm ss} = {\rm AV}_{\rm ss} = 0\ V,\ \emptyset = 2\\ {\rm AV}_{\rm ss} = 0\ V,\ \emptyset = 2\ V,\ V,\ V_{\rm ss} = 0\ V,\ V,\ V,\ V,\ V,\ V,\ V,\ V,\ V,$

		Conditio	on A		Conditio	on B		Conditio	on C	
		20 MH	İz		16 MH	z		10 MH	İz	-
ltem	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
Resolution	10	10	10	10	10	10	10	10	10	Bits
Conversion time		_	6.7	_	_	8.4	_		13.4	μs
Analog input capacitance	_	_	20	_	_	20	_	_	20	pF
Permissible signal- source	_	_	10* ³	—	_	10* ³	—	_	10 ^{*1}	kΩ
impedance			5* ⁴	-		5* ⁴	-		5* ²	•
Nonlinearity error			±5.0		—	±5.0		—	±11.0	LSB
Offset error		_	±5.5	—	_	±5.5	—	—	±11.5	LSB
Full-scale error	_	_	±5.5	_	_	±5.5	_	_	±11.5	LSB
Quantization error		—	±0.5	—	—	±0.5	_	—	±0.5	LSB
Absolute accuracy			±6.0	—		±6.0	—		±12.0	LSB

Notes: 1. When 4.0 V \leq AV $_{cc} \leq$ 5.5 V

2. When 2.7 V \leq AV_{cc} < 4.0 V

3. When conversion time \geq 11. 17 μs (CKS = 1 and ø \leq 12 MHz, or CKS = 0)

4. When conversion time < 11. 17 μ s (CKS = 1 and \emptyset > 12 MHz)

5. For the low-voltage F-ZTAT version, V $_{\rm cc}$ = 3.0 V to 5.5 V and AV $_{\rm cc}$ = 3.0 V to 5.5 V.

24.5 **D/A Conversion Characteristics**

Table 24.12 lists the D/A conversion characteristics.

Table 24.12 D/A Conversion Characteristics

- Preliminary -Condition A:V_{cc} = 5.0 V ± 10%, AV_{cc} = 5.0 V ± 10%, V_{ss} = AV_{ss} = 0 V, \emptyset = 2 MHz to maximum operating frequency, $T_a = -20$ to $+75^{\circ}C$ (regular specifications), $T_a = -40$ to $+85^{\circ}C$ (wide-range specifications) Condition B:V_{cc} = 4.0 V to 5.5 V, AV_{cc} = 4.0 V to 5.5 V, V_{ss} = AV_{ss} = 0 V, \emptyset = 2 MHz to maximum operating frequency, $T_a = -20$ to $+75^{\circ}C$ (regular specifications), $T_a = -40$ to $+85^{\circ}C$ (wide-range specifications) Condition C:V_{cc} = 2.7 V to 5.5 V*, AV_{cc} = 2.7 V to 5.5 V*, V_{ss} = AV_{ss} = 0 V, ϕ = 2 MHz to maximum operating frequency, $T_a = -20$ to $+75^{\circ}C$

		С	onditio	on A	C	onditio	on B	С	onditio	on C	
			20 Mł	Ηz	_	16 MH	Ιz	_	10 MH	Ιz	-
Item		Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
Resolution		8	8	8	8	8	8	8	8	8	Bits
Conversion time	With 20 pF load capacitance	_	_	10		_	10		_	10	μs
Absolute accuracy	With 2 MΩ load resistance	_	±1.0	±1.5	_	±1.0	±1.5	_	±2.0	±3.0	LSB
	With 4 MΩ load resistance	_	_	±1.0		_	±1.0	_		±2.0	-

Note: *For the low-voltage F-ZTAT version, V_{cc} = 3.0 V to 5.5 V and AV_{cc} = 3.0 V to 5.5 V.

24.6 Flash Memory Characteristics

Table 24.13 shows the flash memory characteristics.

Table 24.13 Flash Memory Characteristics	— Preliminary —
Conditions	(5-V version):
$V_{cc} = 5.0 V \pm 10\%, V_{ss} = 0 V, T_a = 0 \text{ to } +75^{\circ}\text{C}$ (reg	ular specifications), $T_a = 0$ to
+85°C (wide-range specifications)	
(Low-voltage version): $V_{cc} = 3.0$ V to 3.6 V, $V_{ss} =$	0 V, $T_a = 0$ to +75°C
(programming/erasing operating temperature)	

Item		Symbol	Min	Тур	Max	Unit	Test Condition
Programming	time* ^{1,*2,*4}	tP	_	10	200	ms/ 32 bytes	
Erase time*1,*	3, _* 5	tE	— 100		1200	ms/ block	
Reprogrammi	ng count	N_{wec}	_	_	100	Times	
Programming	Wait time after SWE-bit setting*1	x	10	—	—	μs	
	Wait time after PSU-bit setting ^{*1}	У	50	—	—	μs	
	Wait time after P-bit setting ^{*1, *4}	Z	150		200	μs	
	Wait time after P-bit clear* ¹	α	10	—	—	μs	
	Wait time after PSU-bit clear ^{*1}	β	10	—	—	μs	
	Wait time after PV-bit setting ^{*1}	γ	4	—	—	μs	
	Wait time after dummy write ^{*1}	ε	2	—	—	μs	
	Wait time after PV-bit clear ^{*1}	η	4	_	_	μs	
	Maximum programming count ^{*1,*4,*5}	Ν	_	_	1000	Times	tΡ = 200 μs

Table 24.13 Flash Memory Characteristics (cont)

— Preliminary —

 $\label{eq:conditions} \begin{array}{ll} (5\text{-V version})\mbox{:}\\ V_{\rm cc}\mbox{=} 5.0\ V \pm 10\%,\ V_{\rm ss}\mbox{=} 0\ V,\ T_{\rm a}\mbox{=} 0\ to\ +75^{\circ}\mbox{C}\ (regular\ specifications),\ T_{\rm a}\mbox{=} 0\ to\ +85^{\circ}\mbox{C}\ (wide-range\ specifications)\\ (Low-voltage\ version)\mbox{:} V_{\rm cc}\mbox{=} 3.0\ V\ to\ 3.6\ V,\ V_{\rm ss}\mbox{=} 0\ V,\ T_{\rm a}\mbox{=} 0\ to\ +75^{\circ}\mbox{C} \end{array}$

(programming/erasing operating temperature)

ltem		Symbol	Min	Тур	Мах	Unit	Test Condition
Erase	Wait time after SWE-bit setting ^{*1}	х	10		—	μs	
	Wait time after ESU-bit setting*1	У	200		—	μs	
	Wait time after E-bit setting* ^{1,} * ⁶	Z	5	—	10	ms	
	Wait time after E-bit clear ^{*1}	α	10	—	—	μs	
	Wait time after ESU-bit clear*1	β	10	—	—	μs	
	Wait time after EV-bit setting ^{*1}	γ	20	—	—	μs	
	Wait time after dummy write*1	8	2		—	μs	
	Wait time after EV-bit clear*1	η	5		—	μs	
	Maximum erase count ^{*1,*6,*7}	Ν	—	—	120	Times	tE = 10 ms

Notes: 1. Set the times according to the program/erase algorithms.

- Programming time per 32 bytes (Shows the total period for which the P-bit in the flash memory control register (FLMCR1) is set. It does not include the programming verification time.)
- 3. Block erase time (Shows the total period for which the E-bit in FLMCR1 is set. It does not include the erase verification time.)
- Maximum programming time (tP (max) = wait time after P-bit setting (z) × maximum programming count (N))
- 5. Number of times when the wait time after P-bit setting (z) = 200 μ s.
- The number of writes should be set according to the actual set value of z to allow programming within the maximum programming time (tP).
- Maximum erase time (tE (max) = Wait time after E-bit setting (z) × maximum erase count (N))
- Number of times when the wait time after E-bit setting (z) = 10 ms. The number of erases should be set according to the actual set value of z to allow erasing within the maximum erase time (tE).

24.7 Usage Note

The F-ZTAT and mask ROM versions have been confirmed as fully meeting the reference values for electrical characteristics shown in this manual. However, actual performance figures, operating margins, noise margins, and other properties may vary due to differences in the manufacturing process, on-chip ROM, layout patterns, etc.

When system evaluation testing is carried out using the F-ZTAT version, the same evaluation tests should also be conducted for the mask ROM version when changing over to that version.

Appendix A Instruction Set

A.1 Instruction

Operation Notation

Rd	General register (destination)*1
Rs	General register (source)*1
Rn	General register*1
ERn	General register (32-bit register)
MAC	Multiply-and-accumulate register (32-bit register)*2
(EAd)	Destination operand
(EAs)	Source operand
EXR	Extend register
CCR	Condition code register
N	N (negative) flag in CCR
Z	Z (zero) flag in CCR
V	V (overflow) flag in CCR
С	C (carry) flag in CCR
PC	Program counter
SP	Stack pointer
#IMM	Immediate data
disp	Displacement
+	Addition
_	Subtraction
×	Multiplication
÷	Division
^	Logical AND
V	Logical OR
\oplus	Exclusive logical OR
\rightarrow	Transfer from left-hand operand to right-hand operand, or transition from left- hand state to right-hand state
7	NOT (logical complement)
() < >	Operand contents
:8/:16/:24/:32	8-, 16-, 24-, or 32-bit length

Notes: 1. General registers include 8-bit registers (R0H to R7H, R0L to R7L), 16-bit registers (R0 to R7, E0 to E7), and 32-bit registers (ER0 to ER7).

2. MAC instructions cannot be used in the H8S/2138 Series and H8S/2134 Series.

Condition Code Notation

Symbol	Meaning
\$	Changes according operation result.
*	Indeterminate (value not guaranteed).
0	Always cleared to 0.
1	Always set to 1.
_	Not affected by operation result.

Table A.1Instruction Set

1. Data Transfer Instructions

			Ir			ssir on)		(Con	diti	on C	Cod	e	No Sta	. of tes
	Mnemonic	Size	xx#	Rn	@ERn	@(d,ERn)	@-ERn/@ERn+	@aa	@(d,PC)	@@aa	I	Operation	1	н	N	z	v	с	Normal	Advanced
MOV	MOV.B #xx:8,Rd	в	2									#xx:8→Rd8	-	-	\$	\$	0	-		1
	MOV.B Rs,Rd	В		2								Rs8→Rd8	-	—	\$	\$	0	_		1
	MOV.B @ERs,Rd	В			2							@ERs→Rd8	_	-	\$	\$	0	-	:	2
	MOV.B @(d:16,ERs),Rd	В				4						@(d:16,ERs)→Rd8	-	-	\$	\$	0	-	:	3
	MOV.B @(d:32,ERs),Rd	В				8						@(d:32,ERs)→Rd8	-	-	¢	\$	0	—		5
	MOV.B @ERs+,Rd	В					2					@ERs→Rd8,ERs32+1→ERs32	-	-	\$	\$	0	—	:	3
	MOV.B @aa:8,Rd	В						2				@aa:8→Rd8	-	-	\$	\$	0	-	:	2
	MOV.B @aa:16,Rd	В						4				@aa:16→Rd8	-	-	\$	\$	0	—	:	3
	MOV.B @aa:32,Rd	В						6				@aa:32→Rd8	-	-	\$	\$	0	—		4
	MOV.B Rs,@ERd	В			2							Rs8→@ERd		-	\$	\$	0 -		-	2
	MOV.B Rs,@(d:16,ERd)	В				4						Rs8→@(d:16,ERd)	_	-	\$	\$	0	-	:	3
	MOV.B Rs,@(d:32,ERd)	В				8						Rs8→@(d:32,ERd)	-	-	\$	\$	0	-		5
	MOV.B Rs,@-ERd	В					2					ERd32-1→ERd32,Rs8→@ERd	-	-	\$	\$	0	-	:	3
	MOV.B Rs,@aa:8	В						2				Rs8→@aa:8	-	-	\$	\$	0	-	:	2
	MOV.B Rs,@aa:16	В						4				Rs8→@aa:16	-	-	\$	\$	0	-	:	3
	MOV.B Rs,@aa:32	В						6				Rs8→@aa:32	-	-	\$	\$	0	-		4
	MOV.W #xx:16,Rd	w	4									#xx:16→Rd16	-	-	\$	\$	0	-		2
	MOV.W Rs,Rd	w		2								Rs16→Rd16	_	-	\$	\$	0	_		1
	MOV.W @ERs,Rd	w			2							@ERs→Rd16	_	-	\$	\$	0	-	:	2
	MOV.W @(d:16,ERs),Rd	w				4						@(d:16,ERs)→Rd16	-	-	\$	\$	0	-	:	3
	MOV.W @(d:32,ERs),Rd	w				8						@(d:32,ERs)→Rd16	-	-	\$	\$	0	-		5
	MOV.W @ERs+,Rd	w					2					@ERs \rightarrow Rd16,ERs32+2 \rightarrow ERs32	-	-	\$	\$	0	—	:	3
	MOV.W @aa:16,Rd	w						4				@aa:16→Rd16	-	-	\$	\$	0	—	:	3
	MOV.W @aa:32,Rd	w						6				@aa:32→Rd16	-	-	\$	\$	0	-		4
	MOV.W Rs,@ERd	w			2							Rs16→@ERd	-	-	\$	\$	0	-	:	2
	MOV.W Rs,@(d:16,ERd)	w				4						Rs16→@(d:16,ERd)	-	-	\$	\$	0	_	:	3
	MOV.W Rs,@(d:32,ERd)	w				8						Rs16→@(d:32,ERd)	-	-	\$	\$	0	_		5
	MOV.W Rs,@-ERd	w					2					ERd32-2→ERd32,Rs16→@ERd	-	-	\$	\$	0	-	:	3
	MOV.W Rs,@aa:16	w						4				Rs16→@aa:16	-	-	\$	\$	0	—	:	3
	MOV.W Rs,@aa:32	w						6				Rs16→@aa:32	-	-	\$	\$	0	_		4

Table A.1Instruction Set (cont)

1. Data Transfer Instructions

			Ir		dre: ucti								(Con	ditie	on C	Code	e	No. Stat	of tes ^{*1}
	Mnemonic	Size	xx#	Rn	@ERn	@(d,ERn)	@-ERn/@ERn+	@aa	@(d,PC)	@ @aa	1	Operation	1	н	N	z	v	с	Normal	Advanced
MOV	MOV.L #xx:32,ERd	L	6									#xx:32→Rd32	-	-	\$	¢	0	-	3	3
	MOV.L ERs,ERd	L		2								ERs32→ERd32	_	-	\$	\$	0	_	1	1
	MOV.L @ERs,ERd	L			4							@ERs→ERd32	_	-	\$	\$	0	_	4	1
	MOV.L @(d:16,ERs),ERd	L				6						@(d:16,ERs)→ERd32	-	-	\$	\$	0	_	Ę	5
	MOV.L @(d:32,ERs),ERd	L				10						@(d:32,ERs)→ERd32	_	-	\$	\$	0	_	7	7
	MOV.L @ERs+,ERd	L					4					@ERs \rightarrow ERd32,ERs32+4 \rightarrow ERs32	_	-	\$	\$	0	—	Ę	5
	MOV.L @aa:16,ERd	L						6				@aa:16→ERd32	-	-	\$	¢	0	_	Ę	5
	MOV.L @aa:32,ERd	L						8				@aa:32→ERd32	_	_	\$	¢	0	_	6	3
	MOV.L ERs,@ERd	L			4							ERs32→@ERd	_	-	\$	¢	0	_	4	4
	MOV.L ERs,@(d:16,ERd)	L				6						ERs32→@(d:16,ERd)	_	-	\$	\$	0	_	5	5
	MOV.L ERs,@(d:32,ERd)	L				10						ERs32→@(d:32,ERd)	_	-	\$	\$	0	_	7	7
	MOV.L ERs, @-ERd	L					4					ERd32-4→ERd32,ERs32→@ERd	_	_	\$	¢	0	_	5	5
	MOV.L ERs,@aa:16	L						6				ERs32→@aa:16	-	-	\$	¢	0	_	Ę	5
	MOV.L ERs,@aa:32	L						8				ERs32→@aa:32	-	_	\$	¢	0	_	6	3
POP	POP.W Rn	w									2	@SP→Rn16,SP+2→SP	-	_	\$	¢	0	_	3	3
	POP.L ERn	L									4	@SP→ERn32,SP+4→SP	-	-	\$	¢	0	_	5	5
PUSH	PUSH.W Rn	w									2	SP-2→SP,Rn16→@SP	_	-	\$	\$	0	_	3	3
	PUSH.L ERn	L									4	SP-4→SP,ERn32→@SP	-	_	\$	¢	0	_	5	5
LDM	LDM @SP+,(ERm-ERn)	L									4	(@SP→ERn32,SP+4→SP) Repeated for each restored register.	-	-	-	-	—	-	7/9/1	1 [1]
STM	STM (ERm-ERn),@-SP	L									4	(SP-4→SP,ERn32→@SP) Repeated for each saved register.	-	-	-	-	_	-	7/9/1	1 [1]
MOVFPE	MOVFPE @aa:16,Rd	Car	not	be	use	d wi	th th	ne H	18S/	213	8 S	eries and H8S/2134 Series.	-						[2	2]
MOVTPE	MOVTPE Rs,@aa:16																		[2	2]

Table A.1 Instruction Set (cont)

2. Arithmetic Instructions

			Ir						e ar (By)			Con	diti	on C	od	9		. of tes*1
	Mnemonic	Size	xx#	Rn	@ERn	@(d,ERn)	@-ERn/@ERn+	Qaa	@(d,PC)	@ @aa		Operation	1	н	N	z	v	с	Normal	Advanced
ADD	ADD.B #xx:8,Rd	В	2									Rd8+#xx:8→Rd8	-	\$	\$	\$	\$	\$		1
	ADD.B Rs,Rd	В		2								Rd8+Rs8→Rd8	-	\$	\$	\$	\$	↕		1
	ADD.W #xx:16,Rd	w	4									Rd16+#xx:16→Rd16	-	[3]	\$	\$	\$	\$:	2
	ADD.W Rs,Rd	W		2								Rd16+Rs16→Rd16	-	[3]	\$	\$	\$	\$		1
	ADD.L #xx:32,ERd	L	6									ERd32+#xx:32→ERd32	-	[4]	\$	\$	\$	€	:	3
	ADD.L ERs,ERd	L		2								ERd32+ERs32→ERd32	-	[4]	\$	\$	\$	€		1
ADDX	ADDX #xx:8,Rd	В	2									Rd8+#xx:8+C→Rd8	-	\$	\$	[5]	\$	\$		1
	ADDX Rs,Rd	В		2								Rd8+Rs8+C→Rd8	-	\$	\$	[5]	\$	\$		1
ADDS	ADDS #1,ERd	L		2								ERd32+1→ERd32	-	-	-	_	_	_		1
	ADDS #2,ERd	L		2								ERd32+2→ERd32	-	-	-	_	-			1
	ADDS #4,ERd	L		2								ERd32+4→ERd32	-	-	-	_	_			1
INC	INC.B Rd	В		2								Rd8+1→Rd8	-	-	\$	\$	\$	_		1
	INC.W #1,Rd	w		2								Rd16+1→Rd16	-	-	\$	\$	\$	_		1
	INC.W #2,Rd	w		2								Rd16+2→Rd16	-	-	\$	\$	\$	_		1
	INC.L #1,ERd	L		2								ERd32+1→ERd32	-	-	\$	\$	\$			1
	INC.L #2,ERd	L		2								ERd32+2→ERd32	-	-	\$	\$	\$	_		1
DAA	DAA Rd	В		2								Rd8 decimal adjust →Rd8	-	*	\$	\$	*	↕		1
SUB	SUB.B Rs,Rd	В		2								Rd8-Rs8→Rd8	1-	\$	\$	\$	\$	\$		1
	SUB.W #xx:16,Rd	w	4									Rd16-#xx:16→Rd16	-	[3]	\$	\$	\$	\$:	2
	SUB.W Rs,Rd	w		2								Rd16-Rs16→Rd16	-	[3]	\$	\$	\$	\$		1
	SUB.L #xx:32,ERd	L	6									ERd32-#xx:32→ERd32	-	[4]	\$	\$	\$	\$:	3
	SUB.L ERs,ERd	L		2								ERd32-ERs32→ERd32	-	[4]	\$	\$	\$	\$		1
SUBX	SUBX #xx:8,Rd	В	2									Rd8-#xx:8-C→Rd8	-	\$	\$	[5]	\$	\$		1
	SUBX Rs,Rd	В		2								Rd8-Rs8-C→Rd8	-	\$	\$	[5]	\$	\$		1
SUBS	SUBS #1,ERd	L		2							1	ERd32-1→ERd32	1-	1-	-	-	-	_		1
	SUBS #2,ERd	L		2								ERd32-2→ERd32	_	_	-	-	_	_		1
	SUBS #4,ERd	L		2							1	ERd32-4→ERd32	_	_	_	-	_	_		1
DEC	DEC.B Rd	В		2								Rd8-1→Rd8	_	_	\$	\$	\$	_		1
	DEC.W #1,Rd	w		2							1	Rd16-1→Rd16	1-	1-	\$	\$	\$	_		1
	DEC.W #2,Rd	w		2							1	Rd16-2→Rd16	1-	1-	\$	\$	\$	_		1
	DEC.L #1,ERd	L		2								ERd32-1→ERd32	_	_	\$	\$	\$	_		1
	DEC.L #2,ERd	L		2							1	ERd32-2→ERd32	-	1_	¢	\$	\$	_		1

Table A.1Instruction Set (cont)

2. Arithmetic Instructions

						ssir ion l)		(Con	ditio	on C	ode	÷		. of tes ^{*1}
	Mnemonic	Size	xx#	Rn	@ERn	@(d,ERn)	@-ERn/@ERn+	@aa	@(d,PC)	@ @aa		Operation	1	н	N	z	v	с	Normal	Advanced
DAS	DAS Rd	В		2								Rd8 decimal adjust →Rd8	-	*	\$	\$	*	_		1
MULXU	MULXU.B Rs,Rd	В		2								Rd8×Rs8→Rd16 (unsigned multiplication)	-	-	-	-	_	—	1	2
	MULXU.W Rs,ERd	w		2								Rd16×Rs16→ERd32 (unsigned multiplication)	-	_	_	_	_	_	2	:0
MULXS	MULXS.B Rs,Rd	В		4								Rd8×Rs8→Rd16 (signed multiplication)	-	-	\$	\$	_		1	3
	MULXS.W Rs,ERd	w		4								Rd16×Rs16→ERd32 (signed multiplication)	-	-	\$	¢	—	_	2	1
DIVXU	DIVXU.B Rs,Rd	В		2								Rd16+Rs8→Rd16 (RdH: remainder, RdL: quotient) (unsigned division)	-	-	[6]	[7]	_	_	1	2
	DIVXU.W Rs,ERd	W		2								ERd32÷Rs16→ERd32 (Ed: remainder, Rd: quotient) (unsigned division)	-	-	[6]	[7]	-	_	2	:0
DIVXS	DIVXS.B Rs,Rd	В		4								Rd16÷Rs8→Rd16 (RdH: remainder, RdL: quotient) (signed division)	-	-	[8]	[7]	_	_	1	3
	DIVXS.W Rs,ERd	w		4								ERd32÷Rs16→ERd32 (Ed: remainder, Rd: quotient) (signed division)	-	-	[8]	[7]	_		2	1
CMP	CMP.B #xx:8,Rd	В	2									Rd8-#xx:8	-	\$	\$	\$	\$	¢		1
	CMP.B Rs,Rd	В		2								Rd8-Rs8	—	¢	\$	\$	\$	\$		1
	CMP.W #xx:16,Rd	W	4									Rd16-#xx:16	—	[3]	\$	\$	\$	\$		2
	CMP.W Rs,Rd	W		2								Rd16-Rs16	-	[3]	\$	\$	\$	\$		1
	CMP.L #xx:32,ERd	L	6									ERd32-#xx:32	-	[4]	\$	\$	\$	\$;	3
	CMP.L ERs,ERd	L		2								ERd32-ERs32	-	[4]	\$	\$	\$	\$		1
NEG	NEG.B Rd	В		2								0-Rd8→Rd8	-	\$	\$	\$	\$	¢		1
	NEG.W Rd	W		2								0-Rd16→Rd16	-	\$	\$	\$	\$	\$		1
	NEG.L ERd	L		2								0-ERd32→ERd32	-	\$	\$	\$	≎	\$		1
EXTU	EXTU.W Rd	W		2								$0 \rightarrow$ (<bits 5="" 8="" to=""> of Rd16)</bits>	-	-	0	\$	0	_		1
	EXTU.L ERd	L		2								$0 \rightarrow$ (<bits 16="" 31="" to=""> of ERd32)</bits>	-	-	0	¢	0	_		1
EXTS	EXTS.W Rd	W		2								(<bit 7=""> of Rd16) → (<bits 15="" 8="" to=""> of Rd16)</bits></bit>	-	-	\$	\$	0	_		1
	EXTS.L ERd	L		2								(<bit 15=""> of ERd32) \rightarrow (<bits 16="" 31="" to=""> of ERd32)</bits></bit>	-	-	\$	\$	0	—		1
TAS	TAS @ERd	В			4							$\begin{array}{l} ERd-0 \to CCR \; set, (1) \to \\ (<\!bit \; 7\!> of @ ERd) \end{array}$	-	-	\$	\$	0	_		4

Table A.1Instruction Set (cont)

2. Arithmetic Instructions

					dre: ucti		-)		c	Con	ditio	on C	od	e	No. Stat	of tes ^{*1}
	Mnemonic	Size	XX#	Rn	@ERn	@(d,ERn)	@-ERn/@ERn+	@aa	@(d,PC)	@ @ aa		Operation	I	н	N	z	v	с	Normal	Advanced
MAC	MAC @ERn+,@ERm+	Car	nnot	be	used	d wi	th th	ne H	8S/:	213	88 S	eries and H8S/2134 Series.							[2	2]
CLRMAC	CLRMAC																			
LDMAC	LDMAC ERs,MACH																			
	LDMAC ERs,MACL																			
STMAC	STMAC MACH,ERd	1																		
	STMAC MACL,ERd	1																		

Table A.1 Instruction Set (cont)

3. Logic Instructions

			In		dre: ucti)			Con	ditio	on C	Cod	e	No. Stat	. of tes ^{*1}
	Mnemonic	Size	***	Rn	@ERn	@ (d,ERn)	@-ERn/@ERn+	@ aa	@ (d,PC)	@ @ aa		Operation	I	н	N	z	v	с	Normal	Advanced
AND	AND.B #xx:8,Rd	В	2									Rd8∧#xx:8→Rd8	-	-	\$	¢	0	-	1	1
	AND.B Rs,Rd	В		2								Rd8∧Rs8→Rd8	-	-	\$	¢	0	_	1	1
	AND.W #xx:16,Rd	w	4									Rd16∧#xx:16→Rd16	1-	-	\$	\$	0	-	1	2
	AND.W Rs,Rd	w		2								Rd16∧Rs16→Rd16	1-	-	\$	\$	0	-	1	1
	AND.L #xx:32,ERd	L	6									ERd32∧#xx:32→ERd32	—	-	\$	\$	0	_	3	3
	AND.L ERs,ERd	L		4								ERd32∧ERs32→ERd32	_	-	\$	\$	0	-	2	2
OR	OR.B #xx:8,Rd	В	2									Rd8∨#xx:8→Rd8	1-	-	\$	\$	0	—	1	1
	OR.B Rs,Rd	В		2								Rd8∨Rs8→Rd8	1-	-	\$	\$	0	—	1	1
	OR.W #xx:16,Rd	w	4									Rd16∨#xx:16→Rd16	-	-	\$	\$	0	_	2	2
	OR.W Rs,Rd	w		2								Rd16∨Rs16→Rd16	-	-	\$	¢	0	—	1	1
	OR.L #xx:32,ERd	L	6									ERd32∨#xx:32→ERd32	-	-	\$	\$	0	_	3	3
	OR.L ERs,ERd	L		4								ERd32∨ERs32→ERd32	—	-	\$	\$	0	_	2	2
XOR	XOR.B #xx:8,Rd	В	2									Rd8⊕#xx:8→Rd8	—	-	\$	\$	0	-	1	1
	XOR.B Rs,Rd	В		2								Rd8⊕Rs8→Rd8	-	-	\$	¢	0	-	1	1
	XOR.W #xx:16,Rd	w	4									Rd16⊕#xx:16→Rd16	-	-	\$	¢	0	-	2	2
	XOR.W Rs,Rd	w		2								Rd16⊕Rs16→Rd16	-	-	\$	\$	0	_	1	1
	XOR.L #xx:32,ERd	L	6									ERd32⊕#xx:32→ERd32	-	-	\$	\$	0	—	3	3
	XOR.L ERs,ERd	L		4								ERd32⊕ERs32→ERd32	1-	-	\$	\$	0	-	2	2
NOT	NOT.B Rd	В		2								¬ Rd8→Rd8	-	-	\$	\$	0	-	1	1
	NOT.W Rd	w		2								¬ Rd16→Rd16	-	-	\$	\$	0	_	1	1
	NOT.L ERd	L		2								¬ ERd32→ERd32	—	-	\$	¢	0	_	1	1

Table A.1 Instruction Set (cont)

4. Shift Instructions

			In	Ad stru			ng N Len										0	Con	ditio	on C	Cod	e		o. of ates [*]
	Mnemonic	Size	XX#	Rn	@ERn	@(d,ERn)	@-ERn/@ERn+	@aa	@(d,PC)	@ @ aa	99			Operati	ion		1	н	N	z	v	с	Normal	Advanced
SHAL	SHAL.B Rd	В		2													-	—	\$	\$	¢	\$		1
	SHAL.B #2,Rd	В		2													_	_	¢	↕	¢	↕		1
	SHAL.W Rd	W		2]╟•╢				-0	_	_	¢	\$	¢	\$		1
	SHAL.W #2,Rd	W		2								C N	ISB	-		LSB	-	—	\$	\$	\$	\$		1
	SHAL.L ERd	L		2													-	—	\$	\$	\$	\$		1
	SHAL.L #2,ERd	L		2													-	_	¢	\$	\$	\$		1
SHAR	SHAR.B Rd	В		2													-	_	\$	\$	0	\$		1
	SHAR.B #2,Rd	В		2													-	_	\$	\$	0	\$		1
	SHAR.W Rd	W		2								╏└╺┨				-	-	—	\$	\$	0	\$		1
	SHAR.W #2,Rd	W		2						T			ISB		•	LSB C	-	—	¢	\$	0	\$		1
	SHAR.L ERd	L		2													-	—	¢	\$	0	\$		1
	SHAR.L #2,ERd	L		2													-	_	\$	\$	0	\$		1
SHLL	SHLL.B Rd	В		2													-	_	\$	\$	0	\$		1
	SHLL.B #2,Rd	В		2													-	—	\$	\$	0	\$		1
	SHLL.W Rd	W		2								╏╟╍ſ				-0	-	—	\$	\$	0	\$		1
	SHLL.W #2,Rd	W		2								C N	ISB	-		LSB	-	—	\$	\$	0	\$		1
	SHLL.L ERd	L		2													-	_	\$	\$	0	\$		1
	SHLL.L #2,ERd	L		2													-	_	\$	\$	0	\$		1
SHLR	SHLR.B Rd	В		2													-	—	\$	\$	0	\$		1
	SHLR.B #2,Rd	В		2													-	—	\$	\$	0	\$		1
	SHLR.W Rd	W		2								0-					-	—	\$	\$	0	\$		1
	SHLR.W #2,Rd	W		2								N	1SB		•	LSB C	-	_	\$	\$	0	\$		1
	SHLR.L ERd	L		2													-	_	\$	\$	0	\$		1
	SHLR.L #2,ERd	L		2								1					-	-	\$	\$	0	\$		1
ROTXL	ROTXL.B Rd	В		2						T							-	_	\$	\$	0	\$		1
	ROTXL.B #2,Rd	В		2						T	1	1					-	—	\$	\$	0	\$		1
	ROTXL.W Rd	w		2								1 [_				-	_	\$	\$	0	\$		1
	ROTXL.W #2,Rd	W		2									MS	в 🖛		- LSB	-	-	\$	\$	0	\$		1
	ROTXL.L ERd	L		2								1				-	-	-	\$	\$	0	\$		1
	ROTXL.L #2,ERd	L		2						t		1						_	¢	\$	0	\$		1

Table A.1 Instruction Set (cont)

4. Shift Instructions

			In		dre: ucti)		0	Con	ditio	on C	Cod	e	No. Stat	of es ^{*1}
	Mnemonic	Size	#xx	Rn	@ ERn	@ (d,ERn)	@-ERn/@ERn+	@ aa	@ (d,PC)	@ @ aa	1	Operation	I	н	N	z	v	с	Normal	Advanced
ROTXR	ROTXR.B Rd	В		2									-	-	\$	\$	0	\$	1	
	ROTXR.B #2,Rd	В		2									-	-	\$	\$	0	\Leftrightarrow	1	I
	ROTXR.W Rd	w		2									_	-	\$	¢	0	\leftrightarrow	1	I
	ROTXR.W #2,Rd	w		2								MSB → LSB C	-	-	\$	¢	0	\leftrightarrow	1	I
	ROTXR.L ERd	L		2									-	-	\$	\$	0	\$	1	I
	ROTXR.L #2,ERd	L		2									-	-	\$	\$	0	€	1	I
ROTL	ROTL.B Rd	В		2									—	-	\$	¢	0	€	1	I
	ROTL.B #2,Rd	В		2									-	-	\$	¢	0	€	1	I
	ROTL.W Rd	w		2									-	-	\$	\$	0	↔	1	I
	ROTL.W #2,Rd	w		2								C MSB - LSB	-	-	¢	¢	0	\leftrightarrow	1	I
	ROTL.L ERd	L		2									_	-	\$	\$	0	\$	1	I
	ROTL.L #2,ERd	L		2									-	-	\$	\$	0	\$	1	I
ROTR	ROTR.B Rd	В		2									—	-	\$	\$	0	\$	1	I
	ROTR.B #2,Rd	В		2									-	-	\$	¢	0	€	1	I
	ROTR.W Rd	w		2									-	-	\$	\$	0	≎	1	I
	ROTR.W #2,Rd	w		2								MSB	_		\$	¢	0	≎	1	I
	ROTR.L ERd	L		2									_	—	\$	¢	0	€	1	I
	ROTR.L #2,ERd	L		2									_	-	\$	¢	0	€	1	I

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Table A.1Instruction Set (cont)

5. Bit Manipulation Instructions

			Ir						e an (By)	-		Con	diti	on (Cod	e	No. Stat	
	Mnemonic	Size	xx#	Rn	@ERn	@(d,ERn)	@-ERn/@ERn+	@aa	@(d,PC)	@ @aa	1	Operation	1	н	N	z	v	с	Normal	Advanced
BSET	BSET #xx:3,Rd	В		2								(#xx:3 of Rd8)←1	-	—	-	—	-	—	1	1
	BSET #xx:3,@ERd	В			4							(#xx:3 of @ERd)←1	-	_	-	-	-	—	2	4
	BSET #xx:3,@aa:8	В						4				(#xx:3 of @aa:8)←1	-	_	-	-	-	—	4	4
	BSET #xx:3,@aa:16	В						6				(#xx:3 of @aa:16)←1	-		-	-	-	—	5	5
	BSET #xx:3,@aa:32	В						8				(#xx:3 of @aa:32)←1	-	—	-	-	-	—	6	3
	BSET Rn,Rd	В		2								(Rn8 of Rd8)←1	-		-	_	-		1	1
	BSET Rn,@ERd	В			4							(Rn8 of @ERd)←1	-	_	-	_	-	_	2	4
	BSET Rn,@aa:8	В						4				(Rn8 of @aa:8)←1	-	_	-	-	-	—	2	4
	BSET Rn,@aa:16	В						6				(Rn8 of @aa:16)←1	-		-	_	-	_	Ę	5
	BSET Rn,@aa:32	В						8				(Rn8 of @aa:32)←1	-	_	-	_	-	_	6	6
BCLR	BCLR #xx:3,Rd	В		2								(#xx:3 of Rd8)←0	_	_	-	_	_	_	1	1
	BCLR #xx:3,@ERd	В			4							(#xx:3 of @ERd)←0	-	_	_	-	-	_	2	4
	BCLR #xx:3,@aa:8	В						4				(#xx:3 of @aa:8)←0	-	_	_	-	-	_	4	4
	BCLR #xx:3,@aa:16	в						6				(#xx:3 of @aa:16)←0	-	_	-	-	-	_	5	5
	BCLR #xx:3,@aa:32	В						8				(#xx:3 of @aa:32)←0	-	_	-	-	-	_	e	6
	BCLR Rn,Rd	В		2								(Rn8 of Rd8)←0	-	_	_	-	-	_	1	1
	BCLR Rn,@ERd	В			4							(Rn8 of @ERd)←0	-	_	-	_	_	_	2	4
	BCLR Rn,@aa:8	В						4				(Rn8 of @aa:8)←0	-	_	-	-	-	_	2	4
	BCLR Rn,@aa:16	В						6				(Rn8 of @aa:16)←0	-	_	-	-	-	_	Ę	5
	BCLR Rn,@aa:32	В						8				(Rn8 of @aa:32)←0	1_	_	1-	-	-	_	6	3
BNOT	BNOT #xx:3,Rd	В		2								(#xx:3 of Rd8)← [¬ (#xx:3 of Rd8)]	_	_	_	-	-	_	1	1
	BNOT #xx:3,@ERd	В			4							(#xx:3 of @ERd)← [¬ (#xx:3 of @ERd)]	-	-	-	-	-	—	2	4
	BNOT #xx:3,@aa:8	В						4				(#xx:3 of @aa:8)← [¬ (#xx:3 of @aa:8)]	-	-	-	_	-	—	2	4
	BNOT #xx:3,@aa:16	В						6				(#xx:3 of @aa:16)← [¬ (#xx:3 of @aa:16)]	-	_	-	_	_	—	5	5
	BNOT #xx:3,@aa:32	В						8				(#xx:3 of @aa:32)← [¬ (#xx:3 of @aa:32)]	-	_	-	-	_	_	6	6
	BNOT Rn,Rd	В		2								(Rn8 of Rd8)← [¬ (Rn8 of Rd8)]	-	_	-	-	_	—	1	1
	BNOT Rn,@ERd	В			4							(Rn8 of @ERd)← [¬ (Rn8 of @ERd)]	-	—	-	-	-	—	2	4
	BNOT Rn,@aa:8	В						4				(Rn8 of @aa:8)← [¬ (Rn8 of @aa:8)]	-	_	-	-	-	—	2	4
	BNOT Rn,@aa:16	В						6				(Rn8 of @aa:16)← [¬ (Rn8 of @aa:16)]	-	_	-	-	_	—	5	5
	BNOT Rn,@aa:32	В						8				(Rn8 of @aa:32)← [¬ (Rn8 of @aa:32)]	-	-	-	-	_	_	6	3

Table A.1 Instruction Set (cont)

5. Bit Manipulation Instructions

			In			ssir on I)			Con	diti	on C	Cod	e		. of tes ^{*1}
	Mnemonic	Size	#xx	Rn	@ERn	@(d,ERn)	@-ERn/@ERn+	Qaa	@(d,PC)	@ @aa	1	Operation	1	н	N	z	v	с	Normal	Advanced
BTST	BTST #xx:3,Rd	В		2								¬ (#xx:3 of Rd8)→Z	-	-	-	\$	—	-		1
	BTST #xx:3,@ERd	В			4							¬ (#xx:3 of @ERd)→Z	-	-	-	\$	—	_	:	3
	BTST #xx:3,@aa:8	В						4				¬ (#xx:3 of @aa:8)→Z	-	-	-	\$	—	_	:	3
	BTST #xx:3,@aa:16	В						6				¬ (#xx:3 of @aa:16)→Z	-	-	_	\$	—	_	4	4
	BTST #xx:3,@aa:32	В						8				¬ (#xx:3 of @aa:32)→Z	-	-	-	\$	—	—	ę	5
	BTST Rn,Rd	В		2								¬ (Rn8 of Rd8)→Z	-	-	_	\$	_	_		1
	BTST Rn,@ERd	В			4							¬ (Rn8 of @ERd)→Z	-	-	-	\$	_	_	:	3
	BTST Rn,@aa:8	В						4				¬ (Rn8 of @aa:8)→Z	-	-	_	\$	—	-	;	3
	BTST Rn,@aa:16	В						6				¬ (Rn8 of @aa:16)→Z	-	-	-	\$	_	_	4	4
	BTST Rn,@aa:32	В						8				¬ (Rn8 of @aa:32)→Z	-	-	-	\$	—	-	ę	5
BLD	BLD #xx:3,Rd	В		2								(#xx:3 of Rd8)→C	-	-	-	-	_	\$		1
	BLD #xx:3,@ERd	В			4							(#xx:3 of @ERd)→C	-	_	-	_	_	\$:	3
	BLD #xx:3,@aa:8	В						4				(#xx:3 of @aa:8)→C	-	_	-	-	_	\$:	3
	BLD #xx:3,@aa:16	В						6				(#xx:3 of @aa:16)→C	-	-	_	-	—	\$	4	4
	BLD #xx:3,@aa:32	В						8				(#xx:3 of @aa:32)→C	-	-	-	-	_	\$	ę	5
BILD	BILD #xx:3,Rd	В		2								¬ (#xx:3 of Rd8)→C	-	-	-	-	_	\$		1
	BILD #xx:3,@ERd	В			4							¬ (#xx:3 of @ERd)→C	-	-	_	-	_	\$:	3
	BILD #xx:3,@aa:8	В						4				¬ (#xx:3 of @aa:8)→C	-	-	-	-	_	\$:	3
	BILD #xx:3,@aa:16	В						6				¬ (#xx:3 of @aa:16)→C	-	-	_	-	—	\$	4	4
	BILD #xx:3,@aa:32	В						8				¬ (#xx:3 of @aa:32)→C	-	-	-	-	_	\$	ę	5
BST	BST #xx:3,Rd	В		2								C→(#xx:3 of Rd8)	-	_	_	-	_	_		1
	BST #xx:3,@ERd	В			4							C→(#xx:3 of @ERd)	-	-	-	-	_	-	4	4
	BST #xx:3,@aa:8	В						4				C→(#xx:3 of @aa:8)	-	-	-	-	_	_	4	4
	BST #xx:3,@aa:16	В						6				C→(#xx:3 of @aa:16)	-	_	-	-	_	_	ę	5
	BST #xx:3,@aa:32	В						8				C→(#xx:3 of @aa:32)	-	-	-	-	_	_	6	6
BIST	BIST #xx:3,Rd	В		2								¬ C→(#xx:3 of Rd8)	1-	-	-	-	_	_		1
	BIST #xx:3,@ERd	В			4							¬ C→(#xx:3 of @ERd)	-	-	-	-	_	_	4	4
	BIST #xx:3,@aa:8	В						4				¬ C→(#xx:3 of @aa:8)	-	_	_	-	_	_	4	4
	BIST #xx:3,@aa:16	В						6				¬ C→(#xx:3 of @aa:16)	-	_	_	-	_	_	ę	5
	BIST #xx:3,@aa:32	В						8				¬ C→(#xx:3 of @aa:32)	1-	_	-	-	_	_	6	6

Table A.1Instruction Set (cont)

5. Bit Manipulation Instructions

			Ir			ssir on l	-)		-	Con	diti	on C	ode	e		. of tes*
	Mnemonic	Size	XX#	Rn	@ERn	@(d,ERn)	@-ERn/@ERn+	@aa	@(d,PC)	@ @aa		Operation	1	н	N	z	v	с	Normal	Advanced
BAND	BAND #xx:3,Rd	В		2								C∧ (#xx:3 of Rd8)→C	-	_	-	_	-	\$		1
	BAND #xx:3,@ERd	В			4							C∧ (#xx:3 of @ERd)→C	-	-	-	_	-	€	:	3
	BAND #xx:3,@aa:8	В						4				C∧ (#xx:3 of @aa:8)→C	-	-	-	-	-	↕	:	3
	BAND #xx:3,@aa:16	В						6				C∧ (#xx:3 of @aa:16)→C	-	-	-	_	-	\$		4
	BAND #xx:3,@aa:32	В						8				C∧ (#xx:3 of @aa:32)→C	-	-	-	_	-	\$		5
BIAND	BIAND #xx:3,Rd	В		2								C∧ [¬ (#xx:3 of Rd8)]→C	-	_	_	_	_	\$		1
	BIAND #xx:3,@ERd	В			4							C∧ [¬ (#xx:3 of @ERd)]→C	-	-	-	_	-	€	:	3
	BIAND #xx:3,@aa:8	В						4				C∧ [¬ (#xx:3 of @aa:8)]→C	1-	-	_	-	-	↕	:	3
	BIAND #xx:3,@aa:16	В						6				C∧ [¬ (#xx:3 of @aa:16)]→C	-	-	-	-	-	↕		4
	BIAND #xx:3,@aa:32	В						8				C∧ [¬ (#xx:3 of @aa:32)]→C	-	-	-	_	_	≎		5
BOR	BOR #xx:3,Rd	В		2								C∨ (#xx:3 of Rd8)→C	-	-	-	_	-	€		1
	BOR #xx:3,@ERd	В			4							C∨ (#xx:3 of @ERd)→C	-	-	-	_	-	€	:	3
	BOR #xx:3,@aa:8	В						4				C∨ (#xx:3 of @aa:8)→C	1-	-	-	_	-	↕	:	3
	BOR #xx:3,@aa:16	В						6				C∨ (#xx:3 of @aa:16)→C	-	-	-	-	-	↕		4
	BOR #xx:3,@aa:32	В						8				C∨ (#xx:3 of @aa:32)→C	-	-	-	_	-	\$		5
BIOR	BIOR #xx:3,Rd	В		2								C∨ [¬ (#xx:3 of Rd8)]→C	-	-	-	_	-	\$		1
	BIOR #xx:3,@ERd	В			4							C∨ [¬ (#xx:3 of @ERd)]→C	-	_	-	_	-	\$:	3
	BIOR #xx:3,@aa:8	В						4				C∨ [¬ (#xx:3 of @aa:8)]→C	-	-	-	_	-	€	:	3
	BIOR #xx:3,@aa:16	В						6				C∨ [¬ (#xx:3 of @aa:16)]→C	-	_	-	_	-	\$		4
	BIOR #xx:3,@aa:32	В						8				C∨ [¬ (#xx:3 of @aa:32)]→C	-	_	-	—	-	\$:	5
BXOR	BXOR #xx:3,Rd	В		2								C⊕ (#xx:3 of Rd8)→C	-	_	-	_	_	≎		1
	BXOR #xx:3,@ERd	В			4							C⊕ (#xx:3 of @ERd)→C	-	-	-	_	_	€	:	3
	BXOR #xx:3,@aa:8	В						4				C⊕ (#xx:3 of @aa:8)→C	-	-	-	_	-	\$:	3
	BXOR #xx:3,@aa:16	В						6				C⊕ (#xx:3 of @aa:16)→C	-	_	_	-	-	€		4
	BXOR #xx:3,@aa:32	В						8				C⊕ (#xx:3 of @aa:32)→C	-	-	_	_	_	\$		5
BIXOR	BIXOR #xx:3,Rd	В		2								C⊕ [¬ (#xx:3 of Rd8)]→C	-	-	-	-	_	\$		1
	BIXOR #xx:3,@ERd	В			4							C⊕ [¬ (#xx:3 of @ERd)]→C	-	-	-	-	-	≎		3
	BIXOR #xx:3,@aa:8	В						4				C⊕ [¬ (#xx:3 of @aa:8)]→C	-	-	-	_	_	€	:	3
	BIXOR #xx:3,@aa:16	В						6				C⊕ [¬ (#xx:3 of @aa:16)]→C	-	_	_	-	-	€		4
	BIXOR #xx:3,@aa:32	В						8				C⊕ [¬ (#xx:3 of @aa:32)]→C	1-	_	_	_	_	\$:	5

Table A.1 Instruction Set (cont)

6. Branch Instructions

			In		dre: ucti)			(Con	ditio	on C	Cod	e		. of tes ^{*1}
	Mnemonic	Size	#xx	Rn	@ERn	@(d,ERn)	@-ERn/@ERn+	@aa	@(d,PC)	@ @aa	1	Operation	Branch Condition	ı	н	N	z	v	с	Normal	Advanced
Bcc	BRA d:8(BT d:8)	-							2			if condition is true then	Always	-	-	—	-	—	—	2	2
	BRA d:16(BT d:16)	-							4			PC←PC+d else next;		-	-	-	-	—	_	:	3
	BRN d:8(BF d:8)	-							2				Never	-	-	_	_	—	_	2	2
	BRN d:16(BF d:16)	-							4					-	-	-	-	_	-	:	3
	BHI d:8	-							2				C∨Z=0	-	-	-	-	—	-	2	2
	BHI d:16	-							4					-	-	_	-	_	_	:	3
	BLS d:8	-							2				C∨Z=1	_	_	_	-	_	_	2	2
	BLS d:16	-							4					-	_	_	-	_	_	:	3
	BCC d:8(BHS d:8)	-							2				C=0	-	-	-	-	—	_	2	2
	BCC d:16(BHS d:16)	-							4					-	_	_	_	_	_	;	3
	BCS d:8(BLO d:8)	-							2				C=1	-	-	—	-	—	-	2	2
	BCS d:16(BLO d:16)	-							4					-	_	_	-	_	_	:	3
	BNE d:8	-							2				Z=0	-	_	_	-	_	_	2	2
	BNE d:16	-							4					-	_	_	-	_	_	;	3
	BEQ d:8	-							2				Z=1	-	-	—	-	—	_	2	2
	BEQ d:16	-							4					-	-	_	-	_	_	:	3
	BVC d:8	-							2				V=0	-	_	_	-	_	_	2	2
	BVC d:16	-							4					-	-	_	-	_	_	:	3
	BVS d:8	-							2				V=1	-	-	_	-	_	_	2	2
	BVS d:16	-							4					-	-	_	-	_	_	:	3
	BPL d:8	-							2				N=0	-	-	_	-	_	_	2	2
	BPL d:16	-							4					-	_	_	_	_	_	:	3
	BMI d:8	-							2				N=1	-	-	_	-	—	_	2	2
	BMI d:16	-							4					-	_	_	-	_	_	:	3
	BGE d:8	-							2			1	N⊕V=0	-	-	-	-	_	_	2	2
	BGE d:16	-							4			1		-	-	-	-	_	_	:	3
	BLT d:8	-							2			1	N⊕V=1	-	-	—	-	_	_	2	2
	BLT d:16	-							4			1		-	-	—	-	_	_	:	3
	BGT d:8	-							2			1	Z∨(N⊕V)=0	-	-	_	-	_	_	2	2
	BGT d:16	1-							4			1		-	-	-	-	_	-	:	3
	BLE d:8	1-							2			1	Z∨(N⊕V)=1	_	-	_	-	_	_	2	2
	BLE d:16	1_							4			1		-	_	_	_	_	_	:	3

Table A.1 Instruction Set (cont)

6. Branch Instructions

			Ir		ldre ucti								(Con	diti	on (Cod	e	No. Stat	of tes ^{*1}
	Mnemonic	Size	xx#	Rn	@ERn	@(d,ERn)	@-ERn/@ERn+	@aa	@(d,PC)	@ @ aa	I	Operation	I	н	N	z	v	с	Normal	Advanced
JMP	JMP @ERn	-			2							PC←ERn	-	-	-	_	-	-	2	2
	JMP @aa:24	-						4				PC←aa:24	-	_	-	—	-	—	3	3
	JMP @@aa:8	-								2		PC←@aa:8	-	_	-	—	-	—	4	5
BSR	BSR d:8	-							2			PC→@-SP,PC←PC+d:8	-	-	-	—	-	—	3	4
	BSR d:16	-							4			PC→@-SP,PC←PC+d:16	-	-	-	—	-	—	4	5
JSR	JSR @ERn	-			2							PC→@-SP,PC←ERn	-	-	-	—	-	—	3	4
	JSR @aa:24	-						4				PC→@-SP,PC←aa:24	-	—	-	—	-	—	4	5
	JSR @@aa:8	-								2		PC→@-SP,PC←@aa:8	—	—	-	—	-	—	4	6
RTS	RTS	-									2	PC←@SP+	-	_	-	_	-	_	4	5

Table A.1Instruction Set (cont)

7. System Control Instructions

			Ir			ssir on l)			Con	diti	on (Cod	e		. of tes ^{*1}
	Mnemonic	Size	XX#	Rn	@ERn	@(d,ERn)	@-ERn/@ERn+	@aa	@(d,PC)	@ @aa	1	Operation	1	н	N	z	v	с	Normal	Advanced
TRAPA	TRAPA #xx:2	-										$PC \rightarrow @-SP,CCR \rightarrow @-SP,$ $EXR \rightarrow @-SP,$	1	-	-	-	-	-	7 [9]	8 [9]
RTE	RTE	-										EXR←@SP+,CCR←@SP+, PC←@SP+	\$	\$	\$	\$	\$	\$	5 [9]
SLEEP	SLEEP	-										Transition to power-down state	1-	-	-	-	_	-	2	2
LDC	LDC #xx:8,CCR	В	2									#xx:8→CCR	\$	\$	\$	\$	\$	\$	1	1
	LDC #xx:8,EXR	В	4									#xx:8→EXR	-	-	-	-	—	-	2	2
	LDC Rs,CCR	В		2								Rs8→CCR	\$	\$	\$	\$	\$	\$	1	1
	LDC Rs,EXR	В		2								Rs8→EXR	-	-	-	-	—	-	1	1
	LDC @ERs,CCR	w			4							@ERs→CCR	\$	\$	\$	\$	\$	\$	3	3
	LDC @ERs,EXR	W			4							@ERs→EXR	-	-	-	-	—	-	3	3
	LDC @(d:16,ERs),CCR	W				6						@(d:16,ERs)→CCR	\$	¢	\$	\$	\$	\$	4	1
	LDC @(d:16,ERs),EXR	W				6						@(d:16,ERs)→EXR	-	-	_	-	—	—	4	1
	LDC @(d:32,ERs),CCR	W				10						@(d:32,ERs)→CCR	\$	¢	¢	¢	\$	¢	e	6
	LDC @(d:32,ERs),EXR	W				10						@(d:32,ERs)→EXR		-	-	-	—	_	6	6
	LDC @ERs+,CCR	W					4					$@ERs \rightarrow CCR, ERs32+2 \rightarrow ERs32$	\$	\$	¢	\$	\$	\$	4	1
	LDC @ERs+,EXR	W					4					@ERs \rightarrow EXR,ERs32+2 \rightarrow ERs32	_	_	_	_	-	_	4	1
	LDC @aa:16,CCR	W						6				@aa:16→CCR	\$	\$	\$	\$	\$	\$	4	1
	LDC @aa:16,EXR	w						6				@aa:16→EXR	_	_	-	-	-	_	4	1
	LDC @aa:32,CCR	W						8				@aa:32→CCR	\$	¢	¢	\$	\$	\$	5	5
	LDC @aa:32,EXR	W						8				@aa:32→EXR	-	-	-	-	-	-	5	5

Table A.1 Instruction Set (cont)

7. System Control Instructions

			In		dre: ucti)			Con	diti	on (Cod	e		. of tes ^{*1}
	Mnemonic	Size	XX#	Rn	@ERn	@(d,ERn)	@-ERn/@ERn+	@aa	@(d,PC)	@ @ aa	1	Operation	I	н	N	z	v	с	Normal	Advanced
STC	STC CCR,Rd	В		2								CCR→Rd8	-	-	-	—	-	—	ſ	1
	STC EXR,Rd	В		2								EXR→Rd8	-	-	-	—	-	—	1	1
	STC CCR,@ERd	W			4							CCR→@ERd	-	-	-	—	-	—	3	3
	STC EXR,@ERd	W			4							EXR→@ERd	_	-	-	—	-	—	3	3
	STC CCR,@(d:16,ERd)	W				6						CCR→@(d:16,ERd)	_	-	-	_	-	—	2	4
	STC EXR,@(d:16,ERd)	W				6						EXR→@(d:16,ERd)	_	-	-	—	-	—	4	4
	STC CCR,@(d:32,ERd)	W				10						CCR→@(d:32,ERd)	—	-	-	_	-	—	6	6
	STC EXR,@(d:32,ERd)	W				10						EXR→@(d:32,ERd)	_	-	-	—	-	—	6	6
	STC CCR,@-ERd	W					4					ERd32-2→ERd32,CCR→@ERd	_	-	-	—	-	—	4	4
	STC EXR,@-ERd	W					4					ERd32-2→ERd32,EXR→@ERd	_	-	-	—	-	—	4	4
	STC CCR,@aa:16	W						6				CCR→@aa:16	_	-	-	—	-	—	4	4
	STC EXR,@aa:16	W						6				EXR→@aa:16	_	-	-	—	-	—	4	4
	STC CCR,@aa:32	W						8				CCR→@aa:32	-	-	-	—	-	—	Ę	5
	STC EXR,@aa:32	W						8				EXR→@aa:32	_	-	-	—	-	—	Ę	5
ANDC	ANDC #xx:8,CCR	В	2									CCR∧#xx:8→CCR	\$	¢	\$	\$	¢	\$	1	1
	ANDC #xx:8,EXR	В	4									EXR∧#xx:8→EXR	-	-	-	—	-	—	2	2
ORC	ORC #xx:8,CCR	В	2									CCR∨#xx:8→CCR	\$	\$	\$	\$	\$	\$		1
	ORC #xx:8,EXR	В	4									EXR∨#xx:8→EXR	_	-	-	_	-	—	2	2
XORC	XORC #xx:8,CCR	В	2									CCR⊕#xx:8→CCR	\$	\$	¢	\$	\$	\$		1
	XORC #xx:8,EXR	В	4									EXR⊕#xx:8→EXR	_	-	-	_	-	—	2	2
NOP	NOP	-									2	PC←PC+2	_	-	_	_	-	_		1

Table A.1 Instruction Set (cont)

8. Block Transfer Instructions

			Ir		dre: ucti)		0	Con	ditio	on C	od	e	No. Stat	of es ^{*1}
	Mnemonic	Size	xx#	Rn	@ERn	@(d,ERn)	@-ERn/@ERn+	@aa	@(d,PC)	@ @ aa		Operation	1	н	N	z	v	с	Normal	Advanced
EEPMOV	EEPMOV.B	-									4	if R4L≠0 Repeat @ER5→@ER6 ER5+1→ER5 ER6+1→ER6 R4L-1→R4L Until R4L=0 else next;	-	_	-	-		-	4+2	'n*2
	EEPMOV.W	-									4	if R4≠0 Repeat @ER5→@ER6 ER5+1→ER5 ER6+1→ER6 R4-1→R4 Until R4=0 else next;	-		-	_		—	4+2	n*2

Notes: 1. The number of states is the number of states required for execution when the instruction and its operands are located in on-chip memory.

- 2. n is the initial value set in R4L or R4.
- [1] 7 states when the number of saved/restored registers is 2, 9 states when 3, and 11 states when 4.
- [2] Cannot be used with the H8S/2138 Series and H8S/2134 Series.
- [3] Set to 1 when there is a carry from or borrow to bit 11; otherwise cleared to 0.
- [4] Set to 1 when there is a carry from or borrow to bit 27; otherwise cleared to 0.
- [5] If the result is zero, the previous value of the flag is retained; otherwise the flag is cleared to 0.
- [6] Set to 1 if the divisor is negative; otherwise cleared to 0.
- [7] Set to 1 if the divisor is zero; otherwise cleared to 0.
- [8] Set to 1 if the quotient is negative; otherwise cleared to 0.
- [9] When EXR is valid, the number of states is increased by 1.

A.2 Instruction Codes

Table A.2Instruction Codes

Instruc-	Manada								Instructio	Instruction Format				
tion		Size	1st E	1st Byte	2nd Byte	3yte	3rd Byte	4th Byte	5th Byte	6th Byte	7th Byte	8th Byte	9th Byte	10th Byte
ADD	ADD.B #xx:8,Rd	в	8	rd	IMM	Δ								
	ADD.B Rs,Rd	В	0	8	rs	rd								
	ADD.W #xx:16,Rd	≥	7	6	-	rd	=	IMM						
	ADD.W Rs,Rd	8	0	6	rs	rd								
	ADD.L #xx:32,ERd	_	7	A	-	0 erd		≤	IMM					
	ADD.L ERS, ERd	_	0	٨	1 ers 0 erd	0 erd								
ADDS	ADDS #1,ERd	_	0	в	0	0 erd								
	ADDS #2,ERd	-	0	в	8	0 erd								
	ADDS #4,ERd	_	0	æ	6	0 erd								
ADDX	ADDX #xx:8,Rd	ш	6	ā	IMM	Σ								
	ADDX Rs,Rd	В	0	ш	rs	rd								
AND	AND.B #xx:8,Rd	۵	ш	Þ	MMI	Σ								
	AND.B Rs,Rd	۵	-	9	s	p								
	AND.W #xx:16,Rd	≥	2	6	9	q	=	MMI						
	AND.W Rs,Rd	3	9	9	LS	rd								
	AND.L #xx:32,ERd	_	7	٨	9	0 erd		4	MMI					
	AND.L ERS, ERd	_	0	-	ш	0	9 9	0 ers 0 erd						
ANDC	ANDC #xx:8,CCR	۵	0	9	MMI	Σ								
	ANDC #xx:8,EXR	ш	0	-	4	-	9 0	IMM						
BAND	BAND #xx:3,Rd	в	7	9	0 IMM	rd								
	BAND #xx:3,@ERd	ш	7	ပ	0 erd	0	7 6	0 IMMI 0						
	BAND #xx:3,@aa:8	В	7	ш	abs	s	7 6	0 IMMI 0						
	BAND #xx:3,@aa:16	ш	9	٨	-	0		abs	7 6	0 MMI 0				
	BAND #xx:3,@aa:32	ш	9	A	e	0		Ø	abs		7 6	0 IMM 0		
Bcc	BRA d:8 (BT d:8)	Ι	4	0	disp	d								
	BRA d:16 (BT d:16)	Ι	5	8	0	0	C	disp						
	BRN d:8 (BF d:8)	Ι	4	-	disp	đ								
	BRN d:16 (BF d:16)	Ι	5	œ	-	0	0	disp						

Instruc-	Mnemonic							Instruction Format	in Format				
tion		SIZE	1st Byte	3yte	2nd Byte	3rd Byte	4th Byte	5th Byte	6th Byte	7th Byte	8th Byte	9th Byte	10th Byte
Bcc	BHI d:8	Ι	4	7	disp								
	BHI d:16	Ι	5	œ	2	disp	d						
	BLS d:8	Ι	4	з	disp								
	BLS d:16	Ι	5	80	3 9	disp	d						
	BCC d:8 (BHS d:8)	I	4	4	disp								
	BCC d:16 (BHS d:16)	Ι	5	8	4 0	disp	d						
	BCS d:8 (BLO d:8)	Ι	4	5	disp								
	BCS d:16 (BLO d:16)	Ι	5	8	5 0	disp	d						
	BNE d:8	Ι	4	9	disp								
	BNE d:16	Ι	5	8	6 0	disp	d						
	BEQ d:8	Ι	4	7	disp								
	BEQ d:16	Ι	9	8	7 0	disp	ds						
	BVC d:8	Ι	4	80	disp								
	BVC d:16	I	2	8	0	di	disp						
	BVS d:8	Ι	4	6	disp								
	BVS d:16	Ι	5	8	0 6	disp	sp						
	BPL d:8	Ι	4	A	disp								
	BPL d:16	Ι	5	œ	о Р	disp	ď						
	BMI d:8	I	4	В	disp								
	BMI d:16	Ι	5	8	B 0	disp	sp						
	BGE d:8	I	4	υ	disp								
	BGE d:16	Ι	5	8	0 C	disp	sp						
	BLT d:8	I	4	D	disp								
	BLT d:16	Ι	5	8	0 D	disp	b						
	BGT d:8	Ι	4	ш	disp								
	BGT d:16	Ι	5	80	о Э	disp	þ						
	BLE d:8	I	4	ш	disp								
	BLE d:16	Ι	5	8	0 4	disp	d						

 Table A.2
 Instruction Codes (cont)

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Mnemonic	Ciro					Instructio	Instruction Format				
כ		1st Byte	2nd Byte	3rd Byte	4th Byte	5th Byte	6th Byte	7th Byte	8th Byte	9th Byte	10th Byte
	В	7 2	0 IMM rd								
	В	7 D	0 erd 0	7 2	0 MMI 0						
	в	7 F	abs	7 2	0 MMI 0						
	В	6 A	1 8	а	abs	7 2	0 MMI 0				
	В	6 A	8 8		at	abs		7 2	0 IMM 0		
	ш	6 2	E								
	ш	7 D	0 erd 0	6	0 L						
	m	7 F	abs	6	0 L						
	в	6 A	- 8	a	abs	6	0 E				
	m	6 A	8 N		at	abs		6	n 0		
	۵	7 6	1 IMM rd								
	В	7 C	0 erd 0	7 6	1 IMM 0						
	В	7 E	abs	7 6	1 IMM 0						
	В	6 A	1 0	σ	abs	7 6	1 IMM 0				
	В	6 A	3 0		abs	S		7 6	1 IMM 0		
	в	7 7	1 IMM rd								
	В	7 C	0 erd 0	7 7	1 IMM 0						
	В	7 E	abs	7 7	7 1 IMM 0						
	в	6 A	1	g	abs	7 7	1 IMM 0				
	В	6 A	3 0		at	abs		7 7	1 IMM 0		
	в	7 4	1 IMM rd								
	В	7 C	0 erd 0	7 4	1 IMM 0						
	в	7 E	abs	7 4	1 IMM 0						
	В	6 A	1 0	а	abs	7 4	1 IMM 0				
	В	6 A	3 0		at	abs		7 4	1 IMM 0		

Table A.2 Instruction Codes (cont)

Instruc-	Mnemonic	į								<u>ء</u>	structic	Instruction Format				
tion		Size	1st Byte	syte	2nd Byte	3yte	3rd Byte	rte	4th Byte	5th	5th Byte	6th Byte	7th Byte	8th Byte	9th Byte	10th Byte
BIST	BIST #xx:3,Rd	в	9	7	1 IMM	p										
	BIST #xx:3,@ERd	В	7	D	0 erd	0	9	7 1	1 IMM 0							
	BIST #xx:3,@aa:8	В	7	ш	sqe	ş	9	7 1	1 IMM 0							
	BIST #xx:3,@aa:16	в	9	A	-	8		abs		9	7	1 IMM 0				
	BIST #xx:3,@aa:32	В	9	A	3	8				abs			2 9	1 IMM 0		
BIXOR	BIXOR #xx:3,Rd	в	7	5	1 IMM	p										
	BIXOR #xx:3,@ERd	۵	7	υ	0 erd	0	~	5	1 IMM 0							
	BIXOR #xx:3,@aa:8	۵	7	ш	abs	ş	7	5	1 IMM 0							
	BIXOR #xx:3,@aa:16	ш	9	٨	-	0		abs		2	ۍ 	1 IMM 0				
	BIXOR #xx:3,@aa:32	В	9	А	3	0				abs			7 5	1 IMM 0		
BLD	BLD #xx:3,Rd	в	7	7	0 IMM	p										
	BLD #xx:3,@ERd	В	7	С	0 erd	0	7	7 0	0 MMI 0							
	BLD #xx:3,@aa:8	в	7	ш	abs	ş	7	7 0	0 MMI 0							
	BLD #xx:3,@aa:16	В	9	A	-	0		abs		7	7	0 MMI 0				
	BLD #xx:3,@aa:32	в	9	A	с	0			.0	abs			7 7	0 IMM 0		
BNOT	BNOT #xx:3,Rd	۵	7	-	0 IMM	Þ										
	BNOT #xx:3,@ERd	в	7	D	0 erd	0	7	1	0 MMI 0							
	BNOT #xx:3, @aa:8	В	7	ш	abs	ş	7	1 0	0 IMM 0							
	BNOT #xx:3,@aa:16	В	9	А	+	8		abs		7	-	0 IMM 0				
	BNOT #xx:3,@aa:32	в	9	A	с	8			.u	abs			7 1	0 IMM 0		
	BNOT Rn,Rd	В	9	-	ш	p										
	BNOT Rn, @ERd	В	7	D	0 erd	0	9	-	rn 0							
	BNOT Rn, @aa:8	В	7	ш	abs	ş	9	-	rn 0							
	BNOT Rn, @aa:16	в	9	A	-	8		abs		9	-	0 				
	BNOT Rn, @aa:32	В	9	A	e	8			.0	abs			6 1	0 LI		

 Table A.2
 Instruction Codes (cont)

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Instruc-	Mnemonic									Instruct	Instruction Format				
tion		SIZE		1st Byte	2nd Byte	3rd	3rd Byte	4th Byte		5th Byte	6th Byte	7th Byte	8th Byte	9th Byte	10th Byte
BOR	BOR #xx:3,Rd	в	7	4	0 IMM rd										
	BOR #xx:3, @ERd	В	7	ပ	0 erd 0	7	4	0 IMM	0						
	BOR #xx:3, @aa:8	В	7	ш	abs	7	4	0 IMM	0						
	BOR #xx:3,@aa:16	ш	9	A	1		at	abs	_	7 4	0 IMM 0				
	BOR #xx:3,@aa:32	в	9	A	3 0				abs			7 4	0 IMM 0		
BSET	BSET #xx:3,Rd	В	7	0	0 IMM rd										
	BSET #xx:3,@ERd	В	7	۵	0 erd 0	7	0	0 IMM	0						
	BSET #xx:3,@aa:8	в	7	ш	abs	7	0	0 IMM	0						
	BSET #xx:3,@aa:16	В	9	A	1 8		at	abs		7 0	0 IMM 0				
	BSET #xx:3,@aa:32	В	9	A	3 8				abs			7 0	0 MMM 0		
	BSET Rn,Rd	В	9	0	m										
	BSET Rn, @ERd	в	7	۵	0 erd 0	9	0	E	0						
	BSET Rn, @aa:8	В	7	ш	abs	9	0	E	0						
	BSET Rn, @aa:16	в	9	A	1 8		abs	SC		6 0	m 0				
	BSET Rn, @aa:32	В	9	A	3 8				abs			6 0	rn 0		
BSR	BSR d:8	Ι	5	5	disp										
	BSR d:16	Ι	5	С	0 0		di	disp							
BST	BST #xx:3,Rd	в	9	7	0 IMM rd										
	BST #xx:3,@ERd	в	7	۵	0 erd 0	9	7	0 IMM	0						
	BST #xx:3,@aa:8	۵	7	ш	abs	9	7	0 IMM	0						
	BST #xx:3,@aa:16	В	9	A	1 8		at	abs		6 7	0 IMM 0				
	BST #xx:3,@aa:32	В	9	A	3 8				abs			6 7	0 MMM 0		
BTST	BTST #xx:3,Rd	ш	7	Э	0 IMM rd										
	BTST #xx:3,@ERd	ш	7	ပ	0 erd 0	~	e	0 IMM	0						
	BTST #xx:3,@aa:8	ш	7	ш	abs	~	e	0 IMM	0						
	BTST #xx:3,@aa:16	ш	9	A	1		at	abs		7 3	0 IMM 0				
	BTST #xx:3,@aa:32	۵	9	A	3				abs			7 3	0 IMM 0		
	BTST Rn,Rd	ш	9	ю	n Td										
	BTST Rn, @ERd	В	7	ပ	0 erd 0	9	e	E	0						

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Instruc-	Mnemonic	i							Instructio	Instruction Format				
tion		azic		1st Byte	2nd Byte		3rd Byte	4th Byte	5th Byte	6th Byte	7th Byte	8th Byte	9th Byte	10th Byte
BTST	BTST Rn, @aa:8	۵	7	ш	abs	9	3	n D						
	BTST Rn, @aa:16	ш	9	A	1 0		al	abs	6 3	0 ш				
	BTST Rn, @aa:32	В	9	A	3 0				abs		6 3	rn 0		
BXOR	BXOR #xx:3,Rd	ш	7	5	0 IMM rd									
	BXOR #xx:3,@ERd	В	7	c	0 erd 0	7	5	0 MMI 0						
	BXOR #xx:3, @aa:8	ш	7	ш	abs	7	ъ	0 MMI 0						
	BXOR #xx:3,@aa:16	۵	9	A	1		al	abs	7 5	0 MMI 0				
	BXOR #xx:3, @aa:32	в	9	A	3 0				abs		7 5	0 IMM 0		
CLRMAC	CLRMAC CLRMAC	Ι	Cann	ot be us	sed with the	H8S/2	138 Serie	es and H8S/	Cannot be used with the H8S/2138 Series and H8S/2134 Series.					
CMP	CMP.B #xx:8,Rd	в	A	rd	MMI									
	CMP.B Rs,Rd	ш	-	ပ	rs rd									
	CMP.W #xx:16,Rd	Μ	7	6	2 rd		IN	IMM						
	CMP.W Rs,Rd	×	-	۵	rs rd									
	CMP.L #xx:32,ERd	L	7	A	2 0 erd	p			IMM					
	CMP.L ERS, ERd	_	-	ш	1 ers 0 erd	q								
DAA	DAA Rd	۵	0	ш	0	_								
DAS	DAS Rd	В	-	ш	0 Id									
DEC	DEC.B Rd	В	-	А	0 rd									
	DEC.W #1,Rd	≥	-	в	5 rd									
	DEC.W #2,Rd	Ν	-	В	D									
	DEC.L #1,ERd	Γ	-	в	7 0 erd	p								
	DEC.L #2,ERd	L	-	В	F 0 erd	p								
DIVXS	DIVXS.B Rs,Rd	۵	0	-	0	5	-	rs rd						
	DIVXS.W Rs,ERd	≥	0	-	0 D	5	3	rs 0 erd	q					
DIVXU	DIVXU.B Rs,Rd	۵	5	-	rs rd									
	DIVXU.W Rs,ERd	≥	5	ю	rs 0 erd	p								
EEPMOV	EEPMOV EEPMOV.B	Ι	7	۵	5 C	5	6	8						
	EEPMOV.W	Ι	7	В	D 4	5	6	8 						

Instruc-	Mnemonio	į								1	Instruction Format	on Forn	nat				
tion		Size		1st Byte	2nd Byte	rte	3rd Byte		4th Byte		5th Byte	6th I	6th Byte	7th Byte	8th Byte	9th Byte	10th Byte
EXTS	EXTS.W Rd	Ν	-	7	D	rd											
	EXTS.L ERd	-	٢	7	F 0	0 erd											
EXTU	EXTU.W Rd	N	-	7	5	rd											
	EXTU.L ERd	Г	٦	7	2 0	0 erd											
INC	INC.B Rd	ш	0	A	0	гd											
	INC.W #1,Rd	N	0	В	5	rd											
	INC.W #2,Rd	Ν	0	в	Q	rd											
	INC.L #1,ERd	L	0	В	7 0	0 erd											
	INC.L #2,ERd	Г	0	В	0 J	0 erd											
ЧМГ	JMP @ERn	Ι	5	6	0 ern	0											
	JMP @aa:24	Ι	5	A			abs										
	JMP @@aa:8	Ι	5	в	abs												
JSR	JSR @ERn	I	2	D	0 ern	0											
	JSR @aa:24	Ι	5	ш			abs										
	JSR @@aa:8		5	ш	abs												
LDC	LDC #xx:8,CCR	в	0	7	IMM												
	LDC #xx:8,EXR	В	0	1	4	1	0	7	IMM								
	LDC Rs, CCR	в	0	3	0	rs											
	LDC Rs, EXR	۵	0	ю	-	S											
	LDC @ERs,CCR	≥	0	-	4	0		0	0 ers 0								
	LDC @ERs,EXR	≥	0	-	4	-	9	6	0 ers 0								
	LDC @(d:16,ERs),CCR	≥	0	-	4	0		<u>о</u>	0 ers 0		q	disp					
	LDC @(d:16,ERs),EXR	≥	0	-	4	-		<u>о</u>	0 ers 0		đ	disp					
	LDC @(d:32,ERs),CCR	≥	0	-	4	0	7	8	ers 0	9	<u>е</u>	2	0		di	disp	
	LDC @(d:32,ERs),EXR	≥	0	-	4	-	2	8	0 ers 0	9	<u>م</u>	7	0		đ	disp	
	LDC @ERs+,CCR	≥	0	-	4	0		0	0 ers 0								
	LDC @ERs+,EXR	≥	0	-	4	-	9	0	0 ers 0								
	LDC @aa:16,CCR	≥	0	-	4	0	9	в	0		в	abs					
	LDC @aa:16,EXR	×	0	-	4	-	9	В	0		а	abs					

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Instruc-											Instructic	Instruction Format				
tion	Mnemonic	Size		1st Byte	2nd Byte	Byte	3rd Byte	lyte	4th Byte	3yte	5th Byte	6th Byte	7th Byte	8th Byte	9th Byte	10th Byte
LDC	LDC @aa:32,CCR	×	0	-	4	0	9	۵	5	0		at	abs			
	LDC @aa:32,EXR	Ν	0	-	4	1	9	В	2	0		at	abs			
ПDМ	LDM.L @SP+, (ERn-ERn+1)	_	0	-	-	0	9	٥	7	0 em+1						
	LDM.L @SP+, (ERn-ERn+2)	L	0	-	2	0	9	D	7	0 ern+2						
	LDM.L @SP+, (ERn-ERn+3)	_	0	-	3	0	9	D	7	0 ern+3						
LDMAC	LDMAC ERS, MACH	Ц	Canr	not be u	Ised wit	h the H	8S/213	8 Serie	s and	H8S/21	Cannot be used with the H8S/2138 Series and H8S/2134 Series.					
	LDMAC ERs, MACL	_														
MAC	MAC @ERn+,@ERm+	Ι														
MOV	MOV.B #xx:8,Rd	ш	ш	2	≦	MM										
	MOV.B Rs,Rd	В	0	c	rs	rd										
	MOV.B @ERs,Rd	В	9	8	0 ers	гq										
	MOV.B @(d:16,ERs),Rd	В	9	ш	0 ers	rd		disp	đ							
	MOV.B @(d:32,ERs),Rd	В	7	8	0 ers	0	9	A	2	rd		di	disp			
	MOV.B @ERs+,Rd	в	9	c	0 ers	p										
	MOV.B @aa:8,Rd	в	2	d	abs	S										
	MOV.B @aa:16,Rd	ш	9	۲	0	ē		abs	ş							
	MOV.B @aa:32,Rd	ш	9	A	2	Þ				abs	6					
	MOV.B Rs, @ERd	В	9	8	1 erd	rs										
	MOV.B Rs, @(d:16, ERd)	В	9	ш	1 erd	rs		disp	ġ.							
	MOV.B Rs, @(d:32, ERd)	В	7	8	0 erd	0	9	A	A	ſS		dis	disp			
	MOV.B Rs, @-ERd	ш	9	v	1 erd	rs										
	MOV.B Rs,@aa:8	в	з	ß	abs	SC										
	MOV.B Rs,@aa:16	В	9	A	8	rs		abs	ş							
	MOV.B Rs,@aa:32	в	9	A	A	rs				abs	5					
	MOV.W #xx:16,Rd	Ν	7	6	0	p		IMM	M							
	MOV.W Rs,Rd	≥	0	۵	s	Þ										
	MOV.W @ERs,Rd	Ν	9	6	0 ers	p										
	MOV.W @(d:16,ERs),Rd	≥	9	ш.	0 ers	Þ		disp	ġ.							
	MOV.W @(d:32,ERs),Rd	≥	2	∞	0 ers	0	9	в	2	P		di	disp			

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Instruc-	nomon	i							-	Instruction Format	n For	mat				
tion		Size	-	1st Byte	2nd Byte	3yte	3rd Byte	4th Byte		5th Byte	6th	6th Byte	7th Byte	8th Byte	9th Byte	10th Byte
MOV	MOV.W @ERs+,Rd	Μ	9	D	0 ers	гd										
	MOV.W @aa:16,Rd	Μ	9	В	0	р		abs								
	MOV.W @aa:32,Rd	3	9	в	2	Þ			abs							
	MOV.W Rs,@ERd	≥	9	6	1 erd	s										
	MOV.W Rs, @(d:16,ERd)	N	9	ш	1 erd	rs		disp								
	MOV.W Rs, @(d:32,ERd)	Ν	7	8	0 erd	0	6 B	A				disp	d			
	MOV.W Rs, @-ERd	Ν	9	D	1 erd	rs										
	MOV.W Rs,@aa:16	≥	9	ш	8	s		abs								
	MOV.W Rs,@aa:32	8	9	в	A	rs			abs							
	MOV.L #xx:32,Rd	_	2	A	0	0 erd			MMI							
	MOV.L ERS,ERd	_	0	ш	1 ers 0 erd	0 erd										
	MOV.L @ERs,ERd	_	0	-	0	0	6 9	0 ers 0 erd	p							
	MOV.L @(d:16,ERs),ERd	_	0	-	0	0	ц 9	0 ers 0 erd	rd	q	disp					
	MOV.L @(d:32,ERs),ERd	_	0	-	0	0	7 8	0 ers 0	9	<u></u>	2	0 erd		đi	disp	
	MOV.L @ERs+,ERd	_	0	-	0	0	6 D	0 ers 0 erd	rd							
	MOV.L @aa:16,ERd	_	0	-	0	0	6 B	0 0 erd	p	а	abs					
	MOV.L @aa:32 ,ERd	Γ	0	1	0	0	6 B	2 0 erd	rd			abs	0			
	MOV.L ERS,@ERd	_	0	-	0	0	6 9	1 erd 0 ers	S							
	MOV.L ERs, @(d:16,ERd)	_	0	-	0	0	9 9	1 erd 0 ers	S	q	disp					
	MOV.L ERs, @(d:32,ERd)*	_	0	-	0	0	7 8	0 erd 0	9	<u>م</u>	٩	0 ers		ġ	disp	
	MOV.L ERs,@-ERd	_	0	-	0	0	0 9	1 erd 0 ers	S							
	MOV.L ERs,@aa:16	_	0	-	0	0	9 9	8 0 ers	S	a	abs					
	MOV.L ERs,@aa:32	Ч	0	-	0	0	6 B	A 0 ers	S			abs	0			
MOVFPE	MOVFPE MOVFPE @aa:16,Rd	В	Cannc	ot be us	sed with	the H£	3S/2138 Se	Cannot be used with the H8S/2138 Series and H8S/2134 Series.	/2134 S	eries.						
MOVTPE	MOVTPE MOVTPE Rs, @aa:16	в														
MULXS	MULXS.B Rs,Rd	В	0	1	с	0	5 0	rs rd	-							
	MULXS.W Rs,ERd	≥	0	-	υ	0	5 2	rs 0 erd	p							
MULXU	MULXU.B Rs,Rd	в	5	0	rs	Þ										
	MULXU.W Rs,ERd	≥	5	2	rs	0 erd										

Instruc-	Mnemonic	į							Instructic	Instruction Format				
tion		azic	1st Byte	lyte	2nd Byte	3yte	3rd Byte	4th Byte	5th Byte	6th Byte	7th Byte	8th Byte	9th Byte	10th Byte
NEG	NEG.B Rd	в	-	7	8	rd								
	NEG.W Rd	3	-	7	റ	p								
	NEG.L ERd	_	-	7	<u>е</u>	0 erd								
NOP	NOP	Ι	0	0	0	0								
NOT	NOT.B Rd	ш	-	7	0	p								
	NOT.W Rd	≥	-	7	-	Þ								
	NOT.L ERd	_		7	ю	0 erd								
OR	OR.B #xx:8,Rd	в	υ	rd	IMM	¥								
	OR.B Rs,Rd	۵	-	4	s.	p								
	OR.W #xx:16,Rd	Ν	7	6	4	rd	4	IMM						
	OR.W RS,Rd	3	9	4	s	p								
	OR.L #xx:32,ERd	_	7	A	4	0 erd		IMMI	W					
	OR.L ERS,ERd	_	0	-	Ŀ	0	6 4	0 ers 0 erd						
ORC	ORC #xx:8,CCR	В	0	4	IMM	¥								
	ORC #xx:8,EXR	в	0	-	4	-	0 4	IMM						
РОР	POP.W Rn	8	9	۵	7	٤								
	POP.L ERn	_	0	-	0	0	0 9	7 0 ern						
PUSH	PUSH.W Rn	Ν	9	D	ч	ш								
	PUSH.LERn	_	0	-	0	0	0 9	F 0 ern						
ROTL	ROTL.B Rd	В	-	2	8	rd								
	ROTL.B #2, Rd	ш	-	7	U	Þ								
	ROTL.W Rd	Χ	-	2	6	p								
	ROTL.W #2, Rd	≥	-	7	۵	Þ								
	ROTL.L ERd	_	-	7	<u>е</u>	0 erd								
	ROTL.L #2, ERd	_	-	2	<u></u>	0 erd								

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Instruc-	Mamania	;							Instructic	Instruction Format				
tion		Size	•	1 st Byte	2nd Byte	syte	3rd Byte	4th Byte	5th Byte	6th Byte	7th Byte	8th Byte	9th Byte	10th Byte
ROTR	ROTR.B Rd	в	-	ю	8	Þ								
	ROTR.B #2, Rd	В	٢	3	c	rd								
	ROTR.W Rd	×	-	3	6	rd								
	ROTR.W #2, Rd	×	~	3	۵	p								
	ROTR.L ERd	_	-	в	<u>е</u>	0 erd								
	ROTR.L #2, ERd	_	-	3	ц.	0 erd								
ROTXL	ROTXL.B Rd	В	۲	2	0	rd								
	ROTXL.B #2, Rd	ш	-	2	4	Þ								
	ROTXL.W Rd	Χ	-	2	-	p								
	ROTXL.W #2, Rd	≥	-	2	2	Ð								
	ROTXL.L ERd	_	-	2	е С	0 erd								
	ROTXL.L #2, ERd	_	-	2	~	0 erd								
ROTXR	ROTXR.B Rd	В	۲	3	0	rd								
	ROTXR.B #2, Rd	в	-	ю	4	p								
	ROTXR.W Rd	Ν	۲	3	٢	rd								
	ROTXR.W #2, Rd	≥	~	з	5	Ъ								
	ROTXR.L ERd	Γ	٢	3	3	0 erd								
	ROTXR.L #2, ERd	_	-	ю	~	0 erd								
RTE	RTE	I	5	6	7	0								
RTS	RTS	I	2	4	7	0								
SHAL	SHAL.B Rd	в	-	0	8	rd								
	SHAL.B #2, Rd	В	٢	0	с	rd								
	SHAL.W Rd	≥	-	0	<u></u> б	rd								
	SHAL.W #2, Rd	×	-	0	D	rd								
	SHAL.L ERd	_	-	0	<u>е</u>	0 erd								
	SHAL.L #2, ERd	_	-	0	<u></u>	0 erd								

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Instruc-	Manual									-	Instruction Format	on Fori	mat				
tion		Size		1st Byte	2nd Byte	3yte	3rd Byte		4th Byte	-	5th Byte	6th	6th Byte	7th Byte	8th Byte	9th Byte	10th Byte
SHAR	SHAR.B Rd	B	-	-	80	p											
	SHAR.B #2, Rd	ш	-	-	U	Þ											
	SHAR.W Rd	Μ	-	+	6	p											
	SHAR.W #2, Rd	N	-	1	D	p											
	SHAR.LERd	_	1	1	8	0 erd											
	SHAR.L#2, ERd	_	-	-	<u></u> ш	0 erd											
SHLL	SHLL.B Rd	В	٢	0	0	p											
	SHLL.B #2, Rd	В	-	0	4	p											
	SHLL.W Rd	N	-	0	1	p											
	SHLL.W #2, Rd	Μ	1	0	5	rd											
	SHLL.L ERd	_	-	0	ю г	0 erd											
	SHLL.L #2, ERd	_	٢	0	2	0 erd											
SHLR	SHLR.B Rd	в	-	-	0	p											
	SHLR.B #2, Rd	В	-	+	4	p											
	SHLR.W Rd	×	-	+	-	Þ											
	SHLR.W #2, Rd	N	٢	1	5	p											
	SHLR.L ERd	-	-	-	ю.	0 erd											
	SHLR.L #2, ERd	L	۱	1	7 0	0 erd											
SLEEP	SLEEP	Ι	0	-	80	0											
STC	STC.B CCR,Rd	ш	0	2	0	Þ											
	STC.B EXR,Rd	۵	0	2	-	Þ											
	STC.W CCR, @ERd	≥	0	-	4	0		9	1 erd 0								
	STC.W EXR, @ERd	≥	0	-	4	-	9	9	1 erd 0								
	STC.W CCR, @(d:16,ERd)	×	0	-	4	0	9	Е.	erd 0	_	q	disp					
	STC.W EXR, @ (d: 16, ERd)	≥	0	-	4	-		щ. Т	1 erd 0		q	disp					
	STC.W CCR, @(d:32,ERd)	3	0	-	4	0	7	8	0 erd 0	9	<u>_</u>	٩	0		σ	disp	
	STC.W EXR, @ (d:32, ERd)	N	0	1	4	1	7	8 0	0 erd 0	9	В	A	0		q	disp	
	STC.W CCR, @-ERd	≥	0	-	4	0	 9	-	1 erd 0								
	STC.W EXR,@-ERd	≥	0	-	4	-		-	1 erd 0								

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Instruc-	Macmonio	;									Instruction Format				
tion		Size		1st Byte	2nd Byte	3yte	3rd Byte	/te	4th Byte		5th Byte 6th Byte	7th Byte	8th Byte	9th Byte	10th Byte
STC	STC.W CCR, @aa:16	Μ	0	-	4	0	9	В	8	0	abs				
	STC.W EXR,@aa:16	Ν	0	٢	4	+	9	В	8	0	abs				
	STC.W CCR, @aa:32	Ν	0	1	4	0	9	В	A	0	abs	S			
	STC.W EXR, @aa:32	Ν	0	1	4	-	9	В	A (0	at	abs			
STM	STM.L (ERn-ERn+1), @-SP	_	0	+	۲	0	9	D	F F	0 ern					
	STM.L (ERn-ERn+2), @-SP	_	0	-	2	0	9	۵	F 0 ern	ern					
	STM.L (ERn-ERn+3), @-SP	_	0	-	e	0	9	٥	F 0 ern	ern					
STMAC	STMAC MACH, ERd	-	Cann	ot be u:	sed with	the H8	S/2138	Series	and H8	Cannot be used with the H8S/2138 Series and H8S/2134 Series.	Series.				
	STMAC MACL, ERd	_													
SUB	SUB.B Rs,Rd	В	٢	8	rs	rd									
	SUB.W #xx:16,Rd	Ν	7	6	3	rd		IMM							
	SUB.W Rs,Rd	8	-	6	s	rd									
	SUB.L #xx:32,ERd	_	7	A	3	0 erd				IMM					
	SUB.L ERS, ERd	Г	٢	A	1 ers 0 erd	0 erd									
SUBS	SUBS #1,ERd	_	~	в	0	0 erd									
	SUBS #2,ERd	-	-	в	8	0 erd									
	SUBS #4,ERd	Г	٢	В	6	0 erd									
SUBX	SUBX #xx:8,Rd	в	в	rd	IMM	Σ									
	SUBX Rs,Rd	۵	-	ш	S	p									
TAS	TAS @ERd	ш	0	-	ш	0	7	В	0 erd (U					
TRAPA	TRAPA #x:2	Ι	5	7	00 IMM	0									
XOR	XOR.B #xx:8,Rd	ш	۵	p	MMI	Σ									
	XOR.B Rs,Rd	в	-	5	s	rd									
	XOR.W #xx:16,Rd	Ν	7	6	5	rd		IMM	_						
	XOR.W Rs,Rd	≥	9	5	S	p		_							
	XOR.L #xx:32,ERd	L	7	A	5	0 erd				IMM					
	XOR.L ERS, ERd	_	0	-	ш	0	9	5	0 ers 0 erd	erd					

$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$	Instruc-	Mnemonic	ï					Instructio	Instruction Format				
Z XORC #xx:5 XORC #xx:6 XORC #xx:6 ind ind ind ind ind ind ind ind ind ind	tion		SIZE		2nd byte	3rd byte	4th byte	5th byte	6th byte	7th byte	8th byte	9th byte	10th byte
XORC #xx:E ind ind ind ind: ind: ind: ind: ind: in	XORC	XORC #xx:8,CCR	В		MMI								
, m: erd, ern, erm: srd, ern, erm: zorrespondence Vddress Register ster Gen ER ER ER		XORC #xx:8,EXR	۵	0	4 1		MMI						
ind ard, ern, erm: sorrespondenco Address Register ster Gen ER ER ER ER	Note: *	Bit 7 of the 4th byte of	f the N	AOV.L ERs,	@ (d:32, EF	Rd) instructio	m can be eit	ther 0 or 1.					
, m: erd, ern, erm: correspondence Address Register 2-Bit Register ER ER ER ER	Legend IMM: abs:		e data iddres	(2, 3, 8, 16, s (8, 16, 24,	or 32 bits) or 32 bits)								
Address Register Shown in the following table. Address Register 16-Bit Register 8-Bit Register 32-Bit Register 6-Bit Register 8-Bit Register Register General Register 8-Bit Register Register General Register 6-Bit Register 000 ER0 0000 R0 0001 001 ER1 0001 R1 0001 001 ER1 0001 R1 0001 001 ER1 0001 R1 0001 001 ER7 0111 R7 111 ER7 0111 R1 111 E1 1000 R0 011 E1 1001 R1 011 E1 1011 R1 111 E1 1011 R1	disp: rs, rd, rr ers, erd		lent (ε eld (4 eld (3 eld (3 ERm,	3, 16, or 32 t bits, indicat bits, indicat respectively	bits) bits) ing an 8-bit (ing an addre	or 16-bit regi ss register c	ister. rs, rd, or 32-bit regi	and rn corre ister. ers, er	espond to of rd, ern, and	berand form erm corresp	ats Rs, Rd, oond to oper	and Rn, res and formats	bectively.) ERs, ERd,
ddress Registers 16-Bit Register 8-Bit Register 2-Bit Registers 16-Bit Register 8-Bit Register ster General Register 8-Bit Register ER0 0000 R0 0000 ER1 0000 R1 0000 ER1 0001 R1 0000 ER1 0001 R1 0001 ER7 0111 R7 0111 001 E1 1000 1000 1001 E1 1001 1001 0 001 E1 1001 1111 E7 1111 E7 1111	The cor	respondence between	regist	er fields anc	l general reç	jisters is sho	wn in the fo	lowing tabl	ē.				
tter General Register General Register Register Field Register Field Register ER0 0000 R0 0000 R0 0000 ER1 0001 R1 0001 R1 0001 ER1 0001 R1 0001 R1 0001 ER7 0111 R7 0111 R7 0111 ER7 0111 R7 0111 1001 1001 1001 E1 1001 1001 1101 11111 11111 1111	Adc 32-I	dress Registers Bit Registers		16-Bit	Register		8-Bit	Register					
ER0 0000 R0 0000 ER1 0001 R1 0001 • • • • • • • • • • • • • • • • • • •	Registé Field			Register Field	General Registe		Register Field	Genera Registe	er F				
ER1 0001 R1 0001 • • • • • • • • • • • • • • • • • • •	000	ERO		0000	RO		0000	ROH					
 ERZ 0111 ERZ 0111 RZ 0111 RZ 0111 1000 E0 1001 1001 1001 1001 1111 E7 1111 	001	ER1	_	0001	R1		0001	R1H					
 ERZ 0111 ERZ 0111 RZ 0111 RZ 0111 1000 1000 1001 1001 1001 1001 1111 E7 1111 	•	•		•	•		•	•					
ERZ 0111 R7 0111 1000 E0 1000 1001 E1 1001 • • • • • • • • • • • • • • • • • • •	•	•		•	•		•	•					
1000 E0 1000 1001 E1 1001 • • • • • • 1111 1111 E7 1111	• 11 1 1	ER7	2	0111	R 7		0111	R7H					
E1 1001 • • • 1111 E7				1000	EO		1000	ROL					
• • E7				1001	Ē		1001	R1L					
• • E7 1111				•	•		•	•					
• • E7 1111				•	•		•	•					
E7 1111				•	•		•	•					
				1111	E7		1111	R7L					

• ER7 • 5

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Table A.2 Instruction Codes (cont)

A.3 Operation Code Map

Table A.3 shows the operation code map.

Table A.3 Operation Code Map (1)

- Instruction when most significant bit of BH is 0.

2nd byte

1st byte

Instruction code:

		АН	AL	BH BL			•	 Instruction when most significant bit of BH is 1. 	n when mo	ost signific	ant bit of B	His 1.				
]											
AH	0	-	2	e	4	5	9	7	8	6	A	в	υ	٥	ш	ц
0	NOP	Table A.3 (2)	STC *	AC LDMAC	ORC	XORC	ANDC	LDC	AL	ADD	Table A.3 (2)	Table A.3 (2)	W	MOV	ADDX	Table A.3 (2)
-	Table A.3 (2)	Table A.3 (2)	Table A.3 (2)	ΫĂ	OR	XOR	AND	Table A.3 (2)	ึ่งเ	SUB	Table A.3 (2)	Table A.3 (2)	Ö	CMP	SUBX	Table A.3 (2)
2																
e								MOV.B	9. >							
4	BRA	BRN	BHI	BLS	BCC	BCS	BNE	BEQ	BVC	BVS	BPL	BMI	BGE	BLT	BGT	BLE
5	MULXU	DIVXU	MULXU	UXVID L	RTS	BSR	RTE	TRAPA	Table A.3 (2)		JMP		BSR		JSR	
9			č		R	XOR	AND	BST BIST	W	MOV	Table A.3 (2)			MOV		
2	BOE	BNOI	BULK		BOR BIOR	BXOR	BAND		MOV	Table A.3 (2)		EEPMOV		Table A.3 (3)	A.3 (3)	
80								ADD	0							
ი								ADDX	X							
۲								CMP	Ę							
ш								SUBX	BX							
υ								OR	æ							
۵								XOR	R							
ш								AND	Q							
ш								MOV	N							
Note:	* Cannot be	e used wit	th the H8	Note: * Cannot be used with the H8S/2138 Series and H8S/2134 Series.	es and H8	S/2134 Sei	ries.									

	2	m	4	2	9	7	ω	6	4	ш	U F	D	ш	L H
LDM STM LDC		g/	STC		MAC*		SLEEP		CLRMAC*		Table A.3 (3)	Table A.3 (3)	TAS	Table A.3 (3)
										AC	ADD			
				INC		INC	ADDS	SC				INC		INC
										W	MOV			
SHLL SHLL	SHL	SHL	Ļ			SHLL	SHAL	٦L			SHAL			SHAL
SHLR SHLR	SHL	SHLI	ĸ			SHLR	SHAR	AR			SHAR			SHAR
ROTXL ROTXL	ROTX	ROTX				ROTXL	ROTL	1			ROTL			ROTL
ROTXR ROTXR	ROTXR	ROTXR				ROTXR	ROTR	R			ROTR			ROTR
NOT NOT	NOT			ЕХТИ		ЕХТИ	NEG	U		NEG		EXTS		EXTS
										SI	SUB			
			_	DEC		DEC	SUBS	SS				DEC		DEC
										Ö	CMP			
BRN BHI BLS BCC		BCC		BCS	BNE	BEQ	BVC	BVS	BPL	BMI	BGE	BLT	BGT	BLE
Table MOV Table MOVFPE		MOVFF	*ш				MOV		MOV		MOVTPE			
ADD CMP SUB OR		OR		XOR	AND									
ADD CMP SUB OR		OR		XOR	AND									
Note: * Cannot be used with the H8S/2138 Series and H8S/2134 Series.	138 Series and H8	and H8	S/2	134 Serie	<i>i</i>									

Table A.3 Operation Code Map (2)

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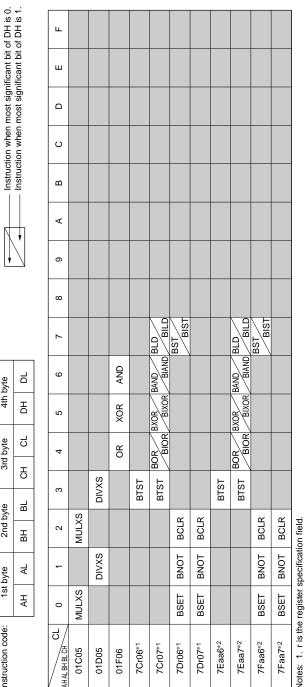
ВГ 2nd byte

ВН

AH

1st byte AL

Instruction code:



4th byte

3rd byte

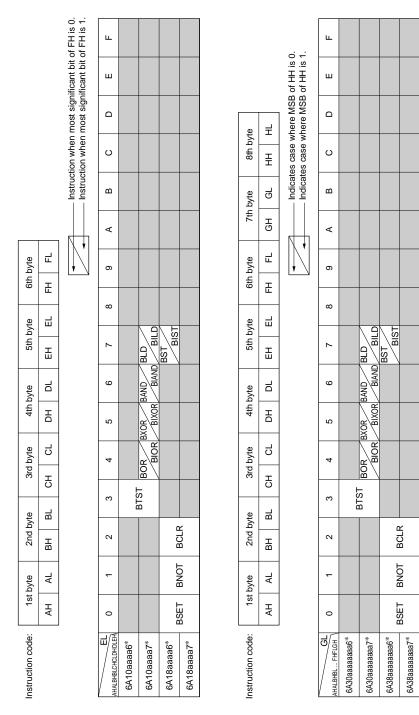
2nd byte

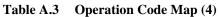
1st byte

Instruction code:

Notes: 1. r is the register specification field. 2. aa is the absolute address specification.

 Table A.3
 Operation Code Map (3)





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Note: * aa is the absolute address specification.

A.4 Number of States Required for Execution

The tables in this section can be used to calculate the number of states required for instruction execution by the H8S/2000 CPU. Table A.5 shows the number of instruction fetch, data read/write, and other cycles occurring in each instruction, and table A.4 shows the number of states required per cycle according to the bus size. The number of states required for execution of an instruction can be calculated from these two tables as follows:

Number of states = $I \times S_1 + J \times S_2 + K \times S_k + L \times S_L + M \times S_M + N \times S_N$

Examples of Calculation of Number of States Required for Execution

Examples: Advanced mode, stack located in external address space, on-chip supporting modules accessed in two states with 8-bit bus width, external devices accessed in three states with one wait state and 8-bit bus width.

1. BSET #0,@FFFFC7:8

From table A.5, I = L = 2 and J = K = M = N = 0From table A.4, $S_I = 8$ and $S_L = 2$ Number of states $= 2 \times 8 + 2 \times 2 = 20$

2. JSR @@30

From table A.5, I = J = K = 2 and L = M = N = 0From table A.4, $S_I = S_J = S_K = 8$ Number of states $= 2 \times 8 + 2 \times 8 + 2 \times 8 = 48$

			Ac	cess Cond	itions				
		0	On-Chip		External Device				
		Supporting Module		8-Bit Bus		16-Bit Bus			
Cycle	On-Chip Memory	8-Bit Bus	16-Bit Bus	2-State Access	3-State Access	2-State Access	3-State Access		
Instruction fetch	1	4	2	4	6 + 2m	2	3 + m		
S									
Branch address fetch									
S									
Stack operation									
S _κ									
Byte data access		2		2	3 + m	_			
SL									
Word data access		4		4	6 + 2m	_			
S _M									
Internal operation	1	1	1	1	1	1	1		
S _N									

Table A.4Number of States per Cycle

Legend:

m: Number of wait states inserted into external device access

Note: Cannot be used in the H8S/2138 Series and H8S/2134 Series.

Instruction	Mnemonic	Instruction Fetch I	Branch Address Read J	Stack Operation K	Byte Data Access L	Word Data Access M	Internal Operation N
ADD	ADD.B #xx:8,Rd	1					
	ADD.B Rs,Rd	1					
	ADD.W #xx:16,Rd	2					
	ADD.W Rs,Rd	1					
	ADD.L #xx:32,ERd	3					
	ADD.L ERs,ERd	1					
ADDS	ADDS #1/2/4,ERd	1					
ADDX	ADDX #xx:8,Rd	1					
	ADDX Rs,Rd	1					
AND	AND.B #xx:8,Rd	1					
	AND.B Rs,Rd	1					
	AND.W #xx:16,Rd	2					
	AND.W Rs,Rd	1					
	AND.L #xx:32,ERd	3					
	AND.L ERs,ERd	2					
ANDC	ANDC #xx:8,CCR	1					
	ANDC #xx:8,EXR	2					
BAND	BAND #xx:3,Rd	1					
	BAND #xx:3,@ERd	2			1		
	BAND #xx:3,@aa:8	2			1		
	BAND #xx:3,@aa:16	3			1		
	BAND #xx:3,@aa:32	4			1		
Bcc	BRA d:8 (BT d:8)	2					
	BRN d:8 (BF d:8)	2					
	BHI d:8	2					
	BLS d:8	2					
	BCC d:8 (BHS d:8)	2					
	BCS d:8 (BLO d:8)	2					
	BNE d:8	2					
	BEQ d:8	2					
	BVC d:8	2					
	BVS d:8	2					
	BPL d:8	2					
	BMI d:8	2					
	BGE d:8	2					
	BLT d:8	2					

Instruction	Mnemonic	Instruction Fetch I	Branch Address Read J	Stack Operation K	Byte Data Access L	Word Data Access M	Internal Operation N
Bcc	BGT d:8	2					
	BLE d:8	2					
	BRA d:16 (BT d:16)	2					1
	BRN d:16 (BF d:16)	2					1
	BHI d:16	2					1
	BLS d:16	2					1
	BCC d:16 (BHS d:16)	2					1
	BCS d:16 (BLO d:16)	2					1
	BNE d:16	2					1
	BEQ d:16	2					1
	BVC d:16	2					1
	BVS d:16	2					1
	BPL d:16	2					1
	BMI d:16	2					1
	BGE d:16	2					1
	BLT d:16	2					1
	BGT d:16	2					1
	BLE d:16	2					1
BCLR	BCLR #xx:3,Rd	1					
	BCLR #xx:3,@ERd	2			2		
	BCLR #xx:3,@aa:8	2			2		
	BCLR #xx:3,@aa:16	3			2		
	BCLR #xx:3,@aa:32	4			2		
	BCLR Rn,Rd	1					
	BCLR Rn,@ERd	2			2		
	BCLR Rn,@aa:8	2			2		
	BCLR Rn,@aa:16	3			2		
	BCLR Rn,@aa:32	4			2		
BIAND	BIAND #xx:3,Rd	1					
	BIAND #xx:3,@ERd	2			1		
	BIAND #xx:3,@aa:8	2			1		
	BIAND #xx:3,@aa:16	3			1		
	BIAND #xx:3,@aa:32	4			1		

Instruction	Mnemonic	Instruction Fetch I	Branch Address Read J	Stack Operation K	Byte Data Access L	Word Data Access M	Internal Operation N
BILD	BILD #xx:3,Rd	1					
	BILD #xx:3,@ERd	2			1		
	BILD #xx:3,@aa:8	2			1		
	BILD #xx:3,@aa:16	3			1		
	BILD #xx:3,@aa:32	4			1		
BIOR	BIOR #xx:8,Rd	1					
	BIOR #xx:8,@ERd	2			1		
	BIOR #xx:8,@aa:8	2			1		
	BIOR #xx:8,@aa:16	3			1		
	BIOR #xx:8,@aa:32	4			1		
BIST	BIST #xx:3,Rd	1					
	BIST #xx:3,@ERd	2			2		
	BIST #xx:3,@aa:8	2			2		
	BIST #xx:3,@aa:16	3			2		
	BIST #xx:3,@aa:32	4			2		
BIXOR	BIXOR #xx:3,Rd	1					
	BIXOR #xx:3,@ERd	2			1		
	BIXOR #xx:3,@aa:8	2			1		
	BIXOR #xx:3,@aa:16	3			1		
	BIXOR #xx:3,@aa:32	4			1		
BLD	BLD #xx:3,Rd	1					
	BLD #xx:3,@ERd	2			1		
	BLD #xx:3,@aa:8	2			1		
	BLD #xx:3,@aa:16	3			1		
	BLD #xx:3,@aa:32	4			1		
BNOT	BNOT #xx:3,Rd	1					
	BNOT #xx:3,@ERd	2			2		
	BNOT #xx:3,@aa:8	2			2		
	BNOT #xx:3,@aa:16	3			2		
	BNOT #xx:3,@aa:32	4			2		
	BNOT Rn,Rd	1					
	BNOT Rn,@ERd	2			2		
	BNOT Rn,@aa:8	2			2		
	BNOT Rn,@aa:16	3			2		
	BNOT Rn,@aa:32	4			2		

Instruction	Mnemonic		Instruction Fetch I	Branch Address Read J	Stack Operation K	Byte Data Access L	Word Data Access M	Internal Operation N
BOR	BOR #xx:3,R	d	1					
	BOR #xx:3,@	ERd	2			1		
	BOR #xx:3,@	aa:8	2			1		
	BOR #xx:3,@	aa:16	3			1		
	BOR #xx:3,@	aa:32	4			1		
BSET	BSET #xx:3,F	٦d	1					
	BSET #xx:3,0	@ERd	2			2		
	BSET #xx:3,0	@aa:8	2			2		
	BSET #xx:3,0	@aa:16	3			2		
	BSET #xx:3,0	@aa:32	4			2		
	BSET Rn,Rd		1					
	BSET Rn,@E	Rd	2			2		
	BSET Rn,@a	ia:8	2			2		
	BSET Rn,@a	a:16	3			2		
	BSET Rn,@a	a:32	4			2		
BSR	BSR d:8	Normal	2		1			
		Advanced	2		2			
	BSR d:16	Normal	2		1			1
		Advanced	2		2			1
BST	BST #xx:3,Ro	t	1					
	BST #xx:3,@	ERd	2			2		
	BST #xx:3,@	aa:8	2			2		
	BST #xx:3,@	aa:16	3			2		
	BST #xx:3,@	aa:32	4			2		
BTST	BTST #xx:3,F	۶d	1					
	BTST #xx:3,0	@ERd	2			1		
	BTST #xx:3,0	@aa:8	2			1		
	BTST #xx:3,0	@aa:16	3			1		
	BTST #xx:3,0	@aa:32	4			1		
	BTST Rn,Rd		1					
	BTST Rn,@E	Rd	2			1		
	BTST Rn,@a	a:8	2			1		
	BTST Rn,@a	a:16	3			1		
	BTST Rn,@a	a:32	4			1		

Instruction	Mnemonic		Instruction Fetch I	Branch Address Read J	Stack Operation K	Byte Data Access L	Word Data Access M	Internal Operation N
BXOR	BXOR #xx:3,Rd		1					
	BXOR #xx:3,@E	Rd	2			1		
	BXOR #xx:3,@a	a:8	2			1		
	BXOR #xx:3,@a	a:16	3			1		
	BXOR #xx:3,@a	a:32	4			1		
CLRMAC	CLRMAC		Cannot be us	ed with the H	8S/2138 Serie	s and H8S/213	34 Series.	
CMP	CMP.B #xx:8,Rd		1					
	CMP.B Rs,Rd		1					
	CMP.W #xx:16,F	Rd	2					
	CMP.W Rs,Rd		1					
	CMP.L #xx:32,E	Rd	3					
	CMP.L ERs,ERd	I	1					
DAA	DAA Rd		1					
DAS	DAS Rd		1					
DEC	DEC.B Rd		1					
	DEC.W #1/2,Rd		1					
	DEC.L #1/2,ERd		1					
DIVXS	DIVXS.B Rs,Rd		2					11
	DIVXS.W Rs,ER	d	2					19
DIVXU	DIVXU.B Rs,Rd		1					11
	DIVXU.W Rs,ER	d	1					19
EEPMOV	EEPMOV.B		2			2n+2 *2		
	EEPMOV.W		2			2n+2 *2		
EXTS	EXTS.W Rd		1					
	EXTS.L ERd		1					
EXTU	EXTU.W Rd		1					
	EXTU.L ERd		1					
INC	INC.B Rd		1					
	INC.W #1/2,Rd		1					
	INC.L #1/2,ERd		1					
JMP	JMP @ERn		2					
	JMP @aa:24		2					1
	JMP @@aa:8	Normal	2	1				1
		Advanced	2	2				1

Instruction	Mnemonic		Instruction Fetch I	Branch Address Read J	Stack Operation K	Byte Data Access L	Word Data Access M	Internal Operation N
JSR	JSR @ERn	Normal	2		1			
		Advanced	2		2			
	JSR @aa:24	Normal	2		1			1
		Advanced	2		2			1
	JSR @@aa:8	Normal	2	1	1			
		Advanced	2	2	2			
LDC	LDC #xx:8,CCR		1					
	LDC #xx:8,EXR		2					
	LDC Rs,CCR		1					
	LDC Rs,EXR		1					
	LDC @ERs,CCI	R	2				1	
	LDC @ERs,EXF	ર	2				1	
	LDC @(d:16,ER	s),CCR	3				1	
	LDC @(d:16,ER	s),EXR	3				1	
	LDC @(d:32,ER	s),CCR	5				1	
	LDC @(d:32,ER	s),EXR	5				1	
	LDC @ERs+,CO	CR	2				1	1
	LDC @ERs+,E>	(R	2				1	1
	LDC @aa:16,C0	CR	3				1	
	LDC @aa:16,E>	(R	3				1	
	LDC @aa:32,C0	CR	4				1	
	LDC @aa:32,E>	(R	4				1	
LDM	LDM.L @SP+, (E	Rn-ERn+1)	2		4			1
	LDM.L @SP+, (E	Rn-ERn+2)	2		6			1
	LDM.L @SP+, (E	Rn-ERn+3)	2		8			1
LDMAC	LDMAC ERs, M	ACH	Cannot be us	ed with the H	18S/2138 Serie	s and H8S/21	34 Series.	
	LDMAC ERs, M	ACL						
MAC	MAC @ERn+, @	⊉ERm+	_					
MOV	MOV.B #xx:8,Ro	b	1					
	MOV.B Rs,Rd		1					
	MOV.B @ERs,F	۲d	1			1		
	MOV.B @(d:16,	ERs),Rd	2			1		
	MOV.B @(d:32,	ERs),Rd	4			1		
	MOV.B @ERs+	,Rd	1			1		1
	MOV.B @aa:8,F	۶d	1			1		
	MOV.B @aa:16	,Rd	2			1		

Instruction	Mnemonic	Instruction Fetch I	Branch Address Read J	Stack Operation K	Byte Data Access L	Word Data Access M	Internal Operation N
MOV	MOV.B @aa:32,Rd	3			1		
	MOV.B Rs,@ERd	1			1		
	MOV.B Rs,@(d:16,ERd)	2			1		
	MOV.B Rs,@(d:32,ERd)	4			1		
	MOV.B Rs,@-ERd	1			1		1
	MOV.B Rs,@aa:8	1			1		
	MOV.B Rs,@aa:16	2			1		
	MOV.B Rs,@aa:32	3			1		
	MOV.W #xx:16,Rd	2					
	MOV.W Rs,Rd	1					
	MOV.W @ERs,Rd	1				1	
	MOV.W @(d:16,ERs),Rd	2				1	
	MOV.W @(d:32,ERs),Rd	4				1	
	MOV.W @ERs+,Rd	1				1	1
	MOV.W @aa:16,Rd	2				1	
	MOV.W @aa:32,Rd	3				1	
	MOV.W Rs,@ERd	1				1	
	MOV.W Rs,@(d:16,ERd)	2				1	
	MOV.W Rs,@(d:32,ERd)	4				1	
	MOV.W Rs,@-ERd	1				1	1
	MOV.W Rs,@aa:16	2				1	
	MOV.W Rs,@aa:32	3				1	
	MOV.L #xx:32,ERd	3					
	MOV.L ERs,ERd	1					
	MOV.L @ERs,ERd	2				2	
	MOV.L @(d:16,ERs),ERd	3				2	
	MOV.L @(d:32,ERs),ERd	5				2	
	MOV.L @ERs+,ERd	2				2	1
	MOV.L @aa:16,ERd	3				2	
	MOV.L @aa:32,ERd	4				2	
	MOV.L ERs,@ERd	2				2	
	MOV.L ERs,@(d:16,ERd)	3				2	
	MOV.L ERs,@(d:32,ERd)	5				2	
	MOV.L ERs,@-ERd	2				2	1
	MOV.L ERs,@aa:16	3				2	
	MOV.L ERs,@aa:32	4				2	

Instruction	Mnemonic	Instruction Fetch I	Branch Address Read J	Stack Operation K	Byte Data Access L	Word Data Access M	Internal Operation N	
MOVFPE	MOVFPE @:aa:16,Rd	Cannot be us	ed with the H	I8S/2138 Serie	s and H8S/21	34 Series.		
MOVTPE	MOVTPE Rs,@:aa:16		_					
MULXS	MULXS.B Rs,Rd	2					11	
	MULXS.W Rs,ERd	2					19	
MULXU	MULXU.B Rs,Rd	1					11	
	MULXU.W Rs,ERd	1					19	
NEG	NEG.B Rd	1						
	NEG.W Rd	1						
	NEG.L ERd	1						
NOP	NOP	1						
NOT	NOT.B Rd	1						
	NOT.W Rd	1						
	NOT.L ERd	1						
OR	OR.B #xx:8,Rd	1						
	OR.B Rs,Rd	1						
	OR.W #xx:16,Rd	2						
	OR.W Rs,Rd	1						
	OR.L #xx:32,ERd	3						
	OR.L ERs,ERd	2						
ORC	ORC #xx:8,CCR	1						
	ORC #xx:8,EXR	2						
POP	POP.W Rn	1				1	1	
	POP.L ERn	2				2	1	
PUSH	PUSH.W Rn	1				1	1	
	PUSH.L ERn	2				2	1	
ROTL	ROTL.B Rd	1						
	ROTL.B #2,Rd	1						
	ROTL.W Rd	1						
	ROTL.W #2,Rd	1						
	ROTL.L ERd	1						
	ROTL.L #2,ERd	1						

Instruction	Mnemonic		Instruction Fetch I	Branch Address Read J	Stack Operation K	Byte Data Access L	Word Data Access M	Internal Operation N
ROTR	ROTR.B Rd		1					
	ROTR.B #2,F	۲d	1					
	ROTR.W Rd		1					
	ROTR.W #2,I	٦d	1					
	ROTR.L ERd		1					
	ROTR.L #2,E	Rd	1					
ROTXL	ROTXL.B Rd		1					
	ROTXL.B #2,	Rd	1					
	ROTXL.W Ro	ł	1					
	ROTXL.W #2	,Rd	1					
	ROTXL.L ER	d	1					
	ROTXL.L #2,	ERd	1					
ROTXR	ROTXR.B Rd		1					
	ROTXR.B #2	,Rd	1					
	ROTXR.W R	b	1					
	ROTXR.W #2	2,Rd	1					
	ROTXR.L ER	d	1					
	ROTXR.L #2,	ERd	1					
RTE	RTE		2		2/3 *1			1
RTS	RTS	Normal	2		1			1
		Advanced	2		2			1
SHAL	SHAL.B Rd		1					
	SHAL.B #2,R	d	1					
	SHAL.W Rd		1					
	SHAL.W #2,F	Rd	1					
	SHAL.L ERd		1					
	SHAL.L #2,EI	٦d	1					
SHAR	SHAR.B Rd		1					
	SHAR.B #2,R	d	1					
	SHAR.W Rd		1					
	SHAR.W #2,F	۶d	1					
	SHAR.L ERd		1					
	SHAR.L #2,E	Rd	1					

Instruction	Mnemonic	Instruction Fetch I	Branch Address Read J	Stack Operation K	Byte Data Access L	Word Data Access M	Internal Operation N
SHLL	SHLL.B Rd	1					
	SHLL.B #2,Rd	1					
	SHLL.W Rd	1					
	SHLL.W #2,Rd	1					
	SHLL.L ERd	1					
	SHLL.L #2,ERd	1					
SHLR	SHLR.B Rd	1					
	SHLR.B #2,Rd	1					
	SHLR.W Rd	1					
	SHLR.W #2,Rd	1					
	SHLR.L ERd	1					
	SHLR.L #2,ERd	1					
SLEEP	SLEEP	1					1
STC	STC.B CCR,Rd	1					
	STC.B EXR,Rd	1					
	STC.W CCR,@ERd	2				1	
	STC.W EXR,@ERd	2				1	
	STC.W CCR,@(d:16,ERd)	3				1	
	STC.W EXR,@(d:16,ERd)	3				1	
	STC.W CCR,@(d:32,ERd)	5				1	
	STC.W EXR,@(d:32,ERd)	5				1	
	STC.W CCR,@-ERd	2				1	1
	STC.W EXR,@-ERd	2				1	1
	STC.W CCR,@aa:16	3				1	
	STC.W EXR,@aa:16	3				1	
	STC.W CCR,@aa:32	4				1	
	STC.W EXR,@aa:32	4				1	
STM	STM.L (ERn-ERn+1),@-SP	2		4			1
	STM.L (ERn-ERn+2),@-SP	2		6			1
	STM.L (ERn-ERn+3),@-SP	2		8			1
SUB	SUB.B Rs,Rd	1					
	SUB.W #xx:16,Rd	2					
	SUB.W Rs,Rd	1					
	SUB.L #xx:32,ERd	3					
	SUB.L ERs,ERd	1					

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Instruction	Mnemonic		Instruction Fetch I	Branch Address Read J	Stack Operation K	Byte Data Access L	Word Data Access M	Internal Operation N
SUBS	SUBS #1/2/4,	ERd	1					
SUBX	SUBX #xx:8,F	۲d	1					
	SUBX Rs,Rd		1					
TAS	TAS @ERd		2			2		
TRAPA	TRAPA #x:2	Normal	2	1	2/3 * ¹			2
		Advanced	2	2	2/3 *1			2
XOR	XOR.B #xx:8,	Rd	1					
	XOR.B Rs,Rd		1					
	XOR.W #xx:1	6,Rd	2					
	XOR.W Rs,Ro	ł	1					
	XOR.L #xx:32	,ERd	3					
	XOR.L ERs,E	Rd	2					
XORC	XORC #xx:8,0	CCR	1					
	XORC #xx:8,8	EXR	2					

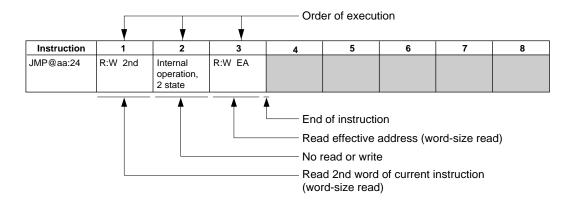
Notes: 1. 2 when EXR is invalid, 3 when valid.

2. When n bytes of data are transferred.

A.5 Bus States During Instruction Execution

Table A.6 indicates the types of cycles that occur during instruction execution by the CPU. See table A.4 for the number of states per cycle.

How to Read the Table:



Legend:

R:B	Byte-size read
R:W	Word-size read
W:B	Byte-size write
W:W	Word-size write
:M	Transfer of the bus is not performed immediately after this cycle
2nd	Address of 2nd word (3rd and 4th bytes)
3rd	Address of 3rd word (5th and 6th bytes)
4th	Address of 4th word (7th and 8th bytes)
5th	Address of 5th word (9th and 10th bytes)
NEXT	Start address of instruction following executing instruction
EA	Effective address
VEC	Vector address

Figure A.1 shows timing waveforms for the address bus and the $\overline{\text{RD}}$ and $\overline{\text{WR}}$ signals during execution of the above instruction with an 8-bit bus, using three-state access with no wait states.

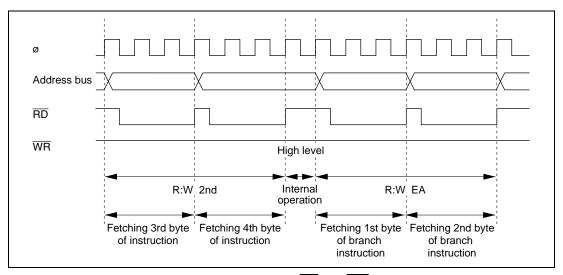


Figure A.1 Address Bus, RD and WR Timing (8-Bit Bus, Three-State Access, No Wait States)

Instruction	1	2	3	4	5	6	7	8	9
ADD.B #xx:8,Rd	R:W NEXT								
ADD.B Rs,Rd	R:W NEXT								
ADD.W #xx:16,Rd	R:W 2nd	R:W NEXT							
ADD.W Rs,Rd	R:W NEXT								
ADD.L #xx:32,ERd	R:W 2nd	R:W 3rd	R:W NEXT						
ADD.L ERs,ERd	R:W NEXT								
ADDS #1/2/4,ERd	R:W NEXT								
ADDX #xx:8,Rd	R:W NEXT								
ADDX Rs,Rd	R:W NEXT								
AND.B #xx:8,Rd	R:W NEXT								
AND.B Rs,Rd	R:W NEXT								
AND.W #xx:16,Rd	R:W 2nd	R:W NEXT							
AND.W Rs,Rd	R:W NEXT								
AND.L #xx:32,ERd	R:W 2nd	R:W 3rd	R:W NEXT						
AND.L ERs,ERd	R:W 2nd	R:W NEXT							
ANDC #xx:8,CCR	R:W NEXT								
ANDC #xx:8,EXR	R:W 2nd	R:W NEXT							
BAND #xx:3,Rd	R:W NEXT								
BAND #xx:3,@ERd	R:W 2nd	R:B EA	R:W:M NEXT						
BAND #xx:3,@aa:8	R:W 2nd	R:B EA	R:W:M NEXT						
BAND #xx:3, @aa:16	R:W 2nd	R:W 3rd	R:B EA	R:W:M NEXT					
BAND #xx:3, @aa:32	R:W 2nd	R:W 3rd	R:W 4th	R:B EA	R:W:M NEXT				
BRA d:8 (BT d:8)	R:W NEXT	R:W EA							
BRN d:8 (BF d:8)	R:W NEXT	R:W EA							
BHI d:8	R:W NEXT	R:W EA							
BLS d:8	R:W NEXT	R:W EA							
BCC d:8 (BHS d:8)	R:W NEXT	R:W EA							
BCS d:8 (BLO d:8)	R:W NEXT	R:W EA							
BNE d:8	R:W NEXT	R:W EA							
BEQ d:8	R:W NEXT	R:W EA							
BVC d:8	R:W NEXT	R:W EA							
BVS d:8	R:W NEXT	R:W EA							
BPL d:8	R:W NEXT	R:W EA							

 Table A.6
 Instruction Execution Cycle

Instruction	1	2	3	4	5	6	7	8	9
BMI d:8	R:W NEXT	R:W EA							
BGE d:8	R:W NEXT	R:W EA							
BLT d:8	R:W NEXT	R:W EA							
BGT d:8	R:W NEXT	R:W EA							
BLE d:8	R:W NEXT	R:W EA							
BRA d:16 (BT d:16)	R:W 2nd	Internal operation, 1 state	R:W EA						
BRN d:16 (BF d:16)	R:W 2nd	Internal operation, 1 state	R:W EA						
BHI d:16	R:W 2nd	Internal operation, 1 state	R:W EA						
BLS d:16	R:W 2nd	Internal operation, 1 state	R:W EA						
BCC d:16 (BHS d:16)	R:W 2nd	Internal operation, 1 state	R:W EA						
BCS d:16 (BLO d:16)	R:W 2nd	Internal operation, 1 state	R:W EA						
BNE d:16	R:W 2nd	Internal operation, 1 state	R:W EA						
BEQ d:16	R:W 2nd	Internal operation, 1 state	R:W EA						
BVC d:16	R:W 2nd	Internal operation, 1 state	R:W EA						
BVS d:16	R:W 2nd	Internal operation, 1 state	R:W EA						
BPL d:16	R:W 2nd	Internal operation, 1 state	R:W EA						
BMI d:16	R:W 2nd	Internal operation, 1 state	R:W EA						
BGE d:16	R:W 2nd	Internal operation, 1 state	R:W EA						

 Table A.6
 Instruction Execution Cycle (cont)

Instruction	1	2	3	4	5	6	7	8	9
BLT d:16	R:W 2nd	Internal operation, 1 state	R:W EA						
BGT d:16	R:W 2nd	Internal operation, 1 state	R:W EA						
BLE d:16	R:W 2nd	Internal operation, 1 state	R:W EA						
BCLR #xx:3,Rd	R:W NEXT								
BCLR #xx:3,@ERd	R:W 2nd	R:B:M EA	R:W:M NEXT	W:B EA					
BCLR #xx:3,@aa:8	R:W 2nd	R:B:M EA	R:W:M NEXT	W:B EA					
BCLR #xx:3, @aa:16	R:W 2nd	R:W 3rd	R:B:M EA	R:W:M NEXT	W:B EA				
BCLR #xx:3, @aa:32	R:W 2nd	R:W 3rd	R:W 4th	R:B:M EA	R:W:M NEXT	W:B EA			
BCLR Rn,Rd	R:W NEXT								
BCLR Rn,@ERd	R:W 2nd	R:B:M EA	R:W:M NEXT	W:B EA					
BCLR Rn,@aa:8	R:W 2nd	R:B:M EA	R:W:M NEXT	W:B EA					
BCLR Rn,@aa:16	R:W 2nd	R:W 3rd	R:B:M EA	R:W:M NEXT	W:B EA				
BCLR Rn,@aa:32	R:W 2nd	R:W 3rd	R:W 4th	R:B:M EA	R:W:M NEXT	W:B EA			
BIAND #xx:3,Rd	R:W NEXT								
BIAND #xx:3, @ERd	R:W 2nd	R:B EA	R:W:M NEXT						
BIAND #xx:3, @aa:8	R:W 2nd	R:B EA	R:W:M NEXT						
BIAND #xx:3, @aa:16	R:W 2nd	R:W 3rd	R:B EA	R:W:M NEXT					
BIAND #xx:3, @aa:32	R:W 2nd	R:W 3rd	R:W 4th	R:B EA	R:W:M NEXT				
BILD #xx:3,Rd	R:W NEXT								
BILD #xx:3,@ERd	R:W 2nd	R:B EA	R:W:M NEXT						
BILD #xx:3,@aa:8	R:W 2nd	R:B EA	R:W:M NEXT						
BILD #xx:3,@aa:16	R:W 2nd	R:W 3rd	R:B: EA	R:W:M NEXT					

 Table A.6
 Instruction Execution Cycle (cont)

Instruction	1	2	3	4	5	6	7	8	9
BILD #xx:3,@aa:32	R:W 2nd	R:W 3rd	R:W 4th	R:B EA	R:W:M NEXT				
BIOR #xx:3,Rd	R:W NEXT								
BIOR #xx:3,@ERd	R:W 2nd	R:B EA	R:W:M NEXT						
BIOR #xx:3,@aa:8	R:W 2nd	R:B EA	R:W:M NEXT						
BIOR #xx:3,@aa:16	R:W 2nd	R:W 3rd	R:B EA	R:W:M NEXT					
BIOR #xx:3,@aa:32	R:W 2nd	R:W 3rd	R:W 4th	R:B EA	R:W:M NEXT				
BIST #xx:3,Rd	R:W NEXT								
BIST #xx:3,@ERd	R:W 2nd	R:B:M EA	R:W:M NEXT	W:B EA					
BIST #xx:3,@aa:8	R:W 2nd	R:B:M EA	R:W:M NEXT	W:B EA					
BIST #xx:3,@aa:16	R:W 2nd	R:W 3rd	R:B:M EA	R:W:M NEXT	W:B EA				
BIST #xx:3,@aa:32	R:W 2nd	R:W 3rd	R:W 4th	R:B:M EA	R:W:M NEXT	W:B EA			
BIXOR #xx:3,Rd	R:W NEXT								
BIXOR #xx:3, @ERd	R:W 2nd	R:B EA	R:W:M NEXT						
BIXOR #xx:3, @aa:8	R:W 2nd	R:B EA	R:W:M NEXT						
BIXOR #xx:3, @aa:16	R:W 2nd	R:W 3rd	R:B EA	R:W:M NEXT					
BIXOR #xx:3, @aa:32	R:W 2nd	R:W 3rd	R:W 4th	R:B EA	R:W:M NEXT				
BLD #xx:3,Rd	R:W NEXT								
BLD #xx:3,@ERd	R:W 2nd	R:B EA	R:W:M NEXT						
BLD #xx:3,@aa:8	R:W 2nd	R:B EA	R:W:M NEXT						
BLD #xx:3,@aa:16	R:W 2nd	R:W 3rd	R:B EA	R:W:M NEXT					
BLD #xx:3,@aa:32	R:W 2nd	R:W 3rd	R:W 4th	R:B EA	R:W:M NEXT				
BNOT #xx:3,Rd	R:W NEXT								
BNOT #xx:3,@ERd	R:W 2nd	R:B:M EA	R:W:M NEXT	W:B EA					

 Table A.6
 Instruction Execution Cycle (cont)

Instruction	1	2	3	4	5	6	7	8	9
BNOT #xx:3,@aa:8	R:W 2nd	R:B:M EA	R:W:M NEXT	W:B EA					
BNOT #xx:3, @aa:16	R:W 2nd	R:W 3rd	R:B:M EA	R:W:M NEXT	W:B EA				
BNOT #xx:3, @aa:32	R:W 2nd	R:W 3rd	R:W 4th	R:B:M EA	R:W:M NEXT	W:B EA			
BNOT Rn,Rd	R:W NEXT								
BNOT Rn,@ERd	R:W 2nd	R:B:M EA	R:W:M NEXT	W:B EA					
BNOT Rn,@aa:8	R:W 2nd	R:B:M EA	R:W:M NEXT	W:B EA					
BNOT Rn,@aa:16	R:W 2nd	R:W 3rd	R:B:M EA	R:W:M NEXT	W:B EA				
BNOT Rn,@aa:32	R:W 2nd	R:W 3rd	R:W 4th	R:B:M EA	R:W:M NEXT	W:B EA			
BOR #xx:3,Rd	R:W NEXT								
BOR #xx:3,@ERd	R:W 2nd	R:B EA	R:W:M NEXT						
BOR #xx:3,@aa:8	R:W 2nd	R:B EA	R:W:M NEXT						
BOR #xx:3,@aa:16	R:W 2nd	R:W 3rd	R:B EA	R:W:M NEXT					
BOR #xx:3,@aa:32	R:W 2nd	R:W 3rd	R:W 4th	R:B EA	R:W NEXT				
BSET #xx:3,Rd	R:W NEXT								
BSET #xx:3,@ERd	R:W 2nd	R:B:M EA	R:W:M NEXT	W:B EA					
BSET #xx:3,@aa:8	R:W 2nd	R:B:M EA	R:W:M NEXT	W:B EA					
BSET #xx:3, @aa:16	R:W 2nd	R:W 3rd	R:B:M EA	R:W:M NEXT	W:B EA				
BSET #xx:3, @aa:32	R:W 2nd	R:W 3rd	R:W 4th	R:B:M EA	R:W:M NEXT	W:B EA			
BSET Rn,Rd	R:W NEXT								
BSET Rn,@ERd	R:W 2nd	R:B:M EA	R:W:M NEXT	W:B EA					
BSET Rn,@aa:8	R:W 2nd	R:B:M EA	R:W:M NEXT	W:B EA					
BSET Rn,@aa:16	R:W 2nd	R:W 3rd	R:B:M EA	R:W:M NEXT	W:B EA				
BSET Rn,@aa:32	R:W 2nd	R:W 3rd	R:W 4th	R:B:M EA	R:W:M NEXT	W:B EA			

 Table A.6
 Instruction Execution Cycle (cont)

Instru	ction	1	2	3	4	5	6	7	8	9
BSR A d:8	Advanced	R:W NEXT	R:W EA	W:W:M Stack (H)	W:W Stack (L)					
BSR A d:16	Advanced	R:W 2nd	Internal operation, 1 state	R:W EA	W:W:M Stack (H)	W:W Stack (L)				
BST #xx:3	,Rd	R:W NEXT								
BST #xx:3	,@ERd	R:W 2nd	R:B:M EA	R:W:M NEXT	W:B EA					
BST #xx:3	,@aa:8	R:W 2nd	R:B:M EA	R:W:M NEXT	W:B EA					
BST #xx:3	,@aa:16	R:W 2nd	R:W 3rd	R:B:M EA	R:W:M NEXT	W:B EA				
BST #xx:3	,@aa:32	R:W 2nd	R:W 3rd	R:W 4th	R:B:M EA	R:W:M NEXT	W:B EA			
BTST #xx:	3,Rd	R:W NEXT								
BTST #xx:	3,@ERd	R:W 2nd	R:B EA	R:W:M NEXT						
BTST #xx:	3,@aa:8	R:W 2nd	R:B EA	R:W:M NEXT						
BTST #xx: @aa:16	3,	R:W 2nd	R:W 3rd	R:B EA	R:W:M NEXT					
BTST #xx: @aa:32	3,	R:W 2nd	R:W 3rd	R:W 4th	R:B EA	R:W:M NEXT				
BTST Rn,F	۶d	R:W NEXT								
BTST Rn,0	@ERd	R:W 2nd	R:B EA	R:W:M NEXT						
BTST Rn,0	@aa:8	R:W 2nd	R:B EA	R:W:M NEXT						
BTST Rn,0	@aa:16	R:W 2nd	R:W 3rd	R:B EA	R:W:M NEXT					
BTST Rn,0	@aa:32	R:W 2nd	R:W 3rd	R:W 4th	R:B EA	R:W:M NEXT				
BXOR #xx	:3,Rd	R:W NEXT								
BXOR #xx	:3,@ERd	R:W 2nd	R:B EA	R:W:M NEXT						
BXOR #xx	:3,@aa:8	R:W 2nd	R:B EA	R:W:M NEXT						
BXOR #xx @aa:16	:3,	R:W 2nd	R:W 3rd	R:B EA	R:W:M NEXT					
BXOR #xx @aa:32	:3,	R:W 2nd	R:W 3rd	R:W 4th	R:B EA	R:W:M NEXT				
CLRMAC		Cannot be u	used in the I	H8S/2138 S	eries and H8	3S/2134 Seri	ies			

 Table A.6
 Instruction Execution Cycle (cont)

Instruction	1	2	3	4	5	6	7	8	9
CMP.B #xx:8,Rd	R:W NEXT								
CMP.B Rs,Rd	R:W NEXT								
CMP.W #xx:16,Rd	R:W 2nd	R:W NEXT							
CMP.W Rs,Rd	R:W NEXT								
CMP.L #xx:32,ERd	R:W 2nd	R:W 3rd	R:W NEXT						
CMP.L ERs,ERd	R:W NEXT								
DAA Rd	R:W NEXT								
DAS Rd	R:W NEXT								
DEC.B Rd	R:W NEXT								
DEC.W #1/2,Rd	R:W NEXT								
DEC.L #1/2,ERd	R:W NEXT								
DIVXS.B Rs,Rd	R:W 2nd	R:W NEXT	Internal ope	eration, 11 st	ates				
DIVXS.W Rs,ERd	R:W 2nd	R:W NEXT	Internal ope	eration, 19 st	tates				
DIVXU.B Rs,Rd	R:W NEXT	Internal ope	eration, 11 st	tates					
DIVXU.W Rs,ERd	R:W NEXT	Internal ope	eration, 19 st	tates	1				
EEPMOV.B	R:W 2nd	R:B EAs*1	R:B EAd*1	R:B EAs* ²	W:B EAd* ²	R:W NEXT			
EEPMOV.W	R:W 2nd	R:B EAs*1	R:B EAd* ¹	R:B EAs* ²	W:B EAd* ²	R:W NEXT			
EXTS.W Rd	R:W NEXT			\leftarrow Repeated	n times $^{*^2} \rightarrow$				
EXTS.L ERd	R:W NEXT								
EXTU.W Rd	R:W NEXT								
EXTU.L ERd	R:W NEXT								
INC.B Rd	R:W NEXT								
INC.W #1/2,Rd	R:W NEXT								
INC.L #1/2,ERd	R:W NEXT								
JMP @ERn	R:W NEXT	R:W EA							
JMP @aa:24	R:W 2nd	Internal operation, 1 state	R:W EA						
JMP Advanced @@aa:8	R:W NEXT	R:W:M aa:8	R:W aa:8	Internal operation, 1 state	R:W EA				
JSR Advanced @ERn	R:W NEXT	R:W EA	W:W:M Stack (H)	W:W Stack (L)					
JSR Advanced @aa:24	R:W 2nd	Internal operation, 1 state	R:W EA	W:W:M Stack (H)	W:W Stack (L)				
JSR Advanced @@aa:8	R:W NEXT	R:W:M aa:8	R:W aa:8	W:W:M Stack (H)	W:W Stack (L)	R:W EA			

 Table A.6
 Instruction Execution Cycle (cont)

Instruction	1	2	3	4	5	6	7	8	9
LDC #xx:8,CCR	R:W NEXT								
LDC #xx:8,EXR	R:W 2nd	R:W NEXT							
LDC Rs,CCR	R:W NEXT								
LDC Rs,EXR	R:W NEXT								
LDC @ERs,CCR	R:W 2nd	R:W NEXT	R:W EA						
LDC @ERs,EXR	R:W 2nd	R:W NEXT	R:W EA						
LDC@(d:16,ERs), CCR	R:W 2nd	R:W 3rd	R:W NEXT	R:W EA					
LDC@(d:16,ERs), EXR	R:W 2nd	R:W 3rd	R:W NEXT	R:W EA					
LDC@(d:32,ERs), CCR	R:W 2nd	R:W 3rd	R:W 4th	R:W 5th	R:W NEXT	R:W EA			
LDC@(d:32,ERs), EXR	R:W 2nd	R:W 3rd	R:W 4th	R:W 5th	R:W NEXT	R:WEA			
LDC @ERs+,CCR	R:W 2nd	R:W NEXT	Internal operation, 1 state	R:W EA					
LDC @ERs+,EXR	R:W 2nd	R:W NEXT	Internal operation, 1 state	R:W EA					
LDC @aa:16,CCR	R:W 2nd	R:W 3rd	R:W NEXT	R:W EA					
LDC @aa:16,EXR	R:W 2nd	R:W 3rd	R:W NEXT	R:W EA					
LDC @aa:32,CCR	R:W 2nd	R:W 3rd	R:W 4th	R:W NEXT	R:W EA				
LDC @aa:32,EXR	R:W 2nd	R:W 3rd	R:W 4th	R:W NEXT	R:W EA				
LDM.L @SP+, (ERn-ERn+1)	R:W 2nd	R:W:M NEXT	Internal operation, 1 state	R:W:M Stack (H) * ³	R:W Stack (L) * ³				
LDM.L @SP+, (ERn-ERn+2)	R:W 2nd	R:W:M NEXT	Internal operation, 1 state	R:W:M Stack (H) * ³	R:W Stack (L) * ³				
LDM.L @SP+, (ERn-ERn+3)	R:W 2nd	R:W:M NEXT	Internal operation, 1 state	R:W:M Stack (H) * ³	R:W Stack (L) * ³				
LDMAC ERs,MACH	Cannot be	used in the H	18S/2138 Se	eries and H8	S/2134 Serie	es			
LDMAC ERs,MACL									
MAC @ERn+, @ERm+									
MOV.B #xx:8,Rd	R:W NEXT								
MOV.B Rs,Rd	R:W NEXT								
MOV.B @ERs,Rd	R:W NEXT	R:B EA							
MOV.B @(d:16,ERs), Rd	R:W 2nd	R:W NEXT	R:B EA						

Table A.6 Instruction Execution Cycle (cont)

Instruction	1	2	3	4	5	6	7	8	9
MOV.B @(d:32,ERs),Rd	R:W 2nd	R:W 3rd	R:W 4th	R:W NEXT	R:B EA				
MOV.B @ERs+,Rd	R:W NEXT	Internal operation, 1 state	R:B EA						
MOV.B @aa:8,Rd	R:W NEXT	R:B EA							
MOV.B @aa:16,Rd	R:W 2nd	R:W NEXT	R:B EA						
MOV.B @aa:32,Rd	R:W 2nd	R:W 3rd	R:W NEXT	R:B EA					
MOV.B Rs,@ERd	R:W NEXT	W:B EA							
MOV.B Rs, @(d:16,ERd)	R:W 2nd	R:W NEXT	W:B EA						
MOV.B Rs, @(d:32,ERd)	R:W 2nd	R:W 3rd	R:W 4th	R:W NEXT	W:B EA				
MOV.B Rs,@-ERd	R:W NEXT	Internal operation, 1 state	W:B EA						
MOV.B Rs,@aa:8	R:W NEXT	W:B EA							
MOV.B Rs,@aa:16	R:W 2nd	R:W NEXT	W:B EA						
MOV.B Rs,@aa:32	R:W 2nd	R:W 3rd	R:W NEXT	W:B EA					
MOV.W #xx:16,Rd	R:W 2nd	R:W NEXT							
MOV.W Rs,Rd	R:W NEXT								
MOV.W @ERs,Rd	R:W NEXT	R:W EA							
MOV.W @(d:16,ERs),Rd	R:W 2nd	R:W NEXT	R:W EA						
MOV.W @(d:32,ERs),Rd	R:W 2nd	R:W 3rd	R:W 4th	R:W NEXT	R:W EA				
MOV.W @ERs+,Rd	R:W NEXT	Internal operation, 1 state	R:W EA						
MOV.W @aa:16,Rd	R:W 2nd	R:W NEXT	R:W EA						
MOV.W @aa:32,Rd	R:W 2nd	R:W 3rd	R:W NEXT	R:B EA					
MOV.W Rs,@ERd	R:W NEXT	W:W EA							
MOV.W Rs, @(d:16,ERd)	R:W 2nd	R:W NEXT	W:W EA						
MOV.W Rs, @(d:32,ERd)	R:W 2nd	R:W 3rd	R:W 4th	R:W NEXT	W:W EA				
MOV.W Rs,@-ERd	R:W NEXT	Internal operation, 1 state	W:W EA						
MOV.W Rs,@aa:16	R:W 2nd	R:W NEXT	W:W EA						
MOV.W Rs,@aa:32	R:W 2nd	R:W 3rd	R:W NEXT	W:W EA					

 Table A.6
 Instruction Execution Cycle (cont)

Instruction	1	2	3	4	5	6	7	8	9
MOV.L #xx:32,ERd	R:W 2nd	R:W 3rd	R:W NEXT						
MOV.L ERs,ERd	R:W NEXT								
MOV.L @ERs,ERd	R:W 2nd	R:W:M NEXT	R:W:M EA	R:W EA+2					
MOV.L @(d:16,ERs),ERd	R:W 2nd	R:W:M 3rd	R:W NEXT	R:W:M EA	R:W EA+2				
MOV.L @(d:32,ERs),ERd	R:W 2nd	R:W:M 3rd	R:W:M 4th	R:W 5th	R:W NEXT	R:W:M EA	R:W EA+2		
MOV.L @ERs+, ERd	R:W 2nd	R:W:M NEXT	Internal operation, 1 state	R:W:M EA	R:W EA+2				
MOV.L @aa:16, ERd	R:W 2nd	R:W:M 3rd	R:W NEXT	R:W:M EA	R:W EA+2				
MOV.L @aa:32, ERd	R:W 2nd	R:W:M 3rd	R:W 4th	R:W NEXT	R:W:M EA	R:W EA+2			
MOV.L ERs,@ERd	R:W 2nd	R:W:M NEXT	W:W:M EA	W:W EA+2					
MOV.L ERs, @(d:16,ERd)	R:W 2nd	R:W:M 3rd	R:W NEXT	W:W:M EA	W:W EA+2				
MOV.L ERs, @(d:32,ERd)	R:W 2nd	R:W:M 3rd	R:W:M 4th	R:W 5th	R:W NEXT	W:W:M EA	W:W EA+2		
MOV.L ERs,@-ERd	R:W 2nd	R:W:M NEXT	Internal operation, 1 state	W:W:M EA	W:W EA+2				
MOV.L ERs, @aa:16	R:W 2nd	R:W:M 3rd	R:W NEXT	W:W:M EA	W:W EA+2				
MOV.L ERs, @aa:32	R:W 2nd	R:W:M 3rd	R:W 4th	R:W NEXT	W:W:M EA	W:W EA+2			
MOVFPE @aa:16, Rd	Cannot be u	used in the H	18S/2138 Se	eries and H8	S/2134 Seri	es	1		
MOVTPE Rs, @aa:16									
MULXS.B Rs,Rd	R:W 2nd	R:W NEXT	Internal ope	eration, 11 st	tates				
MULXS.W Rs,ERd	R:W 2nd	R:W NEXT	Internal ope	eration, 19 st	ates				
MULXU.B Rs,Rd	R:W NEXT	Internal ope	eration, 11 st	ates					
MULXU.W Rs,ERd	R:W NEXT	Internal ope	eration, 19 st	ates					
NEG.B Rd	R:W NEXT								
NEG.W Rd	R:W NEXT								
NEG.L ERd	R:W NEXT								
NOP	R:W NEXT								
NOT.B Rd	R:W NEXT								
NOT.W Rd	R:W NEXT								

 Table A.6
 Instruction Execution Cycle (cont)

Instruction	1	2	3	4	5	6	7	8	9
NOT.L ERd	R:W NEXT								
OR.B #xx:8,Rd	R:W NEXT								
OR.B Rs,Rd	R:W NEXT								
OR.W #xx:16,Rd	R:W 2nd	R:W NEXT							
OR.W Rs,Rd	R:W NEXT								
OR.L #xx:32,ERd	R:W 2nd	R:W 3rd	R:W NEXT						
OR.L ERs,ERd	R:W 2nd	R:W NEXT							
ORC #xx:8,CCR	R:W NEXT								
ORC #xx:8,EXR	R:W 2nd	R:W NEXT							
POP.W Rn	R:W NEXT	Internal operation, 1 state	R:W EA						
POP.L ERn	R:W 2nd	R:W:M NEXT	Internal operation, 1 state	R:W:M EA	R:W EA+2				
PUSH.W Rn	R:W NEXT	Internal operation, 1 state	W:W EA						
PUSH.L ERn	R:W 2nd	R:W:M NEXT	Internal operation, 1 state	W:W:M EA	W:W EA+2				
ROTL.B Rd	R:W NEXT								
ROTL.B #2,Rd	R:W NEXT								
ROTL.W Rd	R:W NEXT								
ROTL.W #2,Rd	R:W NEXT								
ROTL.L ERd	R:W NEXT								
ROTL.L #2,ERd	R:W NEXT								
ROTR.B Rd	R:W NEXT								
ROTR.B #2,Rd	R:W NEXT								
ROTR.W Rd	R:W NEXT								
ROTR.W #2,Rd	R:W NEXT								
ROTR.L ERd	R:W NEXT								
ROTR.L #2,ERd	R:W NEXT								
ROTXL.B Rd	R:W NEXT								
ROTXL.B #2,Rd	R:W NEXT								
ROTXL.W Rd	R:W NEXT								
ROTXL.W #2,Rd	R:W NEXT								
ROTXL.L ERd	R:W NEXT								

 Table A.6
 Instruction Execution Cycle (cont)

Instr	uction	1	2	3	4	5	6	7	8	9
ROTXL.L	#2,ERd	R:W NEXT								
ROTXR.	3 Rd	R:W NEXT								
ROTXR.	3 #2,Rd	R:W NEXT								
ROTXR.\	N Rd	R:W NEXT								
ROTXR.\	<i>N</i> #2,Rd	R:W NEXT								
ROTXR.L	ERd	R:W NEXT								
ROTXR.L	_ #2,ERd	R:W NEXT								
RTE		R:W NEXT	R:W Stack (EXR)	R:W Stack (H)	R:W Stack (L)	Internal operation, 1 state	R:W *4			
RTS	Advanced	R:W NEXT	R:W:M Stack (H)	R:W Stack (L)	Internal operation, 1 state	R:W *4				
SHAL.B F	Rd	R:W NEXT								
SHAL.B #	#2,Rd	R:W NEXT								
SHAL.W	Rd	R:W NEXT								
SHAL.W	#2,Rd	R:W NEXT								
SHAL.L E	ERd	R:W NEXT								
SHAL.L #	≢2,ERd	R:W NEXT								
SHAR.B	Rd	R:W NEXT								
SHAR.B	#2,Rd	R:W NEXT								
SHAR.W	Rd	R:W NEXT								
SHAR.W	#2,Rd	R:W NEXT								
SHAR.L I	ERd	R:W NEXT								
SHAR.L #	#2,ERd	R:W NEXT								
SHLL.B F	۶d	R:W NEXT								
SHLL.B #	≢2,Rd	R:W NEXT								
SHLL.W	Rd	R:W NEXT								
SHLL.W	#2,Rd	R:W NEXT								
SHLL.L E	Rd	R:W NEXT								
SHLL.L #	2,ERd	R:W NEXT								
SHLR.B I	Rd	R:W NEXT								
SHLR.B #	#2,Rd	R:W NEXT								
SHLR.W	Rd	R:W NEXT								
SHLR.W	#2,Rd	R:W NEXT								
SHLR.L E	ERd	R:W NEXT								
SHLR.L #	#2,ERd	R:W NEXT								

 Table A.6
 Instruction Execution Cycle (cont)

Instruction	1	2	3	4	5	6	7	8	9
SLEEP	R:W NEXT	Internal operation :M							
STC CCR,Rd	R:W NEXT								
STC EXR,Rd	R:W NEXT								
STC CCR,@ERd	R:W 2nd	R:W NEXT	W:W EA						
STC EXR,@ERd	R:W 2nd	R:W NEXT	W:W EA						
STC CCR, @(d:16,ERd)	R:W 2nd	R:W 3rd	R:W NEXT	W:W EA					
STC EXR, @(d:16,ERd)	R:W 2nd	R:W 3rd	R:W NEXT	W:W EA					
STC CCR, @(d:32,ERd)	R:W 2nd	R:W 3rd	R:W 4th	R:W 5th	R:W NEXT	W:W EA			
STC EXR, @(d:32,ERd)	R:W 2nd	R:W 3rd	R:W 4th	R:W 5th	R:W NEXT	W:W EA			
STC CCR,@-ERd	R:W 2nd	R:W NEXT	Internal operation, 1 state	W:W EA					
STC EXR,@-ERd	R:W 2nd	R:W NEXT	Internal operation, 1 state	W:W EA					
STC CCR,@aa:16	R:W 2nd	R:W 3rd	R:W NEXT	W:W EA					
STC EXR,@aa:16	R:W 2nd	R:W 3rd	R:W NEXT	W:W EA					
STC CCR,@aa:32	R:W 2nd	R:W 3rd	R:W 4th	R:W NEXT	W:W EA				
STC EXR,@aa:32	R:W 2nd	R:W 3rd	R:W 4th	R:W NEXT	W:W EA				
STM.L (ERn-ERn+1),@-SP	R:W 2nd	R:W:M NEXT	Internal operation, 1 state	W:W:M Stack (H) * ³	W:W Stack (L) * ³				
STM.L (ERn-ERn+2),@-SP	R:W 2nd	R:W:M NEXT	Internal operation, 1 state	W:W:M Stack (H) * ³	W:W Stack (L) * ³				
STM.L (ERn-ERn+3),@-SP	R:W 2nd	R:W:M NEXT	Internal operation, 1 state	W:W:M Stack (H) * ³	W:W Stack (L) * ³				
STMAC MACH,ERd	Cannot be	used in the H	18S/2138 Se	eries and H8	S/2134 Seri	es			
STMAC MACL,ERd									
SUB.B Rs,Rd	R:W NEXT								
SUB.W #xx:16,Rd	R:W 2nd	R:W NEXT							
SUB.W Rs,Rd	R:W NEXT								
SUB.L #xx:32,ERd	R:W 2nd	R:W 3rd	R:W NEXT						
SUB.L ERs,ERd	R:W NEXT								

 Table A.6
 Instruction Execution Cycle (cont)

Instr	uction	1	2	3	4	5	6	7	8	9
SUBS #1	/2/4,ERd	R:W NEXT								
SUBX #x	x:8,Rd	R:W NEXT								
SUBX Rs	,Rd	R:W NEXT								
TAS @I	ERd	R:W 2nd	R:W NEXT	R:B:M EA	W:B EA					
TRAPA #x:2	Advanced	R:W NEXT		W:W Stack (L)	W:W Stack (H)	W:W Stack (EXR)	R:W:M VEC	R:W VEC+2	Internal operation, 1 state	R:W * ⁷
XOR.B #	xx8,Rd	R:W NEXT								
XOR.B R	s,Rd	R:W NEXT								
XOR.W #	txx:16,Rd	R:W 2nd	R:W NEXT							
XOR.W F	Rs,Rd	R:W NEXT								
XOR.L #	x:32,ERd	R:W 2nd	R:W 3rd	R:W NEXT						
XOR.L E	Rs,ERd	R:W 2nd	R:W NEXT							
XORC #>	x:8,CCR	R:W NEXT								
XORC #>	x:8,EXR	R:W 2nd	R:W NEXT							
Reset excep- tion handling	Advanced	R:W:M VEC		Internal operation, 1 state	R:W *⁵					
Interrupt excep- tion handling	Advanced	R:W * ⁶		W:W Stack (L)	W:W Stack (H)	W:W Stack (EXR)	R:W:M VEC	R:W VEC+2	Internal operation, 1 state	R:W * ⁷

 Table A.6
 Instruction Execution Cycle (cont)

Notes: 1. EAs is the contents of ER5. EAd is the contents of ER6.

- EAs is the contents of ER5. EAd is the contents of ER6. Both registers are incremented by 1 after execution of the instruction. n is the initial value of R4L or R4. If n = 0, these bus cycles are not executed.
- 3. Repeated two times to save or restore two registers, three times for three registers, or four times for four registers.
- 4. Start address after return.
- 5. Start address of the program.
- 6. Prefetch address, equal to two plus the PC value pushed onto the stack. In recovery from sleep mode or software standby mode the read operation is replaced by an internal operation.
- 7. Start address of the interrupt-handling routine.

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Appendix B Internal I/O Registers

B.1 Addresses

Address	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Module Name	Bus Width
H'EC00	MRA	SM1	SM0	DM1	DM0	MD1	MD0	DTS	Sz	DTC	16/32*
to	SAR										
H'EFFF											
	MRB	CHNE	DISEL	_	_	_	_	_	_		
	DAR										
	CRA										
	CRB										
H'FEE4	KBCOMP	IrE	IrCKS2	IrCKS1	IrCKS0	KBADE	KBCH2	KBCH1	KBCH0	IrDA/ expasion A/D	8
H'FEE6	DDCSWR	SWE	SW	IE	IF	CLR3	CLR2	CLR1	CLR0	IIC0	8
H'FEE8	ICRA	ICR7	ICR6	ICR5	ICR4	ICR3	ICR2	ICR1	ICR0	Interrupt	8
H'FEE9	ICRB	ICR7	ICR6	ICR5	ICR4	ICR3	ICR2	ICR1	ICR0	controller	
H'FEEA	ICRC	ICR7	ICR6	ICR5	ICR4	ICR3	ICR2	ICR1	ICR0		
H'FEEB	ISR	IRQ7F	IRQ6F	IRQ5F	IRQ4F	IRQ3F	IRQ2F	IRQ1F	IRQ0F		
H'FEEC	ISCRH	IRQ7SCB	IRQ7SCA	IRQ6SCB	IRQ6SCA	IRQ5SCB	IRQ5SCA	IRQ4SCB	IRQ4SCA		
H'FEED	ISCRL	IRQ3SCB	IRQ3SCA	IRQ2SCB	IRQ2SCA	IRQ1SCB	IRQ1SCA	IRQ0SCB	IRQ0SCA		
H'FEEE	DTCERA	DTCEA7	DTCEA6	DTCEA5	DTCEA4	DTCEA3	DTCEA2	DTCEA1	DTCEA0	DTC	8
H'FEEF	DTCERB	DTCEB7	DTCEB6	DTCEB5	DTCEB4	DTCEB3	DTCEB2	DTCEB1	DTCEB0		
H'FEF0	DTCERC	DTCEC7	DTCEC6	DTCEC5	DTCEC4	DTCEC3	DTCEC2	DTCEC1	DTCEC0		
H'FEF1	DTCERD	DTCED7	DTCED6	DTCED5	DTCED4	DTCED3	DTCED2	DTCED1	DTCED0		
H'FEF2	DTCERE	DTCEE7	DTCEE6	DTCEE5	DTCEE4	DTCEE3	DTCEE2	DTCEE1	DTCEE0		
H'FEF3	DTVECR	SWDTE	DTVEC6	DTVEC5	DTVEC4	DTVEC3	DTVEC2	DTVEC1	DTVEC0		
H'FEF4	ABRKCR	CMF	_	_	_	—	_	_	BIE	Interrupt	8
H'FEF5	BARA	A23	A22	A21	A20	A19	A18	A17	A16	controller	
H'FEF6	BARB	A15	A14	A13	A12	A11	A10	A9	A8		
H'FEF7	BARC	A7	A6	A5	A4	A3	A2	A1	_		
H'FF80	FLMCR1	FWE	SWE	_	_	EV	PV	E	Р	FLASH	8
H'FF81	FLMCR2	FLER	_	_	_	_	_	ESU	PSU		

Address	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Module Name	Bus Width
H'FF82	PCSR	_	_	_	_	_	PWCKB	PWCKA	_	PWM	8
	EBR1	_	_	_	_	_	_	EB9/—	EB8/—	FLASH	8
H'FF83	SYSCR2	KWUL1	KWUL0	P6PUE	_	SDE	CS4E	CS3E	HI12E	HIF	8
	EBR2	EB7	EB6	EB5	EB4	EB3	EB2	EB1	EB0	FLASH	8
H'FF84	SBYCR	SSBY	STS2	STS1	STS0	_	SCK2	SCK1	SCK0	SYSTEM	8
H'FF85	LPWRCR	DTON	LSON	NESEL	EXCLE	_	_	_	_	-	
H'FF86	MSTPCRH	MSTP15	MSTP14	MSTP13	MSTP12	MSTP11	MSTP10	MSTP9	MSTP8	-	
H'FF87	MSTPCRL	MSTP7	MSTP6	MSTP5	MSTP4	MSTP3	MSTP2	MSTP1	MSTP0	•	
H'FF88	SMR1	C/Ā	CHR	PE	O/E	STOP	MP	CKS1	CKS0	SCI1	8
	ICCR1	ICE	IEIC	MST	TRS	ACKE	BBSY	IRIC	SCP	IIC1	_
H'FF89	BRR1									SCI1	8
	ICSR1	ESTP	STOP	IRTR	AASX	AL	AAS	ADZ	ACKB	IIC1	_
H'FF8A	SCR1	TIE	RIE	TE	RE	MPIE	TEIE	CKE1	CKE0	SCI1	8
H'FF8B	TDR1									-	
H'FF8C	SSR1	TDRE	RDRF	ORER	FER	PER	TEND	MPB	MPBT	-	
H'FF8D	RDR1									-	
H'FF8E	SCMR1	_	_	_	_	SDIR	SINV	_	SMIF	-	
	ICDR1	ICDR7	ICDR6	ICDR5	ICDR4	ICDR3	ICDR2	ICDR1	ICDR0	IIC1	8
	SARX1	SVAX6	SVAX5	SVAX4	SVAX3	SVAX2	SVAX1	SVAX0	FSX	-	
H'FF8F	ICMR1	MLS	WAIT	CKS2	CKS1	CKS0	BC2	BC1	BC0	-	
	SAR1	SVA6	SVA5	SVA4	SVA3	SVA2	SVA1	SVA0	FS	-	
H'FF90	TIER	ICIAE	ICIBE	ICICE	ICIDE	OCIAE	OCIBE	OVIE	_	FRT	16
H'FF91	TCSR	ICFA	ICFB	ICFC	ICFD	OCFA	OCFB	OVF	CCLRA	-	
H'FF92	FRCH									-	
H'FF93	FRCL									-	
H'FF94	OCRAH									-	
	OCRBH									-	
H'FF95	OCRAL									-	
	OCRBL									-	
H'FF96	TCR	IEDGA	IEDGB	IEDGC	IEDGD	BUFEA	BUFEB	CKS1	CKS0		
H'FF97	TOCR	ICRDMS	OCRAMS	ICRS	OCRS	OEA	OEB	OLVLA	OLVLB	-	
H'FF98	ICRAH										
	OCRARH									-	
H'FF99	ICRAL										
	OCRARL									-	
H'FF9A	ICRBH									-	
	OCRAFH									-	

Address	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Module Name	Bus Width
H'FF9B	ICRBL									FRT	16
	OCRAFL										
H'FF9C	ICRCH										
	OCRDMH	0	0	0	0	0	0	0	0		
H'FF9D	ICRCL										
	OCRDML										
H'FF9E	ICRDH										
H'FF9F	ICRDL										
H'FFA0	SMR2	C/Ā	CHR	PE	O/E	STOP	MP	CKS1	CKS0	SCI2	8
	DADRAH	DA13	DA12	DA11	DA10	DA9	DA8	DA7	DA6	PWMX	
	DACR	TEST	PWME	_	_	OEB	OEA	OS	CKS		
H'FFA1	BRR2									SCI2	8
	DADRAL	DA5	DA4	DA3	DA2	DA1	DA0	CFS	_	PWMX	
H'FFA2	SCR2	TIE	RIE	TE	RE	MPIE	TEIE	CKE1	CKE0	SCI2	8
H'FFA3	TDR2										
H'FFA4	SSR2	TDRE	RDRF	ORER	FER	PER	TEND	MPB	MPBT		
H'FFA5	RDR2										
H'FFA6	SCMR2	_	_	_	_	SDIR	SINV	_	SMIF		
	DADRBH	DA13	DA12	DA11	DA10	DA9	DA8	DA7	DA6	PWMX	8
	DACNTH										
H'FFA7	DADRBL	DA5	DA4	DA3	DA2	DA1	DA0	CFS	REGS		
	DACNTL							_	REGS		
H'FFA8	TCSR0	OVF	WT/IT	TME	RSTS	RST/NMI	CKS2	CKS1	CKS0	WDT0	16
	TCNT0 (write)										
H'FFA9	TCNT0 (read)										
H'FFAC	P1PCR	P17PCR	P16PCR	P15PCR	P14PCR	P13PCR	P12PCR	P11PCR	P10PCR	Ports	8
H'FFAD	P2PCR	P27PCR	P26PCR	P25PCR	P24PCR	P23PCR	P22PCR	P21PCR	P20PCR		
H'FFAE	P3PCR	P37PCR	P36PCR	P35PCR	P34PCR	P33PCR	P32PCR	P31PCR	P30PCR		
H'FFB0	P1DDR	P17DDR	P16DDR	P15DDR	P14DDR	P13DDR	P12DDR	P11DDR	P10DDR		
H'FFB1	P2DDR	P27DDR	P26DDR	P25DDR	P24DDR	P23DDR	P22DDR	P21DDR	P20DDR		
H'FFB2	P1DR	P17DR	P16DR	P15DR	P14DR	P13DR	P12DR	P11DR	P10DR		
H'FFB3	P2DR	P27DR	P26DR	P25DR	P24DR	P23DR	P22DR	P21DR	P20DR		
H'FFB4	P3DDR	P37DDR	P36DDR	P35DDR	P34DDR	P33DDR	P32DDR	P31DDR	P30DDR		
H'FFB5	P4DDR	P47DDR	P46DDR	P45DDR	P44DDR	P43DDR	P42DDR	P41DDR	P40DDR		
H'FFB6	P3DR	P37DR	P36DR	P35DR	P34DR	P33DR	P32DR	P31DR	P30DR		
H'FFB7	P4DR	P47DR	P46DR	P45DR	P44DR	P43DR	P42DR	P41DR	P40DR		

Address	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Module Name	Bus Width
H'FFB8	P5DDR	_	_	_	_	_	P52DDR	P51DDR	P50DDR	Ports	8
H'FFB9	P6DDR	P67DDR	P66DDR	P65DDR	P64DDR	P63DDR	P62DDR	P61DDR	P60DDR		
H'FFBA	P5DR	_	_	_	_	_	P52DR	P51DR	P50DR		
H'FFBB	P6DR	P67DR	P66DR	P65DR	P64DR	P63DR	P62DR	P61DR	P60DR		
H'FFBD	P8DDR	_	P86DDR	P85DDR	P84DDR	P83DDR	P82DDR	P81DDR	P80DDR		
H'FFBE	P7PIN	P77PIN	P76PIN	P75PIN	P74PIN	P73PIN	P72PIN	P71PIN	P70PIN		
H'FFBF	P8DR	_	P86DR	P85DR	P84DR	P83DR	P82DR	P81DR	P80DR		
H'FFC0	P9DDR	P97DDR	P96DDR	P95DDR	P94DDR	P93DDR	P92DDR	P91DDR	P90DDR		
H'FFC1	P9DR	P97DR	P96DR	P95DR	P94DR	P93DR	P92DR	P91DR	P90DR		
H'FFC2	IER	IRQ7E	IRQ6E	IRQ5E	IRQ4E	IRQ3E	IRQ2E	IRQ1E	IRQ0E	Interrupt controller	8
H'FFC3	STCR	IICS	IICX1	IICX0	IICE	FLSHE	—	ICKS1	ICKS0	System	8
H'FFC4	SYSCR	CS2E	IOSE	INTM1	INTM0	XRST	NMIEG	HIE	RAME		
H'FFC5	MDCR	EXPE	_	_	_	_	_	MDS1	MDS0		
H'FFC6	BCR	ICIS1	ICIS0	BRSTRM	BRSTS1	BRSTS0	_	IOS1	IOS0	Bus	8
H'FFC7	WSCR	RAMS	RAM0	ABW	AST	WMS1	WMS0	WC1	WC0	controller	
H'FFC8	TCR0	CMIEB	CMIEA	OVIE	CCLR1	CCLR0	CKS2	CKS1	CKS0	TMR0,	16
H'FFC9	TCR1	CMIEB	CMIEA	OVIE	CCLR1	CCLR0	CKS2	CKS1	CKS0	TMR1	
H'FFCA	TCSR0	CMFB	CMFA	OVF	ADTE	OS3	OS2	OS1	OS0		
H'FFCB	TCSR1	CMFB	CMFA	OVF	_	OS3	OS2	OS1	OS0		
H'FFCC	TCORA0										
H'FFCD	TCORA1										
H'FFCE	TCORB0										
H'FFCF	TCORB1										
H'FFD0	TCNT0										
H'FFD1	TCNT1										
H'FFD2	PWOERB	OE15	OE14	OE13	OE12	OE11	OE10	OE9	OE8	PWM	8
H'FFD3	PWOERA	OE7	OE6	OE5	OE4	OE3	OE2	OE1	OE0		
H'FFD4	PWDPRB	OS15	OS14	OS13	OS12	OS11	OS10	OS9	OS8		
H'FFD5	PWDPRA	OS7	OS6	OS5	OS4	OS3	OS2	OS1	OS0		
H'FFD6	PWSL	PWCKE	PWCKS	_	_	RS3	RS2	RS1	RS0		
H'FFD7	PWDR0 to PWDR15										
H'FFD8	SMR0	C/Ā	CHR	PE	O/E	STOP	MP	CKS1	CKS0	SCI0	8
	ICCR0	ICE	IEIC	MST	TRS	ACKE	BBSY	IRIC	SCP	IIC0	_
H'FFD9	BRR0									SCI0	_
	ICSR0	ESTP	STOP	IRTR	AASX	AL	AAS	ADZ	ACKB	IIC0	_

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Address	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Module Name	Bus Width
H'FFDA	SCR0	TIE	RIE	TE	RE	MPIE	TEIE	CKE1	CKE0	SCI0	8
H'FFDB	TDR0										
H'FFDC	SSR0	TDRE	RDRF	ORER	FER	PER	TEND	MPB	MPBT		
H'FFDD	RDR0										
H'FFDE	SCMR0	_	_	_	_	SDIR	SINV	_	SMIF		
	ICDR0	ICDR7	ICDR6	ICDR5	ICDR4	ICDR3	ICDR2	ICDR1	ICDR0	IIC0	
	SARX0	SVAX6	SVAX5	SVAX4	SVAX3	SVAX2	SVAX1	SVAX0	FSX		
H'FFDF	ICMR0	MLS	WAIT	CKS2	CKS1	CKS0	BC2	BC1	BC0		
	SAR0	SVA6	SVA5	SVA4	SVA3	SVA2	SVA1	SVA0	FS		
H'FFE0	ADDRAH	AD9	AD8	AD7	AD6	AD5	AD4	AD3	AD2	A/D	8
H'FFE1	ADDRAL	AD1	AD0	_	_	_	_	_	_		
H'FFE2	ADDRBH	AD9	AD8	AD7	AD6	AD5	AD4	AD3	AD2		
H'FFE3	ADDRBL	AD1	AD0	_	_	_	_	_	_		
H'FFE4	ADDRCH	AD9	AD8	AD7	AD6	AD5	AD4	AD3	AD2		
H'FFE5	ADDRCL	AD1	AD0	_	_	_	_	_	_		
H'FFE6	ADDRDH	AD9	AD8	AD7	AD6	AD5	AD4	AD3	AD2		
H'FFE7	ADDRDL	AD1	AD0	_	_	_	_	_	_		
H'FFE8	ADCSR	ADF	ADIE	ADST	SCAN	CKS	CH2	CH1	CH0		
H'FFE9	ADCR	TRGS1	TRGS0	_	_	_	_	_	_		
H'FFEA	TCSR1	OVF	WT/IT	TME	PSS	RST/NMI	CKS2	CKS1	CKS0	WDT1	16
	TCNT1 (write)										
H'FFEB	TCNT1 (read)										
H'FFF0	HICR	_	_	_	_	_	IBFIE2	IBFIE1	FGA20E	HIF	8
	TCRX	CMIEB	CMIEA	OVIE	CCLR1	CCLR0	CKS2	CKS1	CKS0	TMRX	
	TCRY	CMIEB	CMIEA	OVIE	CCLR1	CCLR0	CKS2	CKS1	CKS0	TMRY	
H'FFF1	KMIMR	KMIMR7	KMIMR6	KMIMR5	KMIMR4	KMIMR3	KMIMR2	KMIMR1	KMIMR0	Interrupt controller	
	TCSRX	CMFB	CMFA	OVF	ICF	OS3	OS2	OS1	OS0	TMRX	
	TCSRY	CMFB	CMFA	OVF	ICIE	OS3	OS2	OS1	OS0	TMRY	_
H'FFF2	KMPCR	KM7PCR	KM6PCR	KM5PCR	KM4PCR	KM3PCR	KM2PCR	KM1PCR	KM0PCR	Ports	
	TICRR									TMRX	
	TCORAY									TMRY	_
H'FFF3	TICRF									TMRX	_
	TCORBY									TMRY	_
H'FFF4	IDR1	IDR7	IDR6	IDR5	IDR4	IDR3	IDR2	IDR1	IDR0	HIF	_
	TCNTX									TMRX	_
	TCNTY									TMRY	_

Address	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Module Name	Bus Width
H'FFF5	ODR1	ODR7	ODR6	ODR5	ODR4	ODR3	ODR2	ODR1	ODR0	HIF	8
	TCORC									TMRX	
	TISR	_	_	_	_	_	_	_	IS	TMRY	
H'FFF6	STR1	DBU	DBU	DBU	DBU	C/D	DBU	IBF	OBF	HIF	
	TCORAX									TMRX	_
H'FFF7	TCORBX										_
H'FFF8	DADR0									D/A	
H'FFF9	DADR1										
H'FFFA	DACR	DAOE1	DAOE0	DAE	_	_	_	_	_		
H'FFFC	IDR2	IDR7	IDR6	IDR5	IDR4	IDR3	IDR2	IDR1	IDR0	HIF	_
	TCONRI	SIMOD1	SIMOD0	SCONE	ICST	HFINV	VFINV	HIINV	VIINV	Timer connectior	- 1
H'FFFD	ODR2	ODR7	ODR6	ODR5	ODR4	ODR3	ODR2	ODR1	ODR0	HIF	_
	TCONRO	HOE	VOE	CLOE	CBOE	HOINV	VOINV	CLOINV	CBOINV	Timer connectior	n
H'FFFE	STR2	DBU	DBU	DBU	DBU	C/\overline{D}	DBU	IBF	OBF	HIF	_
	TCONRS	TMRX/Y	ISGENE	HOMOD1	HOMOD0	VOMOD1	VOMOD0	CLMOD1	CLMOD0	Timer	_
H'FFFF	SEDGR	VEDG	HEDG	CEDG	HFEDG	VFEDG	PREQF	IHI	IVI	connectior	۱

Lower Address	Register Name	H8S/2138 Series Register Selection Conditions	H8S/2134 Series Register Selection Conditions	Module Name
H'EC00	MRA	RAME = 1 in SYSCR	_	DTC
to	SAR	-		
H'EFFF	MRB			
	DAR	-		
	CRA	-		
	CRB			
H'FEE4	KBCOMP	No conditions	No conditions	IrDA/ expansion A/D
H'FEE6	DDCSWR	MSTP4 = 0	_	IIC0
H'FEE8	ICRA	No conditions	No conditions	Interrupt
H'FEE9	ICRB			controller
H'FEEA	ICRC			
H'FEEB	ISR	-		
H'FEEC	ISCRH	-		
H'FEED	ISCRL	-		
H'FEEE	DTCERA	No conditions	_	DTC
H'FEEF	DTCERB			
H'FEF0	DTCERC			
H'FEF1	DTCERD			
H'FEF2	DTCERE			
H'FEF3	DTVECR			
H'FEF4	ABRKCR	No conditions	No conditions	Interrupt
H'FEF5	BARA			controller
H'FEF6	BARB	-		
H'FEF7	BARC			
H'FF80	FLMCR1	FLSHE = 1 in STCR	FLSHE = 1 in STCR	Flash
H'FF81	FLMCR2			memory
H'FF82	PCSR	FLSHE = 0 in STCR	FLSHE = 0 in STCR	PWM
	EBR1	FLSHE = 1 in STCR	FLSHE = 1 in STCR	Flash memory
H'FF83	SYSCR2	FLSHE = 0 in STCR	FLSHE = 0 in STCR	HIF
	EBR2	FLSHE = 1 in STCR	FLSHE = 1 in STCR	Flash memory
H'FF84	SBYCR	FLSHE = 0 in STCR	FLSHE = 0 in STCR	System
H'FF85	LPWRCR	-		
H'FF86	MSTPCRH			
H'FF87	MSTPCRL	-		

B.2 Register Selection Conditions

Lower Address	Register Name	H8S/2138 Series Register Sel Conditions	ection	H8S/2134 Series Register Selection Conditions	Module Name		
H'FF88	SMR1	MSTP6 = 0, IICE = 0 in STCR		MSTP6 = 0, IICE = 0 in STCR	SCI1		
	ICCR1	MSTP3 = 0, IICE = 1 in STCR		_	IIC1		
H'FF89	BRR1	MSTP6 = 0, IICE = 0 in STCR		MSTP6 = 0, IICE = 0 in STCR	SCI1		
	ICSR1	MSTP3 = 0, IICE = 1 in STCR		_	IIC1		
H'FF8A	SCR1	MSTP6 = 0		MSTP6 = 0	SCI1		
H'FF8B	TDR1						
H'FF8C	SSR1						
H'FF8D	RDR1						
H'FF8E	SCMR1	MSTP6 = 0, IICE = 0 in STCR		MSTP6 = 0, IICE = 0 in STCR			
	ICDR1	MSTP3 = 0, IICE = 1 in STCR	ICE = 1 in ICCR1	_	IIC1		
	SARX1		ICE = 0 in ICCR1	_			
H'FF8F	ICMR1		ICE = 1 in ICCR1	_			
	SAR1		ICE = 0 in ICCR1	—			
H'FF90	TIER	MSTP13 = 0		MSTP13 = 0	FRT		
H'FF91	TCSR						
H'FF92	FRCH						
H'FF93	FRCL						
H'FF94	OCRAH						
	OCRBH						
H'FF95	OCRAL						
	OCRBL						
H'FF96	TCR						
H'FF97	TOCR						
H'FF98	ICRAH						
	OCRARH						
H'FF99	ICRAL						
	OCRARL						
H'FF9A	ICRBH						
	OCRAFH						
H'FF9B	ICRBL						
	OCRAFL						
H'FF9C	ICRCH	_					
	OCRDMH						
H'FF9D	ICRCL						
	OCRDML						

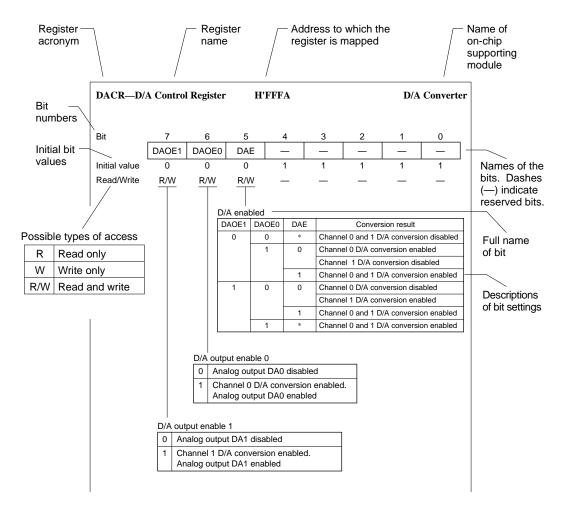
Lower Address	Register Name	H8S/2138 Series Register Sele Conditions	ection	H8S/2134 Series Register Sele Conditions	ection	Module Name
H'FF9E	ICRDH	MSTP13 = 0		MSTP13 = 0		FRT
H'FF9F	ICRDL	-				
H'FFA0	SMR2	MSTP5 = 0, IICE = 0 in STCR		MSTP5 = 0, IICE = 0 in STCR		SCI2
	DADRAH	MSTP11 = 0, IICE = 1 in STCR	REGS = 0 in DACNT/ DADRB	MSTP11 = 0, IICE = 1 in STCR	REGS = 0 in DACNT/ DADRB	PWMX
	DACR		REGS = 1 in DACNT/ DADRB	_	REGS = 1 in DACNT/ DADRB	-
H'FFA1	BRR2	MSTP5 = 0, IICE = 0 in STCR		MSTP5 = 0, IICE = 0 in STCR		SCI2
	DADRAL	MSTP11 = 0, IICE = 1 in STCR	REGS = 0 in DACNT/ DADRB	MSTP11 = 0, IICE = 1 in STCR	REGS = 0 in DACNT/ DADRB	PWMX
H'FFA2	SCR2	MSTP5 = 0		MSTP5 = 0		SCI2
H'FFA3	TDR2					
H'FFA4	SSR2					
H'FFA5	RDR2					
H'FFA6	SCMR2	MSTP5 = 0, IICE = 0 in STCR		MSTP5 = 0, IICE = 0 in STCR		_
	DADRBH	MSTP11 = 0, IICE = 1 in STCR	REGS = 0 in DACNT/ DADRB	MSTP11 = 0, IICE = 1 in STCR	REGS = 0 in DACNT/ DADRB	PWMX
	DACNTH		REGS = 1 in DACNT/ DADRB	_	REGS = 1 in DACNT/ DADRB	_
H'FFA7	DADRBL		REGS = 0 in DACNT/ DADRB	_	REGS = 0 in DACNT/ DADRB	_
	DACNTL		REGS = 1 in DACNT/ DADRB	_	REGS = 1 in DACNT/ DADRB	-
H'FFA8	TCSR0	No conditions		No conditions		WDT0
	TCNT0 (write)	-				
H'FFA9	TCNT0 (read)	-				
H'FFAC	P1PCR	No conditions		No conditions		Ports
H'FFAD	P2PCR					
H'FFAE	P3PCR					
H'FFB0	P1DDR					
H'FFB1	P2DDR					
H'FFB2	P1DR	_				
H'FFB3	P2DR					

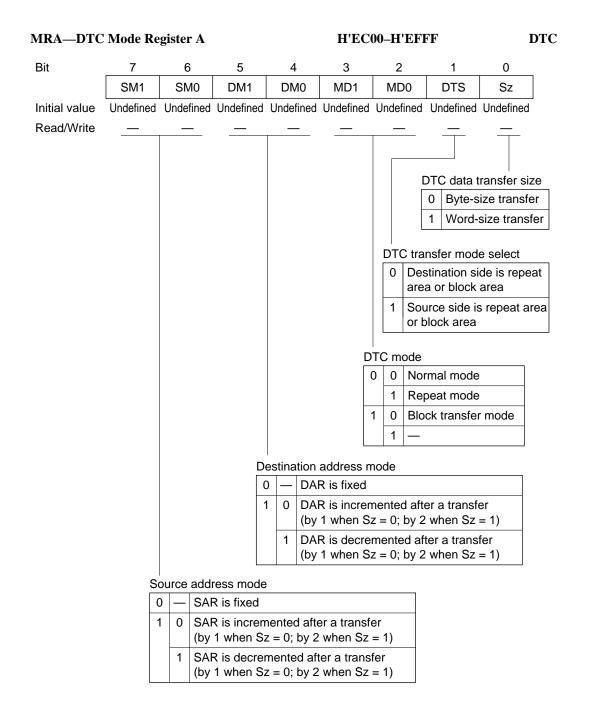
Lower Address	Register Name	H8S/2138 Series Register Selection Conditions	H8S/2134 Series Register Selection Conditions	Module Name
H'FFB4	P3DDR	No conditions	No conditions	Ports
H'FFB5	P4DDR			
H'FFB6	P3DR			
H'FFB7	P4DR			
H'FFB8	P5DDR			
H'FFB9	P6DDR			
H'FFBA	P5DR	-		
H'FFBB	P6DR	-		
H'FFBD	P8DDR	-		
H'FFBE	P7PIN			
H'FFBF	P8DR			
H'FFC0	P9DDR			
H'FFC1	P9DR			
H'FFC2	IER	No conditions	No conditions	Interrupt controller
H'FFC3	STCR	No conditions	No conditions	System
H'FFC4	SYSCR			
H'FFC5	MDCR			
H'FFC6	BCR			Bus
H'FFC7	WSCR			controller
H'FFC8	TCR0	MSTP12 = 0	MSTP12 = 0	TMR0,
H'FFC9	TCR1			TMR1
H'FFCA	TCSR0			
H'FFCB	TCSR1			
H'FFCC	TCORA0			
H'FFCD	TCORA1			
H'FFCE	TCORB0			
H'FFCF	TCORB1			
H'FFD0	TCNT0			
H'FFD1	TCNT1			
H'FFD2	PWOERB	No conditions		PWM
H'FFD3	PWOERA			
H'FFD4	PWDPRB			
H'FFD5	PWDPRA			
H'FFD6	PWSL	MSTP11 = 0		
H'FFD7	PWDR0 to PWDR15			

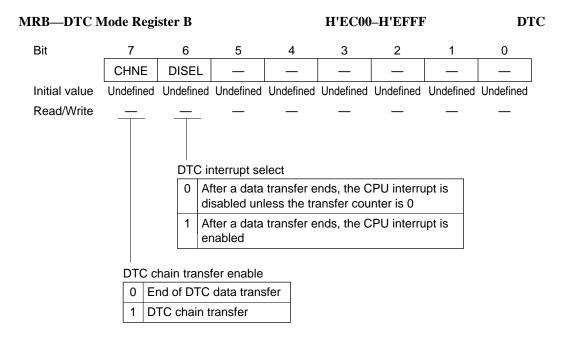
Lower Address	Register Name	H8S/2138 Series Register Sele Conditions	ection	H8S/2134 Series Register Selection Conditions	Module Name
H'FFD8	SMR0	MSTP7 = 0, IICE = 0 in STCR		MSTP7 = 0, IICE = 0 in STCR	SCI0
	ICCR0	MSTP4 = 0, IICE = 1 in STCR		_	IIC0
H'FFD9	BRR0	MSTP7 = 0, IICE = 0 in STCR		MSTP7 = 0, IICE = 0 in STCR	SCI0
	ICSR0	MSTP4 = 0, IICE = 1 in STCR		_	IIC0
H'FFDA	SCR0	MSTP7 = 0		MSTP7 = 0	SCI0
H'FFDB	TDR0	- -			
H'FFDC	SSR0				
H'FFDD	RDR0	-			
H'FFDE	SCMR0	MSTP7 = 0, IICE = 0 in STCR		MSTP7 = 0, IICE = 0 in STCR	
	ICDR0	MSTP4 = 0, IICE = 1 in STCR	ICE = 1 in ICCR0	_	IIC0
	SARX0	-	ICE = 0 in ICCR0	_	
H'FFDF	ICMR0	-	ICE = 1 in ICCR0	_	
	SAR0	-	ICE = 0 in ICCR0	_	
H'FFE0	ADDRAH	MSTP9 = 0		MSTP9 = 0	A/D
H'FFE1	ADDRAL	- -			
H'FFE2	ADDRBH				
H'FFE3	ADDRBL	- -			
H'FFE4	ADDRCH	- -			
H'FFE5	ADDRCL	- -			
H'FFE6	ADDRDH				
H'FFE7	ADDRDL				
H'FFE8	ADCSR	-			
H'FFE9	ADCR				
H'FFEA	TCSR1	No conditions		No conditions	WDT1
	TCNT1 (write)				
H'FFEB	TCNT1 (read)				
H'FFF0	HICR	MSTP2 = 0, HIE = 1 in SYSCR			HIF
	TCRX	MSTP8 = 0, HIE = 0 in SYSCR	TMRX/Y = 0 TCONRS	in—	TMRX
	TCRY		TMRX/Y = 1 TCONRS	inMSTP8 = 0, HIE = 0 in SYSCR	TMRY

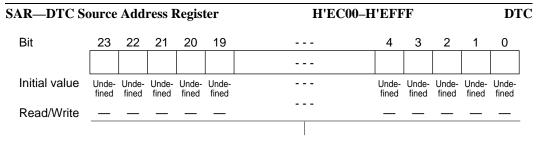
Lower Address	Register Name	H8S/2138 Series Register Sele Conditions	ection H8S/2134 Series Register Selection Conditions	Module Name	
H'FFF1	KMIMR	MSTP2 = 0, HIE = 1 in SYSCR	MSTP2 = 0, HIE = 1 in SYSCR	Interrupt controller	
	TCSRX	MSTP8 = 0, HIE = 0 in SYSCR	TMRX/Y = 0 in— TCONRS	TMRX	
	TCSRY	-	TMRX/Y = 1 inMSTP8 = 0, HIE = 0 in SYSCR TCONRS	TMRY	
H'FFF2	KMPCR	MSTP2 = 0, HIE = 1 in SYSCR	MSTP2 = 0, HIE = 1 in SYSCR	Ports	
	TICRR	MSTP8 = 0, HIE = 0 in SYSCR	TMRX/Y = 0 in— TCONRS	TMRX	
	TCORAY	-	TMRX/Y = 1 inMSTP8 = 0, HIE = 0 in SYSCR TCONRS	TMRY	
H'FFF3	TICRF	MSTP8 = 0, HIE = 0 in SYSCR	TMRX/Y = 0 in— TCONRS	TMRX	
	TCORBY	-	TMRX/Y = 1 inMSTP8 = 0, HIE = 0 in SYSCR TCONRS	TMRY	
H'FFF4	IDR1	MSTP2 = 0, HIE = 1 in SYSCR	_	HIF	
	TCNTX	MSTP8 = 0, HIE = 0 in SYSCR	TMRX/Y = 0 in TCONRS	TMRX	
	TCNTY	-	TMRX/Y = 1 inMSTP8 = 0, HIE = 0 in SYSCR TCONRS	TMRY	
H'FFF5	ODR1	MSTP2 = 0, HIE = 1 in SYSCR	_	HIF	
	TCORC	MSTP8 = 0, HIE = 0 in SYSCR	TMRX/Y = 0 in TCONRS	TMRX	
	TISR	-	TMRX/Y = 1 inMSTP8 = 0, HIE = 0 in SYSCR TCONRS	TMRY	
H'FFF6	STR1	MSTP2 = 0, HIE = 1 in SYSCR	_	HIF	
	TCORAX	MSTP8 = 0, HIE = 0 in SYSCR	TMRX/Y = 0	TMRX	
H'FFF7	TCORBX		in TCONRS		
H'FFF8	DADR0	MSTP10 = 0	MSTP10 = 0	D/A	
H'FFF9	DADR1				
H'FFFA	DACR	_			
H'FFFC	IDR2	MSTP2 = 0, HIE = 1 in SYSCR		HIF	
	TCONRI	MSTP8 = 0, HIE = 0 in SYSCR		Timer connectio	
H'FFFD	ODR2	MSTP2 = 0, HIE = 1 in SYSCR		HIF	
	TCONRO	MSTP8 = 0, HIE = 0 in SYSCR		Timer connectio	
H'FFFE	STR2	MSTP2 = 0, HIE = 1 in SYSCR		HIF	
	TCONRS	MSTP8 = 0, HIE = 0 in SYSCR	_	Timer connectio	
H'FFFF	SEDGR				

B.3 Functions









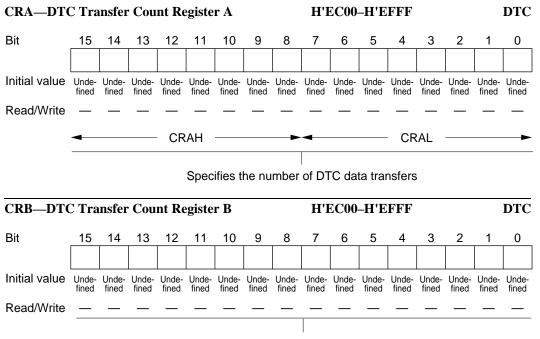
Specifies DTC transfer data source address

DAR-DTC D	estin	ation	Add	ress I	Regist	er H'EC00–H	H'EC00-H'EFFF				
Bit	23	22	21	20	19		4	3	2	1	0
Initial value	Unde- fined	Unde- fined	Unde- fined	Unde- fined	Unde- fined		Unde- fined	Unde- fined	Unde- fined	Unde- fined	Unde- fined
Read/Write	_	_		_			_	_	_		_

Specifies DTC transfer data destination address

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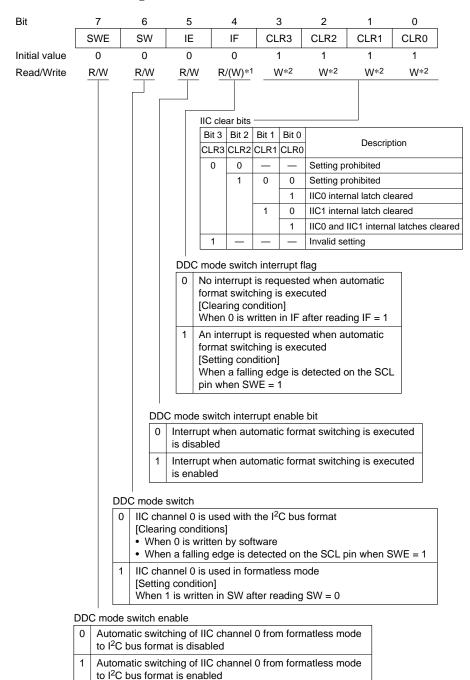
Specifies the number of DTC block data transfers

КВСОМР—К	Leyboard	Comp	arator (Contro	ol Regist	er H'	FEE4]	IrDA/COMP
Bit	7	6	ł	5	4	3	2	1		0
	IrE	IrCK	S2 IrCl	KS1	IrCKS0	KBADE	KBCH2	КВС	H1	KBCH0
Initial value	0	0	. (0	0	0	0	0		0
Read/Write	R/W	R/W	/ R/	/W	R/W	R/W	R/W	R/V	N	R/W
			Keyboard] I compa	rator cont	rol ———				
			Bit 3	Bit 2	Bit 1	Bit 0	A/D conv	rerter	A/I	D converter
			KBADE	KBCH	2 KBCH	1 KBCH0	channel 6		cha	nnel 7 input
			0	—	_		AN6	;		AN7
			1	0	0	0	CIN)	ι	Jndefined
						1	CIN		ļ	
					1	0	CIN		ł	
						1	CIN		ł	
				1	0	0	CIN		ł	
					1	0	CIN		ł	
						1	CIN		ł	
		rDA Clo	ck select	2 to 0					I	
		0	0	0	B×:	3/16 (3/16 c	of the bit rat	e)		
				1	ø/2					
			1	0	ø/4					
				1	ø/8					
		1	0	0	ø/16					
			1	1	ø/32 ø/64					
				1	ø/64 ø/12					
				I	0/12	.0				
	IrDA en							D D C		

0	The TxD2/IrTxD and RxD2/IrRxD pins function as TxD2 and RxD2
1	The TxD2/IrTxD and RxD2/IrRxD pins function as IrTxD and IrRxD

DDCSWR—DDC Switch Register

H'FEE6



Notes: 1. Only 0 can be written, to clear the flag.

2. Always read as 1.

ICRA—Interr ICRB—Interr ICRC—Interr	upt Contr	ol Registo	er B	H'FEE8 H'FEE9 H'FEEA			Interrupt Controller Interrupt Controller Interrupt Controller		
Bit	7	6	5	4	3	2	1	0	
	ICR7	ICR6	ICR5	ICR4	ICR3	ICR2	ICR1	ICR0	
Initial value	0	0	0	0	0	0	0	0	
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	
		· · · ·	t control le rrespondir		t source is	s control le	evel 0 (nor	n-priority)	

1 Corresponding interrupt source is control level 1 (priority)

Correspondence between Interrupt Sources and ICR Settings

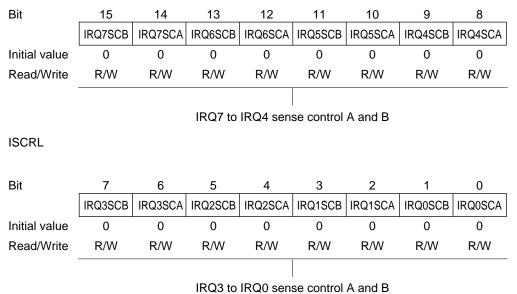
Register	Bits									
Register	7	6	5	4	3	2	1	0		
ICRA	IRQ0	IRQ1	IRQ2 IRQ3	IRQ4 IRQ5	IRQ6 IRQ7	DTC	Watchdog timer 0	Watchdog timer 1		
ICRB	A/D converter	Free- running timer				8-bit timer channel 1	8-bit timer channels X, Y	HIF		
ICRC	SCI channel 0	SCI channel 1	SCI channel 2	IIC channel 0 (option)	IIC channel 1 (option)	_	_	—		

ISR—IRQ Sta	tus Regis	ter		H'I	FEEB		Interrup	t Controllei
Bit	7	7 6 5 4 3					1	0
	IRQ7F	IRQ6F	IRQ5F	IRQ4F	IRQ3F	IRQ2F	IRQ1F	IRQ0F
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/(W)* R/(W)* R/		R/(W)*	R/(W)*	R/(W)*	R/(W)*	R/(W)*	R/(W)*
	R/(W)* R/(W)*						detection ng, rising, tection is ection is	
							(n = 7 to 0)

Note: * Only 0 can be written, to clear the flag.

ISCRH—IRQ Sense Control Register H	H'FEEC	Interrupt Controller
ISCRL—IRQ Sense Control Register L	H'FEED	Interrupt Controller

ISCRH



ISCRH bits 7–0 ISCRL bits 7–0		Description
IRQ7SCB- IRQ0SCB	IRQ7SCA– IRQ0SCA	Description
0	0	Interrupt request generated at IRQ7–IRQ0 input at low level
	1	Interrupt request generated at falling edge of IRQ7–IRQ0 input
1	0	Interrupt request generated at rising edge of IRQ7–IRQ0 input
	1	Interrupt request generated at both falling and rising edges of IRQ7–IRQ0 input

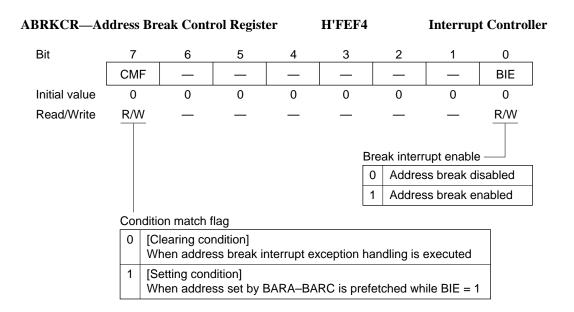
DTCER—DTC Enable Register

Bit	7	6	5	4	3	2	1	0
	DTCE7	DTCE6	DTCE5	DTCE4	DTCE3	DTCE2	DTCE1	DTCE0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
	DTC activation enable 0 DTC activation by interrupt is disabled [Clearing conditions] • When data transfer ends with the DISEL bit set to 1 • When the specified number of transfers end 1 DTC activation by interrupt is enabled [Holding condition] When the DISEL bit is 0 and the specified number of transfers have not ended							
DTVECR—DTC Vector Register H'FEF3 DTC								
Bit	7	6	5	4	3	2	1	0
	SWDTE	DTVEC6	DTVEC5	DTVEC4	DTVEC3	DTVEC2	DTVEC1	DTVEC0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/(W)*	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Sets vector number for DTC software activation								
		0 DTC software activation is disabled [Clearing condition] When the DISEL bit is 0 and the specified number of transfers have not ended						
		Clearing co Vhen the D	ndition]	s 0 and the	e specified	number o	of transfers	have

Note: * A value of 1 can always be written to the SWDTE bit, but 0 can only be written after 1 is read.

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DTC



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BARA—Break Address Register A BARB—Break Address Register B BARC—Break Address Register C					H'FEF5 H'FEF6 H'FEF7			Interrupt Controller Interrupt Controller Interrupt Controller		
Bit	7	6	5	4	3	2	1	0		
BARA	A23	A22	A21	A20	A19	A18	A17	A16		
Initial value	0	0	0	0	0	0	0	0		
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W		

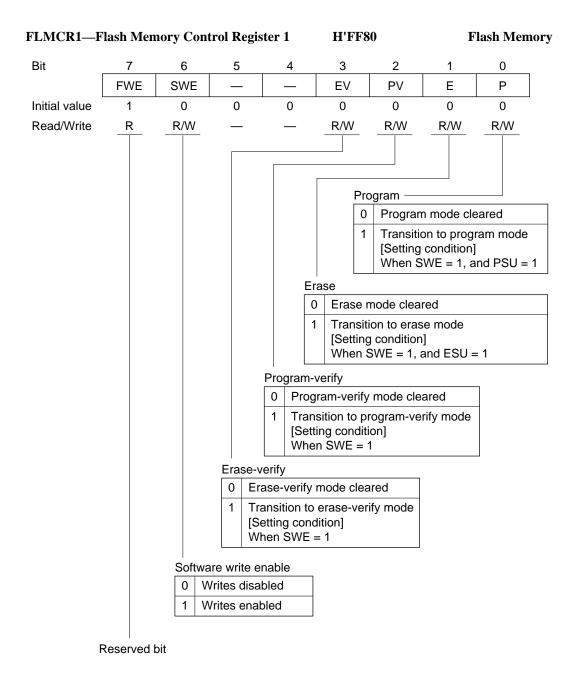
Specifies address (bits 23–16) at which address break is to be generated

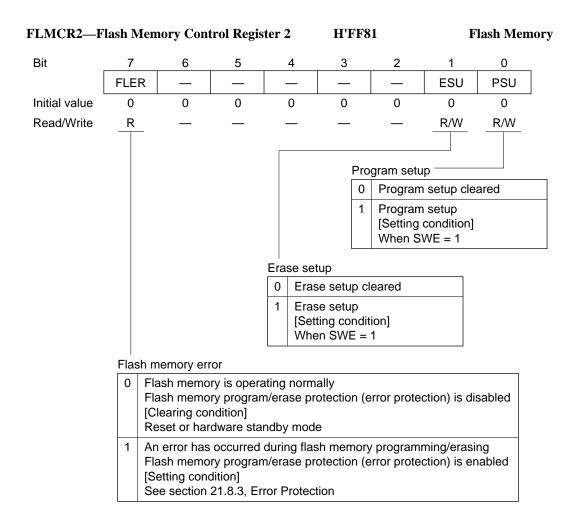
Bit	7	6	5	4	3	2	1	0
BARB	A15	A14	A13	A12	A11	A10	A9	A8
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Specifies address (bits 15-8) at which address break is to be generated

Bit	7	6	5	4	3	2	1	0
BARC	A7	A6	A5	A4	A3	A2	A1	—
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	—

Specifies address (bits 7–1) at which address break is to be generated









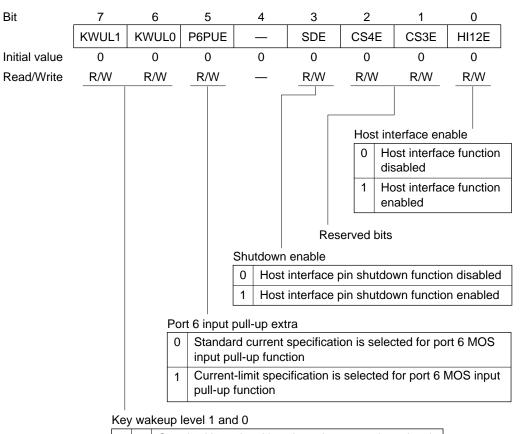
Bit 7 6 5 4 3 2 1 0 PWCKB ____ _ ___ PWCKA _ _ ____ 0 0 0 0 0 Initial value 0 0 0 Read/Write ____ R/W R/W ___ ____ ___ ____ ____ PWM clock select PWSL PCSR Bit 7 Bit 6 Bit 2 Bit 1 Description PWCKE PWCKS PWCKB PWCKA 0 _ Clock input is disabled _ 1 0 ø (system clock) is selected ____ ____ 1 0 ø/2 is selected 0 1 ø/4 is selected 1 0 ø/8 is selected 1 ø/16 is selected

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PWM



H'FF83



0	0	Standard input level is selected as port 6 input level
	1	Input level 1 is selected as port 6 input level
1	0	Input level 2 is selected as port 6 input level
	1	Input level 3 is selected as port 6 input level

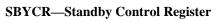
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HIF

EBR1—Eras EBR2—Eras		0			H'FF8 H'FF8	-		`lash Memory `lash Memory	
Bit	7	6	5	4	3	2	1	0	
	—	—	—	—	—		EB9/—*2	EB8/— ^{*2}	
Initial value	0	0	0	0	0	0	0	0	
Read/Write	—	—	—	—	—	—	R/W*1,*2	R/W ^{*1,*2}	
Bit	7	6	5	4	3	2	1	0	
	EB7	EB6	EB5	EB4	EB3	EB2	EB1	EB0	
Initial value	0	0	0	0	0	0	0	0	
Read/Write	R/W*1	R/W	R/W	R/W	R/W	R/W	R/W	R/W	

Notes: 1. In normal mode, these bits cannot be modified and are always read as 0.
2. Bits EB8 and EB9 are not present in the 64-kbyte versions; they cannot be modified and are always read as 0.

Erase Blocks		
Block	(Size)	Addresses
128-kbyte versions	64-kbyte versions	Addresses
EB0 (1 kbyte)	EB0 (1 kbyte)	H'(00)0000–H'(00)03FF
EB1 (1 kbyte)	EB1 (1 kbyte)	H'(00)0400–H'(00)07FF
EB2 (1 kbyte)	EB2 (1 kbyte)	H'(00)0800–H'(00)0BFF
EB3 (1 kbyte)	EB3 (1 kbyte)	H'(00)0C00-H'(00)0FFF
EB4 (28 kbytes)	EB4 (28 kbytes)	H'(00)1000–H'(00)7FFF
EB5 (16 kbytes)	EB5 (16 kbytes)	H'(00)8000–H'(00)BFFF
EB6 (8 kbytes)	EB6 (8 kbytes)	H'(00)C000–H'(00)DFFF
EB7 (8 kbytes)	EB7 (8 kbytes)	H'00E000-H'00FFFF
EB8 (32 kbytes)	_	H'010000–H'017FFF
EB9 (32 kbytes)	—	H'018000–H'01FFFF



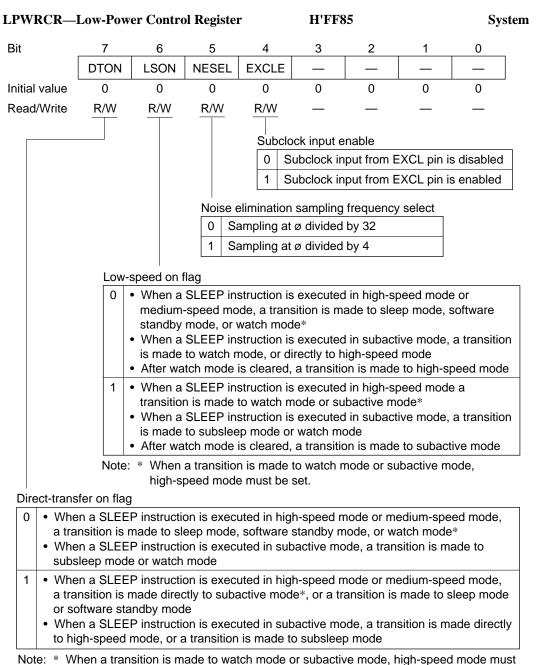
H'FF84

System

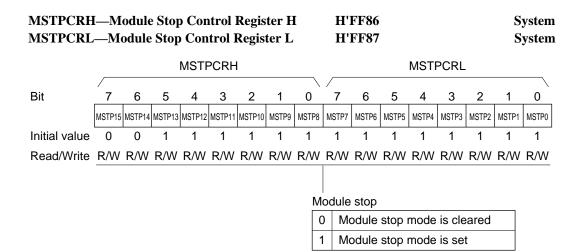
Bit	7	6	5	4	3	2	1	0		
	SSBY	STS2	STS1	STS) —	SCK2	SCK1	SCK0		
Initial value	0	0	0	0	0	0	0	0		
Read/Write	R/W	R/W	R/W	R/W		R/W	R/W	R/W		
					lect 2 to (
			0	0	0	Bus master i	-	-		
					1	Medium-spe				
				1	0	Medium-spe	ed clock =	: ø/4		
					1	Medium-spe	ed clock =	: ø/8		
			1	0	0	Medium-speed clock = Ø/16				
					1	Medium-spe	ed clock =	= ø/32		
				1	—	—				
		Standby t								
		0	0	0 3	Standby	time = 8192 states				
				1 3	Standby	time = 16384 :	states			
			1	0	Standby	time = 32768 :	me = 32768 states			
				1 :	Standby	time = 65536 s	states			
		1	0	0 ;	Standby	time = 131072	states			
	1 Standby time = 262144 stat						states			
			1	0 1	Reserved	ł				
				1 :	Standby	time = 16 state	es*			
		Note: * TI	his setting		-	d in the flash		ersion		

Software standby

0	Transition to sleep mode after execution of SLEEP instruction in high-speed mode or medium-speed mode Transition to subsleep mode on execution of SLEEP instruction in subactive mode
1	Transition to software standby mode, subactive mode, or watch mode after execution of SLEEP instruction in high-speed mode or medium-speed mode Transition to watch mode or high-speed mode after execution of SLEEP instruction in subactive mode



be set.

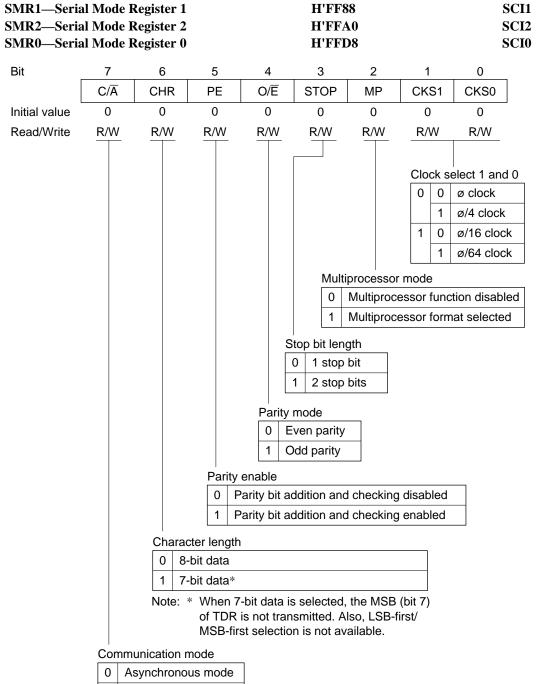


The correspondence between MSTPCR bits and on-chip supporting modules is shown below.

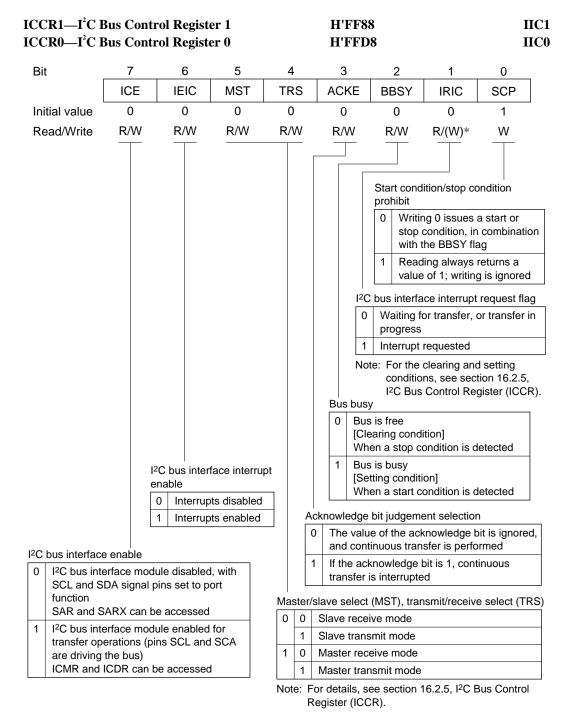
Register	Bit	Module
MSTPCRH	MSTP15	_
	MSTP14*	Data transfer controller (DTC)
	MSTP13	16-bit free-running timer (FRT)
	MSTP12	8-bit timers (TMR0, TMR1)
	MSTP11	8-bit PWM timer (PWM), 14-bit PWM timer (PWMX)
	MSTP10	D/A converter
	MSTP9	A/D converter
	MSTP8	8-bit timers (TMRX, TMRY), timer connection
MSTPCRL	MSTP7	Serial communication interface 0 (SCI0)
	MSTP6	Serial communication interface 1 (SCI1)
	MSTP5	Serial communication interface 2 (SCI2)
	MSTP4*	I ² C bus interface (IIC) channel 0 (option)
	MSTP3*	I ² C bus interface (IIC) channel 1 (option)
	MSTP2*	Host interface (HIF)
	MSTP1*	_
	MSTP0*	_

Note: Bits 1 and 0 can be read and written but do not affect operation.

* Must be set to 1 in the H8S/2134 Series.



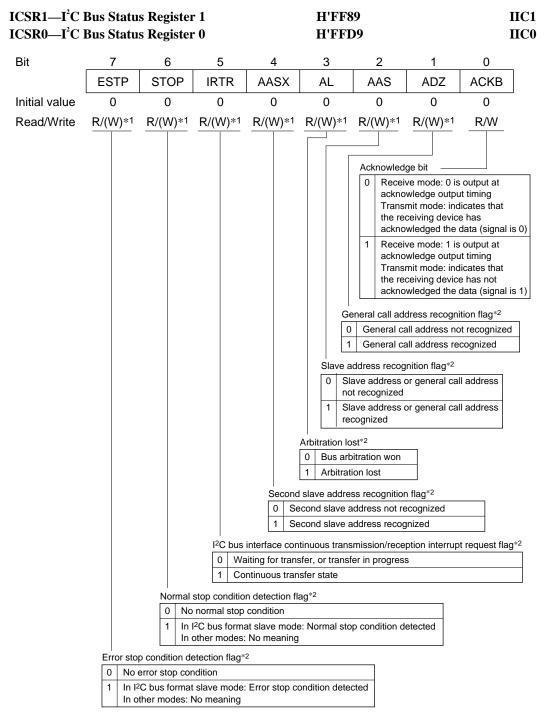
1 Synchronous mode





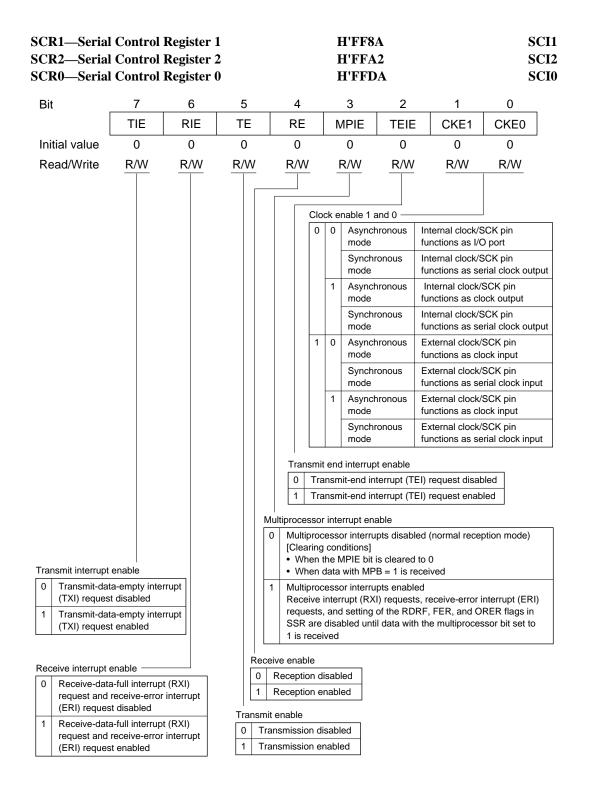
BRR1—Bit Ra BRR2—Bit Ra BRR0—Bit Ra	ate Register 2			H'FF89 H'FFA1 H'FFD9	l	SCI1 SCI2 SCI0			
Bit	7	6	5	4	3	2	1	0	-
Initial value	1	1	1	1	1	1	1	1	
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	
									-

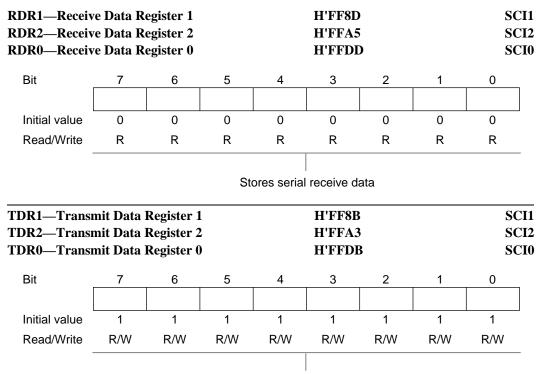
Sets the serial transmit/receive bit rate



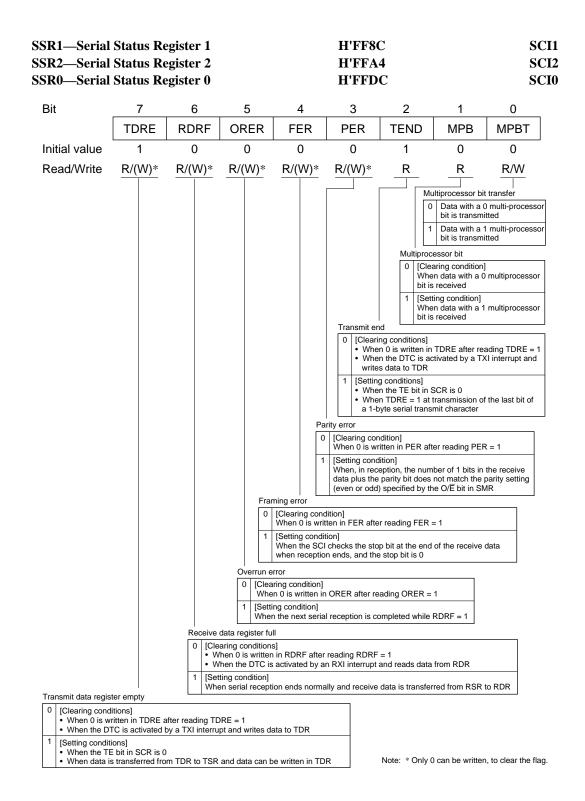
Notes: 1. Only 0 can be written, to clear the flag.

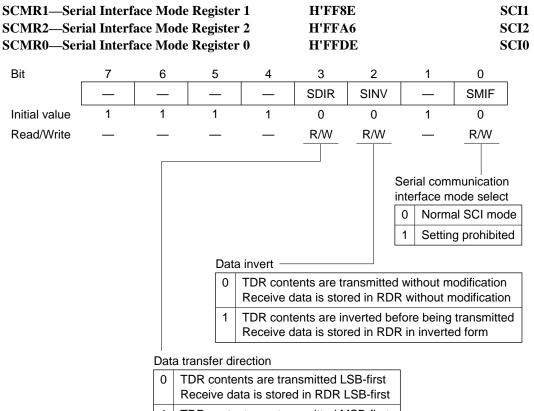
2. For the clearing and setting conditions, see section 16.2.6, I²C Bus Status Register (ICSR).





Stores serial transmit data





1	TDR contents are transmitted MSB-first
	Receive data is stored in RDR MSB-first

CDR1—I ² C B CDR0—I ² C B					H'FF8E H'FFDI			
Bit	7	6	5	4	3	2	1	0
	ICDR7	ICDR6	ICDR5	ICDR4	ICDR3	ICDR2	ICDR1	ICDR0
Initial value	_	_	_	_				_
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
ICDRR								
Bit	7	6	5	4	3	2	1	0
	ICDRR7	ICDRR6	ICDRR5	ICDRR4	ICDRR3	ICDRR2	ICDRR1	ICDRR0
Initial value			_		_			_
Read/Write	R	R	R	R	R	R	R	R
ICDRS								
Bit	7	6	5	4	3	2	1	0
	ICDRS7	ICDRS6	ICDRS5	ICDRS4	ICDRS3	ICDRS2	ICDRS1	ICDRS0
Initial value	_							_
Read/Write	—	—	—	—	—	—	—	—
ICDRT								
Bit	7	6	5	4	3	2	1	0
	ICDRT7	ICDRT6	ICDRT5	ICDRT4	ICDRT3	ICDRT2	ICDRT1	ICDRT0
Initial value	—	—	—	—	—	—	—	—
Read/Write	W	W	W	W	W	W	W	W
TDRE, RDRI	- (internal	flags)						
Bit							_	_
							TDRE	RDRF
Initial value							0	0
Read/Write							_	

Note: For details, see section 16.2.1, I²C Bus Data Register (ICDR).

788

SARX1—Second Slave Address Register 1	H'FF8E	IIC1
SAR1—Slave Address Register 1	H'FF8F	IIC1
SARX0—Second Slave Address Register 0	H'FFDE	IIC0
SAR0—Slave Address Register 0	H'FFDF	IIC0

Bit	7	6	5	4	3	2	1	0
	SVA6	SVA5	SVA4	SVA3	SVA2	SVA1	SVA0	FS
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
				For	mat selec			
SARX								
Bit	7	6	5	4	3	2	1	0
	SVAX6	SVAX5	SVAX4	SVAX3	SVAX2	SVAX1	SVAX0	FSX
Initial value	0	0	0	0	0	0	0	1
Read/Write				R/W	R/W	R/W	R/W	R/W
	R/W	R/W	R/W	FC/ V V	r/ v v	r/ v v	r/ v v	r/ v v

DDCSWR Bit 6	SAR Bit 0	SARX Bit 0	Operating Mode
SW	FS	FSX	
0	0	0	I ² C bus format • SAR and SARX slave addresses recognized
		1	I²C bus formatSAR slave address recognizedSARX slave address ignored
1		0	I²C bus formatSAR slave address ignoredSARX slave address recognized
		1	Synchronous serial format • SAR and SARX slave addresses ignored
1	0	0	Formatless mode (start/stop conditions not
		1	detected)
	1		 Acknowledge bit used
		1	Formatless mode* (start/stop conditions not detected) • No acknowledge bit

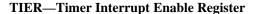
Second slave address

Note: * Do not set this mode when automatic switching to the I²C bus format is performed by means of the DDCSWR setting.

	ICMR1—I ² C Bus Mode Register 1 ICMR0—I ² C Bus Mode Register 0					H'FF8F H'FFDF					
Bit	7	6	5	4	3		2	1	0		
	MLS		CKS2	CKS1			BC2	BC1	BC0		
Initial value	0	0	0	0	0	I	0	0	0		
Read/Write	R/W	R/W	R/W	R/W	R/V	V	R/W	R/W	R/W		
				Bit counte	er						
				BC2	BC1	BC0	Syr	nchronous	l ² C bus		
							ser	ial format	format		
				0	0	0		8	9		
					1	1		1	2 3		
					I	1	_	3	4		
				1	0	0		4	5		
					Ū	1		5	6		
					1	0		6	7		
						1		7	8		
			IICX 0 1	CKS2 0 1 0	CKS1 0 1 0 1 0 1 1 0 1 0	CKS0 0 1 0 1 0 1 0 1 0 1 0 1 0 0	Ø/2 Ø/4 Ø/4 Ø/6 Ø/8 Ø/1 Ø/1 Ø/1 Ø/1 Ø/5 Ø/8 Ø/9 Ø/1	0 8 4 0 00 12 28 6 0 6 6 28			
			nsertion bit Data and ac		1	1 0 1	ø/2 ø/2 ø/2	00 24 56			
			Nait inserte								
	MSE	3-first/LSB-firs	st select*								
	0	MSB-first									

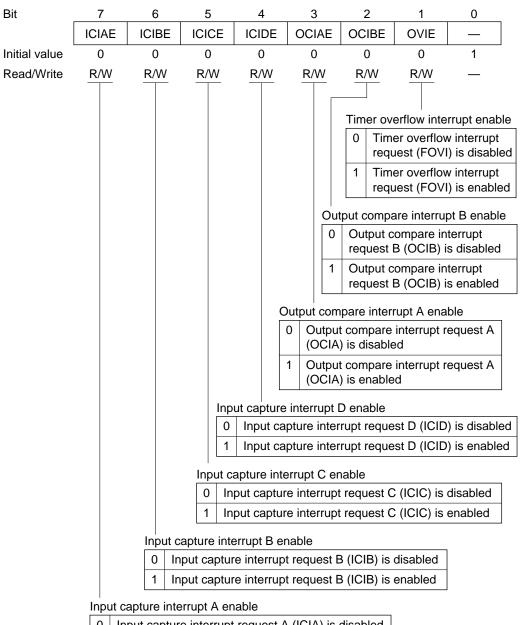
0	
1	LSB-first

Note: * Do not set this bit to 1 when the I²C bus format is used.



Bit

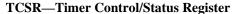
H'FF90

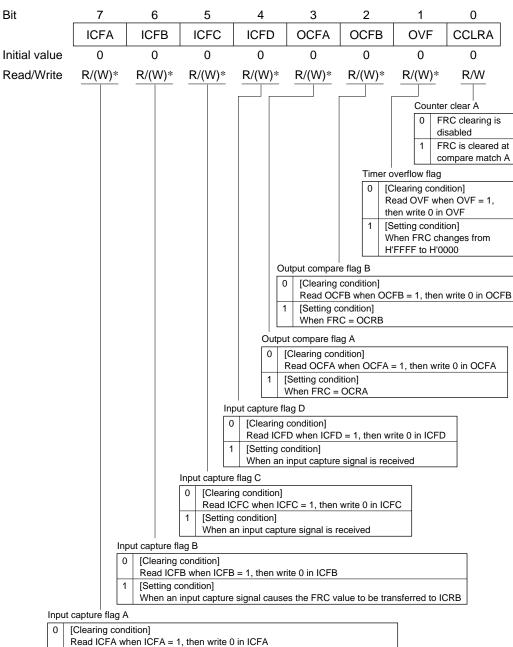


0	Input capture interrupt request A (ICIA) is disabled	
1	Input capture interrupt request A (ICIA) is enabled]

HITACHI

FRT

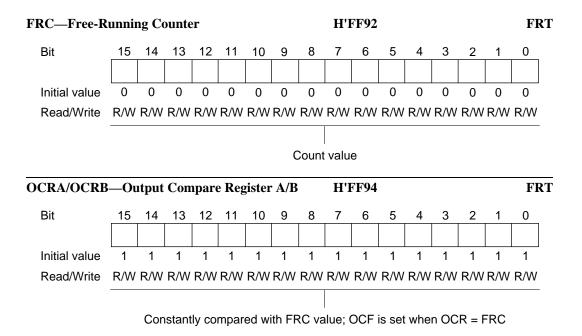




	Read ICFA when ICFA
1	[Setting condition]

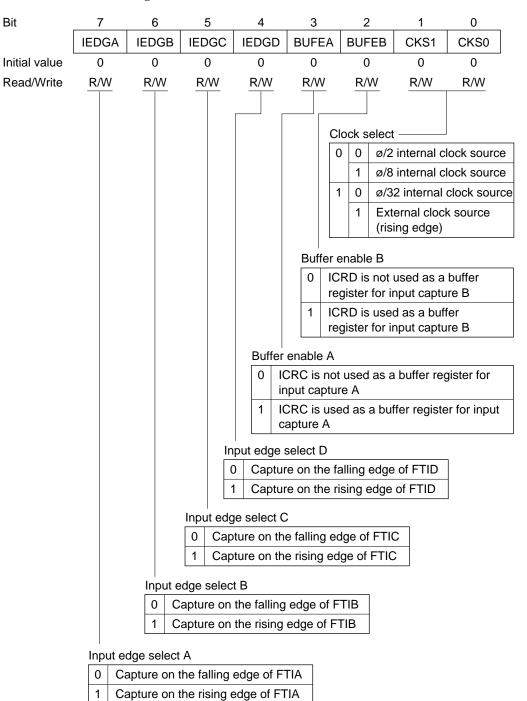
When an input capture signal causes the FRC value to be transferred to ICRA

Note: * Only 0 can be written in bits 7 to 1, to clear the flags.

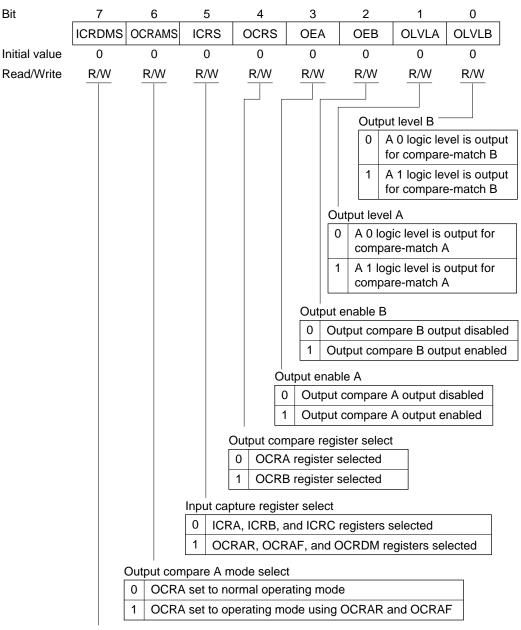


TCR—Timer Control Register

H'FF96

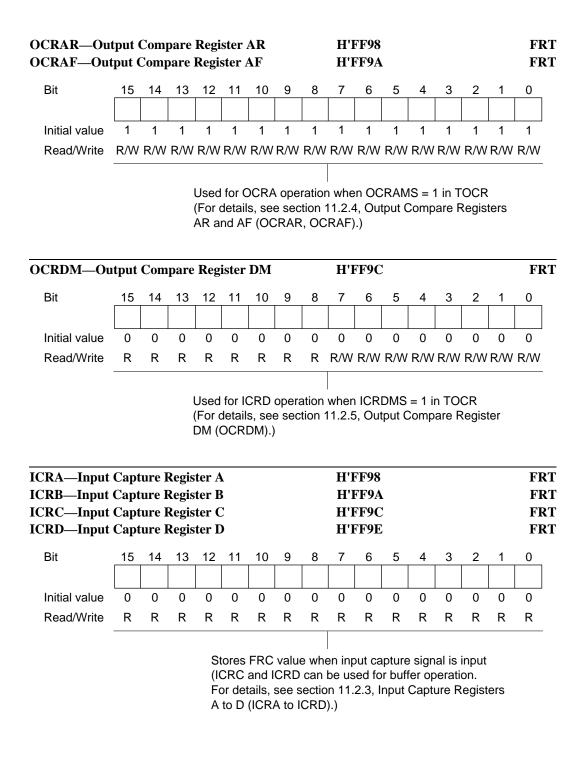


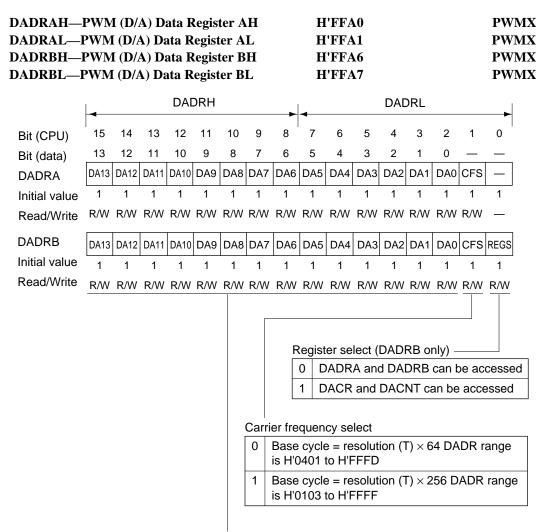
TOCR—Timer Output Compare Control Register H'FF97



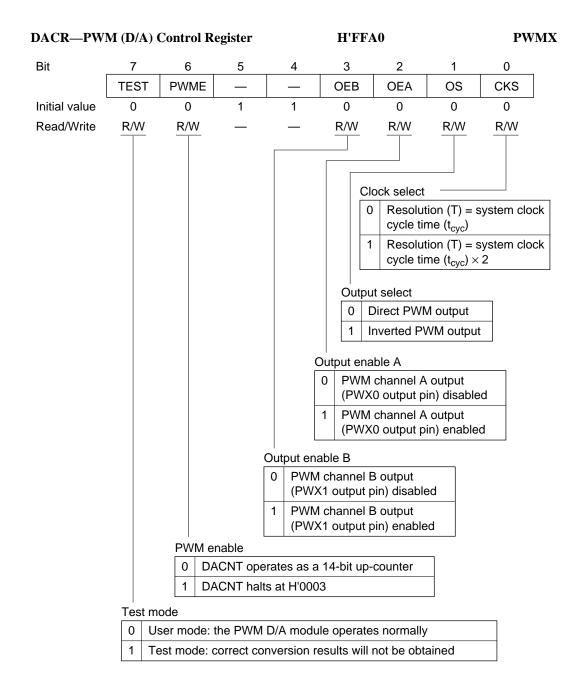
Input capture D mode select

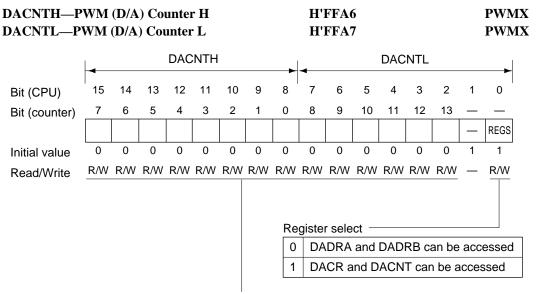
0	ICRD set to normal operating mode
1	ICRD set to operating mode using OCRDM



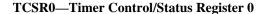


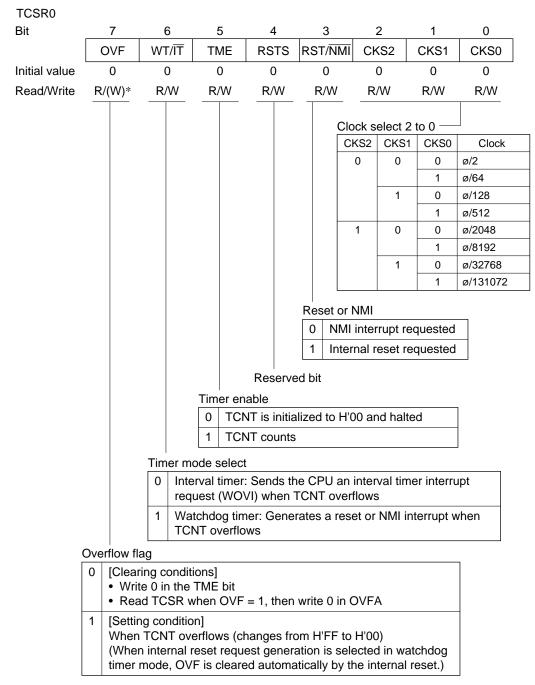
D/A conversion data





Up-counter





Note: * Only 0 can be written, to clear the flag.

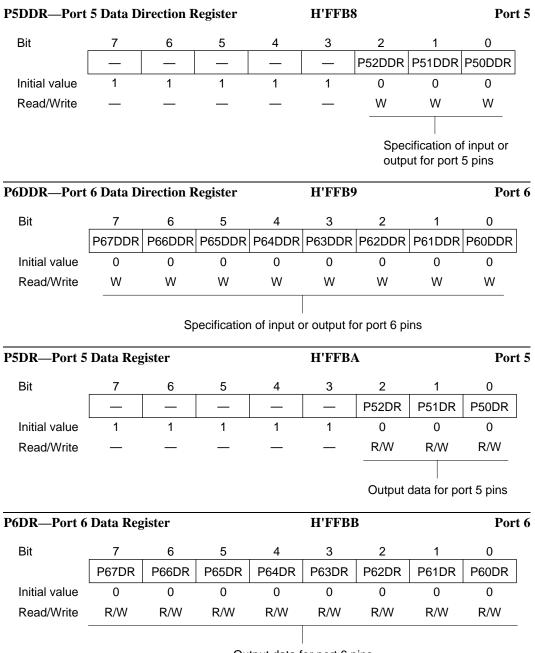
	CCNT0—Timer Counter 0 CCNT1—Timer Counter 1				H'FFA8 (W), H'FFA9 (R) H'FFEA (W), H'FFEB (R)				
Bit	7	6	5	4	3	2	1	0	
Initial value	0	0	0	0	0	0	0	0	
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	
				Up-co	unter				
P1PCR—Port	1 MOS P	ull-Up Co	ontrol Reg	gister	H'FFA(2		Port	t 1
Bit	7	6	5	4	3	2	1	0	
	P17PCR	P16PCR	P15PCR	P14PCR	P13PCR	P12PCR	P11PCR	P10PCR	
Initial value	0	0	0	0	0	0	0	0	
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	
P2PCR—Port	2 MOS P		-		in MOS in H'FFAI		DS	Port	t 2
Bit	7	6	5	4	_				
		0	0	4	3	2	1	0	
	P27PCR	-	P25PCR					0 P20PCR	
Initial value		-	-						
Initial value Read/Write	P27PCR	P26PCR	P25PCR	P24PCR	P23PCR	P22PCR	P21PCR	P20PCR	
	P27PCR 0	P26PCR 0 R/W	P25PCR 0 R/W	P24PCR 0 R/W	P23PCR 0	P22PCR 0 R/W	P21PCR 0 R/W	P20PCR 0	
	P27PCR 0 R/W	P26PCR 0 R/W C	P25PCR 0 R/W	P24PCR 0 R/W ort 2 built-	P23PCR 0 R/W	P22PCR 0 R/W put pull-up	P21PCR 0 R/W	P20PCR 0	3
Read/Write	P27PCR 0 R/W	P26PCR 0 R/W C	P25PCR 0 R/W	P24PCR 0 R/W ort 2 built-	P23PCR 0 R/W in MOS in	P22PCR 0 R/W put pull-up	P21PCR 0 R/W	0 R/W	3
Read/Write P3PCR—Port	P27PCR 0 R/W 3 MOS P	P26PCR 0 R/W C ull-Up Cc	P25PCR 0 R/W ontrol of p ontrol Reg 5	P24PCR 0 R/W ort 2 built- gister 4	P23PCR 0 R/W in MOS in H'FFAF	P22PCR 0 R/W put pull-up E 2	P21PCR 0 R/W os	P20PCR 0 R/W Port	± 3
Read/Write P3PCR—Port	P27PCR 0 R/W 3 MOS P 7	P26PCR 0 R/W C ull-Up Cc	P25PCR 0 R/W ontrol of p ontrol Reg 5	P24PCR 0 R/W ort 2 built- gister 4	P23PCR 0 R/W in MOS in H'FFAF 3	P22PCR 0 R/W put pull-up E 2	P21PCR 0 R/W os	P20PCR 0 R/W Port	±3
Read/Write P3PCR—Port Bit	P27PCR 0 R/W 3 MOS P 7 P37PCR	P26PCR 0 R/W C ull-Up Co 6 P36PCR	P25PCR 0 R/W ontrol of p ontrol Reg 5 P35PCR	P24PCR 0 R/W ort 2 built- gister 4 P34PCR	P23PCR 0 R/W in MOS in H'FFAH 3 P33PCR	P22PCR 0 R/W put pull-up E 2 P32PCR	P21PCR 0 R/W 0s 1 P31PCR	P20PCR 0 R/W Port 0 P30PCR	±3

P1DDR—Port	1 Data D	irection F	Register	gister H'FFB0					
Bit	7	6	5	4	3	2	1	0	
	P17DDR	P16DDR	P15DDR	P14DDR	P13DDR	P12DDR	P11DDR	P10DDR	
Initial value	0	0	0	0	0	0	0	0	
Read/Write	W	W	W	W	W	W	W	W	
		Sp	pecification	n of input o	or output fo	or port 1 pi	ns		
P2DDR—Port 2 Data Direction Register H'FFB1 Port							Port 2		
Bit	7	6	5	4	3	2	1	0	
	P27DDR	P26DDR	P25DDR	P24DDR	P23DDR	P22DDR	P21DDR	P20DDR	
Initial value	0	0	0	0	0	0	0	0	
Read/Write	W	W	W	W	W	W	W	W	
P1DR—Port 1	Data Reg		pecification	n of input c	or output for H'FFB2	or port 2 pi	ns	Port 1	
Bit	7	6	5	4	3	2	1	0	
	P17DR	P16DR	P15DR	P14DR	P13DR	P12DR	P11DR	P10DR	
Initial value	0	0	0	0	0	0	0	0	
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	
			Ou	tput data f	or port 1 p	oins			
P2DR—Port 2	Data Reg	gister			H'FFB3	3		Port 2	
Bit	7	6	5	4	3	2	1	0	
	P27DR	P26DR	P25DR	P24DR	P23DR	P22DR	P21DR	P20DR	
Initial value	0	0	0	0	0	0	0	0	
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	

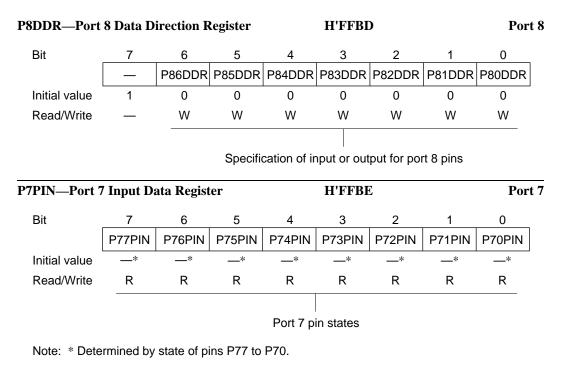
Output data for port 2 pins

P3DDR—Port	P3DDR—Port 3 Data Direction Register				H'FFB4				
Bit	7	6	5	4	3	2	1	0	
	P37DDR	P36DDR	P35DDR	P34DDR	P33DDR	P32DDR	P31DDR	P30DDR	
Initial value	0	0	0	0	0	0	0	0	
Read/Write	W	W	W	W	W	W	W	W	
P4DDR—Port	4 Data Di			n of input c	or output for H'FFB5	or port 3 pi	ns	Port 4	
Bit	7	6	5	4	3	2	1	0	
	P47DDR			P44DDR		P42DDR	P41DDR		
Initial value	0	0	0	0	0	0	0	0	
Read/Write	W	W	W	W	W	W	W	W	
Specification of input or output for port 4 pins P3DR—Port 3 Data Register H'FFB6 Port 3									
P3DR—Port 3	Data Reg	-					115	Port 3	
P3DR—Port 3 Bit	Data Reg 7	-	5	4			1	Port 3	
		jister		-	H'FFB6	5			
	7	ister 6	5	4	H'FFB6	2	1	0	
Bit	7 P37DR	ister 6 P36DR	5 P35DR	4 P34DR	H'FFB6 3 P33DR	2 P32DR	1 P31DR	0 P30DR	
Bit Initial value	7 P37DR 0	ister 6 P36DR 0	5 P35DR 0 R/W	4 P34DR 0	H'FFB6 3 P33DR 0 R/W	2 P32DR 0 R/W	1 P31DR 0	0 P30DR 0	
Bit Initial value	7 P37DR 0 R/W	ister 6 P36DR 0 R/W	5 P35DR 0 R/W	4 P34DR 0 R/W	H'FFB6 3 P33DR 0 R/W	2 P32DR 0 R/W	1 P31DR 0	0 P30DR 0	
Bit Initial value Read/Write	7 P37DR 0 R/W	ister 6 P36DR 0 R/W	5 P35DR 0 R/W	4 P34DR 0 R/W	H'FFB6 3 P33DR 0 R/W or port 3 p	2 P32DR 0 R/W	1 P31DR 0	0 P30DR 0 R/W	
Bit Initial value Read/Write P4DR—Port 4	7 P37DR 0 R/W Data Reg	ister 6 P36DR 0 R/W	5 P35DR 0 R/W Ou	4 P34DR 0 R/W tput data f	H'FFB6 3 P33DR 0 R/W or port 3 p H'FFB7	2 P32DR 0 R/W	1 P31DR 0 R/W	0 P30DR 0 R/W Port 4	
Bit Initial value Read/Write P4DR—Port 4	7 P37DR 0 R/W Data Reg	ister 6 P36DR 0 R/W ister	5 P35DR 0 R/W Ou 5	4 P34DR 0 R/W tput data f	H'FFB6 3 P33DR 0 R/W or port 3 p H'FFB7 3	2 P32DR 0 R/W bins	1 P31DR 0 R/W	0 P30DR 0 R/W Port 4	
Bit Initial value Read/Write P4DR—Port 4 Bit	7 P37DR 0 R/W Data Reg 7 P47DR	ister 6 P36DR 0 R/W ister 6 P46DR	5 P35DR 0 R/W Ou 5 P45DR	4 P34DR 0 R/W tput data f 4 P44DR	H'FFB6 3 P33DR 0 R/W or port 3 p H'FFB7 3 P43DR	2 P32DR 0 R/W bins 2 P42DR	1 P31DR 0 R/W 1 P41DR	0 P30DR 0 R/W Port 4	

Output data for port 4 pins



Output data for port 6 pins



28DR—Port 8 Data Register					Port 8			
Bit	7	6	5	4	3	2	1	0
	_	P86DR	P85DR	P84DR	P83DR	P82DR	P81DR	P80DR
Initial value	1	0	0	0	0	0	0	0
Read/Write	_	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Output data for port 8 pins

P9DDR—Port	P9DDR—Port 9 Data Direction Register				H'FFC0		Port 9	
Bit	7	6	5	4	3	2	1	0
	P97DDR	P96DDR	P95DDR	P94DDR	P93DDR	P92DDR	P91DDR	P90DDR
Mode 1			I	1	1		I	
Initial value	0	1	0	0	0	0	0	0
Read/Write	W	W	W	W	W	W	W	W
Modes 2 and 3	3							
Initial value	0	0	0	0	0	0	0	0
Read/Write	W	W	W	W	W	W	W	W

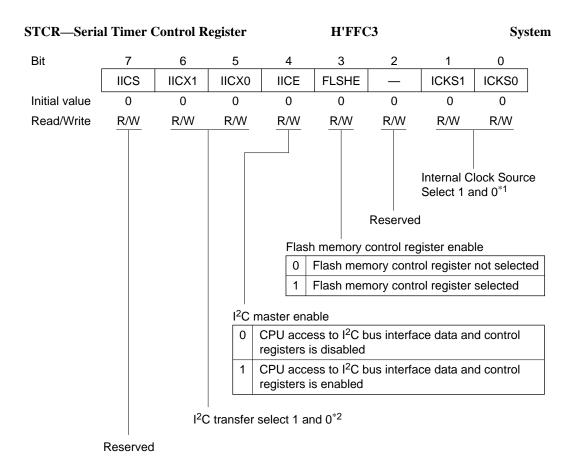
Specification of input or output for port 9 pins

P9DR—Port 9 Data Register H'FFC1 Port 9 7 Bit 6 5 3 2 1 0 4 P97DR P96DR P95DR P94DR P93DR P92DR P91DR P90DR 0 Initial value 0 __* 0 0 0 0 0 Read/Write R/W R R/W R/W R/W R/W R/W R/W

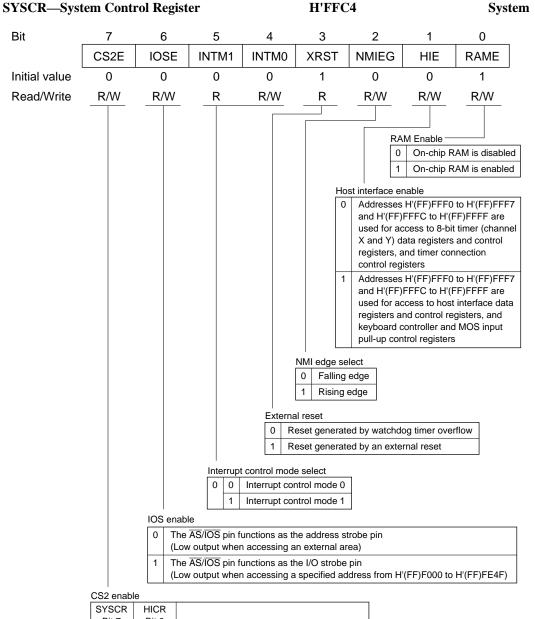
Output data for port 9 pins

Note: * Determined by state of pin P96.

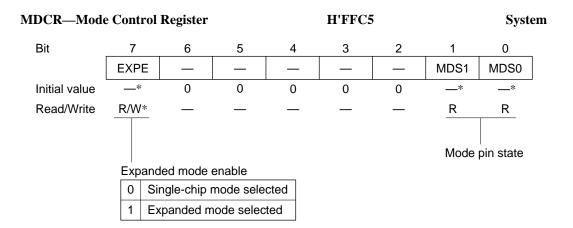
IER—IRQ En	IER—IRQ Enable Register					2	Interrupt Controller		
Bit	7	6	5	4	3	2	1	0	
	IRQ7E	IRQ6E	IRQ5E	IRQ4E	IRQ3E	IRQ2E	IRQ1E	IRQ0E	
Initial value	0	0	0	0	0	0	0	0	
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	
			IRC	7 to IRQ0	enable				
			0	IRQn int	errupt disa	abled			
			1	IRQn int	errupt ena	bled			
				•	(n =	= 7 to 0)			



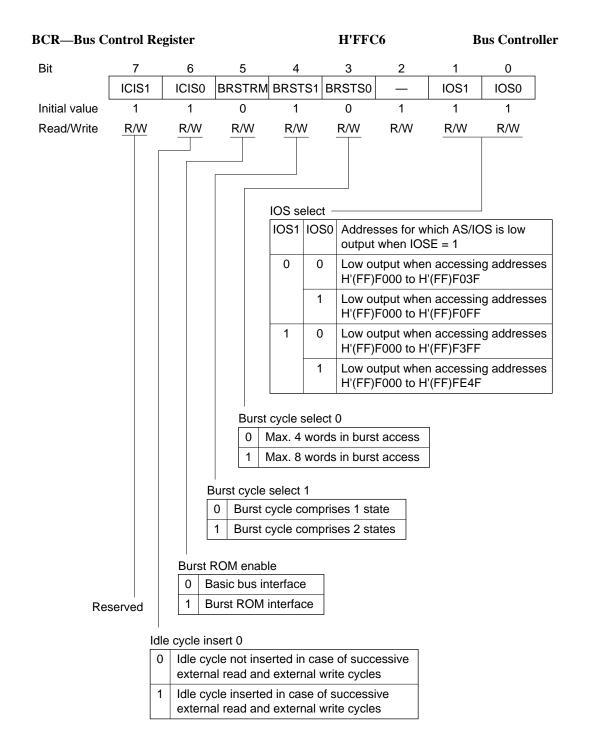
- Notes: 1. Used for 8-bit timer input clock selection. For details, see section 12.2.4, Timer Control Register (TCR).
 - Used for I²C bus interface transfer clock selection. For details, see section 16.2.4, I²C Bus Mode Register (ICMR).

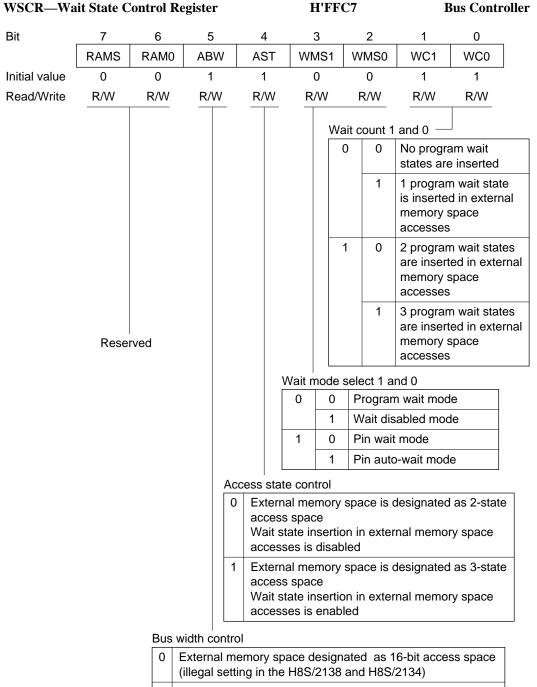


SYSCR	HICR						
Bit 7	Bit 0	Description					
CS2E	FGA20E						
0	0	CS2 pin function halted					
	1	(CS2 fixed high internally)					
1	0	$\overline{\text{CS2}}$ pin function selected for P81/ $\overline{\text{CS2}}$ pin					
	1	$\overline{\text{CS2}}$ pin function selected for P90/ $\overline{\text{ECS2}}$ pin					

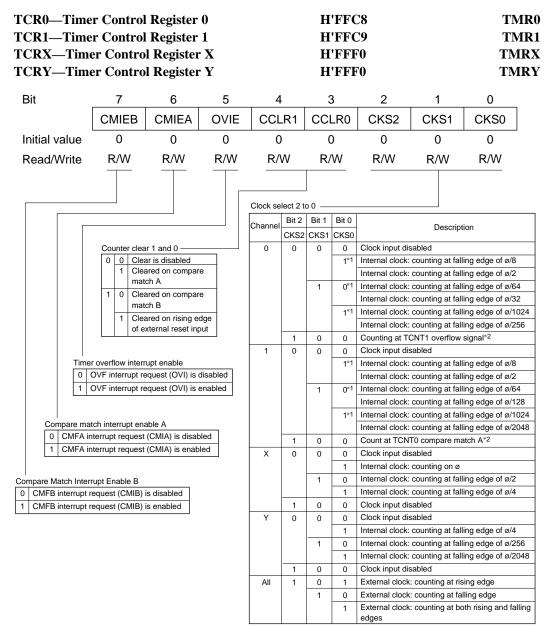


Note: * Determined by the MD1 and MD0 pins.



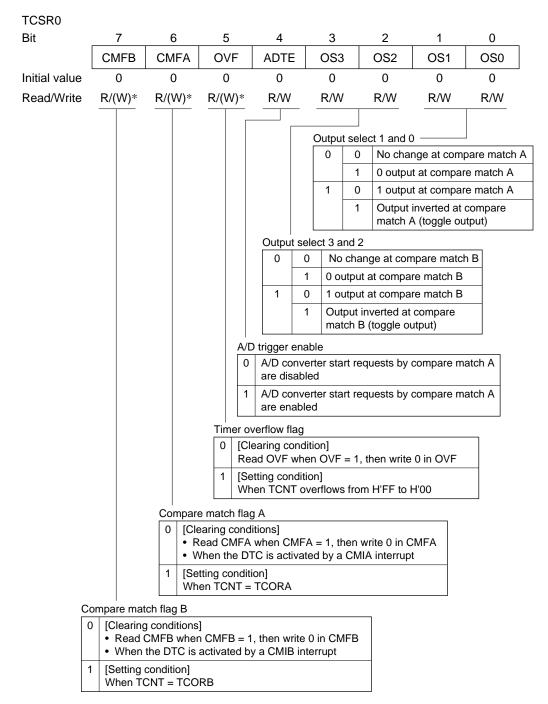


1 External memory space designated as 8-bit access space

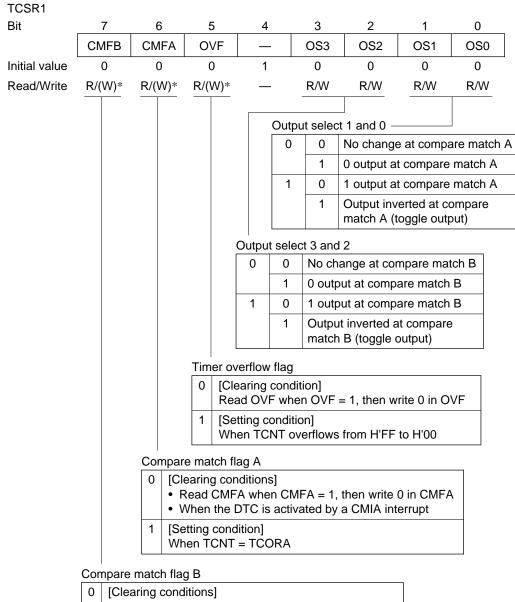


Notes: 1. Selected by ICKS1 and ICKS0 in STCR. For details, see section 12.2.4, Timer Control Register (TCR).

 If the clock input of channel 0 is the TCNT1 overflow signal and that of channel 1 is the TCNT0 compare match signal, no incrementing clock is generated. Do not use this setting.



Note: * Only 0 can be written in bits 7 to 5, to clear the flags.



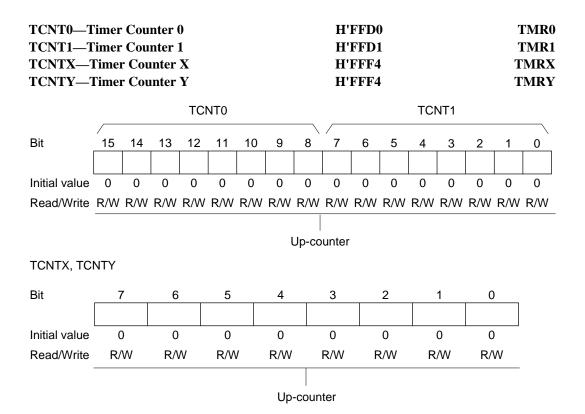
0	 [Clearing conditions] Read CMFB when CMFB = 1, then write 0 in CMFB When the DTC is activated by a CMIB interrupt
1	[Setting condition] When TCNT = TCORB

Note: * Only 0 can be written in bits 7 to 5, to clear the flags.

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TCORA1—Time Constant Register A1H'FFCDTTCORB0—Time Constant Register B0H'FFCETTCORB1—Time Constant Register B1H'FFCFTTCORAY—Time Constant Register AYH'FFF2TTCORBY—Time Constant Register BYH'FFF3TTCORC—Time Constant Register CH'FFF5TTCORAX—Time Constant Register AXH'FFF6T												FMR0 FMR1 FMR0 FMR1 MRY MRY MRX MRX MRX				
	TCORA0 TCORB0							TCORA1 TCORB1								
Bit	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Initial value Read/Write	1 R/W	1 R/W	1 R/W	1 R/W	1 R/W	1 R/W	1 R/W	1 R/W	1 R/W	1 R/W	1 R/W	1 R/W	1 R/W	1 R/W	1 R/W	1 R/W
Compare match flag (CMF) is set when TCOR and TCNT values match																
TCORAX, T TCORBX, T																
Bit	7	,	6		5		4		3		2		1	0		
Initial value	1		1		1		1		1		1		1	1		
Read/Write	R/	W	R/V	V	R/W	1	R/W		R/W	R	R/W	R	/W	R/	N	
	(Comp	are m	atch	flag (C	CMF)	is set	whe	n TCC)R an	d TCI	NT va	lues r	match		
TCORC																
Bit	7	,	6		5		4		3		2		1	0		
Initial value Read/Write							1 R/W		1 R/W	R	1 R/W		1 /W	1 R/\		
				-												

Compare match C signal is generated when sum of TCORC and TICR contents match TCNT value



PWOERA—PV PWOERB—PV	_		H'FFD3 H'FFD2			PWM PWM		
Bit	7	6	5	4	3	2	1	0
PWOERA	OE7	OE6	OE5	OE4	OE3	OE2	OE1	OE0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Bit	7	6	5	4	3	2	1	0
PWOERB	OE15	OE14	OE13	OE12	OE11	OE10	OE9	OE8
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Switching between PWM output and port output

-		
DDR	OE	Description
0	0	Port input
	1	Port input
1	0	Port output or PWM 256/256 output
	1	PWM output (0 to 255/256 output)

PWDPRA—PV PWDPRB—PV		•	0		H'FFD5 H'FFD4			PWN PWN
Bit	7	6	5	4	3	2	1	0
PWDPRA	OS7	OS6	OS5	OS4	OS3	OS2	OS1	OS0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Bit	7	6	5	4	3	2	1	0
PWDPRB	OS15	OS14	OS13	OS12	OS11	OS10	OS9	OS8
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

PWM output polarity control

0	PWM direct output (PWDR value corresponds to high width of output)
1	PWM inverted output (PWDR value corresponds to low width of output)

PWSL—PWM	l Register	Select				PW					
Bit	7	6	5	4	:	3		2		1	0
	PWCKE	PWCKS	—	_	R	S3		RS2		RS1	RS0
Initial value	0	0	1	0	0		0		0	0	
Read/Write	R/W	R/W	—	—	R/	R/W		R/W		R/W	R/W
					Register Select —						
					0 0 0			0	PW	DR0 sel	ected
								1	PW	DR1 sel	ected
								0	PWDR2 selected		ected
					1		1	PW	DR3 sel	ected	
						1	0	0	PW	DR4 sel	ected
								1	PWDR5 selected		ected
							1	0	PWDR6 selected		
									PWDR7 select		
					1	0	0			DR8 sel	
										DR9 sele	
							1			/DR10 se	
										/DR11 se	
					1 0					DR12 se	
										/DR13 se	
					1 0 PWE				/DR14 se		
								1	PW	DR15 se	elected

PWM clock enable, PWM clock select

PV	/SL	PC	SR					
Bit 7	Bit 6	Bit 2	Bit 1	Description				
PWCKE	PWCKS	PWCKB	PWCKA					
0	_	—		Clock input disabled				
1	0	—		ø (system clock) selected				
	1	0	0	ø/2 selected				
			1	ø/4 selected				
		1	0	ø/8 selected				
			1	ø/16 selected				

Bit	7	6	5	4	3	2	1	0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Specifies duty factor of basic output pulse and number of additional pulses

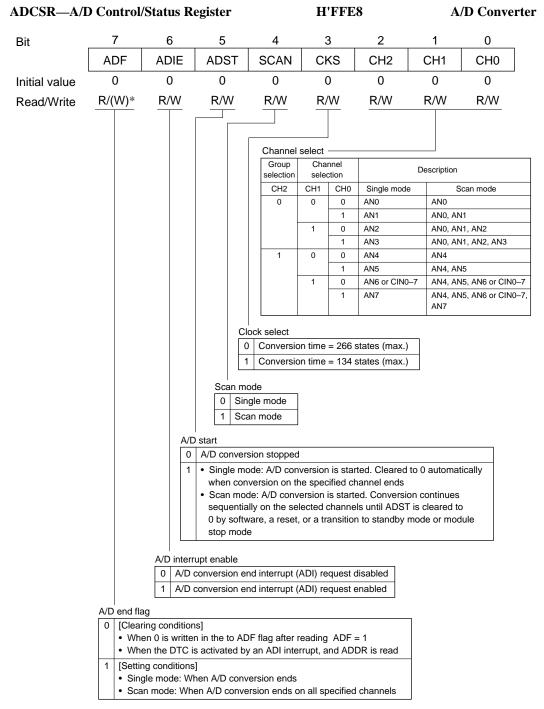
ADDRAH—A/D Data Register AH	H'FFE0	A/D Converter
ADDRAL—A/D Data Register AL	H'FFE1	A/D Converter
ADDRBH—A/D Data Register BH	H'FFE2	A/D Converter
ADDRBL—A/D Data Register BL	H'FFE3	A/D Converter
ADDRCH—A/D Data Register CH	H'FFE4	A/D Converter
ADDRCL—A/D Data Register CL	H'FFE5	A/D Converter
ADDRDH—A/D Data Register DH	H'FFE6	A/D Converter
ADDRDL—A/D Data Register DL	H'FFE7	A/D Converter

ADDRH							ADDRL									
Bit	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	AD9	AD8	AD7	AD6	AD5	AD4	AD3	AD2	AD1	AD0			Ι		_	—
Initial value	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Read/Write	R	R	R	R	R	R	R	R	R	R	R	R	R	R	R	R

Stores A/D data

Correspondence between a	nalog input channels and ADDR registe	rs
	alog inpat chamble and tebert regiote	

Analog Inp	A/D Data Register	
Group 0	Group 1	AD Data Register
AN0	AN4	ADDRA
AN1	AN5	ADDRB
AN2	AN6 or CIN0–CIN7	ADDRC
AN3	AN7	ADDRD



Note: * Only 0 can be written, to clear the flag.

ADCR—A/D Control Register

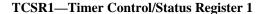


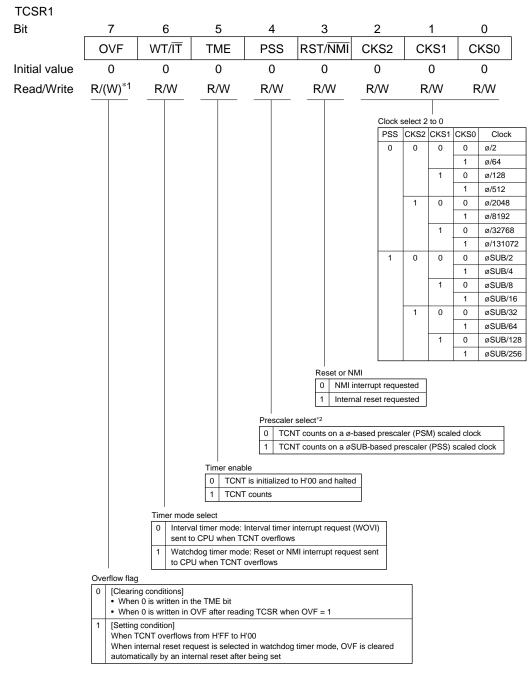
A/D Converter

Bit	7	6	5	4	3	2	1	0
	TRGS1	TRGS0	—	—	—	—	—	_
Initial value	0	0	1	1	1	1	1	1
Read/Write	R/W	R/W	—	—	—	—	—	—

Timer trigger select

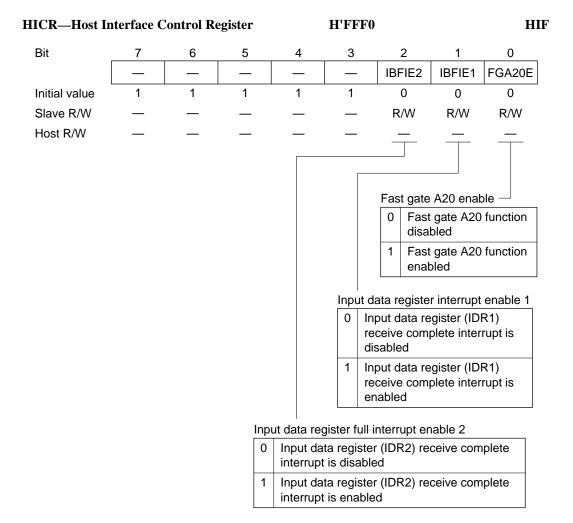
0	0	Start of A/D conversion by external trigger is disabled
	1	Start of A/D conversion by external trigger is disabled
1	0	Start of A/D conversion by external trigger (8-bit timer) is enabled
	1	Start of A/D conversion by external trigger pin is enabled



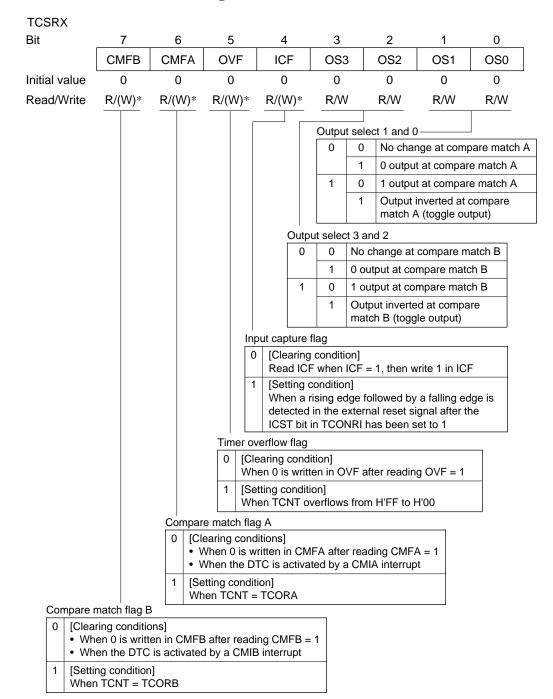


Notes: 1. Only 0 can be written, to clear the flag.

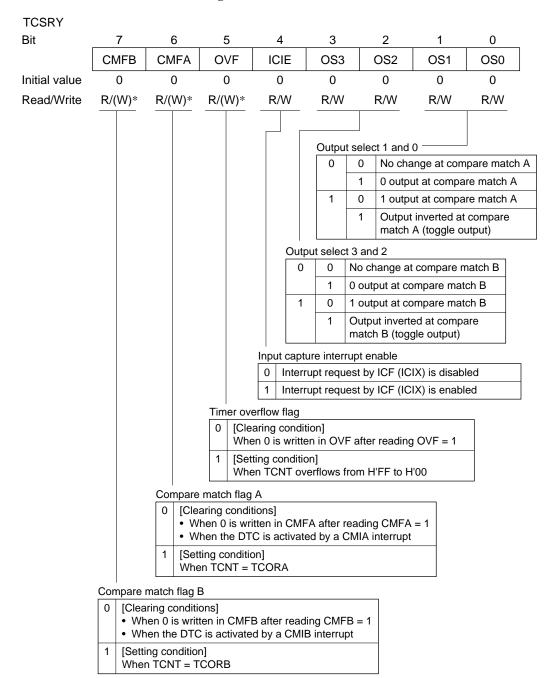
2. For operation control when a transition is made to power-down mode, see section 23.2.3, Timer Control/Status Register (TCSR).



H'FFF1



Note: * Only 0 can be written in bits 7 to 4, to clear the flags.



Note: * Only 0 can be written in bits 7 to 5, to clear the flags.

KMIMR								
Bit	7	6	5	4	3	2	1	0
	KMIMR7	KMIMR6	KMIMR5	KMIMR4	KMIMR3	KMIMR2	KMIMR1	KMIMR0
Initial value	1	0	1	1	1	1	1	1
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
			Keyboa	ard matrix	interrupt n	nask		
			0 Ke	ey-sense i	nput interr	upt reques	sts enable	d
			1 Ke	ey-sense i	nput interr	upt reques	sts disable	d
TICRR—Inpu	ıt Capture	Register	R		I	I'FFF2		TMR
TICRF—Inpu	-	0			I	H'FFF3		TMR
Bit	7	6	5	4	3	2	1	0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R	R	R	R	R	R	R	R
		Sto	ores TCNT	value at f	all of exte	rnal triggei	rinput	
KMPCR—Po	rt 6 MOS	Pull-Up (Control R	egister	H'FFF2			Port
Bit	7	6	5	4	3	2	1	0
	KM7PCR	KM6PCR	KM5PCR	KM4PCR	KM3PCR	KM2PCR	KM1PCR	KM0PCR
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
		С	ontrol of p	ort 6 built-	in MOS in	out pull-ur	20	

KMIMR—Keyboard Matrix Interrupt Mask Register H'FFF1 Interrupt Controller

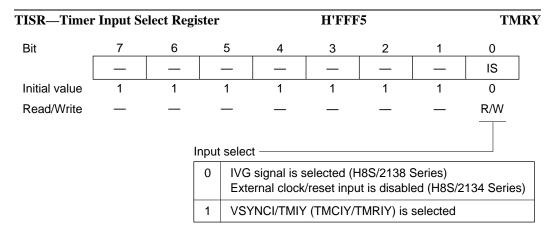
Note: KMPCR has the same address as TICRR/TCORAY of TMRX/TMRY. When selecting KMPCR, set the HIE bit to 1 in SYSCR.

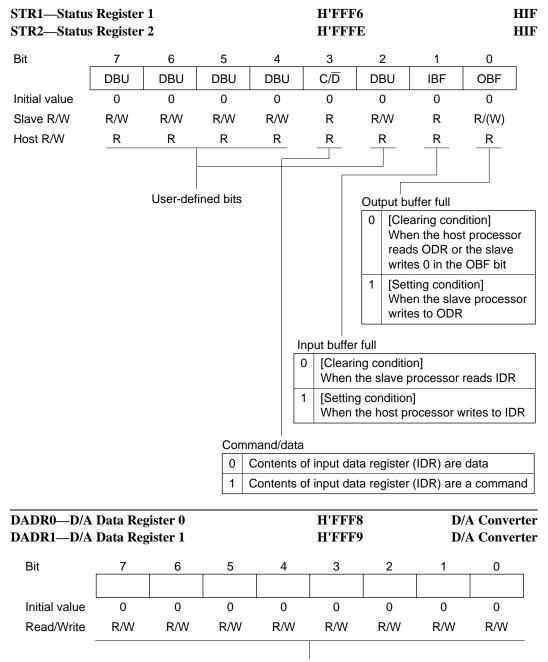
IDR1—Input Data Register 1 IDR2—Input Data Register 2				H'FFF4 H'FFFC					IIF IIF
Bit	7	6	5	4	3	2	1	0	_
	IDR7	IDR6	IDR5	IDR4	IDR3	IDR2	IDR1	IDR0	
Initial value									_
Slave R/W	R	R	R	R	R	R	R	R	
Host R/W	W	W	W	W	W	W	W	W	

Stores host data bus contents at rise of $\overline{\text{IOW}}$ when $\overline{\text{CS}}$ is low

ODR1—Output Data Register 1 ODR2—Output Data Register 2					H'FFF5 H'FFFD			H) H)
Bit	7	6	5	4	3	2	1	0
	ODR7	ODR6	ODR5	ODR4	ODR3	ODR2	ODR1	ODR0
Initial value	_		_		_			
Slave R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Host R/W	R	R	R	R	R	R	R	R
								<u> </u>

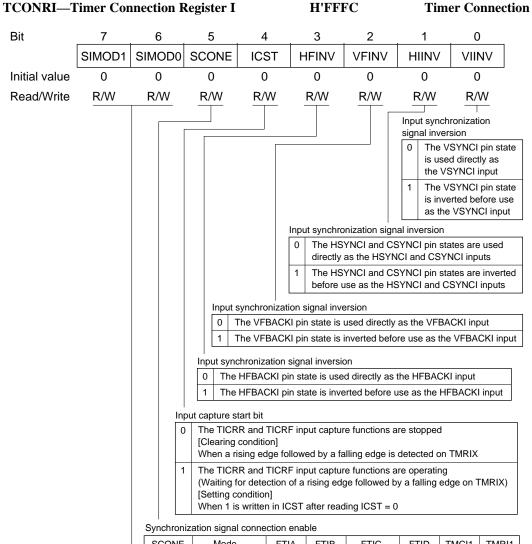
ODR contents are output to the host data bus when HA0 is low, $\overline{\text{CS}}$ is low, and $\overline{\text{IOR}}$ is low





Stores data for D/A conversion

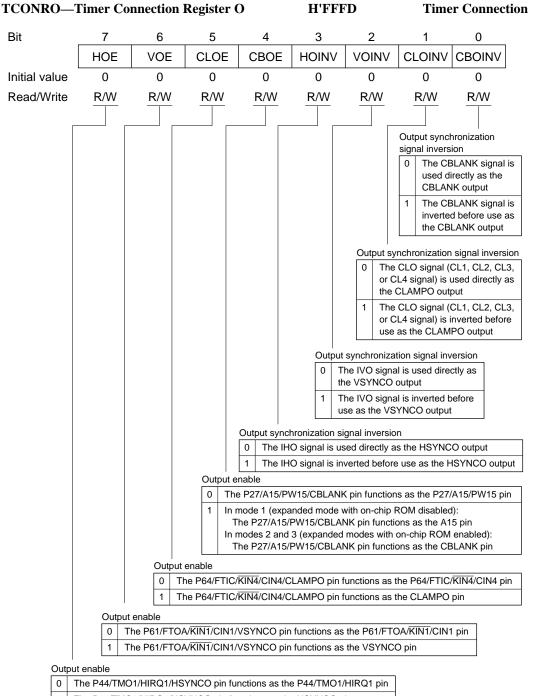
DACR—D/A	Control I	Register	r			H'FFI	FA	D	/A Convert
Bit	7	6	5	2	1	3	2	1	0
	DAOE1	DAOE	DA	E –	-	_	_	_	—
Initial value	0	0	0	1		1	1	1	1
Read/Write	R/W	R/W	D/A enal	_	_	_	_	_	—
			DAOE1	DAOE0	DA	E	Conve	ersion result	t
			0	0	*	Chan	nel 0 and 1	D/A conver	sion disabled
				1	0		nel 0 D/A co nel 1 D/A c		
					1	Chan	nel 0 and 1	D/A conver	sion enabled
			1	0	0		nel 0 D/A co nel 1 D/A co		
					1	Chan	nel 0 and 1	D/A conver	sion enabled
				1	*	Chan	nel 0 and 1	D/A conver	sion enabled
		0 A 1 E	D/A conve	ible 0 itput DA0 ersion is e itput DA0	enabl	ed on cha	annel 0.		*: Don't car
	D/A out						-		
	0 An	alog ou	tput DA1	disabled			_		
				nabled of is enable		nnel 1.			



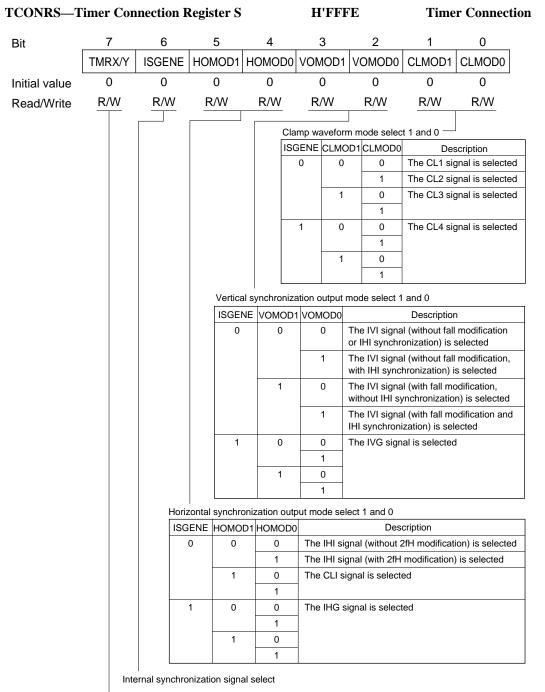
SCONE	Mode	FTIA	FTIB	FTIC	FTID	TMCI1	TMRI1
0	Normal connection	FTIA input	FTIB input	FTIC input	FTID input	TMCI1 input	TMRI1 input
1	Synchronization signal connec- tion mode	IVI signal	TMO1 signal	VFBACKI input	IHI signal	IHI signal	IVI inverse signal

Input synchronization mode select 1 and 0

SIMOD1	SIMOD0	Mode	IHI signal	IVI signal
0	0	No signal	HFBACKI input	VFBACKI input
	1	S-on-G mode	CSYNCI input	PDC input
1	0	Composite mode	HSYNCI input	PDC input
	1	Separate mode	HSYNCI input	VSYNCI input

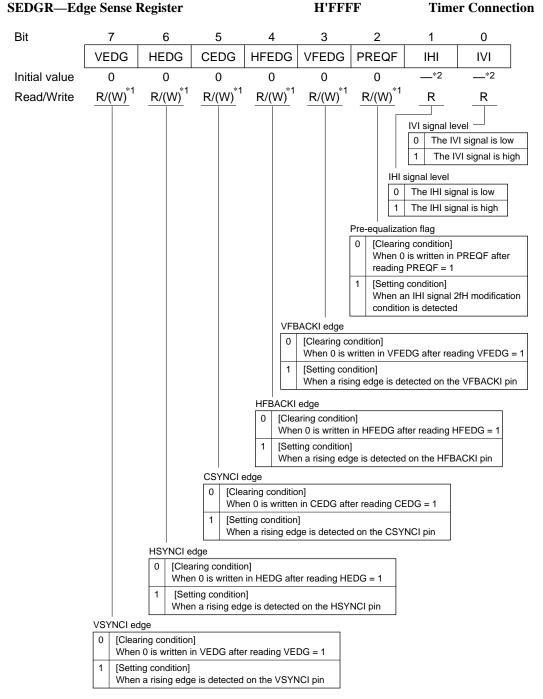


1 The P44/TMO1/HIRQ1/HSYNCO pin functions as the HSYNCO pin



TMRX/TMRY access select

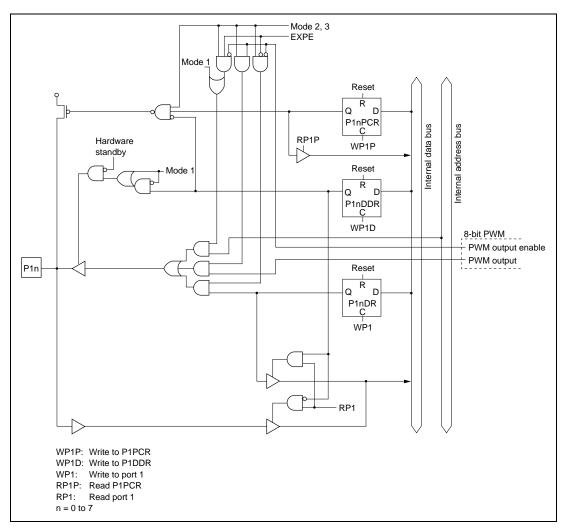
0	The TMRX registers are accessed at addresses H'FFF0 to H'FFF5
1	The TMRY registers are accessed at addresses H'FFF0 to H'FFF5



Notes: 1. Only 0 can be written, to clear the flags.

2. The initial value is undefined since it depends on the pin states.

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C.1 Port 1 Block Diagram

Figure C.1 Port 1 Block Diagram

C.2 Port 2 Block Diagrams

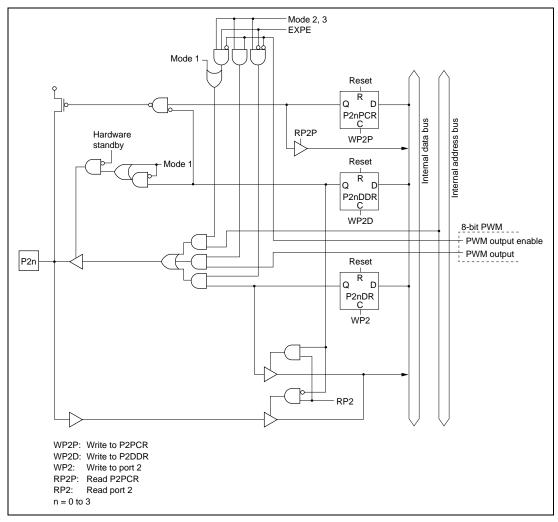


Figure C.2 Port 2 Block Diagram (Pins P20 to P23)

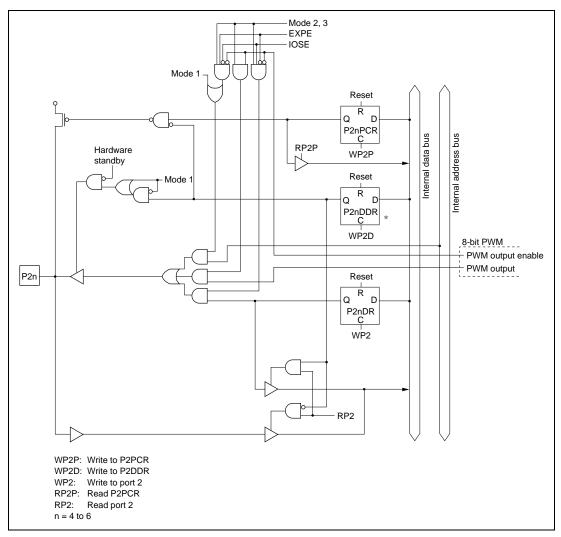


Figure C.3 Port 2 Block Diagram (Pins P24 to P26)

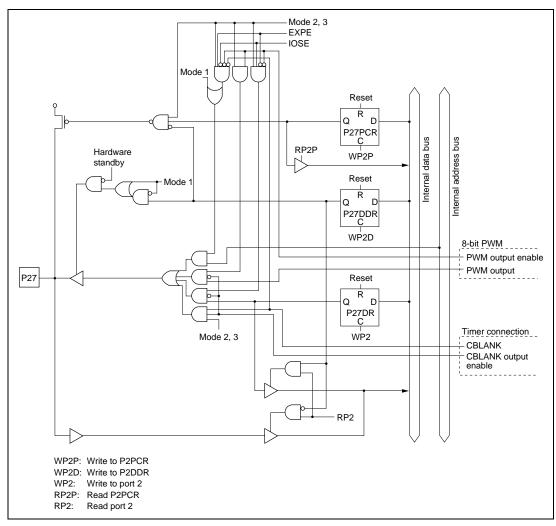


Figure C.4 Port 2 Block Diagram (Pin P27)

C.3 Port 3 Block Diagram

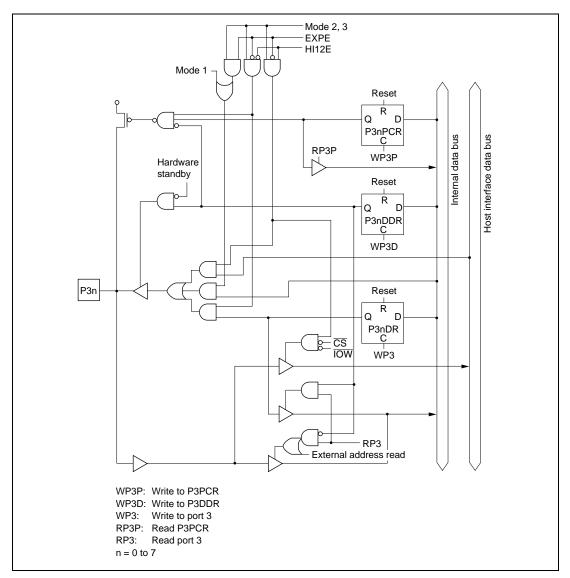


Figure C.5 Port 3 Block Diagram

C.4 Port 4 Block Diagrams

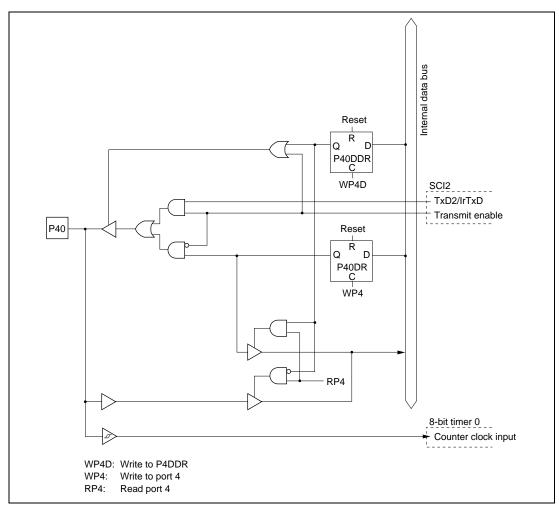


Figure C.6 Port 4 Block Diagram (Pin P40)

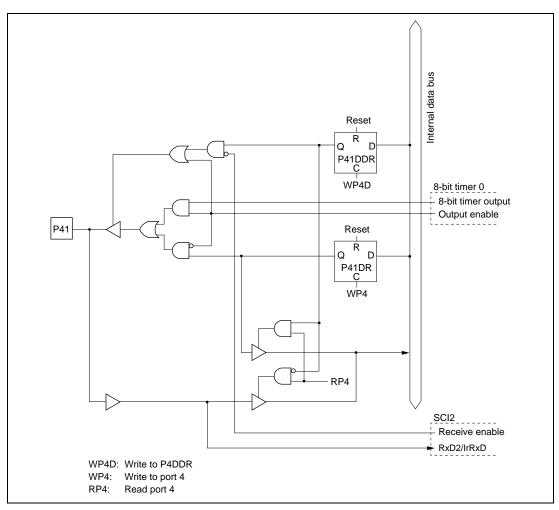


Figure C.7 Port 4 Block Diagram (Pin P41)

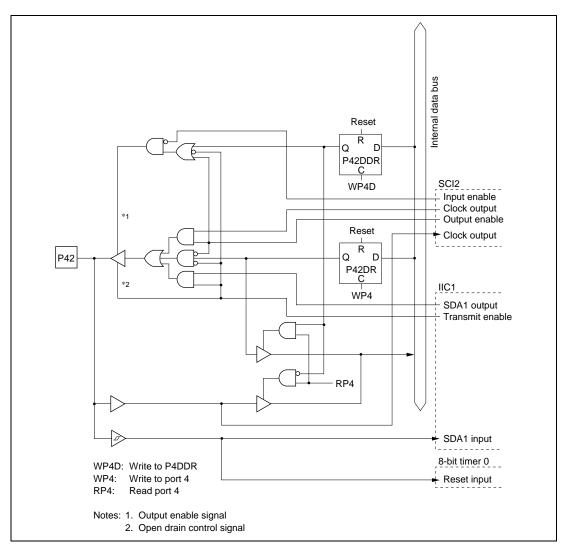


Figure C.8 Port 4 Block Diagram (Pin P42)

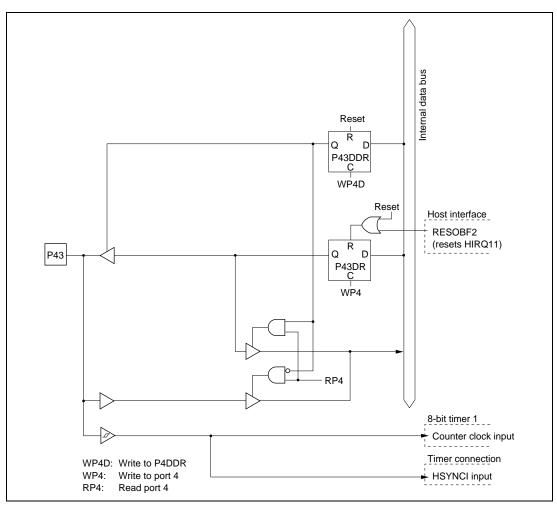


Figure C.9 Port 4 Block Diagram (Pin P43)

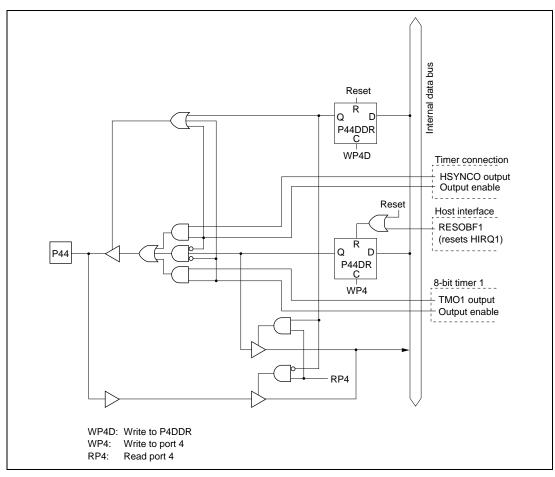


Figure C.10 Port 4 Block Diagram (Pin P44)

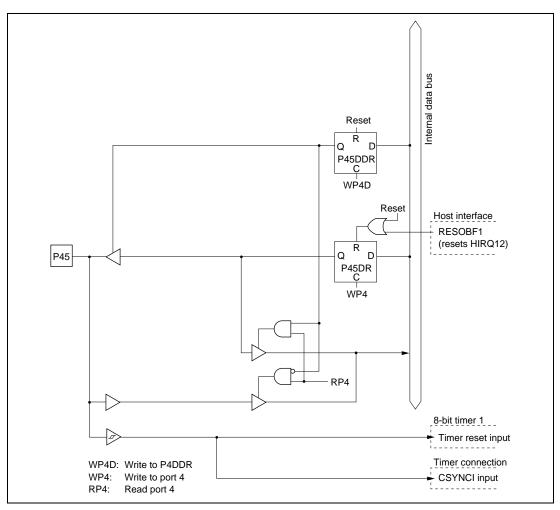


Figure C.11 Port 4 Block Diagram (Pin P45)

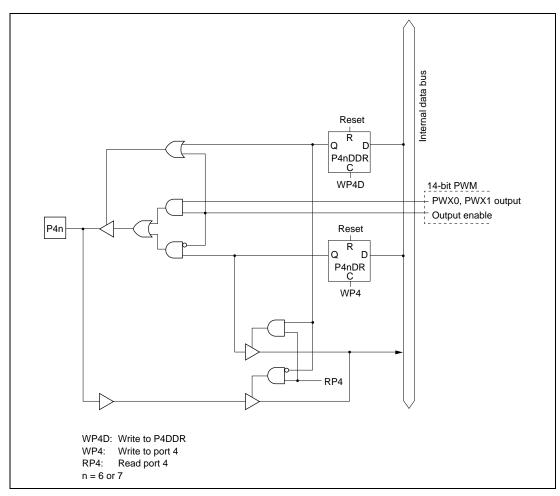


Figure C.12 Port 4 Block Diagram (Pins P46, P47)

C.5 Port 5 Block Diagrams

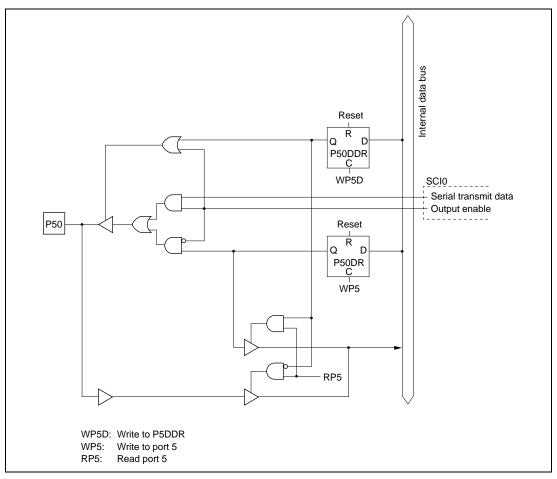


Figure C.13 Port 5 Block Diagram (Pin P50)

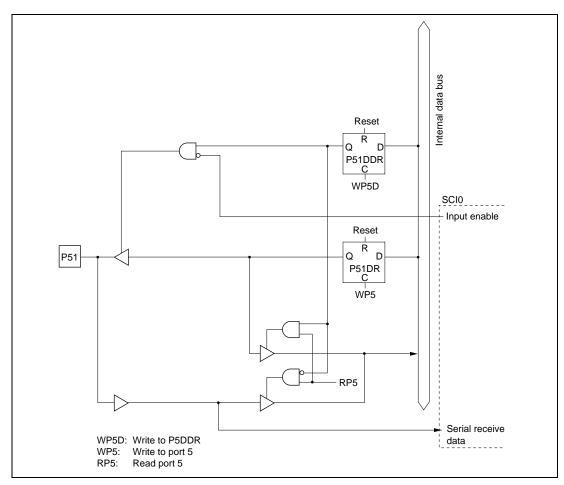


Figure C.14 Port 5 Block Diagram (Pin P51)

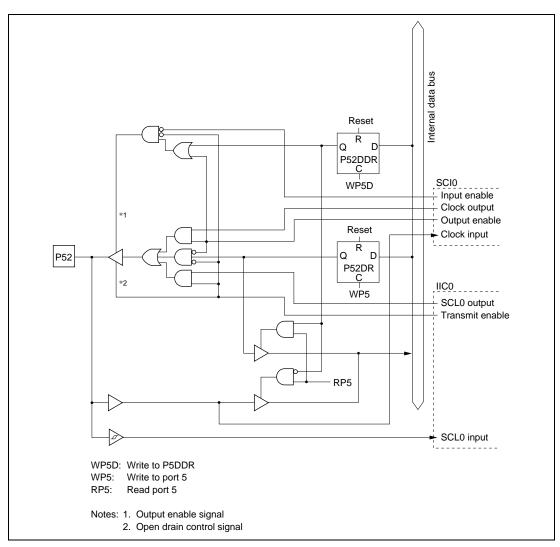


Figure C.15 Port 5 Block Diagram (Pin P52)

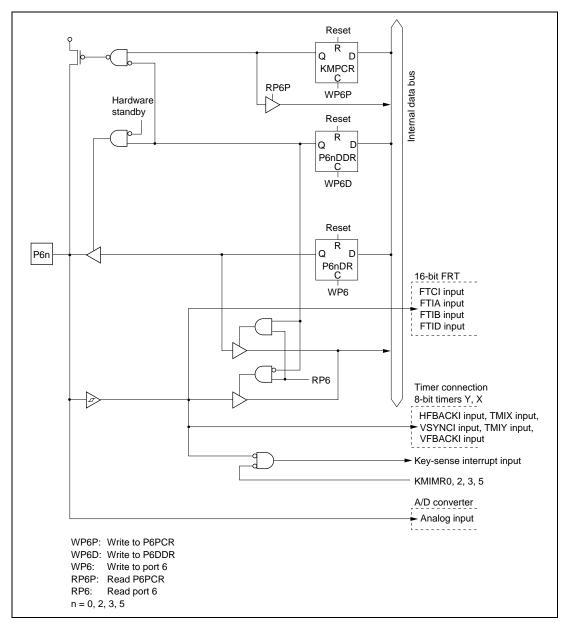


Figure C.16 Port 6 Block Diagram (Pins P60, P62, P63, P65)

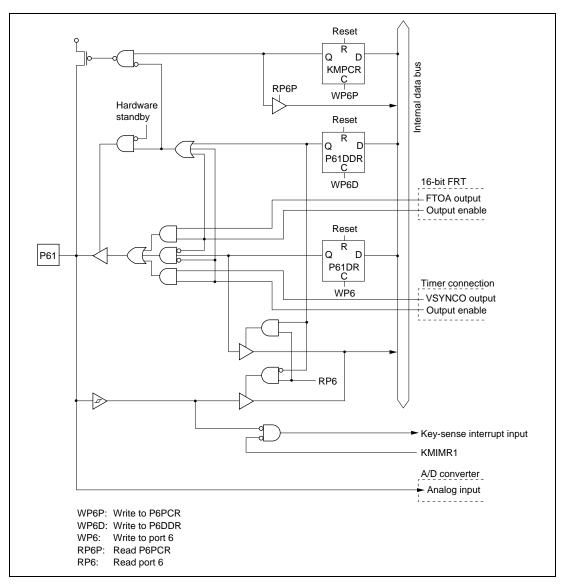


Figure C.17 Port 6 Block Diagram (Pin P61)

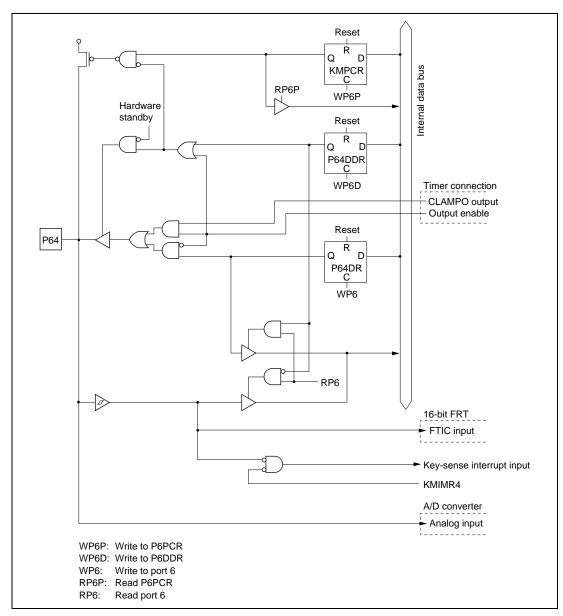


Figure C.18 Port 6 Block Diagram (Pin P64)

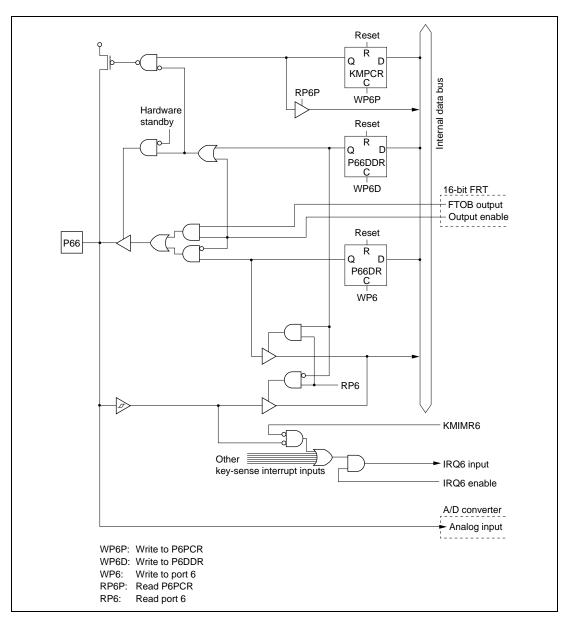


Figure C.19 Port 6 Block Diagram (Pin P66)

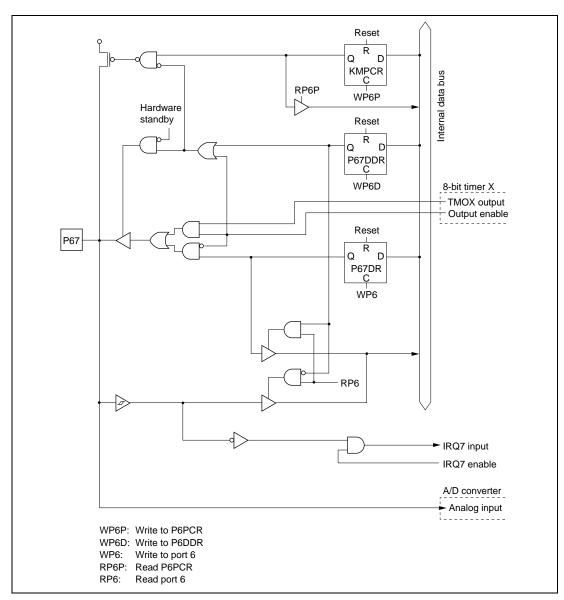
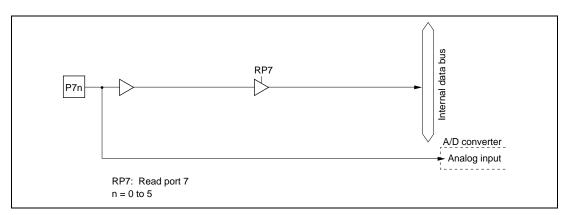
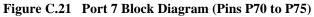


Figure C.20 Port 6 Block Diagram (Pin P67)

C.7 Port 7 Block Diagrams





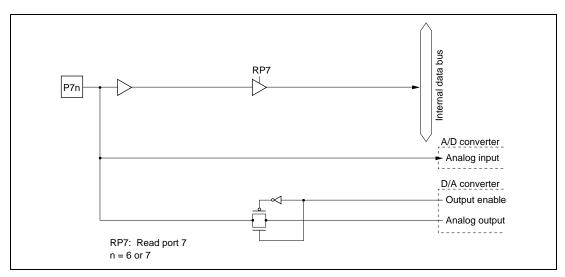


Figure C.22 Port 7 Block Diagram (Pins P76, P77)

C.8 Port 8 Block Diagrams

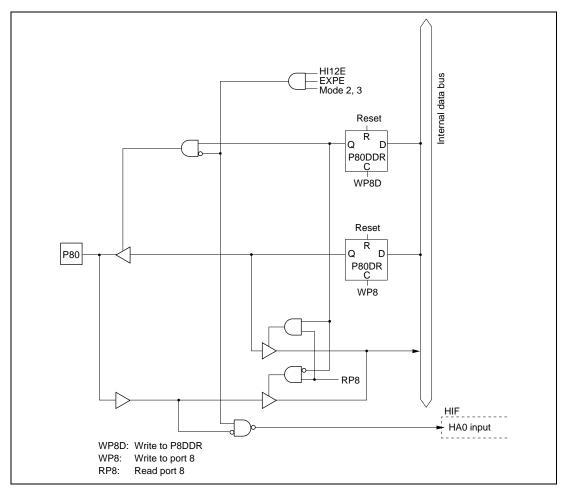


Figure C.23 Port 8 Block Diagram (Pin P80)

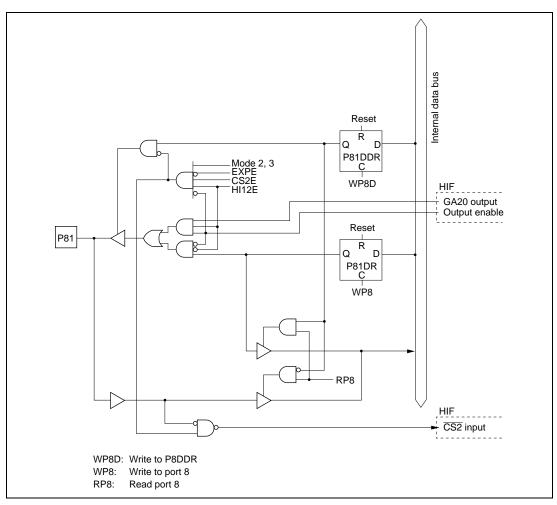


Figure C.24 Port 8 Block Diagram (Pin P81)

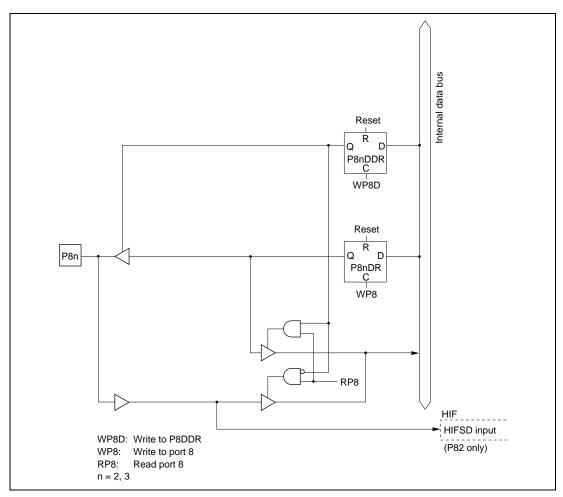


Figure C.25 Port 8 Block Diagram (Pins P82, P83)

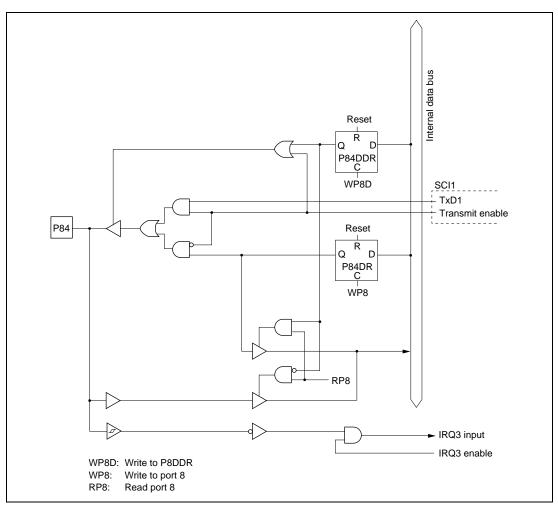


Figure C.26 Port 8 Block Diagram (Pin P84)

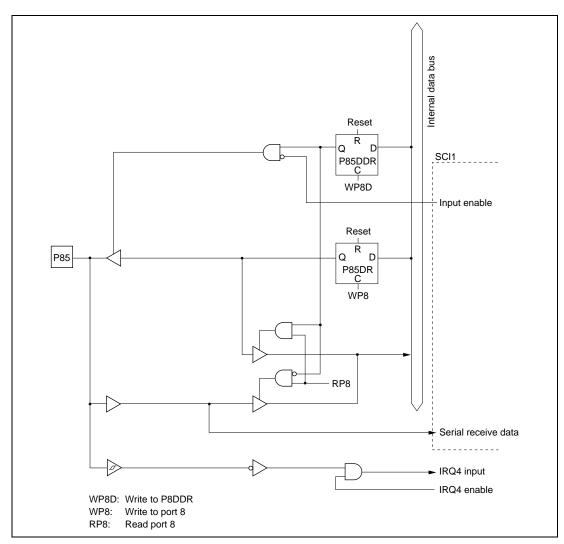


Figure C.27 Port 8 Block Diagram (Pin P85)

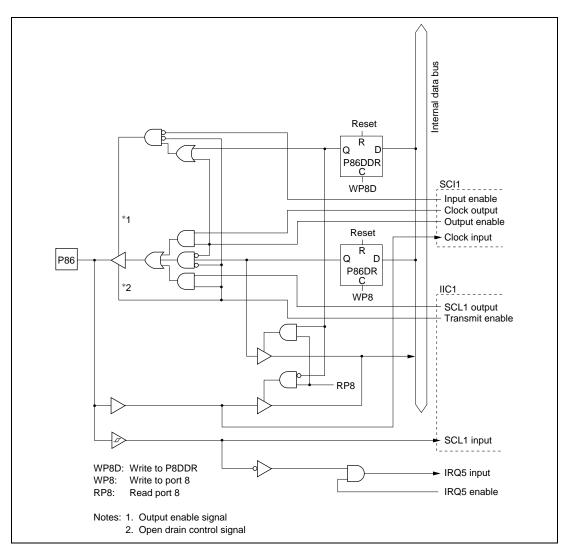


Figure C.28 Port 8 Block Diagram (Pin P86)

C.9 Port 9 Block Diagrams

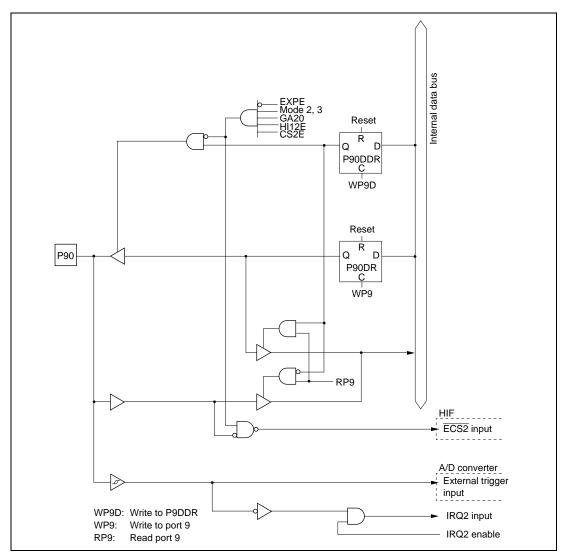


Figure C.29 Port 9 Block Diagram (Pin P90)

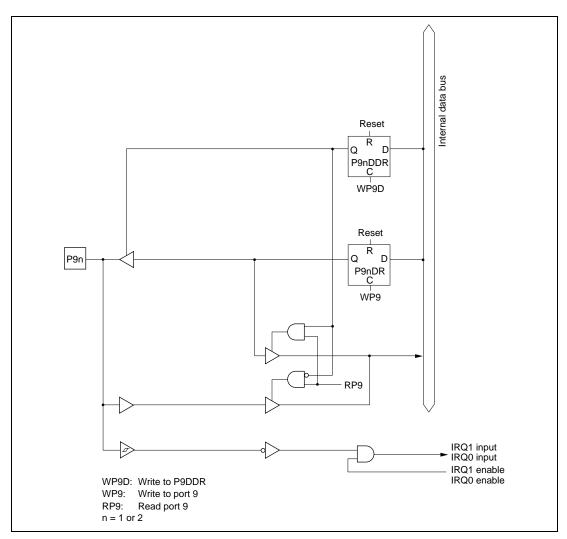


Figure C.30 Port 9 Block Diagram (Pins P91, P92)

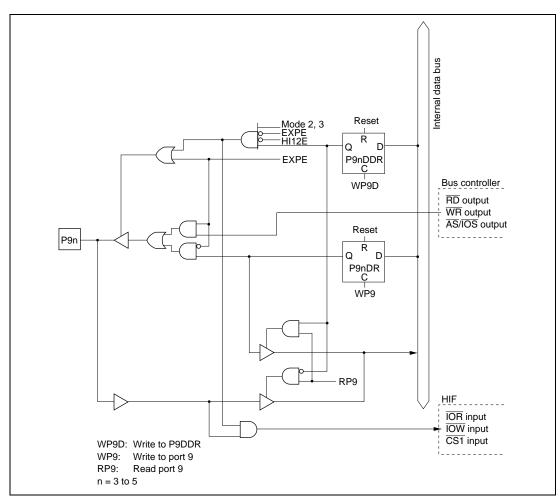


Figure C.31 Port 9 Block Diagram (Pins P93 to P95)

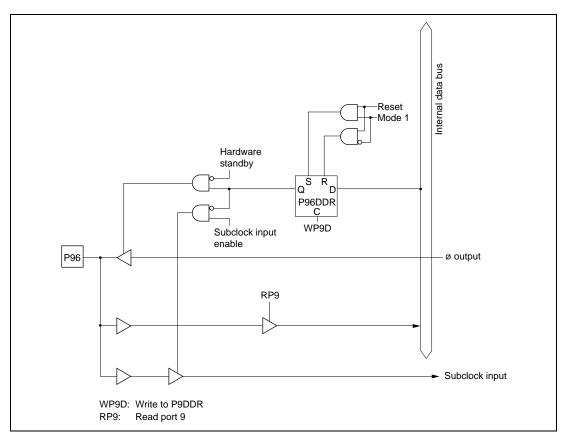


Figure C.32 Port 9 Block Diagram (Pin P96)

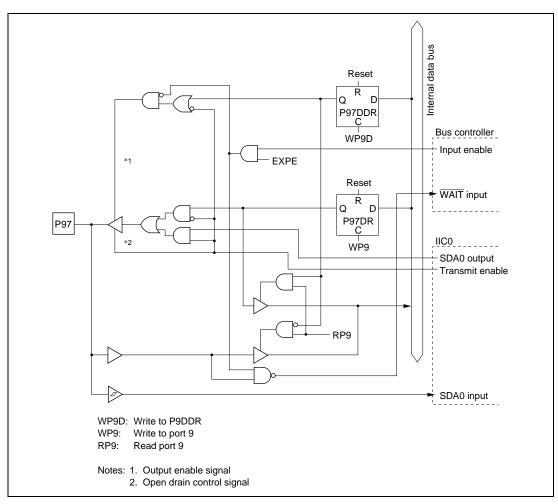


Figure C.33 Port 9 Block Diagram (Pin P97)

Appendix D Pin States

D.1 Port States in Each Processing State

Table D.1 I/O Port States in Each Processing State

Port Name Pin Name	MCU Operating Mode	Reset	Hardware Standby Mode	Software Standby Mode	Watch Mode	Sleep Mode	Sub- sleep Mode	Subactive Mode	Program Execution State
Port 1 A7 to A0	1	L	Т	keep*	keep*	keep*	keep*	A7 to A0	A7 to A0
	2, 3 (EXPE = 1)	Т						Address output/ input port	Address output/ input port
	2, 3 (EXPE = 0)							I/O port	I/O port
Port 2	1	L	Т	keep*	keep*	keep*	keep*	A15 to A8	A15 to A8
A15 to A8	2, 3 (EXPE = 1)	Т						Address output/ input port	Address output/ input port
	2, 3 (EXPE = 0)							I/O port	I/O port
Port 3	1	Т	Т	Т	Т	Т	Т	D7 to D0	D7 to D0
D7 to D0	2, 3 (EXPE = 1)								
	2, 3 (EXPE = 0)			keep	keep	keep	keep	I/O port	I/O port
Port 4	1	Т	Т	keep	keep	keep	keep	I/O port	I/O port
	2, 3 (EXPE = 1)								
	2, 3 (EXPE = 0)								
Port 5	1	Т	Т	keep	keep	keep	keep	I/O port	I/O port
	2, 3 (EXPE = 1)								
	2, 3 (EXPE = 0)								
Port 6	1	Т	Т	keep	keep	keep	keep	I/O port	I/O port
	2, 3 (EXPE = 1)								
	2, 3 (EXPE = 0)								
Port 7	1	Т	Т	Т	Т	Т	Т	Input port	Input port
	2, 3 (EXPE = 1)								
	2, 3 (EXPE = 0)								
Port 8	1	Т	Т	keep	keep	keep	keep	I/O port	I/O port
	2, 3 (EXPE = 1)								
	2, 3 (EXPE = 0)								
Port 97	1	Т	Т	T/keep	T/keep	T/keep	T/keep	WAIT/	WAIT/
WAIT	2, 3 (EXPE = 1)							I/O port	I/O port
	2, 3 (EXPE = 0)			keep	keep	keep	keep	I/O port	I/O port

	MCU Operating Mode	Reset	Hardware Standby Mode	Software Standby Mode	Watch Mode	Sleep Mode	Sub- sleep Mode	Subactive Mode	Program Execution State
Port 96 ø EXCL	1	Clock output	Т	[DDR = 1] H [DDR = 0] T	innut	[DDR = 1] clock output	EXCL input	EXCL input	Clock output/ EXCL input/ input port
	2, 3 (EXPE = 1)	Т				[DDR = 0] T	-		
	2, 3 (EXPE = 0)								
Port 95 to 93	1	Н	т	Н	Н	Н	Н	AS, WR,	AS, WR,
AS, WR, RD	2, 3 (EXPE = 1)	Т						RD	RD
	2, 3 (EXPE = 0)			keep	keep	keep	keep	I/O port	I/O port
Port 92 to 90	1	Т	Т	keep	keep	keep	keep	I/O port	I/O port
	2, 3 (EXPE = 1)								
	2, 3 (EXPE = 0)								

Table D.1 I/O Port States in Each Processing State (cont)

Legend:

H: High

L: Low

T: High-impedance state

keep: Input ports are in the high-impedance state (when DDR = 0 and PCR = 1, MOS input pullups remain on).

Output ports maintain their previous state.

Depending on the pins, the on-chip supporting modules may be initialized and the I/O port function determined by DDR and DR used.

DDR: Data direction register

Note: *In the case of address output, the last address accessed is retained.

Appendix E Timing of Transition to and Recovery from Hardware Standby Mode

E.1 Timing of Transition to Hardware Standby Mode

(1) To retain RAM contents with the RAME bit set to 1 in SYSCR, drive the RES signal low 10 system clock cycles before the STBY signal goes low, as shown in figure E.1. RES must remain low until STBY signal goes low (minimum delay from STBY low to RES high: 0 ns).

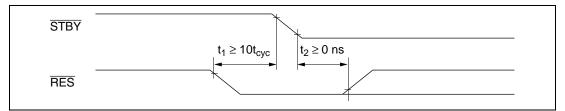


Figure E.1 Timing of Transition to Hardware Standby Mode

(2) To retain RAM contents with the RAME bit cleared to 0 in SYSCR, or when RAM contents do not need to be retained, $\overline{\text{RES}}$ does not have to be driven low as in (1).

E.2 Timing of Recovery from Hardware Standby Mode

Drive the $\overline{\text{RES}}$ signal low at least 100 ns before $\overline{\text{STBY}}$ goes high to execute a reset.

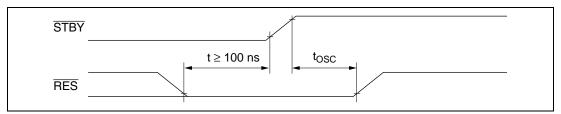


Figure E.2 Timing of Recovery from Hardware Standby Mode

Appendix F Product Code Lineup

Product T	уре			Product Code	Mark Code	Package (Hitachi Package Code)	Notes
H8S/2138 Series	H8S/2138	Mask ROM version	Standard product (5 V version, 4 V version, 3 V version)	HD6432138	HD6432138(***)FA	80-pin QFP (FP-80A)	In planning stage
					HD6432138(***)TF	80-pin TQFP (TFP-80C)	-
			Version with on-chip I ² C bus interface (5 V version, 4 V version, 3 V version)	HD6432138W	HD6432138W(***)FA	80-pin QFP (FP-80A)	_
					HD6432138W(***)TF	80-pin TQFP (TFP-80C)	_
		F-ZTAT version	Version with on-chip I ² C bus interface (5 V/4 V version)	HD64F2138	HD64F2138FA20	80-pin QFP (FP-80A)	Under developmen
			Low-voltage version (3 V version)	HD64F2138V	HD64F2138VFA10	80-pin QFP (FP-80A)	Under developmen
	H8S/2137	7 Mask ROM version	Standard product (5 V version, 4 V version, 3 V version)	HD6432137	HD6432137(***)FA	80-pin QFP (FP-80A)	In planning stage
					HD6432137(***)TF	80-pin TQFP (TFP-80C)	
			Version with on-chip I ² C bus interface	HD6432137W	HD6432137W(***)FA	80-pin QFP (FP-80A)	_
			(5 V version, 4 V version, 3 V version)		HD6432137W(***)TF	80-pin TQFP (TFP-80C)	-

Table F.1 H8S/2138 Series and H8S/2134 Series Product Code Lineup — Preliminary

Product T	ype			Product Code	Mark Code	Package (Hitachi Package Code)	Notes
H8S/2134 Series	H8S/2134	Mask ROM version	Standard product (5 V version, 4 V version, 3 V version)	HD6432134	HD6432134(***)FA	80-pin QFP (FP-80A)	In planning stage
					HD6432134(***)TF	80-pin TQFP (TFP-80C)	-
		F-ZTAT version	Standard product (5 V/4 V version)	HD64F2134	HD64F2134FA20	80-pin QFP (FP-80A)	
					HD64F2134TF20	80-pin TQFP (TFP-80C)	_
			Low-voltage version (3 V version)	HD64F2134V	HD64F2134VFA10	80-pin QFP (FP-80A)	_
					HD64F2134VTF10	80-pin TQFP (TFP-80C)	-
	H8S/2133	Mask ROM version	Standard product (5 V version, 4 V version, 3 V version)	HD6432133	HD6432133(***)FA	80-pin QFP (FP-80A)	In planning stage
					HD6432133(***)TF	80-pin TQFP (TFP-80C)	
	H8S/2132	Mask ROM version	Standard product (5 V version, 4 V version, 3 V version)	HD6432132	HD6432132(***)FA	80-pin QFP (FP-80A)	Under development
					HD6432132(***)TF	80-pin TQFP (TFP-80C)	-
		F-ZTAT version	Standard product (5 V/4 V version)	HD64F2132R	HD64F2132RFA20	80-pin QFP (FP-80A)	Under development
					HD64F2132RTF20	80-pin TQFP (TFP-80C)	_
			Low-voltage version (3 V version)	HD64F2132RV	HD64F2132RVFA10	80-pin QFP (FP-80A)	Under development
					HD64F2132RVTF10	80-pin TQFP (TFP-80C)	-
	H8S/2130	Mask ROM version	Standard product (5 V version, 4 V version, 3 V version)	HD64F2130	HD6432130(***)FA	80-pin QFP (FP-80A)	Under development
					HD6432130(***)TF	80-pin TQFP (TFP-80C)	_

Table F.1 H8S/2138 Series and H8S/2134 Series Product Code Lineup (cont)

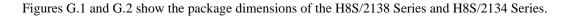
- Preliminary -

Note: (***) is the ROM code.

The F-ZTAT version of the H8S/2138 has an on-chip I^2C bus interface as standard. The F-ZTAT 5 V/4 V version supports the operating ranges of the 5 V version and the 4 V version.

The above table includes products in the planning stage or under development. Information on the status of individual products can be obtained from Hitachi's sales offices.

Appendix G Package Dimensions



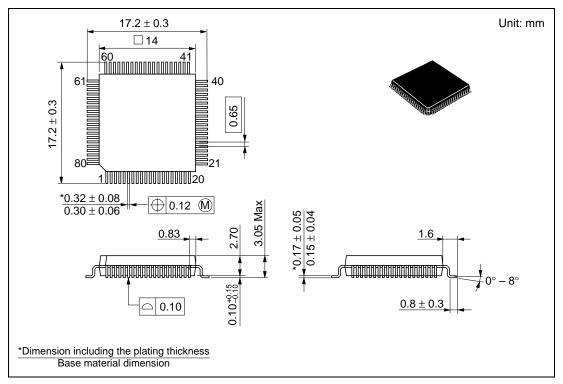


Figure G.1 Package Dimensions (FP-80A)

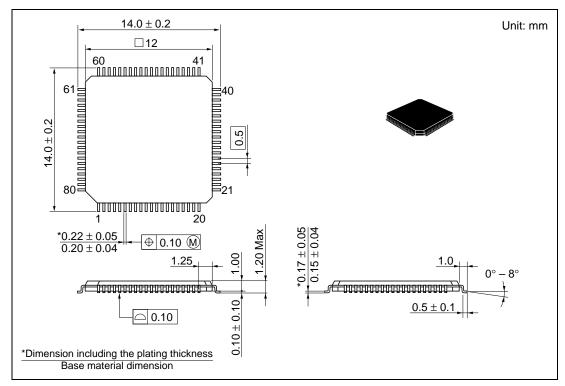


Figure G.2 Package Dimensions (TFP-80C)